

Transistor Arrays

THE MARK OF RELIABILITY

## INTEGRATED CIRCUITS

INTERFACE<br>- High Voltage<br>- High Current<br>- BiMOS and Complex Arrays

## LINEAR

- Radio/Communications
- Video and Television
- Audio


## HALL EFFECT DEVICES

TRANSISTOR ARRAYS


# SPRAGUE ELECTRIC COMPANY 

INTERFACE AND LINEAR INTEGRATED CIRCUITS
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[^2]


GENERAL INFORMATION

HIGH-VOLTAGE INTERFACE DRIVERS

## HIGH-CURRENT INTERFACE DRIVERS

BIMOS AND COMPLEX ARRAY INTERFACE DRIVERS

MILITARY AND AEROSPACE DEVICES

RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

VIDEO AND TELEVISION INTEGRATED CIRCUITS

AUDIO POWER AMPLIFIERS
hall effect devices

TRANSISTOR ARRAYS AND MISCELLANEOUS DEVICES


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## Sprague Part Numbering Systems



## Sprague Part Numbering Systems



1 = SELECTED VERSION, SEE DETAIL SPECIFICATIONS
MIL $=$ MILITARY GRADE WITH SCREENING TO MIL-STD-883, CLASS B (PACKAGES C AND D ONLY)

DEVICE TYPE (THREE DIGITS).

PACKAGE DESIGNATION.
C = GLASS/METAL HERMETIC, 14-PIN FLAT PACK
D = GLASS/METAL HERMETIC, 14-PIN DUAL IN-LINE
$K=$ UNPACKAGED CHIP OR PROBED WAFER
$P=$ PLASTIC, 14-PIN DUAL IN-LINE
$R=$ CERAMIC/GLASS HERMETIC, 14 -PIN DUAL IN-LINE

FAMILY (UH ONLY).

TPP - 1000

DEVICE TYPE (FOUR DIGITS OR FOUR DIGITS AND LETTER).

FAMILY.
TPP $=$ DARLINGTON ARRAY
TPQ = QUAD TRANSISTOR ARRAY

## CROSS-REFERENCE in Numerical Order

The suggested Sprague replacement devices are based on similarity as shown in currently published data. Exact replacement in all applications is not guaranteed. The user should compare the specifications of the competitive and recommended Sprague replacement.

| Manufacturers' Abbreviations: |  |
| :--- | :--- |
|  |  |
| AMI | American Microsystems |
| CS | Cherry Semiconductor |
| DI | Dionics, Inc. |
| EXR | Exar Integrated Systems |
| FER | Ferranti Limited |
| FSC | Fairchild Semiconductor |
| FUJ | Fuijtsu |
| GE | General Electric* |
| HIT | Hitachi Ltd. |
| IR | International Rectifier* |
| IT | IT Semiconductors |
| MAL | P. R. Mallory* |
| MAT | Matsushita |
| MIT | Mitsubishi Electric Corp. |
| MOT | Motorola Semiconductor |
| NEC | Nippon Electric Co. |
| NS | National Semiconductor |
| OKI | Oki Semiconductor |
| PE | Pro-Electron |
| PLS | Plessey Semiconductor |
| RAY | Raytheon Co.* |
| RCA | RCA |
| RFA | Rifa |
| SANY | Sanyo |
| SG | Silicon General Inc. |
| SIG | Signetics Corp. |
| SIL | Silicoonix |
| SGS | SGAAATES |
| SPC | Sprague Products Co.* |
| SPR | Sprague Electric Co. |
| SYL | Sylvania |
| THM | Thomson-CSF |
| TI | Texas Instruments |
| TLF | AEG-Telefunken |
| TOKO | RCL Toko |
| TOS | Toshiba Corp. |
| UNI | Unitrode |


| Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement |
| :--- | :--- | :--- |
| AD741CH |  | ULN-2151D* |
| AD741CN |  | ULN-2151M* |

[^3]| Competitive Part Number | Manufacturer | Suggested Sprague Replacement | Competitive Part <br> Number | Manufacturer | Suggested Sprague Replacement |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CA3045F | RCA | ULS-2045R | DH3724CN | NS | TPQ-3724 |
| CA3045L | RCA | ULS-2045H | DH3725CN | NS | TPQ-3725 |
| CA3046 | RCA | ULN-2046A |  |  |  |
| CA3054 | RCA | ULN-2054A | D1302 | DI | UDN-7183A |
| CA3064E | RCA | ULN-2264A* | D1502 | DI | UDN-6144A* $\dagger$ |
| CA3065 | RCA | ULN-2165A* | D1507 | DI | UDN-6116A-19 |
| CA3066 | RCA | ULN-2266A* | D1509 | DI. | UDN-6116A-29 |
| CA3067 | RCA | ULN-2267A* | D1510 | DI | UDN-6510A |
| CA3070 | RCA | ULN-2124A* | D1512 | DI | UDN-6514A |
| CA3071 | RCA | ULN-2127A* | D1514 | DI | UDN-6118A-29 |
| CA3072 | RCA | ULN-2228A* |  |  |  |
| CA3075 | RCA | ULN-2129A* | DM3724CN | NS | TPQ-3724 |
| CA3081E | RCA | ULN-2081A | DM3725CN | NS | TPQ-3725 |
| CA3082E | RCA | ULN-2082A | DS3611N | NS | UDN-3611M |
| CA3083E | RCA | ULN-2083A | DS3612N | NS | UDN-3612M |
| СА3086 | RCA | ULN-2986A | DS3613N | NS | UDN-3613M |
| CA3089E | RCA | ULN-2289A* | DS3614N | NS | UDN-3614M |
| CA3120E | RCA | ULN-2125A* |  |  |  |
| CA3121E | RCA | ULN-2269A* | DVR-01 |  | UHP-480* |
| CA3123E | RCA | ULN-2137A* |  |  | U11-480 |
| CA31260 | RCA | ULN-2262A* | FPQ2222 |  | TPQ-2222 |
| CA3135G | RCA | ULN-2261A* | FPQ2907 | FSC | TPQ-2907 |
| CA3146E | RCA | ULN-2046A-1 | FPQ3724 | FSC | TPQ-3724 |
| CA3153G | RCA | ULN-2297A* | FPQ3725 | FSC | TPQ-3725 |
| CA3170E | RCA | ULN-2268A** | FSA2619P | FSC | TND-908 |
| CA3172G | RCA | ULN-2229A* | FSA2719P | FSC | TND-903 |
| CA3183E | RCA | ULN-2083A-1 |  |  |  |
| CA3189E | RCA | ULN-3889A* | GEL2113 | GE | ULN-2111A |
| CA3195 | RCA | ULN-3812A* |  |  |  |
| CA3209E | RCA | ULX-3888A* | HA1137W | HIT | ULN-2289A* |
| CA3217E | RCA | ULN-3914A | HA1156W | HIT | ULN-3810A-1 |
| CA3219E | RCA | UDN-2541B | HA1199 | HIT | ULN-2249A |
| CA3724G | RCA | TPQ-3724 | HA1364 | HIT | ULN-22900 |
| CA3725G | RCA | TPQ-3725 | HA1377A | HIT | ULX-3777W* |
| CA10806A | RCA | ULN-3914A | HA1388 <br> HA12402 | HIT HIT | $\begin{aligned} & \text { ULX-3788W* } \\ & \text { ULN-2204A } \end{aligned}$ |
| CS102 | CS | ULN-3304M* |  |  |  |
| CS122 | CS | ULN-3306M* | 17512 | 17 | UHP-491* |
| CS166 | CS | ULN-2492A | 17552 | $1 T$ | ULN-2001A |

[^4]| Competitive |  | Suggested | Competitive |  | Suggested |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Part |  | Sprague | Part |  | Sprague |
| Number | Manufacturer | Replacement | Number | Manufacturer | Replacement |
| ITT554 | ITI | ULN-2002A | LM124N | NS | ULN-4336A* |
| ITT556 | ITI | ULN-2003A | LM148N | NS | ULN-4336A* |
| ITT652 | ITI | ULN-2001A | LM224N | NS | ULN-4336A* |
| ITT654 | ITI | ULN-2002A | LM324N | NS | ULN-4336A* |
| IT656 | ITI | ULN-2003A | LM377N | NS | ULN-2274B* |
| ITT3064 | ITI | ULN-2264A* | LM378N | NS | ULN-2278B-1* |
| ITT3065 | ITI | ULN-2165A* | LM380N | NS | ULN-2280B |
|  |  |  | LM383AT | NS | ULN-37022 |
| KB4402 | TOKO | ULN-2289A* | LM383T | NS | ULN-37012 |
| KB4409 | TOKO | ULN-3810A | LM384N | NS | ULN-3784B |
|  |  |  | LM741CH | NS | ULN-2151D* |
| L119 | SGS | ULX-3908Q* | LM741CN | NS | ULN-2151M* |
| L180 | SGS | ULX-3801Q* | LM746N | NS | ULN-2228A* |
| L201 | SGS | ULN-2001A | LM1304 | NS | ULN-2120A* |
| L202 | SGS | ULN-2002A | LM1305 | NS | ULN-2122A* |
| L203 | SGS | ULN-2003A | LM1307N | NS | ULN-2128A* |
| L204 | SGS | ULN-2004A | LM1310N | NS | ULN-3810A-1 |
| L601 | SGS | ULN-2821A | LM1391N | NS | ULN-2291M* |
| L602 | SGS | ULN-2822A | LM1394N | NS | ULN-2294M* |
| L603 | SGS | ULN-2823A |  |  |  |
| L604 | SGS | ULN-2824A | LM1800N | NS | ULN-3812A |
|  |  |  | LM1820N | NS | ULN-2137A* |
| LA705PC | SANY | ULN-3812A | LM1827N | NS | ULN-2224A* |
| LA758PC | SANY | ULN-3812A | LM1828N | NS | ULN-2228A* |
| LA1160 | SANY | ULN-2243A | LM1829N | NS | ULN-2262A* |
| LA1230 | SANY | ULN-2289A* | LM1841N | NS | ULN-2136A* |
| LA1364 | SANY | ULN-2264A* | LM1848N | NS | ULN-2229A* |
| LA1368 | SANY | ULN-2298A* | LM1877N | NS | ULN-2274B* |
| LA1369 | SANY | ULN-2224A* | LM2002T | NS | ULN-37012 |
| LA3045 | SANY | ULS-2045H | LM2002AT | NS | ULN-37022 |
| LA3046 | SANY | ULN-2046A | LM2111N | NS | ULN-2111A |
| LA3086 | SANY | ULN-2086A | LM2113N | NS | ULN-2111A |
| LA3089 | SANY | ULN-2289A* | LM3045D | NS | ULS-2045H |
| LA3301 | SANY | ULN-3810A-1 | LM3046N | NS | ULN-2046A |
| LA3350 | SANY | ULN-3810A. | LM3053N | NS | ULN-2209M* |
| LB1231 | SANY | ULN-2001A | LM3054N | NS | ULN-2054A |
| LB1232 | SANY | ULN-2002A | LM3064N | NS | ULN-2264A* |
| LB1233 | SANY | ULN-2003A | LM3065N | NS | ULN-2165A* |
| LB1234 | SANY | ULN-2004A | LM3066N | NS | ULN-2266A* |
| LB1294 | SANY | UHP-491* | LM3067N | NS | ULN-2267A* |

[^5]| Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement | Competitive <br> Part <br> Number | Manufacturer | Suggested Sprague Replacement |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
| LM3070N | NS | ULN-2124A* | MC1356P | MOT | ULN-2136A* |
| LM3071N | NS | ULN-2127A* | MC1357P | MOT | ULN-2111A |
| LM3072N | NS | ULN-2228A* | MC1358P | MOT | ULN-2165A* |
| LM3075N | NS | ULN-2129A* | MC1364P | MOT | ULN-2264A* |
| LM3086N | NS | ULN-2086A | MC1370P | MOT | ULN-2124A* |
| LM3089N | NS | ULN-2289A* | MC1371P | MOT | ULN-2127A* |
| LM3611N | NS | UDN-3611M | MC1375P | MOT | ULN-2129A* |
| LM3612N | NS | UDN-3612M | MC1389P | MOT | ULN-2289A* |
| LM3613N | NS | UDN-3613M | MC1391P | MOT | ULN-2291M* |
| LM3614N | NS | UDN-3614M | MC1394P | MOT | ULN-2294M* |
|  |  |  | MC1398P | MOT, | ULN-2298A* |
| M54523 | MIT | ULN-2003A |  |  |  |
| M54524P | MIT | ULN-2001A | MC1411L | MOT | ULN-2001R |
| M54525P | MIT | ULN-2002A | MC1411P | MOT | ULN-2001A |
| M54526P | MIT | ULN-2004A | MC1412L | MOT | ULN-2002R |
| M54532P | MIT | ULN-2064B | MC1412P | MOT | ULN-2002A |
| M54562P | MIT | UDN-2982A | MC1413L | MOT | ULN-2003R |
| M5463P | MIT | UDN-2981A | MC1413P | MOT | ULN-2003A |
|  |  |  | MC1413TP | MOT | ULQ-2003A |
| MB3759C | FUJ | ULQ-8194R§ | MC1416L | MOT | ULN-2004R |
| MB3759P | FUJ | ULQ-8194A§ | MC1416P | MOT | ULN-2004A |
| MB3760C | FUJ | ULQ-8195R§ | MC1417P | MOT | UDN-2580A |
| MB3760P | FUJ | ULQ-8195A§ | MC1439G | MOT | ULN-2139G* |
|  |  |  | MC1439P1 | MOT | ULN-2139M* |
| MC1304 | MOT | ULN-2120A* | MC1471P1 | MOT | UDN-5711M |
| MC1305 | MOT | ULN-2122A* | MC1472P1 | MOT | UDN-5712M |
| MC1307P | MOT | ULN-2128A* | MC1473P1 | MOT | UDN-5713M |
| MC1309 | MOT | ULN-3809A | MC1474P1 | MOT | UDN-5714M |
| MC1310EP | MOT | ULN-3810A | MC1741CG | MOT | ULN-2151D* |
| MC1310P | MOT | ULN-3810A | MC1741CP1 | MOT | ULN-2151M* |
| MC1311P | MOT | ULN-3812A | MC3346 | MOT | ULN-2046A |
| MC1320P | MOT | ULN-2137A* | MC3357P | MOT | ULX-3857A* |
| MC1324P | MOT | ULN-2224A* | MC3386P | MOT | ULN-2086A |
| MC1326P | MOT | ULX-2226A* | MC3403P | MOT | ULN-4336A* |
| MC1327P | MOT | ULN-2217A* | MFC4050 | MOT | ULN-2135E* |
| MC1328P | MOT | ULN-2228A* |  |  |  |
| MC1329P | MOT | ULN-2229A* | ML3045 |  | ULS-2045H |
| MC1339P | MOT | ULN-2126A* | ML3046 |  | ULN-2046A |
| MC1344P | MOT | ULN-3812A | ML3086 |  | ULN-2086A |

*№ longer manufactured. Listed for reference only.
§Sprague engineering bulletin in preparation.

| Competitive |  | Suggested | Competitive |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Part |  | Sprague | Part |  | Suggested |
| Number | Manufacturer | Replacement | Number |  | Sprague |
| MPQ2221 | MOT | TPQ-2221 |  | NE594F | Manufacturer | Replacement

[^6]| Competitive |  | Suggested | Competitive |  | Suggested |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Part |  | Sprague | Part |  | Sprague |
| Number | Manufacturer | Replacement | Number | Manufacturer | Replacement |
| Q2T2222 | Tl | TPQ-2222 | SG2002N | SG | ULN-2002A |
| Q2T3725 | Tl | TPQ-3725 | SG2003J | SG | ULS-2003R |
|  |  |  | SG2003N | SG | ULN-2003A |
| RC741DN | RAY | ULN-2151M* | SG2004J | SG | ULS-2004R |
| RC741TE | RAY | ULN-2151D* | SG2004N | SG | ULN-2004A |
| RC4136DP | RAY | ULN-4136A* | SG2524BJ | SG | ULQ-8124R§ |
| RC4236DP | RAY | ULN-4236A* | SG2524BN | SG | ULQ-8124A§ |
| RC4336DP | RAY | ULN-4336A* |  |  |  |
| RC4436DP | RAY | ULN-4436A* | SG2524F | SIG | ULQ-8124R§ |
|  |  |  | SG2524N | SIG | ULQ-8124A§ |
| \$4534 | AMI | UCN-4810A |  |  |  |
| \$4535 | AMI | UCN-5818A | SG2525AJ | SG | ULQ-8125R§ |
|  |  |  | SG2525AN | SG | ULQ-8125A§ |
| SA594N | SIG | UDQ-6118A-2§ | SG2526J | SG | ULQ-8126R |
| SE5560F | SIG | ULS-8160R | SG2526N | SG | ULQ-8126A |
| SE5560N | SIG | ULS-8160A | SG2527AJ | SG | ULQ-8127R§ |
| SE5561N | SIG | ULS-8161M | SG2527AN | SG | ULQ-8127A§ |
| SE5562F | SIG | ULS-8162R§ | SG2841N | SG | UDN-2841B |
| SE5562N | SIG | ULS-8162A§ | SG3081N | SG | ULN-2081A |
| SE5563F | SIG | ULS-8163R§ | SG3082N | SG | ULN-2082A |
| SE5563N | SIG | ULS-8163A§ | SG3083N | SG | ULN-2083A |
|  |  |  | SG3086N | SG | ULN-2086A |
| SFC2046E | THM | ULN-2046A | SG3146N | SG | ULN-2046A-1 |
| SFC2054EC | THM | ULN-2054A | SG3183N | SG | ULN-2083A-1 |
| SFC2086E | THM | ULN-2086A | SG3524BJ | SG | ULN-8124R§ |
|  |  |  | SG3524BN | SG | ULN-8124A§ |
| SG741CT | SG | ULN-2151D* | SG3524N | SIG | U N -8124A§ |
| SG741CM | SG | ULN-2151M* | SG3524N | SIG | ULN-8124A§ |
| SG1524BJ | SG | ULS-8124R§ | SG3525AJ | SG | ULN-8125R§ |
|  |  |  | SG3525AN | SG | ULN-8125A§ |
| SG1524F | SIG | ULS-8124R§ | SG3526J | SG | ULN-8126R |
|  |  |  | SG3526N | SG | ULN-8126A |
| SG1525AJ | SG | ULS-8125R§ | SG3527AJ | SG | ULN-8127R§ |
| SG1526J | SG | ULS-8162R | SG3527AN | SG | ULN-8127A§ |
| SG1527AJ | SG | ULS-8127R§ | SG3635P | SG | UDN-2935Z |
| SG2001J | SG | ULS-2001R | SG3821] | SG | ULS-2045H |
| SG2001N | SG | ULN-2001A | SG3821N | SG | ULN-2046A |
| SG2002J | SG | ULS-2002R | SG3822N | SG | ULN-2054A |

[^7]| Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement | Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SG3851J | SG | ULS-2011R | SN75469 | TI | ULN-2024R |
| SG3851N | SG | ULN-2011A | SN75469N | Tl | ULN-2024A |
| SG3852J | SG | ULS-2012R | SN75471P | TI | UDN-3611M $\dagger$ |
| SG3852N | SG | ULN-2012A | SN75472P | TI | UDN-3612M $\dagger$ |
| SG3853J | SG | ULS-2013R | SN75473P | TI | UDN-3613M $\dagger$ |
| SG3853N | SG | ULN-2013A | SN75474P | TI | UDN-3614M $\dagger$ |
| SG3854J | SG | ULS-2014R | SN75475P | TI | UDN-5712M $\dagger$ |
| SG3854N | SG | ULN-2014A | SN75476P | Tl | UDN-5711M $\dagger$ |
| SG3886N | SG | ULN-2086A | SN75477P | TI | UDN-5722M $\dagger$ |
| SG6118N | SG | UDN-6118A | SN75478P | TI | UDN-5713M $\dagger$ |
|  | PLS |  | SN75479P | Tl | UDN-5714M $\dagger$ |
| SL3045C | PLS | ULS-2045R | SN75518N | TI | UCN-5818A§ |
| SL3046C | PLS | ULN-2046A | SN75605 | TI | UDN-2950Z |
| SL3054 | PLS | ULN-2054A | SN76104N | TI | ULN-2120A* |
| SL3081D | PLS | ULN-2081A | SN76105N | TI | ULN-2122A* |
| SL3082D | PLS | ULN-2082A | SN76110N | TI | ULN-2128A* |
| SL3083E | PLS | ULN-2083A | SN76111N | TI | ULN-2121A* |
| SL3086 | PLS | ULN-2086A | SN76113N | TI | ULN-2128A* |
| SL3145E | PLS | ULS-2045H | SN76115N | TI | ULN-3810A |
| SL3146E | PLS | ULN-2046A-1 | SN76116N | TI | ULN-3812A |
| SL3183E | PLS | ULN-2083A-1 | SN76130N | TI | ULN-2126A* |
| SN72741L | TI | ULN-2151D* | SN76177ND | Tl | ULN-2278B* |
| SN72741P | TI | ULN-2151M* | SN76226N | TI | ULN-2216A* |
| SN75064NE | TI | ULN-2064B | SN76227N | TI | ULN-2217A* |
| SN75065NE | TI | ULN-2065B | SN76228N | Tl | ULN-2218A* |
| SN75066NE | TI | ULN-2066B | SN76242N | TI | ULN-2124A* |
| SN75067NE | Tl | ULN-2067B | SN76243AN | TI | ULN-2127A* |
| SN75068NE | TI | ULN-2068B | SN76246N | TI | ULN-2228A* |
| SN75069NE | Tl | ULN-2069B | SN76266N | TI | ULN-2266A* |
| SN75074NE | TI | ULN-2074B | SN76267N | TI | ULN-2267A* |
| SN75075NE | Tl | ULN-2075B | SN76298N | TI | ULN-2298A* |
| SN75407P | TI | UDN-5732M | SN76564N | TI | ULN-2264A* |
| SN75437ND | Tl | UDN-2541B | SN76565N | TI | ULN-2264A* |
| SN75466J | TI | ULN-2021R | SN76591P | TI | ULN-2291M* |
| SN75466N | TI | ULN-2021A | SN76594P | TI | ULN-2294M* |
| SN75467J | Tl | ULN-2022R | SN76635N | Tl | ULN-2137A* |
| SN75467N | TI | ULN-2022A | SN76642N | TI | ULN-2111A |
| SN75468J | Tl | ULN-2023R | SN76643N | TI | ULN-2111A |
| SN75468N | Tl | ULN-2023A | SN76665N | TI | ULN-2165A* |

[^8]

[^9]| Competitive <br> Part <br> Number | Manufacturer | Suggested Sprague Replacement | Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement |
| :---: | :---: | :---: | :---: | :---: | :---: |
| TL495] | II | ULQ-8195R§ | TVCM-27 | SPC | ULN-2298A* |
| TL495IN | II | ULQ-8195A§ | TVCM-28 | SPC | ULN-2211B* |
| TL594CJ | TI | ULN-8194R§ | TVCM-29 | SPC | ULN-3812A |
| TL594CN | II | ULN-8194A§ | TVCM-30 | SPC | ULN-2264A* |
| TL594J | II | ULQ-8194R§ | TVCM-33 | SPC | ULN-2267A* |
| TL594IN | It | ULQ-8194A§ | TVCM-34 | SPC | ULN-2269A* |
| TL594MJ | TI | ULS-8194R§ | TVCM-35 | SPC | ULN-2280B |
| TL595CJ | It | ULN-8195R§ | TVCM-36 | SPC | ULN-3784B |
| TL595CN | TI | ULN-8195A§ | TVCM-37 | SPC | ULN-2285A* |
| TL595] | TI | ULQ-8195R§ | TVCM-38 | SPC | ULN-2285P* |
| TL5951N | TI | ULQ-8195A§ | TVCM-39 | SPC | ULN-2289A* |
| TL595MJ | It | ULS-8195R§ | TVCM-40 | SPC | ULN-2298A* |
|  |  |  | TVCM-62 | SPC | ULN-3812A |
| TVCM-1 | SPC | ULN-2114W* | TVCM-65 | SPC | ULN-2278B* |
| TVCM-2 | SPC | ULN-2114A* | TVCM-66 | SPC | ULN-2046A |
| TVCM-3 | SPC | ULN-2114K* | TVCM-67 | SPC | ULN-2054A |
| TVCM-4 | SPC | ULN-2111A | TVCM-68 | SPC | ULN-2208M* |
| TVCM-5 | SPC | ULN-2111A | TVCM-73 | SPC | ULN-3810A |
| TVCM-6 | SPC | ULN-2120A* |  |  |  |
| TVCM-7 | SPC | ULN-2122A* | U5E737394 | FSC | ULN-2114W* |
| TVCM-8 | SPC | ULN-2124A* | U5E7746394 | FSC | ULN-2114W* |
| TVCM-9 | SPC | ULN-2127A* | U6A758394 | FSC | ULN-3812A |
| TVCM-10 | SPC | ULN-2128A* | U6A7704394 | FSC | ULN-2211B* |
| TVCM-11 | SPC | ULN-2165A* | U6A7720394 | FSC | ULN-2137A* |
| TVCM-12 | SPC | ULN-2121A* | U6A7729394 | FSC | ULN-2122A* |
| TVCM-13 | SPC | ULN-2126A* | U6A7732394 | FSC | ULN-2120A* |
| TVCM-14 | SPC | ULN-2131M* | U6A7746394 | FSC | ULN-2114A* |
| TVCM-15 | SPC | ULN-2125A* | U6A7767394 | FSC | ULN-2128A* |
| TVCM-16 | SPC | ULN-2129A* | U6A7781394 | FSC | ULN-2127A* |
| TVCM-17 | SPC | ULN-2135E* | U6B7780394 | FSC | ULN-2124A* |
| TVCM-18 | SPC | ULN-2136A* | U6E7729394 | FSC | ULN-2122A* |
| TVCM-19 | SPC | ULN-2137A* | U7F7064394 | FSC | ULN-2264A* |
| TVCM-20 | SPC | ULN-2209M* | U7F7065354 | FSC | ULN-2165A* |
| TVCM-21 | SPC | ULN-2224A* | U7F7065394 | FSC | ULN-2165A* |
| TVCM-22 | SPC | ULN-2228A* | U7F7075394 | FSC | ULN-2129A* |
| TVCM-23 | SPC | ULN-2274B* | U7F7729394 | FSC | ULN-2122A* |
| TVCM-24 | SPC | ULN-2276P* | U7F7732394 | FSC | ULN-2120A* |
| TVCM-25 | SPC | ULN-2278B* | U7F7746394 | FSC | ULN-2114A* |
| TVCM-26 | SPC | ULN-2278B* | U7F7767394 | FSC | ULN-2128A* |

[^10]| Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement | Competitive <br> Pait <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
| U7F7780394 | FSC | ULN-2124A* | UA3089PC | FSC | ULN-2289A* |
| U7F7781394 | FSC | ULN-2127A* | UA7327 | FSC | ULN-2270B |
| U8F7746394 | FSC | ULN-2114W* |  |  | $\bigcirc 6$ |
| U9A7746394 | FSC | ULN-2114A* | UC1524AJ | UNI | 教 ULS-8124R§ |
| U9A7781394 | FSC | ULN-2127A* | UC1525AJ | UNI | 1 ULS-8125R§ |
| U9B7780394 | FSC | ULN-2124A* | UC1526J | UNI | \% ULS-8126R |
| U9C7065354 | FSC | ULN-2165A* | UC1527AJ | UNI | ULS-8127R§ |
|  |  |  | UC2524AJ | UNI | ULQ-8124R§ |
| U417B | TLF | ULN-2204A | UC2524AN | UNI | ULQ-8124A§ |
|  |  |  | UC2525AJ | UNI | ULQ-8125R§ |
| UA704PC | FSC | ULN-2211B* | UC2525AN | UNI | ULQ-8125A§ |
| UA705PC | FSC | ULN-3812A | UC2526J | UNI | ULQ-8126R |
| UA720PC | FSC | ULN-2137A* | UC2526N | UNI | ULQ-8126A |
| UA729PC | FSC | ULN-2122A* | UC2527AJ | UNI | ULQ-8127R§ |
| UA732PC | FSC | ULN-2120A* | UC2527AN | UNI | ULQ-8127A§ |
| UA737EC | FSC | ULN-2114K* | UC3524AJ | UNI | ULN-8124R§ |
| UA739PC | FSC | ULN-2126A* | UC3524AN | UNI | ULN-8124A§ |
| UA741CT | FSC | ULN-2151D* | UC3525AJ | UNI | ULN-8125R§ |
| UA741CV | FSC | ULN-2151M* | UC3525AN | UNI | ULN-8125A§ |
| UA746PC | FSC | ULN-2228A* | UC3526J | UNI | ULN-8126R |
| UA753TC | FSC | ULN-2209M* | UC3526N | UNI | ULN-8126A |
| UA758PC | FSC | ULN-3812A | UC3527AJ | UNI | ULN-8127R§ |
| UA767PC | FSC | ULN-2128A* | UC3527AN | UNI | ULN-8127A§ |
| UA780PC | FSC | ULN-2124A* | UC494ACJ | UNI | ULN-8194R§ |
| UA781PC | FSC | ULN-2127A* | UC494ACN | UNI | ULN-8194A§ |
| UA787PC | FSC | ULN-2162A* | UC494AJ | UNI | ULS-8194R§ |
| UA1391TC | FSC | ULN-2191M** | UC495ACJ | UNI | ULN-8195R§ |
| UA1394TC | FSC | ULN-2294M* | UC495ACN | UNI | ULN-8195A§ |
| UA2136PC | FSC | ULN-2136A* | UC495AJ | UNI | ULS-8195R§ |
| UA3045DM | FSC | ULS-2045H |  |  |  |
| UA3046PC | FSC | ULN-2046A | UCN4810N | 11 | UCN-4810A |
| UA3054PC | FSC | ULN-2054A | UDN2841NE | TI | UDN-2841B |
| UA3064PC | FSC | ULN-2264A* | UDN2845NE | TI | UDN-2845B |
| UA3065PC | FSC | ULN-2165A* | UDN5711N | TI | UDN-5711M |
| UA3067PC | FSC | ULN-2267A* | UDN5712N | TI | UDN-5712M |
| UA3075PC | FSC | ULN-2129A* | UDN5713N | TI | UDN-5713M |
| UA3066PC | FSC | ULN-2266A* | UDN5714N | Tl | UDN-5714M |
| UA3067PC | FSC | ULN-2267A* |  |  |  |
| UA3086PC | FSC | ULN-2086A* | UDN-6164A | SPR | UDN-6116A-1 |

[^11]| Competitive |  | Suggested | Competitive |  | Suggested |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Part |  | Sprague | Part |  | Sprague |
| Number | Manufacturer | Replacement | Number | Manufacturer | Replacement |
| UDN-6184A | SPR | UDN-6118A-1 | ULN-2114A | SPR | ULN-2228A* |
| ULN2001AJ | TI | ULN-2001R | ULN-2209V |  | ULN-2209M* |
| ULN2001AN | TI | ULN-2001A |  |  |  |
| ULN2002A | Tl | ULN-2002R | ULN-2210A | SPR | ULN-3810A |
| ULN2002AN | TI | ULN-2002A | ULN-2225P | SPR | ULN-2211B* |
| ULN2003A | Tl | ULN-2003R | ULN-2226A | SPR | ULN-2224A* |
| ULN2003AN | TI | ULN-2003A | ULN-2244A | SPR | ULN-3812A |
| ULN2004AJ | TI | ULN-2004R | ULN-2245A | SPR | ULN-3812A |
| ULN2004AN | TI | ULN-2004A | ULN-2275P | SPR | ULN-2274B* |
| ULN2005AJ | TI | ULN-2005R | ULN-2277P | SPR | ULN-2278B* |
| ULN2005AN | Tl | ULN-2005A | ULN-2281B | SPR | ULN-3784B |
|  |  |  | ULN-2287A | SPR | ULN-2289A* |
| ULN2064NE | TI | ULN-2064B | ULN-2301M | SPR | ULN-2300M* |
| ULN2065NE | Tl | ULN-2065B |  |  |  |
| ULN2066NE | TI | ULN-2066B | ULN-3006M | SPR | UGN-3201M |
| ULN2067NE | Tl | ULN-2067B | ULN-3006T | SPR | UGN-3019T |
|  |  |  | ULN-3007M | SPR | UGN-3203M |
| ULN2068 | MOT | ULN-2068B | ULN-3008M | SPR | UGN-3501M |
|  |  |  | ULN-3008T | SPR | UCN-3501T |
| ULN2068NE | TI | ULN-2068B | ULN-3100M | SPR | UGN-3600M |
| ULN2069NE | Tl | ULN-2069B | ULN-3101M | SPR | UGN-3601M |
| ULN2074NE | Tl | ULN-2074B | ULN-3330Y-2 | SPR | ULN-3330Y |
| ULN2075NE | Tl | ULN-2075B | ULN-3905A | SPR | ULN-3914A |
|  |  |  | ULS-3006T | SPR | UGS-3019T |
| ULN-2110A | SPR | ULN-3810A |  |  |  |
| ULN-2113A | SPR | ULN-2111A | UPA2001C | NEC | ULN-2001A |

[^12]| Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement | Competitive <br> Part <br> Number | Manufacturer | Suggested <br> Sprague <br> Replacement |
| :---: | :---: | :---: | :---: | :---: | :---: |
| UPA2002C | NEC | ULN-2002A | XR2204CP | EXR | ULN-2004A |
| UPA2003C | NEC | ULN-2003A | XR2205CP | EXR | ULN-2005A |
| UPA2004C | NEC | ULN-2004A | XR6118P | EXR | UDN-6118A |
| UPC324 | NEC | ULN-4336A* | XR6128P | EXR | UDN-6128A |
| XR1310CP | EXR | ULN-3810A | ZN1060 | FER | ULN-8160A |
| XR1800P | EXR | ULN-3812A |  |  |  |
|  |  |  | 512 | ITI | UHP-491* |
| XR2001CN | EXR | ULN-2001R | 552 | ITI | ULN-2001A |
| XR2001P | EXR | ULQ-2001A | 554 | ITI | ULN-2002A |
| XR2002CN | EXR | ULN-2002R | 556 | ITI | ULN-2003A |
| XR2002P | EXR | ULQ-2002A | 652 | ITI | ULN-2001A |
| XR2003CN | EXR | ULN-2003R | 654 | ITI | ULN-2002A |
| XR2003P | EXR | ULQ-2003A | 656 | ITI | ULN-2003A |
| XR2004CN | EXR | ULN-2004R |  |  |  |
| XR2004P | EXR | ULQ-2004A | 9665DC | FSC | ULN-2001R |
| XR2011CN | EXR | ULN-2011R | 9665DM | FSC | ULS-2001R |
| XR2011CP | EXR | ULN-2011A | 9665PC | FSC | ULN-2001A |
| XR2012CN | EXR | ULN-2012R | 9666DC | FSC | ULN-2002R |
| XR2012CP | EXR | ULN-2012A | 9666DM | FSC | ULS-2002R |
| XR2013CN | EXR | ULN-2013R | 9666PC | FSC | ULN-2002A |
| XR2013CP | EXR | ULN-2013A | 9667DC | FSC | ULN-2003R |
| XR2014CN | EXR | ULN-2014R | 9667DM | FSC | ULS-2003R |
| XR2014CP | EXR | ULN-2014A | 9667PC | FSC | ULN-2003A |
| XR2201CP | EXR | ULN-2001A | 9668DC | FSC | ULN-2004R |
| XR2202CP | EXR | ULN-2002A | 9668DM | FSC | ULS-2004R |
| XR2203CP | EXR | ULN-2003A | 9668PC | FSC | ULN-2004A |

[^13]
## HOW TO ORDER

$\mathrm{T}^{\mathrm{o}}$O PLACE AN ORDER, obtain price and delivery, or request additional technical literature, call or write your local sales office (see inside back cover) or:

From U.S.A. Sprague Electric Co.<br>Marshall Street<br>North Adams, MA 01247<br>(413) 664-4411<br>Telex: 710-369-1360<br>From Asia Sprague World Trade Corp.<br>Eastern Branch<br>G.P.O. Box 4289<br>Hong Kong<br>3-7440010<br>Telex: 78043395

From Europe Sprague World Trade Corp. 3 Chemin de Tavernay
1218 Grand Saconex
Geneva, Switzerland
022-98-4021
Telex: 23469
$\mathbf{R}^{\text {EQUESTS FOR additional technical in- }}$ formation on standard or custom devices may be sent to the appropriate manufacturing facility:

For all monolithic integrated circuits except Hall effect devices,

Sprague Electric Co.
115 Northeast Cutoff
Worcester, MA 01606
(617) 853-5000

Telex: 710-340-6304
For discrete semiconductors and Hall Effect devices,

Sprague Electric Co.
70 Pembroke Road
Concord, NH 03301
(603) 224-1961

Telex: 710-361-1495

## SPRAGUE FACILITIES

Sprague Electric Company manufactures active and passive components in 15 locations in the United States and in five countries in Europe and the Far East. Headquarters of the Semiconductor Division is in Worcester, Mass. All semiconductor wafer fabrication is done in the Worcester plant, as are all
services integral to its support. Volume assembly operations are located both in Worcester and in Manila, Republic of the Philippines. Sales offices and sales representatives are located throughout the United States and Canada, Latin America, Europe, Japan, Africa, and the Far East.


INTEGRATED CIRCUIT OPERATIONS, Worcester, Massachusetts

## Semiconductor Operations

The integrated circuit operation of the Sprague Electric Semiconductor Division is located in a modern 115,000 square-foot plant in Worcester, Mass. Discrete components, such as transistors and diodes, and Hall Effect integrated circuits are manufactured at the division's Concord, N.H., plant, which occupies 30,000 square feet.

Sprague Electric is a leading manufacturer of volume integrated circuits serving the consumer, industrial controls, and peripherals markets. Production process technologies include complementary metalgate MOS, high-voltage and high-current bipolar, and high-performance bipolar linear. This breadth of process technology enables Sprague Electric to manufacture optimal cost-performance integrated circuits.


TRANSISTOR OPERATIONS, Concord, New Hampshire

## How Integrated Circuits are Shipped

Integrated circuits are shipped in one of these carriers:

A-Channel Anti-Static Plastic Tubing TO-220 Plastic Magazine Individual Plastic Box

Integrated circuit chips are shipped in either unscribed wafer form or individually partitioned in a plastic box.

## Quality Control and Reliability

All critical points in the manufacturing processes of Sprague Electric integrated circuits are carefully
monitored for compliance to engineering specifications. Electrical tests are made on $100 \%$ of the parts by automatic test systems. Lot sampling assures meeting customer A.Q.L. requirements. Calibration of test standards and equipment is performed at periodic intervals in order to maintain test accuracy.

Sprague Electric Company conducts a continuing reliability assurance program to detect deviations in device characteristics. Test samples are taken at random from each lot and are subjected to testing for performance evaluation and specification compliance. Routinely, finished samples are subjected to all electrical performance tests. A copy of the quality control inspection plan used for specific integrated circuits is available on request.

## ENGINEERING BULLETINS

The information in this data book is equivalent to the Sprague Engineering Bulletins listed below. If an individual bulletin and this data book are compared, the latest revision takes precedence. For example, data on the UCN-4805A, described in Chapter 4, supersedes Bulletin 26181, which is presently in print. If that bulletin is revised to match this data book, it will carry the ' $A$ ' revision letter. If revisions beyond what appear here are later incorporated, the bulletin would then bear a ' $B$ ' revision letter.

| Part Number | Bulletin Number | Part Number | Bulletin Number |
| :---: | :---: | :---: | :---: |
| UHC/UHD-400 through 433-1 | $29300.1 \quad 3 \mathrm{P}$ | ULN-2249A | 27121.10 |
| UHP-400 through 433-1 | 29300B 2P | ULN-2260A | 27119.2 |
| UHC/UHD-500 through 533 | 29300.1 3P | ULN-2270B and 2270Q | 27124.10 |
| UHP-500 through 533 | 29300B 2P | ULN-2280B | 27117.11A |
| TPP-1000 and 2000 | 29714A | ULN-2283B and 2283B-1 | $27117.21 \quad 2 P$ |
| SG 1526J | 27466.10 | ULN-2290B and 22900 | 27110.32 2P |
| ULN-2001A through 2015A | 29304 C | ULN-2350C and 2351C | 27405 |
| ULS-2001H through 2015H | 29304.1B | ULN-2401A | 27460 |
| ULS-2001R through 2015R | 29034.1B | ULN-2429A | 27461 |
| ULN-2021A through 2025A | $29304 C$ | ULN-2430M | 27462 |
| ULS-2021H through 2025H | 29304.1B | ULN-2435A and 2445A | 27460.10 |
| ULN-2031A through 2033A | 29710A 2P | ULN-2455A | 27460.10 |
| ULS-2045H | 29707 2P | TPQ-2483 and 2484 | 29711A |
| ULN-2046A | 29707 2P | SG 2526J | 27466.10 |
| ULN-2046A-1 | - | UDN-2541B/W and UDN-2542B/W | 29317 |
| ULN-2047A | 29712 2P | UDN-2580A through 2588A | 29316 |
| ULN-2054A | 29708A 2P | UDN-2595A | 29320 |
| ULN-2061M and 2062M | 29305 C | ULN-2810A through 2815A | 29304.3A 2P |
| ULN-2064B through 2077B | 29305 C | ULS-2801H through 2815H | 29304.4A |
| ULS-2064H through 2077H | 29305.1 | ULS-2801R through 2815R | 29304.4A |
| ULN-2081A and 2082A | 29709 | ULN-2821A through 2825A | 29304.3A 2P |
| ULN-2083A | 29713 2P | ULS-2821H through 2825 H | 29304.4A |
| ULN-2083A-1 | - | UDN-2841B and 2845B | 29314 A |
| ULS-2083H | 29713 2P | UDN-2878W and 2879W | 29305.10 |
| ULN-2086A | -102E | UTN-2886B and 2888A | $29401 \quad 2 P$ |
| ULN-2111A | $27102 \mathrm{E} \quad 2 \mathrm{P}$ | TPQ-2906 and 2907 | 29711A |
| ULN-2140A | 29015.210A 2P | UDN-2935Z | 29318.3 |
| ULS-2140H | 29015.210A 2P | UDN-2949Z | 29318A |
| ULN-2204A | 27121.50A | UDN-2950Z | 29318.3 |
| TPQ-2221 and 2222 | 29711A | UDN-2952B and 2952W | 29319 |
| ULN-2240A | 27121.62 | UDN-2956A and 2957A | 29309 A 2P |
| ULN-2241A | 27121.61A | UDQ-2956R and 2957R | 29309.1A |
| ULN-2242A | 27121.60A | UDN-2975W and 2976W | 29319.10 |
| ULN-2243A | 27105.1 |  |  |

NOTE: 2P (2nd printing) indicates minor changes and/or corrections not normally affecting device performance.

## ENGINEERING BULLETINS (Continued)

| Part Number | Bulletin Number | Part Number | Bulletin Number |  |
| :---: | :---: | :---: | :---: | :---: |
| UDN-2981A through 2984A | 29310A | UCN-4401A | 26180A | 2 P |
| UDS-2981H through 2984H | 29310.1 2P | UCS-4401H | 26180.1 |  |
| TPP-3000 | 29714A | UCN-4801A | 26180A | 2 P |
| UGN-3013T | 27603B | UCS-4801H | 26180.1 |  |
| UGN/UGS-3019T/U | 27601B | UCN-4805A | 26181A |  |
| UGN/UGS-3020T | 27602A | UCN-4807A and 4808A | 26186 |  |
| UGN/UGS-3030T/U | 27606A | UCN-4810A | 26182A |  |
| UGN-3040T | 27607 | UCS-4810H | 26182.1 |  |
| UGN/UGS-3075T/U | 27608 | UCN-4815A | 26183 | 2 P |
| UGN/UGS-3076T/U | 27609 | UCN-4815H | 26183.1 |  |
| UGN-3201M and 3203M | 27604 | UCN-4821A through 4823A | 26185 | 2P |
| UGN-3220S | 27605 | UCS-4821H through 4823H | 26185.1 |  |
| ULN-3310D/T | 27481 | NE/SE 5560F and 5560N | 27466A |  |
| ULN-3330D/T/V | 27480B | NE 5561F | 27466.1 |  |
| UGN-3501M | $27500.1 \quad 2 P$ | UDN-5703A through 5707A | 29306 | 2P |
| UGN-3501T | 27500 2P | UDS-5703H through 5707H | 29306.1 | 2 P |
| SG 3526J | 27466.10 | UDN-5711M through 5714M | 29307A | 2 P |
| UGN-3600M and 3601M | 27120B | UDS-5711H through 5714H | 29307.1 |  |
| UDN-3611M through 3614M | 29308 2P | UDN-5722M | 29307.2 |  |
| UDS-3611H through 3614H | 29308.1 | UDN-5732M | 29307.4 |  |
| ULN-37012 | 27117.31 | UDN-5733M | 29306 | 2 P |
| ULN-37022 | 27117.33 | UDS-5733H | 29306.1 | 2 P |
| ULN-37032 | 27117.34 | UDN-5742M | 29307.4 |  |
| ULN-3705M | 27117.23 | UDS-5791H | 29315.1A |  |
| TPQ-3724 through 3725A | 29711A | TPQ-6001 through 6100A | 29711A |  |
| ULN-3784B | 27117.12 | UDN-6116A through 6128R-2 | 29313B | 2 P |
| TPQ-3798 and 3799 | 29711A | UDN-6138A through 6148A-2 | 29313B | 2 P |
| ULN-3804A | 27121.52 | TPQ-6501 and 6502 | 29711A |  |
| ULN-3809A | 27109.112 | UDN-6510A/R and 6514A/R | 29313.3 |  |
| ULN-3810A | 27109.113 | TPQ-6600 through 6700 | 29711A |  |
| ULN-3812A | 27109.114 | UDN-7180A through 7186A | 29311A | 2 P |
| ULN-3838A | 27121.53 | ULN-8126A and 8126R | 27466.10 | 2 P |
| ULN-3840A | 27121.64 | ULQ-8126A and 8126R | 27466.10 | 2 P |
| ULN-3859A | 27105.10 | ULS-8126R | 27466.10 | 2 P |
| TPQ-3904 and 3906 | 29711A | ULN-8160A and 8160R | 27466A |  |
| TPP-4000 | 29714A | ULS-8160R | 27466A |  |
| UCN-4202A and 4203A | 26184A | ULN-8161M | 27466.1 |  |

NOTE: 2P (2nd printing) indicates minor changes and/or corrections not normally affecting device performance.

## HIGH-VOLTAGE INTERFACE DRIVERS

## HIGH-CURRENT INTERFACE DRIVERS

## BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS

MILITARY AND AEROSPACE DEVICES

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS <br> RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

VIDEO AND TELEVISION INTEGRATED CIRCUITS
AUDIO POWER AMPLIFIERS
HALL EFFECT DEVICES


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UDN-6116R through 6128R-2 Hermetic Display Drivers ..... 2-3
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## SELECTION GUIDE TO HIGH-VOLTAGE INTERFACE DRIVERS

| Device Type | Absolute Maximum Ratings |  | Outputs |
| :---: | :---: | :---: | :---: |
|  | $I_{\text {Out }}$ | $V_{\text {OUT }}$ |  |
| UHP-500 through 533 | 500 mA | 100 V | Sink 4 |
| UCN-4823A | 500 mA | 100 V | Sink 8 |
| UDN-6116A/R | -40 mA | 85 V | Source 6 |
| UDN-6116A-1 | -40 mA | 115 V | Source 6 |
| UDN-6116A/R-2 | - 40 mA | 65 V | Source 6 |
| UDN-6118A/R | -40 mA | 85 V | Source 8 |
| UDN-6118A-1 | -40 mA | 115 V | Source 8 |
| UDN-6118A/R-2 | -40 mA | 65 V | Source 8 |
| UDN-6126A/R | -40 mA | 85 V | Source 6 |
| UDN-6126A-1 | -40 mA | 115 V | Source 6 |
| UDN-6126A/R-2 | -40 mA | 65 V | Source 6 |
| UDN-6128A/R | -40 mA | 85 V | Source 8 |
| UDN-6128A-1 | -40 mA | 115 V | Source 8 |
| UDN-6128A/R-2 | -40 mA | 65 V | Source 8 |
| UDN-6138A | -40 mA | $\pm 40 \mathrm{~V}$ | Source 8 |
| UDN-6138A-2 | -40 mA | $\pm 30 \mathrm{~V}$ | Source 8 |
| UDN-6148A | -40 mA | $\pm 40 \mathrm{~V}$ | Source 8 |
| UDN-6148A-2 | -40 mA | $\pm 30 \mathrm{~V}$ | Source 8 |
| UDN-6510A/R | - 40 mA | 200V | Source 8 |
| UDN-6514A/R | -40 mA | 140 V | Source 8 |
| UDN-7180A | 20 mA | -115V | Sink 8 |
| UDN-7180A | 20 mA | -115V | Sink 8 |
| UDN-7183A | 3.25 mA | -115V | Sink 8 |
| UDN-7184A | 2.0 mA | -115 V | Sink 8 |
| UDN-7186A | 1.0 mA | -115V | Sink 8 |

# SERIES UDN-6100A AND UDN-6100R FLUORESCENT DISPLAY DRIVERS 

## FEATURES

-Digit or Segment Drivers

- Low Input Current
- Integral Output Pull-Down Resistors
- high Output Breakdown Voltage
- Single or Split Supply Operation


UDN-6116* UDN-6126*


UDN-6118*
UDN-6128*


DWG. NO. A-11,222
UDN-6138*
UDN-6148*

DEVICE TYPE NUMBER DESIGNATION

| Input Compatibility | No. of Drivers | $V_{\text {OUT }}$ | No. of Pins | Type Number |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Plastic DIP | Ceramic DIP |
| 5 V TLL, CMOS | 6 | 60 V | 16 | UDN-6116A-2 | UDN-6116R-2 |
|  |  | 80 V | 16 | UDN-6116A | UDN-6116R |
|  |  | 110 V | 16 | UDN-6116A-1 | - |
|  | 8 | 60 V | 18 | UDN-6118A-2 | UDN-6118R-2 |
|  |  | 80 V | 18 | UDN-6118A | UDN-6118R |
|  |  | 110 V | 18 | UDN-6118A-1 | - |
|  |  | $\pm 30 \mathrm{~V}$ | 20 | UDN-6138A-2 | - |
|  |  | $\pm 40 \mathrm{~V}$ | 20 | UDN-6138A | - |
| 6-15V CMOS, PMOS | 6 | 60 V | 16 | UDN-6126A-2 | UDN-6126R-2 |
|  |  | 80 V | 16 | UDN-6126A | UDN-6126R |
|  |  | 110 V | 16 | UDN-6126A-1 | - |
|  | 8 | 60 V | 18 | UDN-6128A-2 | UDN-6128R-2 |
|  |  | 80 V | 18 | UDN-6128A | UDN-6128R |
|  |  | 110 V | 18 | UDN-6128A-1 | - |
|  |  | $\pm 30 \mathrm{~V}$ | 20 | UDN-6148A-2 | - |
|  |  | $\pm 40 \mathrm{~V}$ | 20 | UDN-6148A | - |

ABSOLUTE MAXIMUM RATINGS at $\mathrm{T}_{\mathrm{A}} \boldsymbol{=} \boldsymbol{+ 2 5}^{\circ} \mathrm{C}$(Voltages are with reference to ground unless otherwise shown)
Supply Voltage, $V_{B B}$ (all devices, suffix $A$ or $R$ )
(UDN-6138/48A or R, ref. $V_{E E}$ ) ..... 85 V
(all devices, suffix $A-1$ ) ..... 115 V
(all devices, suffix A-2 or R-2) ..... 65 V
(UDN-6138/48A-2 or R-2, ref. $\mathrm{V}_{\mathrm{EE}}$ ) ..... 65 V
Supply Voltage, $V_{\text {EE }}$ (UDN-6138/48 all suffixes) ..... $-40 \mathrm{~V}$
Input Voltage, $\mathrm{V}_{\text {IN }}$ (all devices) ..... 20 V
(UDN-6138/48 all suffixes, ref. $\mathrm{V}_{\mathrm{EE}}$ ) ..... 55 V
Output Current, Iout ..... $-40 \mathrm{~mA}$
Allowable Package Powier Dissipation, $P_{D}$ ..... See Graph
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{I}_{\mathrm{S}}$ ..... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$


DWG. NO. A-11,224

## ELECTRICAL CHARACTERISTICS (over operating temperature range)

Note: All Values Specified At

| Suffixes | $A$ | $R$ | $A-1$ | A-2 | R-2 |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{B B}=$ | 80 | 80 | 110 | 60 | 60 | Volts |
| ${ }^{*} V_{B B}=$ | 0 | 0 | MA | 0 | 0 | Volts |

*UDN-6138 and UDN-6148

| Characteristic | Symbol | Applicable Devices |  | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Basic Part No. | Suffix |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | Iout | All | All | $V_{\text {IN }}=0.4 \mathrm{~V}$ | - | - | 15 | $\mu \mathrm{A}$ |
| Output OFF Voltage | $V_{\text {Out }}$ | All | All | $V_{\text {IV }}=0.4 \mathrm{~V}$ | - | - | 1.0 | $V$ |
| Output Pull-Down Current | $\mathrm{I}_{\text {OUT }}$ | All | A or R | Input Open,$V_{\text {OUT }}=V_{\text {BB }}$ | 450 | 650 | 1100 | $\mu \mathrm{A}$ |
|  |  |  | A-1 |  | 600 | 900 | 1500 | $\mu \mathrm{A}$ |
|  |  |  | A-2 or R-2 |  | 350 | 500 | 775 | $\mu \mathrm{A}$ |
| Output ON Voltage | $V_{\text {OUT }}$ | UDN-6116/18/38 | $A$ or R | $\begin{aligned} & V_{\text {IN }}=2.4 \mathrm{~V}, \\ & \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA} \end{aligned}$ | 77 | 78 | - | $V$ |
|  |  |  | A-1 |  | 107 | 108 | - | V |
|  |  |  | A-2 or R-2 |  | 57 | 58 | - | $V$ |
|  |  | UDN-6126/28/48 | $A$ or R | $\begin{aligned} & V_{\text {II }}=4.0 \mathrm{~V}, \\ & \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA} \end{aligned}$ | 77 | 78 | - | V |
|  |  |  | A-1 |  | 107 | 108 | - | V |
|  |  |  | A-2 or R-2 |  | 57 | 58 | - | V |
| Input ON Current | $I_{\text {IN }}$ | UDN-6116/18/38 | All | $\mathrm{V}_{\text {IV }}=2.4 \mathrm{~V}$ | - | 120 | 225 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{\text {IV }}=5.0 \mathrm{~V}$ | - | 375 | 650 | $\mu \mathrm{A}$ |
|  |  | UDN-6126/28/48 | All | $V_{\text {IN }}=4.0 \mathrm{~V}$ | - | 130 | 250 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{\text {IN }}=15 \mathrm{~V}$ | - | 675 | 1150 | $\mu \mathrm{A}$ |
| Supply Current | $I_{B B}$ | $\frac{\text { All }}{\text { ODN-6116 }}$ | All | All Inputs Open | - | 10 | 100 | $\mu \mathrm{A}$ |
|  |  |  | A or R | All Inputs $=2.4 \mathrm{~V}$ | - | 5.0 | 7.5 | mA |
|  |  |  | A-1 | Two Inputs $=2.4 \mathrm{~V}$ | - | 2.5 | 4.5 | mA |
|  |  |  | A-2 or R-2 | All Inputs $=2.4 \mathrm{~V}$ | - | 4.0 | 6.0 | mA |
|  |  | UDN-6118/38 | A or R | All Inputs $=2.4 \mathrm{~V}$ | - | 6.0 | 9.0 | mA |
|  |  |  | A-1 | Two Inputs $=2.4 \mathrm{~V}$ | - | 2.5 | 4.5 | mA |
|  |  |  | A-2 or R-2 | All Inputs $=2.4 \mathrm{~V}$ | - | 5.5 | 8.0 | mA |
|  |  | UDN-6126 | $A$ or R | All Inputs $=4.0 \mathrm{~V}$ | - | 5.0 | 7.5 | mA |
|  |  |  | A. 1 | Two !nputs $=4.0 \mathrm{~V}$ | - | 2.5 | 4.5 | mA |
|  |  |  | A-2 or R-2 | All Inputs $=4.0 \mathrm{~V}$ | - | 4.0 | 6.0 | mA |
|  |  | UDN-6128/48 | $A$ or R | All Inputs $=4.0 \mathrm{~V}$ | - | 6.0 | 9.0 | mA |
|  |  |  | A-1 | Two Inputs $=4.0 \mathrm{~V}$ | - | 2.5 | 4.5 | mA |
|  |  |  | A-2 or R-2 | All Inputs $=4.0 \mathrm{~V}$ | - | 5.5 | 8.0 | mA |

## RECOMMENDED OPERATING CONDITIONS

| Supply Voltage | $V_{B B}$ | $\begin{aligned} & \text { UDN-6116/18/ } \\ & 26 / 28 \end{aligned}$ | A or R | 5.0 | - | 70 | $V$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | A-1 | 5.0 | - | 100 | $V$ |
|  |  |  | A-2 or R-2 | 5.0 | - | 50 | $V$ |
|  |  | UDN-6138/48 | A | 5.0 | - | 40 | $V$ |
|  |  |  | A-2 | 5.0 | - | 30 | $V$ |
|  | $V_{\text {EE }}$ | UDN-6138/48 | A | 0 | - | -40 | $V$ |
|  |  |  | A-2 | 0 | - | -30 | $V$ |
| Input ON Voltage | $V_{\text {IN }}$ | UDN-6116/18/38 | All | 2.4 | - | 15 | $V$ |
|  |  | UDN-6126/28/48 | All | 4.0 | - | 15 | $V$ |
| Output ON Current | $\mathrm{I}_{\text {OUT }}$ | All | All | - | - | -25 | mA |

NOTE: Positive (negative) current is defined as going into (coming out of) the specified device pin.

## PARTIAL SCHEMATIC

## One Driver

(All Types)


DWG.NO. A-10,592C

| Type (All Suffixes) | $R_{\text {IN }}$ | $R_{B}$ |
| :---: | :---: | :---: |
| UDN-6116/18/38 | $10 \mathrm{k} \Omega$ | $30 \mathrm{k} \Omega$ |
| UDN-6126/28/48 | $20 \mathrm{k} \Omega$ | $20 \mathrm{k} \Omega$ |

## TYPICAL MULTIPLEXED FLUORESCENT DISPLAY



## UDN-6510A/R AND UDN-65 14A/R HIGH-VOLTAGE SOURCE DRIVERS

## FEATURES

- TTL/MOS-Compatible Inputs
- High Output-Breakdown Voltage
- 40 mA Output-Current Ca pability
- Low Power Dissipation
- Reliable Monolithic Construction

EASY, EFFECTIVE INTERFACE for low-level TTL or MOS circuitry and high-voltage loads is available with Sprague UDN-6510A/R and UDN$6514 \mathrm{~A} / \mathrm{R}$ bipolar integrated circuits. These eightchannel devices drive the anodes of gas-discharge displays or the grids and anodes of large, multiplexed dot-matrix vacuum-fluorescent display panels.

Types UDN-6510A and UDN-6510R supply an output-voltage swing of up to 100 V with a maximum $\mathrm{V}_{\mathrm{BB}}$ of 200 V . Typically, the output is switched between +100 V and +180 V .

Types UDN-6514A and UDN-6514R can switch output-voltage levels from ground to +135 V with appropriate pull-down circuitry and a maximum supply voltage of +140 V .

Each device in the series has eight independent drivers made up of switched constant-current level

shifters and PNP/NPN driver stages. Driver inputs operate with open-drain PMOS or CMOS, or with open-collector or standard TTL.

Types UDN-6510R and UDN-6514R are furnished in 18-pin dual in-line industrial-grade, hermetically sealed ceramic packages. Types UDN6510A and UDN-6514A are supplied in inexpensive 18-pin dual in-line plastic packages. To simplify applications designs, all units have input connections on one side of the package and output pins on the other. All devices are rated for operation over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
ABSOLUTE MAXIMUM RATINGS
at $T_{A}=+25^{\circ} \mathrm{C}$
( $V_{\text {REF }}=$ GROUND unless otherwise specified)
Supply Voltage, $V_{B B}$ (UDN-6510A/R) ..... 200 V
(UDN-6514A/R) ..... 140 V
Output OFF Voltage ( $V_{\text {REF }}=V_{B B}$ ), $V_{\text {OUT }}$ (UDN-6510A/R) ..... $-100 \mathrm{~V}$
Input Voltage, $V_{\mathbb{I N}}$ ..... 20 V
Output Current, I Iou ..... $-40 \mathrm{~mA}$
Package Power Dissipation, $P_{D}$ ..... See Graph
Operating Temperature Range, $T_{A}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ ..... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE

## PARTIAL SCHEMATIC

One Driver (All Types)



Caution: The high input impedance of these devices makes them susceptible to static discharge damage associated with handling and testing. Techniques similar to those used for handling MOS devices should be employed.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=200 \mathrm{~V}$ (UDN-6510A/R) or 140 V (UDN-6514A/R), all voltage measurements are referenced to ground (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | Iout | UDN-6510A/R | $\mathrm{V}_{\text {out }}=100 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0.4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | - | 15 | $\mu \mathrm{A}$ |
|  |  | UDN-6514A/R | $\mathrm{V}_{\text {Out }}=0 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0.4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | - | 15 | $\mu \mathrm{A}$ |
| Output ON Voltage | $V_{\text {out }}$ | UDN-6510A/R | $V_{\mathbb{I}}=2.4 \mathrm{~V}_{1} \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 195 | 197 | - | V |
|  |  | UDN-6514A/R | $\mathrm{V}_{\mathbb{N}}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 135 | 137 | - | V |
| Input ON Current | $I_{\text {IN }}$ | All | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}$ | - | 120 | 225 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{IV}}=5.0 \mathrm{~V}$ | - | 375 | 650 | $\mu \mathrm{A}$ |
| Supply Current | $I_{B B}$ | All | All inputs open | - | 10 | 100 | $\mu \mathrm{A}$ |
|  |  |  | One input $=3.5 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |

RECOMMENDED OPERATING CONDITIONS

| Supply Voltage | $V_{\text {BB }}$ | UDN-6510A/R |  | 55 | - | 180 | $V$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | UDN-6514A/R |  | 55 | - | 130 | V |
| Output OFF Voltage | $\mathrm{V}_{\text {out }}$ | UDN-6510A/R | Reference $V_{B B}$ | - | - | -80 | V |
| Input ON Voltage | $V_{\text {IV }}$ | AII |  | 2.4 | - | 15 | $V$ |
| Output ON Current | Tout | All |  | - | - | -25 | mA |

NOTE: Negative current is defined as coming out of the specified device pin.


MULTIPLEXED DOT-MATRIX VACUUM-FLUORESCENT DISPLAY APPLICATION


Dwg. No. A-11,659

## SERIES UDN-7180A

## GAS DISCHARGE DISPLAY SEGMENT DRIVERS

## FEATURES

- Reliable Monolithic Construction
- High Output Breakdown Voltage
- Low Power
- TIL/MOS Compatible Inputs



## Description

Series UDN-7180A segment drivers are monolithic high-voltage bipolar integrated circuits for interfacing between MOS or other low-voltage circuits and the cathode of gas-discharge display panels.

These drivers reduce substantially the number of discrete components required with panels (Beckman, Burroughs, Dale, Matsushita, NEC, Pantek, etc) in calculator, clock and instrumentation applications.

The UDN-7183A, UDN-7184A, and UDN-7186A drivers contain appropriate level shifting, signal amplification, current limiting, and output OFF-state voltage bias. The UDN-7180A driver requires external current limiting and is intended for higher-current applications or where individual outputs are operated at different current levels (i.e. with alpha-numeric displays). All inputs have pull-down resistors for direct connection to open-drain PMOS logic.

These devices provide output currents suitable for display segments in a wide variety of display sizes and number of display digits. Either a fixed split supply operation or a feedback-controlled scheme is allowed.

## Applications

The Series UDN-7180A drivers can be used in a wide variety of lowlevel to high-voltage applications utilizing gas discharge displays such as those found in calculators, clocks, point-of-sale terminals, and instruments. Their high reliability combined with minimum size, ease of installation, and the cost advantages of a complete monolithic interface make them the ideal choice in many applications. A typical application showing the use of these devices, and their counterpart anode drivers, is shown.

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$

| Suppiy Voltage, $\mathrm{V}_{\mathrm{Kk}}$ | $-115 \mathrm{~V}$ |
| :---: | :---: |
| Input Voltage, $\mathrm{V}_{\mathbb{N}}$ | $+20 \mathrm{~V}$ |
| Output Current, IouT: UDN-7180A | 20 mA |
| UDN-7183A | 3.25 mA |
| UDN-7184A | 2.0 mA |
| UDN-7186A | 1.0 mA |
| Power Dissipation, $\mathrm{P}_{\text {D }}$ | 1.13 W* |
| Operating Temperature Range, $T$ | $0+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $+150^{\circ} \mathrm{C}$ |

[^14]Due to the high input impedance of these devices, they are susceptible to static discharge damage sometimes associated with handling and testing. Therefore, techniques similar to those used for handling MOS devices should be employed.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{KK}}=110 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Test <br> Fig. | UDN-7180/83A |  |  | UDN-7184A |  |  | UDN-7186A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Output ON Voltage UDN-7183/84/86A | $\mathrm{V}_{\text {on }}$ | All inputs at 2.4 V | 1 | -100 | -104 | - | -98 | -102 | - | -97 | $-100$ | - | V |
|  |  | All inputs at $2.4 \mathrm{~V}, \mathrm{~V}_{\text {KK }}=-70 \mathrm{~V}$ | 1 | - | -66 | - | - | -65 | - | - | -63 | - | $V$ |
| Output ON Voltage UDN-7180A | $\mathrm{V}_{\text {ON }}$ | All inputs at 2.4 V , $\mathrm{I}_{\mathrm{ON}}=14 \mathrm{~mA}$ |  | -105 | -108 | - | - | - | - | - | - | - | V |
| Output OFF Voltage | $V_{\text {off }}$ | All inputs at 0.4 V , Reference $V_{\text {Kk }}$ | 2 | 76 | 84 | - | 76 | 84 | - | 76 | 84 | - | V |
| Output Current ( $\mathrm{L}_{\text {IMming }}$ ) | $\mathrm{I}_{\text {on }}$ | All inputs at $2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{KK}}=-110 \mathrm{~V}$, Test output held at -60 V | 3 A |  | $\begin{gathered} \text { N-7183A } \\ 1850 \end{gathered}$ | only 2450 | 910 | 1140 | 1520 | 440 | 550 | 725 | $\mu \mathrm{A}$ |
| Output Current ( Isesss ) | $\mathrm{I}_{\text {on }}$ | All inputs at $0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{KK}}=-110 \mathrm{~V}$, <br> Test output held at -66 V | 3B | -95 | -120 | -155 | -65 | -85 | -115 | -50 | -65 | -90 | $\mu \mathrm{A}$ |
| Input High Current | $\mathrm{I}_{\mathrm{H}}$ | Test input at 2.4 V , Other inputs at 0 V | 4 | - | 100 | 200 | - | 100 | 200 | - | 100 | 200 | $\mu \mathrm{A}$ |
| Input Low Current | I | Test input at 0.4 V , One input at 2.4 V , Other inputs at 0.4 V | 5 | - | 1 | 10 | - | 1 | 10 | - | 1 | 10 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{I}_{\mathrm{kK}}$ | All inputs at 0 V | 6 |  | -125 | -175 | - | -125 | -175 | - | -125 | -175 | $\mu \mathrm{A}$ |

NOTES:

1. All voltage measurements are referenced to pin 9 unless otherwise specified.
2. All voltage measurements made with $10 \mathrm{M} \Omega$ DVM or VTVM.
3. Recommended $\mathrm{V}_{\mathrm{Kk}}$ operating range: -85 to -110 V .
4. Positive (negative) current is defined as going into (coming out of) the specified device pin.

## TEST CIRCUITS



FIGURE 1


DWG. NO. A-9738B

FIGURE 2


DWG. NO. A-9739B
FIGURE 3A


DWG. NO. A-9740B

FIGURE 3B

FIGURE 4


FIGURE 5


DWG. NO. A-9743

PARTIAL SCHEMATIC


TYPICAL APPLICATION


## TYPICAL SIX-DIGIT CLOCK





Dwg. No. A-11,094B

## ANODE AND CATHODE WAVEFORMS



# A MONOLITHIC IC SERIES FOR GAS-DISCHARGE DISPLAY INTERFACE 

## Introduction

The switching of the high voltages necessary for display panels such as the Burroughs Panaplex (1) has long presented difficulties to the semiconductor industry - particularly to IC manufacturers. It is difficult to fabricate devices capable of sustaining 200 volts or greater with standard IC processes of today. Solutions to the high voltage gas discharge display interface also must be inexpensive as well as functional; this cost/ simplicity factor prohibits most unusual or exotic circuit designs and/or IC processes.

The earliest (and a great many recent) gas discharge interface schemes used discrete components, but that has been an increasingly cumbersome and expensive solution. Competition at the system level has largely come from LEDs, and a great many standard ICs are available for the smaller LEDs. In most instances, the small displays have gone to LEDs. However, the larger display applications are still an opportunity for gas discharge since character size and cost are not directly related. The cost impact upon the potential for gas discharge displays in many systems is a function of interface complexity and cost, and it was to this end that a joint Sprague/Burroughs effort was launched.

Early Sprague/Burroughs meetings were held to define the relevant factors involved in such a program and provide the necessary insight for both parties into
the capabilities of diode isolated ICs, the voltage and current requirements of the Panaplex displays, the need for minimization of power (battery systems), packaging of the circuits, component count and cost, etc. Add to this the potential for use with feedback controlled supplied, poorly regulated d-c supplies, the wide variety of numbers of display digits, the range of digit sizes (in use or contemplated), etc., and our task was not to be an easy one.

Our direction was determined by two factors: a history of fabricating $130-140$ volt PN diode isolated display circuits, and a more recent effort to utilize compatible thin-film resistor technology. These factors, coupled with considerable expertise in designing and processing high voltage ICs, dictated an approach utilizing a split ( $\pm 100 \mathrm{~V}$ ) supply. The split supply would provide the 200 volts needed to ionize the display and the resistor capability would greatly aid the incorporation of functions previously done by discrete components - including both input and output (segment) current limiting, pulldown (open drain PMOS), pullup and pulldown reference for IC outputs, and a high impedance voltage divider for the output OFF bias. All level shifting is accomplished via use of PNP or NPN transistors, and the capacitors previously required were negated.

Figure 1


## Basic Scheme

Replacing discrete components through incorporating their function into this IC series results in the block diagram of Figure 1 with its basic requirement for a single digit and single segment driver; a scheme capable of driving as many as eight digits and the eight segments. Additional digits or segments beyond the eight provided in an 18-lead DIP may be driven by combinations of packages beyond the minimum two necessary. Example: three ICs-two digit and one segment-will fulfill the needs of a 12 to 16 digit calculator.
Included in this series of high voltage interface are two digit driver packages: UDN-6116 (6-digit), and UDN-6118 (8-digit). Segment drivers include the UDN-7180, UDN-7183, UDN-7184, and UDN7186, and the four offer current ranges compatible with display sizes from $0.250^{\prime \prime}$ to $1^{\prime \prime}$ panels, and others will be made available as needs are defined.

## Digit Interface

The digit driver is the more complex of the two and its schematic is shown in Figure 2. Input address polarity is positive (active high in TTL parlance) and the circuit is designed to interface from TTL (4.5 volts from open collector-or using pull-up to $\mathrm{V}_{\mathrm{CC}}$ ), CMOS, PMOS, etc. Input current-limiting and onehalf of the pull-down for open drain PMOS is the function of $\mathrm{R}_{5} ; \mathrm{R}_{6}$ adds the second half of the pulldown to the ground bus. The protective value of $\mathrm{R}_{4}$ and $R_{5}$ must be noted; a junction failure in $Q_{1}$ has the two resistors as a current limiter to the MOS (or TTL) output and will minimize the likelihood of destroying the low level logic outputs.

Input transistor $\mathrm{Q}_{4}$ is a high voltage inverter and sinks the base current of $P N P Q_{3}$. A positive input ( 4.5 to 20 V ) will turn on $\mathrm{Q}_{4}$ and this base current ( 65 $\mu \mathrm{A}$ typ.) for $\mathrm{PNO}_{3}$ will turn on the output Darlington $\left(\mathrm{Q}_{\mathrm{i}}\right.$ and $\left.\mathrm{Q}_{2}\right)$ and source digit current.

ELECTRICAL CHARACTERISTICS: $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{KK}}=110 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Test Fig. | UDN-7180/83A |  |  | UDN-7184A |  |  | UDN-7186A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Output ON Voltage UDN-7183/84/86A | $\mathrm{V}_{\text {on }}$ | All inputs at 2.4 V | 1 | -100 | -104 | - | -98 | -102 | - | -97 | -100 | - | V |
|  |  | All inputs at 2.4 V, $\mathrm{V}_{\mathrm{KK}}=-70 \mathrm{~V}$ | 1 | - | -66 | - | - | -65 | - | - | -63 | - | V |
| Output ON Voltage UDN-7180A | $\mathrm{V}_{\text {on }}$ | All inputs at 2.4 V , $\mathrm{I}_{\mathrm{on}}=14 \mathrm{~mA}$ |  | -105 | -108 | - | - | - | - |  | - | - | V |
| Output OFF Voltage | $V_{\text {off }}$ | $\begin{aligned} & \text { All inputs at } 0.4 \mathrm{~V} \text {, } \\ & \text { Reference } \mathrm{V}_{\mathrm{kK}} \end{aligned}$ | 2 | 76 | 84 | - | 76 | 84 | - | 76 | 84 | - | V |
| Output Current (liminco) | $\mathrm{I}_{\text {on }}$ | All inputs at $2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{KK}}=-110 \mathrm{~V}$, Test output held at -60 V | 3A |  | $\begin{gathered} 1-7183 A \\ 1850 \\ \hline \end{gathered}$ | $\begin{aligned} & \text { only } \\ & 2450 \\ & \hline \end{aligned}$ | 910 | 1140 | 1520 | 440 | 550 | 725 | $\mu \mathrm{A}$ |
| Output Current ( Istess ) | Ion | All inputs at $0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{KK}}=-110 \mathrm{~V}$, Test output held at -66 V | 3B | -95 | -120 | -155 | -65 | -85 | -115 | $-50$ | -65 | -90 | $\mu \mathrm{A}$ |
| Input High Current | $\mathrm{I}_{\mathrm{H}}$ | Test input at 2.4 V , Other inputs at 0 V | 4 | - | 100 | 200 | - | 100 | 200 | - | 100 | 200 | $\mu \mathrm{A}$ |
| Input Low Current | $I_{1}$ | Test input at 0.4 V , One input at 2.4 V , Other inputs at 0.4 V | 5 | - | 1 | 10 | - | 1 | 10 | - | 1 | 10 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{I}_{\mathrm{kx}}$ | All inputs at 0 V | 6 | - | -125 | -175 | - | -125 | -175 | - | -125 | -175 | $\mu \mathrm{A}$ |

## NOTES:

1. All voltage measurements are referenced to pin 9 unless otherwise specified.
2. All voltage measurements made with $10 \mathrm{M} \Omega$ DVM or VTVM.
3. Recommended $\mathrm{V}_{\mathrm{Kk}}$ operating range: -85 to -110 V
4. Positive (negative) current is defined as going into (coming out of) the specified device pin.

## PARTIAL SCHEMATIC



DWG.NO. A-11,364

Figure 2

Consistent ionization and extinguishing of the display panel is the result of the $60-75$ volt swings available from both digit and segment ICs. The conditions that previously created problems for the -direct MOS drive with minimal swings at the output have been very adequately handled with the increased output swings of the $6100 / 7100$ series. Problems from leading zero blanking, low temperature, low ambient light, etc. which previously gave difficulty are well taken care of with this series of ICs.

## Segment Inferface

The segment driver circuit is shown in Figure 3 and the value of $\mathbf{R}_{\mathbf{2}}$ (segment limiting) is determined via masking for the appropriate display current. Its
counterpart pull-up resistor $R_{1}$ is also changed to some known ratio of $\mathbf{R}_{2}$. The ground terminal (\#9) is referenced near, or connected directly to ground, and the $V_{K K}$ line is typically a -90 to -100 volts.

The input PNP $\left(Q_{1}\right)$ serves as a level translator and provides d -c level shifting to the output Darlington ( $\mathrm{Q}_{2}$ and $\mathrm{Q}_{3}$ ). Emitter resistor ( $\mathbf{R}_{3}$ ) both limits the input current and furnished pull-down for open drain PMOS. An added intent is the measure of protection furnished the MOS by the very high impedance of $\mathrm{R}_{3}$.

The basic switching function is the combination of PNP $Q_{1}$, Darlington $Q_{2}$ and $Q_{3}$, and the associated resistors $\mathbf{R}_{1}, \mathbf{R}_{2}$, and $\mathbf{R}_{3}$. Address polarity is again active high. The input may be raised a maximum of 20 volts above ground and will function with input levels obtained from CMOS and open collector TTL (4.5 V).

## PARTIAL SCHEMATIC



Figure 3

## TYPICAL APPLICATION



Figure 4

The OFF output biasing network is common to all the individual drivers with the level of bias determined by the ratio of $R_{7}$ to the total of $R_{7}$ and $R_{8}$. As in the digit driver, the value of output bias is $\approx 2 / 3$ the voltage across $\mathrm{V}_{\mathrm{KK}}$ and ground-thus insuring sufficient 'on to off' swings to properly fire, and effectively extinguish unaddressed segments during a scan. Emitter follower $Q_{4}$ and $Q_{5}$ sources current to the pull-up bus connected to the various outputs as they are turned on during the display scan.

## Minimum Component Interface

The impact of this new product family may be seen in the typical digital clock of Figure 5. This a-c powered clock uses a Mostek 50250 clock IC, a UDN-6116A-1 digit driver, and a UDN-7183 segment driver. Total component count is approximately 30
pieces, and the board layout is straightforward and uses single-sided board.

Many calculator interface schemes use considerble numbers of components ( 70 to 100 typically) to drive gas discharge panels. As one example: a twelve digit/eight segment machine uses 85-90 discretes while the new IC version uses only three packages, and results in less space along with considerable simplification. Other applications will benefit similarly with this series of circuits.

## Summary

Display technology and usage has emerged at a mind boggling rate in the past several years-largely due to the fantastic growth rate of calculators. The planar gas panels have been an integral portion of this burgeoning market, but like all the other displays


Figure 5
available does not meet the requirements for an ideal display.

Gas discharge panels are a fine combination of aesthetics, reliability, low cost, large character size, multiplexing capability, etc., but have been impacted to some degree by the lack of an available and inexpensive, totally monolithic interface. The move toward IC interface for displays has stifled some potential - largely in favor of LEDs; although many applications requiring large characters and/or in high ambient light turn toward gas panels. The planar gas discharge display is a long way from obscurity, and the availability of this family of ICs should open up new areas as well as satisfying existing systems.

The intent from the inception of this program has been to produce and provide a standard, inexpensive and easy to use interface for gas discharge displays. A great many potential applications exist for these circuits in consumer and commercial products. From the calculator and digital clock areas this product also will find use in automotive dashboards, point-of-sale systems, electronic cash registers and scales, and instrumentation. The market for displays is still very elastic, and many applications for gas discharge panels are continuing to appear. The Sprague contribution to this market is this series of state-of-theart interface ICs.

# TRENDS IN IC INTERFACE FOR ELECTRONIC DISPLAYS 

## Introduction

Display technology was truly set into high gear by the explosion of the electronic calculator business. Expansion at a phenomenal pace continues, encompassing a multitude of products, particularly high-volume consumer products (calculators, clocks, games, and watches). Recently, further stimulated by the "microprocessor revolution," with its far-reaching effects, and the resulting changeover to solid state design from electromechanical, mechanical, fluidic, or electrical systems, the vistas for displays have expanded well beyond the horizon. Products have been and are being developed, using microprocessors and displays, that never previously existed.

To augment this microprocessor revolution, semiconductor manufacturers are developing many new interface circuits useful with displays, although some of these will not be exclusively for display systems. To accomplish this, the present boundaries of device design, process, packaging, and electrical parameters will require continual extension and expansion.

## Display Buffers

A continuing evolution of standard interface ICs is needed to buffer low-level logic from high-voltage and /or high-current loads. Some of this buffer development will serve display systems. Since there already is a broad assortment of buffers (particularly for low- to medium-current LED applications), the ongoing development in simple or low-order interface will mainly concentrate upon further reduction in discrete component count, package improvement (particularly for high-current/high-power devices), improvements in device current, voltage, switching speed, and greater reliability.

Figures 1, 2, and 3 show some Sprague interface ICs that represent buffer circuits; other vendors supply similar, or identical, high-current or high-voltage buffers to allow operation of displays from low-level logic. Two basic changes have occurred relatively recently:

1. Greater use of 18 -pin DIPs for eight driver channels (Source Driver, Figure 2).
2. Creation of sourcing functions (Figures 2 and 3 ; useful for LED, gas-discharge, vacuum fluorescent, incandescent, and electromagnetic displays, depending upon device ratings). While further buffer designs are needed (particularly in high-current ( $>2 \mathrm{~A}$ ) and high-voltage ( $>100 \mathrm{~V}$ ) circuits), the main emphasis will be toward the incorporation of logic and control circuitry with output buffers.

## Complex Interface

Paralleling (though lagging) the microprocessor LSI revolution is the area of greatest future for IC display circuits: The need for complex, smart or high-order interface. This will be MSI to LSI logic (with perhaps some linear functions) combined with suitable output buffers.

## UDN-6116A-1 GAS-DISCHARGE DRIVER



Figure 1A


DWG.NO. A-10,592C
Figure 18

SERIES UDN-2980 SOURCE DRIVER


Figure 2A
Figure 28

Display interface ICs (similar to the MOS I/O control chips), both custom and standard product, are becoming available in this category. High-volume applications may justify custom ICs, but the more general trend will be toward standard, off-the-shelf designs chiefly due to the high costs of developing custom ICs.

The higher voltage displays (gas-discharge, vacuum fluorescent, a-c plasma, and d-c electroluminescent) may share some circuits (if appropriately planned and designed), particularly in the area of matrix displays. It is difficult to imagine, however, much commonality between high-current LEDs, high-voltage gas-discharge or a-c plasma, and low-power LCDs,


Figure 3
8-DIGIT/8-SEGMENT HIGH-CURRENT LED INTERFACE
although they should share considerably the development of cellular CAD circuit designs. Basic shift registers, latches and decoders do have considerable commonality.

In Figure 4 is a pinout and logic diagram of the first BiMOS Sprague IC combining logic and output drive. Although not expressly intended for display applications, this BiMOS (CMOS logic and bipolar outputs) IC has a great deal of utility to engineers working with lower voltages and high currents (LEDs, incandescent and electromagnetic displays). Type UCN4801A is a parallel-in /parallel-out unit composed of eight ' $D$ ' latches and eight $350 \mathrm{~mA} / 50 \mathrm{~V}$ bipolar Darlington outputs.


Figure 4A


Figure 4B
UCN-4801A BIMOS LATCH/DRIVER

More recently, Sprague has designed a serial-in/parallel-out BiMOS interface IC expressly for use with vacuum fluorescent displays. Figure 5 shows the UCN-4810A 10-bit serial-in/ parallel-out interface for use with VF displays; the use of serial data allows 10 output lines, data in and data out in a standard 18-lead DIP. It makes possible both fewer IC packages and simpler PC board wiring, although it is slower than a parallel data approach. It uses only a single pin of the I/O ports.


Figure 5B UCN-4810A VF DRIVER BLOCK DIAGRAM


Figure 5A UCN-4810A PINOUT

A slightly more recent design for vacuum fluorescent displays is the Sprague UCN-4815A. This is a 22-lead, 8 -bit parallel-in/parallel-out BiMOS unit. The unit may have data inputs and a strobe bus (see Figure 6). The chip enable/blanking pin provides control of VF buffers. A power-on-clear is internally incorporated.


Figure 6
UCN-4815A PARALLEL 8-BIT VF INTERFACE

## Device Technologies

With the exception of LCD displays (which at least until recently have been largely, if not entirely, driven by MOS) the display and interface technologies in high-volume use are mainly associated with bipolar semiconductors. Early display interface ICs (particularly devices such as the 7447 and 7448) were aimed at LED technology and represent MSI with modest output capability. The increasing use of higher voltage displays, multiplexed high-current applications, and the need for greater circuit complexity and low pin count will dictate other technologies, such as $\mathrm{I}^{2} \mathrm{~L}, \mathrm{BiMOS}, \mathrm{CMOS} / \mathrm{DMOS}$, and possibly DMOS.

## Standard Bipolar

Standard bipolar technology, long associated with TTL or linears (early op amps), appears very limited in scope for the future. Circuit density and supply power requirements will dictate other processes for functions beyond the simple MSI level. The advantages of standard bipolar ICs appear to be in the areas of simple high-current, high-power or high-voltage interface. In particular, applications requiring the combination of high voltages ( $\geq 100 \mathrm{~V}$ ) or multiple high-current outputs ( $\geq 2 \mathrm{~A}$ ) will restrict the logic /control circuitry to a low level. Cost, chip size and package power dissipation will restrict this circuitry largely to versatile, simple buffers.

## $\mathrm{I}^{2}$

Anticipated to increase significantly is the use of $I^{2} \mathrm{~L}$ for systems of low to modest voltages (LEDs through VF). The present limits of $\mathrm{I}^{2} \mathrm{~L}$ appear to be limited to applications below the $50-$ to 60 -volt level. $\mathrm{I}^{2} \mathrm{~L}$, with its combination of circuit density, low power and reasonable switching speeds should make a fine match for LEDs or other low-voltage display applications. For higher voltages ( $>25$ or 30 V ), prospects the penalty of reduced circuit density may diminish its cost effectiveness. Some increase in standoff voltage may be afforded by the uses of cascaded output transistors or process improvements, thus reducing the need to sacrifice logic density. Without a standard I'L logic family, the main market penetration would appear to be custom designs although there is a definite opportunity for standard interface for lower voltage applications, particularly LEDs and vacuum fluorescent.

## BiMOS

BiMOS, a combination of CMOS and bipolar for interface ICs, seems to fit a technology niche of higher breakdown voltages than $I^{2} L$, especially where logic power and supply voltage range ( 5 to 15 V ) is important. BiMOS or BiFET ICs, which are presently on the market, are largely related to operational amplifiers, although other uses, such as the Sprague application of BiMOS to interface, are emerging.

Currently, it is feasible to design and manufacture BiMOS interface with breakdown voltages in the 80 to 100 V range. With additional time and greater concentration on increasing BV, it appears that higher voltages ( $\geq 150 \mathrm{~V}$ ) for output buffers could be obtained. By obtaining breakdowns in the 120 V to 160 V range, BiMOS then becomes a viable IC technology for interface for the higher voltage displays: d-c gas-discharge with $\pm 100$ to $\pm 130 \mathrm{~V}$; a-c plasma with 160 to 170 V , and glow transfer or d-c electroluminescent (DCEL) opportunities with a range of $120-150$ volts.

Switching speeds and output configurations (active pull-down or resistive) are critical to matrix displays (particularly a-c plasma) with large numbers of drive lines. Adding active pull-down or pull-up will tend to increase chip size (and cost), thus adding to the potential overall difficulty of BiMOS with its greater process complexity and slightly longer manufacturing cycle. This does appear to be a very key technology for the near future. Its product niche will include for applications requiring 60 to 100 V (or more) breakdowns, low-power logic, wide supply range, modest speeds, and MSI to small LSI.

## CMOS/DMOS

Chiefly being carried on by Texas Instruments, CMOS /DMOS display interface appears to be intended for much of the same display market as BiMOS. Product information now available indicates 60 to 100 V breakdown (DMOS outputs), CMOS logic, low to modest output currents ( $\leq 25 \mathrm{~mA}$ ), and logic speeds to 4 MHz . Designs now being promoted are targeted toward a-c plasma and vacuum fluorescent panels.

Two apparent disadvantages now appear to exist:

1. Logic operates from $12 \mathrm{~V} \pm 10 \%$ (may be done to provide maximum speed).
2. Output drive current is insufficient for high-current displays (without 100 mA , or more, the larger matrix panels will use discretes or another technology).
These shortcomings may be modified with time, although it is doubtful if 500 mA to 1 A DMOS outputs are practical.

## Dielectric Isolation

Affording the highest breakdown voltage capability of present technologies is dielectric isolation. Since there is no collector-to-substrate PN junction, nor a collector-to-isolation wall PN junction, considerable improvement in collector-to-base and collector-to-emitter voltage is possible. Additionally, transistor sizes are considerably smaller than their PN-isolated counterparts. The dielectrically isolated devices offered by Dionics span a spectrum of approximately 100 volts to 280 volts (a-c plasma driver). DI affords the maximum breakdown voltage capability currently available.

Opposing this great advantage in breakdown voltage, however, is the increased process complexity of dielectrically isolated ICs. Definite improvements are needed in the area of process simplification, cost reduction, and alternate sources. Large-volume use of DI circuits will be restrained until these problems (particularly alternate sources) can be overcome. DI interface, with its potential for 300 V transistors, has a great promise if the barriers can be overcome.

## Packaging

Semiconductor design and process have greatly outstripped packaging currently in use, particularly in the area of power-handling capability. Greater concentration and resources are required to solve some of the following display interface related problems:

1. DIP power dissipation.
2. Greater number of leads (and smaller package sizes).
3. Improved plastic DIP resistance to moisture and corrosive environments.
4. Lower package manufacturing costs.
5. Smaller module or display subassemblies.

Power dissipation difficulties (strobed high currents) are most associated with LEDs. Use of very low duty-cycle and bright LEDs (particularly alphanumeric and matrix) dictates a need for multiplexing with peak currents as high as 3 A . Nothing currently on the market exceeds 1.75 A per output, and DIP ratings preclude d-c operation at such currents. However, many of the high-current applications are within the capability of standard bipolar ICs now offered.

For LSI ICs containing many I/O lines, the 24-, 28 -, and 40 -lead DIPs are standard. Since package size and cost increase together, it may be desirable to constrain many newer ICs to 18 -, 20-, or 22-lead DIPs (with $0.300^{\prime \prime}$ spacing, 22 also in use with $0.450^{\prime \prime}$ width). Printed wiring board real estate is increasingly dictating smaller size. Solutions such as the quad in-line (Rockwell) or less than $0.100^{\prime \prime}$ centers are possible. There are problems associated with a non-standard configuration (lack of sockets and higher prices) and the smaller physical size will not aid the quest for higher power (LEDs).

Improvements in plastic DIP moisture resistance and reliability are already underway; uses of tri-metal schemes (such as RCA's), silicon nitride or quartz passivation will continue to improve resistance to moisture and corrosive fumes. For display applications, these reliability improvements are of greatest concern in high-voltage devices.

Lower package costs are necessary to further increase the use of ICs in areas such as flat panel matrix displays. Currently, much of the cost of such a system is related to drive electronics, and much of the cost of the interface is the assembly cost of the DIPs (or hybrids). Increased use of automated assembly, film-carrier techniques and solder bumps will enhance the choice of ICs over discretes, and flat panel over CRT.

Also of concern is the possible mating of IC chips, solder-bump chips, or film-strip chips into the display assembly. Candidates for such a treatment would include d-c and a-c plasma, LEDs (already being done to a degree), DCEL, ACEL, LCD, and VF. Panel technologies using thick or thin-film techniques could benefit from such an approach. The biggest barrier to such an integrated assembly is the market data needed to justify tooling and lead time. It will only require one manufacturer willing to be a pioneer to further swing display technology into integrated systems. Prospects for purchasing a display complete with all drive electronics, such as a flat panel a-c plasma matrix (chips mounted via hybrid techniques on the rear of the glass envelope), are improving with time.

## Summary

A bright future exists for IC interface in display systems; the combination of logic (from MSI to small LSI) with suitable output buffers will further assist display designs. The following IC Technology-Display Interface matrix lists the key characteristics and primary display applications of various semiconductor technologies. Since many of these characteristics are changing, the table lists the device characteristics either now available or for the near future.

The most dynamic technologies for the immediate future appear to be BiMOS, $I^{2} L$, CMOS /DMOS, and, perhaps soon, DMOS. Sprague, Dionics, RCA, Texas Instruments, National Semiconductor, and others are using these device technologies to carve market niches where suitable. The dynamics of the IC market make for an uncertain future for any supplier of display circuitry unable or unwilling to continue the technological advancement necessary to meet the changing demands of the display market.

## IC TECHNOLOGY - DISPLAY INTERFACE

| Technology | Breakdown V | Output 1 | LOGIC |  |  |  | $\begin{aligned} & \text { Primary Display } \\ & \text { Suitability } \\ & \hline \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  |
|  |  |  | Speed | $\frac{\text { Complexity }}{(\max )}$ | Range | Power |  |
| Linear Process Bipolar | 10 to $\sim 170 \mathrm{~V}$ | $<10 \mathrm{~mA}$ to 2 A | $<1 \mathrm{MHz}$ | MSI | 5 V | High | $\begin{aligned} & \text { LEDS, GD, VF, ACP, } \\ & \text { DCFI FM } \end{aligned}$ |
|  | 20 to $\sim 60 \mathrm{~V}$ | $<10 \mathrm{~mA}$ to 2 A | $3-6 \mathrm{MHz}$ | LSI | 5 V | Low-Modest | LED, VF, EM |
| BiMOS | 50 to -150 V | $<10 \mathrm{MA}$ to 500 mA | 2-5 MHz | LSI | 5 to 15 V | Low | LED, GD, VF, ACP, DCEL, EM |
| CMOS/DMOS | 60 to $\sim 100 \mathrm{~V}$ | $\sim 25 \mathrm{~mA}$ | 2-4 MHz | LSI | 12 V | Low | GD, VF, ACP, LCD |
| DI | $\sim 200$ to -300 V | $<10 \mathrm{~mA}$ to 100 mA | 1 MHz (est) | MSI | 5 V | High | GD, VF, ACP, DCEL |

[^15]
# RELIABILITY OF SERIES UDN-6100A HIGH-VOLTAGE DISPLAY DRIVERS 


#### Abstract

THIS REPORT SUMMARIZES accelerated-life tests that have been performed on Series UDN-6100A integrated circuits and provides information that can be used to calculate the failure rate at any junction operating temperature.


## INTRODUCTION

Product-reliability improvement is a continuous and evolving process at Sprague Electric Company. Ongoing life tests, environmental tests, and stress tests are performed to establish failure rates and monitor established process-control procedures. Failures are analyzed to determine design changes or process improvements that can be implemented to improve device reliability.
The reliability of integrated circuits can be measured by qualification tests, accelerated tests, and burn-in:

1) Qualification testing is performed at $+125^{\circ} \mathrm{C}$ for 1000 hours with an LTPD $=5$ in accordance with MIL-STD-883B. This testing is normally conducted in response to a specific customer request or requirement. Qualification testing highlights design problems or gross processing problems, but does not provide sufficient data to generate accurate failure rates in a reasonable period of time.
2) Accelerated testing is performed at temperatures above $+125^{\circ} \mathrm{C}$ and is used to generate failure-rate data.
3) Burn-in is intended to remove infantmortality rejects and is conducted at $+150^{\circ} \mathrm{C}$ for 96 hours or at $+125^{\circ} \mathrm{C}$ for 168 hours. An analysis of test results from Sprague Electric's Double-Deuce ${ }^{\text {w }}$ burn-in program found $1.27 \%$ failures in more than 325,000 pieces tested in a recent time period. Most failures
were due to slight parametric shifts. Catastrophic failures, which would cause userequipment failure, were less than $0.1 \%$.

## ACCELERATED-LIFE TESTS

Sprague Electric performs accelerated-life tests on integrated circuits at junction temperatures of $+150^{\circ} \mathrm{C}$ or $+175^{\circ} \mathrm{C}$ at the recommended operating voltages. The internal power dissipation on some high-power circuits requires the ambient temperature to be lower than $+150^{\circ} \mathrm{C}$ to keep the junction temperature between $+150^{\circ} \mathrm{C}$ and $+175^{\circ} \mathrm{C}$.

In these tests, failures are produced so that the statistical life distribution may be established. The distribution cannot be established without failures. High-temperature accelerated-life testing is necessary to accumulate data in reasonable time periods. It has been established that the failure mechanisms all temperatures in these tests are identical. Temperdtures above $+175^{\circ} \mathrm{C}$ are not generally used for the following reasons:
a) Industry-standard molding compounds degrade and release contaminants (halides) at approximately $+200^{\circ} \mathrm{C}$.
b) Life-test boards constructed with materials capable of withstanding exposure to temperatures greater than $+175^{\circ} \mathrm{C}$ have been deemed to be cost prohibitive.
c) Increases in junction leakage currents may increase the power dissipation and device temperature to an indeterminant level.

Table I contains Series UDN-6100A data produced by life tests that were conducted at $+150^{\circ} \mathrm{C}$. The data includes the number of test samples, number of units in each sample, and the time periods during which failures occurred. The total time-on-test varies, with priority changes influencing allocation of oven and board space, as new products are introduced. The time intervals between test readings were chosen for ease of plotting on lognormal paper.

The acceleration factor calculated using the Arrhenius equation, and a 1 eV activation energy, is approximately $5 \times$ for each $25^{\circ} \mathrm{C}$ temperature rise in junction temperature and is multiplicative. ${ }^{1}$ This allows the data to be compared to qualification life-test data by equating 200 hours at $+150^{\circ} \mathrm{C}$ to 1000 hours at $+125^{\circ} \mathrm{C}$. If these tests had been qualification tests, they would have ended at 200 hours at $+150^{\circ} \mathrm{C}$ or 40 hours at $+175^{\circ} \mathrm{C}$.

The data at the bottom of Table I is compiled by calculating the probability of success $\left(P_{s}\right)$, the cumulative probability of success, the probability of failure $\left(P_{f}\right)$ and the percentage of failed units in each time period.

The cumulative percent of failures is plotted on log-normal plotting paper in Figure 1. This paper has a logarithmic time-scale axis and a probability-scale
axis. A log-normal distribution plots a straight line. A line of best fit is drawn through the plotted points and extended to determine the median lifetime at the $50 \%$ fail-point. The median life at a junction temperature of $+150^{\circ} \mathrm{C}$ is 100,000 hours, in this case.

The log-normal distribution is commonly and widely used, because most semiconductor device data fits such a distribution. ${ }^{2}$ When the median life has been found at the elevated temperature, it can be converted to the lower temperature of the actual application. The Arrhenius equation, which relates the reaction rate to temperature, is used to make this conversion. ${ }^{1}$ The Arrhenius equation is:

$$
\begin{aligned}
\mathrm{V}_{\mathrm{r}}= & \mathrm{V}_{\mathrm{r}}{ }^{\mathrm{o}} \mathrm{e}^{-\varepsilon / \mathrm{kT}} \\
\text { where } \mathrm{V}_{\mathrm{r}}^{0}= & \mathrm{a} \text { constant } \\
\varepsilon= & \text { activation energy } \\
\mathrm{k}= & \text { Boltzmann's constant } \\
\mathrm{T}= & \text { absolute temperature in degrees } \\
& \text { Kelvin }
\end{aligned}
$$

An activation energy of 1.0 electron-volt was established by testing Series ULN-2000A, Series UDN-5700M, and Series UDN-2980A devices at multiple temperatures. Failure analysis of devices rejected during the testing also supports this activation energy, as failures were mainly due to increased leakages, reduced beta, and surface inversion?

TABLE I
TEST RESULTS AT $\mathrm{T}_{\mathrm{J}}=+150^{\circ} \mathrm{C}$

|  |  |  | HOURS ON TEST |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TEST | BIAS |  | 90 | 150 | 300 | 600 | 1200 | 1800 | 2000 | 5000 | 6000 |
| NUMBER | VOLTS | QTY. | NUMBER OF FAILURES |  |  |  |  |  |  |  |  |
| 1 | 80 | 24 | 0 | 0 | 2 | - | - | - | - | - | - |
| 2 | 80 | 24 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | - |
| 3 | 80 | 12 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | - |
| 4 | 80 | 12 | 0 | 0 | 0 | 0 | 2 | 1 | 1 | 0 | 0 |
| 5 | 110 | 24 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | - | - |
| 6 | 80 | 12 | 0 | 0 | 0 | - | - | - | - | - | - |
| TOTAL ON T |  |  | 108 | 108 | 108 | 72 | 72 | 58 | 57 | 31 | 8 |
| TOTAL FAILU |  |  | 0 | 0 | 2 | 0 | 2 | 1 | 3 | 0 | 0 |
| TOTAL GOOD |  |  | 108 | 108 | 106 | 72 | 70 | 57 | 54 | 31 | 8 |
| $\mathrm{P}_{\text {s }}$ | 3 |  | 1.00 | 1.00 | 0.981 | 1.00 | 0.972 | 0.983 | 0.947 | 1.00 | 1.00 |
| Cumulative |  |  | 1.00 | 1.00 | 0.981 | 0.981 | 0.954 | 0.938 | 0.888 | 0.888 | 0.888 |
| $\mathrm{P}_{\mathrm{f}}=1$ - |  |  | 0 | 0 | 0.019 | 0.019 | 0.046 | 0.062 | 0.112 | 0.112 | 0.112 |
| \% Failures |  |  | 0 | 0 | 1.9 | 1.9 | 4.6 | 6.2 | 11.2 | 11.2 | 11.2 |



Figure 1
CUMULATIVE PERCENT OF FAILURES

The median life-point is drawn on Arrhenius graph paper in Figure 2. Arrhenius plotting paper gives a graphical solution, rather than a mathematical solution, to the problem of equivalent median lifetime at any junction temperature. A line is drawn through this point (or points when multiple temperatures are used) with a slope of $\varepsilon=1.0 \mathrm{eV}$.

Although not as statistically accurate as the median lifetime, the $5 \%$ fail-point can be read from Figure 1 and plotted parallel to the median-life line in Figure 2.

The median life with lower junction temperatures may now be determined using Figure 2. It must be emphasized that this is junction temperature and not ambient temperature. The temperature rise at the junction due to internal power dissipation must be taken into account using the formula:

$$
\begin{aligned}
& T_{J}=P_{D} \theta_{\mathrm{JA}}+T_{\mathrm{A}} \\
& \text { or } \\
& \mathrm{T}_{\mathrm{J}}=\mathrm{P}_{\mathrm{D}} \Theta_{\mathrm{JC}}+\mathrm{T}_{\mathrm{C}}
\end{aligned}
$$

The median lifetime, or $50 \%$ fail-point, as determined in Figure 2, is approximately 100 years at
$+125^{\circ} \mathrm{C}$ or 1,000 years at $+90^{\circ} \mathrm{C}$ junction temperature.

The approximate failure rate $(\overline{\mathrm{FR}})$ may be determined from $\overline{\mathrm{FR}}=1$ /Median Life, where Median Life is taken from Figure 2 at the intersection of the junction-temperature line and median-life plot. The actual instantaneous failure rate may be calculated using a Goldwaite plot. ${ }^{4}$ However, this approximation is very close. At $+100^{\circ} \mathrm{C}$ the failure rate would be:

$$
\begin{gathered}
\overline{\mathrm{FR}}=1 /\left(4 \times 10^{6} \text { hours }\right) \\
=0.025 \% / 1000 \text { hours }
\end{gathered}
$$

Other failure rate values have been calculated in Table II.

TABLE II
SERIES UDN-6100A FAILURE RATES
$T_{5}$

$\left({ }^{\circ} \mathrm{C}\right)$ | Median Life |
| :---: |
| $(\mathrm{h})$ | | Failure Rate |
| :---: |
| $(\% / 1000 \mathrm{~h})$ |



Figure 2
MEDIAN LIFE

## CONCLUSION

The relationship between temperature and failure rate is well documented and is an important factor in all designs. Load currents, duty cycle, and ambient temperature must be considered by the design engineer to establish a junction-temperature limit that provides failure rates within design objectives.

Figure 2 shows that a design with a junction temperature of $+100^{\circ} \mathrm{C}$, calculated from internal power dissipation and external ambient temperature, reaches the $5 \%$ fail-point in 10 years. Lowering the junction temperature to $+70^{\circ} \mathrm{C}$ increases the time to 100 years.

A complete sequence of environmental tests on Series UDN-6100A, including temperature cycle, pressure cooker, and biased humidity tests are also
continuously monitored to ensure that assembly and package technology remain within established limits.

These environmental tests and accelerated-life tests establish a base line for comparisons of new processes and materials.

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4
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[^16]SELECTION GUIDE TO HIGH-CURRENT INTERFACE DRIVERS

| Device Type | Absolute Maximum Ratings |  | Outputs |
| :---: | :---: | :---: | :---: |
|  | $\mathrm{I}_{\text {OUT }}$ | $V_{\text {Out }}$ |  |
| UHP-400 through 433 | 500 mA | 40 V | Sink 4 |
| UHP-400 through 433-1 | 500 mA | 70 V | Sink 4 |
| UHP-500 through 533 | 500 mA | 100 V | Sink 4 |
| ULN-2001 through 2005A | 500 mA | 50 V | Sink 7 |
| ULN-2011 through 2015A | 600 mA | 50 V | Sink 7 |
| ULN-2021 through 2025A | 500 mA | 95 V | Sink 7 |
| ULN-2061M | 1.75 A | 50 V | Source/Sink 2 |
| ULN-2062M | 1.75 A | 80 V | Source/Sink 2 |
| ULN-2064/66/68/70B | 1.75 A | 50 V | Sink 4 |
| ULN-2065/67/69/71B | 1.75 A | 80 V | Sink 4 |
| ULN-2074/76B | 1.75 A | 50 V | Source/Sink 4 |
| ULN-2075/77B | 1.75 A | 80 V | Source/Sink 4 |
| UDN-2541B/W | 1.5 A | 60 V | Sink 4 |
| UDN-2542B/W | 1.5 A | 80 V | Sink 4 |
| UDN-2580A | - 500 mA | 50 V | Source 8 |
| UDN-2580A-1 | - 500 mA | 80 V | Source 8 |
| UDN-2585A | - 250 mA | 20 V | Source 8 |
| UDN-2588A | - 500 mA | 50 V | Source 8 |
| UDN-2588A-1 | - 500 mA | 80 V | Source 8 |
| UDN-2595A | 200 mA | 20 V | Sink 8 |
| ULN-2801 through 2805A | 500 mA | 50 V | Sink 8 |
| ULN-2811 through 2815A | 600 mA | 50 V | Sink 8 |
| ULN-2821 through 2825A | 500 mA | 95 V | Sink 8 |
| UDN-2841B | 1.75 A | -50V | Sink 4 |
| UDN-2845B | 1.75 A | -50 V | Source/Sink 4 |
| UDN-2878W | 5.0 A | 50 V | Sink 4 |
| UDN-2879W | 5.0 A | 80 V | Sink 4 |
| UTN-2886B | 800/1600 mA | 35 V | Sink $4+2$ |
| UTN-2888A | 800 mA | 35 V | Sink 8 |
| UDN-2933/34B | $\pm 800 \mathrm{~mA}$ | 30 V | 3 Half-Bridge |
| UDN-2935Z | $\pm 2.0 \mathrm{~A}$ | 35 V | Half-Bridge |
| UDN-2949Z | $\pm 2.0 \mathrm{~A}$ | 30 V | Half-Bridge |
| UDN-2950Z | $\pm 2.0 \mathrm{~A}$ | 35 V | Half-Bridge |
| UDN-2952B/W | $+3.5 \mathrm{~A}$ | 40 V | Full Bridge |
| UDN-2956/57A | - 500 mA | -80V | Source 5 |
| UDN-2975W | 5.0 A | 50 V | Source/Sink 2 |
| UDN-2976W | 5.0 A | 60 V | Source/Sink 2 |
| UDN-2981/82A | - 500 mA | 50 V | Source 8 |
| UDN-2983/84A | $-500 \mathrm{~mA}$ | 80 V | Source 8 |
| UDN-3611 through 3614M | 600 mA | 80 V | Sink 2 |
| UDN-5703 through 5707A | 600 mA | 80 V | Sink 4 |
| UDN-5711 through 5714M | 600 mA | 80 V | Sink 2 |
| UDN-5722M | 600 mA | 70 V | Sink 2 |
| UDN-5732M | 600 mA | 70 V | Sink 2 |
| UDN-5733A | 600 mA | 80 V | Sink 4 |
| UDN-5742M | 700 mA | 70 V | Sink 2 |

## SERIES UHP-400, UHP-400-1 AND UHP-500 POWER AND RELAY DRIVERS

## FEATURES

- Inputs Compatible with DTL/TTL
- 500 mA Output Sink Current Capability
- Pinning Compatible with 54/74 Logic Series
- Transient Protected Outputs on Relay Drivers
- High Voltage Output - 100 V Series UHP-500, 70 V Series

UHP-400-1, 40 V Series UHP-400

## Description

These power and relay drivers are bi-polar monolithic circuits and incorporate logic gates and high-current switching transistors on the same chip. Each output transistor is capable of sinking 500 mA in the ON state. In the OFF state, Series UHP-400 devices will sustain 40V, Series UHP-400-1 devices will sustain 70V, and Series UHP-500 devices will sustain 100V.

## Applications

The UHP-400, UHPP-400-1, and UHP-500 Series Power Drivers are ideally suited for driving incandescent lamps, relays, solenoids, and other interface devices with up to 1 A output current per package.

|  |  |  <br> UHP-403/403-1/503 Quad OR | UHP-406/406-1/506 <br> Quad AND |
| :---: | :---: | :---: | :---: |
| UHP-407/407-1/507 Quad NAND | UHP-408/408-1/508 Quad 2 NAND | UHP-432/432-1/532 Quad 2 NOR | UHP-433/433-1/533 Quad NOR |

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{CC}}$ ..... 7V
Input Voltage, $\mathrm{V}_{\text {in }}$ ..... 5.5VOutput Off-state Voltage, $\mathrm{V}_{\text {off }}$
Series UHP-40040 V
Series UHP-400-1 ..... 70V
Series UHP-500 ..... 100V
Output On-State Sink Current, I Ion ..... 500 mA
Suppression Diode Off-State Voltage, $\mathrm{V}_{\text {off }}$Series UHP-40040V
Series UHP-400-1 ..... 70V
Series UHP-500 ..... 100 V
Suppression Diode On-State Current, Ion ..... 500 mA
Operating Free-Air Temperature Range, $T_{A}$ $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{s}$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :--- | :--- | :--- | :---: |
| Supply Voltage (VCC) | 4.75 | 5.0 | 5.25 | V |
| Operating Temperature Range | 0 | +25 | $+85^{\circ}$ | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) |  |  | 250 | mA |

Series UHP 14-pin plastic dual in-line; copper lead frame and epoxy encapsulation standard for high power handling
capability.*

## Thermal Resistance:





${ }^{*} \phi_{\text {ia }}$ of $60^{\circ} \mathrm{C} / \mathrm{W}$ permits operation of four outputs continuously and simultaneously at 250 mA with a junction temperature which will not exceed $+150^{\circ} \mathrm{C}\left(\phi_{\mathrm{j}}\right)$
at a $+85^{\circ} \mathrm{C}$ ambient.

At manufacturer's option, these devices may be marked with the original Series UHP-400, UHP-400-1, or UHP-500 part numbers and/or part numbers in the new Series UDN-0400A, UDN-0400A-1, or UDN-0500A, respectively. Similar devices using the original and new part numbering systems are identical in all respects. For example: UHP-408 is exactly the same as the UDN-0408A.

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{C c}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Input Voltage | $V_{\text {in }}(1)$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {in }(0)}$ |  | MIN |  |  |  |  |  | 0.8 | V |  |
| "0" Input Current at all Inputs except Strobe | $1 \mathrm{in}(0)$ |  | MAX | 0.4 V | 4.5V |  |  | $-0.55$ | -0.8 | mA | 2 |
| "0" Input Current at Strobe | l in(0) |  | MAX | 0.4 V | 4.5V |  |  | -1.1 | -1.6 | mA |  |
| "1" Input Current at all Inputs except Strobe | $\mathrm{in}(1)$ |  | $\begin{aligned} & \hline \text { MAX } \\ & \text { MAX } \end{aligned}$ | $\begin{aligned} & 2.4 \mathrm{~V} \\ & 5.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0 \mathrm{~V} \\ & \mathrm{OV} \end{aligned}$ |  |  |  | $\begin{aligned} & 40 \\ & 1 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~mA} \\ & \hline \end{aligned}$ | 2 |
| "1" Input Current at Strobe | $\operatorname{lin}(1)$ |  | MAX | 2.4 V | OV |  |  |  | 100 | $\mu \mathrm{A}$ | 2 |
|  |  |  | MAX | 5.5 V | OV |  |  |  | 1 | mA |  |

SWITCHING CHARACTERISTICS at $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time <br> Series UHP-400 <br> Series UHP-400-1 <br> Series UHP-500 | $t_{\text {pdo }}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{S}}=40 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=265 \Omega(6 \mathrm{Watts}) \\ & \mathrm{V}_{\mathrm{S}}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega(10 \text { Watts }) \\ & \mathrm{V}_{\mathrm{S}}=100 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=670 \Omega(15 \text { Watts }) \end{aligned}$ |  | 200 | 500 | ns | 3 |
| Turn-off Delay Time <br> Series UHP-400 <br> Series UHP-400-1 <br> Series UHP-500 | $t_{\text {pdl }}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{S}}=40 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=265 \Omega \text { ( } 6 \text { Watts) } \\ & \mathrm{V}_{\mathrm{S}}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & \mathrm{V}_{\mathrm{S}}=100 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=670 \Omega \text { (15 Watts) } \end{aligned}$ |  | 300 | 750 | ns | 3 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each input tested separately.
3. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.
4. Capacitance values specified include probe and test fixture capacitance.

INPUT PULSE CHARACTERISTICS

| $V_{\text {in }(0)}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~s}$ |
| :--- | :--- | ---: |
| $\mathrm{~V}_{\text {in }(1)}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{r}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |

## Type UHP-400, UHP-400-1, and UHP-500 Quad 2-Input AND Power Drivers



ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Output Reverse Current Type UHP-400 | loff |  | MIN | 2.0 V | 2.0 V | 40 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-400-1 | loff |  | MIN | 2.0 V | 2.0 V | 70 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-500 | loff |  | MIN | 2.0 V | 2.0 V | 100 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V_{\text {on }}$ |  | MIN | 0.8 V | $\mathrm{V}_{\text {cc }}$ | 150 mA |  |  | 0.5 | V | \% |
|  |  |  | MIN | 0.8 V | $\mathrm{V}_{\text {cc }}$ | 250 mA |  |  | 0.7 | V |  |
| "1" Level Supply Current | $\operatorname{lcc}(1)$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 4 | 6 | mA | 1,2 |
| "0" Level Supply Current | Icc(0) | NOM | MAX | OV | OV |  |  | 17.5 | 24.5 | mA | 1,2 |

NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Capacitance values specified include probe and test fixture capacitance.


## Type UHP-402, UHP-402-1, and UHP-502

## Quad 2-Input OR Power Drivers



ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | VCC | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current Type UHP-402 | loff |  | MIN | 2.0 V | OV | 40 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-402-1 | 1 off |  | MIN | 2.0 V | OV | 70 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-502 | loff |  | MIN | 2.0 V | OV | 100 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 0.8 V | 0.8 V | 150 mA |  |  | 0.5 | V |  |
|  |  |  | MIN | 0.8 V | 0.8 V | 250 mA |  |  | 0.7 | V |  |
| "1" Level Supply Current | $\operatorname{ICC(1)}$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 4.1 | 6.3 | mA | 1,2 |
| "0" Level Supply Current | $\operatorname{ICC}(0)$ | NOM | MAX | OV | 0 V |  |  | 18 | 25 | mA | 1,2 |

NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Capacitance values specified include probe and test fixture capacitance.


## Type UHP-403, UHP-403-1, and UHP-503

## Quad OR Relay Drivers



ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Output Reverse Current Type UHP-403 | loft |  | MIN | 2.0 V | OV | 40V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-403-1 | loff |  | MIN | 2.0 V | OV | 70V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-503 | loff |  | MIN | 2.0 V | OV | 100 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 0.8 V | 0.8 V | 150 mA |  |  | 0.5 | V |  |
|  |  |  | MIN | 0.8 V | 0.8 V | 250 mA |  |  | 0.7 | V |  |
| Diode Leakage Current | ILK | NOM | NOM | OV | OV | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | $V_{\text {cc }}$ | $V_{C C}$ |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | 5.0 V | 5.0 V |  |  | 4.1 | 6.3 | mA | 1,2 |
| "0" Level Supply Current | $\mathrm{ICC}(0)$ | NOM | MAX | 0 V | OV |  |  | 18 | 25 | mA | 1,2 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $I_{f}=200 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.


## Type UHP-406, UHP-406-1, and UHP-506 Quad AND Relay Drivers



ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Output Reverse Current Type UHP-406 | loff |  | MIN | 2.0 V | 2.0 V | 40 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-406-1 | loff |  | MIN | 2.0 V | 2.0 V | 70 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "1" Output Reverse Current Type UHP-506 | loff |  | MIN | 2.0 V | 2.0 V | 100 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 0.8 V | VCC | 150 mA |  |  | 0.5 | $V$ |  |
|  |  |  | MIN | 0.8 V | Vcc | 250 mA |  |  | 0.7 | V |  |
| Diode Leakage Current | ILK | NOM | NOM | OV | OV | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | $V_{D}$ | NOM | NOM | $V_{C C}$ | $V_{C C}$ |  |  | 1.5 | 1.75 | $V$ | 4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | 5.0 V | 5.0V |  |  | 4 | 6 | mA | 1,2 |
| "0" Level Supply Current | $\operatorname{ICC}(0)$ | NOM | MAX | OV | OV |  |  | 17.5 | 24.5 | mA | 1,2 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $l_{f}=200 \mathrm{~mA}$
5. Capacitance values specified include probe and test fixture capacitance.


## Type UHP-407, UHP-407-1, and UHP-507 Quad NAND Relay Drivers


ows. no. A. 7973

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current Type UHP-407 | loff |  | MIN | 0.8 V | Vcc | 40 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "1" Output Reverse Current; Type UHP-407-1 | loff |  | MIN | 0.8 V | Vcc | 70 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-507 | loft |  | MIN | 0.8 V | Vcc | 100 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 2.0 V | 2.0 V | 150 mA |  |  | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 250 mA |  |  | 0.7 | V |  |
| Diode Leakage Current | ILK | NOM | NOM | VCC | $\mathrm{V}_{\mathrm{CC}}$ | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 4 |
| Diode Forward Voltage Drop | VD | NOM | NOM | OV | OV |  |  | 1.5 | 1.75 | V | 5 |
| "1" Level Supply Current | $\mathrm{ICC}(1)$ | NOM | MAX | OV | OV |  |  | 6 | 7.5 | mA | 1,2 |
| "0" Level Supply Current | ICC(0) | NOM | MAX | 5 V | 5 V |  |  | 20 | 26.5 | mA | 1,2 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Capacitance values specified include probe and test fixture capacitance.
4. Diode leakage current measured at $V_{R}=V_{\text {off(min }}$.
5. Diode forward voltage drop measured at $I_{f}=200 \mathrm{~mA}$.



DWG. MO. A-7900A

## Type UHP-408, UHP-408-1, and UHP-508 Quad 2-Input NAND Power Drivers



## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Output Reverse Current Type UHP-408 | loff |  | MIN | 0.8 V | VCC | 40 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-408-1 | loff |  | MIN | 0.8 V | $V_{C C}$ | 70 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-508 | Ioff |  | MIN | 0.8V | $V_{C c}$ | 100 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 0 " Output Voltage | $V_{\text {on }}$ |  | MIN | 2.0 V | 2.0 V | 150 mA |  |  | 0.5 | $V$ |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 250 mA |  |  | 0.7 | V |  |
| "1" Level Supply Current | ICC(1) | NOM | MAX | OV | OV |  |  | 6 | 7.5 | mA | 1,2 |
| "0" Level Supply Current | ICC(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 20 | 26.5 | mA | 1,2 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Capacitance values specified include probe and test fixture capacitance.


## Type UHP-432, UHP-432-1, and UHP-532 Quad 2-Input NOR Power Drivers



ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Output Reverse Current Type UHP-432 | loff |  | MIN | 0.8 V | 0.8 V | 40 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-432-1 | loff |  | MIN | 0.8 V | 0.8 V | 70 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current Type UHP-532 | loff |  | MIN | 0.8 V | 0.8 V | 100 V |  |  | 50 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 2.0 V | OV | 150 mA |  |  | 0.5 | V | . |
|  |  |  | MIN | 2.0 V | 0 V | 250 mA |  |  | 0.7 | V |  |
| "0" Level Supply Current. | $\operatorname{ICC}(0)$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 20 | 25 | mA | 1,2 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | OV | OV |  |  | 6 | 7.5 | mA | 1,2 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} . \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each gate.
3. Capacitance values specified include probe and test fixture capacitance.


## Type UHP-433, UHP-433-1, and UHP-533 Quad NOR Relay Drivers



## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Output Reverse Current Type UHP-433 | loff |  | MIN | 0.8 V | 0.8 V | 40 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "1" Output Reverse Current Type UHP-433-1 | loff |  | MIN | 0.8 V | 0.8 V | 70 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 1 " Output Reverse Current <br> Type UHP-533 | loff |  | MIN | 0.8 V | 0.8 V | 100V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 2.0 V | 0 V | 150 mA |  |  | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | OV | 250 mA |  |  | 0.7 | $V$ |  |
| Diode Leakage Current | luk | NOM | NOM | $V_{C C}$ | VCC | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | OV | OV |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | $\operatorname{lcc}(1)$ | NOM | MAX | OV | 0 V |  |  | 6 | 7.5 | mA | 1,2 |
| "0" Level Supply Current | $\mathrm{K}_{\mathrm{Cc}(0)}$ | NOM | MAX | 5 V | 5 V |  |  | 20 | 25 | mA | 1,2 |

## NOTES:

1. Typical values are at $V_{C C}=5.0, T_{A}=25^{\circ} \mathrm{C}$
2. Each gate.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $\mathrm{I}_{\mathrm{f}}=200 \mathrm{~mA}$
5. Capacitance values specified include probe and test fixture capacitance.


# SERIES ULN-2000A HIGH-VOLTAGE, HIGH-CURRENT DARLINGTON ARRAYS 

THESE HIGH-VOLTAGE, HIGH-CURRENT Darlington arrays are comprised of seven silicon NPN Darlington pairs on a common monolithic substrate. All units have open-collector outputs and integral diodes for inductive load transient suppression.

Peak inrush currents to 600 mA (Series ULN2000A and ULN-2020A) or 750 mA (Series ULN2010A) are permissible, making them ideal for driving tungsten filament lamps.

Series ULN-2001A devices are general purpose arrays that may be used with standard bipolar digital logic using external current limiting, or with most PMOS or CMOS directly. All are pinned with outputs opposite inputs to facilitate printed wiring board layout and are priced to compete directly with discrete transistor alternatives.
Series ULN-2002A is designed for use with 14 to 25 V PMOS devices. Each input has a Zener diode and resistor in series to limit the input current to a safe value in that application. The Zener diode also gives these devices excellent noise immunity.

Series ULN-2003A has a $2.7 \mathrm{k} \Omega$ series base resistor for each Darlington pair, allowing operation directly with TTL or CMOS operating at a supply voltage of 5 V . These devices will handle numerous interface needs - particularly those beyond the capabilities of standard logic buffers.

Series ULN-2004A has a $10.5 \mathrm{k} \Omega$ series input resistor that permits operation directly from CMOS or PMOS outputs utilizing supply voltages of 6 to 15 V . The required input current is below that of Series ULN-2003A, while the required input voltage is less than that required by Series ULN-2002A.

Series ULN-2005A is designed for use with standard TTL and Schottky TTL, with which higher output currents are required and loading of the logic

output is not a concern. These devices will sink a minimum of 350 mA when driven from a "totem pole" logic output.

Series ULN-2000A is the original high-voltage, high-current Darlington array. The output transistors are capable of sinking 500 mA and will sustain at

Device Number Designation

| $\mathrm{V}_{\text {cetmax }}$ | 50 V | 50 V | 95 V |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {cmax }}$ | 500 mA | 600 mA | 500 mA |  |  |  |
|  |  |  |  |  |  |  |


| General Purpose <br> PMOS, CMOS | ULN-2001A | ULN-2011A | ULN-2021A |
| :---: | :---: | :---: | :---: |
| $14-25 \mathrm{~V}$ <br> PMOS | ULN-2002A | ULN-2012A | ULN-2022A |
| 5L <br> TL, CMOS | ULN-2003A | ULN-2013A | ULN-2023A |
| 6-15 <br> CMOS, PMOS | ULN-2004A | ULN-2014A | ULN-2024A |
| High-Output <br> TL | ULN-2005A | ULN-2015A | ULN-2025A |

least 50 V in the off state. Outputs may be paralleled for higher load-current capability. Series ULN-2010A devices are similar, except that they will sink 600 mA . Series ULN-2020A will sustain 95 V in the OFF state.

All Series ULN-2000A Darlington arrays are furnished in a 16 -pin dual in-line plastic package. These can also be supplied in a hermetic dual in-line package for use in military and aerospace applications.

> ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature for any one Darlington pair (unless otherwise noted)
Output Voltage, $\mathrm{V}_{\text {CE }}$ (Series ULN-2000, 2010A) ..... 50 V
(Series ULN-2020A) ..... 95 V
Input Voltage, $\mathrm{V}_{\text {IN }}$ (Series ULN-2002, 2003, 2004A) ..... 30 V
(Series ULN-2005A) ..... 15 V
Continuous Collector Current, IC (Series ULN-2000, 2020A) ..... 500 mA
(Series ULN-2010A) ..... 600 mA
Continuous Input Current, $\mathrm{I}_{\mathrm{N}}$ ..... 25 mA
Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ (one Darlington pair) ..... 1.0 W
(total package) ..... 2.0 W*
Operating Ambient Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$

$$
-55^{\circ} \mathrm{C} \text { to }+150^{\circ} \mathrm{C}
$$

*Derate at the rate of $16.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+25^{\circ} \mathrm{C}$.
Under normal operating conditions, these devices will sustain 350 mA per out put with $V_{\text {CE(SAT) }}=1.6 \mathrm{~V}$ at $+70^{\circ} \mathrm{C}$ with a pulse width of 20 ms and a duty cycle of $34 \%$.

## ALLOWABLE AVERAGE POWER DISSIPATION

 AS A FUNCTION OF AMBIENT TEMPERATURE

Dwg. No. A-9753C

Series ULN-2001A (each driver)

## PARTIAL SCHEMATICS



Series ULN-2002A (each driver)

Series ULN-2003A (each driver)


DWG. No. A-9650


DWG. No. A-965I

Series ULN-2004A
(each driver)


DWG. NO. A-9898 A

Series ULN-2005A
(each driver)

(5. ©. No. A-10.228

## SERIES ULN-2000A

ELECTRICAL CHARACTERISTICS AT $+25^{\circ} \mathrm{C}$ (unless otherwise noted)


## SERIES ULN-2010A

ELECTRICAL CHARACTERISTICS AT $+25^{\circ}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1A | All | $\mathrm{V}_{C E}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | 1B | ULN-2012A | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {IV }}=6.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2014A | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{W}}=1.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CESSAT }}$ | 2 | All | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, I_{B}=350 \mu \mathrm{~A}$ | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | - | 1.3 | 1.6 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=600 \mu \mathrm{~A}$ | - | 1.7 | 1.9 | V |
| Input Current | $\mathrm{I}_{\text {Inow) }}$ | 3 | ULN-2012A | $\mathrm{V}_{\mathrm{IV}}=17 \mathrm{~V}$ | - | 0.82 | 1.25 | mA |
|  |  |  | ULN-2013A | $\mathrm{V}_{\mathbb{N}}=3.85 \mathrm{~V}$ | - | 0.93 | 1.35 | mA |
|  |  |  | ULN-2014A | $\mathrm{V}_{\mathrm{IN}}=5.0 \mathrm{~V}$ | - | 0.35 | 0.5 | mA |
|  |  |  |  | $\mathrm{V}_{\mathbb{N}}=12 \mathrm{~V}$ | - | 1.0 | 1.45 | mA |
|  |  |  | ULN-2015A | $\mathrm{V}_{\mathbb{N}}=3.0 \mathrm{~V}$ | - | 1.5 | 2.4 | mA |
|  | $1_{\text {IVOFF) }}$ | 4 | All | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 50 | 65 | - | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {INONS }}$ | 5 | ULN-2012A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}_{1} \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - | 17 | V |
|  |  |  | ULN-2013A | $\mathrm{V}_{\text {CF }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | - | - | 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - | 3.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - | 3.5 | V |
|  |  |  | ULN-2014A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - | 8.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - | 9.5 | V |
|  |  |  | ULN-2015A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - | 2.6 | V |
| D-C Forward Current Transfer Ratio | $\mathrm{h}_{\mathrm{FE}}$ | 2 | ULN-2011A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 1000 | - | - |  |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | 900 | - | - |  |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | - | All |  | - | 15 | 25 | pF |
| Turn-On Delay | $\mathrm{t}_{\text {PLH }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {PHL }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{s}$ |
| Clamp Diode | $I_{R}$ | 6 | All | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Leakage Current |  |  |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode | $V_{\text {F }}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 1.7 | 2.0 | $V$ |
| Forward Voltage |  |  |  | $\mathrm{I}_{\mathrm{F}}=500 \mathrm{~mA}$ | - | 2.1 | 2.5 | V |

## SERIES ULN-2020A

ELECTRICAL CHARACTERISTICS AT $+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | $\begin{aligned} & \text { Test } \\ & \text { Fig. } \end{aligned}$ | Applicable Devices | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1 A | All | $\mathrm{V}_{\text {cE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | 1B | ULN-2022A | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {W }}=6.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2024A | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {W }}=1.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {cegat) }}$ | 2 | All | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | - | 0.9 | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | - | 1.3 | 1.6 | V |
| Input Current | $I_{\text {mon) }}$ | 3 | ULN-2022A | $\mathrm{V}_{\mathrm{W}}=17 \mathrm{~V}$ | - | 0.82 | 1.25 | mA |
|  |  |  | ULN-2023A | $\mathrm{V}_{\text {IN }}=3.85 \mathrm{~V}$ | - | 0.93 | 1.35 | mA |
|  |  |  | ULN-2024A | $\mathrm{V}_{\text {IV }}=5.0 \mathrm{~V}$ | - | 0.35 | 0.5 | mA |
|  |  |  |  | $\mathrm{V}_{\mathrm{W}}=12 \mathrm{~V}$ | - | 1.0 | 1.45 | mA |
|  |  |  | ULN-2025A | $\mathrm{V}_{\text {IV }}=3.0 \mathrm{~V}$ | - | 1.5 | 2.4 | mA |
|  | $1_{1 \text { moff }}$ | 4 | All | $\mathrm{I}_{\mathrm{c}}=500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 50 | 65 | - | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {iv(a) }}$ | 5 | ULN-2022A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - | 13 | V |
|  |  |  | ULN-2023A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | - | - | 2.4 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=250 \mathrm{~mA}$ | - | - | 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=300 \mathrm{~mA}$ | - | - | 3.0 | V |
|  |  |  | ULN-2024A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=125 \mathrm{~mA}$ | - | - | 5.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}$ | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {cF }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=275 \mathrm{~mA}$ | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=350 \mathrm{~mA}$ | - | - | 8.0 | V |
|  |  |  | ULN-2025A | $\mathrm{V}_{\text {CF }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - | 2.4 | V |
| D-C Forward Current Iransfer Ratio | $\mathrm{h}_{\text {fE }}$ | 2 | ULN-2021A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=350 \mathrm{~mA}$ | 1000 | - | - |  |
| Input Capacitance | $\mathrm{C}_{1}$ | - | All |  | - | 15 | 25 | pF |
| Turn-On Delay | $\mathrm{t}_{\mathrm{PH}}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {pll }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Clamp Diode | $\mathrm{I}_{\mathrm{R}}$ | 6 | All | $\mathrm{V}_{\mathrm{R}}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Leakage Current |  |  |  | $\mathrm{V}_{\mathrm{R}}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 1.7 | 2.0 | V |

## TEST FIGURES



FIGURE 1A


FIGURE 3


FIGURE 1B


FIGURE 4


FIGURE 5

FIGURE 6


FIGURE 7

PEAK COLLECTOR CURRENT
AS A FUNCTION OF DUTY CYCLE


COLLECTOR CURRENT
AS A FUNCTION OF SATURATION VOLTAGE


DWG. NO. A-9754B

COLLECTOR CURRENT AS A FUNCTION OF INPUT CURRENT


DWG. MO. A-10,872A

# INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE 

SERIES ULN-2002A


SERIES ULN-2003A


SERIES ULN-2005A

SERIES ULN-2004A


## TYPICAL APPLICATIONS

## PMOS TO LOAD



BUFFER FOR HIGH-CURRENT LOAD


TTL TO LOAD


USE OF PULL-UP RESISTORS TO INCREASE DRIVE CURRENT


## ULN-2061M THROUGH ULN-2077B 1.5A DARLINGTON SWITCHES

## FEATURES

- TIL, DTL, PMOS, CMOS Compatible Inputs
- Transient-Protected Outputs
- Loads to 480 Watts
- Plastic Dual In-Line Packages
- Heat-Sink Contact Tabs on Quad Arrays

HIGH-VOLTAGE, HIGH-CURRENT Darlington arrays ULN-2061M through ULN-2077B are designed as interface between low-level logic and a variety of peripheral loads such as relays, solenoids, d-c and stepper motors, multiplexed LED and incandescent displays, heaters, and similar loads to 480 watts ( 1.5 A per output, $80 \mathrm{~V}, 26 \%$ duty cycle).

The devices have a minimum output breakdown of 50 V and a minimum $\mathrm{V}_{\mathrm{CE}(\mathrm{SUS})}$ of 35 V measured at 100 mA , or a minimum output breakdown of 80 V and a minimum $\mathrm{V}_{\mathrm{CE}(\mathrm{SUS})}$ of 50 V .

Dual-driver arrays ULN-2061M and ULN-2062M


ULN-2061M
ULN-2062M
are used for common-emitter (externally connected), or emitter-follower applications. Both devices are supplied in miniature 8-pin dual in-line plastic packages.

Quad drivers ULN-2064B, ULN-2065B, ULN2068B and ULN-2069B are intended for use with TTL, low-speed TTL, and 5 V MOS logic. Types ULN-2065B and ULN-2069B are selected for the 80 V minimum output breakdown specification. Types ULN-2068B and ULN-2069B have predriver stages and are most suitable for applications requiring high gain (low input-current loading).


ULN-2064B
ULN-2065B
ULN-2066B
ULN-2067B


ULN-2068B
ULN-2069B
ULN-2070B
ULN-2071B


ULN-2074B
ULN-2075B
ULN-2076B
ULN-2077B

Types ULN-2066B, ULN-2067B, ULN-2070B and ULN-2071B are similar to the preceding quad drivers except that they are designed for use with PMOS and 12 V CMOS logic. The ULN-2070B and ULN-2071B both have a predriver stage and are best suited for use where input current is restricted by MOS output ratings.
Isolated Darlington arrays ULN-2074B through ULN-2077B are identical to Types ULN-2064B through ULN-2067B except for the isolated Darlington pin-out and the deletion of suppression diodes. These switches are for emitter-follower or similar isolated-Darlington applications.
All quad Darlington arrays (suffix "B" devices) are supplied in a 16 -pin plastic dual in-line package with heat-sink contact tabs. A copper-alloy lead frame provides maximum power dissipation using standard cooling methods. This lead configuration facilitates attachment of external heat sinks for increased power dissipation with standard IC sockets and printed wiring boards.

## SELECTION GUIDE

| Part Number | $\begin{aligned} & \text { MAX } \\ & V_{C E X} \end{aligned}$ | MIN. <br> $V_{\text {cesus }}$ | $\begin{gathered} \text { MAX. } \\ V_{\mathbb{I N}} \end{gathered}$ | Application |
| :---: | :---: | :---: | :---: | :---: |
| ULN-2061M ULN-2062M | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 60 \mathrm{~V} \end{aligned}$ | TL, DTL, Schotthy TL, and 5 V CMOS |
| ULN-2064B ULN-2065B | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 15 \mathrm{~V} \\ & 15 \mathrm{~V} \end{aligned}$ | TL, DTL, Schotthy TL and 5 V CMOS |
| ULN-2066B ULN-2067B | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 30 \mathrm{~V} \end{aligned}$ | 6 to 15 V CMOS and PMOS |
| ULN-2068B ULN-2069B | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 15 \mathrm{~V} \\ & 15 \mathrm{~V} \end{aligned}$ | TL, DTL, Schotthy TL, and 5 V CMOS |
| ULN-2070B <br> ULN-2071B | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 30 \mathrm{~V} \end{aligned}$ | 6 to 15 V CMOS and PMOS |
| ULN-2074B ULN-2075B | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 60 \mathrm{~V} \end{aligned}$ | General Purpose |
| ULN-2076B <br> ULN-2077B | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 60 \mathrm{~V} \end{aligned}$ | 6 to 15 V CMOS and PMOS |

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature for Any One Driver (unless otherwise noted)

Output Voltage, $V_{\text {CEx }}$. . . . . . . . . . . . . . . . . . . . . . . See Guide
Output Sustaining Voltage, $\mathrm{V}_{\text {CESSus) }}$ ..... See Guide
Output Current, Iour (Note 1) ..... 1.75 A
Input Voltage, $V_{\mathbb{W}}$ (Note 2) ..... See Guide
Input Current, $I_{B}$ (Note 3) ..... 25 mA
Supply Voltage, V (ULN-2068/69B) ..... 10 V
(ULN-2070/71B) ..... 20 V
Total Package Power Dissipation ..... See GraphOperating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$Storage Temperature Range, $T_{\mathrm{S}} \ldots \ldots \ldots .-55^{\circ} \mathrm{C}$ to $-150^{\circ} \mathrm{C}$
NOTES:$-55^{\circ} \mathrm{C}$ to $-150^{\circ} \mathrm{C}$

1. Allowable combinations of output current, number of outputs conducting, and duty cycle are shown on following pages.
2. Input voltage is referenced to the substrate (no connection to other pins) for Type ULN-2061/62M and ULN-2074/75/76/77B; reference is ground for all other types.
3. Input current may be limited by maximum allowable input voltage.

## ALLOWABLE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



## ULN-2061M AND ULN-2062M

## PARTIAL SCHEMATIC



ELECTRICAL CHARACTERISTICS at $+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1 | ULN-2061M | $V_{C E}=50 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{C E}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2062M | $V_{C E}=80 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {ce(SUS) }}$ | 2 | ULN-2061M | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | 35 | - | V |
|  |  |  | ULN-2062M | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=0.4 \mathrm{~V}$ | 50 | - | V |
| Collector-Emitter Saturation Voltage | $V_{\text {CEISAT }}$ | 3 | Both | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=625 \mu \mathrm{~A}$ | - | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=935 \mu \mathrm{~A}$ | - | 1.2 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=1.25 \mathrm{~mA}$ | - | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}^{*}, \mathrm{I}_{\mathrm{B}}=2.0 \mathrm{~mA}$ | - | 1.4 | V |
|  |  |  | ULN-2062M | $\mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}^{*}, \mathrm{I}_{\mathrm{B}}=2.25 \mathrm{~mA}$ | - | 1.5 | V |
| Input Current | $\mathrm{I}_{\text {(VON) }}$ | 4 | Both | $V_{\text {IN }}=2.4 \mathrm{~V}$ | 1.4 | 4.3 | mA |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=3.75 \mathrm{~V}$ | 3.3 | 9.6 | mA |
| Input Voltage | $V_{\text {INOM) }}$ | 5 | Both | $V_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 2.0 | V |
|  |  |  | ULN-2061M | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}^{*}$ | - | 2.5 | V |
|  |  |  | ULN-2062M | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}^{*}$ | - | 2.5 | V |
| Turn-On Delay | $\mathrm{t}_{\text {PL }}$ | - | Both | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.0 | $\mu \mathrm{s}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {PHL }}$ | - | Both | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.5 | $\mu \mathrm{s}$ |
| Clamp Diode Leakage Current | $I_{R}$ | 6 | ULN-2061M | $V_{R}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2062M | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | 7 | Both | $\mathrm{I}_{\mathrm{F}}=1.0 \mathrm{~A}$ | - | 1.75 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{F}}=1.5 \mathrm{~A}$ | - | 2.0 | V |

*Pulse-Test

## ULN-2064B THROUGH ULN-2067B

## PARTIAL SCHEMATIC



$$
\begin{aligned}
& \left.\begin{array}{l}
\text { ULN-2064B } \\
\text { ULN-2065B }
\end{array}\right\} \quad R_{\mathbb{N}}=350 \Omega \\
& \left.\begin{array}{l}
\text { ULN-2066B } \\
\text { ULN-2067B }
\end{array}\right\} \quad R_{\mathbb{N}}=3 \mathrm{k} \Omega
\end{aligned}
$$

(SIMILAR TO ULN-2074B THROUGH ULN-2077B)


ELECTRICAL CHARACTERISTICS at $+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | 1 | ULN-2064/66B | $V_{\text {CE }}=50 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{C E}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2065/67B | $V_{\text {CE }}=80 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {celsus, }}$ | 2 | ULN-2064/66B | $\mathrm{I}_{\mathrm{c}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | 35 | - | V |
|  |  |  | ULN-2065/67B | $\mathrm{I}_{\mathrm{c}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | 50 | - | V |
| Collector-Emitter Saturation Voltage | $V_{\text {CESSAT }}$ | 3 | All | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=625 \mu \mathrm{~A}$ | - | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=750 \mathrm{~mA}, \mathrm{I}_{8}=935 \mu \mathrm{~A}$ | - | 1.2 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=1.25 \mathrm{~mA}$ | - | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.0 \mathrm{~mA}$ | - | 1.4 | V |
|  |  |  | ULN-2065/67B | $\mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.25 \mathrm{~mA}$ | - | 1.5 | V |
| Input Current | $\mathrm{I}_{\text {(NON) }}$ | 4 | ULN-2064/65B | $\mathrm{V}_{\mathrm{IV}}=2.4 \mathrm{~V}$ | 1.4 | 4.3 | mA |
|  |  |  |  | $V_{\text {IN }}=3.75 \mathrm{~V}$ | 3.3 | 9.6 | mA |
|  |  |  | ULN-2066/67B | $\mathrm{V}_{\text {IN }}=5.0 \mathrm{~V}$ | 0.6 | 1.8 | mA |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ | 1.7 | 5.2 | mA |
| Input Voltage | $V_{\text {INON }}$ | 5 | ULN-2064/65B | $V_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 2.0 | V |
|  |  |  | ULN-2064B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}$ | - | 2.5 | V |
|  |  |  | ULN-2065B | $V_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}$ | - | 2.5 | V |
|  |  |  | ULN-2066/67B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 6.5 | V |
|  |  |  | ULN-2066B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}$ | - | 10 | V |
|  |  |  | ULN-2067B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}^{\text {I }} \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}$ | - | 10 | V |
| Turn-On Delay | $\mathrm{t}_{\text {PLH }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $t_{\text {PHL }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.5 | $\mu \mathrm{S}$ |
| Clamp Diode Leakage Current | $I_{R}$ | 6 | ULN-2064/66B | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{R}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2065/67B | $V_{R}=80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=1.0 \mathrm{~A}$ | - | 1.75 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{F}}=1.5 \mathrm{~A}$ | - | 2.0 | V |

## ULN-2068B THROUGH ULN-2071B

## PARTIAL SCHEMATIC



ULN-2068B
ULN-2069B $\}$
ULN-2070B
ULN-2071B $\}$
$R_{\mathbb{N}}=11.6 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{S}}=3.4 \mathrm{k} \Omega$


ELECTRICAL CHARACTERISTICS at $+25^{\circ} \mathrm{C}, \mathrm{V}_{5}=5.0 \mathrm{~V}$ (ULN-2068/69B) or $\mathrm{V}_{5}=12 \mathrm{~V}$ (ULN-2070/71B) (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1 | ULN-2068/70B | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2069/71B | $V_{\text {CE }}=80 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{C E}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {cefsus) }}$ | 2 | ULN-2068/70B | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | 35 | - | $V$ |
|  |  |  | ULN-2069/71B | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | 50 | - | V |
| Collector-Emitter Saturation Voltage | $V_{\text {CEISAT }}$ | 3 | ULN-2068/69B | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=2.75 \mathrm{~V}$ | - | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=.750 \mathrm{~mA}, \mathrm{~V}_{\mathbb{1}}=2.75 \mathrm{~V}$ | - | 1.2 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathbb{N}}=2.75 \mathrm{~V}$ | - | 1.3 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{~V}_{\text {iN }}=2.75 \mathrm{~V}$ | - | 1.4 | V |
|  |  |  | ULN-2069B | $\mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}, \mathrm{~V}_{\mathbb{N}}=2.75 \mathrm{~V}$ | - | 1.5 | V |
|  |  |  | ULN-2070/71B | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 1.1 | V |
|  |  |  |  | $\mathrm{i}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 1.2 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.25 \mathrm{~A}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 1.4 | V |
|  |  |  | ULN-2071B | $\mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 1.5 | $V$ |
| Input Current | $\mathrm{I}_{\text {INON) }}$ | 4 | ULN-2068/69B | $\mathrm{V}_{\mathbb{N}}=2.75 \mathrm{~V}$ | - | 550 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {IV }}=3.75 \mathrm{~V}$ | - | 1000 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2070/71B | $\mathrm{V}_{\mathrm{N}}=5.0 \mathrm{~V}$ | - | 400 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{N}}=12 \mathrm{~V}$ | - | 1250 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {INON }}$ | 5 | ULN-2068B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}$ | - | 2.75 | V |
|  |  |  | ULN-2069B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}$ | - | 2.75 | V |
|  |  |  | ULN-2070B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}$ | - | 5.0 | V |
|  |  |  | ULN2071B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}$ | - | 5.0 | V |
| Supply Current | $I_{s}$ | 8 | ULN-2068/69B | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=2.75 \mathrm{~V}$ | - | 6.0 | mA |
|  |  |  | ULN-2070/71B | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 4.5 | mA |
| Turn-On Delay | $t_{\text {PH }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {PHL }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}, \mathrm{I}_{\mathrm{c}}=1.25 \mathrm{~A}$ | - | 1.5 | $\mu s$ |
| Clamp Diode Leakage Current | $I_{R}$ | 6 | ULN-2068/70B | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{R}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2069/71B | $V_{R}=80 \mathrm{~V}$ | - | 50 | $\mu A$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=1.0 \mathrm{~A}$ | - | 1.75 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{F}}=1.5 \mathrm{~A}$ | - | 2.0 | V |

## ULN-2074B THROUGH ULN-2077B

## PARTIAL SCHEMATIC



(SIMILAR TO ULN-2064B THROUGH ULN-2067B)


ELECTRICAL CHARACTERISTICS at $+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1 | ULN-2074/76B | $V_{C E}=50 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2075/77B | $V_{C E}=80 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{C E}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {CESSUS) }}$ | 2 | ULN-2074/76B | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | 35 | - | V |
|  |  |  | ULN-2075/77B | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=0.4 \mathrm{~V}$ | 50 | - | V |
| Collector-Emitter Saturation Voltage | $V_{\text {CEISAT }}$ | 3 | All | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=625 \mu \mathrm{~A}$ | - | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=935 \mu \mathrm{~A}$ | - | 1.2 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=1.25 \mathrm{~mA}$ | - | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.0 \mathrm{~mA}$ | - | 1.4 | V |
|  |  |  | ULN-2075/77B | $\mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.25 \mathrm{~mA}$ | - | 1.5 | V |
| Input Current | $I_{\text {IMON }}$ | 4 | ULN-2074/75B | $\mathrm{V}_{\mathrm{N}}=2.4 \mathrm{~V}$ | 1.4 | 4.3 | mA |
|  |  |  |  | $\mathrm{V}_{\text {IV }}=3.75 \mathrm{~V}$ | 3.3 | 9.6 | mA |
|  |  |  | ULN-2076/77B | $\mathrm{V}_{\text {IN }}=5.0 \mathrm{~V}$ | 0.6 | 1.8 | mA |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ | 1.7 | 5.2 | mA |
| Input Voltage | $V_{\text {inow }}$ | 5 | ULN-2074/75B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 2.0 | V |
|  |  |  | ULN-2074B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}$ | - | 2.5 | V |
|  |  |  | ULN-2075B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}$ | - | 2.5 | V |
|  |  |  | ULN-2076/77B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 6.5 | V |
|  |  |  | ULN-2076B | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}$ | - | 10 | V |
|  |  |  | ULN-2077B | $\mathrm{V}_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.5 \mathrm{~A}$ | - | 10 | V |
| Turn-On Delay | $\mathrm{t}_{\text {PLH }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {PHL }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.5 | $\mu s$ |

## TEST FIGURES



Figure 1


Figure 2


Figure 3


Figure 4


Figure 5


Figure 6


Figure 7


Figure 8

## PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE







## PEAK COLLECTOR CURRENT

AS A FUNCTION OF DUTY CYCLE (Continued)


## COLLECTOR CURRENT AS A FUNCTION OF INPUT CURRENT AT $\mathbf{+ 2 5}^{\circ} \mathbf{C}$




## INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE AT +25²





3


BIDIRECTIONAL MOTOR CONTROL

## TYPICAL APPLICATIONS (Continued)



COMMON-ANODE LED DRIVERS
(Series UDN-2980A devices can be used in similar applications at currents of up to 500 mA )


COMMON-CATHODE LED DRIVERS
(Types ULN-2068/70B are also applicable)

## UDN-2541B/W AND UDN-2542B/W QUAD NAND-GATE POWER DRIVERS

## FEATURES

- TIL, CMOS, PMOS, NMOS Compatible
- 1.5 A Continuous Output Current
- Efficient Input/Output Pin Structure
- Low Output Saturation Voltage
- SN75437NE Equivalent

COMBINING NAND LOGIC GATES and highcurrent bipolar outputs, the four power and relay drivers in this series can provide interface between low-level signal-processing circuits and medium-power loads in extremely harsh environments. Each of the four independent outputs of these devices can sink up to 1.5 A in the ON state.

Type UDN-2541B/W and UDN-2542B/W integrated circuits differ only in output-voltage ratings and high-current saturation limits. Types UDN2541 B and UDN-2541 W are rated at 60 V and 1.25 A. Types UDN-2542B and UDN-2542W are



UDN-2541B
UDN-2542B
rated at 1.0 A with a breakdown voltage of greater than 80 V . All devices have a minimum output sustaining voltage of 35 V . Inputs are compatible with most TTL, DTL, LSTTL, and 5 V to 15 V CMOS and PMOS logic.

Types UDN-2541B and UDN-2542B are supplied in 16-pin dual in-line packages with heat-sink contact tabs. This configuration enables easy attachment of an inexpensive heat sink and fits a standard integrated circuit socket or printed wiring board layout. The outputs include transient suppression diodes for inductive loads such as relays, solenoids, and $\mathrm{d}-\mathrm{c}$ and stepping motors.

Types UDN-2541W and UDN-2542W, with higher power-dissipation ratings, are in 12-pin single in-line power-tab packages that allow efficient attachment of external heat sinks for maximum allowable package power dissipation. The tab is at ground potential and needs no insulation. These devices are used to drive high-current incandescent lamps, LEDs, heaters, and (with external transient suppression) high-voltage inductive loads.

## ABSOLUTE MAXIMUM RATINGS <br> at $+25^{\circ} \mathrm{C}$ Free-Air Temperature


(UDN-2542B/W) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 80 V
Output Current, $\mathrm{I}_{\text {out }}$. ............................................................. 1.5 A
Supply Voltage, $\mathrm{V}_{c c}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
Input Voltage, $\mathbb{V}_{\mathbb{N}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
Power Dissipation, $P_{D}$ (Each Driver) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 2.5 W
(Total Package) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . See Graph



RECOMMENDED OPERATING CONDITIONS

| Supply Voltage Range, $\mathrm{V}_{\text {cc }}$. | 4.5 V to 7 V |
| :---: | :---: |
| Input Voltage, $V_{\text {W(1) }}$ | 2 V to 7 V |
| $V_{\text {wio }}$ | $<0.8 \mathrm{~V}$ |

## ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE

UDN-2541B
UDN-2542B


Dwg. No. A-11,793A

UDN-2541W
UDN-2542W


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=4.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | UDN-2541B/W |  | UDN-2542BW |  | Units |
|  |  |  | Min. | Max. | Min. | Max. |  |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | $\mathrm{V}_{\text {OUT }}=60 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0.8 \mathrm{~V}, \mathrm{~V}_{\text {Enable }}=2.0 \mathrm{~V}$ | - | 100 | - | - | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {Out }}=60 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=2.0 \mathrm{~V}, \mathrm{~V}_{\text {ENABLIE }}=0.8 \mathrm{~V}$ | - | 100 | - | - | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {OUT }}=80 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0.8 \mathrm{~V}, \mathrm{~V}_{\text {ENABLE }}=2.0 \mathrm{~V}$ | - | - | - | 100 | $\mu A$ |
|  |  | $\mathrm{V}_{\text {OUT }}=80 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=2.0 \mathrm{~V}, \mathrm{~V}_{\text {Enabie }}=0.8 \mathrm{~V}$ | - | - | - | 100 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $V_{\text {CEISUS) }}$ | $\mathrm{T}_{\text {OUT }}=100 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=\mathrm{V}_{\text {ENaBLE }}=0.8 \mathrm{~V}$ | 35 | - | 50 | - | V |
| Output Saturation Voltage | $V_{\text {ceisat }}$ | $\mathrm{I}_{\text {OUT }}=250 \mathrm{~mA}, \mathrm{~V}_{\text {IV }}=\mathrm{V}_{\text {ENaBLE }}=2.0 \mathrm{~V}$ | - | 350 | - | 350 | mV |
|  |  | $\mathrm{T}_{\text {OUT }}=500 \mathrm{~mA}, \mathrm{~V}_{\text {iN }}=\mathrm{V}_{\text {ENABLE }}=2.0 \mathrm{~V}$ | - | 500 | - | 500 | mV |
|  |  | $\mathrm{I}_{\text {OUT }}=750 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\text {ENaBLE }}=2.0 \mathrm{~V}$ | - | 800 | - | 750 | mV |
|  |  | $\mathrm{T}_{\text {OUT }}=1.0 \mathrm{~A}, \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\text {ENABLE }}=2.0 \mathrm{~V}$ | - | 1.1 | - | 1.0 | V |
|  |  | $\mathrm{T}_{\text {OUT }}=1.25 \mathrm{~A}, \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\text {ENabIE }}=2.0 \mathrm{~V}$ | - | 1.4 | - | - | V |
| Input Voltage | Logic 1 | $V_{\text {IN(1) }}$ or $V_{\text {ENabie(1) }}$ | 2.0 | - | 2.0 | - | V |
|  | Logic 0 | $V_{\text {(N0) }}$ or $V_{\text {enableiol }}$ | - | 0.8 | - | 0.8 | V |
| Input Current | Logic 1 | $\mathrm{V}_{\text {(NI) }}$ or $\mathrm{V}_{\text {Enable(1) }}=2.0 \mathrm{~V}$ | - | 20 | - | 20 | $\mu \mathrm{A}$ |
|  | Logic 0 | $V_{\text {IN()) }}$ or $\mathrm{V}_{\text {ENable }}=0.8 \mathrm{~V}$ | - | 10 | - | 10 | $\mu \mathrm{A}$ |
| Input Clamp Voltage | $\mathrm{V}_{\text {IK }}$ | $\mathrm{I}_{\text {IN }}$ or $\mathrm{I}_{\text {ENable }}=-10 \mathrm{~mA}$ | - | -1.5 | - | -1.5 | V |
| Total Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | $\mathrm{T}_{\text {OUT }}=750 \mathrm{~mA}, \mathrm{~V}_{1 N}{ }^{*}=\mathrm{V}_{\text {ENABLE }}=2.0 \mathrm{~V}$ | - | 75 | - | 75. | mA |
|  |  | $\mathrm{T}_{\text {OUT }}=1.25 \mathrm{~A}, \mathrm{~V}_{\text {IV }}{ }^{\text { }}=\mathrm{V}_{\text {ENaBLE }}=2.0 \mathrm{~V}$ | - | 125 | - | 125 | mA |
|  |  | Outputs Open, $\mathrm{V}_{\mathbb{N}}{ }^{*}=\mathrm{V}_{\text {enable }}=0.8 \mathrm{~V}$ | - | 5.0 | - | 5.0 | mA |
| Clamp Diode Forward Voltage $\dagger$ | $V_{F}$ | $\mathrm{I}_{\mathrm{F}}=1.0 \mathrm{~A}$ | - | 1.6 | - | 1.6 | V |
|  |  | $\mathrm{I}_{\mathrm{F}}=1.5 \mathrm{~A}$ | - | 2.0 | - | 2.0 | V |
| Clamp Diode Leakage Current $\dagger$ | $I_{R}$ | $\mathrm{V}_{\mathrm{R}}=60 \mathrm{~V}, \mathrm{~V}_{\text {IV }}=\mathrm{V}_{\text {ENABLE }}=2.0 \mathrm{~V}, \mathrm{D}_{1}+\mathrm{D}_{2}$ or $\mathrm{D}_{3}+\mathrm{D}_{4}$ | - | 50 | - | - | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\text {Enable }}=2.0 \mathrm{~V}, \mathrm{D}_{1}+\mathrm{D}_{2}$ or $\mathrm{D}_{3}+\mathrm{D}_{4}$ | - | - | - | 50 | $\mu \mathrm{A}$ |

*All inputs simultaneously, all other tests are performed with each input tested separately.
$\dagger$ Test not applicable to SIP (suffix 'W') devices.

TYPICAL APPLICATION
UDN-2541B Driving A Stepper Motor


# SERIES UDN-2580A 8-CHANNEL SOURCE DRIVERS 

## FEATURES

- TTL, CMOS, PMOS, NMOS Compatible
- High Output Current Ratings
- Internal Transient Suppression
- Efficient Input/Output Pin Structure

THIS versatile family of integrated circuits, originally designed to link NMOS logic with high-current inductive loads, will work with many combinations of logic- and load-voltage levels, meeting interface requirements beyond the capabilities of standard logic buffers.
Series UDN-2580A source drivers can drive incandescent, LED, or vacuum fluorescent displays. Internal transient-suppression diodes permit the drivers to be used with inductive loads.

Type UDN-2580A is a high-current source driver used to switch the ground ends of loads that are directly connected to a negative supply. Typical loads are telephone relays, PIN diodes, and LEDs.
Type UDN-2585A is a driver designed for applications requiring low output saturation voltages. Typical loads are low-voltage LEDs and incandescent displays. The eight non-Darlington outputs will simultaneously sustain continuous load currents of -120 mA at ambient temperatures to $+70^{\circ} \mathrm{C}$.

Type UDN-2588A, a high-current source driver similar to Type UDN-2580A, has separate logic and driver supply lines. Its eight drivers can serve as an interface between positive logic (TTL, CMOS, PMOS) or negative logic (NMOS) and either negative or split-load supplies.

Types UDN-2580A and UDN-2588A are rated for operation with output voltages of up to 50 V . Selected devices, carrying the suffix "-1" on the Sprague part number, have maximum ratings of 80 V .
Types UDN-2580A and UDN-2585A are furnished in 18-pin dual in-line plastic packages; Type UDN-2588A is supplied in a 20 -pin dual in-line plastic package. All input connections are on one side of the packages, output pins on the other, to simplify printed wiring board layout.


UDN-2580A UDN-2585A


UDN-2588A

## ABSOLUTE MAXIMUM RATINGS <br> at $25^{\circ} \mathrm{C}$ Free-Air Temperature for Any One Driver (unless otherwise noted)

Output Voltage, $\mathrm{V}_{\text {CE }}$
Supply Voltage, $V_{S}$ (ref. sub.)
Supply Voltage, $\mathrm{V}_{\text {cc }}$ (ref. sub.)
Input Voltage, $V_{\mathbb{N}}$ (ref. $V_{S}$ )
Total Current, $I_{C C}+I_{S}$
Substrate Current, $I_{\text {SUB }}$

| UDN-2580A | UDN-2580A-1 | UDN-2585A | UDN-2588A | UDN-2588A-1 |
| :---: | :---: | :---: | :---: | :---: |
| 50 V | 80 V | 25 V | 50 V | 80 V |
| 50 V | 80 V | 25 V | 50 V | 80 V |
| - | - | - | 50 V | 80 V |
| -30 V | -30 V | -20 V | -30 V | -30 V |
| -500 mA | -500 mA | -250 mA | -500 mA | -500 mA |
| 3.0 A | 3.0 A | 2.0 A | 3.0 A | 3.0 A |

Allowable Power Dissipation, $P_{D}$ (single output)
Operating Temperature Range, $T_{A}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

*Derate at the rate of $18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$

For simplification, these devices are characterized on the following pages with specific voltages for inputs, logic supply ( $\mathrm{V}_{s}$ ), load supply $\left(\mathrm{V}_{\mathrm{EE}}\right)$, and collector supply $\left(\mathrm{V}_{\mathrm{CC}}\right)$. Typical use of the UDN-2580A and UDN-2580A-1 is with negative referenced logic. The more common application of the UDN-2585A, UDN-2588A, and UDN-2588A-1 is with positive referenced logic supplies. In application, the devices are capable of operation over a wide range of logic and supply voltage levels:

## TYPICAL OPERATING VOLTAGES

| $V_{\text {S }}$ | $V_{\text {INOW }}$ | $V_{\text {IV(OFF) }}$ | $V_{c c}$ | $\mathrm{V}_{\text {EE(MAX) }}$ | Device Type |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OV | -15 V to -3.6 V | -0.5 V to 0 V | NA | -25V | UDN-2585A |
|  |  |  |  | -50 V | UDN-2580A |
|  |  |  |  | $-80 \mathrm{~V}$ | UDN-2580A-1 |
| +5V | 0 V to +1.4 V | +4.5V to +5 V | NA | $-20 \mathrm{~V}$ | UDN-2585A |
|  |  |  |  | $-45 \mathrm{~V}$ | UDN-2580A |
|  |  |  |  | $-75 \mathrm{~V}$ | UDN-2580A-1 |
|  |  |  | $\leq 5 \mathrm{~V}$ | -45 V | UDN-2588A |
|  |  |  |  | -75V | UDN-2588A-1 |
| +12 V | 0 V to +8.4V | +11.5 V to +12 V | NA | $-13 \mathrm{~V}$ | UDN-2585A |
|  |  |  |  | -38V | UDN-2580A |
|  |  |  |  | -68V | UDN-2580A-1 |
|  |  |  | $\leq 12 \mathrm{~V}$ | $-38 \mathrm{~V}$ | UDN-2588A |
|  |  |  |  | -68V | UDN-2588A-1 |
| $+15 \mathrm{~V}$ | 0 V to +11.4V | +14.5 V to +15 V | NA | $-10 \mathrm{~V}$ | UDN-2585A |
|  |  |  |  | -35 V | UDN-2580A |
|  |  |  |  | -65 V | UDN-2580A-1 |
|  |  |  | $\leq 15 \mathrm{~V}$ | $-35 \mathrm{~V}$ | UDN2588A |
|  |  |  |  | -65V | UDN-2588A-1 |

NOTE: The substrate must be tied to the most negative point in the external circuit to maintain isolation between drivers and to provide for normal circuit operation.

## UDN-2580A <br> UDN-2580A-1

## PARTIAL SCHEMATIC



DWG. NO. A-11, 358


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$,
$V_{S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-45 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | UDN-2580A | $\mathrm{V}_{\text {IV }}=-0.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {IV }}=-0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | UDN-2580A-1 | $\mathrm{V}_{\text {IV }}=-0.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathbb{I}}=-0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {cessus) }}$ | UDN-2580A | $\mathrm{V}_{\mathbb{N}}=-0.4 \mathrm{~V}, \mathrm{I}_{\text {Out }}=-25 \mathrm{~mA}$, Note 1 | 35 | - | V |
|  |  | UDN-2580A-1 | $\mathrm{V}_{\mathrm{IN}}=-0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-75 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$, Note 1 | 50 | - | V |
| Output Saturation Voltage | $V_{\text {CESSAT }}$ | Both | $\mathrm{V}_{\text {IV }}=-2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | - | 1.8 | V |
|  |  |  | $\mathrm{V}_{\text {IN }}=-3.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-225 \mathrm{~mA}$ | - | 1.9 | V |
|  |  |  | $\mathrm{V}_{\text {IV }}=-3.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - | 2.0 | V |
| Input Current | $l_{\text {INON })}$ | Both | $\mathrm{V}_{\text {IN }}=-3.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - | -500 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {IV }}=-15 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - | -2.1 | mA |
|  | $I_{\text {INOFF) }}$ | Both | $\mathrm{I}_{\text {OUT }}=-500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$, Note 3 | -50 | - | $\mu^{\prime} \mathrm{A}$ |
| Input Voltage | $\mathrm{V}_{\text {IVION }}$ | Both | $\mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 1.8 \mathrm{~V}$, Note 4 | - | -2.4 | V |
|  |  |  | $\mathrm{I}_{\text {OUT }}=-225 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 1.9 \mathrm{~V}$, Note 4 | - | -3.0 | V |
|  |  |  | $\mathrm{I}_{\text {Out }}=-350 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 2.0 \mathrm{~V}$, Note 4 | - | -3.6 | V |
|  | $\mathrm{V}_{\text {IVOFF) }}$ | Both | $\mathrm{I}_{\text {out }}=-500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | -0.2 | - | V |
| Clamp Diode Leakage Current | $I_{R}$ | UDN-2580A | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | UDN-2580A-1 | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | Both | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 2.0 | V |
| Input Capacitance | $\mathrm{C}_{\text {W }}$ | Both |  | - | 25 | pF |
| Turn-On Delay | $\mathrm{t}_{\text {PHL }}$ | Both | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {Out }}$ | - | 5.0 | $\mu \mathrm{s}$ |
| Turn-Off Delay | $t_{\text {PLH }}$ | Both | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {OUT }}$ | - | 5.0 | $\mu \mathrm{s}$ |

NOTES: 1. Pulsed test, $\mathrm{t}_{\mathrm{p}} \leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
2. Negative current is defined as coming out of the specified device pin.
3. The $I_{\text {inoff }}$ current limit guarantees against partial turn-on of the output.
4. The $V_{\mathbb{I N O N}}$ voltage limit guarantees a minimum oufput source current per the specified conditions.
5. The substrate must always be tied to the most negative point and must be at least 4.0 V below $\mathrm{V}_{\mathrm{s}}$.

## UDN-2585A

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$,
$V_{S}=O V, V_{E E}=-20 V$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output Leakage <br> Current | $\mathrm{I}_{\text {cex }}$ | $\mathrm{V}_{\text {IV }}=-0.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-25 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {IV }}=-0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-25 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $V_{\text {CEISUS }}$ | $\mathrm{V}_{\mathbb{N}}=-0.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$, Note 1 | 15 | - | V |
| Output Saturation Voltage | $\mathrm{V}_{\text {CESSAT }}$ | $\mathrm{V}_{\mathbb{N}}=-4.6 \mathrm{~V}, \mathrm{I}_{\text {Ouf }}=-60 \mathrm{~mA}$ | - | 1.1 | V |
|  |  | $\mathrm{V}_{\mathbb{W}}=-4.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-120 \mathrm{~mA}$ | - | 1.2 | V |
| Input Current | $I_{\text {INON }}$ | $\mathrm{V}_{\mathbb{W}}=-4.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-120 \mathrm{~mA}$ | - | -1.6 | mA |
|  |  | $\mathrm{V}_{\mathbb{W}}=-14.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-120 \mathrm{~mA}$ | - | -5.0 | mA |
| Input Voltage | $V_{\text {INON) }}$ | $\mathrm{I}_{\text {OUT }}=-120 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 1.2 \mathrm{~V}$, Note 3 | - | -4.6 | V |
|  | $V_{\text {(VOOF) }}$ | $\mathrm{I}_{\text {OUT }}=-100 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | -0.4 | - | V |
| Clamp Diode Leakage Current | $I_{R}$ | $\mathrm{V}_{\mathrm{R}}=25 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | $\mathrm{I}_{\mathrm{F}}=120 \mathrm{~mA}$ | - | 2.0 | V |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ |  | - | 25 | pF |
| Turn-On Delay | $t_{\text {PHL }}$ | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {our }}$ | - | 5.0 | $\mu \mathrm{s}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {PLH }}$ | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 5.0 | $\mu \mathrm{S}$ |

NOTES: 1. Pulsed test, $\mathrm{t}_{\mathrm{p}} \leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
2. Negative current is defined as coming out of the specified device pin.
3. The $\mathrm{V}_{\text {inow }}$ voltage limit guarantees a minimum output source current per the specified conditions.
4. The substrate must always be tied to the most negative point and must be at least 4.0 V below $\mathrm{V}_{\mathrm{s}}$.


OWG.NO. A-11,360


## UDN-2588A UDN-2588A-1

PARTIAL SCHEMATIC


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$,
$V_{S}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-40 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | UDN-2588A | $\mathrm{V}_{\text {W }} \geq 4.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-45 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {IN }} \geq 4.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-45 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | UDN-2588A-1 | $\mathrm{V}_{\mathbb{W}} \geq 4.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-75 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {IN }} \geq 4.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=\mathrm{V}_{\text {EE }}=-75 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {CEISUS }}$ | UDN-2588A | $\mathrm{V}_{\text {IN }} \geq 4.6 \mathrm{~V}$, $\mathrm{I}_{\text {Out }}=-25 \mathrm{~mA}$, Note 1 | 35 | - | V |
|  |  | UDN-2588A-1 | $\mathrm{V}_{\mathbb{N}} \geq 4.6 \mathrm{~V}, \mathrm{~V}_{\text {EE }}=-70 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$, Note 1 | 50 | - | $V$ |
| Output Saturation Voltage | $\mathrm{V}_{\text {CEISAT }}$ | Both | $\mathrm{V}_{\mathbb{N}}=2.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$, Ref. $\mathrm{V}_{\text {cc }}$ | - | 1.8 | V |
|  |  |  | $\mathrm{V}_{\mathbb{W}}=2.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-225 \mathrm{~mA}$, Ref. $\mathrm{V}_{\text {cC }}$ | - | 1.9 | V |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=1.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$, Ref. $\mathrm{V}_{\text {cc }}$ | - | 2.0 | V |
| Input Current | $I_{\text {INON }}$ | Both | $\mathrm{V}_{\mathbb{N}}=1.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - | -500 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{S}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-30 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - | -2.1 | mA |
|  | $I_{\text {INOFF) }}$ | Both | $\mathrm{I}_{\text {OUT }}=-500 \mathrm{~A}, \mathrm{~T}_{A}=70^{\circ} \mathrm{C}$, Note 3 | -50 | - | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {INON }}$ | Both | $\mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 1.8 \mathrm{~V}$, Note 4 | - | 2.6 | V |
|  |  |  | $\mathrm{I}_{\text {OUT }}=-225 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 1.9 \mathrm{~V}$, Note 4 | - | 2.0 | V |
|  |  |  | $\mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}, \mathrm{~V}_{\text {CE }} \leq 2.0 \mathrm{~V}$, Note 4 | - | 1.4 | V |
|  | $V_{\text {wioff) }}$ | Both | $\mathrm{I}_{\text {OUT }}=-500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 4.8 | - | V |
| Clamp Diode Leakage Current | $I_{R}$ | UDN-2588A | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | UDN-2588A-1 | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | Both | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 2.0 | V |
| Input Capacitance | $\mathrm{C}_{\mathrm{N}}$ | Both |  | - | 25 | pF |
| Turn-On Delay | $\mathrm{t}_{\text {Phl }}$ | Both | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 5.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | tplh | Both | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {OUT }}$ | - | 5.0 | $\mu \mathrm{S}$ |

NOTES: 1. Pulsed test, $\mathrm{t}_{\mathrm{p}} \leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
2. Negative current is defined as coming out of the specified device pin.
3. The $I_{\text {INoff) }}$ current limit guarantees against partial turn-on of the output.
4. The $V_{\mathbb{W} O \mathbb{N}}$ voltage limit guarantees a minimum output source current per the specified conditions.
5. The substrate must always be tied to the most negative point and must be at least 4.0 V below $V_{s}$.
6. $V_{c c}$ must never be more positive than $V_{S}$.


ALLOWABLE PEAK COLLECTOR CURRENT AT $\mathbf{7 0}^{\circ} \mathrm{C}$ AS A FUNCTION OF DUTY CYCLE


Dwa. No. A-11,108B

## TYPICAL APPLICATIONS



COMMON-CATHODE LED DRIVER


TELECOMMUNICATIONS
RELAY DRIVER
(Negative Logic)


DWG.NO. A-11,362

TELECOMMUNICATIONS RELAY DRIVER (Positive Logic)


DWG.NO. A-11,363

VACUUM FLUORESCENT DISPLAY DRIVER
(Split Supply)

## UDN-2595A 8-CHANNEL CURRENT-SINK DRIVER

## FEATURES

- 200 mA Current Rating
- Low Saturation Voltage
- TLL, CMOS, NMOS Compatible
- Efficient Input/Output Pin Format
- 18-Pin Dual In-Line Plastic Package

DEVELOPED for use with low-voltage LED and incandescent displays requiring low output saturation voltage, Type UDN-2595A meets many other interface needs, including those exceeding the capabilities of standard logic buffers.

The eight non-Darlington outputs of this driver can simultaneously sink load currents of 200 mA at ambient temperatures of up to $+85^{\circ} \mathrm{C}$.

The eight-channel driver's active low inputs can be linked directly to TTL, Schottky TTL, DTL, 5 to 16 V CMOS, and NMOS logic. All input connections are on one side of the package, output connections on the other, for simplified layout of printed wiring boards.

Type UDN-2595A is supplied in an 18-pin dual-in-line plastic package with a copper lead frame that maximizes the driver's power-handling capabilities. A hermetically sealed version of Type UDN-2595A, with reduced package power dissipation ratings, is available on special order.

This device complements Sprague Type UDN2585A, an eight-channel source driver.


## ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature

for any one driver
(unless otherwise noted)
Output Voltage, $\mathrm{V}_{\mathrm{CE}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 V
Supply Voltage, $\mathrm{V}_{\mathrm{S}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 V
Input Voltage, $V_{\mathbb{N}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 V
Output Collector Current, $I_{C}$. . . . . . . . . . . . . . . . . . . 200 mA
Ground Terminal Current, $I_{\text {Gnd }}$.......................... . . 1.6 A
Allowable Power Dissipation, $P_{D}$
$\quad$ (single output) ..................... . . . . . . . . . . 1.0 W
(total package) . . . . . . . . . . . . . . . . . . . . . . . . . 2.2 W*
Operating Temperature Range, $T_{A} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
${ }^{*}$ Derate at the rate of $18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+25^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=5.0 \mathrm{~V}$ (unless otherwise noted).

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | $\mathrm{V}_{\text {IN }} \geq 4.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=20 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {IN }} \geq 4.6 \mathrm{~V}, \mathrm{~V}_{\text {OUI }}=20 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $\mathrm{V}_{\text {CESAAT }}$ | $\mathrm{V}_{\mathrm{iN}}=0.4 \mathrm{~V}, \mathrm{I}_{\text {out }}=50 \mathrm{~mA}$ | - | 0.5 | V |
|  |  | $\mathrm{V}_{\text {IV }}=0.4 \mathrm{~V}, \mathrm{~T}_{\text {out }}=100 \mathrm{~mA}$ | - | 0.6 | V |
| Input Current | $\mathrm{T}_{\text {M (ON) }}$ | $\mathrm{V}_{\text {IV }}=0.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ | - | -1.6 | mA |
|  |  | $\mathrm{V}_{\mathbb{I}}=0.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}, \mathrm{~V}_{S}=15 \mathrm{~V}$ | - | -5.0 | mA |
| Input Voltage | $V_{\text {INON })}$ | $\mathrm{T}_{\text {OUT }}=100 \mathrm{~mA}, \mathrm{~V}_{\text {OUT }} \leq 0.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=5 \mathrm{~V}$ | - | 0.4 | V |
|  | $V_{\text {ivoff) }}$ | $\mathrm{I}_{\text {OUT }}=100 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 4.6 | - | V |
| Input Capacitance | $\mathrm{C}_{11}$ |  | - | 25 | pF |
| Supply Current | $\mathrm{I}_{\text {ss }}$ | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ | - | 6.0 | mA |
|  |  | $\mathrm{V}_{\mathbb{N}}=0.4 \mathrm{~V}, \mathrm{I}_{\text {out }}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{S}}=15 \mathrm{~V}$ | - | 20 | mA |

## NOTES:

1. Negative current is defined as coming out of the specified device pin.
2. The $V_{\mathbb{I N O N}}$ voltage limit guarantees a minimum output sink current per the specified conditions.
3. $I_{s s}$ is measured with any one of eight drivers turned ON .


# SERIES ULN-2800A HIGH-VOLTAGE, HIGH-CURRENT DARLINGTON TRANSISTOR ARRAYS 

IDEALLY SUITED for interfacing between lowlevel digital logic circuitry and high-power peripheral loads, the Series ULN-2800A high-voltage, highcurrent Darlington transistor arrays feature peak load current ratings of 600 mA (Series ULN-2800A and ULN-2820A) or 750 mA (Series ULN-2810A) for each of the eight drivers in each device. Under the proper conditions, high-power loads of up to 4 A at 50 V ( 200 W at $23 \%$ duty cycle) or 3.2 A at 95 V ( 304 W at $33 \%$ duty cycle) can be controlled. Typical loads include relays, solenoids, stepping motors, multiplexed LED and incandescent displays, and heaters. All devices feature open collector outputs and integral diodes for inductive load transient suppression.

The Series ULN-2801A devices are general purpose arrays which may be used with standard bipolar digital logic using external current limiting, or with most PMOS or CMOS directly. All are pinned with outputs opposite inputs to facilitate ease of circuit board layout and are priced to compete directly with discrete transistor alternatives.

The Series ULN-2802A was specifically designed for use with 14 to 25 V PMOS devices. Each input has a Zener diode and resistor in series to limit the input current to a safe value in that application. The Zener diode also means excellent noise immunity for these devices.

The Series ULN-2803A has a $2.7 \mathrm{k} \Omega$ series base resistor to each Darlington pair, and thus allows operation directly with TTL or CMOS operating at a supply voltage of 5 V . These devices will handle numerous interface needs - particularly those beyond the capabilities of standard logic buffers.

The Series ULN-2804A features a $10.5 \mathrm{k} \Omega$ series input resistor to permit their operation directly from CMOS or PMOS outputs utilizing supply voltages of 6 to 15 V . The required input current is below that of the Series ULN-2803A while the required input voltage is less than that required by the Series ULN-2802A.

The Series ULN-2805A is especially designed for use with standard and Schottky TTL where higher output currents are required and loading of the logic

output is not a concern. These devices will sink a minimum of 350 mA when driven from a "totem pole" logic output.

The Series ULN-2800A is the standard highvoltage, high-current Darlington array. The output transistors are capable of sinking 500 mA and will withstand at least 50 V in the OFF state. Outputs may be paralleled for higher load current capability. The Series ULN-2810A devices are similar except that they will sink 600 mA . The Series ULN-2820A will withstand 95 V in the OFF state.

All Series ULN-2800A Darlington arrays are furnished in an 18 -pin dual in-line plastic package.

Device Type Number Designation

| $V_{\text {CE(MAX }}=$ <br> $I_{\text {C(MAX) }}=$ | 500 mA | 50 V | 95 V |
| :---: | :---: | :---: | :---: |
|  | 600 mA | 500 mA |  |
| General Purpose <br> PMOS, CMOS | ULN-2801A | ULN-2811A | ULN-2821A |
| 14-25 V <br> PMOS | ULN-2802A | ULN-2812A | ULN-2822A |
| 5 V <br> TTL, CMOS | ULN-2803A | ULN-2813A | ULN-2823A |
| 6 - 15 V <br> CMOS, PMOS | ULN-2804A | ULN-2814A | ULN-2824A |
| High Output <br> TTL | ULN-2805A | ULN-2815A | ULN-2825A |

ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature for any one Darlington pair (unless otherwise noted)
Output Voltage, $\mathrm{V}_{\text {CE }}$ (Series ULN-2800, 2810A) ..... 50 V
(Series ULN-2820A) ..... 95 V
Input Voltage, $\mathrm{V}_{\text {IN }}$ (Series ULN-2802, 2803, 2804A) ..... 30 V
(Series ULN-2805A) ..... 15 V
Continuous Collector Current, IC (Series ULN-2800, 2820A) ..... 500 mA
(Series ULN-2810A) ..... 600 mA
Continuous Base Current, $I_{B}$ ..... 25 mA
Power Dissipation, $P_{D}$ (one Darlington pair) ..... 1.0 W
(total package) ..... 2.25 W* $^{*}$
Operating Ambient Temperature Range, $T_{A}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ ..... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
${ }^{*}$ Derate at the rate of $18.18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$.
Under normal operating conditions, these devices will sustain 350 mA per output with $\mathrm{V}_{\mathrm{CE}(S A T)}=1.6 \mathrm{~V}$ at $50^{\circ} \mathrm{C}$ with a pulse width of 20 ms and a duty cycle of $40 \%$.

## PARTIAL SCHEMATICS



Series ULN-2801A
(each driver)


WG. No. A-9650

## Series ULN-2802A <br> (each driver)



Ow. *o. A-965

## Series ULN-2803A

(each driver)


DWG. MO. A-9898 A

Series ULN-2804A


No. A-10. 228

Series ULN-2805A
(each driver)

## SERIES ULN-2800A

ELECTRICAL CHARACTERISTICS at $25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | 1A | All | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | 1B | ULN-2802A | $V_{C E}=50 \mathrm{~V}, T_{A}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=6.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2804A | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=1.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CEISAT }}$ | 2 | All | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | - | 0.9 | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | - | 1.3 | 1.6 | V |
| Input Current | Iin(on) | 3 | ULN-2802A | $\mathrm{V}_{\text {IN }}=17 \mathrm{~V}$ | - | 0.82 | 1.25 | mA |
|  |  |  | ULN-2803A | $\mathrm{V}_{\text {IN }}=3.85 \mathrm{~V}$ | - | 0.93 | 1.35 | mA |
|  |  |  | ULN-2804A | $\mathrm{V}_{\text {IN }}=5.0 \mathrm{~V}$ | - | 0.35 | 0.5 | mA |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ | - | 1.0 | 1.45 | mA |
|  |  |  | ULN-2805A | $V_{\text {IN }}=3.0 \mathrm{~V}$ | - | 1.5 | 2.4 | mA |
|  | $\mathrm{I}_{\text {IN(OFF) }}$ | 4 | All | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}, \mathrm{~T}_{A}=70^{\circ} \mathrm{C}$ | 50 | 65 | - | $\mu \mathrm{A}$ |
| Input Voltage | $\mathrm{V}_{\text {IN(ON })}$ | 5 | ULN-2802A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - | 13 | V |
|  |  |  | ULN-2803A | $\mathrm{V}_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | - | - | 2.4 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | - | - | 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - | 3.0 | V |
|  |  |  | ULN-2804A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | - | - | 5.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - | 8.0 | V |
|  |  |  | ULN-2805A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - | 2.4 | V |
| D-C Forward Current Transfer Ratio | $\mathrm{h}_{\mathrm{FE}}$ | 2 | ULN-2801A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 1000 | - | - |  |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | - | All |  | - | 15 | 25 | pF |
| Turn-On Delay | ton | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | toff | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Clamp Diode Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | 6 | All | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{R}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 1.7 | 2.0 | V |

Series ULN-2800A and ULN-2810A devices are also available (with reduced package power capability) in industrial-grade hermetic packages. To order, change the last letter of the part number from ' $A$ ' to ' $R$ '. Note that the high-voltage devices $\left(B V_{C E} \geq 95 V\right)$ are not presently available with this packaging option.

## SERIES ULN-2810A

## ELECTRICAL CHARACTERISTICS at $25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1 A | All | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | 1B | ULN-2812A | $\mathrm{V}_{\mathrm{CE}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\mathbb{1}}=6.0 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2814A | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {IV }}=1.0 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CEISAT }}$ | 2 | All | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | - | $\begin{array}{ll}1.1 & 1.3\end{array}$ | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | - | 1.31 .6 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=600 \mu \mathrm{~A}$ | - | $1.7 \quad 1.9$ | V |
| Input Current | $\mathrm{I}_{\text {ITON }}$ | 3 | ULN-2812A | $\mathrm{V}_{\text {IN }}=17 \mathrm{~V}$ | - | $\begin{array}{ll}0.82 & 1.25\end{array}$ | mA |
|  |  |  | ULN-2813A | $\mathrm{V}_{\mathbb{N}}=3.85 \mathrm{~V}$ | - | 0.931 .35 | mA |
|  |  |  | ULN-2814A | $\mathrm{V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 0.350 .5 | mA |
|  |  |  |  | $\mathrm{V}_{\mathbb{I}}=12 \mathrm{~V}$ | - | 1.01 .45 | mA |
|  |  |  | ULN-2815A | $\mathrm{V}_{\mathrm{N}}=3.0 \mathrm{~V}$ | - | 1.5 | mA |
|  | $\mathrm{I}_{\text {IN(Off) }}$ | 4 | All | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 50 | 65 | $\mu \mathrm{A}$ |
| Input Voltage | $\mathrm{V}_{\text {IN(ON) }}$ | 5 | ULN-2812A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - 17 | V |
|  |  |  | ULN-2813A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | - | - 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - 3.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - 3.5 | V |
|  |  |  | ULN-2814A | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | - | - 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - 8.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - 9.5 | V |
|  |  |  | ULN-2815A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | - | - 2.6 | V |
| $\begin{array}{\|l\|} \hline \text { D-C Forward Current } \\ \text { Transfer Ratio } \\ \hline \end{array}$ | $\mathrm{h}_{\text {fE }}$ | 2 | ULN-2811A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 1000 | - |  |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}$ | 900 | - - |  |
| Input Capacitance | $\mathrm{CIN}_{\text {IN }}$ | - | All |  | - | $15 \quad 25$ | pF |
| Turn-On Delay | ton | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | $0.25 \quad 1.0$ | $\mu \mathrm{S}$ |
| Turn-Off Delay | toff | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | $0.25 \quad 1.0$ | $\mu \mathrm{S}$ |
| Clamp Diode Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | 6 | All | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | $1.7 \quad 2.0$ | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{F}}=500 \mathrm{~mA}$ | - | 2.12 .5 | V |

[^17]
## SERIES ULN-2820A

ELECTRICAL CHARACTERISTICS at $25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $I_{\text {CEX }}$ | 1A | All | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | 1B | ULN-2822A | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{IN}}=6.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | ULN-2824A | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=1.0 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CEISAT }}$ | 2 | All | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | - | 0.9 | 1.1 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | - | 1.3 | 1.6 | V |
| Input Current | IIN(ON) | 3 | ULN-2822A | $\mathrm{V}_{\text {IN }}=17 \mathrm{~V}$ | - | 0.82 | 1.25 | mA |
|  |  |  | ULN-2823A | $\mathrm{V}_{\mathrm{IN}}=3.85 \mathrm{~V}$ | - | 0.93 | 1.35 | mA |
|  |  |  | ULN-2824A | $\mathrm{V}_{\mathrm{IN}}=5.0 \mathrm{~V}$ | - | 0.35 | 0.5 | mA |
|  |  |  |  | $\mathrm{V}_{\mathbb{1}}=12 \mathrm{~V}$ | - | 1.0 | 1.45 | mA |
|  |  |  | ULN-2825A | $\mathrm{V}_{\text {IN }}=3.0 \mathrm{~V}$ | - | 1.5 | 2.4 | mA |
|  | $\mathrm{T}_{\text {IN(OFF) }}$ | 4 | All | $\mathrm{T}_{\mathrm{C}}=500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 50 | 65 | - | $\mu \mathrm{A}$ |
| Input Voltage | $\mathrm{V}_{\text {IN(ON }}$ | 5 | ULN-2822A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - | 13 | V |
|  |  |  | ULN-2823A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | - | - | 2.4 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | - | - | 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | - | - | 3.0 | V |
|  |  |  | ULN-2824A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | - | - | 5.0 | V |
|  |  |  |  | $\mathrm{V}_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - | 8.0 | V |
|  |  |  | ULN-2825A | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | - | - | 2.4 | V |
| D-C Forward Current Transfer Ratio | $h_{\text {fe }}$ | 2 | ULN-2821A | $\mathrm{V}_{C E}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 1000 | - | - |  |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | - | All |  | - | 15 | 25 | pF |
| Turn-On Delay | ton | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | toff | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 0.25 | 1.0 | $\mu \mathrm{S}$ |
| Clamp Diode | $I_{R}$ | 6 | All | $\mathrm{V}_{\mathrm{R}}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Leakage Current |  |  |  | $\mathrm{V}_{\mathrm{R}}=95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | 7 | All | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ |  | 1.7 | 2.0 | V |

## TEST FIGURES



FIGURE IA


FIGURE 2


FIGURE 4


FIGURE 6


FIGURE 1B


FIGURE 3


FIGURE 5


COLLECTOR CURRENT
AS A FUNCTION OF SATURATION VOLTAGE


COLLECTOR CURRENT
AS A FUNCTION OF INPUT CURRENT


ALLOWABLE AVERAGE POWER DISSIPATION AS A FUNCTION OF AMBIENT TEMPERATURE


PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE



INPUT CURRENT
AS A FUNCTION OF INPUT VOLTAGE


SERIES ULN-2802A


SERIES ULN-2804A


DWa. No, A-10, 258

SERIES ULN-2805A


 TO INCREASE DRIVE CURRENT

## TYPICAL DISPLAY INTERFACE



DWG. NO. A-10, 378

## UDN-2841B AND UDN-2845B QUAD DARLINGTON 1.5 A DRIVERS

## FEATURES

- Inputs Compatible with DTL, TLL, LSTLL, CMOS
-     - 50 V Darlington Outputs
- Current-Sink or Sink-and-Source Combination
- 16-Pin Dual In-Line Plastic Package

THIS PAIR OF QUAD DARLINGTON switches is designed for high-current, high-voltage peripheral driver applications. They provide solutions to interface problems involving electronic discharge printers, d-c motor drive (bipolar or unipolar), telephone relays, PIN diodes, LEDs, and other high-current loads operating with negative voltage supplies.

Type UDN-2841B is for current-sink applications in which the load is connected to ground. The outputs switch the negative supply. The input PNP transistor in each driver serves as a level translator. The first NPN stage provides current gain to drive the Darlington-pair outputs.

Type UDN-2845B is a current-sink, currentsource combination in a single dual in-line plastic package. It can be used in bipolar switching applications in which neither end of the load is at ground potential.

Types UDN-2841 and UDN-2845B are intended for use with 5 V TTL, Schottky TTL, DTL, and CMOS logic. Both drivers reduce component count, lower system costs, and reduce circuit and board complexity.


DWG. NO. A-10,323B

Current Sink


Dwg. No. A-10,489

Current Source


## ABSOLUTE MAXIMUM RATINGS <br> at $+25^{\circ} \mathrm{C}$ Free-Air Temperature

## For Single Darlington Output <br> (Unless Otherwise Noted)

| Output Voltage, $\mathrm{V}_{\text {cteoff }}$ | 50 V |
| :---: | :---: |
| Output Sustaining Voltage, $\mathrm{V}_{\text {cesuss }}$ | 35 V |
| Substrate Voltage, $\mathrm{V}_{\text {sub }}$ | -50 V |
| Continuous Output Current, Iow | 1.75 A |
| Supply Voltage, $\mathrm{V}_{\text {s }}$ | 10 V |
| Input Voltage, $V_{\mathbb{W}}$ | 10 V |
| Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ (one output) | See Graph |
| Operating Temperature Range, $T_{A}$. | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

SCHEMATIC
(Each Driver)

|  | Resistor Values in $\mathrm{k} \Omega$ |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Amplifier 1 \& 3 |  |  | Amplifier 2 \& 4 |  |
| Type Number | $\mathrm{R}_{\mathrm{N}}$ | $\mathrm{R}_{\mathrm{S}}$ | $\mathrm{R}_{\mathrm{N}}$ | $\mathrm{R}_{\mathrm{S}}$ |  |
| UDN-2841B | 3.3 | 15 | 3.3 | 15 |  |
| UDN-2845B | 3.3 | 15 | 3.3 | 1 |  |

NOTE: The substrate terminals must be tied to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal device operation.

ALLOWABLE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE


DWG. NO. A-10,488C

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=\boldsymbol{+ 2 5 ^ { \circ } \mathrm { C } \text { (unless otherwise noted) } { } ^ { \text { ( } } \text { ( }}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | $\mathrm{V}_{\mathrm{EE}}=-50 \mathrm{~V}, \mathrm{~V}_{\mathbb{W}}=0.4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{EE}}=-50 \mathrm{~V}, \mathrm{~V}_{\mathbb{W}}=0.4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {cestus) }}$ | $\mathrm{V}_{\mathrm{EE}}=-50 \mathrm{~V}, \mathrm{~V}_{\mathrm{W}}=0.4 \mathrm{~V}, \mathrm{l}_{\text {OUT }}=100 \mathrm{~mA}$ | 35 | 50 | - | V |
| Output Saturation Voltage | $V_{\text {cefish }}$ | $\mathrm{I}_{\text {OUT }}=500 \mathrm{~mA}$ | - | - | 1.1 | V |
|  |  | $\mathrm{l}_{\text {out }}=1.0 \mathrm{~A}$ (Note 1) | - | - | 1.4 | V |
|  |  | $\mathrm{I}_{\text {out }}=1.5 \mathrm{~A}($ (Note 1) | - | - | 1.6 | , |
| Input Current | 1 Imon) | $\mathrm{I}_{\text {our }}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=2.4 \mathrm{~V}$ | - | 300 | 500 | $\mu \mathrm{A}$ |
| Input Voltage (Note 1) | $V_{\text {wow }}$ | $\mathrm{I}_{\text {our }}=1.5 \mathrm{~A}$ | - | - | 2.4 | $V$ |
| Supply Current (Note 1) | $I_{s}$ | $\mathrm{I}_{\text {out }}=500 \mathrm{~mA}$, UDN-2841B, UDN-2845B (Note 2) | - | 2.5 | 3.75 | mA |
|  |  | $\mathrm{l}_{\text {out }}=500 \mathrm{~mA}, \mathrm{UDN}$-2845B (Note 3) | - | 3.3 | 7.5 | mA |
| Turn-On Delay | $\mathrm{t}_{\text {poion }}$ | $\mathrm{R}_{\mathrm{L}}=30 \Omega, 0.5 \mathrm{~V}_{1 \text { II }}$ to $0.5 \mathrm{~V}_{\text {our }}$ | - | - | 2.0 | $\mu \mathrm{s}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {putafi }}$ | $\mathrm{R}_{\mathrm{L}}=39 \Omega, 0.5 \mathrm{~V}_{\text {W1 }}$ to $0.5 \mathrm{~V}_{\text {our }}$ | - | - | 5.0 | $\mu \mathrm{s}$ |

## NOTES:

1. Each driver tested separately.
2. Drivers 1 \& 3 (sink drivers) only, $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-40 \mathrm{~V}$.
3. Drivers 2 \& 4 (source drivers) only, $V_{S}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-40 \mathrm{~V}$.

## TEST CIRCUITS

UDN-2841B


DWG. NO. A-10,487A

UDN-2845B


DWG. NO. A-10,484A

## ALLOWABLE OUTPUT CURRENT

## AS A FUNCTION OF DUTY CYCLE

WITHOUT HEAT SINK


WITH STAVER V-7 HEAT SINK


## OUTPUT-STAGE TRANSIENT PROTECTION

When switching inductive loads, the output transistors of UDN2841B and UDN-2845B drivers should be protected by a suitable clamping technique. The simplest approach is to clamp each output with a discrete diode, as shown in Figures 1 and 2.


DWG. NO. A-11,790A
Figure 1 UDN-2841B


DWG. NO. A-11,787A

Figure 2


UDN-2845B

For improved turnoff, a combination diode/Zener diode scheme can be used. The Zener diode in the clamp circuit of Figure 3 allows the flyback voltage to rise above the supply voltage, speeding turnoff of the load. An appropriate resistor can be substituted for the Zener diode. With a 1 A load, substitution of a $15 \Omega$ resistor results in operation similar to that of the Zener diode circuit.

Figure 3
UDN-2841B

## TYPICAL APPLICATIONS

## BIPOLAR MOTOR DRIVER



ELECTROSENSITIVE PRINTER INTERFACE


## UDN-2878W AND UDN-2879W QUAD HIGH-CURRENT DARLINGTON SWITCHES

## FEATURES

- Output Currents to 4 A
- Output Voltages to 80 V
- Loads to 1280 W
- TTL, DTL, or CMOS Compatible Inputs
- Internal Clamp Diodes
- Plastic Single In-Line Package
- Heat-Sink Tab

THESE QUAD DARLINGTON ARRAYS are designed to serve as interface between lowlevel logic and peripheral power devices such as solenoids, motors, incandescent displays, heaters, and similar loads of up to 320 W per channel. Both integrated circuits include transient-suppression diodes that enable use with inductive loads. The input logic is compatible with most TTL, DTL, LS TTL, and 5 V CMOS logic.

Type UDN-2878W and UDN-2879W 4 A arrays are identical except for output-voltage ratings. The former is rated for operation to 50 V ( 35 V sustaining), while the latter has a minimum output breakdown rating of 80 V ( 50 V sustaining). The
$\begin{array}{lllllllllllll}B_{1} & C_{1} & G N D & C_{2} & K_{1-2} & B_{2} & B_{3} & V_{5} & C_{3} & K_{3-4} & C_{4} & B_{4} \\ & & & & & & & \text { OWG. NO. } & \text { A-11,974 }\end{array}$
$\begin{array}{llllllllllll}B_{1} & C_{1} & \text { GND } & C_{2} & K_{1-2} & B_{2} & B_{3} & V_{S} & C_{3} & K_{3-4} & C_{4} & B_{\mathbf{4}}\end{array}$

economical Type UDN-2878W-2 and Type UDN2879 W -2 are recommended for applications requiring load currents of 3 A or less. These less expensive devices are identical to the basic parts except for the maximum allowable load-current rating.

For maximum power-handling capability, all drivers are supplied in a 12-pin single in-line power-tab package. The tab is at ground potential and needs no insulation. External heat sinks are usually required for proper operation of these devices.

|  | Output <br> Device | Sustaining <br> Voltage | Output <br> Current |
| :--- | :---: | :---: | :---: |
| UDN-2878W | 50 V | 35 V | 4 A |
| UDN-2878W-2 | 50 V | 35 V | 3 A |
| UDN-2879W | 80 V | 50 V | 4 A |
| UDN-2879W-2 | 80 V | 50 V | 3 A |

## ABSOLUTE MAXIMUM RATINGS <br> at $+25^{\circ} \mathrm{C}$ Free-Air Temperature for any driver <br> (unless otherwise noted)

Output Voltage, $\mathrm{V}_{\text {cex }}$ (UDN-2878W \& UDN-2878W-2) ..... 50 V
(UDN-2879W \& UDN-2879W-2) ..... 80 V
Output Current, $\mathrm{I}_{\mathrm{C}}$ (UDN-2878W \& UDN-2879W) ..... 5.0 A
(UDN-2878W-2 \& UDN-2979W-2) ..... 4.0 A
Input Voltage, $V_{\mathbb{N}}$ ..... 15 V
Input Current, $\mathrm{I}_{\mathbb{N}}$ ..... 25 mA
Supply Voltage, Vs ..... 10 V
Total Package Power Dissipation, $P_{D}$ See Graph
Operating Ambient Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S}$

$$
-55^{\circ} \mathrm{C} \text { to }+150^{\circ} \mathrm{C}
$$

## ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION

## AS A FUNCTION OF TEMPERATURE




DWG. NO. A-12,037

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{S}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Fig. | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | 1 | UDN-2878W/W-2 | $V_{\text {CE }}=50 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  |  | UDN-2879WN-2 | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $V_{\text {cessus) }}$ | 2 | UDN-2878W/W-2 | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\text {W }}=0.4 \mathrm{~V}$ | 35 | - | V |
|  |  |  | UDN-2879W/N-2 | $\mathrm{I}_{\mathrm{c}}=100 \mathrm{~mA}, \mathrm{~V}_{\text {iv }}=0.4 \mathrm{~V}$ | 50 | - | $V$ |
| Collector-Emitter Saturation Voltage | $V_{\text {cessat }}$ | 2 | All | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=2.75 \mathrm{~V}$ | - | 1.1 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{~V}_{\text {W }}=2.75 \mathrm{~V}$ | - | 1.3 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=2.0 \mathrm{~A}, \mathrm{~V}_{\mathbb{W}}=2.75 \mathrm{~V}$ | - | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=3.0 \mathrm{~A}, \mathrm{~V}_{\mathbb{N}}=2.75 \mathrm{~V}$ | - | 1.9 | V |
|  |  |  | UDN-2878/2879W | $\mathrm{I}_{\mathrm{C}}=4.0 \mathrm{~A}, \mathrm{~V}_{\mathrm{W}}=2.75 \mathrm{~V}$ | - | 2.2 | V |
| Input Current | $\mathrm{I}_{\text {W }}$ | 3 | All | $\mathrm{V}_{\mathrm{W}}=2.75 \mathrm{~V}$ | - | 550 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{W}}=3.75 \mathrm{~V}$ | - | 1000 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {M(WO) }}$ | 4 | All | $\mathrm{V}_{\text {CE }}=2.2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=3.0 \mathrm{~A}$ | - | 2.75 | $V$ |
|  |  |  | UDN-2878/2879W | $\mathrm{V}_{\text {CE }}=2.2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=4.0 \mathrm{~A}$ | - | 2.75 | V |
| Supply Current per Driver | $\mathrm{I}_{\text {s }}$ | 7 | All | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathbb{W}}=2.75 \mathrm{~V}$ | - | 6.0 | mA |
| Turn-On Delay | $\mathrm{t}_{\mathrm{PH}}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {prl }}$ | - | All | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}, \mathrm{I}_{\mathrm{c}}=3.0 \mathrm{~A}$ | - | 1.5 | $\mu \mathrm{S}$ |
| Clamp Diode Leakage Current | $I_{\text {R }}$ | 5 | All | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | UDN-2879WN-2 | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | 6 | All | $\mathrm{I}_{\mathrm{F}}=3.0 \mathrm{~A}$ | - | 2.5 | $V$ |
|  |  |  | UDN-2878/2879W | $\mathrm{I}_{\mathrm{F}}=4.0 \mathrm{~A}$ | - | 3.0 | V |

CAUTION: High-current tests are pulse tests or require heat sinking.

TEST FIGURES


Figure 1


Figure 2

## TEST FIGURES (Continued)



Figure 3


Figure 4


Figure 6


Figure 7

## TYPICAL APPLICATIONS

STEPPER-MOTOR DRIVER

UDN-2878W


DWG. NO. A-11,975

INPUT WAVEFORMS


## TYPICAL APPLICATIONS (Continued)



DIGIT DRIVER
FOR MULTIPLEXED INCANDESCENT LAMP DISPLAY
UDN-2879W


## UTN-2886B AND UTN-2888A MONOLITHIC SCR ARRAYS

## FEATURES

- Low Input Current
- TTL, LSTTL and CMOS Compatible
- Momentary Inrush Current Capability to 2 A
- Minimum Forward Blocking Voltage 35 V
- Use with Full-Wave or Half-Wave Sources

INTENDED FOR USE with microprocessors that are strobing power loads, these monolithic SCR arrays will interface to high-current loads including lamps, relays, and solenoids. The use of multiple SCRs in a single package reduces component count, insertion costs, assembly time, and circuit space, while improving overall circuit reliability.

Each array contains multiple SCRs with integral current limiting and gate-to-cathode resistors. In all cases, the maximum allowable SCR current rating at $+25^{\circ} \mathrm{C}$ is 800 mA continuous or 2 amperes nonrecurring peak. Outputs may be paralleled for higher load current capability within the limits of the allowable package power dissipation rating.

The UTN-2886B array contains four individual SCRs and two pairs of paralleled SCRs (pins 8-9 and $1-16$ ). Each SCR is capable of continuous and simultaneous operation at $250 \mathrm{~mA}(500 \mathrm{~mA}$ at pins 9 and 16) at an ambient temperature of $+50^{\circ} \mathrm{C}$. The 16 lead package with heat-sink contact tabs allows maximum power dissipation with standard cooling methods. Further increases in power dissipation can be obtained by attaching an external heat sink to the webbed leads.

The UTN-2888A SCR array contains eight isolated devices, each capable of continuous and simultaneous operation at 200 mA at an ambient temperature of $+50^{\circ} \mathrm{C}$.

These SCR arrays operate from an unfiltered half-wave ( 50 or 60 Hz ) or full-wave ( 100 or 120 Hz ) rectified source. They are not intended for use with a-c sources, and will not sustain commercial a-c line voltages ( 115 VAC ).


UTN-2886B


UTN-2888A

## ABSOLUTE MAXIMUM RATINGS

for any one individual SCR*
Forward Blocking Voltage (Input Open), $V_{\text {AK }} \ldots \ldots \ldots 35 \mathrm{~V}$
Reverse Blocking Voltage, $\mathrm{V}_{\mathrm{KA}} \ldots \ldots . . . . . . . . . . . .300 \mathrm{mV}$
Continuous Forward Current, $I_{A} \ldots \ldots . \ldots \ldots . . . .$.
Peak Forward Surge Current, $I_{A} \ldots \ldots . \ldots . . . . .$. . 2.0 A

Peak Gate Input Power, $P_{\text {W }} \ldots . . . . . . . . . . . . . . . . .$.
Gate Input Current, $\mathrm{I}_{\mathrm{N}} \ldots \ldots . . . . . . . . . . . . . . . . . .55 \mathrm{~mA}$
Reverse Gate Input Voltage, $\mathrm{V}_{\mathbb{W}} \ldots . . . . . . . . . . . . .5 .5 \mathrm{~V}$
Total Package Power Dissipation, $P_{0} \ldots \ldots .$. .... See Graph Operating Temperature Range, $T_{A} \ldots \ldots .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## ALLOWABLE AVERAGE POWER DISSIPATION

 as a function of ambient temperature

ELECTRICAL CHARACTERISTICS for any one individual SCR*

| Characteristic | Symbol | Test Temp. | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Forward Blocking Current | $\mathrm{I}_{\mathrm{A}}$ | $+70^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {AK }}=35 \mathrm{~V}, \mathrm{~V}_{\mathbb{I}}=100 \mathrm{mV}$ | - | 50 | $\mu \mathrm{A}$ |
| Gate-to-Anode |  |  |  |  |  |  |
| Leakage Current | $\mathrm{I}_{\text {IN }}$ | $+70^{\circ} \mathrm{C}$ | $V_{\text {AK }}=0 \mathrm{~V}, \mathrm{~V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 250 | $\mu \mathrm{A}$ |
| Forward ON Voltage | $V_{\text {aKion }}$ | $+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{A}}=275 \mathrm{~mA}, \mathrm{~V}_{\mathbb{N}}=2.5 \mathrm{~V}$ | - | 1.2 | V |
|  |  | $+55^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{A}}=275 \mathrm{~mA}, \mathrm{~V}_{\mathrm{IV}}=2.5 \mathrm{~V}$ | - | 1.15 | $V$ |
| Gate Trigger Current | $\mathrm{T}_{\text {IVON) }}$ | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {AK }}=7.0 \mathrm{~V}, \mathrm{~V}_{\text {iN }}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | - | 300 | $\mu \mathrm{A}$ |
| Gate Trigger Voltage | $V_{\text {IVON }}$ | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{AK}}=1.7 \mathrm{~V}, \mathrm{t}_{\mathrm{gt}}=20 \mu \mathrm{~s}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | - | 2.5 | $V$ |
| Gate OFF Voltage | $\mathrm{V}_{\text {IN(OFF) }}$ | $+70^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {AK }}=35 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | 100 | $\bar{\square}$ | mV |
| Gate OFF Current | TIM(OF) | $+70^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {AK }}=35 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | - | 10 | $\mu \mathrm{A}$ |
| Holding Current | 1 | $0^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{IN}(\mathrm{NIT})}=20 \mathrm{~mA}$ | - | 10 | mA |
|  |  | $+55^{\circ} \mathrm{C}$ |  | - | 5.0 | mA |
| Anode OFF Voltage | $V_{\text {AK(OFF) }}$ | $+55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathbb{I}}=5.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$ | 400 | - | mV |

${ }^{*} I_{A}, I_{\mathbb{I}}$, and $I_{H}$ test conditions and limits for the paralleled SCRs at pin 8-9 or pin 1-16 of the UTN-2886B are twice the value shown.


TYPICAL LAMP APPLICATION


TYPICAL WAVEFORMS

## APPLICATION NOTES

1. These devices normally operate from an unfiltered half-wave or full-wave rectified source. They cannot be operated with a bidirectional (unrectified) a-c source.
2. During operation, the SCR is turned ON by application of a positive voltage to the input. The SCR will remain ON, even though the input voltage is removed or made slightly negative, until the anode-to-cathode voltage is reduced to below the anode OFF voltage.
3. When using multiple SCRs and a common supply, gate-to-anode leakage currents can hold the
supply voltage above the anode OFF voltage and prevent proper turn-OFF. To insure proper operation, resistor R should be used as shown in the typical application. The maximum resistor value is determined from:

$$
R=\frac{V_{\text {AKOFF) }}}{(n-1) I_{G A}}=\frac{400 \mathrm{mV}}{(n-1) 250 \mu \mathrm{~A}}
$$

where $n$ is the number of SCRs being used in the system. Note that $\mathrm{n}=2$ for pin 8-9 and pin 1-16 of the UTN-2886B.
4. Various combinations of number of outputs conducting, duty cycle, and ambient temperature must be held within the allowable package power dissipation limits shown.

# UDN-2935Z AND UDN-2950Z BIPOLAR HALF-BRIDGE MOTOR DRIVERS 

## FEATURES

- 3.5 A Peak Output
- 37 V Min. Output Breakdown
- Output Transient Protection
- Tri-State Outputs
- TLL, CMOS, PMOS, NMOS Compatible Inputs
- Internal Thermal Shutdown
- High-Speed Chopper (to 100 kHz )
- UDN-2935Z Replaces SG3635P
- UDN-2950Z Replaces UDN-2949Z, SN75605
- T0-220 Style Packages

BOTH Type UDN-2935Z and UDN-2950Z integrated circuits are designed for servomotor applications using pulse-width modulation. These two high-current, monolithic half-bridge motor drivers combine a sink-and-source driver with diode transient protection, input gain, level shifting, logic stages, and a voltage regulator for sin-gle-supply operation.

The UDN-2935Z output goes high with an active low input at pin 2 ; it is especially desirable in NMOS microprocessor applications. The UDN-2950Z output goes high with an active high input at pin 2 ; its inputs can be tied together for single-wire control. The input circuitry of both devices is compatible with TTL and low-voltage CMOS, PMOS, and NMOS logic. Both ICs have logic lockout (tri-state output) that prevents source and sink drivers from turning ON simultaneously.

In typical applications, the chopper-drive mode is characterized by low power-dissipation levels, low saturation voltages, and short chopper-storage


UDN-2935Z


DWG, NO. A-11,177
UDN-2950Z
times for the sink drivers. The motor drivers can be used in pairs for full-bridge operation, or as triplets in three-phase brushless d-c motor-drive applications. They can also be teamed with the Sprague Electric UCN-4202A stepper motor translator/ driver for bipolar d-c stepper motor control

The motor drivers' single-chip construction and power-tab TO-220 package enable cost-effective and reliable system designs supported by excellent power-dissipation ratings, minimum size, and ease of installation; because the package's heat tab is at ground potential, several devices can share a common heat sink without insulating hardware.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage Range, Vs | 8.0 V to 35 V |
| :---: | :---: |
| Output Voltage Range, $\mathrm{V}_{\text {our }}$ | -2.0 V to $\mathrm{V}_{\mathrm{s}}+2.0 \mathrm{~V}$ |
| Input Voltage Range, $\mathrm{V}_{\text {w }}$ | -0.3 V to +7.0 V |
| Peak Output Current ( $100 \mathrm{~ms}, 10 \% \mathrm{~d}-\mathrm{c}$ ) $\mathrm{T}_{\text {op }}$ | $\pm 3.5 \mathrm{~A}$ |
| Continuous Output Current, Iour | $\pm 2.0 \mathrm{~A}$ |
| Package Power Dissipation, $\mathrm{P}_{0}$ | See Graph |
| Operating Temperature Range, $T_{A}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $-55^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

ALLOWABLE POWER DISSIPATION AS A FUNCTION OF AMBIENT TEMPERATURE


DWG. NO. A-12,000A

TRUTH TABLE

| Source Driver, | Sink Driver, | Output, Pin 4 |  |
| :---: | :---: | :---: | :---: |
|  | Pin 5 | UDN-2935Z | UDN-2950Z |
| Low | Low | High | Low |
| Low | High | High | High Z |
| High | Low | Low | High |
| High | High | High Z | High |

## FUNCTIONAL BLOCK DIAGRAMS

UDN-2935Z


5

UDN-2950Z


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{T}_{\text {TAB }}=+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=35 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Source Driver-Input, Pin 2 |  | Sink Driver Input, Pin 5 | Output, Pin 4 | Other | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | UDN-2935Z | UDN-2950Z |  |  |  | Min. | Max. | Units |
| Output Leakage Current | 2.4 V | 0.8 V | 2.4 V | 0 V | - | - | -500 | $\mu \mathrm{A}$ |
|  | 2.4 V | 0.8 V | 2.4 V | 35 V | - | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | 2.4 V | 0.8 V | 0.8 to 2.4 V | 2.0 A | Fig. 1 | 35 | - | $V$ |
| Output Saturation Voltage | 0.8 V | 2.4 V | 2.4 V | $-2.0 \mathrm{~A}$ | - | 33 | - | $V$ |
|  | 2.4 V | 0.8 V | 0.8 V | 2.0 A | - | - | 2.0 | V |
| Output Source Current | 0.8 V | 2.4 V | 2.4 V | - | - | -2.0 | - | A |
| Output Sink Current | 2.4 V | 0.8 V | 0.8 V | - | - | 2.0 | - | A |
| Input Open-Circuit Voltage | $-250 \mu \mathrm{~A}$ | $-250 \mu \mathrm{~A}$ | $-250 \mu \mathrm{~A}$ | - | - | - | 7.5 | V |
| Input Current | - | 2.4 V | 2.4 V | NC | - | - | -700 | $\mu \mathrm{A}$ |
|  | 2.4 V | - | 2.4 V | NC | - | - | 10 | $\mu \mathrm{A}$ |
|  | 0.8 V | 0.8 V | 0.8 V | NC | - | - | -1.6 | mA |
| Propagation Delay | 2.4 V | 0.8 V | 0.8 to 2.4 V | 2.0 A | - | - | 750 | ns |
|  | 0.8 to 2.4 V | 2.4 to 0.8 V | 2.4 V | 2.0 A | - | - | 2.0 | $\mu \mathrm{S}$ |
| Clamp Diode Forward Voltage | NC | NC | NC | 2.0 A | Fig. 2 | - | 2.2 | $V$ |
| Supply Current | 0.8 V | 2.4 V | NC | NC | - | - | 35 | mA |

NOTE: Positive (negative) current is defined as going into (coming out of) the specified device pin.

## TEST FIGURE 1

TEST FIGURE 2


Dwg.No. A-12,118

## APPLICATION NOTES

It should be noted that an additional power dissipation component may arise from crossover currents flowing from supply to ground when current direction through the load is reversed. This is due to differences in the switching speeds between the source and sink drivers. Although the internal logic lockout protects these devices from catastrophic failure, the crossover power component can cause device operation at substantially higher junction temperatures.

If timing conditions are ignored, the magnitude of this power can be approximated as:

$$
P_{\mathrm{D}}=V_{\mathrm{S}} \times I_{\mathrm{C}} \times t \times f
$$

where $V_{\mathrm{S}}=$ supply voltage
$I_{C}=$ crossover current $(\approx 3.5 \mathrm{~A}$ max. $)$
$t=$ crossover current duration $(\approx 1 \mu s)$
$f=$ frequency of direction change
In some applications (high switching speeds or high package power dissipation), it is recommended that the inputs be driven separately, and that the sink driver not be turned ON for at least $2 \mu \mathrm{~S}$ (maximum source $\mathrm{t}_{\mathrm{PD}}$ ) after the source driver input is turned OFF. The sink driver should be turned OFF at least 750 ns (maximum sink $\mathrm{t}_{\mathrm{PD}}$ ) before the source driver is turned ON.

RECOMMENDED TIMING CONDITIONS
(UDN-2950Z shown)


## TYPICAL APPLICATIONS

## 3-PHASE BRUSHLESS D-C MOTOR DRIVE



SINGLE-WINDING D-C OR STEPPER MOTOR DRIVE

FULL-BRIDGE D-C SERVO MOTOR DRIVE


Dwg.No, A-12,114


## UDN-2949Z HIGH-CURRENT BIPOLAR HALF-BRIDGE MOTOR DRIVER

## FEATURES

- 3.5 A Peak Output
- 30 V Output Breakdown
- Output Transient Suppression
- TL, CMOS, PMOS, NMOS Compatible Inputs
- High-Speed Chopper (to 100 kHz )
- Low Standby Current ( 10 mA )
- T0-220 Style Package

THE UDN-2949Z is a monolithic half-bridge motor driver supplied in a power-tab TO-220 style package. The circuit combines sink and source drivers with diode protection, gain and level shifting systems, and a voltage regulator for single-supply operation. The unit is specifically designed for servomotor drive applications using pulse-width modulation (chopping).

The chopper drive mode is characterized by a minimum power dissipation requirement, low saturation voltages, and low chopper storage times for the NPN sink driver. Predriver stages reduce input drive requirements while allowing the output to switch currents of 2 amperes.

The PNP sourcing driver is turned ON by an active high input while the NPN sinking driver is activated with a low input. These inputs are completely compatible with TTL, low-voltage CMOS, PMOS, and NMOS.

The UDN-2949Z may be used in pairs (fullbridge) for d-c stepper motor or brushless a-c motor drive applications. Such applications may require an external ground clamp diode ( 1 N 4000 ) connected at the output of each device in order to minimize package power dissipation.


Single-chip construction and the power-tab TO-220 style package provide improved cost effectiveness and reliability over discrete component motor drive systems with excellent power dissipation capability, minimum size, ease of installation, and heat sinking.

The package heat tab is at ground potential. Multiple devices may share a common heat sink without insulating hardware.

The UDN-2949Z power driver may be used in stepper-motor bipolar bridge-driver circuits, for example, with the Sprague UCN-4202A Stepper Motor Translator/Driver.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage Range, $\mathrm{V}_{\mathrm{s}}$. .................. 15 V to 30 V
Input Voltage Range, $\mathrm{V}_{\mathbb{N}} \ldots \ldots . . .-0.3 \mathrm{~V}$ to +7.0 V
Peak Output Current ( $100 \mathrm{~ms}, 10 \%$ d.c.), I Iop $\ldots . . \pm 3.5 \mathrm{~A}$

Package Power Dissipation, $P_{0} \ldots \ldots . .$. . . . See Graph
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

|  | LOGIC | TRUTH TABLE |
| :---: | :---: | :---: |
| Source Driver | Sink Driver | Output, |
| Input, $\mathrm{V}_{2}$ | Input, $\mathrm{V}_{5}$ | $V_{4}$ |
| Low | Low | Low |
| Low | High | Open |
| High | High | High |
| High | Low | Disallowed |

ELECTRICAL CHARACTERISTICS at $T_{A}=25^{\circ} \mathbf{C}, \mathbf{V}_{\mathbf{S}}=24 \mathrm{~V}$ (unless otherwise noted).

| Characteristic | Test Conditions |  |  |  | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Source Driver Input, Pin 2 | $\begin{aligned} & \text { Sink Driver } \\ & \text { Input, Pin } 5 \end{aligned}$ | Output Pin 4 | Other |  |  |  |
|  |  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | 0.8 V | 2.4 V | 0 V | $\mathrm{V}_{S}=28 \mathrm{~V}$ | - | -500 | $\mu \mathrm{A}$ |
|  | 0.8 V | 2.4 V | 28 V | $\mathrm{V}_{\mathrm{S}}=28 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | 0.8 V | 0.8 to 2.4 V | 2.0 A | Test Fig. 1 | 30 | - | $V$ |
| Output Saturation Voltage | 2.4 V | 2.4 V | $-2.0 \mathrm{~A}$ |  | 22 | - | V |
|  | 0.8 V | 0.8 V | 2.0 A |  | - | 2.0 | V |
| Output Source Current | 2.4 V | 2.4 V | - |  | -2.0 | - | A |
| Output Sink Current | 0.8 V | 0.8 V | - |  | 2.0 | - | A |
| Input Open-Circuit Voltage | $-250 \mu \mathrm{~A}$ | $-250 \mu \mathrm{~A}$ | - |  | - | 7.5 | V |
| Input Current | 2.4 V | 2.4 V | NC |  | - | -700 | uA |
|  | 0.8 V | 0.8 V | NC |  | - | $-5.0$ | mA |
| Propagation Delay | 0.8 V | 0.8 to 2.4 V | NC |  | - | 750 | ns |
|  | 0.8 to 2.4 V | 2.4 V | NC |  | - | 5.0 | us |
| Clamp Diode Forward Voltage | NC | NC | 2.0 A | Test Fig. 2 | - | 2.2 | $V$ |
| Supply Current | NC | NC | NC |  | - | 35 | mA |

[^18]


OWG. No. A-11,179

## APPLICATION NOTES

1. The source and sink outputs should not be ON simultaneously ( $\mathbf{V}_{\mathbf{2}} \mathrm{High}, \mathrm{V}_{5}$ Low). High "crossover" currents could degrade or destroy the device.
2. Do not assume from the Logic Truth Table that both inputs can be connected ( $\mathrm{V}_{4}$ High or Low only). The sink driver is considerably faster than the source driver. An input shift from high-to-low levels could produce a condition where both drivers are ON, and that condition could occur for as long as $5 \mu \mathrm{~s}$.
3. It is recommended that the inputs be driven separately, and that the sink driver input
not be pulled low (turned ON) for at least $5 \mu \mathrm{~s}$ (max. source $t_{P D}$ ) after the source driver input is pulled low (turned OFF). The sink driver should be allowed to go high (turned OFF) at least 750 ns (max. sink $t_{P D}$ ) before the source driver goes high (turned ON).



PACKAGE POWER DISSIPATION
AS A FUNCTION OF TEMPERATURE


DWG. NO. A-11,183

SINGLE-WINDING D-C OR STEPPER MOTOR
FULL-BRIDGE D-C SERVO MOTOR APPLICATION


## UDN-2952B AND UDN-2952W FULL-BRIDGE MOTOR DRIVERS

## features

- High Output Current
- Adjustable Short-Circuit Protection
- Thermal Protection
- Internal Clamp Diodes
- TIL, DTL, PMOS, CMOS Compatible
- DIP or SIP Packaging

FULL-BRIDGE MOTOR-DRIVER integrated circuits, Types UDN-2952B and UDN-2952W combine low-level logic circuitry and Darlington output power drivers for bidirectional control of d-c motors or solenoids operating with continuous load currents of up to 2 A and peak start-up currents as high as 3.5A.

For applications requiring load currents of 1 A or less (2 A peak), the economical Type UDN-2952B-2 and UDN-2952W-2 are recommended. The lower-


cost devices are identical to the basic parts, except for the maximum allowable load-current rating.

These monolithic integrated circuits have extensive circuit protection. Both drivers have thermal shutdown networks that disable motor drive if the package power dissipation ratings are exceeded. Internal diode transient suppression is provided onchip. Output-current limiting is determined by the user's selection of a sensing resistor.

The Type UDN-2952B full-bridge power driver is supplied in a 16-pin dual in-line plastic package with copper heat-sink contact tabs. The lead configuration enables easy attachment of a heat sink while fitting a standard integrated circuit socket or printed wiring board layout. Type UDN-2952W, for higher power requirements, is in a 12 -pin single in-line power tab package. The tab is at ground potential and needs no insulation. For output currents above 700 mA at normal ambient temperatures, both drivers require an external heat sink.

## UDN-2952B AND UDN-2952W

## ABSOLUTE MAXIMUM RATINGS

$$
\text { at } \mathrm{T}_{\mathrm{TAB}}=+70^{\circ} \mathrm{C}
$$


Logic Supply Voltage Range, $\mathrm{V}_{\mathrm{DD}}$. . . . . . . . . . . . . . 4.5V to 15 V
Substrate Voltage Range, $\mathrm{V}_{\text {sus }} \ldots \ldots . . . . . . . . .$. . OV to -20 V
Logic Input Voltage, $\mathrm{V}_{\text {phase }}$ or $\mathrm{V}_{\text {enable }}$. . . . . . . . . . . . . . . . . 30 30 V
Output Current, I Iout (UDN-2952B and UDN-2952W) .... $\pm 3.5 \mathrm{~A}$
(UDN-2952B-2 and UDN-2952W-2) $\ldots \pm 2 \mathrm{~A}$
Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ $\qquad$ . See Graphs
Operating Temperature Range, $T_{A}$ $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## TRUTH TABLE

| ENABLE | PHASE | $\mathrm{V}_{\mathrm{SS}}$ | $\mathrm{V}_{\text {DD }}$ | OUT $_{1}$ | OUT $_{2}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| High | X | X | X | Open | Open |
| Low | High | $<0.8 \mathrm{~V}$ | $>4.5 \mathrm{~V}$ | High | Low |
| Low | Low | $<0.8 \mathrm{~V}$ | $>4.5 \mathrm{~V}$ | Low | High |
| X | X | $>0.9 \mathrm{~V}$ | $>4.5 \mathrm{~V}$ | Open | Open |
| X | X | X | 0 V | Open | Open |

$X=$ Irrelevant.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=40 \mathrm{~V}, \mathrm{~V}_{\mathrm{DO}}=5 \mathrm{~V}, \mathrm{~T}_{\text {TAB }} \leq+70^{\circ} \mathrm{C}$,
Figure 1 (unless otherwise noted)

|  |  |  | Limits |  |
| :--- | :--- | :--- | :--- | :--- |
| Characteristic | Symbol | Test Conditions | Min. Typ. Max. Units |  |

Output Drivers (OUT, or OUT ${ }_{2}$ )

| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | $V_{\text {EMable }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=V_{\text {B8, }}$, Note 1 | - | - | 500 | $\mu \mathrm{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $V_{\text {EMable }}=5 \mathrm{~V}, \mathrm{~V}_{\text {Ouf }}=0 \mathrm{~V}$, Note 1 | - | - | -500 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $\mathrm{V}_{\text {cesat }}$ | $\mathrm{V}_{\text {EMaBE }}=0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1 \mathrm{~A}$, Notes 1 and 2 | - | 1.2 | 1.5 | V |
|  |  | $\mathrm{V}_{\text {EABBIE }}=0 \mathrm{~V}, \mathrm{I}_{\text {OUI }}=2 \mathrm{~A}$, Notes 1 and 3 | - | 1.5 | 2.0 | $V$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {cessus) }}$ | $\mathrm{I}_{\text {our }}=1 \mathrm{~A}$, Figure 2, Notes 1 and 2 | 40 | - | - | $V$ |
|  |  | $\mathrm{I}_{\text {out }}=2 \mathrm{~A}$, Figure 2, Notes 1 and 3 | 40 | - | - | V |
| Motor Supply Current | $\mathrm{I}_{\text {B8ON }}$ | $\mathrm{V}_{\text {EMasiE }}=0.8 \mathrm{~V}$, Outputs Open; Note 1 | - | 15 | 30 | mA |
|  | $\mathrm{I}_{\text {BBoff }}$ | $\mathrm{V}_{\text {Emaie }}=2.4 \mathrm{~V}$, Outputs Open, Note 1 | - | 3.0 | 5.0 | mA |
| Clamp Diode Forward Voltage | $\mathrm{V}_{\mathrm{F}}$ | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~A}$, Note 2 | - | 1.0 | 1.5 | V |
|  |  | $\mathrm{I}_{\mathrm{F}}=2 \mathrm{~A}$, Note 3 | - | 1.8 | 2.2 | V |

Control Logic (PHASE or ENABLE)

| Logic Open-Circuit Voltage | $V_{\text {w }}$ | $\mathrm{I}_{\text {Puase }}$ or $\mathrm{I}_{\text {EMABLIE }}=-250 \mu \mathrm{~A}$ | - | - | 7.5 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Logic Input Current | $\mathrm{I}_{\text {m(1) }}$ | $V_{\text {Prase }}$ or $V_{\text {Emable }}=2.4 \mathrm{~V}$ | - | -50 | -100 | $\mu \mathrm{A}$ |
|  | $I_{\text {m(0) }}$ | $V_{\text {Prase }}$ or $V_{\text {Emale }}=0.8 \mathrm{~V}$ | - | -1.0 | -1.6 | mA |
| Logic Input Voltage | $V_{\text {m(1) }}$ |  | 2.4 | - | - | V |
|  | $V_{1 \text { (10) }}$ |  | - | - | 0.8 | V |
| Logic Supply Current | $\mathrm{I}_{00}$ |  | - | 15 | 30 | mA |
| Sense Trigger Voltage | $\mathrm{V}_{\text {SS }}$ | $V_{\text {Emabile }}=0.8 \mathrm{~V}$ | - | 850 | - | mV |
| Turn-On Delay Time | $\mathrm{t}_{\text {dot }}$ | Source Drivers | - | 1.0 | - | $\mu \mathrm{S}$ |
|  |  | Sink Drivers | - | 0.5 | - | $\mu \mathrm{S}$ |
| Turn-Off Delay Time | $\mathrm{t}_{\text {p11 }}$ | Source Drivers | - | 2.0 | - | $\mu \mathrm{s}$ |
|  |  | Sink Drivers | - | 1.0 | - | $\mu \mathrm{S}$ |
| Thermal Shutdown | $\mathrm{T}_{\mathrm{J}}$ |  | - | 175 | - | ${ }^{\circ} \mathrm{C}$ |

NOTES: 1. Test is performed with $\mathrm{V}_{\text {prase }}=0.8 \mathrm{~V}$ and then repeated for $\mathrm{V}_{\text {Phase }}=2.4 \mathrm{~V}$.
2. Output measurement at 1 A are applicable to the UDN-2952B, UDN-2952B-2, UDN-2952W, and UDN-2952W-2.
3. Output measurements at 2A are applicable only to the UDN-2952B and UDN-2952W.

## FUNCTIONAL BLOCK DIAGRAM



ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION
AS A FUNCTION OF TEMPERATURE


Dwg. No. A-11,793A

UDN-2952W


Dwg. No. A-11,794

## TEST FIGURES



FIGURE 2

## TYPICAL APPLICATIONS



NOTES:

1. This is not a bipolar chopper application.
2. Resistor $R_{s}$ sets the maximum allowable output current for protection against crossover currents and short circuits. $R_{S}=0.6 / /_{\text {LIMTr }}$.

## TYPICAL APPLICATIONS (Continued)

## FULL-BRIDGE D-C SERVO MOTOR APPLICATION



Dwg. No. A-11,984


Dwg. No. A-11,983

# UDN-2956A AND UDN-2957A HIGH-VOLTAGE, HIGH-CURRENT SOURCE DRIVERS 

COMPRISED of five common collector NPN Darlington output stages, the associated common base PNP input stages, and a common "enable" stage, the UDN-2956A and UDN-2957A high-voltage, high-current source drivers are used to switch the ground end of loads which are directly connected to a negative supply. Typical loads include telephone relays, PIN diodes, and LEDs. Both devices will sustain output OFF voltages of -80 V and will source currents to -500 mA per driver. Under normal operating conditions, these units will sustain load currents of -200 mA on each of the five drivers simultaneously at ambient temperatures up to $+70^{\circ} \mathrm{C}$.

The UDN-2956A driver is intended for use with MOS (PMOS or CMOS) logic input levels operating with supply voltages from 6 V to 16 V . The UDN2957A driver has appropriate input current limiting resistors for operation from TTL, Schottky TTL, DTL, and 5 V CMOS. With either device, the input and enable levels must both be biased towards the positive supply to activate the output load.

Integral transient suppression diodes allow these devices to be used with inductive loads without the need for discrete diodes. In order to maintain isolation between drivers, the substrate should be connected to the most negative supply applied.

Input connections are on one side of the dual in-line package, output connections on the other side to simplify printed wiring board layout.

The UDN-2956A and UDN-2957A high-voltage, high-current drivers are supplied in 14-lead dual in-line packages conforming to JEDEC outline


TO-116 (MO-001AA). Hermetically-sealed versions of these devices (with reduced package power dissipation capability) are available.

## ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ <br> Free-Air Temperature (reference pin 7)

Supply Voltage, $\mathrm{V}_{\mathrm{EE}}$. . ............................ -80 V
Input Voltage, $V_{\text {IN }}$ (UDN-2956A) ..................... +20 V
(UDN-2957A) ................... +10 V
Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . -500 mA
Power Dissipation, $P_{D}$ (any one driver) . . . . . . . . . . . . . 1.0 W
(total package) . ............ 2.0 W*
Operating Temperature Range, $T_{A} \quad \ldots \ldots .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S} \ldots . . . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $16.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} C, V_{\text {Emable }}=V_{I N}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limit |
| :---: | :---: | :---: | :---: | :---: |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | UDN-2956A | $\mathrm{V}_{\mathbb{N}}=\mathrm{V}_{\text {ENABLE }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  |  | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {Emabie }}=15 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  |  | $V_{\text {iv }}=15 \mathrm{~V}, \mathrm{~V}_{\text {ENabiE }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  | UDN-2957A | $\mathrm{V}_{\mathbb{W}}=\mathrm{V}_{\text {ENaBLE }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $-200 \mu \mathrm{~A} \mathrm{Max}$. |
|  |  |  | $\mathrm{V}_{\text {IV }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {EMABLE }}=3.85 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=3.85 \mathrm{~V}, \mathrm{~V}_{\text {EMABLE }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUt }}=-80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | $-200 \mu \mathrm{~A}$ Max. |
| Collector-Emitter Saturation Voltage | $V_{\text {CEISAT }}$ | UDN-2956A | $\mathrm{V}_{\text {iN }}=6.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | -1.20 V Max. |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=7.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-175 \mathrm{~mA}$ | - 1.35 V Max. |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=10 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - 1.70 V Max |
|  |  | UDN-2957A | $\mathrm{V}_{\mathbb{W}}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | - 1.20 V Max. |
|  |  |  | $\mathrm{V}_{\mathbb{W}}=2.7 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-175 \mathrm{~mA}$ | -1.35 V Max . |
|  |  |  | $\mathrm{V}_{\mathrm{IW}}=3.9 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | - 1.70 V Max. |
| Input Current | $\mathrm{I}_{\text {M }}$ | UDN-2956A | $\mathrm{V}_{\text {IN }}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-2.0 \mathrm{~V}$ | $650 \mu \mathrm{~A}$ Max. |
|  |  |  | $\mathrm{V}_{\text {IW }}=15 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | 1.85 mA Max. |
|  |  | UDN-2957A | $\mathrm{V}_{\mathbb{N}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-2.0 \mathrm{~V}$ | $675 \mu \mathrm{~A}$ Max. |
|  |  |  | $\mathrm{V}_{\mathrm{W}}=3.85 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | 1.40 mA Max . |
|  | $\mathrm{I}_{\text {INOFF }}$ | ALL | $\mathrm{I}_{\text {OUT }}=-500 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $50 \mu \mathrm{~A}$ Min. |
| Output Source Current | $\mathrm{I}_{\text {OUT }}$ | UDN-2956A | $\mathrm{V}_{\mathbb{W}}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -125 mA Min. |
|  |  |  | $\mathrm{V}_{\mathrm{W}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-2.0 \mathrm{~V}$ | -200 mA Min. |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=7.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -250 mA Min. |
|  |  |  | $\mathrm{V}_{\mathbb{W}}=8.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | - 300 mA Min . |
|  |  |  | $\mathrm{V}_{\mathbb{W}}=9.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | - 350 mA Min. |
|  |  | UDN-2957A | $\mathrm{V}_{\mathbb{I}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-2.0 \mathrm{~V}$ | -125 mA Min. |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=2.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -200 mA Min. |
|  |  |  | $\mathrm{V}_{\text {IN }}=3.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -250 mA Min. |
|  |  |  | $\mathrm{V}_{\mathbb{W}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-2.0 \mathrm{~V}$ | -300 mA Min. |
|  |  |  | $\mathrm{V}_{\mathbb{W}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | - 350 mA Min . |
| Output Sustaining Voltage | $\mathrm{V}_{\text {CEISUS }}$ | UDN-2956A | $\mathrm{V}_{\text {WI }}=0.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 50 V Min. |
|  |  | UDN-2957A | $\mathrm{V}_{\text {IW }}=0.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 50 V Min. |
| Clamp Diode Leakage Current | $I_{R}$ | ALL | $V_{R}=80 \mathrm{~V}$ | $50 \mu \mathrm{~A}$ Max. |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | ALL | $I_{F}=350 \mathrm{~mA}$ | 2.0V Max. |
| Turn-On Delay | $\mathrm{t}_{\text {ON }}$ | ALL | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }} R_{\mathrm{L}}=400 \Omega \mathrm{C}_{\mathrm{T}}=25 \mathrm{pF}$ | $4.0 \mu \mathrm{~s}$ Max. |
| Turn-Off Delay | $\mathrm{t}_{\text {OF }}$ | ALL | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out. }} \mathrm{R}_{\mathrm{L}}=400 \Omega \mathrm{C}_{\mathrm{T}}=25 \mathrm{pF}$ | $10 \mu s$ Max. |

## INPUT CURRENT

AS A FUNCTION OF INPUT VOLTAGE



# ALLOWABLE PEAK OUTPUT CURRENT AS A FUNCTION OF DUTY CYCLE 





## UDN-2975W AND UDN-2976W DUAL 4 A SOLENOID DRIVERS

## FEATURES

- 5 A Peak Output
- TTLPMOS/CMOS Compatible Inputs
- Low Input Current
- Output Voltage to 60 V
- Single-Ended or Split Supply
- Adjustable Short-Circuit Protection
- Internal Clamp Diodes
- Plastic SIP With Heat-Sink Tab

CURRENT CONTROL for operation of a pair of print solenoids is provided by both Type UDN2975W and UDN-2976W. Each IC's dual driver sections operate directly from the printer control line. The two devices differ only in output-voltage ratings. They can be used at currents of up to 4 A .

Type UDN-2975W is rated at 50 V . Type UDN2976 W is rated at 60 V or $\pm 30 \mathrm{~V}$. Inputs are compatible with most TTL, DTL, LSTTL, and 5 V to 15 V CMOS and PMOS logic.

Current is controlled by a current-sensing latch method that uses only one external sensing resistor for each driver. The load current is compared with the reference voltage and, at the level fixed by the system designer $\left(\mathrm{V}_{\mathrm{REF}} / 10=\mathrm{I}_{\text {LOAD }} \times \mathrm{R}_{\text {SENSE }}\right)$, a latch is set, shutting OFF one of the output transistors. The internal flyback diode then maintains the flux without further input from the power supply, resulting in maximum efficiency. The latch is reset by pulling the input high.

For the maximum in power-handling capability, the integrated circuits are supplied in 12-pin single


Dwg.No. A-12,105
in-line power tab packages. For proper operation, an external heat sink is required. The tab is at $V_{\text {EE }}$ potential and must be insulated from ground when Type UDN-2976W is used with a split supply.

## ABSOLUTE MAXIMUM RATINGS <br> of $\mathrm{T}_{\text {TAB }}=+70^{\circ} \mathrm{C}$

Supply Voltage, $\mathrm{V}_{\text {CC }}$ (Ref. $\mathrm{V}_{E E}$, UDN-2975W) . . . . . . . . . . . 50 V
(Ref. $V_{E E}$, UDN-2976W) . . . . . . . . . . . . 60 V
$V_{\text {EE }}$ (Ref, GND, UDN-2975W) . . . . . . . . . . . . . OV
(Ref. GND, UDN-2976W) . . . . . . . . . 30 V
Peak Output Current, $\mathrm{l}_{\text {our }}$. . . . . . . . . . . . . . . . . . . . . . . . . 5 A
Input Voltage, $\mathrm{V}_{\mathbb{N}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 7 V
Reference Voltage, $\mathrm{V}_{\text {REF }} \ldots \ldots . .$. . . . . . . . . . . . . . . . . . . . 5 V
Package Power Dissipation, $P_{D} \ldots \ldots . . . . . .$. . . . See Graph
Operating Temperature Range, $T_{A} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## FUNCTIONAL BLOCK DIAGRAM (ONE OF TWO DRIVERS)



Dwg. No. A-12,106A
ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE


To maintain isolation between integrated circuit components and to provide for normal transistor operation, the substrate (pin 1) must be connected to the most negative point in the external circuit.

TRUTH TABLE

|  |  | Source | Sink |  |
| :--- | :---: | :---: | :---: | :---: |
| $V_{\text {IN }}$ | $V_{\text {SENSE }}$ | Driver | Driver | Function |
| High | $N A$ | $O f f$ | $O f f$ | Off |
| Low | $<V_{\text {REF }} / 10$ | $0 n$ | $O n$ | On |
| Low | $>V_{\text {REF }} / 10$ | Off | $0 n$ | Flyback |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ}$ C $\mathrm{T}_{\text {Tus }} \leq+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=45 \mathrm{~V}$ (UDN-2975W) or 55 V (UDN-2976W), $\mathrm{V}_{\mathrm{Et}}=\mathrm{V}_{\text {sesse }}=\mathbf{O V}$ (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |


| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | UDN-2975W | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {CC }}=50 \mathrm{~V}, \mathrm{~V}_{\text {SOURCE }}=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{IN}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {SINK }}=\mathrm{V}_{\text {cC }}=50 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | UDN-2976W | $\mathrm{V}_{\mathrm{IN}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {CC }}=60 \mathrm{~V}, \mathrm{~V}_{\text {SOUTCE }}=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{IN}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {SINK }}=\mathrm{V}_{\text {cC }}=60 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $V_{\text {cEISAT }}$ | Both | Source Drivers, $\mathrm{I}_{\text {LOAD }}=4 \mathrm{~A}$ | - | 3.5 | $V$ |
|  |  |  | Sink Drivers, $\mathrm{I}_{\text {LOAD }}=4 \mathrm{~A}$ | - | 2.5 | $V$ |
| Output Sustaining Voltage (Source drivers only) | $\mathrm{V}_{\text {CE(sus) }}$ | UDN-2975W | $\mathrm{I}_{\text {LOAD }}=4 \mathrm{~A}, \mathrm{~L}=3.5 \mathrm{mH}$ | 50 | - | $V$ |
|  |  | UDN-2976W | $\mathrm{I}_{\text {LOAD }}=4 \mathrm{~A}, \mathrm{~L}=3.5 \mathrm{mH}$ | 60 | - | V |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | Both | $\mathrm{I}_{\mathrm{F}}=4 \mathrm{~A}$ | - | 2.0 | $V$ |
| Output Rise Time | $\mathrm{t}_{\mathrm{r}}$ | Both | $\mathrm{I}_{\text {LAAD }}=4 \mathrm{~A}, 10 \%$ to $90 \%$, Resistive Load | - | 2.0 | $\mu \mathrm{S}$ |
| Output Fall Time | $t_{1}$ | Both | $\mathrm{I}_{\text {LOAD }}=4 \mathrm{~A}, 90 \%$ to $10 \%$, Resistive Load | - | 2.0 | $\mu \mathrm{s}$ |

## Control Logic

| Logic Input Voltage | $V_{\text {W(1) }}$ | Both |  | 2.0 | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $V_{\text {IV(0) }}$ | Both | See Notes | - | 0.5 | $V$ |
| Logic Input Current | In(1). | Both | $V_{\mathbb{N}}=2.4 \mathrm{~V}$ | - | 20 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\text {IN(0) }}$ | Both | $\mathrm{V}_{\mathrm{N}}=0.4 \mathrm{~V}$ | - | -20 | $\mu A$ |
|  | $\mathrm{I}_{\text {REFI) }}$ | Both | $V_{\text {REF }}=6.0 \mathrm{~V}$ | - | 20 | $\mu \mathrm{A}$ |
| Reference/Sense Ratio | - | Both | $\mathrm{V}_{\text {REF }}=2.0$ to 5.0 V | 9.5 | 10.5 | - |
| Supply Current | $\mathrm{I}_{\mathrm{C}}$ | Both | Outputs Open | - | 25 | mA |
|  | $\mathrm{I}_{\text {EE }}$ | Both | Outputs Open | - | -20 | mA |
| Propagation Delay Time | $\mathrm{t}_{\mathrm{pd}}$ | Both | $50 \% \mathrm{~V}_{\text {in }}$ to $50 \% \mathrm{~V}_{\text {out, }}$ Resistive Load | - | 3.0 | $\mu \mathrm{s}$ |
|  |  |  | $100 \% V_{\text {sense }}$ to $50 \% V_{\text {out }}{ }^{*}$, Resistive Load | - | 3.0 | $\mu \mathrm{S}$ |
| Minimum Reset Pulse Width | $\mathrm{t}_{\text {in }}$ | Both |  | - | 1.0 | $\mu \mathrm{s}$ |

${ }^{*}$ Where $V_{\text {sence }}=V_{\text {Ref }} / 10.5$
NOTES: Negative current is defined as coming out of (sourcing) the specific device pin.
For improved noise immunity, hysteresis insures $V_{\mathbb{W}(0)}$ of 0.8 V max. after $V_{\mathbb{N}}$ is 0.5 V or less.

## SERIES UDN-2980A HIGH-VOLTAGE, HIGH-CURRENT SOURCE DRIVERS

## FEATURES

- TLL, DTL, PMOS, or CMOS Compatible Inputs
- 500 mA Output Source Current Capability
- Transient-Protected Outputs
- Output Breakdown Voltage to 80 V

RECOMMENDED for applications requiring separate logic and load grounds, load supply voltage to +80 V , and load currents to 500 mA , Series UDN-2980A source drivers are used as interfaces between standard low-power digital logic and relays, solenoids, stepping motors, and LEDs.

Under normal operating conditions, these devices will sustain 120 mA continuously for each of the eight outputs at an ambient temperature of $+50^{\circ} \mathrm{C}$ and a supply of +15 V . All devices in this series incorporate input current limiting resistors and output transient suppression diodes.

Type UDN-2981A and UDN-2983A drivers are for use with +5 V logic systems - TTL, Schottky TTL, DTL, and 5 V CMOS. Type UDN-2982A and UDN-2984A drivers are intended for MOS interface (PMOS and CMOS) operating from supply voltages

of 6 to 16 V . Types UDN-2981A and UDN-2982A will sustain a maximum output OFF voltage of +50 V , while Types UDN-2983A and UDN-2984A will sustain an output voltage of +80 V . In all cases, the output is switched on by an active high input level.

Series UDN-2980A high-voltage, high-current source drivers are supplied in 18 -lead dual in-line packages. On special order, hermetically-sealed versions of these devices (with reduced package power dissipation capability) can also be furnished.

## ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature

[^19]ONE OF EIGHT DRIVERS


POWER DISSIPATION AS A FUNCTION OF AMBIENT TEMPERATURE


Dwg. No. A-11,112A

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Test Fig. | Limit |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cEx }}$ | UDN-2981/82A | $V_{\mathbb{N}}=0.4 \mathrm{~V}^{*}, \mathrm{~V}_{S}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | 1 | - | - | 200 | $\mu \mathrm{A}$ |
|  |  | UDN-2983/84A | $\mathrm{V}_{\mathbb{N}}=0.4 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{S}}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | 1 | - | - | 200 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $V_{\text {GEISAT }}$ | All | $\mathrm{V}_{\mathbb{N}}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | 2 | - | 1.6 | 1.8 | V |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-225 \mathrm{~mA}$ | 2 | - | 1.7 | 1.9 | V |
|  |  |  | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | 2 | - | 1.8 | 2.0 | V |
| Input Current | $\mathrm{I}_{\text {INON }}$ | UDN-2981/83A | $V_{\mathbb{N}}=2.4 \mathrm{~V}$ | 3 | - | 140 | 200 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=3.85 \mathrm{~V}$ | 3 | - | 310 | 450 | $\mu \mathrm{A}$ |
|  |  | UDN-2982/84A | $\mathrm{V}_{\mathbb{N}}=2.4 \mathrm{~V}$ | 3 | - | 140 | 200 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathbb{N}}=12 \mathrm{~V}$ | 3 | - | 1.25 | 1.93 | mA |
| Output Source Current | Iout | UDN-2981/83A | $\mathrm{V}_{\mathbb{W}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=2.0 \mathrm{~V}$ | 2 | -350 | - | - | mA |
|  |  | UDN-2982/84A | $\mathrm{V}_{\mathbb{W}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=2.0 \mathrm{~V}$ | 2 | -350 | - | - | mA |
| Supply Current (Outputs Open) | $I_{s}$ | UDN-2981/82A | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{S}}=50 \mathrm{~V}$ | 4 | - | - | 10 | mA |
|  |  | UDN-2983/84A | $\mathrm{V}_{\text {IV }}=2.4 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{S}}=80 \mathrm{~V}$ | 4 | - | - | 10 | mA |
| Clamp Diode Leakage Current | $I_{R}$ | UDN-2981/82A | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}^{*}$ | 5 | - | - | 50 | $\mu \mathrm{A}$ |
|  |  | UDN-2983/84A | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}^{*}$ | 5 | - | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | All | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | 6 | - | 1.5 | 2.0 | V |
| Turn-On Delay | $\mathrm{t}_{0 \times}$ | All | $\begin{aligned} 0.5 \mathrm{E}_{\text {IN }} \text { to } 0.5 \mathrm{E}_{\text {out }}, \mathrm{R}_{\mathrm{L}} & =100 \Omega, \\ V_{S} & =35 \mathrm{~V} \end{aligned}$ | - | - | 1.0 | 2.0 | $\mu \mathrm{s}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {off }}$ | All | $\begin{aligned} 0.5 \mathrm{E}_{\mathrm{W}} \text { to } 0.5 \mathrm{E}_{\text {out }}, \mathrm{R}_{\mathrm{L}} & =100 \Omega, \\ \mathrm{~V}_{\mathrm{S}} & =35 \mathrm{~V} \end{aligned}$ | - | - | 5.0 | 10 | $\mu \mathrm{s}$ |

[^20]
## TEST FIGURES



Figure 1


DWG. NO. A-11,085

Figure 3


Figure 2


Figure 4


Figure 5


Figure 6

## ALLOWABLE PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE TYPE UDN-2981A882A




ALLOWABLE PEAK COLLECTOR CURRENT
AS A FUNCTION OF DUTY CYCLE
SERIES UDN-2980A



## ALLOWABLE PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE TYPES UDN-2983A/84A




INPUT CURRENT
AS A FUNCTION OF INPUT VOLTAGE


## TYPICAL ELECTROSENSITIVE PRINTER APPLICATION



Dwg. No. A-11,113

TYPICAL VALUES: $\mathbf{V}_{\mathbf{S}}=\mathbf{5 0} \mathrm{V}$

$$
\mathrm{I}_{\text {OUT }}=\mathbf{2 0 0 - 3 0 0} \mathrm{mA}
$$

## SERIES UDN-3600M DUAL 2-INPUT PERIPHERAL AND POWER DRIVERS

## FEATURES

- Four Logic Types
- DTL/TTL/PMOS/CMOS Compatible Inputs
- Low Input Current
- 300 mA Continuous Output Current
- Standoff Voltage of 80 V
- Pin-for-Pin Replacement for Series LM3600N
- Pin-for-Pin Replacement for SN75451BP through SN75454BP and 75461 through 75464


## Description

THESE MINI-DIP dual 2-input peripheral power drivers are bipolar monolithic integrated circuits with AND, NAND, OR, or NOR logic gates and high-current switching transistors on the same chip. The two output transistors are capable of simultaneously sinking 300 mA continuously at ambient temperatures of up to $+70^{\circ} \mathrm{C}$. In the OFF state, these drivers will withstand at least 80 V .

## Applications

Series UDN-3600M dual drivers are ideally suited for interface between low-level or high-level logic and high-current/high-voltage loads. Typical applications include driving peripheral loads such as incandescent lamps, light-emitting diodes, memories, heaters, and other non-inductive loads of up to 600 mA (both drivers in parallel).

With appropriate external-diode transient-suppression, Series UDN3600 M drivers can also be used with inductive loads such as relays, solenoids, and stepping motors.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{\text {cc }}$ ..... 7.0 V
Input Voltage, $V_{\text {IN }}$ ..... 30 V
Output Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Output On-State Sink Current, $\mathrm{I}_{\text {ON }}$ ..... 600 mA
Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ ..... 1.5 W
Each Driver ..... 0.8 W
Derating Factor Above $T_{A}=25^{\circ} \mathrm{C}$ ..... $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ or $80^{\circ} \mathrm{C} / \mathrm{W}$
Operating Free-Air Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ ..... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage (Vcc) | 4.75 | 5.0 | 5.25 | V |
| Operating Temperature Range | 0 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) |  |  | 300 | mA |

INPUT PULSE CHARACTERISTICS

| $V_{\text {in }(0)}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~s}$ |
| :--- | ---: | ---: |
| $V_{\text {in( } 11}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{r}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. |  |  |
| "1" Input Voltage | $V_{\text {in( } 11}$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {in(0) }}$ |  | MIN |  |  |  |  |  | 0.8 | V |  |
| "0" Input Current | $\operatorname{lin}(0)$ |  | MAX | 0.4 V | 30 V |  |  | 50 | 100 | $\mu \mathrm{A}$ | 2 |
| "1" Input Current | $\operatorname{lin}(1)$ |  | MAX | 30 V | 0 V |  |  |  | 10 | $\mu \mathrm{A}$ | 2 |
| Input Clamp Voltage | $V_{1}$ |  | MIN | -12 mA |  |  |  |  | -1.5 | V |  |

SWITCHING CHARACTERISTICS at $V_{c c}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

|  | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristic |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time | $\mathrm{t}_{\text {pdo }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega(10 \text { Watts }) \\ & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 200 | 500 | ns | 3 |
| Turn-off Delay Time | $t_{p d 1}$ | $\begin{aligned} & V_{S}=70 \mathrm{~V}, R_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 300 | 750 | ns | 3 |

## NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each input tested separately.
3. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.
4. Capacitance values specified include probe and test fixture capacitance.

## Type UDN-3611M Dual AND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V_{\text {on }}$ |  | MIN | 0.8 V | $V_{\text {CC }}$ | 100 mA |  | 0.25 | 0.4 | V |  |
|  |  |  | MIN | 0.8 V | $V_{\text {cc }}$ | 300 mA |  | 0.5 | 0.7 | V |  |
| "1" Level Supply Current | Icc(1) | NOM | MAX | 5.0 V | 5.0 V |  |  | 8.0 | 12 | mA | 1,2 |
| "0" Level Supply Current | ICC(0) | NOM | MAX | OV | OV |  |  | 35 | 49 | mA | 1,2 |



## Type UDN-3612M Dual NAND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | Other Input | Output | Min. | Гур. | Max. | Units |  |
| "1" Output Reverse Current | $l_{\text {off }}$ |  | MIN | 0.8 V | $V_{\text {cc }}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ | + |
|  |  |  | OPEN | 0.8 V | $V_{\text {cc }}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 2.0 V | 2.0 V | 100 mA |  | 0.25 | 0.4 | $V$ |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 300 mA |  | 0.5 | 0.7 | $V$ |  |
| "1" Level Supply Current | Icc(1) | NOM | MAX | OV | 0 V |  |  | 12 | 14 | mA | 1,2 |
| "0" Level Supply Current | Tcc(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 40 | 53 | mA | 1,2 |



## Type UDN-3613M Dual OR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)



## Type UDN-3614M Dual NOR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input. | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | $\mathrm{l}_{\text {off }}$ | \% | MIN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V_{\text {on }}$ |  | MIN | 2.0 V | 0 V | 100 mA |  | 0.25 | 0.4 | V |  |
|  |  | \% | MIN | 2.0 V | 0 V | 300 mA |  | 0.5 | 0.7 | $V$ |  |
| "1" Level Supply Current | $\operatorname{Icc(1)}$ | NOM | MAX | OV | OV |  |  | 12 | 15 | mA | 1,2 |
| "0" Level Supply Current | $\mathrm{ICCl}(0)$ | NOM | MAX | 5.0 V | 5.0 V |  | * | 40 | 50 | mA | 1,2 |



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Capacitance values specified include probe and test fixture capacitance.

## SERIES UDN-5700A <br> QUAD 2-INPUT PERIPHERAL AND POWER DRIVERS

## -Transient-Protected Outputs

## FEATURES:

- Four Logic Types
- DTL/TLLPMOS/CMOS Compatible Inputs
- Low Input Current
- 300 mA Continuous Output Current
- Standoff Voltage of 80 V


## Description

THese 16-LEAD QUAD 2-input peripheral and power drivers are bipolar monolithic integrated circuits containing AND, NAND, OR, or NOR logic gates, high-current switching transistors, and transient-suppression diodes on the same chip. The four output transistors are capable of simultaneously sinking 300 mA continuously at ambient temperatures of up to $+70^{\circ} \mathrm{C}$. In the OFF state, these drivers will withstand at least 80 V .

## Applications

Series UDN-5700A quad drivers are ideally suited for interface between low-level or high-level logic and high-current/high-voltage loads. Typical applications include driving peripheral loads such as incandescent lamps, light-emitting diodes, memories, and heaters.

The integral transient-suppression diodes allow their use with inductive loads such as relays, solenoids, or stepping motors without the need of discrete diodes. For non-inductive loads, the diode-common bus can be used for a convenient lamp test.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{\text {cc }}$ ..... 7.0 V
Input Voltage, $V_{\text {W }}$ ..... 30 V
Output Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Output On-State Sink Current, I Ion ..... 600 mA
Suppression Diode Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Suppression Diode On-State Current, Ion ..... 600 mA
Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ ..... 2.0 W
Each Driver ..... 0.8 W
Derating Factor Above $25^{\circ} \mathrm{C}$ $16.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ or $60^{\circ} \mathrm{C} / \mathrm{W}$
Operating Free-Air Temperature Range, $T_{A}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage (V $\mathrm{V}_{\text {CC }}$ : | 4.75 | 5.0 | 5.25 | V |
| Operating Temperature Range | 0 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) |  |  | 300 | mA |

INPUT PULSE CHARACTERISTICS

| $V_{\text {in }(0)}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~s}$ |
| :--- | :--- | :---: |
| $\mathrm{~V}_{\text {in }(1)}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{r}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. |  |  |
| "1" Input Voltage | $V_{\text {in }(1)}$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {in(0) }}$ |  | MIN |  |  |  |  |  | 0.8 | V |  |
| "0" Input Current | $\operatorname{lin}(0)$ |  | MAX | 0.4 V | 30 V |  |  | -50 | -100 | $\mu \mathrm{A}$ | 2 |
| "1" Input Current | $\underline{\ln (1)}$ |  | MAX | 30 V | 0 V |  |  |  | 10 | $\mu \mathrm{A}$ | 2 |
| Input Clamp Voltage | $V_{1}$ |  | MIN | -12 mA |  |  |  |  | -1.5 | V |  |

$$
\text { SWITCHING CHARACTERISTICS at } V_{c c}=5.0 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}
$$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time | $t_{\text {pdo }}$ | $\begin{aligned} & V_{S}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & C_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 200 | 500 | ns | 3 |
| Turn-off Delay Time | $t_{\text {pd }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=70 \mathrm{~V}_{1} \mathrm{R}_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 300 | 750 | ns | 3 |

NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each input tested separately.
3. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.
4. Capacitance values specified inglude probe and test fixture capacitance.

## Type UDN-5703A Quad OR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | $\mathrm{l}_{\text {ff }}$ |  | MIN | 2.0 V | 0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V$ on |  | MIN | 0.8 V | 0.8 V | 150 mA |  | 0.35 | 0.5 | V |  |
|  |  |  | MIN | 0.8 V | 0.8 V | 300 mA |  | 0.5 | 0.7 | $V$ |  |
| Diode Leakage Current | ILK | NOM | NOM | 0 V | 0 V | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V ${ }_{\text {d }}$ | NOM | NOM | $V_{C C}$ | $V_{\text {cc }}$ |  |  | 1.5 | 1.75 | $V$ | 4 |
| "1" Level Supply Current | $\mathrm{ICC}(1)$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 16 | 25 | mA | 1,2 |
| "0" Level Supply Current | Icc(0) | NOM | MAX | 0 V | 0 V |  |  | 72 | 100 | mA | 1,2 |



## Type UDN-5706A Quad AND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | Ioff |  | MIN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V_{\text {on }}$ |  | MIN | 0.8 V | $V_{\text {cc }}$ | 150 mA |  | 0.35 | 0.5 | $V$ |  |
|  |  |  | MIN | 0.8 V | VCC | 300 mA |  | 0.5 | 0.7 | $V$ |  |
| Diode Leakage Current | ILK | NOM | NOM | 0 V | OV | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | VCC | VCC |  |  | 1.5 | 1.75 | $V$ | 4 |
| "1" Level Supply Current | $I_{C C}(1)$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 16 | 24 | mA | 1,2 |
| " 0 " Level Supply Current | $\mathrm{ICCl}(0)$ | NOM | MAX | 0 V | OV |  |  | 70 | 98 | mA | 1,2 |



1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $\mathrm{I}_{\mathrm{f}}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

Type UDN-5707A Quad NAND Driver
ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{c c}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | Ioff |  | MIN | 0.8 V | $V_{\text {cc }}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | $V_{C C}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 2.0 V | 2.0 V | 150 mA |  | 0.35 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 300 mA |  | 0.5 | 0.7 | V |  |
| Diode Leakage Current | ILK | NOM | NOM | VCC | VCC | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | $V_{D}$ | NOM | NOM | 0 V | 0 V |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | 0 V | 0 V |  |  | 24 | 30 | mA | 1,2 |
| "0" Level Supply Current | $\mathrm{ICC}(0)$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 80 | 106 | mA | 1,2 |



Type UDN-5733A Quad NOR Driver
ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 0 " Output Voltage | Von |  | MIN | 2.0 V | 0 V | 150 mA |  | 0.35 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | OV | 300 mA |  | 0.5 | 0.7 | $V$ |  |
| Diode Leakage Current | ILK | NOM | NOM | Vcc | $V_{\text {cc }}$ | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | OV | 0 V | $\cdots$ |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | Icc(1) | NOM | MAX | 0 V | 0 V |  |  | 24 | 30 | mA | 1,2 |
| "0" Level Supply Current | Icc(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 80 | 100 | mA | 1,2 |



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min). }}$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

# SERIES UDN-5700M <br> DUAL PERIPHERAL AND POWER DRIVERS 

## -Transient-Protected Outputs

## FEATURES

- Four Logic Types
- DTL/TL/PMOS/CMOS Compatible Inputs
- Low Input Current
- 300 mA Continuous Output Current
- Standoff Voltage of 80 V


## Description

THESE MINI-DIP dual peripheral and power drivers are bipolar monolithic integrated circuits incorporating AND, NAND, OR, or NOR logic gates, high-current switching transistors, and transient-suppression diodes on the same chip. The two output transistors are capable of simultaneously sinking 300 mA continuously at ambient temperatures of up to $+70^{\circ} \mathrm{C}$. In the OFF state, these drivers will withstand at least 80 V .

## Applications

Series UDN-5700M dual drivers are ideally suited for interface between low-level or high-level logic and high-current/high-voltage loads. Typical applications include driving peripheral loads such as incandescent lamps, light-emitting diodes, memories, and heaters with a load current of up to 600 mA .

The integral transientsuppression diodes allow the use of these drivers with inductive loads such as relays, solenoids, or stepping motors without the need for discrete diodes. When not required for transient suppression, the diode-common bus can be used for the "lamp test'" function.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$. ..... 7.0 V
Input Voltage, $\mathrm{V}_{\mathbb{N}}$ ..... 30 V
Output Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Output On-State Sink Current, I ${ }_{\text {ON }}$ ..... 600 mA
Suppression Diode Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Suppression Diode On-State Current, $\mathrm{I}_{\mathrm{ON}}$ ..... 600 mA
Power Dissipation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{D}}$ ..... 1.5 W
Each Driver ..... 0.8 W
Derating Factor ..... $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ or $80^{\circ} \mathrm{C} / \mathrm{W}$
Operating Free-Air Temperature Range, $T_{A}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage $\left(\mathrm{V}_{\mathrm{cc}}\right):$ | 4.75 | 5.0 | 5.25 | V |
| Operating Temperature Range | 0 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) |  |  | 300 | mA |

INPUT PULSE CHARACTERISTICS

| $V_{\text {in }(0)}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~S}$ |
| :--- | :--- | :---: |
| $\mathrm{~V}_{\text {in }(1)}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{r}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $\mathrm{V}_{\mathrm{cc}}$ | Driven Input | $\begin{aligned} & \text { Other } \\ & \text { Input } \end{aligned}$ | Output | Min. | Typ. | Max. | Units |  |
| " 1 " Input Voltage | $\mathrm{V}_{\text {in( } 1 \text { ) }}$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {in(0) }}$ |  | MIN |  |  |  |  |  | 0.8 | V |  |
| "0" Input Current at all Inputs except Strobe | $\mathrm{I}_{\text {in }(0)}$ |  | MAX | 0.4 V | 30 V |  |  | -50 | -100 | $\mu \mathrm{A}$ | 2 |
| " 0 " Input Current at Strobe | $1{ }_{\text {in }(0)}$ |  | MAX | 0.4 V | 30 V |  |  | -100 | -200 | $\mu \mathrm{A}$ |  |
| " 1 " Input Current at all Inputs except Strobe | $\operatorname{lin}(1)$ |  | MAX | 30 V | 0 V |  |  |  | 10 | $\mu \mathrm{A}$ | 2 |
| "1" Input Current at Strobe | $\operatorname{lin}(1)$ |  | MAX | 30 V | OV |  |  |  | 20 | $\mu \mathrm{A}$ |  |
| Input Clamp Voltage | $V_{1}$ |  | MIN | $-12 \mathrm{~mA}$ |  |  |  |  | -1.5 | V |  |

## SWITCHING CHARACTERISTICS at $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time | $\mathrm{t}_{\mathrm{pd} 0}$ | $\begin{aligned} & V_{S}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & C_{L}=15 \mathrm{pF} \end{aligned}$ |  | 200 | 500 | ns | 3 |
| Turn-off Delay Time | $t_{p d 1}$ | $\begin{aligned} & V_{S}=70 V_{1} R_{L}=465 \Omega \text { (10 Watts) } \\ & C_{L}=15 \mathrm{pF} \end{aligned}$ |  | 300 | 750 | ns | 3 |

NOTES:

1. Typical values are at $\mathrm{V}_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each input tested separately.
3. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.
4. Capacitance values specified include probe and test fixture capacitance.

## Type UDN-57IIM Dual AND Driver

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{C C}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 0.8 V | $V_{\text {cc }}$ | 150 mA |  | 0.35 | 0.5 | V |  |
|  |  |  | MIN | 0.8 V | $V_{C C}$ | 300 mA |  | 0.5 | 0.7 | V |  |
| Diode Leakage Current | luk | NOM | NOM | 0 V | OV | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | $\mathrm{V}_{\mathrm{CC}}$ | VCC |  |  | 1.5 | 1.75 | $V$ | 4 |
| "1" Level Supply Current | $l_{\text {cC(1) }}$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 8.0 | 12 | mA | 1,2 |
| "0" Level Supply Current | $\operatorname{ICC}(0)$ | NOM | MAX | OV | 0 V |  |  | 35 | 49 | mA | 1,2 |



## Type UDN-5712M Dual NAND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $\cdot^{-} \mathrm{Cc}$ | Driven Input | Other Input | Output | Min. | Typ, | Max. | Units |  |
| " 1 " Output Reverse Current | $l_{\text {off }}$ |  | MIN | 0.8 V | $V_{\text {cc }}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V_{\text {on }}$ |  | MIN | 2.0 V | 2.0 V | 150 mA |  | 0.35 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 300 mA |  | 0.5 | 0.7 | V |  |
| Diode Leakage Current | ILK | NOM | NOM | $V_{\text {cc }}$ | $V_{\text {cc }}$ | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | $V_{D}$ | NOM | NOM | OV | OV |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | $I_{\text {cl(1) }}$ | NOM | MAX | 0 V | 0 V |  |  | 12 | 15 | mA | 1,2 |
| "0" Level Supply Current | Icc(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 40 | 53 | mA | 1,2 |



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$
5. Capacitance values specified include probe and test fixture capacitance.

SERIES UDN-5700M
DUAL PERIPHERAL AND POWER DRIVERS

## Type UDN-5713M Dual OR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)



## Type UDN-5714M Dual NOR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $\mathrm{I}_{\mathrm{f}}=300 \mathrm{~mA}$
5. Capacitance values specified include probe and test fixture capacitance.

# UDN-5722M DUAL PERIPHERAL AND POWER DRIVER - Transient-Protected Outputs 

## FEATURES

- DTLTTL/PMOS/CMOS Compatible Inputs
- Low Input Current
- 350 mA Continuous Output Current
- 70 V Output Standoff Voltage
- Low Supply-Current Requirement
- Direct Replacement For SN75477
frame for enhanced package power dissipation ratings.

The dual driver is ideally suited for interface between low-level logic and high-current inductive loads. Internal transient-suppression diodes allow the use of this driver with stepping motors, relays, or solenoids. Additional non-inductive applications include driving peripheral loads such as light-emitting diodes, memories, heaters, and incandescent lamps with peak load currents of up to 600 mA . When not required for transient suppression, the diode common bus can be used to perform the "lamp test'" function. The outputs may be paralleled for higher load-current capability.

$\mathrm{T}^{\mathrm{H}}$HIS PERIPHERAL AND POWER DRIVER combines dual AND logic gates, high-current switching transistors, and transient-suppression diodes in a bipolar monolithic integrated circuit that meets interface requirements beyond the capabilities of standard logic buffers.

The two output transistors are capable of simultaneously sinking 350 mA continuously at ambient temperatures of up to $+85^{\circ} \mathrm{C}$. In the OFF state, the drivers will withstand at least 70 V .

Type UDN-5722M is supplied in a miniature 8 -pin dual in-line plastic package with a copper lead


## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ ..... 15 V
Input Voltage, $\mathrm{V}_{\mathbb{I}}$ ..... 30 V
Output Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 70 V
Output On-State Sink Current, $\mathrm{I}_{\text {O }}$ ..... 600 mA
Suppression Diode Off-State Voltage, $\mathrm{V}_{\text {ofF }}$ ..... 70 V
Suppression Diode On-State Current, $\mathrm{I}_{\mathrm{ON}}$ ..... 600 mA
Power Dissipation at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{D}}$ ..... 1.5 W* $^{*}$
Operating Free-Air Temperature Range, $T_{A}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ ..... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
${ }^{*}$ Derate at the rate of $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

## RECOMMENDED OPERATING CONDITIONS

| Operating Condition | Min. | Nom. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage $\left(V_{c c}\right)$ | 4.75 | - | 12.6 | V |
| Operating Temperature Range | 0 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) | - | - | 350 | mA |

ELECTRICAL CHARACTERISTICS over recommended operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Input Voltage | $V_{\text {IN(1) }}$ | - | Min. | - | - | - | 2.0 | - | - | V | - |
| " 0 " Input Voltage | $V_{\text {IN(0) }}$ | - | Min. | - | - | - | - | - | 0.8 | V | - |
| " 0 " Input Current at All Inputs Except Strobe | $\mathrm{I}_{\text {IN(0) }}$ | - | Max. | 0.4 V | 30 V | - | - | -5.0 | -10 | $\mu \mathrm{A}$ | 4 |
| "0" Input Current at Strobe | $\mathrm{I}_{1 \times(0)}$ | - | Max. | 0.4 V | 30 V | - | - | -10 | -20 | $\mu \mathrm{A}$ | - |
| " 1 " Input Current at All Inputs Except Strobe | $\mathrm{I}_{\text {(1) }}$ | - | Max. | 30 V | OV | - | - | 5.0 | 10 | $\mu \mathrm{A}$ | 4 |
| "1" Input Current at Strobe | $\mathrm{I}_{\text {(N(1) }}$ | - | Max. | 30 V | 0 V | - | - | 10 | 20 | $\mu \mathrm{A}$ | - |
| Input Clamp Voltage | $V_{\text {CLAMP }}$ | - | Min. | $-12 \mathrm{~mA}$ | - | - | - | - | -1.5 | $V$ | - |
| "1" Output Reverse Current | $\mathrm{I}_{\text {OFF }}$ | - | Min. | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 70 V | - | - | 100 | $\mu \mathrm{A}$ | - |
|  |  | - | Open | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 70 V | - | - | 100 | $\mu \mathrm{A}$ | - |
| "0" Output Voltage | $V_{\text {on }}$ | - | Min. | 2.0 V | 2.0 V | 200 mA | - | 0.4 | 0.6 | $V$ | - |
|  |  | - | Min. | 2.0 V | 2.0 V | 350 mA | - | 0.6 | 0.8 | $V$ | - |
| Diode Leakage Current | $\mathrm{I}_{\text {R }}$ | Nom. | 5.0 | $\mathrm{V}_{\text {cc }}$ | $V_{c c}$ | Open | - | - | 200 | $\mu \mathrm{A}$ | 2 |
| Diode Forward Voltage Drop | $V_{\text {F }}$ | Nom. | 5.0 | 0 V | OV | - | - | 1.5 | 1.75 | $V$ | 3 |
| "1" Level Supply Current | $I_{\text {cc(1) }}$ | Nom. | 5.25 | OV | OV | - | - | 1.0 | 3.0 | mA | 1 |
|  |  |  | 12.6 | 0 V | OV | - | - | 2.6 | 5.0 | mA | 1 |
| "0" Level Supply Current | $\mathrm{I}_{\text {cc(0) }}$ | Nom. | 5.25 | 5.0 V | 5.0 V | - | - | 11 | 17 | mA | 1 |
|  |  |  | 12.6 | 5.0 V | 5.0 V | - | - | 35 | 50 | mA | 1 |

## NOTES:

1. Per package.
2. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\text {off(Min). }}$.
3. Diode forward voltage drop measured at $I_{\mathrm{F}}=300 \mathrm{~mA}$.
4. Each input tested separately.

## SWITCHING TEST CIRCUIT



SWITCHING CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {CC }}=5.0 \mathrm{~V}$
Input-Pulse Characteristics

| $V_{\text {in(0) }}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~s}$ |
| :--- | :--- | :---: |
| $V_{\text {in(1) }}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{t}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |


| Characteristic | Symbol | Test Conditions | Limits |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |  |
| Turn-on Delay Time | $\mathrm{t}_{\text {pd(0) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=30 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega(10 \mathrm{~W}) \\ & \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF} \end{aligned}$ | - | 500 | ns | 1,2 |
| Turn-off Delay Time | $\mathrm{t}_{\mathrm{pd}(1)}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=30 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega(10 \mathrm{~W}) \\ & \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF} \end{aligned}$ | - | 750 | ns | 1,2 |

NOTES:

1. Capacitance values specified include probe and test fixture capacitance.
2. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.

## INPUT/OUTPUT WAVEFORMS



# UDN-5732M AND UDN-5742M DUAL PERIPHERAL AND POWER DRIVERS -Transient-Protected Outputs 

## FEATURES

- DDLTTL/PMOS/CMOS Compatible Inputs
- Low Input Current
- Continuous Output Current to 600 mA
- 70 V Output Standoff Voltage

INCORPORATING logic gates, high-current saturated output transistors, and transient-suppression diodes, Type UDN-5732M and UDN-5742M dual peripheral and power drivers meet interface requirements well beyond the capabilities of standard logic buffers.


The output transistors can each sink 425 mA continuously at ambient temperatures of up to $+70^{\circ} \mathrm{C}$. Reduced ambient temperatures or duty cycles permit increased load currents of up to 500 mA (UDN5723 M ) or 600 mA (UDN-5742M) with miminum saturation voltages. In the OFF state, the drivers will withstand at least 70 V .

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{\text {cc }}$ ..... 7.0 V
Input Voltage, $V_{I N}$ ..... 30 V
Output OFF-State Voltage, Voff ..... 70 V
Output ON-State Sink Current, IoN (UDN-5732M) ..... 600 mA
(UDN-5742M) ..... 700 mA
Suppression Diode OFF-State Voltage, $\mathrm{V}_{\text {of }}$ ..... 70 V
Suppression Diode ON-State Current, Io (UDN-5732M) ..... 600 mA
(UDN-5742M) ..... 700 mA
Allowable Package Power Dissipation, $P_{D}$ ..... $1.5 \mathrm{~W}^{*}$
Operating Free-Air Temperature Range, $T_{A}$ ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$*Derate at the rate of $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

## RECOMMENDED OPERATING CONDITIONS

| Operating Condition | Min. | Nom. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage, $V_{\text {cc }}$ | 4.75 | 5.00 | 5.25 | V |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | 0 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Output Sink Current, UDN-5732M | - | - | 500 | mA |
| Output Sink Current, UDN-5742M | - | - | 600 | mA |

## ELECTRICAL CHARACTERISTICS over recommended operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{c c}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Input Voltage | $V_{\text {IN(1) }}$ | - | Min. | - | - | - | 2.0 | - | - | V | - |
| "0" Input Voltage | $V_{\text {IV(0) }}$ | - | Min. | - | - | - | - | - | 0.8 | V | - |
| "0" Input Current at All Inputs Except Strobe | $I_{\text {IN(0) }}$ | - | Max. | 0.4 V | 30 V | - | - | -50 | -100 | $\mu \mathrm{A}$ | 4 |
| "0" Input Current at Strobe | $\mathrm{I}_{\text {INO) }}$ | - | Max. | 0.4 V | 30 V | - | - | -100 | -200 | $\mu \mathrm{A}$ | - |
| " 1 " Input Current at All Input Except Strobe | $\mathrm{I}_{\text {N(1) }}$ | - | Max. | 30 V | OV | - | - | 5.0 | 10 | $\mu A$ | 4 |
| "1" Input Current at Strobe | $\mathrm{I}_{\text {(W1) }}$ | - | Max. | 30 V | OV | - | - | 10 | 20 | $\mu \mathrm{A}$ |  |
| Input Clamp Voltage | $\mathrm{V}_{\text {CLIMP }}$ | - | Min. | -12mA | - | - | - | - | -1.5 | $V$ | - |
| "1" Output Reverse Current | $\mathrm{I}_{\text {Off }}$ | - | Min. | 0.8 V | $V_{c c}$ | 70 V | - | - | 100 | $\mu \mathrm{A}$ | - |
|  |  | - | Open | 0.8 V | $V_{c c}$ | 70 V | - | - | 100 | $\mu \mathrm{A}$ | - |
| "0" Output Voltage | $V_{\text {ON }}$ | - | Min. | 2.0 V | 2.0 V | 300 mA | - | 0.3 | 0.6 | $V$ | - |
|  |  | - | Min. | 2.0 V | 2.0 V | 500 mA | - | 0.5 | 0.8 | $V$ | - |
|  |  | - | Min. | 2.0 V | 2.0 V | 600 mA | - | 0.7 | 1.0 | $V$ | 5 |
| Diode Leakage Current | $\mathrm{I}_{\text {R }}$ | Nom. | 5.0 | $V_{c c}$ | $\mathrm{V}_{\text {cc }}$ | Open | - | - | 100 | $\mu \mathrm{A}$ | 2 |
| Diode Forward Voltage Drop | $V_{\text {F }}$ | Nom. | 5.0 | OV | OV | - | - | 1.5 | 2.0 | $V$ | 3 |
| "1" Level Supply Current | $\mathrm{I}_{\text {c(1) }}$ | Nom. | 5.25 | OV | OV | - | - | 8.0 | 17 | mA | 1 |
| "0" Level Supply Current | $\mathrm{I}_{\text {cc(0) }}$ | Nom. | 5.25 | 5.0 V | 5.0 V | - | - | 50 | 75 | mA | 1 |

NOTES:

1. Per package.
2. Diode leakage current measured at $V_{R}=70 \mathrm{~V}$.
3. Diode forward voltage drop measured at $\mathrm{I}_{\mathrm{F}}=500 \mathrm{~mA}$ (UDN-5732M) or 600 mA (UDN-5742M).
4. Each input tested separately.
5. Type UDN-5742M only.

## SWITCHING TEST CIRCUIT



## SWITCHING CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$

Input-Pulse Characteristics

| $V_{\text {in(0) }}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~S}$ |
| ---: | :--- | ---: |
| $\mathrm{~V}_{\text {in(1) }}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{r}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |



NOTES:

1. Capacitance values specified include probe and test fixture capacitance.
2. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.

## INPUT/OUTPUT WAVEFORMS



# SERIES ULN-2000A DARLINGTON TRANSISTOR ARRAYS* <br> <br> -Description and Application 

 <br> <br> -Description and Application}

## Introduction

The increased use of electronic circuits in systems formerly built with mechanical, electro-mechanical, or hydraulic components has resulted in systems becoming more precise, more reliable, generally less expensive, smaller, more efficient, and faster. Although the drive capabilities of monolithic integrated logic circuits are adequate for most information processing applications, there now exists a large and rapidly growing number of system applications where the currentcarrying and/or voltage-sustaining capability of the integrated circuit logic is inadequate. Typically, these deficiencies arise when the logic must control such peripheral components as relays, solenoids, punches, stepping motors, and a variety of indicators (incandescent, LED, or gas discharge lamps and displays).

A very common solution to this output interface inadequacy has been the addition of discrete power transistors (or SCRs) and associated passive components to the logic output in order to obtain the necessary current and/or voltage capability. Although this provides a very satisfactory electrical solution, the large number of discrete components often required, high assembly labor costs, and space (packaging) limitations often mean additional problems and cost. A simple, and less expensive solution is the use of monolithic integrated circuits.

The Series ULN-2000A is comprised of four different high-voltage/high-current interface circuits. They are capable of controlling resistive, inductive, or tungsten filament loads of up to 125 watts and are compatible with all standard digital logic families (DTL, TTL, PMOS, and CMOS) without the need for additional discrete components.

High-Voltage and High-Current Capability
A large number of interface problems have been simplified by the Series ULN-2000A high-voltage, high-current Darlington transistor arrays. These devices are suitable for voltage, current, and gain levels beyond the limits of other monolithic buffers and arrays.

The four devices in the ULN-2000A series are all comprised of seven silicon NPN Darlington pairs on a common monolithic substrate. All units feature open collector outputs and integral suppression diodes for use with inductive loads.

All devices have an output sink current capability of 500 mA although peak inrush currents to 600 mA are permissible, making them ideal for use with tungsten filament lamps. All of the outputs will sustain "OFF" voltages of at least 50 volts. Each individual Darlington circuit may therefore switch up to 25 watts ( 50 V at 500 mA ).

A definite asset of monolithic device technology is the very fine match between adjacent outputs when used in parallel. Applications requiring a sink current beyond the capability of a single output can be accommodated by parallel outputs. Continuous operation of all outputs at the maximum rated current is not allowed because of power dissipation limitations imposed by the package. However, as illustrated in Figure 1 , under certain conditions, the Series ULN-2000A Darlington arrays are capable of switching loads totaling more than 125 watts at an ambient temperature of $+70^{\circ} \mathrm{C}$.

[^21]Figure 1

## COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE AND NUMBER OF OUTPUTS




Dwo. no. 4-9753

Figure 2

## ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF AMBIENT TEMPERATURE

## The Basic Darlington Array

The first, and basic array, in this series, is the Type ULN-2001A. This is a general-purpose version with input current limiting normally accomplished via the use of an appropriate discrete resistor connected in series with each input. It is also possible to utilize the intrinsic current limiting of many MOS outputs as shown in Figure 4; a typical P-channel characteristic.

The use of TTL in such a manner is not recommended due to the higher currents and resultant high level of package power dissipation. Outputs of most PMOS and CMOS circuits will not normally source currents of any significance due to their high source impedance.


DWG. NO. A-9595
(each driver)
Figure 3
TYPE ULN-2001A SCHEMATIC

## 14 to 25 Volts PMOS Applications

The Type ULN-2002A Darlington array was specifically designed for use with 14 to 25 volt PMOS devices. Each input has a 7 V Zener diode and a 10,500 ohm resistor (nominal values) to limit the input current to within the capability of most PMOS of the type specified. The basic circuit diagram is shown in Figure 5 with a typical application. Note that there are no pull-down resistors or other external discrete components necessary. The incorporation of the Zener diode also results in excellent noise immunity for this array.

## TTL and CMOS INTERFACE

The ULN-2001A and ULN-2002A allow only a limited number of input options. Shown in Figure 6 is the basic circuit diagram of the Type ULN-2003A. This device has a series base input resistor to each Darlington pair, and thus allows operation directly with TTL or CMOS logic operating at a supply voltage of 5 V (or $12 \mathrm{~V} \mathrm{CMOS} \mathrm{using} \mathrm{FET} \mathrm{characteristics)}$.

A guarantee of 200 mA output sink current capability (saturated) is provided with the worse case TTL logic 1 level of 2.4 volts. Low-power Schottky-clamped TTL logic is generally specified to have a minimum Vout of 2.7 volts. The ULN-2003A is guaranteed to sink 250 mA under this input condition. With the more typical input of 3 volts, the ULN-2003A Darlington pair will sink at least 300 mA in the "ON" state.


Figure 4
TYPICAL P-CHANNEL
drain characteristic


Figure 5
TYPE ULN-2002A SCHEMATIC AND APPLICATION

TTL totem pole outputs are not specified between the $400 \mu \mathrm{~A}$ logic 1 fanout condition and the maximum output short-circuit current ( 20 to 55 mA for the 7400 series). Between these rather wide limits lies the required ULN-2003A input current. The maximum Type ULN-2003A input current level is specified at 1.35 mA at the extrapolated TTL maximum logic 1 level of 3.85 V .

The ULN-2003A Darlington array will handle a great many interface needs - particularly those beyond the capabilities of TTL buffers. Also shown in Figure 6, is a typical application of the ULN-2003A Darlington array. Of particular interest in this application is an unusual use of the transient-suppression diodes for a non-inductive load. The lamp test feature can of course be used with any of the devices in this series.


Figure 6
TYPE ULN-2003A SCHEMATIC AND APPLICATION

The diodes are designed to handle the same current and voltages as the output transistors. Switching can be accomplished through an ordinary switch or an appropriate power transistor. With the standard $+70^{\circ} \mathrm{C}$ ambient and the most widely used lamps (No. 327 or No. 387 lamps) there is no problem with continuous operation.

## 6 to 15 Volt CMOS or PMOS Applications

The Type ULN-2004A Darlington array has an appropriate series input resistor (nominally $10.5 \mathrm{k} \Omega$ ) to allow its operation directly from CMOS or PMOS logic outputs utilizing supply voltages of between 6 and 15 V .

Shown in Figure 7 is a typical application of this array. Although the discrete output buffer could be used to increase the output capability of any of the devices in this series, this is most often done by paralleling outputs as was described earlier.


Figure 7
Type ULN-2004A SCHEMATIC AND APPLICATION

## Input Current

The Darlington collector current (output in saturation) at an ambient temperature of $+25^{\circ} \mathrm{C}$, for any input current is the same for all four devices in this series and is shown in the graph of Figure 8. More accurately, the maximum input current for any collector current is described by the equation:

$$
I_{\mathbb{N}(\mu A)}=I_{C(m A)}+140 \mu \mathrm{~A}
$$

where $I_{I N}$ is the input current in microamperes, $I_{C}$ is the collector current in milliamperes, and the figure 140 represents the maximum shunt current through the emitter-base resistors. The typical input current can be described as:

$$
I_{\mathbb{N}(\mu)}=0.58 I_{C(m A)}+110 \mu \mathrm{~A}
$$

where the figure 0.58 is an adjustment for the typical Darlington current gain and the figure 110 represents the typical shunt current.


Figure 8
COLLECTOR CURRENT AS A FUNCTION OF INPUT CURRENT

The input current as a function of input voltage is shown in Figure 9 for the ULN-2002A, ULN-2003A, and the ULN-2004A. The Type ULN-2001A Darlington array is not shown since input current is more a function of the external circuitry. Systems utilizing either CMOS or PMOS logic should be evaluated for intrinsic current limiting as was shown in Figure 4.




Figure 9
INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE

## Low Available Drive Current Operation

Occasionally, applications featuring minimum available input drive current and a high output load current have shown the Type ULN-2003A and ULN-2004A Darlington arrays to be inadequate for the particular requirement under worst case conditions. This usually results from the restricted drive current available from a TTL or CMOS gate operating from a nominal supply of 5 volts.

Under worst case conditions with a low logic 1 voltage ( 2.4 V ), and a high input resistor value ( $3.51 \mathrm{k} \Omega$ ), the available load current is reduced to only 145 mA . Compounding this problem would be the effect that a high drive current requirement would have on the logic output voltage since that is normally specified at only $400 \mu \mathrm{~A}$. If the gate output is connected to additional logic elements, a minimum logic 1 voltage of 2.0 V must be maintained and at that level the worst case Darlington load current would be reduced to only 31 mA !

A simple solution to this problem is through the use of inexpensive pull-up resistors as shown in Figure 10. The minimum resistor value is determined by the maximum allowable sink current ( 16 mA for TTL, $360 \mu$ A for CMOS), the minimum logic 0 output voltage, and the maximum supply voltage as per the following equation:

$$
R_{P} \geq \frac{V_{s}-V_{\text {out(0) }}}{\text { Iout }}
$$

For standard TTL, the minimum value for $R_{p}$ is about $316 \Omega$ with values between $3000 \Omega$ and $5000 \Omega$ being used customarily. Multiple pull-up resistors in a single in-line package are shown in Sprague Engineering Bulletin No. 7041; resistors in a dual in-line package are shown in Bulletin No. 7042.

## Conclusion

Since the Series ULN-2000A high-voltage, highcurrent Darlington transistor arrays are quite conservatively designed, the basic product is fully capable of being ordered to higher voltages and/or higher currents than the standard specifications. Presently, parts are available to withstand up to 95 volts on the output. Parts with this higher voltage rating would create a potential for switching loads far in excess of 125 watts! Aside from the higher power handling capability, the higher voltage rating is required for driving plasma or gas-discharge displays.


Figure 10
USE OF PULL-UP RESISTORS TO INCREASE DRIVE CURRENT

Although not intended for high power applications, there is also available a Series ULS-2000H with hermetic sealing and an operating temperature range to $+125^{\circ} \mathrm{C}$. These parts are recommended for military and aerospace applications as well as commercial and industrial control applications where severe environments may be encountered.

Cer-DIP, industrial-grade hermetic devices, Series ULQ-2000R, are rated for use over the temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, permitting their use in commercial and industrial applications requiring a moderate package power dissipation ( 1 W at $\mathrm{T}_{\mathrm{A}}=$ $+85^{\circ} \mathrm{C}$ ).

All of these Darlington transistor arrays offer a common solution to a great many interface needs. The minimal component count and straightforward printed wiring board layout offer benefits in cost reduction, simplicity of board layout, and savings in space. Other benefits are a reduction in insertion costs, and lower handling and inventory costs than other alternatives. Cost benefits from some of these factors are not very tangible. However, fewer components, less complex boards, etc. usually result in lower system manufacturing costs.

## INTERFACE IC MOTOR DRIVE APPLICATIONS

THE INCORPORATION OF LOGIC systems and power drivers into a monolithic integrated circuit requires special skill and experience. Sprague Electric Company has developed such skill, and has long been a leader in solid-state interface technology and devices.

Improved systems reliability and performance, lower component counts, space savings
and cost economy are some of the benefits to be derived from the use of Sprague Interface ICs. An increasing number of these Sprague devices are especially designed for or are easily adapted to motor drive applications. The availability of these devices is especially significant in view of the increasing use of microprocessor-based controls for servo and stepper motors.

## UCN-4202A STEPPER MOTOR TRANSLATOR/DRIVER

THE UCN-4202A will drive permanent magnet (PM) stepper motors rated to 500 mA and 15 V with a minimum of external components required, or, the device may be used as a logic translator to drive discrete high-power transistors or the Sprague UDN-2949Z HalfBridge Motor Driver.
With the MONOSTABLE RC timing pin (Pin 11) tied to $\mathrm{V}_{\mathrm{CC}}$ (Pin 16) the circuit performs a full-step function. States B and D are stationary states and a separate input pulse is required to move through each of four output states.
The UCN-4202A internal step logic activates one of four output sink drivers to step the load from one position to the next. The logic is activated when the STEP INPUT (Pin 10) is pulled low for at least $1 \mu \mathrm{~s}$ and then allowed to return high. The sequence of states is determined by the DIRECTION CONTROL (Pin 12), either A-B-C-D, or A-D-C-B.
In the double-step mode states B and D are transition states with durations determined by the MONOSTABLE RC timing (Pin 11). Improved motor torque is obtained at double the nominal motor step angle, and motor stability is improved for high step rates.

## RECOMMENDED MAX. OPERATING CONDITIONS


Output Current, I Iout . . . . . . . . . . . . . . . . . . . . . . 500 mA

Supply Voltage, $\mathrm{V}_{\mathrm{k}} \ldots . . . . . . . . . . . . . . . . . . . . . . . . . .13 .5 \mathrm{~V}$


FULL-STEP MODE



Dwg. No. A-11, 187

## L/R DRIVE CIRCUIT

Used to Drive A 12-Volt
500 mA Unipolar Stepper Motor (Double-Step Mode)

## TYPICAL A-C MOTOR APPLICATION



Dwa. No. B-1447

## UDN-2949Z HIGH-CURRENT BIPOLAR HALF-BRIDGE MOTOR DRIVER

THE UDN-2949Z is a monolithic half-bridge motor driver supplied in a power tab T0-220 style package. The circuit combines sink and source drivers with diode protection, gain and level shifting systems, and a voltage regulator for single-supply operation. The unit is specifically designed for servo motor drive applications using pulse width modulation (chopping).

The chopper drive mode is characterized by a minimum power dissipation requirement while allowing the output to switch currents of 2 amperes. Output d-c current accuracies of better than $10 \%$ at 100 kHz can be obtained.

The UDN-2949Z may be used in pairs (fullbridge) for d-c stepper motor or brushless d-c motor drive applications. High load currents or step rates will usually require an external ground clamp diode (1N4000) connected at the output of each device.

The UDN-2949Z power driver may be also be used in stepper motor bipolar bridge drive circuits for example, with the Sprague UCN-4202A Stepper Motor Translator/Driver, as shown.

RECOMMENDED MAX. OPERATING CONDITIONS
Supply Voltage Range, V $\ldots \ldots .$.
Input Voltage, $\mathrm{V}_{\mathrm{IN}}$.................................. 5.5 V
Continuous Output Current, Iout $\ldots \ldots . . . . . . . . . . . . . .2 .0 \mathrm{~A}$


FULL-BRIDGE D.C SERVO MOTOR APPLICATION


Dwg. No. A-11, 181 A


DWG.NO. A-11,241

## TYPICAL 3-PHASE BRUSHLESS D.C MOTOR DRIVE



## ULN-3701Z and ULN-3702Z HIGH-CURRENT DRIVERS

THESE HIGH-CURRENT drivers are suitable for driving d-c motors rated to $\pm 2.5 \mathrm{~A}$ and 18 $\mathbf{V}$ with minimum external components. Internal voltage, current, and temperature shut-down circuitry protect these devices under the most severe operating conditions. The ULN-3702Z does not include the high-voltage shutdown, allowing operation with supply voltages up to 28 V. The high-gain, high-impedance operational amplifier configuration allows many specialized input, output, and feedback arrangements.


## SERIES ULN-2800A DARLINGTON ARRAYS and SERIES UDN-2980A HIGH-CURRENT SOURCE DRIVERS

THE COMBINATION of separate 8 -channel source and sink driver ICs provides a single or twin motor drive interface solution for "crossover" currents which may occur during switching transitions. No timing provisions are necessary provided the external resistance limits "crossover" currents to the maximum specified for the ICs $( \pm 500 \mathrm{~mA})$.

Flyback voltage should not exceed the recommended $\mathrm{V}_{\mathrm{S}}$ level ( +35 V or +50 V ). With a UDN-2982A/ULN-2803A combination and a +24 V supply the flyback voltage should not exceed $+35 \mathrm{~V}\left[\mathrm{~V}_{\mathrm{S}}(\right.$ max $)+\mathrm{V}_{\text {Zener }}(\max )+$ $\mathrm{V}_{\text {clamp }}(\max ) \leq 35 \mathrm{~V}$ ].

Single motor drives may be accomodated by paralleling both inputs and outputs of each IC
(max $\mathrm{I}_{\mathrm{OUT}}= \pm 1.0 \mathrm{~A} ;$ DIP rating allows $\approx 350$ mA max).

Stepper motor bridge driver circuits using techniques such as that illustrated below should achieve greater reliability and space economy, cost reduction and improved performance.

RECOMMENDED MAX. OPERATING CONDITIONS
Supply Voltage, Vs
UDN-2982A and ULN-2803A . . . . . . . . . . . . . . . 35 V
UDN-2984A and ULN-2823A . . . . . . . . . . . . . . . . 50 V
Peak Output ( 100 ms ), Iop . . . . . . . . . . . . . . . $\pm 350 \mathrm{~mA}$
Continuous Output Current, I Iour
Single Motor . . . . . . . . . . . . . . . . . . . . . $\pm 300 \mathrm{~mA}$
Independent Operation Twin Motors . . . . . . $\pm 300 \mathrm{~mA}$
Simultaneous Operation Twin Motors ..... $\pm 150 \mathrm{~mA}$

UDN-2982A and ULN-2803A Twin Motor Combination


## UDN-2580A SOURCE DRIVER

THE UDN-2580A SOURCE DRIVER serves as a direct interface from the Cybernetic Micro Systems CY500 Motor Controller, utilizing paralleled inputs and outputs. This IC is most useful with supplies of up to -35 V . A selected version (UDN-2580A-1) is available for operation to - 50 V .
recommended max. operating conditions

Output Current, I lout .......................... -350 mA
*Referenced to $-\mathrm{V}(+5 \mathrm{~V}$ and -30 V shown)


## UDN-2845B and UDN-2846B QUAD DRIVERS

THESE QUAD DRIVERS are designed to handle high current loads operating from negative supplies. The d-c motor interface shown uses external diodes for clamping and commutation. A $10 \mu \mathrm{~s}$ interval between input transistions is recommended to prevent "crossover' current damage to the IC.

RECOMMENDED MAX. OPERATING CONDITIONS

Output Current, Iout . . . . . . ........................... 1.5 A

Input Voltage, $\mathrm{V}_{1 \mathrm{~N}}$
UDN-2845B
. 5.0 V
UDN-2846B . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 12 V


## UCN-4401A and UCN-4801A BiMOS LATCH/DRIVERS

THESE HIGH-VOLTAGE, high-current latch/drivers are comprised of four or eight CMOS data latches, a Darlington transistor driver for each latch, and CMOS control circuitry for the common CLEAR, STROBE, and DUTY CYCLE CONTROL functions. Data bits can be sent to the latch/drivers at rates from 500 $\mathrm{kHz}\left(\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}\right)$ to $1 \mathrm{MHz}\left(\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}\right)$.

Microprocessor power can be utilized more effectively in motor drive systems incorporating UCN-4401A or UCN-4801A latch/drivers. The appropriate motor windings can be activated (usually at millisecond rates) while the microprocessor spends nearly $100 \%$ of its time performing other functions.

A full-step drive scheme implemented with the 4-latch UCN-4401A provides 350 mA for each output. The 8 -latch UCN-4801A may be used for systems operating more than one motor, with 300 mA available for each output.

RECOMMENDED MAX. OPERATING CONDITIONS

Output Current, lout ............................ 350 mA




Timing Conditions ( $\mathrm{V}_{\mathrm{DD}}=\mathbf{5 . 0} \mathrm{V}$ )


## EXPANDING THE FRONTIERS OF IC INTERFACE FOR ELECTRONIC DISPLAYS

## INTRODUCTION

The original monolithic high-voltage/high-current power drivers from Sprague were capable of sustaining 100 V and sinking load currents of 250 mA on each of four outputs. That 1970 peripheral driver capability has since been expanded and improved on to solve many of the most difficult display interfaces. Our newest devices are rated for operation to 130 V , sourcing or sinking to 1.5 A , and as many as eight drivers per package (not all together) with inputs for TTL, Schottky TTL, DTL, CMOS, and PMOS.

## LAMP (INCANDESCENT) INTERFACE

Utilizing marketing inputs that related to existing hybrid interface circuits, a group at Sprague designed and manufactured monolithic ICs which initially were largely used for aircraft indicator lamp interface. Although not widely known, these quad driver units were developed quite independently (and simultaneously) to the ubiquitous TI 75451 series of high-speed, low-voltage peripheral drivers. A concentration upon circuit design factors, improvements in DIP packaging (copper alloy lead frames), and tighter, tougher control of diffusion-related
parameters has allowed the manufacture of quad power drivers rather than the dual mini-DIPs offered by TI.

An increased awareness for improvements in reliability and space and power reductions provided a rather successful military market for Sprague lamp and relay interface; early success was evident in military aircraft indicator lamp interface, a tough application for TTL type ICs due to severe inrush currents resulting in secondary breakdown during "turn on". The increased current sinking capability of the Sprague ICs offers a solution to lamp interface that usually obviates the need for "warming" resistors (across the output) which slightly warm the lamp filament and thus minimize problems associated with cold lamp filaments.

The relay driver types of Sprague IC drivers (and other similar transient-protected ICs) are somewhat more useful than the so-called general purpose types, since the diode common terminal may be switched for a system lamp test. As shown in Figure 1, only a single connection to each DIP is required.


Figure 1

## HIGH-CURRENT INTERFACE DRIVERS (Continued)

The high current-sinking capability of the Sprague ICs allow such loads as the \#327 or \#387 lamps to be driven without difficulty of secondary breakdown. The device beta will usually not allow sinking of the 10 to 13 times (nominal value) inrush current of cold lamps; but the lamp rapidly reaches a current level within the device output limitations (Figure 2 shows current as a function of time for a single \#327 lamp). Sustaining this instantaneous inrush current and its peak power has been a key element in the success of many lamp interface circuits.

## GAS DISCHARGE DISPLAY ICs

Early in 1972, Sprague successfully produced its first high-voltage IC designed for gas discharge dis-plays-a five channel, 130 V unit for cathode (segment) interface. Subsequently, other circuits, both cathode and anode drivers, were produced; most of which were used in calculator applications with the Burroughs Panaplex ${ }^{\circledR}$ II. In Figure 3 is shown a display interface system utilizing the UHP-481 and UHP-491 display drivers, associated thick-film networks, and discretes. This was a step forward, but still required external discrete components.

Through a collaborative effort begun late in 1973 between Sprague Electric and Burroughs Corp. a newer, more efficient interface scheme evolved. Featured in "Electronic Displays '75," this series of monolithic IC interface devices for the high-voltage gas discharge panels has been one of the trailblazers in the world of display interface ICs. Intended for use in multiplexed display systems, these ICs present one of the easiest and least expensive solutions

to a difficult interface problem. A combination of high-voltage bipolar techniques with thin-film resistor technology (circuit resistors sputtered over the IC dielectric) has provided both digit (anode) and segment (cathode) interface.

To facilitate a minimum component interface, a split supply ( $\pm 100 \mathrm{~V}$ ) is employed to allow d-c levelshifting (rather than capacitors or $>200 \mathrm{~V}$ transistors) and both digit and segment drivers incorporate all pull-up, pull-down, current limiting, off-bias reference, etc. which were formerly required in discrete and/or hybrid systems. With the combination of the digit and segment drivers (each capable of withstanding 120 V ), the split power supply approach affords PN diode IC technology suitable for driving a display usually requiring a 180 V minimum ionization voltage (equivalent to $\pm 90 \mathrm{~V}$ in the split system).

The use of the Series UDN-6100/7100A gas discharge display drivers shows the need for only two monolithic ICs for displays of up to eight digits and eight segments as shown in Figure 4. Systems requiring digit or segment counts greater than eight employ additional driver ICs, and with the exception of the Type UDN-7180A segment driver, the segment ICs all have outputs with internal current-limiting resistors for the display segments. The UDN7180A device, for reasons of package power dissipation and/or dissimilar segment currents (certain 14 or 16 segment alphanumeric panels) can also be used, but must have external, discrete current-limiting resistors.


Figure 3


Figure 4

Higher current applications are difficult for both programmable current and switching type display drivers. Segment currents beyond 2.5 or 3 mA present package power dissipation limitations to most dual in-line packages. By using external resistors, the Type UDN-7180A driver allows segment currents of up to 14 mA .

The transistor switch with current-limiting resistor scheme used in Sprague gas discharge display drivers
also minimizes problems associated with gas panel arcing which can destroy programmable current circuits. Some of the gas display manufacturers recommend the use of series resistors in each segment line to prevent destruction to the semiconductor interface circuit should such a panel arc occur. Without these series resistors (internal thin-film resistors in Sprague devices) the IC can be destroyed by the high voltage and resulting high current should the panel voltage drop to a very-low level during an arc.

## LED INTERFACE

With the obvious abundance and variety of LED interface integrated circuits it would seem unlikely that there are still systems in search of an IC hardware solution to further minimize cost, component count, space, etc.; but this is definitely the case. The deficiencies are chiefly related to the limited number of current-sourcing circuits and/or highcurrent drivers.

The efficiency of LED displays has improved, but with the larger digits (up to $1^{\prime \prime}$ presently) most of the IC drivers are unable to switch the higher currents required in multiplexed systems. The rule-of-thumb generally applied uses the suggested d-c current multiplied by the number of digits in the display. For example, a multiplexed display of 160 mA peak current will give approximately the same light intensity output as a steady 20 mA in each of eight digits. Of particular difficulty is the switching of currents associated with the lower efficiency yellow and green LEDs. Sprague has provided monolithic integrated circuit solutions to applications requiring segment currents of 350 mA and digit currents of up to 1.5 amperes!

Many of the Sprague ICs used in high-current LED applications were originally designed for use with electro-mechanical loads (relays, solenoids, motors, etc.) although the high-voltage ratings of the drivers are obviously not a concern. A combination of highcurrent, high-voltage Darlington drivers is shown in Figure 5.

The ULN-2074B source driver is utilized as a modified emitter-follower. Through the use of discrete diodes in the common collector line, allowing the base to be switched to a potential higher than the collector, it is then possible to obtain a saturated output. This prevents the usual emitterfollower problems associated with gain, the MOS output impedance, and power. It is also possible to now better define the voltage at the emitter output and to then provide suitable segment current-limiting resistors for the LEDs.

The ULN-2002A sink driver is a high-current Darlington array with the capability of switching multiplexed LEDs with an available limit of 155 mA for each of the seven drivers when used at a $100 \%$ duty cycle. Even the more inefficient yellow or green LEDs can be driven with higher output currents at lower duty cycles ( 400 mA at a $28 \%$ duty cycle).


Figure 5


Figure 6

A new eight-channel source driver is shown as a digit switch for common anode LEDs in Figure 6. The Series UDN-2980A drivers will handle output currents to a maximum of 500 mA . Two basic versions of the driver will allow interface from TTL, Schottky TTL, DTL, PMOS, and CMOS levels. Other versions of the ULN-2003A driver are also available for use with the various logic levels.

Of the three sink drivers shown, the ULN-2003A is probably the better choice from a standpoint of both pinout and component count. It also has straightforward in-out pinning. The ULN-2031A and ULN2081A devices offer lower cost. They are also interchangeable from a pinning aspect although the output ON voltage will be dissimilar.

A common-cathode LED configuration is shown in Figure 7 for currents of up to 1.5 A per digit! A series UDN-2980A source driver is used to switch the segment side, the ULN-2064B or ULN-2074B to switch the digit side. As has been shown with Figure 5, the IC package power dissipation must be considered with high-current applications.

The three examples that have been shown for LED interface represent only a very-small portion of the total applications area. The high-current capabilities and high gain of the Sprague drivers represent potential solutions to many difficult LED display systems alphanumeric, seven-segment, or matrix; commoncathode or common-anode; continuous or multiplexed.

## A-C PLASMA DISPLAY INTERFACE

Plasma displays, such as those manufactured by National Electronics/NCR (USA) and NEC or Fujitsu (Japan), all have one common element with their gas discharge cousin - both types use a neon gas mixture. The plasma panels emit an orange glow when switched at rather high frequencies, and light output intensity is a function of frequency. The a-c term for the plasma display is something of a misnomer since these panels actually operate from a toggled d-c supply (usually in the area of 20 kHz ).

The panel is basically a neon-filled capacitor, and has plates (electrodes) which are covered with the dielectric - between which is the neon mixture. Switching this capacitive load presents a problem
with high peak currents in addition to the older problem of the high voltages which are associated with gas displays. Drive circuits use supply voltages of 150 to 260 V (depending on unipolar or bipolar drive), and the semiconductors used must switch instantaneous currents in the order of several hundred milliamperes for the larger displays.

Several high-voltage, high-current arrays made at Sprague Electric can provide an answer to one side of the a-c plasma display interface. The Series ULN2020A Darlingtons are rated at 95 V while the Series UHP-500 power drivers are rated at 100 V . They are both able to handle the application shown in Figure 8 (a basic d-c, non-multiplexed clock interface rather than a more complex multiplexed system). The ULN-2022A is specifically designed for 14 to 25 V

PMOS logic levels while the UHP-506 is intended for use with TTL.

The high-current diodes that are internal to the Sprague arrays are utilized in the unipolar drive scheme connected to a suitable OFF reference. In one POS application, a set of 14 ULN-2023A Darlington drivers replaced more than 400 discrete components. The cost and space savings in such a machine are considerable, and a very complex printed wiring board was greatly simplified.

Further improvements in interface and plasma displays will no doubt evolve, and thus benefit all concerned - display and interface vendor along with the end user. Plasma displays are well-suited to custom panels (particularly those with various sizes of characters) and with improvements in IC breakdown voltages some further simplification of interface should evolve.


Figure 7


Figure 8

## FLUORESCENT DISPLAY INTERFACE

Although the vast majority of fluorescent displays are directly driven from MOS logic (handheld and low-cost desk calculators), there is an emerging need for interface integrated circuits for use with the larger characters (higher currents) and the higher voltages coming into use. These blue-green display panels originated in Japan, and the manufacturers are quite aggressively pursuing markets such as POS systems, clocks, cash registers, appliances, automotive displays, etc. Larger and/or more complex styles are being made, including displays with alphanumeric capability (a starburst 14 or 16 -segment pattern).

Modest voltage capability ( 60 or 70 volts) is all that is required of a semiconductor device to drive these panels, and the currents are in 20 to 30 mA region. These electrical requirements are well within the capability of many gas discharge digit drivers. In Figure 9, the UHP-491 is shown used with pulldown resistors connected to each output. When both the segment (equivalent to a vacuum tube anode) and the digit (controlled by the grid) are switched sufficiently positive with respect to the cathode (filament), the appropriate display digit/segment are energized.

Another multiplexed configuration is shown in Figure 10; the difference being that a push-pull type of MOS output is in use, and the pull-down rail does not allow the UHP-491 substrate, $V_{\text {DD }}$, and output potentials to be the same. The substrate and output are tied to the most-negative rail, while the $V_{\text {DD }}$ terminal connects to the -12 V line for the MOS.

Since these solutions using the older gas discharge digit driver circuits require the use of appropriate pull-down resistors, either in discrete or thick-film network form, a more suitable solution employs the circuit shown in Figure 11. The UDN-6118/28A devices are designed specifically for use with fluorescent displays and include internal pull-down resistors so that up to eight segments and eight digits will require only two packages and a greatly simplified power supply. The Type UDN-6118A driver is compatible with TTL, Schottky TTL, DTL, and 5 volt CMOS. The Type UDN-6128A driver is for use with 6 to 15 volt PMOS or CMOS logic.

The future of fluorescent displays looks rather strong, particularly if competition further reduces prices. For the moment at least, these displays will not seriously tax the capability of IC interface except, perhaps, from a price/cost standpoint.


Figure 9


Figure 10

## HOT WIRE READOUTS

Although hot wire readouts could easily be placed in the incandescent category, their application in multidigit, multiplexed display systems more closely resembles LED circuit operation. Since hot wire displays will conduct current in either direction, isolation diodes are required to prevent sneak paths
from partially turning ON unaddressed segments. Compare the typical hot wire display of Figure 12 with the LED display of Figure 6. The availability of a suitable, inexpensive diode array would be of considerable asset in multiplexed hot wire systems.


Figure 11


Figure 12

The hot wire readouts are available in both sevensegment and alphanumeric ( 16 -segment) versions and are quite well-suited to high ambient light applications. They do not wash out in sunlight, although their reliability diminishes with the higher
currents required in brightly lighted applications. As described, multiplexed schemes can be cumbersome because of the great number of discrete diodes required. One avionics system using a 16 -character, 16 -segment alphanumeric panel required 256 discrete diodes.


Figure 13

GLOW TRANSFER - BAR GRAPH \& MATRIX PANELS

Neon-based display technology has shifted into many new market areas. The Burroughs Self-Scan ${ }^{\circledR}$ is a solution to many alphanumeric applications; the newer bar graph is a solid state replacement for analog instrumentation. Both use the glow transfer principle of the dot matrix Self-Scan display.

The nominal voltage for this type of panel is 250 V . High-voltage gas discharge drivers (Series UHP-480) or Darlington arrays (Series ULN-2020A) afford a cathode interface to the glow transfer panel. With a typical display current of 3 to 5 mA , the gas discharge drivers are perfectly adequate. For higher current applications, the Darlington arrays are a solution.

As illustrated in Figure 13, the bar graph cathode is easily driven with a Series UHP-480 driver. Signal level shifting is inexpensively accomplished with capacitors; the OFF reference, pull-up, and pulldown is done with a few discretes. The anodes are driven with two discrete transistors ( $\mathrm{BV}_{\mathrm{CES}} \geq 120 \mathrm{~V}$ ). By utilizing a negative supply, the level shifting is easily done in the cathode side. If a positive supply were used, relatively complex d-c level shifting would be required in the anode side. The few discretes necessary in the circuit shown are generally a viable solution when faced with cost and space parameters for the system.

## SUMMARY

The phenomenal growth in display technology has largely come as a result of the electronic calculator, and electronic displays will pervade all our lives in an ever-increasing number of products. The use of digital displays in appliances, gasoline pumps, electronic games (even pinball machines), etc., etc., etc., will also require that a continuing evolution of interface integrated circuits meet the challenges of higher brightness, increased currents, improved reliability, and lower system costs.

Both the display and semiconductor industries have demonstrated that they will meet the challenges of today, and these challenges then become routine with tomorrow.

## INTEGRATED CIRCUITS FOR CURRENT-SOURCING APPLICATIONS

DURING RECENT YEARS, the appearance of - many new low-power monolithic devices (LSI and microprocessors) has created an increased need of peripheral power driver integrated circuits. Interface drivers are typically categorized in terms of their output-drive functions. When current flows out of the driver output terminal and into the load, the device is said to "source"' current. Conversely, current flows from a load into a 'sink'' driver.

Sprague integrated source drivers usually consist of high-voltage PNP devices and high-power NPN Darlington outputs (which provide PNP-type action), with input-level shifting. These power ICs are useful for interfacing low-level logic (TTL, CMOS, NMOS, PMOS) and high-current or high-voltage relays, solenoids, lamps (incandescent, LED, neon), motors, and displays (gas-discharge, LED,

FLOATING LOGIC-GROUND LEVEL (Sink Driver)


DWG.NO. A-11,532
vacuum-fluorescent). They can also be used to provide multi-channel buffers for discrete power semiconductors.

The advantages of source drivers for display interface are quite evident. The X-Y addressing of most readouts requires both source and sink functions to minimize pin count, interconnections, and package count.

A more subtle advantage of source drivers is related to their use with inductive loads or incandescent lamps. Both types of load generate troublesome transients and noise currents on common logic/load ground lines. In addition, high ground currents can shift the ground rail, affecting logic input levels, thresholds, and noise immunity. The use of source drivers can minimize many of these concerns by separating the logic and power returns.

SEPARATE GROUND RETURNS (Source Driver)


## RELAY-DRIVER APPLICATIONS

SERIES UDN-2580A, eight-channel source drivers, and Types UDN-2956A and UDN-2957A, five-channel source drivers, provide current/voltage translation from TTL, positive CMOS, or negative CMOS logic to -48 V telecommunication relays requiring less than 350 mA . All devices have internal inductive-load transient-suppression diodes.

Type UDN-2580A-1 is best driven from negative-reference CMOS or NMOS logic ( -5 V or -12 V swing) in order to provide a -48 V swing at the output. The active-low input Type UDN-2588A-1 can be driven from positive logic TTL
$(+5 \mathrm{~V}$ swing) or CMOS ( +12 V swing) levels. The active-high input Type UDN-2956A is similar to Type UDN-2588A-1, but it also has a chip-enable function that requires a minimum number of drive lines to control outputs from several packages in a simple multiplex scheme.

## RECOMMENDED MAX. OPERATING CONDITIONS

Supply Voltage, $\mathrm{V}_{\mathrm{EE}}$ $-50 \mathrm{~V}$
Continuous Output Current, I $\mathrm{I}_{\text {OUT }}$ (per output) . . . . . . -350 mA

## TELECOMMUNICATIONS

RELAY DRIVER
(Positive Logic)


## TELECOMMUNICATIONS

RELAY DRIVER
(Negative Logic)


DWG.NO. A-11,538

## MULTIPLEXED RELAY DRIVER



## PRINTER APPLICATIONS

SPRAGUE SOURCE DRIVERS have been used extensively in electrosensitive, thermal, and impact printer applications. Multi-channel devices in the Series UDN-2580A and UDN-2980A reduce parts count and provide up to 350 mA per output at voltages up to 75 V (resistive load). Copper lead frames make these devices capable of simultaneously delivering up to 125 mA continuously from all eight channels at an ambient temperature of $+50^{\circ} \mathrm{C}$.

## THERMAL PRINTER APPLICATION



DWG.NO. A-11,530

## RECOMMENDED MAX. OPERATING CONDITIONS

| Supply Voltage Range, $\mathrm{V}_{\text {S }}$ |  |
| :---: | :---: |
| UDN-2588A-1 | to 75 V |
| UDN-2981A and UDN-2982A | 5 V to 45 V |
| UDN-2983A and UDN-2984A | 35 V to 75 V |
| Logic Voltage, $\mathrm{V}_{\mathbb{N}}$ | 12 V |
| Continuous Output Current, I Iout (per output) |  |
| Peak Output Current, $\mathrm{I}_{0 \text { P }}$ | -500 mA |



DWG.NO. A-11,529

## ELECTRO-MECHANICAL DISPLAY APPLICATIONS

SOURCE DRIVERS in the Series UDN-2580A and UDN-2980A, when combined with the Type ULN-2804A sink driver, provide a simple interface between 12 VCMOS logic and a multiplexed electro-mechanical display. As shown, the need for additional inverter packages is eliminated since Type UDN-2580A is activated by a low input level and Type UDN-2982A is turned ON by a high input
input level. All drivers have internal inductive-load transient-suppression diodes and copper lead frames for improved package power dissipation capability.

## RECOMMENDED MAX. OPERATING CONDITIONS



## MULTIPLEXED ELECTRO-MECHANICAL DISPLAY DRIVERS



DWG.NO. B-1476

## VACUUM-FLUORESCENT/GAS-DISCHARGE DISPLAY APPLICATIONS

SPRAGUE SERIES UDN-6100A and UDN2580A source drivers provide solutions to problems encountered in driving higher-voltage vacuumfluorescent and planar gas-discharge displays. Both series of parts provide TTL, CMOS, and NMOS input-logic compatibility. Series UDN-6100A devices are active high (non-inverting) drivers. Series UDN-2580A drivers are active low (inverting) devices.

At minimum cost, Series UDN-6100A-2 devices offer 60 V output breakdowns for vacuumfluorescent displays typically utilizing less than 32 characters. Featuring a minimum 80 V output breakdown voltage, standard Series UDN-6100A drivers (no additional suffix) guarantee 25 mA per output. Suffix - 1 devices provide for a 110 V breakdown, recommending them for 40 to 80 -digit or dot-matrix V-F applications or gas-discharge anode-drive applications requiring the higher output voltage. All of these drivers include internal pull-

MaXIMUM OPERATING VOLTAGES

| $V_{S} V_{B B}$ | $\mathrm{V}_{\text {INON }}$ | $\mathrm{V}_{\text {IN(OFF) }}$ | $\mathrm{V}_{\text {c }}$ | $\mathrm{V}_{\text {EEMAX) }}$ | Device Type |
| :---: | :---: | :---: | :---: | :---: | :---: |
| +5 | <1.4 | > ${ }^{\text {c }}$ | 0 | -45 | UDN-2588A |
|  |  |  |  | -75 | UDN-2588A-1 |
| +12 | $<8.4$ | $>11.5$ | 0 | -45 | UDN-2588A |
|  |  |  |  | -75 | UDN-2588A-1 |
| +30 | 2.4 | <0.4 | NA | -30 | UDN-6138A-2 |
|  | 4.0 | <0.4 | NA | -30 | UDN-6148A-2 |
| +40 | 2.4 | <0.4 | NA | -40 | UDN-6138A |
|  | 4.0 | $<0.4$ | NA | -40 | UDN-6148A |
| +60 | TL or CMOS |  | NA | 0 | Series UDN-6100A-2 |
| +80 | TTL or CMOS |  | NA | 0 | Series UDN-6100A |
| +110 | TTL or CMOS |  | NA | 0 | Series UDN-6100A-1 |

down resistors and provide operation from singleended positive supplies.

Operation from a split-supply allows the user to bias the V-F filament at ground potential or to utilize a system-supply voltage above ground ( $\pm 40 \mathrm{~V}$ instead of +80 V ). Either Type UDN-6138A or Type UDN-6148A source drivers are recommended.

For vacuum-fluorescent display applications requiring a higher current capability (operating several displays with common drive circuitry), Type UDN2588A can be used with appropriate external output pull-down resistors to provide up to 350 mA per output.

## GAS-DISCHARGE DISPLAY DRIVERS



## MULTIPLEXED VACUUM-FLUORESCENT DISPLAY DRIVERS



## VACUUM-FLUORESCENT/GAS-DISCHARGE DISPLAY APPLICATIONS

 (Continued)
## VACUUM-FLUORESCENT DISPLAY DRIVERS <br> (Split Supply)



DWG. NO. A-11,526

## INCANDESCENT LAMP DRIVER APPLICATIONS

DRIVING MULTIPLEXED incandescent lamps at voltages up to 75 V with peak currents approaching 500 mA per segment, Series UDN-2980A eight-channel source drivers, when combined with Type ULN-2069B sink drivers, provide for a very cost-effective approach. Multiplexed lamps must typically be operated at a voltage $\sqrt{N}(N=$ the number of digits) times the nominal d-c voltage, to obtain sufficient brightness. For example, a fourdigit, 28 V display requires 56 V to operate satisfactorily. In addition, care must be taken to select a proper driver to withstand the substantial inrush currents created by cold filaments. Peak currents of up
to ten times the nominal operating currents have been observed. Multiplexed lamps must also incorporate diodes to prevent series/parallel paths to unaddressed elements.

RECOMMENDED MAX. OPERATING CONDITIONS

| Supply Voltage Range, $\mathrm{V}_{\text {S }}$ |  |
| :---: | :---: |
| UDN-2981A and UDN-2982A | 5 V to 45 V |
| UDN-2983A and UDN-2984A | 35 V to 75 V |
| Continuous Output Current, $\mathrm{I}_{\text {out }}$ (per output) |  |
| eak Output Current | 500 |

Supply Voltage Range, $\mathrm{V}_{\mathrm{S}}$
UDN-2981A and UDN-2982A ............... . . 5 V to 45 V
UDN-2983A and UDN-2984A . . .............. . 35 V to 75 V
Continuous Output Current, $\mathrm{I}_{\text {our }}$ (per output) . . . . . . -350 mA
Peak Output Current, Iop ....................... . -500 mA

## MULTIPLEXED LAMP DRIVER, TTL- OR MOS-COMPATIBLE



## LIGHT-EMITTING DIODE APPLICATIONS

SERIES UDN-2580A and Series UDN-2980A 8 -channel source drivers provide monolithic solutions to problems associated with driving multiplexed LED displays in common-cathode or common-anode configurations.

Type UDN-2585A is a non-Darlington inverting (input low = output high) source driver that is frequently used as a segment or dot driver in a common-cathode LED display where multiplexed segment or dot currents do not exceed 120 mA . This device features input logic-level compatibility with open-collector TTL, standard TTL, CMOS, and NMOS, as well as low output saturation voltages.

For common-cathode applications requiring higher segment currents, or for common-anode digit drive applications, Series UDN-2980A is recommended. This non-inverting (input high $=$ output high) series features 350 mA per output continuous current ratings with peak currents reaching 500 mA
per output. Outputs may be paralleled for higher current capability. Type UDN-2982A is logiccompatible with 2.4 V output levels of TTL and CMOS. Similar high output current ratings, for use in inverting applications, are offered by the Type UDN-2580A driver.

Combining Sprague source drivers with multichannel, high-current sink drivers (such as Type ULN-2068B, UDN-2595A, or ULN-2814A) provides simple, compact, and economical solutions to driving high-current multiplexed LED displays.

## RECOMMENDED MAX. OPERATING CONDITIONS

Supply Voltage, $\mathrm{V}_{\mathrm{S}}$
UDN-2585A . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 15 V
UDN-2982A . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 45 V
Continuous Output Current, $\mathrm{I}_{\text {out }}$ (per output)
UDN-2585A $-120 \mathrm{~mA}$
UDN-2982A . . . . . . . . . . . . . . . . . . . . . . . . . . . -350 mA
Input Voltage, $\mathrm{V}_{\mathbb{N}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 15 V

## COMMON-CATHODE LED DISPLAY



## LIGHT-EMITTING DIODE APPLICATIONS

## (Continued)

COMMON-CATHODE LED DISPLAY


COMMON-ANODE LED DISPLAY


## MULTI-CHANNEL INTERFACE TO HIGH-POWER LOADS

SPRAGUE SOURCE DRIVERS can be employed as multi-channel pre-drivers for discrete highcurrent or high-voltage semiconductors, thus reducing the need for many discrete components. For instance, a UDN-2580A 8-channel source driver can provide up to 350 mA of pre-drive current into the base of power NPN devices, making 5 A load currents readily available. Higher load currents can be
obtained by using power NPN Darlington devices.
For a-c loads, it is possible to use any of the Sprague source drivers to provide gate current (with appropriate current-limiting) to a power SCR or triac. This scheme can provide an economical solution to many applications such as driving incandescent lamps or a-c motors at up to 20 A .

DRIVER FOR HIGH-POWER DISCRETE DEVICES


DWG.NO. A-11,533


DWG.NO. A.-11,534

## NEW POWER-INTERFACE ICs

## Introduction

In a continuing effort to maintain industry leadership as a producer of innovative power-interface chips, Sprague Electric Company recently introduced four new monolithic interface integrated circuits intended for medium-power switching applications. These power ICs provide integrated multi-channel interface between low-level TTL, CMOS, NMOS, and PMOS logic families, or microprocessor output ports, and mediumpower peripheral loads such as relays, solenoids, displays, and motors at currents of up to 1.5 A and at voltages of up to $140 \mathrm{~V} .{ }^{1}$
The four new integrated circuits are:
UDN-2585A Octal Source Driver ( 20 V, 120 mA per channel)
Primarily used as a segment/dot driver in common-cathode multiplexed LED display applications.
UDN-2595A Octal Sink Driver ( $20 \mathrm{~V}, 100 \mathrm{~mA}$ per channel)
Primarily a segment/dot driver in common-anode multiplexed LED display applications or as a medium-power buffer circuit to provide interface between various logic families and loads (voltage step-up, voltage step-down, current step-up).
UDN-6514A Octal Source Driver (140 V, 25 mA per channel) Primarily for use in high-voltage display applications such as driving the grids or anodes of the newer large matrix vacuum-fluorescent display panels used for graphics.

## UDN-2541B Quad NAND Sink Driver (60 V, 1.5 A per channel)

Primarily a general-purpose high-current, high-voltage interface between TTL, CMOS, PMOS, and NMOS logic and stepper motors, incandescent lamps, or relays.

All of these drivers add a level of system integration that offers these benefits:

Parts-Count Reduction
Printed Wiring Board Area Reduction
Insertion-Cost Reduction
System-Reliability Improvement
Performance Improvement
Overall System-Cost Reduction
The success of devices such as those described in this paper reaffirms customer needs to simplify designs, reduce costs, and improve overall system per:ormance and reliability through the use of power ntegrated circuits.

[^22]
## UDN-2585A

## Octal Source Driver

The UDN-2585A evolved from a need to drive segments/dots of multiplexed (common-cathode) LED displays. Typical multiplexed LED segment/ dot currents range from 50 mA to 100 mA , depending on LED digit size, number of multiplexed digits, and required display brightness. Frequently, these displays must operate with 5 V supplies. Moderate output-current requirements, combined with a need for low output-saturation voltage, suggest that a non-Darlington approach would provide an adequate solution for this application. It should be noted here that source functions are inherently more difficult to integrate.

A schematic for one of the eight UDN-2585A channels is shown in Figure 1. This source driver is an active-low, inverting device with input-drive requirements consistent with TTL, CMOS, and opendrain NMOS levels. The PNP input requires only 1.6 mA at $0.4 \mathrm{~V}\left(+5 \mathrm{~V}\right.$ logic system, $\left.\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}\right)$ to switch the output fully to the 120 mA output-current level. Input-limiting resistors as well as pull-up resistors are internal to the device.


Figure 1
UDN-2585A PARTIAL SCHEMATIC

In the multiplexed mode, the supply voltage $(+5$ V) can be broken down into four components:

1. Source Driver Output ON voltage
2. Sink Driver Output ON Voltage
3. LED Forward Voltage
4. Current-Limiting Resistor Voltage Drop

A red LED running in saturation (for uniform display brightness) should be driven at approximately 2.0 V with the remaining voltage divided between the other three elements. Operating from a 5.0 V supply dictates that driver voltage drops be kept to a minimum so that adequate display brightness can be achieved and sufficient "headroom"' voltage remains for the required current-limiting resistors.

A 4-digit, 7-segment plus decimal point LED display drive is shown in Figure 2 and requires only two IC drivers. Typical segment currents might be as high as 120 mA , with peak digit currents approaching 1A (7-segment plus $\mathrm{dp} \times 120 \mathrm{~mA}$ ). The UDN2585 A source driver features a guaranteed 1.2 V maximum saturation voltage at 120 mA ; the ULN2068 B sink driver has a guaranteed 1.3 V maximum at 1 A (see Sprague Electric Engineering Bulletins 29316 and 29305, respectively). With the LED operating at 2.0 V , this leaves 0.5 V across the $4.3 \Omega$ cur-rent-limiting resistor.


Figure 2
COMMON-CATHODE LED DRIVER

$$
R_{\mathrm{LIMIT}}=\frac{V_{S}-V_{\text {SAIISOURCE) }}-V_{\text {SAITSINK) }}-V_{\text {F(IOOOE) }}}{I_{\text {F(IOOOE })}}
$$

If source-sink drivers with higher saturation voltages are used, display brightness and uniformity will be somewhat reduced. The UDN-2585A is supplied in a plastic dual in-line package with copper lead frame that permits all eight output drivers to be ON simultaneously and continuously at 120 mA and a $+70^{\circ} \mathrm{C}$ ambient.
This device can also be used to drive discrete semiconductors such as a power NPN or SCR (Figure 3 ). With a current-sourcing capability of 120 mA , load currents up to approximately 2.5 A can be handled with a vanilla-grade NPN and up to 20 A using a power SCR. These schemes provide economical solutions to many peripheral-power applications such as driving incandescent lamps or a-c motors, at 20 A or greater, with Darlingtons and sensitive-gate SCRs.

The UDN-2585A can be defined as an evolutionary device rather than revolutionary product. Although the device does not break any technological barriers (in terms of semiconductor processing or eiectrical capabilities), it does have merit in many applications where an economical current-source function is needed.


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## UDN-2595A Octal Sink Driver

As with the UDN-2585A source driver, the UDN-. 2595A current-sink driver is intended for use as a segment/dot driver in multiplexed (commoncathode) LED display applications. A two-chip approach for driving an 8 -digit, 8 -segment red LED display is shown in Figure 4. Combining the UDN2595A sink driver with the UDN-2982A source driver provides an interface between 5 V TTL, CMOS, or NMOS, and a $50 \mathrm{~mA} /$ segment, $400 \mathrm{~mA} /$ digit LED display. The UDN-2595A sink driver features a guaranteed 0.5 V saturation voltage at 50 mA ; the UDN-2982A source driver has an approximate 2.0 V saturation rating at 400 mA (see Sprague Electric Engineering Bulletins 29320 and 29310, respectively). The $8 \Omega$ current-limiting resistor's value is determined from the same equation as used for the previous application.

Currents of up to 120 mA per segment or 1 A per digit can be obtained by paralleling outputs.
In addition to its LED display applications, the UDN-2595A can also be used as a logic translator (NMOS/CMOS, CMOS/TTL, or NMOS/TTL) or low-level current booster. These applications are shown in Figure 5.


Figure 3
DRIVER FOR HIGH-POWER APPLICATIONS


Figure 4
COMMON-ANODE LED DRIVER


Dwg. No. A-12,045


Dwg. No. A-12,046

Figure 5
UDN-2595A LOGIC TRANSLATOR OR CURRENT BOOSTER


Combining the UDN-2595A sink driver with the UDN-2585A source driver can also provide a lowvoltage ( 15 V , maximum) bipolar stepper-motor drive circuit as shown in Figure 6. Paralleling the outputs of each device provides 200 mA to 400 mA of drive capability. The non-Darlington outputs of both devices enable low-voltage operation and maintain low power dissipation at reasonable current levels. For inductive load transient protection, external flyback diodes must be used for the UDN2595A. Clamp diodes are internal to the UDN2585A.

Input-drive requirements for the UDN-2595A are consistent with TTL, CMOS, and NMOS logic families. Only 1.6 mA (at 0.4 V ) of logic sink current is required to turn the UDN-2595A output ON at the 100 mA level $\left(\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}\right)$. A schematic for one of the UDN-2595A sink-driver channels is shown in Figure 7. The UDN-2595A is supplied in a plastic dual inline package with a copper lead frame providing package power dissipation capability of up to 2.2 W at $+25^{\circ} \mathrm{C}$. All eight output drivers are allowed ON


Figure 7
UDN-2595A PARTIAL SCHEMATIC
continuously and simultaneously with load currents of 200 mA at ambient temperatures up to $+85^{\circ} \mathrm{C}$.

The UDN-2595A octal sink driver provides a basic "nuts and bolts" building-block function for a variety of applications requiring the advantages of system integration.


Figure 6
STEPPER-MOTOR DRIVER

## UDN-6514A

Octal High-Voltage Source Driver
The UDN-6514A is an 8-channel non-inverting, active-high, current-source driver capable of switching 140 V supplies with output currents of up to 40 mA . Standard bipolar technology produces output-voltage breakdowns greater than 140 V in a monolithic integrated design while maintaining costs well below that of dielectrically-isolated devices. Typical applications for this device include driving anodes or grids of large vacuum-fluorescent matrix display panels (Figure 8). Note that external pulldown resistors must be included to provide the full 140 V output-voltage swing. In addition to VF display applications, the UDN-6514A has been used in ink-jet printer applications.

A simplified schematic for the UDN-6514A octal high-voltage source driver is shown in Figure 9. Input-drive requirements are compatible with TTL or CMOS operating at 5 V . A $10 \mathrm{k} \Omega$ input impedence ensures that the input current will not exceed 225 $\mu \mathrm{A}$ with 2.4 V applied. Complete electrical specifications are given in Sprague Electric Engineering Bulletin 29313.3.


Figure 8
MULTIPLEXED DOT-MATRIX VACUUM-FLUORESCENT DISPLAY DRIVER


Figure 9
UDN-6514 PARTIAL SCHEMATIC

As with all Sprague Electric plastic dual in-line packaged power integrated circuits, this device is supplied with a copper lead frame. This allows the maximum possible package power dissipation while ensuring the lowest possible junction temperature for maximum reliability. All eight outputs are allowed to source 25 mA continuously and simultaneously with ambient temperatures up to $+64^{\circ} \mathrm{C}$.
Sprague Electric Company has manufactured high-voltage, low-current, sink drivers since 1973. The 140 V , medium-current, UDN-6514A source driver represents another step forward in the ongoing pursuit of high-voltage capability in monolithic integrated designs. With the availability of highvoltage monolithic integrated circuits such as the UDN-6514A, many designs thought to be "discrete only" can now be made simpler and less expensive through integration.

## UDN-2541B

## Quad NAND High-Current Sink Driver

The UDN-2541B quad NAND high-current sink driver is a $60 \mathrm{~V}, 1.5 \mathrm{~A}$ per output device with nonDarlington saturated outputs. This driver is primarily intended as a general-purpose, high-power, fourchannel driver for incandescent lamps, relays, and stepper motors. Its most important features are a non-Darlington saturated output driven by a variable current source operating from the logic-supply voltage. This provides a much more efficient approach to handling load-inrush currents associated with incandescent and inductive loads, and minimizes drive-current/power requirements.

The typical Darlington driver, with a constantcurrent first stage, although capable of high output currents, tends to have high output-saturation voltage levels. It also usually requires approximately 6 mA of first stage drive supply current, regardless of output-current level.

The non-Darlington constant-current drive method features a relatively low output-saturation voltage, but requires approximately 20 mA of first stage drive supply current, regardless of outputcurrent level.

The UDN-2541B uses a non-Darlington output and a variable-output base-drive current that is a function of output current. Therefore, operating at low output current requires minimum base-drive current (approximately 1 mA to 2 mA ). At high output currents, the base-drive current will rise only to the level required to keep the output driver in saturation (less than 19 mA drive for 750 mA output). Complete specifications are given in Sprague Electric Engineering Bulletin 29317. This technique combines the high-current capability of a Darlington output with the low saturation voltage of a nonDarlington, and reduces the circuit power dissipation by limiting the base-drive current to what is required to drive the output into saturation.


Figure 10
UDN-2541B PARTIAL SCHEMATIC

The output structure of the UDN-2541B sink driver is illustrated in Figure 10. Current source I1 supplies drive current to a Darlington drive circuit, Q1 and Q2, which drives output transistor Q4. With the collector voltage of Q4 equal to or less than 0.7 V, transistor Q3 is partially ON. Transistor Q3 bypasses a portion of the I1 current source from the first stage Darlington and steers it through Q4 to ground. Should the Q4 collector rise above approximately 0.7 V (indicating the need for more base drive), Q3 begins to turn OFF and a greater portion of the I1 current is driven through Q1 and Q2 and amplified to provide more base drive to output transistor Q4. Thus, supply current is optimized to the amount of base drive required to keep Q4 in saturation.

Input-drive requirements for the UDN-2541B are well below TTL, CMOS, PMOS, or NMOS drive capabilities $(20 \mu \mathrm{~A}$ source at $2.0 \mathrm{~V}, 10 \mu \mathrm{~A}$ sink at $0.8 \mathrm{~V})$. The modified bat-wing package allows all four drivers to be operated simultaneously and continuously at 750 mA output current at $+25^{\circ} \mathrm{C}$ with a supply voltage of 5 V . Higher package power dissipation can be achieved through the use of a heat sink attached to the center webbed leads of the package. Typical applications for this device include driving incandescent lamps and d-c stepper motors. Incandescent lamps with steady-state current ratings up to 125 mA can be driven with no current-limiting or warming resistors (assumes 1.5 A peak inrush). The internal diodes can be used to perform a "lamp test", function as shown in Figure 11. Bifilar (unipolar) stepper motors running at up to $35 \mathrm{~V}, 1.5 \mathrm{~A}$ per phase, can be driven directly with the UDN-2541B device. Internal transient-suppression diodes prevent damage to the output transistor from positive high-voltage inductive spikes as the output switches OFF. Figure 12 depicts a typical drive circuit with input waveforms to control a $35 \mathrm{~V}, 1.5 \mathrm{~A}$ per phase unipolar stepper motor using the ENABLE pin of the UDN-2541B as a simple STOP/GO function.

The UDN-2541B quad NAND-gate power driver represents a continued effort to improve the performance of power interface integrated circuits by developing techniques to deal with problems associated with device and packaging power limitations. At the same time, these new techniques do not significantly add to overall device cost. The user is, therefore, offered a proposition not frequently encountered in today's marketplace: The opportunity to get more for less.


Figure 11
INCANDESCENT LAMP DRIVER


Figure 12

## GENERAL INFORMATION

## high-VOLTAGE interface drivers

## HIGH-CURRENT INTERFACE DRIVERS



## BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS <br> MILITARY AND AEROSPACE DEVICES

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

## VIDEO AND TELEVISION INTEGRATED CIRCUITS

AUDIO POWER AMPLIFIERS

HALL EFFECT DEVICES

TRANSISTOR ARRAYS AND MISCELLANEOUS DEVICES

CUSTOM DEVICES
A,

## SECTION 4 - BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS

UCN-4202A and 4203A Stepper-Motor Translator/Drivers ..... 4-2
UCN-4204A 1.25A, 2-Phase Stepper Motor Translator/Driver ..... *
UCN-4401A and 4801A BiMOS Latch/Drivers ..... 4-9
UCN-4805A BiMOS Latched Decoder/Driver ..... 4-12
UCN-4807A and UCN-4808A Addressable Latched Drivers ..... 4-16
UCN-4810A 10-Bit, Serial-In, Latched Driver ..... 4-22
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UCN-5832A 32-Bit BiMOS II Serial/Parallel Sink Driver ..... *
Application Note:
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BiMos Power Drivers to MIL-STD-883 ..... 5-90
*New Product. Contact factory for detailed information.

## UCN-4202A AND UCN-4203A STEPPER-MOTOR TRANSLATORS AND DRIVERS

## FEATURES

- 600 mA Output Current
- Full-Step or Double-Step Operation
- Single-Input Direction Control
- Power-On Reset
- Internal Transient Suppression
- Schmitt Trigger Inputs

DESIGNED TO DRIVE permanent-magnet stepper motors with current ratings of up to 500 mA , these integrated circuits employ a full-step, double-pulse drive scheme that allows use of up to 90 percent of available motor torque. The two devices differ only in output-voltage ratings: Type UCN4202 A has a 20 V breakdown-voltage rating and a 15 V sustaining voltage rating; Type UCN-4203A has a 50 V breakdown-voltage rating and a 35 V sustaining voltage rating.

Both drivers are bipolar $I^{2} \mathrm{~L}$ designs containing approximately 100 logic gates, TTL-compatible input/output circuitry, and 600 mA outputs with internal transient suppressors. The devices operate with a minimum of external components.
The four-phase stepper-motor load is controlled by step-logic functions. To step the load from one position to the next, STEP INPUT is pulled down to a logic low for at least $1 \mu \mathrm{~s}$, then allowed to return to a logic high. The step logic is activated on the positive-going edge, which in turn activates one of the four current-sink outputs. DIRECTION CONTROL determines the sequence of states (A-B-C-D or A-D-C-B).

In the full-step mode, the MONOSTABLE RC timing pin is tied to $\mathrm{V}_{\mathrm{CC}}$, making states B and D stationary. A separate input pulse is required to move through each of the four output states.

In the double-step mode, states B and D are transition states with duration determined by MONOSTABLE RC timing. Improved motor torque is ob-


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tained at double the nominal motor step angle, and motor stability is improved for high step rates.

Higher current ratings, or bipolar operation, can be obtained by using Type UCN-4202A or UCN4203A as a logic translator to drive integrated motor drivers (Sprague Type UDN-2949Z or UDN2952B /W) or discrete high-power transistors.

ABSOLUTE MAXIMUM RATINGS
at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$
Supply Voltage, $\mathrm{V}_{\text {cc }} \ldots \ldots . .$.
$V_{k}$ (UCN-4202A) . . . . . . . . . . . . . . . . . . 20 V
(UCN-4203A) . . . . . . . . . . . . . . . . . . . 50 V
Output Voltage, $\mathrm{V}_{\text {out }}$ (UCN-4202A) . . . . . . . . . . . . . . . . . . 20 V
(UCN-4203A) . . . . . . . . . . . . . . . . . . 50 V
Input Voltage, $\mathrm{V}_{\mathbb{N}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . 7.0 V
Output Sink Current, I Iour . . . . . . . . . . . . . . . . . . . . . 600 mA
Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ (One Driver) . . . . . . . . . . . . . . . . 0.8 W
(Total Package) ............... $2.0 \mathrm{~W}^{*}$
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S} \ldots . . . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Derate at the rate of $16.6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+25^{\circ} \mathrm{C}$.

## RECOMMENDED OPERATING CONDITIONS

| Characteristic | UCN-4202A |  |  | UCN-4203A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 4.5 | 5.0 | 5.5 | 4.5 | 5.0 | 5.5 | $V$ |
| $V_{k}$ | - | 12 | 13.5 | - | 30 | 35 | V |
| Output Voltage, $\mathrm{V}_{\text {CE }}$ | - | - | 13.5 | - | - | 35 | V |
| Output Sink Current, $\mathrm{I}_{\text {Out }}$ | - | - | 500 | - | - | 500 | mA |
| Operating Temperature, $\mathrm{T}_{\mathrm{A}}$ | 0 | 25 | 70 | 0 | 25 | 70 | ${ }^{\circ} \mathrm{C}$ |

## MAXIMUM COLLECTOR CURRENT AS A FUNCTION OF MOTOR TIME CONSTANT



Notes: 1. Values shown take into account static d-c losses ( $V_{\text {san }} I_{\text {out }}$ and $V_{\text {cclcc }}$ ) as well as switching losses induced by inductive flyback through the clamp diodes at $V_{k}=$ 12 V . Maximum package power dissipation is assumed to be 1.33 W at $+70^{\circ} \mathrm{C}$. Higher package power dissipation may be obtained at lower operating temperatures.
2. Use of external discrete flyback diodes will eliminate power dissipation resulting from switching losses and will allow the full 500 mA output capability (Output A, B, $C$, or $D$ and the Driver Output) under all conditions.

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Supply Current | Icc | All | 2 Drivers ON | - | 85 | mA |

TTL Inputs (Pins 1, 9, and 15), ILL Outputs (Pins 13 and 14)

| Input Voltage | $\mathrm{V}_{\mathbb{N ( 1 )}}$ | All | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}$ | 2.0 | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{V}_{\text {W(0) }}$ | All | $V_{c c}=5.5 \mathrm{~V}$ | - | 0.8 | V |
| Tnput Current | $\mathrm{I}_{\text {W(1) }}$ | All | $\mathrm{V}_{\text {CC }}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathbb{N}}=2.4 \mathrm{~V}$ | - | 40 | $\mu \mathrm{A}$ |
|  | $\mathrm{T}_{\text {IN(0) }}$ | All | $\mathrm{V}_{\text {CC }}=5.5 \mathrm{~V}, \mathrm{~V}_{\text {IV }}=0.4 \mathrm{~V}$ | - | -1.6 | mA |
| Input Clamp Voltage | $V_{1 K}$ | All | $\mathrm{I}_{\mathbb{W}}=-12 \mathrm{~mA}$ | - | -1.5 | $V$ |
| Output Voltage | $V_{\text {our(1) }}$ | All | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {ouf }}=80 \mu \mathrm{~A}$ | 2.4 | - | V |
|  | $V_{\text {OUT(0) }}$ | UCN-4202A | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {ouf }}=3.2 \mathrm{~mA}$ | - | 0.4 | V |
|  |  | UCN-4203A | $V_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1.5 \mathrm{~mA}$ | - | 0.4 | V |
| Output Current | Tout(sc) | All | $\mathrm{V}_{\text {cc }}=5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0$ | - | 38 | mA |

Second-Step Monostable RC Input (Pin 11)

| Time Constant | $\mathrm{t}_{\mathrm{RC}}$ | All |  | 0.95 | 1.3 |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Reset Voltage | $\mathrm{V}_{\mathrm{MR}}$ | All | $\mathrm{R}=200 \mathrm{k} \Omega, \mathrm{I}_{\mathbb{N}}=25 \mu \mathrm{~A}$ | - | 50 |
| Reset Current | $\mathrm{I}_{\mathrm{MR}}$ | All | $\mathrm{V}_{\mathbb{N}}=2.0 \mathrm{~V}$ | 40 | - |

Schmitt Trigger Inputs (Pins 10 and 12)

| Threshold Voltage | $\mathrm{V}_{\text {T }}$ | All |  | 1.3 | 2.1 | $V$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $V_{\text {T- }}$ | All |  | 0.6 | 1.1 | V |
| Hysteresis | $\Delta V_{\text {I }}$ | All |  | 0.2 | - | V |
| Input Current | $T_{\text {IN(1) }}$ | All | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{~V}_{\mathbb{E}}=2.4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | 5.0 | $\mu \mathrm{A}$ |
|  |  | All | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{~V}_{\text {IV }}=2.4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | 40 | $\mu \mathrm{A}$ |
|  | $T_{\text {M (0) }}$ | All | $\mathrm{V}_{\mathrm{cc}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathbb{N}}=0.4 \mathrm{~V}$ | - | -1.6 | mA |
| Input Clamp Voltage | $V_{\text {IK }}$ | All | $\mathrm{I}_{\text {IN }}=-12 \mathrm{~mA}$ | - | -1.5 | $V$ |

Open Collector Outputs (Pins 2, 3, 4, 5, and 6)

| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | UCN-4202A | $\mathrm{V}_{\text {cc }}=5.5 \mathrm{~V}, \mathrm{~K}=0$ pen, $\mathrm{V}_{\text {out }}=20 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | UCN-4203A | $\mathrm{V}_{\text {cc }}=5.5 \mathrm{~V}, \mathrm{~K}=0$ pen, $\mathrm{V}_{\text {out }}=50 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $\mathrm{V}_{\text {CESSAT }}$ | UCN-4202A | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUI }}=300 \mathrm{~mA}$ | - | 500 | mV |
|  |  |  | $V_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=400 \mathrm{~mA}$ | - | 750 | mV |
|  |  |  | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=500 \mathrm{~mA}$ | - | 900 | mV |
|  |  | UCN-4203A | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=300 \mathrm{~mA}$ | - | 850 | mV |
|  |  |  | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=400 \mathrm{~mA}$ | - | 1100 | mV |
|  |  |  | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=500 \mathrm{~mA}$ | - | 1350 | mV |
| Output Sustaining Voltage | $V_{\text {CEESUS }}$ | UCN-4202A | $\mathrm{I}_{\text {OUT }}=30 \mathrm{~mA}, \mathrm{t}_{\mathrm{p}} \leq 300 \mu \mathrm{~s}$, Duty Cycle $\leq 2 \%$ | 15 | - | V |
|  |  | UCN-4203A | $\mathrm{I}_{\text {out }}=30 \mathrm{~mA}, \mathrm{t}_{0} \leq 300 \mu \mathrm{~s}$, Duty Cycle $\leq 2 \%$ | 35 | - | V |
| Turn-On Delay | $t_{\text {pdo }}$ | All | $0.5 \mathrm{E}_{\text {in }}$ (Pin 10) to $0.5 \mathrm{E}_{\text {out }}$ | - | 10 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\mathrm{pd} 1}$ | All | $0.5 \mathrm{E}_{\text {in }}(\operatorname{Pin} 10)$ to $0.5 \mathrm{E}_{\text {out }}$ | - | 10 | $\mu \mathrm{S}$ |
| Clamp Diode Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | UCN-4202A | $\mathrm{V}_{\mathrm{R}}=20 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | UCN-4203A | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | All | $\mathrm{I}_{\mathrm{F}}=500 \mathrm{~mA}$ | - | 3.0 | V |

## FUNCTIONAL DESCRIPTION

## Power-On Reset

An internal RS flip-flop sets the Output A "ON" with the initial application of power. This state occurs approximately $30 \mu \mathrm{~s}$ after the logic supply voltage reaches 4 V with supply rise times of up to $10 \mathrm{~ms} / \mathrm{V}$. Once reset, the circuit functions according to the logic input conditions.

## Step Enable

Pin 9 (STEP ENABLE) must be held high to enable the step pulses for advancing the motor to reach the translator logic clock circuits. Pulling this pin low inhibits the translator logic.

## Step Input

Pin 10 (STEP INPUT) is normally high. The logic will advance one position on the positive transition after the input has been pulled low for at least $1 \mu \mathrm{~s}$. The STEP INPUT current specification is compatible with NMOS and CMOS.

## Direction Control

The direction of output rotation is determined by the logic level at pin 12. If the input is held high the rotation is A-D-C-B; if pulled low the rotation is A-B-C-D. This input is also NMOS and CMOS compatible.

FULL-STEP MODE


## Output Enable

Outputs A through D are inhibited (all outputs OFF) when pin 1 (OUTPUT ENABLE) is at high level. This condition creates a potential for wiredOR device outputs, or other potential control functions such as chopping or bi-level drive.

## Transient Suppression

All five power outputs are diode protected against inductive transients. Zener diode or resistor 'flyback' transient suppression is often used, provided the peak output voltage does not exceed the sustaining voltage rating of the device ( 15 V for Type UCN-4202A or 35 V for Type UCN-4203A).

## Full-Step/Double-Step

Full-step operation is the most commonly used drive technique. The devices are capable of unipolar drive without external active devices, either in a full-step mode (pin 11, Monostable RC, tied high), or in a double-step mode (pin 11 connected to RC timing). The double-step mode provides improved torque characteristics, while the specified angular increment is doubled.

DOUBLE-STEP MODE


Dwg. No. A-11,844

## STEPPER MOTORS <br> (Representative List)

| Manufacturer | Model | L/R | Typ. Ratings | Step |
| :--- | :---: | :---: | :---: | :---: |
| Eastern Air | LA23ACK-2 | 1.4 ms | $440 \mathrm{~mA}, 12 \mathrm{~V}$ | $1.8^{\circ}$ |
| Devices | LA23ACK-3 | 1.25 ms | $220 \mathrm{~mA}, 24 \mathrm{~V}$ | $1.8^{\circ}$ |
|  | LA23ACY-1 | 1.2 ms | $440 \mathrm{~mA}, 12 \mathrm{~V}$ | $7.5^{\circ}$ |
|  | LA34ADK-6 | 2.6 ms | $530 \mathrm{~mA}, 14 \mathrm{~V}$ | $1.8^{\circ}$ |
| IMC | S-114 | 1.6 ms | $340 \mathrm{~mA}, 12 \mathrm{~V}$ | $7.5^{\circ}$ |
| Hanson | S-115 | 1.9 ms | $130 \mathrm{~mA}, 12 \mathrm{~V}$ | $7.5^{\circ}$ |
|  | S-382 | 1.6 ms | $171 \mathrm{~mA}, 24 \mathrm{~V}$ | $7.5^{\circ}$ |
|  | S-406 | 4.3 ms | $280 \mathrm{~mA}, 24 \mathrm{~V}$ | $15^{\circ}$ |
|  | S-451 | 3.9 ms | $280 \mathrm{~mA}, 24 \mathrm{~V}$ | $7.5^{\circ}$ |
| North American | K82701-P2 | 1.5 ms | $330 \mathrm{~mA}, 12 \mathrm{~V}$ | $7.5^{\circ}$ |
| Phillips | K83701-P2 | 1.5 ms | $330 \mathrm{~mA}, 12 \mathrm{~V}$ | $15^{\circ}$ |
| Septor | S-0912A | 1.5 ms | $340 \mathrm{~mA}, 12 \mathrm{~V}$ | $9^{\circ}$ |
| Superior | M061-FD-301 | 0.8 ms | $440 \mathrm{~mA}, 12 \mathrm{~V}$ | $1.8^{\circ}$ |
| Electric | M061-FD-311 | 1.5 ms | $220 \mathrm{~mA}, 20 \mathrm{~V}$ | $1.8^{\circ}$ |

## TYPICAL APPLICATIONS

CHOPPER DRIVE CIRCUIT
Used to Drive a $12 \mathrm{~V}, 500 \mathrm{~mA}$
Unipolar Stepper Motor


DISC DRIVE APPLICATIONS

These stepper-motor translator/ drivers provide additional specialpurpose logic for use in disc drive applications. Pin 14 (STATE A) is high with OUTPUT A activated and is used with other drive logic in determining Track 0 Position on the disc. Pin 13 (TIME/OUT MONOSTABLE) in disc drive applications is called ON TRACK and is low with either OUTPUT A or OUTPUT C activated. It is used as a WRITE ENABLE condition with other drive logic.

An independent driver (pins 2 and 15) is used to control the head load solenoid.

## TYPICAL APPLICATIONS (Continued)

BIPOLAR DRIVE CIRCUIT
Used to Drive a 500 mA Stepper Motor


UDN-2952W


## TYPICAL APPLICATIONS (Continued)

## A-C MOTOR DRIVE CIRCUIT

Used to Drive a 2 A Synchronous Motor


Dwg. No. B-1447


## UCN-4401A AND UCN-4801A BiMOS LATCH/DRIVERS

## FEATURES

- High-Voltage, High-Current Outputs
- Output Transient Protection
- CMOS, PMOS, NMOS, TTL Compatible Inputs
- Internal Pull-Down Resistors
- Low-Power CMOS Latches

THESE high-voltage, high-current latch/drivers are comprised of four or eight CMOS data latches, a bipolar Darlington transistor driver for each latch, and CMOS control circuitry for the common CLEAR, STROBE, and OUTPUT ENABLE functions. The bipolar /MOS combination provides an extremely low-power latch with maximum interface flexibility. The UCN-4401A contains four latch/drivers while the UCN-4801A contains eight latch/drivers.

The CMOS inputs are compatible with standard CMOS, PMOS, and NMOS circuits. TTL or DTL circuits may require the use of appropriate pull-up resistors. The bipolar outputs are suitable for use with relays, solenoids, stepping motors, LED or incandescent displays, and other high-power loads.

Both units feature open-collector outputs and integral diodes for inductive load transient suppression. The output transistors are capable of sinking 500 mA and will sustain at least 50 V in the OFF state. Because of limitations on package power dissipation, the simultaneous operation of all drivers at maximum rated current can only be accomplished by a reduction in duty cycle. Outputs may be paralleled for higher load current capability.

The UCN-4401A 4-latch device is furnished in a standard 14 -pin dual in-line plastic package. The UCN-4801A 8-latch device is furnished in a 22-pin dual in-line plastic package with lead centers on $0.400^{\prime \prime}(10.16 \mathrm{~mm})$ spacing. All outputs are pinned opposite their respective inputs to simplify circuit board layout.


DWG.NO. A-10,499A
TYPE UCN-4401A



## ABSOLUTE MAXIMUM RATINGS

Output Voltage, $\mathrm{V}_{\mathrm{CE}}$ ..... 50 V
Supply Voltage, $\mathrm{V}_{00}$ ..... 18 V
Input Voltage Range, $\mathrm{V}_{\mathrm{W}}$ ..... $+0.3 \mathrm{~V}$
Continuous Collector Current, $\mathrm{I}_{\mathrm{c}}$. ..... 500 mA
Package Power Dissipation, $P_{0}$ (UCN-4401A) ..... $1.67 \mathrm{~W}^{*}$
(UCN-4801A) ..... 2.0 W**
Operating Ambient Temperature Range, $T_{A}$. ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

*Derate at the rate of $16.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
${ }^{* *}$ Derate at the rate of $20 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{D D}=5 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Cürrent | ${ }_{\text {cex }}$ | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {celan }}$ | $\mathrm{I}_{\mathrm{c}}=100 \mathrm{~mA}$ | - | 0.9 | 1.1 | V |
|  |  | $\mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}$ | - | 1.1 | 1.3 | V |
|  |  | $\mathrm{I}_{\mathrm{c}}=350 \mathrm{~mA}, \mathrm{~V}_{00}=7.0 \mathrm{~V}$ | - | 1.3 | 1.6 | V |
| Input Voltage | $V_{\text {wo }}$ |  | - | - | 1.0 | V |
|  | $V_{\text {wil }}$ | $\mathrm{V}_{00}=15 \mathrm{~V}$ | 13.5 | - | - | V |
|  |  | $\mathrm{V}_{00}=10 \mathrm{~V}$ | 8.5 | - | - | V |
|  |  | $\mathrm{V}_{\text {Do }}=5.0 \mathrm{~V}$ (see note) | 3.5 | - | - | V |
| Input Resistance | $\mathrm{R}_{\text {IW }}$ | $\mathrm{V}_{00}=15 \mathrm{~V}$ | 50 | 200 | - | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{V}_{00}=10 \mathrm{~V}$ | 50 | 300 | - | k $\Omega$ |
|  |  | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | 50 | 600 | - | $\mathrm{k} \Omega$ |
| Supply Current | $I_{\text {Do(on) }}$ (Each stage) | $\mathrm{V}_{00}=15 \mathrm{~V}$ | - | 1.0 | 2.0 | mA |
|  |  | $\mathrm{V}_{00}=10 \mathrm{~V}$ | - | 0.9 | 1.7 | mA |
|  |  | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | - | 0.7 | 1.0 | mA |
|  | Topoff | $\mathrm{V}_{00}=5.0 \mathrm{~V}$, All Drivers OFF, All Inputs $=0 \mathrm{~V}$ | - | 50 | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{00}=15 \mathrm{~V}$, All Drivers OFF, All Inputs $=0 \mathrm{~V}$ | - | - | 200 | $\mu \mathrm{A}$ |
| Clamp Diode Leakage Current | ${ }_{1}$ | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | - | 50 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 1.7 | 2.0 | V |

[^23]
## TRUTH TABLE

| $\mathrm{IN}_{\mathrm{N}}$ | STROBE | CLEAR | OUTPUT ENABLE | $\mathrm{OUT}_{\mathrm{N}}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | t-1 | t |
| 0 | 1 | 0 | 0 | X | OFF |
| 1 | 1 | 0 | 0 | X | ON |
| X | X | 1 | X | X | OFF |
| X | X | X | 1 | X | OFF |
| X | 0 | 0 | 0 | ON | ON |
| X | 0 | 0 | 0 | OFF | OFF |

[^24]Information present at an input is transferred to its latch when the STROBE is high. A high CLEAR input will set all latches to the output OFF condition regardless of the data or STROBE input levels. A high OUTPUT ENABLE will set all outputs to the OFF condition regardless of any other input conditions. When the OUTPUT ENABLE is low, the outputs depend on the state of their respective latches.

## TIMING CONDITIONS

(Logic Levels are $V_{D D}$ and $V_{S S}$ )

A. Minimum data active time before strobe enabled (data set-up time) ................... 100 ns
B. Minimum data active time after strobe disabled (data hold time) ..................... 100 ns
C. Minimum strobe pulse width . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 300 ns
D. Typical time between strobe activation and output on to off transition .500 ns
E. Typical time between strobe activation and output off to on transition . . ................ 500 ns
F. Minimum clear pulse width . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 300 ns
G. Minimum data pulse width . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 500 ns



CAUTION: Sprague CMOS devices feature input static protection but are still susceptible to damage when exposed to extremely high static electrical charges.

## UCN-4805A BiMOS LATCHED DECODER/DRIVER

## features

- High-Voltage Source Outputs
- CMOS, PMOS, NMOS, TIL Compatible Inputs
- Low-Power CMOS Latches
- Hexadecimal Decoding
- Internal Pull-Up/Pull-Down Resistors
- Wide Supply Voltage Range

DESIGNED for use in high-voltage vacuum fluorescent display driver applications, the UCN-4805A latched decoder/driver combines CMOS logic with bipolar source outputs. The device consists of eight high-voltage bipolar sourcing outputs, with internal pull-down resistors and CMOS input latches, hexadecimal decoder, and control circuitry (strobe and blanking).
Type UCN-4805A is intended to serve as the segment driver with standard 7 -segment displays incorporating a colon or decimal point. The integrated circuit uses hexadecimal decoding to display $0-9, \mathrm{~A}$, $\mathrm{b}, \mathrm{C}, \mathrm{d}, \mathrm{E}$, and F .
This BiMOS latched decoder/driver has sufficient speed to permit operation with most microproces-sor/LSI-based systems. The CMOS input latches provide operation over the supply voltage range of 5 to 15 V with minimum logic loading. Internal output pull-down resistors eliminate the need for external components usually required for fluorescent display applications. When used with standard TTL or lowspeed TTL logic, the device may require employment of input pull-up resistors to insure a proper input logic high.


UCN-4805A

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature and $\mathbf{V}_{s s}=0 \mathbf{V}$

Output Voltage, $\mathrm{V}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . 60 V
Logic Supply Voltage Range, $\mathrm{V}_{\text {DD }}$. . . . . . . . . . . . . . . 4.5 V to 18 V
Driver Supply Voltage Range, $\mathrm{V}_{B B} \ldots . . . . . . . . . .5 .0 \mathrm{~V}$ to 60 V
Input Voltage Range, $\mathrm{V}_{\mathbb{W}} \ldots \ldots . . . . .-0.3 \mathrm{~V}$ to $\mathrm{V}_{D D}+0.3 \mathrm{~V}$
Continuous Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . -40 mA

Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . . .-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
*Derate at the rate of $18.18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$.

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DO}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{Ss}}=\mathbf{O} \mathrm{V}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $V_{\text {OUT }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 57.5 | - | V |
| Output Pull-Down Current | Iour | $V_{\text {OUT }}=V_{\text {BB }}$ | 400 | 850 | $\mu \mathrm{A}$ |
| Output Leakage Current |  | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{1 N(1)}$ | $\mathrm{V}_{D 0}=5.0 \mathrm{~V}$ | 3.5 | 5.3 | V |
|  |  | $V_{D D}=15 \mathrm{~V}$ | 13.5 | 15.3 | V |
|  | $V_{\text {IN(O) }}$ |  | -0.3 | +0.8 | V |
| Input Current | $\mathrm{I}_{\text {IN(I) }}$ | $V_{D D}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{D D}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {W }}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ | 50 | - | $k \Omega$ |
| Supply Current | $\mathrm{I}_{\text {BB }}$ | Display "8" | - | 9.1 | mA |
|  |  | All outputs OFF | - | 100 | $\mu A$ |
|  | $I_{D D}$ | $\mathrm{V}_{\text {DD }}=1 / 0=$ STROBE $=5.0 \mathrm{~V}$, All other inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $V_{D D}=1 / 0=$ STROBE $=15 \mathrm{~V}$, All other inputs $=0 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  | $V_{00}=$ STROBE $=$ BLANK $=5.0 \mathrm{~V}$, Data latched, Display " 8 " | - | 7.0 | mA |
|  |  | $\mathrm{V}_{\text {DO }}=$ STROBE $=$ BLANK $=15 \mathrm{~V}$, Data latched, Display "8" | - | 21 | mA |

NOTE: Positive (negative) current is defined as going into (coming out of) the specified device pin.
Caution: Sprague CMOS devices feature input static protection but are still susceptible to damage when exposed to extremely high static electrical charges.

MAXIMUM ALLOWABLE DUTY CYCLE

| Number of | Max. Allowable Duty Cycle |  |  |
| :---: | :---: | :---: | :---: |
| Outputs ON | at Ambient Temperature of |  |  |
| $\left(\mathrm{l}_{\text {Out }}=\right.$ | $-25 \mathrm{~mA})$ | $50^{\circ} \mathrm{C}$ | $60^{\circ} \mathrm{C}$ |$) 70^{\circ} \mathrm{C}$.

UCN-4805A TRUTH TABLE


TYPICAL INPUT CIRCUITS
TYPICAL OUTPUT DRIVER


Dwg. No. A-10,979A


Dwg. No. A-10,980


## TIMING CONDITIONS

(Logic Levels are $V_{D D}$ and $V_{S S}$ )

A. Minimum Data Active Time Before $\overline{\text { Strobe Enabled }}$
(Data Set-Up Time) . . . . . ................. 100 ns
B. Minimum Data Active Time After Strobe Disabled (Data Hold Time) . . . . . . . . . . . . . . . . . . . . . . . . . 100 ns
C. Minimum Strobe Pulse Width .................. 300 ns
D. Typical Time Between Strobe Activation and Output On to Off Transition .......................... . $1.0 \mu \mathrm{~s}$
E. Typical Time Between Strobe Activation and Output Off to On Transition
$1.0 \mu \mathrm{~s}$
F. Minimum Data Pulse Width ................... 500 ns

Information present at an input is transferred to its latch when the $\overline{\text { STROBE }}(\overline{\mathrm{ST}})$ is low. The latches will continue to accept new data as long as the STROBE is held low. Applications where the latches are bypassed (STROBE tied low) ordinarily require that the $\overline{\text { BLANKING }}$ input be low between digit selection because of possible non-synchronous decoding.
When the $\overline{\text { BLANKING }}(\overline{\mathrm{BL}})$ input is low, all of the output buffers are disabled (OFF) without affecting the information stored in the latches. With the BLANKING input high, the outputs are controlled by the latch/ decoder circuitry.

## UCN-4807A AND UCN-4808A BiMOS ADDRESSABLE LATCHED DRIVERS

## features

- Addressable Data Entry
- 50 V Current-Sink Outputs
- CMOS, PMOS, NMOS, TL Compatible
- Low-Power CMOS Logic and Latches
- Wide Supply-Voltage Range

THESE 8-BIT, ADDRESSABLE, latched drivers are used in a wide variety of power demultiplexer applications. They can drive all types of common peripheral power loads, including lamps, relays, solenoids, LEDs, printer heads, heaters, and stepper motors. They can also be used as DMUX drivers for higher power loads requiring discrete power semiconductors.

Type UCN-4807A and UCN-4808A drivers are identical except for output current ratings. The former is rated for a maximum of 200 mA per output while the latter is capable of sinking up to 600 mA per output. The 50 V outputs are bipolar NPN saturated switches with first stage driver currents optimized for each version.

Each MSI array is comprised of a 3-bit to 8-line decoder, 8 type D latches, 8 open-collector output drivers, and MOS control circuitry for $\overline{\text { CHIP }}$ SELECT, CLEAR, and OUTPUT ENABLE functions. Any of the eight power loads can be addressed individually and can be turned ON or OFF independently of the other loads.

UCN-4808A DERATING

| Number of Outputs ON | Max. Duty Cycle (with $V_{D D}=5 \mathrm{~V}$ ) at Ambient Temperature of |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\left(\mathrm{l}_{\text {OUT }}=500 \mathrm{~mA}\right)$ | $30^{\circ} \mathrm{C}$ | $40^{\circ} \mathrm{C}$ | $50^{\circ} \mathrm{C}$ | $60^{\circ} \mathrm{C}$ | $70^{\circ} \mathrm{C}$ |
| 8 | 33\% | 29\% | 25\% | 21\% | 17\% |
| 7 | 37\% | 33\% | 29\% | 24\% | 20\% |
| 6 | 44\% | 39\% | 33\% | 28\% | 23\% |
| 5 | 52\% | 46\% | 40\% | 34\% | 28\% |
| 4 | 65\% | 58\% | 50\% | 42\% | 35\% |
| 3 | 87\% | 77\% | 67\% | 57\% | 46\% |
| 2 | 100\% | 100\% | 100\% | 85\% | 70\% |
| 1 | 100\% | 100\% | 100\% | 100\% | 100\% |



Under normal operating conditions, all outputs of Type UCN-4807A can sustain 150 mA over the operating temperature range without derating. Type UCN-4808A will sustain 500 mA per output at $30^{\circ} \mathrm{C}$ and a duty cycle of $33 \%$. Other combinations of number of outputs conducting and duty cycle are shown in the specifications.

These devices are supplied in 18 -pin dual in-line plastic packages for operation over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. They are also available in industrial-grade ceramic packages (UCQ-4807R and UCQ-4808R) or in side-brazed, hermetically sealed packages to MIL-STD-883, Class B (UCS-4807H and UCS-4808H).

## ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature

[^25]
## FUNCTIONAL BLOCK DIAGRAM



| Terminal Designation | Function |
| :---: | :---: |
| ADDRESS | A 3-bit binary address on these pins defines which one of the 8 latches is to receive the data. $\mathrm{C}_{\mathbb{N}}$ is the most-significant bit; $\mathrm{A}_{\mathbb{N}}$ is least significant. |
| CHIP SELECT | When this input is low, the addressed output latch will accept data. When CHIP SELECT is high, the latches will retain their existing state, regardless of ADDRESS or DATA input conditions. This input should be held high while ADDRESS is being changed. CHIP SELECT also allows an additional level of address decoding. |
| DATA INPUT | When CHIP SELECT is low, the data bit present here is transferred to the addressed latch and output such that (when OUTPUT ENABLE is high) " 1 " turns the output ON and " 0 " turns the output OFF. |
| CLEAR | When CLEAR goes from high to low, all latches are reset and outputs are turned OFF. |
| OUTPUT ENABLE | When this input is high, the outputs are controlled by their respective latches. When OUTPUT ENABLE is low, all outputs are OFF. |
| OUTPUTS | These are the 8 open-collector NPN outputs. |
| DRIVER SUPPLY | This is the supply voltage for the first stage of the bipolar output drivers. The nominal supply is 5.0 V . |
| LOGIC SUPPLY | This is the CMOS logic supply voltage input. Typically it is between 4.75 V and 15.75 V . |

ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} C, V_{D D}=5 V$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | UCN-4807A |  | UCN-4808A |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Min. | Max. |  |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | $V_{\text {OUT }}=50 \mathrm{~V}$ | - | 50 | - | 50 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {cessat }}$ | $\mathrm{T}_{\text {OUT }}=50 \mathrm{~mA}$ | - | 0.2 | - | - | V |
|  |  | $\mathrm{I}_{\text {Out }}=100 \mathrm{~mA}$ | - | 0.3 | - | - | V |
|  |  | $\mathrm{l}_{\text {our }}=150 \mathrm{~mA}$ | - | 0.4 | - | - | V |
|  |  | $\mathrm{I}_{\text {our }}=200 \mathrm{~mA}$ | - | - | - | 0.5 | V |
|  |  | $\mathrm{T}_{\text {Our }}=350 \mathrm{~mA}$ | - | - | - | 0.7 | V |
|  |  | $\mathrm{T}_{\text {Ouf }}=500 \mathrm{~mA}$ | - | - | - | 1.0 | V |
| Input Voltage | $V_{\text {IN(0) }}$ |  | - | 0.8 | - | 0.8 | V |
|  | $V_{\mathbb{N ( 1 )}}$ | $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | 13.5 | - | 13.5 | - | V |
|  |  | $V_{\text {DD }}=5 \mathrm{~V}$ | 3.5 | - | 3.5 | - | V |
| Input Current | $1_{1 \times(1)}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | - | 300 | - | 300 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{EN}}=\mathrm{V}_{00}=5 \mathrm{~V}$ | - | 100 | - | 100 | $\mu \mathrm{A}$ |
| Input Resistance | $\mathrm{R}_{\text {iN }}$ |  | 50 | - | 50 | - | $k \Omega$ |
| Supply Current | $\mathrm{I}_{\text {Do(on) }}$ | One Driver ON, $\mathrm{V}_{00}=15 \mathrm{~V}$ | - | 5.0 | - | 5.0 | mA |
|  |  | One Driver ON, $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ | - | 1.0 | - | 1.0 | mA |
|  | $\mathrm{I}_{\text {Do(Off) }}$ | CLEAR $=0 \mathrm{~V}$, SELECT $=\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | - | 300 | - | 300 | $\mu \mathrm{A}$ |
|  |  | CLEAR $=0 \mathrm{~V}$, SELECT $=\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ | - | 100 | - | 100 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\text {sion }}$ | One Driver $0 \mathrm{~N}, \mathrm{~V}_{S}=5 \mathrm{~V}$ | - | 5.5 | - | 50 | mA |
|  |  | All Drivers $0 \mathrm{~N}, \mathrm{~V}_{s}=5 \mathrm{~V}$ | - | 45 | - | 160 | mA |
|  | $\mathrm{I}_{\text {S(OFf) }}$ | ENABLE $=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=5 \mathrm{~V}$ | - | 0.1 | - | 35 | mA |

Note: Operation of these devices with standard TLL or DTL may require the use of appropriate pull-up resistors to insure the minimum logic " l ".
CAUTION: Sprague CMOS devices have input static protection but are still susceptible to damage when exposed to extremely high static electrical charges.

TRUTH TABLE

| $\frac{\mathrm{CHIP}}{\mathrm{SELECT}}$ | $\overline{\text { CLEAR }}$ | DATA |  |  |  | OUTPUT ENABLE | $\mathrm{OUT}_{7} \mathrm{OUT}_{6} \mathrm{OUT}_{5} \mathrm{OUT}_{4} \mathrm{OUT}_{3} \mathrm{OUT}_{2} \mathrm{OUT}_{1} \mathrm{OUT}_{5}$ |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X | L | X | $x$ | X | X | X | H | H | H | H | H | H | H | H | Clear |
| H | H | X | X | X | X | H | R | R | R | R | R | R | R | R | Memory |
|  | $H$ $H$ $H$ $H$ $H$ $H$ $H$ $H$ | $\begin{aligned} & \hline D \\ & D \\ & D \\ & D \\ & D \\ & D \\ & D \\ & D \end{aligned}$ | L L H $H$ $H$ $H$ $H$ | L L H L L H H | L $H$ $L$ $H$ $L$ $H$ $H$ $H$ | H H H H H H H H | $R$ $R$ $R$ $R$ $R$ $R$ $R$ $R$ $R$ | $\begin{aligned} & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \hline \mathrm{D} \\ & \hline \end{aligned}$ | R | R R $R$ $R$ $R$ $R$ $R$ $R$ $R$ $R$ | $\begin{aligned} & R \\ & R \\ & R \\ & R \\ & R \\ & R \\ & R \\ & R \\ & R \end{aligned}$ | R R R R R R R $R$ $R$ $R$ | R | $\begin{aligned} & \hline \bar{D} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \mathrm{R} \\ & \hline \end{aligned}$ | Address Latch 0 <br> Address Latch 1 <br> Address Latch 2 <br> Address Latch 3 <br> Address Latch 4 <br> Address Latch 5 <br> Address Latch 6 <br> Address Latch 7 |
| $\begin{aligned} & \hline x \\ & x \end{aligned}$ | $\begin{aligned} & \hline x \\ & x \end{aligned}$ | $\begin{aligned} & x \\ & x \end{aligned}$ | X $\times$ | X | X | $\begin{aligned} & \mathrm{L} \\ & \mathrm{H} \end{aligned}$ | $\begin{aligned} & \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | $\begin{aligned} & \bar{H} \\ & R \end{aligned}$ | $\begin{aligned} & \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | $\begin{aligned} & \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | $\begin{aligned} & \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | $\begin{aligned} & \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | $\begin{aligned} & \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | $\begin{aligned} & \hline \mathrm{H} \\ & \mathrm{R} \end{aligned}$ | Blanking |

[^26]I/O WAVEFORMS


4

Logic Level Irrelevant


Allowable
Transition Time

TIMING CONDITIONS
(Logic Levels are $V_{D D}$ and Ground)
A. Minimum $\overline{\text { CLEAR }}$ Pulse Width ..... 300 ns
B. Minimum CHIP SELECT Pulse Width ..... 500 ns
C. Typical OUTPUT ENABLE (Blanking) Pulse Width ..... $5.0 \mu \mathrm{~s}$
D. Minimum DATA or ADDRESS Setup Time ..... 100 ns
E. Minimum DATA or ADDRESS Hold Time ..... 100 ns
F. Minimum DATA or ADDRESS Pulse Width . ..... 700 ns

## TYPICAL APPLICATIONS

A typical application for Type UCN-4808A, driving a common-cathode LED display, is shown below. Many multi-character LED displays can make use of the high-current capability of this device. With the DATA input held high, the proper address code may be furnished by a 3-bit counter. Note that with DATA held constant and the ADDRESS sequenced through the binary code, setup and hold times associated with CHIP SELECT may be ignored.

The second application illustrates the use of Type UCN-4807A or UCN-4808A as a multiplexed power driver. A wide variety of peripheral loads including lamps, relays, solenoids, LEDs, and stepper motors can be accommodated. Inductive loads require external transient suppression.

These devices can also be employed as multi-channel drivers for discrete high-current or high-voltage semiconductors.

## Common-Cathode LED Display Driver



## TYPICAL APPLICATIONS (Continued)

## Multiplexed Power Driver



Multichannel Driver
for Discrete Power Semiconductors


Dwg. No. A-11,786

# UCN-4810A <br> BiMOS 10-BIT SERIAL-INPUT, LATCHED DRIVER 

## FEATURES

- High-Voltage Source Outputs
- CMOS, PMOS, NMOS, TIL Compatible inputs
- Low-Power CMOS Logic and Latches
- Internal Pull-Down Resistors
- Wide Supply-Voltage Range

COMBINING low-power CMOS logic with bipolar source drivers, the Type UCN-4810A integrated circuit simplifies many display systems. This BiMOS 10-bit serial-input, latched driver is primarily designed for use with vacuum-fluorescent displays, but can also be used with LED and incandescent displays within its output limitations of 60 V and 40 mA per driver.

Selected devices (UCN-4810A-1) have maximum output ratings of 80 V and 40 mA per driver. In all other respects, Type UCN-4810A-1 is identical to Type UCN-4810A.

The CMOS 10-bit shift register and associated latches are designed for operation over a supplyvoltage range of 5 V to 15 V . They cause minimal loading and are compatible with standard CMOS, PMOS, and NMOS logic. When used with standard TTL or low-speed TTL, appropriate pull-up resistors may be required to ensure an input-logic high. A CMOS serial data output allows cascading these devices in multiple drive-line applications required by many dot matrix, alphanumeric, and bar graph displays.

The 10 bipolar outputs are used as segment or digit drivers in vacuum-fluorescent displays. Under normal operating conditions, the devices will source 25 mA per output at $+50^{\circ} \mathrm{C}$ and a duty cycle of $85 \%$. Other combinations of number of outputs conducting and duty cycle are shown in the specifications.


Input Voltage Range, $\mathrm{V}_{\mathbb{N}} \ldots \ldots \ldots . .$.
Continuous Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . -40 mA

Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . . .-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
*Derate at the rate of $18.18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

| Number of <br> Outputs ON | Max. Allowable Duty Cycle <br> at Ambient Temperature of |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\left(\mathrm{l}_{\text {Ouf }}=-25 \mathrm{~mA}\right)$ |  |$+25^{\circ} \mathrm{C}+40^{\circ} \mathrm{C}+50^{\circ} \mathrm{C}+60^{\circ} \mathrm{C}+70^{\circ} \mathrm{C}$.

[^27] susceptible to damage when exposed to extremely high static electrical charges.

```
ELECTRICAL CHARACTERISTICS at \(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{B B}=60 \mathrm{~V}, \mathrm{~V}_{D D}=4.75 \mathrm{~V}\) to \(15.75 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}\)
```

(unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $V_{\text {out }}$ |  | - | 1.0 | V |
| Output ON Voltage | $\mathrm{V}_{\text {out }}$ | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}, \mathrm{~V}_{\text {BB }}=60 \mathrm{~V}$ | 57.5 | - | V |
|  |  | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}, \mathrm{~V}_{\text {BB }}=80 \mathrm{~V}, \mathrm{UCN}-4810 \mathrm{~A}-1$ only | 77.5 | - | V |
| Output Pull-Down Current | $\mathrm{t}_{\text {OUT }}$ | $V_{\text {Out }}=V_{\text {BB }}$ | 400 | 850 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {OUT }}=80 \mathrm{~V}$, UCN-4810A-1 only | 550 | 1150 | $\mu \mathrm{A}$ |
| Output Leakage Current | $\mathrm{I}_{\text {out }}$ | $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {IN(I) }}$ | $V_{D 0}=5.0 \mathrm{~V}$ | 3.5 | 5.3 | V |
|  |  | $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | 13.5 | 15.3 | V |
|  | $V_{\text {IN(0) }}$ |  | -0.3 | +0.8 | V |
| Input Current | $\mathrm{I}_{\text {(1) }}$ | $V_{\text {DO }}=V_{\text {IN }}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DD }}=\mathrm{V}_{\text {iN }}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {IN }}$ | $V_{D D}=5.0 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
| Serial Data Output Resistance | $\mathrm{R}_{\text {out }}$ | $V_{D O}=5.0 \mathrm{~V}$ | - | 20 | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{V}_{\mathrm{DO}}=15 \mathrm{~V}$ | - | 6.0 | $\mathrm{k} \Omega$ |
| Supply Current | $I_{B B}$ | All outputs ON, All outputs open | - | 13 | mA |
|  |  | All outputs OFF, All outputs open | - | 200 | $\mu \mathrm{A}$ |
|  | $I_{D O}$ | $\mathrm{V}_{\text {DO }}=5.0 \mathrm{~V}$, All outputs 0FF, All inputs $=0 \mathrm{~V}$ | $\bar{\square}$ | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $V_{\text {Do }}=5.0 \mathrm{~V}$, One output 0 N, All inputs $=0 \mathrm{~V}$ | - | 1.0 | mA |
|  |  | $V_{\text {DO }}=15 \mathrm{~V}$, One output 0 N, All inputs $=0 \mathrm{~V}$ | - | 3.0 | mA |

NOTE: Positive (negative) current is defined as going into (coming out of) the specified device pin.

TYPICAL INPUT CIRCUIT
FUNCTIONAL BLOCK DIAGRAM



## TIMING CONDITIONS

(Logic Levels are $V_{D D}$ and $V_{S S}$ )

| A. | Minimum Data Active Time Before Clock Pulse (Data Set-Up Time) | 250 ns | 150 ns |
| :---: | :---: | :---: | :---: |
| B. | Minimum Data Pulse Width | 500 ns | 300 ns |
| C. | Minimum Clock Pulse Width | 600 ns | 250 ns |
| D. | Minimum Time Between Clock Activation and Strobe | $1.0 \mu \mathrm{~s}$ | 400 ns |
| E. | Minimum Strobe Pulse Width | 500 ns | 300 ns |
|  | Typical Time Between Strobe Activation and Output Transition | $1.0 \mu \mathrm{~s}$ | $1.0 \mu \mathrm{~s}$ |

SERIAL DATA present at the input is transferred to the shift register on the logic " 0 " to logic " 1 " transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to its respective latch when the STROBE is high (serial-to-parallel conversion). The latches will con-
tinue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the BLANKING input be high during serial data entry.

When the BLANKING input is high, all of the output buffers are disabled (OFF) without affecting the information stored in the latches or shift register. With the BLANKING input low, the outputs are controlled by the state of the latches.

UCN-4810A TRUTH TABLE

| Serial <br> Data <br> Input | Clock <br> Input | Shift Register Contents$I_{1} I_{2} I_{3} \ldots \ldots I_{8} I_{9} I_{10}$ | Serial <br> Data <br> Output | Strobe Input | $\frac{\text { Latch Contents }}{I_{1} I_{2} I_{3} \ldots \ldots I_{8} I_{9} I_{10}}$ | BlankingInput | Output Contents |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  | $\mathrm{I}_{1} \mathrm{l}_{2} \mathrm{I}_{3} \ldots \ldots . \mathrm{l} \mathrm{I}_{8} \mathrm{I}_{9} \mathrm{I}_{10}$ |
| H | $\boxed{\square}$ | $H R_{1} R_{2} \ldots . . R_{7} \mathrm{R}_{8} \mathrm{R}_{9}$ | $\mathrm{R}_{9}$ |  |  |  |  |
| L | $\checkmark$ | $L R_{1} R_{2} \ldots R_{7} R_{8} R_{9}$ | R9 |  |  |  |  |
| X | 2 | $\mathrm{R}_{1} \mathrm{R}_{2} \mathrm{R}_{3} \ldots \mathrm{R}_{8} \mathrm{R}_{9} \mathrm{R}_{10}$ | $\mathrm{R}_{10}$ |  |  |  |  |
|  |  | XXX...... XXX | X | L | $\mathrm{R}_{1} \mathrm{R}_{2} \mathrm{R}_{3} . . \mathrm{R}_{8} \mathrm{R}_{9} \mathrm{R}_{10}$ |  |  |
|  |  | $\mathrm{P}_{1} \mathrm{P}_{2} \mathrm{P}_{3} \ldots \mathrm{P}_{8} \mathrm{P}_{9} \mathrm{P}_{10}$ | $\mathrm{P}_{10}$ | H | $\mathrm{P}_{1} \mathrm{P}_{2} \mathrm{P}_{3} \ldots \mathrm{P}_{8} \mathrm{P}_{9} \mathrm{P}_{10}$ | L | $P_{1} P_{2} P_{3} . . P_{8} P_{9} P_{10}$ |
|  |  |  |  |  | XXX $\ldots \ldots . . . \mathrm{XXX}$ | H | LLL.......LLL |

[^28]
## UCN-4815A

BiMOS LATCH/SOURCE DRIVER

## FEATURES

- High-Voltage Source Outputs
- CMOS, PMOS, NMOS, TTL Compatible Inputs
- Low-Power CMOS Latches
- Internal Pull-Down Resistors
- Wide Supply Voltage Range

DESIGNED primarily for use with high-voltage vacuum fluorescent displays, the UCN-4815A BiMOS latch/source driver consists of eight NPN Darlington source drivers with pull-down resistors, a CMOS latch for each driver, and common strobe, blanking, and enable functions.

The CMOS inputs provide for minimum loading and are compatible with standard CMOS, PMOS, and NMOS logic commonly found in microprocessor designs. The use of CMOS latches also allows operation over a supply voltage range of 5 V to 15 V . When employed with either standard TTL or low speed TTL logic, the UCN-4815A may require the use of appropriate pull-up resistors.

The bipolar outputs may be used as segment, dot (matrix), bar, or digit drivers in vacuum fluorescent displays. All eight outputs can be activated simultaneously at ambient temperatures up to $60^{\circ} \mathrm{C}$. To simplify circuit board layout, all outputs are pinned opposite their respective inputs.

A minimum component display subsystem, requiring few or no discrete components, may be realized by using the UCN-4815A BiMOS Latch/ Source Driver with either a UCN-4805A or UCN4806A latched hexadecimal decoder/drivers or a UCN-4810A serial-to-parallel latch/driver.


ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature and $\mathbf{V}_{\text {ss }}=\mathbf{O V}$

Output Voltage, V out . . . . . . . . . . . . . . . . . . . . . . . . . . . 60 V
Logic Supply Voltage Range, $\mathrm{V}_{\mathrm{DD}} \ldots \ldots . . . .$. . . . 4.5 V to 18 V
Driver Supply Voltage Range, $\mathrm{V}_{\mathrm{BB}} \ldots \ldots . \ldots . \mathrm{I}_{5} .0 \mathrm{~V}$ to 60 V
Input Voltage Range, $\mathrm{V}_{\mathbb{N}} \ldots . . . . . . . \mathrm{I}-0.3 \mathrm{~V}$ to $\mathrm{V}_{D D}+0.3 \mathrm{~V}$
Continuous Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . -40 mA
Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . . . . 2.0 W*
Operating Temperature Range, $T_{A} \ldots \ldots .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
*Derate at the rate of $20 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

| Number of <br> Outputs 0 N | Max. Allowable Duty Cycle <br> at Ambient Temperature of |  |  |
| :---: | :---: | :---: | :---: |
| $\left(\mathrm{I}_{\text {Out }}=-25 \mathrm{~mA}\right)$ | $50^{\circ} \mathrm{C}$ | $60^{\circ} \mathrm{C}$ | $70^{\circ} \mathrm{C}$ |
| 8 | $100 \%$ | $100 \%$ | $86 \%$ |
| 7 |  |  | $98 \%$ |
| 6 |  |  | $100 \%$ |
| 1 | $100 \%$ | $100 \%$ | $100 \%$ |

Caution: Sprague CMOS devices feature input static protection but are still susceptible to damage when exposed to extremely high static electrical charges.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DO}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{OV}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output. OFF Voltage | $V_{\text {OUI }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {orf }}=-25 \mathrm{~mA}$ | 57.5 | - | $v$ |
| Output Pull-Down Current | Iout | $V_{\text {Our }}=V_{\text {BB }}$ | 400 | 850 | $\mu \mathrm{A}$ |
| Output Leakage Current |  | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {W(1) }}$ | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | 3.5 | 5.3 | V |
|  |  | $\mathrm{V}_{00}=15 \mathrm{~V}$ | 13.5 | 15.3 | V |
|  | $\mathrm{V}_{\text {IMOO }}$ |  | -0.3 | +0.8 | V |
| Input Current | $\mathrm{I}_{\text {(1) }}$ | $V_{00}=V_{\text {W }}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {OD }}=\mathrm{V}_{\text {W }}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $Z_{\text {W }}$ | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
| Supply Current | $1_{B B}$ | All outputs ON, All outputs open | - | 10.5 | mA |
|  |  | All outputs OFF | - | 100 | $\mu \mathrm{A}$ |
|  | 100 | $\mathrm{V}_{\text {OD }}=5.0 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {OD }}=15 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{00}=5.0 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 1.0 | mA |
|  |  | $\mathrm{V}_{00}=15 \mathrm{~V}$, One output $0 \mathrm{~N}, \mathrm{All}$ inputs $=0 \mathrm{~V}$ | - | 3.0 | mA |

NOTE: Positive (negative) current is defined as going into (coming out of) the specified device pin.


Dwg. No. A-10,980
TYPICAL INPUT CIRCUIT


TYPICAL OUTPUT DRIVER

## TIMING CONDITIONS


A. Minimum Data Active Time Before Strobe Enabled (Data Set-Up Time) ..... 100 ns
B. Minimum Data Active Time After Strobe Disabled (Data Hold Time) ..... 100 ns
C. Typical Strobe Pulse Width For Power-Up Clear Disable ..... 500 ns
Minimum Strobe Pulse Width After Power-Up Clear Disabled ..... 300 ns
D. Typical Time Between Strobe Activation and Output On to Off Transition ..... $1.0 \mu \mathrm{~s}$
E. Typical Time Between Strobe Activation and Output Off to On Transition ..... $1.0 \mu \mathrm{~s}$
F. Minimum Data Pulse Width ..... 500 ns

Information present at an input is transferred to its latch when the STROBE and ENABLE are high. The latches will continue to accept new data as long is both STROBE and ENABLE are held high. With either STROBE or ENABLE in the low state, no nformation can be loaded into the latches.

When the BLANKING input is high, all of the sutput buffers are disabled (OFF) without affecting he information stored in the latches. With the

BLANKING input low, the outputs are controlled by the state of the latches.

On first applying $V_{D D}$ to the device, all latch outputs assume a low state (Power-Up Clear) resulting in all outputs being OFF. The latches will remain in the low condition until the Clear is disabled by a STROBE high input. Data may be entered into the latches during Power-Up Clear disable if the ENABLE input is also high.

## SERIES UCN-4820A BiMOS 8-BIT SERIAL-INPUT, LATCHED DRIVERS

## FEATURES

- High-Voltage Current-Sink Outputs
- CMOS, PMOS, NMOS, TL Compatible
- Low-Power CMOS Logic and Latches
- Internal Pull-Up/Pull-Down Resistors
- 16-Pin Dual In-Line Plastic Packages

ACOMBINATION of bipolar and MOS technology gives Sprague's Series UCN-4820A an interface flexibility beyond the reach of standard logic buffers and power driver arrays.

The three devices in this series each have eight bipolar current-sink Darlington drivers, a CMOS data latch for each of the eight open-collector outputs, an eight-bit CMOS shift register and CMOS control circuitry. Except for maximum driver voltage ratings, Types UCN-4821A, UCN-4822A and UCN-4823A are identical.

The bipolar outputs can drive multiplexed LED displays, incandescent lamps, thermal print heads, and (with appropriate clamping techniques) relays, solenoids and other high-power inductive loads.

The CMOS shift register and latches, which operate over a 5 - to 15 -volt supply range, minimize loading and are compatible with CMOS, PMOS and NMOS logic. Use of the drivers with TTL and DTL may require a pull-up resistor to ensure an input logic high. By using the serial data output, the drivers can be cascaded for interface applications requiring additional drive lines.

These devices are also available in industrialgrade ceramic packages (Series UCQ-4820R) and in military side-brazed, hermetically sealed packages (Series UCS-4820H).


> ABSOLUTE MAXIMUM RATIMGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature and $\mathrm{V}_{\text {ss }}=0 \mathrm{~V}$

Output Voltage, $\mathrm{V}_{\text {out }}$ (UCN-4821A) . . . . . . . . . . . . . . . . 50 V
(UCN-4822A) . . . . . . . . . . . . . . . . 80 V
(UCN-4823A) ..... . . . . . . . . . . . . . 100 V
Logic Supply Voltage, $V_{D D}$. . . . . . . . . . . . . . . . . . . . . . . . 18 V
Input Voltage Range, $\mathrm{V}_{\mathbb{N}} \ldots \ldots . . . . .-0.3 \mathrm{~V}$ to $\mathrm{V}_{D 0}+0.3 \mathrm{~V}$
Continuous Output Current, $\mathrm{I}_{\text {our }}$. . . . . . . . . . . . . . . . . . 500 mA
Package Power Dissipation, $P_{0}$. .................... . . 1.67 W*
Operating Temperature Range, $T_{A} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

[^29]
## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{D D}=5 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | UCN-4812A | $\mathrm{V}_{\text {out }}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {out }}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | UCN-4822A | $V_{\text {out }}=80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {out }}=80 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | UCN-4823A | $V_{\text {OUT }}=100 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  |  | $V_{\text {OUT }}=100 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | - | 100 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $V_{\text {celsan }}$ | ALL | $\mathrm{l}_{\text {Out }}=100 \mathrm{~mA}$ | - | 1.1 | V |
|  |  |  | $\mathrm{l}_{\text {Out }}=200 \mathrm{~mA}$ | - | 1.3 | V |
|  |  |  | $\mathrm{I}_{\text {OUT }}=350 \mathrm{~mA}, \mathrm{~V}_{\text {DO }}=7.0 \mathrm{~V}$ | - | 1.6 | V |
| Input Voltage | $\mathrm{V}_{\text {IV(0) }}$ | ALL |  | - | - | V |
|  | $\mathrm{V}_{\text {I(1) }}$ | ALL | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 13.5 | - | V |
|  |  |  | $V_{D 0}=10 \mathrm{~V}$ | 8.5 | - | V |
|  |  |  | $\mathrm{V}_{\text {D }}=5.0 \mathrm{~V}$ | 3.5 | - | V |
| Input Resistance | $\mathrm{R}_{\mathbb{N}}$ | ALL | $V_{\text {DD }}=15 \mathrm{~V}$ | 50 | - | $k \Omega$ |
|  |  |  | $V_{0 D}=10 \mathrm{~V}$ | 50 | - | $k \Omega$ |
|  |  |  | $V_{\text {DD }}=5.0 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
| Supply Current | $\mathrm{I}_{\text {DOON }}$ | ALL | One Driver ON, $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | - | 2.0 | mA |
|  |  |  | One Driver ON, $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | - | 1.7 | mA |
|  |  |  | One Driver ON, $\mathrm{V}_{D D}=5.0 \mathrm{~V}$ | - | 1.0 | mA |
|  | $\mathrm{I}_{\text {dof( }}$ | ALL | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All Drivers 0FF, $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$, All Drivers OFF, $\mathrm{V}_{\mathbb{N}}=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |


| Number of <br> Outputs on <br> $\left(l_{\text {OUT }}=\right.$ | Max. Allowable Duty Cycle <br> at Ambient Temperature of |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | $200 \mathrm{~mA})$ | $25^{\circ} \mathrm{C}$ | $40^{\circ} \mathrm{C}$ | $50^{\circ} \mathrm{C}$ | $60^{\circ} \mathrm{C}$ |, $70^{\circ} \mathrm{C}$.

Caution: Sprague CMOS devices have input static protection but are still susceptible to damage when exposed to extremely high static electrical charges.


## TIMING CONDITIONS

(Logic Levels are $V_{D D}$ and $V_{S S}$ )

| A. Minimum Data Active Time Before Clock Pulse (Data Set-Up Time) | 250 ns | 150 ns |
| :---: | :---: | :---: |
| B. Minimum Data Pulse Width | 500 ns | 300 ns |
| C. Minimum Clock Pulse Width | 1.0 ms | 250 ns |
| D. Minimum Time Between Clock Activation and Strobe | $1.0 \mu \mathrm{~s}$ | 400 ns |
| E. Minimum Strobe Pulse Width | 500 ns | 300 ns |
| F. Typical Time Between Strobe Activation and Output Transition | $1.0 \mu \mathrm{~s}$ | 1.0 ms |

SERIAL DATA present at the input is transferred to the shift register on the logic ' 0 ', to logic ' 1 '" transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to its respective latch when the STROBE is high (serial-to-parallel conversion). The latches will con-
tinue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the ENABLE input be high during serial data entry.

When the ENABLE input is high, all of the output buffers are disabled (OFF) without affecting the information stored in the latches or shift register. With the ENABLE input low, the outputs are controlled by the state of the latches.

SERIES UCN-4820A TRUTH TABLE


[^30]
## FUNCTIONAL BLOCK DIAGRAM



Dwg. No. A-11,391B

## TYPICAL INPUT CIRCUITS



ClOCK
in


TYPICAL OUTPUT DRIVER


Dwg. No. A-11,390

Owg. No. A-11,389

# GROUP UCN-5800 BiMOS II HIGH-SPEED INTERFACE DRIVERS 

SPRAGUE UCN-4400 and UCN-4800 BiMOS interface integrated circuits have evolved into new and improved designs. The CMOS sections of the original BiMOS devices have been reduced in size, resulting in faster switching speeds. Second-generation BiMOS devices also provide new and improved functions, as shown in the table below.

| BiMOS II <br> Type Number | Description* | Original BiMOS |
| :--- | :--- | :---: |
| Type Number |  |  |

*Current ratings are maximum tested condition, voltage ratings are absolute maximum allowable.
These are new products. Detailed information, applications engineering assistance, samples, price, and delivery can be obtained directly from the factory in Worcester, Mass., Tel. (617) 853-5000.

## SPRAGUE BiMOS MUSCLE FOR THE MICROPROCESSOR

Sprague Electric offers solutions to users' interface problems through a fusion of bipolar and CMOS technologies in BiMOS to create innovative interface devices.

The company's ability to shape technology to meet the specific needs of users is based on a commitment to provide versatile and practical interface products for systems design.

Sprague BiMOS devices are available with:

- Output breakdown voltage ratings of up to 100 V;
- Output current ratings as high as 600 mA ;
- A logic voltage-supply range of 5 V to 15 V ( $\pm 5 \%$ );
- Logic switching speeds of up to 1 MHz at 5 V and up to 2 MHz at 12 V ;
- And up to 10 channels per dual in-line package.
Among advantages of BiMOS technology are microprocessor compatibility, low-power logic, a wide logic-supply range, component-count reduction, bipolar output capability, CMOS noise immunity, and space-saving integration.


## APPLICATIONS

The following pages make up a sampler of applications for Sprague BiMOS interface devices. Performance specifications, truth tables and timing charts for these integrated circuits appear on previous pages. Additional applications are described in the Sprague brochure WR-185, "Interface ICs for Motor Drive Applications," and in Sprague engineering bulletins covering these BiMOS devices.

## UCN-4401A and UCN-4801A

These four- and eight-bit BiMOS latch/drivers are the first Sprague IC's to incorporate CMOS logic (data latches) and bipolar drivers (NPN Darlingtonpair outputs). Functionally, the eight-bit device is the equivalent of an octal latch and an octal NPN Darlington array.

Figure 1 depicts the use of the eight-bit latch/ driver as an interface between a microprocessor and incandescent lamps. The device can also link a microprocessor with LEDs, high-power discrete semiconductors, relays or small stepper motors. Applications with inductive loads require connection of the internal transient-suppression diodes to the load's voltage supply, or use of discrete diodes. Inductive load applications should be limited to output voltages of +35 V .

Figure 2 shows use of Type UCN-4401A as an interface between a microprocessor and a stepper motor. Input signals to the four-bit device, for both unipolar wave drive and unipolar two-phase drive, are shown in Figures 3 and 4.

Type UCN-4401A can also be used to control discrete PNP transistors providing a high-power motor interface (Figure 5). Use of either singleended or split supplies is possible with this approach.

The four-bit device can be paired with a quad PNP DIP to implement full-bridge drive for a stepper motor (Figure 6).


Figure 1


Figure 2


Figure 3


Figure 4


Figure 5

## SPRAGUE BiMOS (Continued)



Figure 6

## UCN-4810A

This integrated circuit functionally replaces a 10 -bit serial-in, parallel-out shift register, a 10 -bit data latch, and 10 high-voltage buffers (including output pull-down resistors). It is designed for use with vacuum fluorescent displays, but has been put to many other uses, including control of thermal print heads.

Connecting a data-out line from one device to a data-in pin of a second device minimizes the number of input/output lines required for a system. A $20-$ character $5 \times 7$ vacuum fluorescent dot matrix display, for instance, requires only six Type UCN4810s (two as grid drivers and four as dot drivers). An example of cascaded data control is given in Figure 7. The arrangement cascades two devices for grid selection and four as dot drivers.

Data sent to the four dot drivers can be loaded in less than $80 \mu \mathrm{~s}$ using this configuration. The shiftrate limit of the dot drivers is $500 \mathrm{kHz} \mathrm{at} \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.

The two units that function as grid drivers are loaded with a single " 1 "' during each scan cycle. The minimum recommended scan frequency is 100 Hz per character (a clock frequency of 2 kHz for a 20 -character display).

Since blanking ( $20 \mu \mathrm{~s}$ minimum) is required between characters, and since the minimum ON time for each digit or character is $100 \mu \mathrm{~s}$, the maximum number of characters in a display is $80(8 \mathrm{kHz}$ clock, $125 \mu_{\mathrm{S}} \mathrm{ON}$ and blanking time per character).
The typical ON time for vacuum fluorescent characters is $200 \mu \mathrm{~s}$ ( 40 -character panel) to $500 \mu \mathrm{~s}$ (20-character display). Failure to provide proper blanking time can cause ghosting or flicker.

A faster method of loading matrix data, shown in Figure 8, requires more I/O lines. This technique loads shift registers during a blanking period (greater than $20 \mu \mathrm{~s}$ ). Each dot driver has a separate data-input line, but uses common clock, strobe and blanking lines. A second clock is used with the grid drivers.
A typical data-input timing chart for this configuration is shown in Figure 9. With a 20 -character vacuum fluorescent display having a 2 kHz scan frequency, 10 bits of data are loaded during the first blanking period; succeeding 10 -bit data blocks are loaded during blanking periods at $400 \mu$ s intervals.

A more unusual application of Type UCN-4810A is shown in Figure 10: The device is used with a thermal printer. In production, the drivers (in chip form) were built into a hybrid assembly.


Figure 7


Figure 8


Figure 9


Figure 10


Figure 11


Figure 12

## UCN-4815

Type UCN-4815A provides an eight-bit parallelin, parallel-out interface for vacuum fluorescent displays. A typical application appears in Figure 11. A pair of Type ICN-4810As are used for grid control. The two Type UCN-4815As drive a 16 -segment alphanumeric display.

## UCN-4805A

Type UCN-4805A has eight high-voltage source outputs, latched inputs, and both the hexadecimal decoding and speed capabilities for microprocessorbased designs. The device is used to decode and drive seven-segment displays. Its eighth source output is used to generate a colon or decimal point.

A typical application with a 20 -character vacuum fluorescent display is shown in Figure 12. Type UCN-4805A is used as a seven-segment decoder/ driver. A pair of Type UCN-4810As is used for gridselect.

## SERIES UCN-4820A

The drivers in this series were designed for use in printers. Each integrated circuit has an eight-bit serial-input shift register, an eight-bit data latch, and eight NPN Darlington-pair outputs. The data entry rate for this series is 500 kHz (minimum) at $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.

A typical application appears in Figure 13; although the drawing depicts use with an electrosensitive printer, the device can also control inductive loads such as print hammers and solenoids, or thermal print heads.

Use of Types ICN-4823A and UCN-4810A-1 is combined in the planar gas-discharge display application shown in Figure 14. Type UCN-4810A-1 signal inputs are level-shifted (floated to the $\mathrm{V}_{\mathrm{BB}}$ supply level). The application requires external segment limiting and pull-up resistors and use of Zener diodes.


Figure 13


Figure 14

> HIGH-CURRENT INTERFACE DRIVERS

## BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS

MILITARY AND AEROSPACE DEVICES
RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

## AUDIO POWER AMPLIFIERS

hall effect devices


## SECTION 5-MILITARY AND AEROSPACE DEVICES

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NOTE: Most devices described in Sections 2, 3, and 4 can also be supplied in extended-temperature hermetic packages. Contact the local sales office or factory for additional information.

# SERIES 400, 400-1, AND 500 HERMETICALLY SEALED POWER AND RELAY DRIVERS 

## FEATURES

- 500 mA Output Sink Current Capability
- DTL/TTL Compatible Inputs
- Transient Protected Outputs on Relay Drivers
- High Voltage Output - 100 V Series 500, 70V Series 400-1, and 40V Series 400
- Hermetically Sealed Packages to MIL-M-38510
- High-Reliability Screening to MIL-STD-883, Class B


## Description

These Series $400,400-1$, and 500 hermetically sealed power and relay drivers are bipolar monolithic circuits incorporating both logic gates and high-current switching transistors on the same chip. Each device contains four drivers capable of sinking 500 mA in the ON state. In the OFF state, Series 400 devices will sustain 40V, Series 400-1 devices will sustain 70V, and Series 500 devices will sustain 100V.

All devices are available in either a 14-pin hermetic flat-pack package (Types UHC-) or a 14-pin hermetic dual in-line package (Types UHD-). These packages conform to the dimensional requirements of Military Specification MIL-M-38510 and meet all of the processing and environmental requirements of Military Standard MIL-STD-883, Method 5004 and 5005. These devices are also furnished in a plastic 14 -pin dual in-line package (Types UHP-) for operation over a limited temperature range.

## Applications

The UHC- and UHD- Series 400, 400-1, and 500 power and relay drivers are ideally suited for driving incandescent lamps, relays, solenoids, and other interface devices with up to 1A output current per package. Hermetic sealing and an operating temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ recommend them for military and aerospace applications as well as commercial and industrial control applications where severe environments may be encountered.

RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage (VCC) | 4.5 | 5.0 | 5.5 | V |
| Operating Temperature Range | -55 | +25 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) |  |  | 250 | mA |

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ ..... 7 V
Input Voltage, $V_{\text {in }}$ : ..... 5.5V
Output Off-state Voltage, $\mathrm{V}_{\text {off }}$ :
Series UHC-400 and UHD-400 ..... 40V
Series UHC-400-1 and UHD-400-1 ..... 70 V
Series UHC-500 and UHD-500 ..... 100 V
Output On-State Sink Current, Ion. ..... 500 mA
Suppression Diode Off-State Voltage, $V_{\text {off }}$.
Series UHC-400 and UHD-400. ..... 40V
Series UHC-400-1 and UHD-400-1 ..... 70 V
Series UHC-500 and UHD-500. ..... 100 V
Suppression Diode On-State Current, I I ..... 500 mA
Operating Free-Air Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. |  |  |
| "1" Input Voltage | $V_{\text {in }}(1)$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {in }}(0)$ |  | MIN |  |  |  |  |  | 0.8 | V |  |
| " 0 " Input Current at all Inputs except Strobe | $\mathrm{I}_{\text {in(0) }}$ |  | MAX | 0.4 V | 4.5 V |  |  | $-0.55$ | -0.8 | mA | 1,2 |
| " 0 " Input Current at Strobe | In(0) |  | MAX | 0.4 V | 4.5 V |  |  | -1.1 | -1.6 | mA | 2 |
| " 1 " Input Current at all Inputs except Strobe | I in(1) |  | MAX | 2.4 V | OV |  |  |  | 40 | $\mu \mathrm{A}$ | 1 |
|  |  |  | MAX | 5.5 V | OV |  |  |  | 1 | mA | 1 |
| "1" Input Current at Strobe | $\operatorname{lin}(1)$ |  | MAX | 2.4 V | OV |  |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | MAX | 5.5 V | OV |  |  |  | 1 | mA |  |
| " 1 " Output Reverse Current <br> Series 400 <br> Series 400-1 <br> Series 500 | loff |  | MIN |  |  | 40 V |  |  | 100 | $\mu \mathrm{A}$ | 6 |
|  |  |  | MIN |  |  | 70 V |  |  | 100 | $\mu \mathrm{A}$ | 6 |
|  |  |  | MIN |  |  | 100 V |  |  | 100 | $\mu \mathrm{A}$ | 6 |
| "0" Output Voltage | $V_{\text {on }}$ | NOM | MIN |  |  | 150 mA |  |  | 0.5 | V | 6 |
|  |  | NOM | MIN |  |  | 250 mA |  |  | 0.7 | V | 6 |
|  |  | MAX | MIN |  |  | 150 mA |  |  | 0.6 | V | 6 |
|  |  | MAX | MIN |  |  | 250 mA |  |  | 0.8 | V | 6 |
| Diode Leakage Current | ILK | NOM | NOM |  |  | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM |  |  |  |  | 1.5 | 1.75 | V | 2,4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX |  |  |  |  |  | 7.5 | mA | 5,6 |
| "0" Level Supply Current | Icc(0) | NOM | MAX |  |  |  |  |  | 26.5 | mA | 5,6 |

NOTES:

1. Each input.
2. Typical values are at $\mathrm{V}_{\mathrm{Cc}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Measured at $V_{R}=V_{\text {off(min) }}$.
4. Measured at $\mathrm{I}_{\mathrm{f}}=200 \mathrm{~mA}$.
5. Each gate.
6. Input test conditions are listed in Table IV.

Table IV
INPUT CONDITIONS FOR OUTPUT CHARACTERISTIC MEASUREMENTS

| Type UHC- or UHD- | $\begin{aligned} & \text { " } 1 \text { " Output Reverse } \\ & \text { Current ( } l_{\text {off }} \text { ) } \end{aligned}$ |  | "0" Output Voltage ( $\mathrm{V}_{\mathrm{on}}$ ) |  | " 1 " Level Supply Current (Icciii) |  | " 0 " Level Supply Current ( $\mathrm{Icc}_{\mathrm{cc} .}$ ) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Driven Input | Other Input | Driven Input | Other Input | Driven Input | Other Input | Driven Input | Other Input |
| 400, 400-1, 500 | 2.0 V | 2.0 V | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 5.0 V | 5.0 V | OV | OV |
| 402, 402-1, 502 | 2.0 V | 2.0 V | 0.8 V | 0.8 V | 5.0 V | 5.0 V | OV | ov |
| 403, 403-1, 503 | 2.0 V | OV | 0.8 V | 0.8 V | 5.0 V | 5.0 V | OV | OV |
| 406, 406-1, 506 | 2.0 V | 2.0 V | 0.8 V | $V_{c c}$ | 5.0 V | 5.0 V | OV | OV |
| 407, 407-1, 507 | 0.8 V | $\mathrm{V}_{\text {cc }}$ | 2.0 V | 2.0 V | OV | OV | 5.0 V | 5.0 V |
| 408, 408-1, 508 | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 2.0 V | 2.0 V | OV | OV | 5.0 V | 5.0 V |
| 432, 432-1, 532 | 0.8 V | 0.8 V | 2.0 V | OV | OV | OV | 5.0 V | 5.0 V |
| 433, 433-1, 533 | 0.8 V | 0.8 V | 2.0 V | OV | OV | OV | 5.0 V | 5.0V |

SWITCHING CHARACTERISTICS at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Turn-on Delay Time | $t_{\text {pdo }}$ |  |  |  |  |  |
| Series 400 |  | $\mathrm{V}_{\mathrm{S}}=40 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=265 \Omega$ (6 Watts) |  |  | 750 | ns |
| Series 400-1 |  | $\mathrm{V}_{\mathrm{S}}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega$ (10 Watts) |  |  | 750 | ns |
| Series 500 |  | $V_{S}=100 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=670 \Omega$ (15 Watts) |  |  | 750 | ns |
| Turn-off Delay Time | $t_{\text {pd } 1}$ |  |  |  |  |  |
| Series 400 |  | $\mathrm{V}_{S}=40 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=265 \Omega$ (6 Watts) |  |  | 500 | ns |
| Series 400-1 |  | $V_{S}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega$ (10 Watts) |  |  | 500 | ns |
| Series 500 |  | $V_{S}=100 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=670 \Omega$ (15 Watts) |  |  | 500 | ns |

## Typical Switching Test Circuit



INPUT PULSE CHARACTERISTICS

| $V_{\text {in }(0)}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~s}$ |
| :--- | :--- | :---: |
| $\mathrm{~V}_{\text {in }(1)}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{r}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |

## Device Pinning



UHC-403
UHC-403-1
UHC-503


UHC-408
UHC-408-1 UHC-508


UHC-406
UHC-406-1
UHC-506


UHC-432
UHC-432-1
UHC-532


UHC-402
UHC-402-1 UHC-502


UHC-407
UHC-407-1 UHC-507


UHC-433
UHC-433-1
UHC-533


## SERIES ULS-2000H AND ULS-2000R HIGH-VOLTAGE, HIGH-CURRENT DARLINGTON TRANSISTOR ARRAYS

## FEATURES

- TTL, DTL, PMOS, or CMOS Compatible Inputs
- Peak Output Current to 600 mA
- Transient Protected Outputs
- Side-Brazed Hermetic Package, or
- Cer-DIP Package
- High-Reliability Screening Available
- Wide Operating Temperature Ranges

COMPRISED of seven silicon NPN Darlington power drivers on a common monolithic substrate, the Series ULS-2000H and ULS-2000R arrays are ideally suited for driving relays, solenoids, lamps, and other devices with up to 3.0 A output current per package. Both hermetically sealed package styles are rated for operation over the temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$, recommending them for military and aerospace applications or in commercial and industrial applications where severe environments may be encountered.

The 25 integrated circuits permit the circuit designer to select the optimum device for any application. There are two packages, five input characteristics, two output voltages, and two output currents covered by the listings. The appropriate part for use in specific applications can be determined from the Device Type Number Designation chart. Note that the high-voltage devices $\left(B V_{C E} \geq\right.$ 95 V ) are available in the Series ULS -2000 H only. All units feature open collector outputs and integral diodes for inductive load transient suppression.


All series ULS-2000H arrays are furnished in a 16pin side-brazed dual in-line hermetic package that conforms to the dimensional requirements of Military Specification MIL-M-38510 and meets the processing and environmental requirements of Military Standard MIL-STD.-883, Methods 5004 and 5005.

Device Type Number Designation

| $V_{\text {CEmax) }}=$ | 50 V | 50 V | 95 V |
| :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {c(max) }}=$ | 500 mA | 600 mA | 500 mA |
|  | Type Number |  |  |
| General-Purpose | ULS-2001R | ULS-2011R |  |
| PMOS, CMOS | ULS-2001H | ULS-2001H | ULS-2021H |
| 14-25 V | ULS-2002R | ULS-2012R |  |
| PMOS | ULS-2002H | ULS-2012H | ULS-2022H |
| 5V | ULS-2003R | ULS-2013R |  |
| TL, CMOS | ULS-2003H | ULS-2013H | ULS-2023H |
| 6-15 V | ULS-2004R | ULS-2014R |  |
| CMOS, PMOS | ULS-2004H | ULS-2014H | ULS-2024H |
| High-Output | ULS-2005R | ULS-2015R |  |
| TL | ULS-2005H | ULS-2015H | ULS-2025H |

ABSOLUTE MAXIMUM RATINGS
Output Voltage, $\mathrm{V}_{\text {CE }}$ (Series 2000*, 2010*) ..... 50 V
(Series ULS-2020H) ..... 95 V
Input Voltage, $\mathrm{V}_{\mathbb{N}}($ Series 2002*, 2003*, 2004*) ..... 30 V
(Series 2005*) ..... 15 V
Peak Output Current, Iout (Series $2000^{*}$, ULS-2020H) ..... 500 mA
(Series 2010*) ..... 600 mA
Ground Terminai Current, $\mathrm{I}_{\text {Gvo }}$ ..... 3.0 A
Continuous Input Current, $I_{\text {I }}$ ..... 25 mA
Power Dissipation, $P_{0}$ (one Darlington pair) ..... 1.0 W
(total package) See Graphs
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## PARTIAL SCHEMATICS

Series 2001*
(each driver)


## Series 2002*

(each driver)


DWG. Ho. A-9650

Series 2003*
(each driver)


DWG. No. A-965।

DW3. RO. A-9595

Series 2004*
(each driver)

Series 2005*
(each driver)


DWG. NO. A-9898A

G. No. 1-10.228
*Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See following part number description.

## SERIES ULS-2000H AND ULS-2000R

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions |  |  | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Temp. |  | Fig. | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | All |  | $\mathrm{V}_{\text {cE }}=50 \mathrm{~V}$ | 1 A | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | 2002* |  | $V_{\text {CE }}=50 \mathrm{~V}, \mathrm{~V}_{\text {IV }}=6 \mathrm{~V}$ | 1B | - | - | 500 | $\mu \mathrm{A}$ |
|  |  | 2004* |  | $\mathrm{V}_{\mathrm{CE}}=50 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{IN}}=1 \mathrm{~V}$ | 1B | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $V_{\text {CEISAT) }}$ | All | Min. | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=850 \mu \mathrm{~A}$ | 2 | - | 1.6 | 1.8 | $V$ |
|  |  |  |  | $I_{C}=200 \mathrm{~mA}, I_{B}=550 \mu \mathrm{~A}$ | 2 | - | 1.3 | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | $V$ |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | 2 | - | 1.25 | 1.6 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | 2 | - | 0.9 | 1.1 | $V$ |
|  |  |  | Max. | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | 2 | - | 1.6 | 1.8 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.3 | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
| Input Current | $1_{\text {m(ON) }}$ | 2002* |  | $V_{\text {W }}=17 \mathrm{~V}$ | 3 | 480 | 850 | 1300 | $\mu \mathrm{A}$ |
|  |  | 2003* |  | $\mathrm{V}_{\text {W }}=3.85 \mathrm{~V}$ | 3 | 650 | 930 | 1350 | $\mu \mathrm{A}$ |
|  |  | 2004* |  | $V_{\text {W }}=5 \mathrm{~V}$ | 3 | 240 | 350 | 500 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {if }}=12 \mathrm{~V}$ | 3 | 650 | 1000 | 1450 | $\mu \mathrm{A}$ |
|  |  | 2005* |  | $V_{10}=3 \mathrm{~V}$ | 3 | 1180 | 1500 | 2400 | $\mu \mathrm{A}$ |
|  | $1_{\text {wrofe }}$ | All | Max. | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 4 | 25 | 50 | - | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {IMON) }}$ | 2002* | Min. | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 18 | V |
|  |  |  | Max. | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 13 | $V$ |
|  |  | 2003* | Min. | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 3.3 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | 5 | - | - | 3.6 | $V$ |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 3.9 | $V$ |
|  |  |  | Max. | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 2.4 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | 5 | - | - | 2.7 | $V$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 3.0 | $V$ |
|  |  | 2004* | Min. | $V_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | -5 | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 8.0 | V |
|  |  |  |  | $V_{C E}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | 5 | - | - | 10 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 12 | V |
|  |  |  | Max. | $\mathrm{V}_{\mathrm{Cg}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | 5 | - | - | 5.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 6.0 | V |
|  |  |  |  | $V_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | 5 | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 8.0 | V |
|  |  | 2005* | Min. | $V_{C E}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 3.0 | V |
|  |  |  | Max. | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 2.4 | V |
| D-C Forward Current Transfer Ratio | $h_{\text {fE }}$ | 2001* | Min. | $V_{C E}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 2 | 500 | - | - | - |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 2 | 1000 | - | - | - |
| Input Capacitance | $\mathrm{C}_{1 \times}$ | All | $+25^{\circ} \mathrm{C}$ |  | - | - | 15 | 25 | pF |
| Turn-On Delay | $t_{\text {PH }}$ | All | $+25^{\circ} \mathrm{C}$ | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 250 | 1000 | ns |
| Turn-Off Delay | $t_{\text {PM1 }}$ | All | $+25^{\circ} \mathrm{C}$ | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 250 | 1000 | ns |
| Clamp Diode Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | All |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | - | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | All |  | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | 7 | - | 1.7 | 2.0 | V |

*Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See
following part number description.
Note 1: All limits stated apply to the complete Darlington series except as specified for a single device type.
Note 2: The $I_{\text {INOFf) }}$ current limit guarantees against partial turn-on of the output.
Note 3: The $V_{\text {IM(ON) }}$ voltage limit guarantees a minimum output sink current per the specified test conditions.

## SERIES ULS-2010H AND ULS-2010R

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)


[^31]Note 1: All limits stated apply to the complete Darlington series except as specified for a single device type.
Note 2: The $I_{\text {IN(off) }}$ current limit guarantees against partial turn-on of the output.
Note 3: The $V_{\mathbb{N}(O N)}$ voltage limit guarantees a minimum output sink current per the specified test conditions.

## SERIES ULS-2020H

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Test Conditions |  |  | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Temp. |  | Fig. | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{ICEX}^{\text {cex }}$ | All |  | $\mathrm{V}_{\text {ct }}=95 \mathrm{~V}$ | 1 A | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | ULS-2022H |  | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~V}_{\mathrm{W}}=6 \mathrm{~V}$ | 18 | - | - | 500 | $\mu \mathrm{A}$ |
|  |  | ULS-2024H |  | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~V}_{\mathrm{W}}=1 \mathrm{~V}$ | 1B | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CESAI }}$ | All | Min. | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=850 \mu \mathrm{~A}$ | 2 | - | 1.6 | 1.8 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=550 \mu \mathrm{~A}$ | 2 | - | 1.3 | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | $V$ |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | 2 | - | 1.25 | 1.6 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | 2 | - | 0.9 | 1.1 | V |
|  |  |  | Max. | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | 2 | - | 1.6 | 1.8 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.3 | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
| Input Current | $I_{\text {maow }}$ | ULS-2022H |  | $\mathrm{V}_{\text {iN }}=17 \mathrm{~V}$ | 3 | 480 | 850 | 1300 | $\mu \mathrm{A}$ |
|  |  | ULS-2023H |  | $V_{\text {IN }}=3.85 \mathrm{~V}$ | 3 | 650 | 930 | 1350 | $\mu \mathrm{A}$ |
|  |  | ULS-2024H |  | $V_{\text {WV }}=5 \mathrm{~V}$ | 3 | 240 | 350 | 500 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\text {W }}=12 \mathrm{~V}$ | 3 | 650 | 1000 | 1450 | $\mu \mathrm{A}$ |
|  |  | ULS-2025H |  | $\mathrm{V}_{\mathrm{W}}=3 \mathrm{~V}$ | 3 | 1180 | 1500 | 2400 | $\mu \mathrm{A}$ |
|  | $1_{\text {IVOFF) }}$ | All | Max. | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 4 | 25 | 50 | - | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {IMON }}$ | ULS-2022H | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 18 | $V$ |
|  |  |  | Max. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 13 | V |
|  |  | ULS-2023H | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 3.3 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | 5 | - | - | 3.6 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 3.9 | V |
|  |  |  | Max. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 2.4 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | 5 | - | - | 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 3.0 | V |
|  |  | ULS-2024H | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | 5 | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 8.0 | V |
|  |  |  |  | $V_{C E}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | 5 | - | - | 10 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 12 | V |
|  |  |  | Max. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | 5 | - | - | 5.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CF }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | 5 | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {cF }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 8.0 | V |
|  |  | ULS-2025H | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 3.0 | V |
|  |  |  | Max. | $V_{C E}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 2.4 | V |
| D-C Forward Current Transfer Ratio | $\mathrm{h}_{\mathrm{FE}}$ | ULS-2021H | Min. | $V_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 2 | 500 | - | - | - |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 2 | 1000 | - | - | - |
| Input Capacitance | $\mathrm{C}_{\text {W }}$ | All | $+25^{\circ} \mathrm{C}$ |  | - | - | 15 | 25 | pF |
| Turn-On Delay | $\mathrm{t}_{\text {PH }}$ | All | $+25^{\circ} \mathrm{C}$ | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {evt }}$ | - | - | 250 | 1000 | ns |
| Turn-Off Delay | $t_{\text {PHI }}$ | All | $+25^{\circ} \mathrm{C}$ | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 250 | 1000 | ns |
| Clamp Diode Leakage Current | $I_{R}$ | All |  | $\mathrm{V}_{\mathrm{R}}=95 \mathrm{~V}$ | 6 | - | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | All |  | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | 7 | - | 1.7 | 2.0 | V |

Note 1: All limits stated apply to the complete Darlington series except as specified for a single device type.
Note 2: The $\mathrm{I}_{\text {IN(Off) }}$ current limit guarantees against partial turn-on of the output.
Note 3: The $V_{\mathbb{I N}(O N)}$ voltage limit guarantees a minimum output sink current per the specified test conditions.

## TEST FIGURES



FIGURE IA


FIGURE 2



FIGURE IB


FIGURE 3


FIGURE 4


FIGURE 5


FIGURE 6

## SERIES ULS-2000H

## PEAK COLLECTOR CURRENT

AS A FUNCTION OF DUTY CYCLE
$\mathrm{AT}+50^{\circ} \mathrm{C}$


AT $+100^{\circ} \mathrm{C}$

$\mathrm{AT}+\mathbf{7 5}^{\circ} \mathrm{C}$


AT $+125^{\circ} \mathrm{C}$


## SERIES ULS-2000R

PEAK COLLECTOR CURRENT
AS A FUNCTION OF DUTY CYCLE


ALLOWABLE PACKAGE POWER DISSIPATION SERIES ULS-2000H AND ULS-2000R


COLLECTOR CURRENT AS A FUNCTION OF INPUT CURRENT


COLLECTOR CURRENT
AS A FUNCTION OF SATURATION VOLTAGE


## SERIES ULS-2000H AND ULS-2000R PART NUMBERING SYSTEM



MIL = MILITARY GRADE WITH SCREENING TO MIL-STD-883, CLASS B

PACKAGE DESIGNATION.
$\mathrm{C}=$ UNPACKAGED CHIP
H = GLASS/METAL HERMETIC, DUAL IN-LINE
$A=$ PLASTIC, DUAL $\operatorname{IN}$-LINE
$R=$ CERAMIC/GLASS HERMETIC, DUAL IN-LINE
DEVICE INPUT CHARACTERISTICS
$1=$ GENERAL PURPOSE PMOS/CMOS
$2=14-25 \mathrm{~V}$ PMOS
$3=5 \mathrm{~V}$ TTLCMOS
$4=6-15 \mathrm{~V}$ CMOS/PMOS
$5=$ HIGH-OUTPUT TTL
DEVICE OUTPUT CHARACTERISTICS
$0=50 \mathrm{~V}$ AND 500 mA MAXIMUM
$1=50 \mathrm{~V}$ AND 600 mA MAXIMUM
$2=95 \mathrm{~V}$ AND 500 mA MAXIMUM (PACKAGE H OR A ONLY) DEVICE TYPE NUMBER (4 DIGITS IN 2000 SERIES)

OPERATING AMBIENT TEMPERATURE RANGE.

$$
\mathrm{N}=\text { COMMERCIAL }\left(-20^{\circ} \mathrm{C} T O+85^{\circ} \mathrm{C}\right)
$$

$Q=$ EXTENDED $\left(-40^{\circ} \mathrm{C} T 0+85^{\circ} \mathrm{C}\right)$
$S=$ FULL MILITARY $\left(-55^{\circ} \mathrm{C} T 0+125^{\circ} \mathrm{C}\right)$
FAMILY.

## INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE

## SERIES 2002*




SERIES 2004*



[^32]
# ULS-2064H THROUGH ULS-2077H 1.25 A QUAD DARLINGTON SWITCHES 

## FEATURES

- TTL, DTL, PMOS, or CMOS Compatible Inputs
- Transient-Protected Outputs
- Hermetically Sealed Package to MIL-M-38510
- High-Reliability Screening to MIL-STD-883, Class B

INTENDED FOR MILITARY, aerospace, and related applications, ULS-2064H through ULS-2077H high-voltage high-current integrated circuit switches will interface from low-level logic to a variety of peripheral loads such as relays, solenoids, d-c and stepping motors, multiplexed LED and incandescent displays, heaters, and similar loads up to $400 \mathrm{~W}(1.25 \mathrm{~A}$ per output, $80 \mathrm{~V}, 12.5 \%$ duty cycle, $+50^{\circ} \mathrm{C}$ ).

The devices are specified with a minimum output breakdown of 50 volts, and $V_{C E(S U S)}$ minimum of 35 volts measured at 100 mA , or a minimum output breakdown of 80 volts, $\mathrm{V}_{\text {CE(SUS) }}$ minimum of 50 volts, and an output current specification of 1.25 A (saturated).

Types ULS-2064H, ULS-2065H, ULS-2068H and ULS-2069H are designed for use with TTL, DTL, Schottky TTL, and 5 V CMOS logic.

Types ULS-2066H, ULS-2067H, ULS-2070H and ULS-2071H are intended for use with 6 V to 15 V CMOS and PMOS input circuits.

All eight of these devices include integral transient suppression diodes for use with inductive loads.

Types ULS-2068H and ULS-2069H incorporate a pre-driver stage requiring a 5 V supply rail. Types ULS-2070H and ULS-2071H include an added gain stage requiring a 12 V (nominal) supply rail. The input drive requirements for these devices are reduced, while the output can switch currents up to 1.5 A .

Types ULS-2074H through ULS-2077H are intended for use in emitterfollower or similar isolated Darlington applications where common-emitter versions cannot be used. These circuits are identical with the ULS-2064H through ULS-2067H types except for the isolated Darlington pin-out and the omission of the suppression diodes.

All twelve Quad Darlington Switches are supplied in 16-pin hermetic dual-in-line packages. They meet the processing and environmental requirements of MIL-STD-883 Methods 5004 and 5005, and the dimensional requirements of MIL-M-38510.


ULS-2064H THROUGH ULS-2067H


ULS-2068H THROUGH ULS-2071H


ULS-2074H
THROUGH ULS-2077H

## ABSOLUTE MAXIMUM RATINGS <br> at $25^{\circ} \mathrm{C}$ Free-Air Temperature <br> for any one driver <br> (unless otherwise noted)

| utput Voltage, $\mathrm{V}_{\mathrm{c}}$ | See Below |
| :---: | :---: |
| Output Sustaining Voltage, $\mathrm{V}_{\text {CEISUS }}$ | See Below |
| Output Current, $\mathrm{I}_{\text {out }}$ (Note 1) | . 5 |
| Input Voltage, $\mathrm{V}_{\mathbb{N}}$ (Note 2) | See Below |
| input Current, $\mathrm{I}_{\mathrm{B}}$ (Note 3) | 25 mA |
| Supply Voltage, V ${ }_{\text {S }}$ (ULS-2068/69H) | 10 V |
| (ULS-2070/71H) | 20 V |
| Total Package Power Dissipation | See Graph |
| Power Dissipation, $\mathrm{P}_{\mathrm{D}} /$ Output | 2.2 W |
| Operating Ambient Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | 0 $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | 0 $+150^{\circ} \mathrm{C}$ |

## PACKAGE POWER DISSIPATION

 AS A FUNCTION OF TEMPERATURE

| Type Number | $V_{C E X}$ (max.) | $V_{\text {CESSUS }}$ (min.) | $V_{\text {W }}$ (max.) | Application |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { ULS-2064H } \\ & \text { ULS-2065H } \end{aligned}$ | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 15 \mathrm{~V} \\ & 15 \mathrm{~V} \end{aligned}$ | TLL, DTL, Schottky TLL, and 5 V CMOS |
| $\begin{aligned} & \text { ULS-2066H } \\ & \text { ULS-2067H } \end{aligned}$ | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 30 \mathrm{~V} \end{aligned}$ | 6 to 15 V CMOS and PMOS |
| $\begin{aligned} & \text { ULS-2068H } \\ & \text { ULS-2069H } \end{aligned}$ | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 15 \mathrm{~V} \\ & 15 \mathrm{~V} \end{aligned}$ | TLL, DTL, Schottky TL, and 5 V CMOS |
| $\begin{aligned} & \text { ULS-2070H } \\ & \text { ULS-2071H } \end{aligned}$ | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 30 \mathrm{~V} \end{aligned}$ | 6 to 15 V CMOS and PMOS |
| $\begin{aligned} & \text { ULS-2074H } \\ & \text { ULS-2075H } \end{aligned}$ | $\begin{aligned} & 50 \mathrm{~V} \\ & 80 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 35 \mathrm{~V} \\ & 50 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & 60 \mathrm{~V} \end{aligned}$ | General Purpose |
| $\begin{aligned} & \text { ULS-2076H } \\ & \text { ULS-2077H } \end{aligned}$ | $\begin{array}{r} 50 \mathrm{~V} \\ 80 \mathrm{~V} \\ \hline \end{array}$ | $\begin{array}{r} 35 \mathrm{~V} \\ 50 \mathrm{~V} \\ \hline \end{array}$ | $\begin{aligned} & 30 \mathrm{~V} \\ & \mathrm{GOV} \end{aligned}$ | 6 to 15 V CMOS and PMOS |

Notes:

1. For allowable combinations of output current, number of outputs conducting, and duty cycle, see graphs following.
2. Input voltage is with reference to the substrate (no connection to any other pins) for the ULS-2074/75/76/77H, reference is ground for all other types.
3. Input current may be limited by maximum allowable input voltage.

## ULS-2064H THROUGH ULS-2067H

## PARTIAL SCHEMATIC



DWG. no. A-10, 353
ULS-2064H
ULS-2065H
ULS-2066H
ULS-2067H

$$
\begin{aligned}
& \mathrm{R}_{\mathbb{N}}=350 \Omega \\
& \mathrm{R}_{\mathbb{N}}=3 \mathrm{k} \Omega
\end{aligned}
$$



## ULS-2068H THROUGH ULS-2071H

## PARTIAL SCHEMATIC

ULS-2068H ULS-2069H ULS-2070H ULS-2071H

$$
\begin{aligned}
& R_{\mathbb{N}}=2.5 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{S}}=900 \Omega \\
& \mathrm{R}_{\mathbb{N}}=11.6 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{S}}=3.4 \mathrm{k} \Omega
\end{aligned}
$$



## ULS-2074H THROUGH ULS-2077H

## PARTIAL SCHEMATIC



$$
\begin{array}{ll}
\begin{array}{l}
\text { ULS-2074H } \\
\text { ULS-2075H }
\end{array} & R_{\mathbb{N}}=350 \Omega \\
\text { ULS-2076H } & R_{\mathbb{N}}=3 \mathrm{k} \Omega \\
\begin{array}{l}
\text { ULS-2077H }
\end{array} &
\end{array}
$$



## ULS-2064H THROUGH ULS-2067H

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices |  | Test Conditions |  | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Temp. |  | Fig. | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{l}_{\text {cex }}$ | ULS-2064/66H |  | $\mathrm{V}_{\text {cE }}=50 \mathrm{~V}$ | 1 | - | 500 | $\mu \mathrm{A}$ |
|  |  | ULS-2065/67H |  | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}$ | 1 | - | 500 | $\mu \mathrm{A}$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {cessus) }}$ | ULS-2064/66H |  | $\mathrm{T}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=0.4 \mathrm{~V}$ | 2 | 35 | - | V |
|  |  | ULS-2065/67H |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=0.4 \mathrm{~V}$ | 2 | 50 | - | V |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {celsal }}$ | All | $-55^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=1.1 \mathrm{~mA}$ | 3 | - | 1.35 | V |
|  |  |  |  | $\mathrm{T}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=1.7 \mathrm{~mA}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.25 \mathrm{~mA}$ | 3 | - | 1.75 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=3.75 \mathrm{~mA}$ | 3 | - | 1.95 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=625 \mu \mathrm{~A}$ | 3 | - | 1.20 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=935 \mu \mathrm{~A}$ | 3 | - | 1.35 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=1.25 \mathrm{~mA}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.0 \mathrm{~mA}$ | 3 | - | 1.75 | V |
|  |  |  | $+125^{\circ}$ | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=625 \mu \mathrm{~A}$ | 3 | - | 1.35 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=935 \mu \mathrm{~A}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=1.25 \mathrm{~mA}$ | 3 | - | 1.75 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=2.0 \mathrm{~mA}$ | 3 | - | 1.95 | V |
| Input Current | In(mon) | ULS-2064/65H |  | $\mathrm{V}_{\mathrm{W}}=2.4 \mathrm{~V}$ | 4 | - | 4.3 | mA |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=3.75 \mathrm{~V}$ | 4 | - | 9.6 | mA |
|  |  | ULS-2066/67H |  | $\mathrm{V}_{\mathrm{W}}=5.0 \mathrm{~V}$ | 4 | - | 1.8 | mA |
|  |  |  |  | $\mathrm{V}_{\mathrm{W}}=12 \mathrm{~V}$ | 4 | - | 5.2 | mA |
| Input Voltage | $V_{\text {Mrow }}$ | ULS-2064/65 | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 3.1 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 2.0 | V |
|  |  | ULS-2066/67H | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 11.5 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 6.5 | V |
| Turn-On Delay | $\mathrm{t}_{\text {N }}$ | All |  | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 1.0 | $\mu \mathrm{S}$ |
| Turn-Off Delay | $\mathrm{t}_{\text {off }}$ | All |  | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 1.5 | $\mu \mathrm{s}$ |
| Clamp Diode Leakage Current | $I_{R}$ | ULS-2064/66H |  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | 6 | - | 100 | $\mu \mathrm{A}$ |
|  |  | ULS-2065/67H |  | $\mathrm{V}_{\mathrm{R}}=80 \mathrm{~V}$ | 6 | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | All |  | $\mathrm{I}_{\mathrm{F}}=1.25 \mathrm{~A}$ | 7 | - | 2.1 | V |

## ULS-2068H THROUGH ULS-2071H

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted),
$V_{S}=5.0 \mathrm{~V}$ (ULS-2068/69H) or $\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ (ULS-2070/71H)

| Characteristic | Symbol | Applicable Devices |  | Test Conditions | Fig. | Limits |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Temp. |  |  | Min. | Max. |  |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | ULS-2068/70H |  | $\mathrm{V}_{\mathrm{CE}}=50 \mathrm{~V}$ | 1 | - | 500 | $\mu \mathrm{A}$ |
|  |  | ULS-2069/71H |  | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}$ | 1 | - | 500 | $\mu A$ |
| Output Sustaining Voltage | $\mathrm{V}_{\text {ceisus) }}$ | ULS-2068/70H |  | $\mathrm{I}_{\mathrm{c}}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{m}}=0.4 \mathrm{~V}$ | 2 | 35 | - | V |
|  |  | ULS-2069/71H |  | $T_{C}=100 \mathrm{~mA}, \mathrm{~V}_{\mathrm{M}}=0.4 \mathrm{~V}$ | 2 | 50 | - | $V$ |
| Collector-Emitter Saturation Voltage | $V_{\text {celsan }}$ | ULS-2068/69H | $-55^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{N}}=3.2 \mathrm{~V}$ | 3 | - | 1.35 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=3.2 \mathrm{~V}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathrm{w}}=3.2 \mathrm{~V}$ | , | - | 1.75 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{~V}_{\mathrm{m}}=3.2 \mathrm{~V}$ | 3 | - | 1.95 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=2.9 \mathrm{~V}$ | 3 | - | 1.20 | V |
|  |  |  |  | $T_{C}=750 \mathrm{~mA}, \mathrm{~V}_{\mathbb{W}}=2.9 \mathrm{~V}$ | 3 | - | 1.35 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathrm{IV}}=2.9 \mathrm{~V}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{~V}_{\mathrm{W}}=2.9 \mathrm{~V}$ | 3 | - | 1.75 | $V$ |
|  |  |  | $+125^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{M}}=2.8 \mathrm{~V}$ | 3 | - | 1.35 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{~V}_{\mathbb{W}}=2.8 \mathrm{~V}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{11}=2.8 \mathrm{~V}$ | 3 | - | 1.75 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.25 \mathrm{~A}, \mathrm{~V}_{\mathrm{N}}=2.8 \mathrm{~V}$ | 3 | - | 1.95 | $V$ |
|  |  | ULS-2070/71H | $-55^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathbb{W}}=5.5 \mathrm{~V}$ | 3 | - | 1.35 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=750 \mathrm{~mA}, \mathrm{~V}_{\mathbb{1}}=5.5 \mathrm{~V}$ | 3 | - | 1.55 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathrm{W}}=5.5 \mathrm{~V}$ | 3 | - | 1.75 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{~V}_{11}=5.5 \mathrm{~V}$ | 3 | - | 1.95 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{W}}=5.1 \mathrm{~V}$ | 3 | - | 1.20 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{~V}_{11}=5.1 \mathrm{~V}$ | 3 | - | 1.35 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathrm{W}}=5.1 \mathrm{~V}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.25 \mathrm{~A}, \mathrm{~V}_{\mathrm{IW}}=5.1 \mathrm{~V}$ | 3 | - | 1.75 | V |
|  |  |  | $+125^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, V_{\mathrm{M}}=5.0 \mathrm{~V}$ | 3 | - | 1.35 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=750 \mathrm{~mA}, \mathrm{~V}_{\text {IW }}=5.0 \mathrm{~V}$ | 3 | - | 1.55 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}, \mathrm{~V}_{\mathrm{M}}=5.0 \mathrm{~V}$ | 3 | - | 1.75 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=1.25 \mathrm{~A}, \mathrm{~V}_{\mathrm{II}}=5.0 \mathrm{~V}$ | 3 | - | 1.95 | $V$ |
| Input Current | $\mathrm{I}_{\text {mown }}$ | ULS-2068/69H | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{m}}=3.2 \mathrm{~V}$ | 4 | - | 600 | $\mu \mathrm{A}$ |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{II}}=2.75 \mathrm{~V}$ | 4 | - | 550 | $\mu \mathrm{A}$ |
|  |  |  | $+125^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{W}}=2.75 \mathrm{~V}$ | 4 | - | 850 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{\text {WIN }}=3.75 \mathrm{~V}$ | 4 | - | 1000 | $\mu \mathrm{A}$ |
|  |  | ULS-2070/71H |  | $\mathrm{V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | 4 | - | 400 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{it}}=12 \mathrm{~V}$ | 4 | - | 1250 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {mow }}$ | ULS-2068/69H | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 3.2 | $V$ |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{CE}}=2.0 \mathrm{~V}, \mathrm{~L}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 2.75 | $V$ |
|  |  | ULS-2070/71H | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {CE }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 5 | - | 5.0 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $V_{\text {cs }}=2.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=1.0 \mathrm{~A}$ | 5 | - | 5.0 | $V$ |
| Supply Current | $\mathrm{I}_{5}$ | ULS-2068/69H |  | $\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathbb{W}}=3.2 \mathrm{~V}$ | 8 | - | 6.0 | mA |
|  |  | ULS-2070/71H |  | $\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}, \mathrm{~V}_{\mathrm{m}}=5.0 \mathrm{~V}$ | 8 | - | 4.5 | mA |
| Turn-On Delay | $\mathrm{t}_{0 \times 1}$ | All |  | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 1.0 | $\mu \mathrm{S}$ |
| Iurn-Off Delay | $\mathrm{t}_{\text {asf }}$ | All |  | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {wit }}$ | - | - | 1.5 | $\mu \mathrm{s}$ |
| Clamp Diode Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | ULS-2068/70H |  | $V_{8}=50 \mathrm{~V}$ | 6 | - | 100 | $\mu \mathrm{A}$ |
|  |  | ULS-2069/71H |  | $\mathrm{V}_{\mathrm{B}}=80 \mathrm{~V}$ | 6 | - | 100 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $\mathrm{V}_{\mathrm{F}}$ | All |  | $\mathrm{If}_{\mathrm{f}}=1.25 \mathrm{~A}$ | 7 | - | 2.1 | $\checkmark$ |

## ULS-2074H THROUGH ULS-2077H

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)


## TEST FIGURES



Figure 1


Figure 2


Figure 4


Dw. Mo. A-9734A


Figure 3


Figure 6

Figure 5


Figure 7


Figure 8

NOTE: Diodes not applicable to Type ULS-2074H through ULS-2077H.

## input current as a function of input voltage




## COLLECTOR CURRENT AS A FUNCTION

 OF INPUT CURRENT

## ALLOWABLE PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE

AT $+50^{\circ} \mathrm{C}$


Dwg. No. A-11,031
AT $+75^{\circ} \mathrm{C}$


AT $+100^{\circ} \mathrm{C}$


# SERIES ULS-2800H AND ULS-2800R HIGH-VOLTAGE, HIGH-CURRENT DARLINGTON TRANSISTOR ARRAYS 

## features

- TTL, DTL, PMOS, or CMOS Compatible Inputs
- Peak Output Current to 600 mA
- Transient Protected Outputs
- Side-Brazed Hermetic Package, or
- Cer-DIP Package
- High-Reliability Screening Available
- Wide Operating Temperature Ranges

DESIGNED for interfacing between low-level logic circuitry and high-power loads, the Series ULS-2800H and ULS-2800R arrays consist of eight silicon NPN Darlington power drivers on a common monolithic substrate. The choice of five input characteristics, two output voltage ratings ( 50 or 95 V ), two output current ratings ( 500 or 600 mA ), and two package styles (suffix ' $H$ ' or ' R ') allow the circuit designer to select the optimum device for any specific application.
Both hermetically sealed package styles are rated for operation over the temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$, recommending them for military and aerospace applications or commercial and industrial applications where severe environmental conditions may be encountered.

The appropriate specific part number for use in standard logic applications can be determined from the Device Type Number Designation chart. Note that the high-voltage devices $\left(\mathrm{BV}_{\mathrm{CE}} \geq 95 \mathrm{~V}\right)$ are available in the Series ULS-2800H only. All units feature open collector outputs and integral diodes for inductive load transient suppression.


All Series ULS-2800H Darlington power drivers are furnished in an 18-pin side-brazed dual in-line hermetic package that meets the processing and environmental requirements of Military Standard MIL-STD-883, Methods 5004 and 5005.

Device Type Number Designation

| $\begin{aligned} & V_{\text {cemax }}= \\ & I_{\text {cemax }}= \end{aligned}$ | $\begin{gathered} 50 \mathrm{~V} \\ 500 \mathrm{~mA} \end{gathered}$ | $\begin{gathered} 50 \mathrm{~V} \\ 600 \mathrm{~mA} \end{gathered}$ | $\begin{gathered} 95 \mathrm{~V} \\ 500 \mathrm{~mA} \end{gathered}$ |
| :---: | :---: | :---: | :---: |
|  | Type Number |  |  |
| General-Purpose | ULS-2801R | ULS-2811R |  |
| PMOS, CMOS | ULS-2801H | ULS-2811H | ULS-2821H |
| $14-25 \mathrm{~V}$ | ULS-2802R | ULS-2812R |  |
| PMOS | ULS-2802H | ULS-2812H | ULS-2822H |
| 5 V | ULS-2803R | ULS-2813R |  |
| TL, CMOS | ULS-2803H | ULS-2813H | ULS-2823H |
| 6-15 V | ULS-2804R | ULS-2814R |  |
| CMOS, PMOS | ULS-2804H | ULS-2814H | ULS-2824H |
| High-Output | ULS-2805R | ULS-2815R |  |
| TL | ULS-2805H | ULS-2815H | ULS-2825H |

ABSOLUTE MAXIMUM RATINGS
Output Voltage, VCE (Series 2800*, 2810*) ..... 50 V
(Series ULS-2020H) ..... 95 V
Input Voltage, VIN (Series 2802*, 2803*, 2804*) ..... 30 V
(Series 2805*) ..... 15 V
Peak Output Current, Iout (Series 2800*, ULS-2820H) ..... 500 mA
(Series 2810*) ..... 600 mA
Ground Terminal Current, $\mathrm{I}_{\text {GNO }}$ ..... 3.0 A
Continuous Input Current, $1_{\mathbb{N}}$ ..... 25 mA
Power Dissipation, $P_{0}$ (one Darlington pair) ..... 1.0W
(total package) ..... See Graphs
Operating Temperature Range, $T_{A}$ ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{I}_{\mathrm{s}}$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## PARTIAL SCHEMATICS



Series 2801*
(each driver)

## Series 2802*

(each driver)

Series 2803*
(each driver)


[^33]
## SERIES ULS-2800H AND ULS-2800R

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

*Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See following part number description.

Note 1: All limits stated apply to the complete Darlington series except as specified for a single device type.
Note 2: The $I_{\text {IN(OfF) }}$ current limit guarantees against partial turn-on of the output.
Note 3: The $\mathrm{V}_{\mathbb{I}(O N)}$ voltage limit guarantees a minimum output sink current per the specified test conditions.

## SERIES ULS-2810H AND ULS-2810R

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

*Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See following part number description.
Note 1: All limits stated apply to the complete Darlington series except as specified for a single device type.
Note 2: The $I_{\mathbb{N}(0 f F)}$ current limit guarantees against partial turn-on of the output.
Note 3: The $V_{\mathbb{I N}(O N)}$ voltage limit guarantees a minimum output sink current per the specified test conditions.

## SERIES ULS-2820H

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices |  | Test Conditions |  | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Temp |  | Fig. | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | All |  | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}$ | 1A | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | 2822 H |  | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~V}_{\mathrm{V}}=6 \mathrm{~V}$ | 1B | - | - | 500 | $\mu \mathrm{A}$ |
|  |  | 2824H |  | $\mathrm{V}_{\text {CE }}=95 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=1 \mathrm{~V}$ | 1B | - | - | 500 | $\mu$ A |
| Collector-EmitterSaturation Voltage | $V_{\text {CEISAT }}$ | All | Min. | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=850 \mu \mathrm{~A}$ | 2 | - | 1.6 | 1.8 | V |
|  |  |  |  | $\mathrm{T}_{\mathrm{C}}=200 \mathrm{~mA} \mathrm{I}_{\mathrm{B}}=550 \mu \mathrm{~A}$ | 2 | - | 1.3 | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{c}}=350 \mathrm{~mA}, \mathrm{I}_{8}=500 \mu \mathrm{~A}$ | 2 | - | 1.25 | 1.6 | $V$ |
|  |  |  |  | $\mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
|  |  |  |  | $\mathrm{T}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | 2 | - | 0.9 | 1.1 | $V$ |
|  |  |  | Max. | $\mathrm{T}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | 2 | - | 1.6 | 1.8 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=350 \mu \mathrm{~A}$ | 2 | - | 1.3 | 1.5 | V |
|  |  |  |  | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=250 \mu \mathrm{~A}$ | 2 | - | 1.1 | 1.3 | V |
| Tnput Current |  | 2822H |  | $\mathrm{V}_{\mathrm{IN}}=17 \mathrm{~V}$ | 3 | 480 | 850 | 1300 | $\mu \mathrm{A}$ |
|  |  | 2823 H |  | $\mathrm{V}_{\text {IV }}=3.85 \mathrm{~V}$ | 3 | 650 | 930 | 1350 | $\mu \mathrm{A}$ |
|  |  | 2824H |  | $\mathrm{V}_{\mathrm{IV}}=5 \mathrm{~V}$ | 3 | 240 | 350 | 500 | $\mu \mathrm{A}$ |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=12 \mathrm{~V}$ | 3 | 650 | 1000 | 1450 | $\mu \mathrm{A}$ |
|  |  | 2825H |  | $V_{\text {IV }}=3 \mathrm{~V}$ | 3 | 1180 | 1500 | 2400 | $\mu \mathrm{A}$ |
|  |  | All | Max. | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 4 | 25 | 50 | - | $\mu \mathrm{A}$ |
| Tnput Voltage | $V_{\text {INOON }}$ | 2822H | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 18 | V |
|  |  |  | Max. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 13 | V |
|  |  | 2823H | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 3.3 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | 5 | - | - | 3.6 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 3.9 | V |
|  |  |  | Max. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 2.4 | V |
|  |  |  |  | $\mathrm{V}_{C E}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=250 \mathrm{~mA}$ | 5 | - | - | 2.7 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=300 \mathrm{~mA}$ | 5 | - | - | 3.0 | V |
|  |  | $2824 \mathrm{H}$ | Min. | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | 5 | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 8.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}_{\mathrm{i}} \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | 5 | - | - | 10 | V |
|  |  |  |  | $\mathrm{V}_{C E}=2 \mathrm{~V}_{1} \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 12 | V |
|  |  |  | Max. | $V_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=125 \mathrm{~mA}$ | 5 | - | - | 5.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | 5 | - | - | 6.0 | V |
|  |  |  |  | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=275 \mathrm{~mA}$ | 5 | - | - | 7.0 | V |
|  |  |  |  | $\mathrm{V}_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 8.0 | V |
|  |  | 2825H | Min. | $V_{\text {CE }}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}$ | 5 | - | - | 3.0 | V |
|  |  |  | Max. | $V_{C E}=2 \cdot V_{\text {, }} I_{C}=350 \mathrm{~mA}$ | 5 | - | - | 2.4 | V |
| D-C Forward Current Transfer Ratio | $h_{\text {fE }}$ | 2821H | Min. | $V_{C E}=2 \mathrm{~V}, I_{C}=350 \mathrm{~mA}$ | 2 | 500 | - | - | - |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $V_{C E}=2 V_{1} I_{C}=350 \mathrm{~mA}$ | 2 | 1000 | - | - | - |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | All | $+25^{\circ} \mathrm{C}$ |  | - | - | 15 | 25 | pF |
| Turn-On Delay | $t_{\text {PH }}$ | All | $+25^{\circ} \mathrm{C}$ | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 250 | 1000 | ns |
| Turn-Off Delay | $t_{\text {PHI }}$, | All | $+25^{\circ} \mathrm{C}$ | $0.5 \mathrm{E}_{\text {in }}$ to $0.5 \mathrm{E}_{\text {out }}$ | - | - | 250 | 1000 | ns |
| Clamp Diode Leakage Current | $\mathrm{I}_{\mathrm{R}}$ | All |  | $\mathrm{V}_{\mathrm{R}}=95 \mathrm{~V}$ | 6 | - | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{F}$ | All |  | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | 7 | - | 1.7 | 2.0 | V |

[^34]
## TEST FIGURES



FIGURE IA


FIGURE IB

FIGURE 2


FIGURE 4



FIGURE 3


FIGURE 5

FIGURE 6


FIGURE 7

## SERIES ULS-2800H

PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE

$$
\text { AT }+50^{\circ} \mathrm{C}
$$



AT $+100^{\circ} \mathrm{C}$


AT $+75^{\circ} \mathrm{C}$


AT $+125^{\circ} \mathrm{C}$


## SERIES ULS-2800R

PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE



## ALLOWABLE PACKAGE POWER DISSIPATION

SERIES ULS-2800H AND ULS-2800R


COLLECTOR CURRENT AS A FUNCTION OF INPUT CURRENT


## COLLECTOR CURRENT

 AS A FUNCTION OF SATURATION VOLTAGE

## SERIES ULS-2800H AND ULS-2800R PART NUMBERING SYSTEM



## INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE

SERIES 2803*

SERIES 2802*



SERIES 2805*
*Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See previous part number description.

# UDQ-2956R AND UDQ-2957R HIGH-VOLTAGE, HIGH-CURRENT SOURCE DRIVERS 

## EACH OF THESE SOURCE-DRIVER arrays has five NPN Darlington-pair outputs

 and five PNP common-base inputs controlled by a single ENABLE stage.Types UDQ-2956R and UDQ-2957R are typically used to switch the ground ends of loads such as telephone relays, PIN diodes, LEDs and similar devices directly connected to negative supplies. Internal transient-suppression diodes allow use of the drivers with inductive loads.

Each output stage of both integrated circuits will withstand output OFF voltages of -80 V and load currents as high as -500 mA . Under normal operating conditions, the five drivers will simultaneously handle load currents of -170 mA at ambient temperatures of up to $+70^{\circ} \mathrm{C}$.

Type UDQ-2956R is designed for use with PMOS or CMOS logic input levels operating with supply voltages of 6 V to 16 V . Type UDQ2957R has input current-limiting resistors that permit its operation with TTL, Schottky TTL, DTL and 5 V CMOS.

Both devices are supplied in industrial-grade, hermetically sealed 14 -pin dual in-line ceramic packages rated for use over the temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. Input connections are on one side of the packages, output connections on the other, to simplify applications designs.

The substrate of Type UDQ-2956R and Type UDQ-2957R should be tied to the most negative supply available in order to maintain isolation between drivers.


> ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature (reference pin 7)

Supply Voltage, $\mathrm{V}_{\mathrm{EE}}$. . . . . . . . . . . . . . . . . . . . . . . . . -80 V
Input Voltage, $\mathrm{V}_{\mathbb{N}}$ (UDQ-2956R) . . . . . . . . . . . . . . . . . +20 V
(UDQ-2957R) . . . . . . . . . . . . . . . . . +10 V
Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . -500 mA
Power Dissipation, $P_{0}$ (any one driver) ................ 1.0 W (total package) . ............ $1.67 \mathrm{~W}^{*}$
Operating Temperature Range, $T_{A} \ldots \ldots .-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
${ }^{*}$ Derate at the rate of $13.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$. above $+25^{\circ} \mathrm{C}$.

These devices can be ordered with an extended temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ by changing the prefix from 'UDQ' to 'UDS'.

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Applicable Devices | Temp. | Test Conditions | Limit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | UDQ-2956R |  | $V_{\mathbb{I N}}=\mathrm{V}_{\text {EMABLE }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUI }}=-80 \mathrm{~V}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {EMable }}=15 \mathrm{~V}, \mathrm{~V}_{\text {out }}=-80 \mathrm{~V}$ | $-200 \mu A$ Max. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=15 \mathrm{~V}, \mathrm{~V}_{\text {EMable }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUI }}=-80 \mathrm{~V}$ | $-200 \mu$ A Max. |
|  |  | UDQ-2957R |  | $V_{\text {IN }}=V_{\text {EMABLI }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  |  |  | $V_{\mathbb{N}}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {EMABLE }}=3.85 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}$ | $-200 \mu \mathrm{~A}$ Max. |
|  |  |  |  | $\mathrm{V}_{\mathbb{N}}=3.85 \mathrm{~V}, \mathrm{~V}_{\text {EMABLE }}=0.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-80 \mathrm{~V}$ | $-200 \mu \mathrm{~A}$ Max. |
| Collector-Emitter Saturation Voltage | $V_{\text {CEISAT }}$ | UDQ-2956R | $-40^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathbb{N}}=6.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | -1.40 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathbb{N}}=7.0 \mathrm{~V}, \mathrm{~T}_{\text {OUT }}=-175 \mathrm{~mA}$ | -1.55 V Max. |
|  |  |  |  | $V_{\mathbb{W}}=10 \mathrm{~V}, \mathrm{I}_{\text {OUI }}=-350 \mathrm{~mA}$ | -1.90 V Max. |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {IN }}=6.0 \mathrm{~V}, \mathrm{I}_{\text {OUI }}=-100 \mathrm{~mA}$ | -1.20 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathbb{N}}=7.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-175 \mathrm{~mA}$ | -1.35 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{~V}, \mathrm{I}_{\text {OUI }}=-350 \mathrm{~mA}$ | -1.70 V Max. |
|  |  |  | $+85^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathbb{N}}=6.0 \mathrm{~V}, \mathrm{I}_{\text {OUt }}=-100 \mathrm{~mA}$ | -1.40 V Max. |
|  |  |  |  | $V_{\text {iN }}=7.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-175 \mathrm{~mA}$ | -1.55 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=10 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | -1.90 V Max. |
|  |  | UDQ-2957R | $-40^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathbb{U}}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | -1.40 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=2.7 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-175 \mathrm{~mA}$ | -1.55 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=3.9 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | -1.90 V Max. |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathbb{V}}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | -1.20 V Max. |
|  |  |  |  | $V_{\mathbb{I N}}=2.7 \mathrm{~V}_{\text {, }} \mathrm{I}_{\text {OUt }}=-175 \mathrm{~mA}$ | -1.35 V Max. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=3.9 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | -1.70 V Max. |
|  |  |  | $+85^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-100 \mathrm{~mA}$ | -1.40 V Max. |
|  |  |  |  | $V_{\text {IN }}=2.7 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-175 \mathrm{~mA}$ | -1.55 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathbb{W}}=3.9 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=-350 \mathrm{~mA}$ | -1.90 V Max. |
| Input Current | $I_{\text {INON }}$ | UDQ-2956R |  | $V_{\mathbb{N}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | 0.8 mA Max. |
|  |  |  |  | $V_{\text {iv }}=15 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | 2.25 mA Max . |
|  |  | UDQ-2957R |  | $V_{\mathbb{N}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | 1.0 mA Max. |
|  |  |  |  | $V_{\text {IV }}=3.85 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | 2.0 mA Max. |
|  | $I_{\text {M (0FF }}$ | ALL |  | $\mathrm{I}_{\text {OUT }}=-500 \mu \mathrm{~A}$ | $50 \mu \mathrm{~A}$ Min. |
| Output Source Current | $\mathrm{I}_{\text {OUT }}$ | UDQ-2956R | $-40^{\circ} \mathrm{C}$ | $V_{\mathbb{N}}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -75 mA Min . |
|  |  |  |  | $\mathrm{V}_{\mathbb{W}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -125 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=7.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -175 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=8.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -250 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=9.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -300 mA Min. |
|  |  |  | $+85^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {IV }}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -125 mA Min. |
|  |  |  |  | $V_{\mathbb{N}}=6.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -200 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IV }}=7.0 \mathrm{~V}, \mathrm{~V}_{\text {OUI }}=-2.0 \mathrm{~V}$ | -250 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=8.0 \mathrm{~V}, \mathrm{~V}_{\text {oui }}=-2.0 \mathrm{~V}$ | -300 mA Min . |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=9.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -350 mA Min. |
|  |  | UDQ-2957R | $-40^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -50 mA Min. |
|  |  |  |  | $V_{\text {IN }}=2.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -125 mA Min. |
|  |  |  |  | $V_{\text {IN }}=3.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -200 mA Min. |
|  |  |  |  | $V_{\text {IV }}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -250 mA Min. |
|  |  |  |  | $V_{\text {IN }}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -300 mA Min. |
|  |  |  | $+85^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathbb{N}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -125 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -200 mA Min. |
|  |  |  |  | $\mathrm{V}_{\text {IV }}=3.0 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -250 mA Min. |
|  |  |  |  | $\mathrm{V}_{\mathrm{IN}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {OUI }}=-2.0 \mathrm{~V}$ | -300 mA Min. |
|  |  |  |  | $\mathrm{V}_{\mathbb{I}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=-2.0 \mathrm{~V}$ | -350 mA Min. |
| Clamp Diode Leakage Current | $T_{R}$ | ALL |  | $V_{R}=80 \mathrm{~V}$ | $50 \mu A M a x$. |
| Clamp Diode Forward Voltage | $V_{F}$ | ALL |  | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | 2.0 V Max. |
| Turn-On Delay | $\mathrm{t}_{\text {ON }}$ | ALL |  | $0.5 \mathrm{E}_{\text {IN }}$ to $0.5 \mathrm{E}_{\text {OUI, }} \mathrm{R}_{\mathrm{L}}=400 \Omega \mathrm{C}_{\mathrm{T}}=25 \mathrm{pF}$ | $4.0 \mu s$ Max. |
| Turn-0ff Delay | $\mathrm{t}_{\text {OfF }}$ | ALL |  | $0.5 \mathrm{E}_{\mathrm{N}}$ to $0.5 \mathrm{E}_{\text {our. }} \mathrm{R}_{\mathrm{L}}=400 \Omega \mathrm{C}_{\text {T }}=25 \mathrm{pF}$ | $10 \mu s$ Max. |



ALLOWABLE PEAK OUTPUT CURRENT
AS A FUNCTION OF DUTY CYCLE


INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE

$$
\text { at } T_{A}=+25^{\circ} \mathrm{C}
$$




# SERIES UDS-2980H <br> HIGH-VOLTAGE, HIGH-CURRENT SOURCE DRIVERS - Hermetically Sealed 

## FEATURES:

- TTL, DTL, PMOS or CMOS Compatible Inputs
-     - 500 mA Output Source Current Capability
- Transient-Protected Outputs
- High-Reliability Screening to MIL-STD-883, Class B
- Operating Temperature $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$


## S

 ERIES UDS-2980H HERMETICALLY SEALED source drivers interface between standard low-power digital logic, and relays, solenoids, stepping motors, LEDs, lamps, etc., in applications requiring separate logic and load grounds, load supply voltages to +80 V , and /or load currents to 500 mA .Under normal operating conditions these devices will sustain 50 mA continuously on each of the eight outputs, at an ambient temperature of $+85^{\circ} \mathrm{C}$, with a supply of +15 V . All four devices incorporate input current limiting resistors and output suppression diodes.

UDS-2981H and UDS-2983H drivers are intended for use with +5 V logic systems (TTL, Schottky TTL, DTL and 5 V CMOS). UDS-2982H and UDS-2984H drivers are intended for MOS interface (PMOS and CMOS) operating from supply voltages of from +6 to +16 V .

UDS-2981H and UDS-2982H drivers will sustain a maximum output OFF voltage of +50 V ; UDS2983 H and UDS-2984H drivers a maximum output OFF voltage of +80 V .

In all cases the output is switched ON by an active high input level.

Note that the maximum current rating may not be obtained at $-55^{\circ} \mathrm{C}$ because of beta fall-off, or at $+125^{\circ} \mathrm{C}$ because of package power limitations.


Series UDS-2980H drivers are furnished in 18-pin hermetic dual-in-line packages, and are processed to the requirements of MIL-STD-883, Methods 5004 and 5005.

## ABSOLUTE MAXIMUM RATINGS

$$
\text { at } T_{A}=+25^{\circ} \mathrm{C}
$$

Output Voltage Range, $\mathrm{V}_{\mathrm{CE}}$
(UDS-2981H \& UDS-2982H) . . . . . . . . . . . . . . +5 to +50 V
(UDS-2983H \& UDS-2984H) . . . . . . . . . . . . . +35 to +80 V
Input Voltage, $\mathrm{V}_{\text {iN }}$ (UDS-2981H \& UDS-2983H) ....... +15 V
(UDS-2982H \& UDS-2984H) . . . . . . . +30 V
Output Current, $\mathrm{I}_{\text {out }}$. . ........................ -500 mA
Power Dissipation, $P_{D}$ (any one driver) ............... 1.1 W
(total package) . . . . . . . . . . . . . 1.67W*
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots .-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at $13.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$.


ELECTRICAL CHARACTERISTICS from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Temp. | Test Conditions | Fig. | Limit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Leakage Current | $\mathrm{l}_{\text {cex }}$ | UDS-2981/82H |  | $\mathrm{V}_{\text {WV }}=0.25 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{S}}=50 \mathrm{~V}$ | 1 | $200 \mu \mathrm{~A}$ Max. |
|  |  | UDS-2983/84H |  | $\mathrm{V}_{\mathrm{W}}=0.25 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{S}}=80 \mathrm{~V}$ | 1 | $200 \mu \mathrm{~A}$ Max. |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {cesat }}$ | UDS-2981/83H | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {W }}=2.4 \mathrm{~V}, \mathrm{I}_{\text {oft }}=-100 \mathrm{~mA}$ | 2 | 2.0 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathrm{W}}=2.4 \mathrm{~V}, \mathrm{l}_{\text {OUT }}=-200 \mathrm{~mA}$ | 2 | 2.IV Max. |
|  |  |  | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {IV }}=2.4 \mathrm{~V}, \mathrm{I}_{\text {or }}=-350 \mathrm{~mA}$ | - | 2.0 V Max. |
|  |  |  | $+125^{\circ} \mathrm{C}$ | $V_{\text {IV }}=2.4 \mathrm{~V}, \mathrm{~T}_{\text {OII }}=-100 \mathrm{~mA}$ | 2 | 1.8 V Max. |
|  |  |  |  | $\mathrm{V}_{\text {W }}=2.4 \mathrm{~V}_{\text {, }} \mathrm{I}_{\text {OT }}=-200 \mathrm{mA**}$ | 2 | 1.9V Max. |
|  |  | UDS-2982/84H | $-55^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{W}}=5.0 \mathrm{~V}, \mathrm{I}_{\text {our }}=-100 \mathrm{~mA}$ | 2 | 2.0 .0 Vmax . |
|  |  |  |  | $V_{\text {IV }}=5.0 \mathrm{~V}, \mathrm{I}_{\text {OVI }}=-200 \mathrm{~mA}$ | 2 | 2.1 V Max. |
|  |  |  | $+125^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {W }}=5.0 \mathrm{~V}, \mathrm{l}_{\text {OUT }}=-350 \mathrm{~mA}$ | 2 | 2.0 V Max. |
|  |  |  |  | $\mathrm{V}_{\text {wi }}=5.0 \mathrm{~V}, \mathrm{l}_{\text {our }}=-100 \mathrm{~mA}$ | 2 | 1.8 V Max. |
|  |  |  |  | $\mathrm{V}_{\mathrm{W}}=5.0 \mathrm{~V}, \mathrm{I}_{\text {OT }}=-200 \mathrm{~mA}^{* *}$ | 2 | 1.9 V Max. |
| Input Current | $1_{\text {maom }}$ | UDS-2981/83H |  | $V_{\text {W }}=2.4 \mathrm{~V}$ | 3 | $575 \mu \mathrm{~A}$ Max. |
|  |  |  |  | $V_{\text {W }}=3.85 \mathrm{~V}$ | 3 | $1.26 \mathrm{~mA} \mathrm{Max}$. |
|  |  | UDS-2982/84H |  | $\mathrm{V}_{\text {w }}=5.0 \mathrm{~V}$ | 3 | $640 \mu \mathrm{~A}$ Max. |
|  |  |  |  | $\mathrm{V}_{\mathbb{W}}=12 \mathrm{~V}$ | 3 | 1.8 mA Max. |
|  | ${ }^{\text {Mrofr }}$ | UDS-2981/82H |  | $\mathrm{V}_{\mathrm{N}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=50 \mathrm{~V}$ | 3 | $10 \mu \mathrm{~A}$ Max. |
|  |  | UDS-2983/84H |  | $\mathrm{V}_{\mathbb{W}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{s}}=80 \mathrm{~V}$ | 3 | $10 \mu \mathrm{~A}$ Max. |
| Output Source Current | Iout | UDS-2981/83H |  | $\mathrm{V}_{\mathrm{N}}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {cE }}=2.2 \mathrm{~V}$ | 2 | -200 mA Min. |
|  |  | UDS-2982/84H |  | $\mathrm{V}_{\mathrm{W}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=2.2 \mathrm{~V}$ | 2 | -200 mA Min |
| Supply Current (Outputs Open) | $I_{s}$ | UDS-2981H | $+25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{N}}=2.4 \hat{\mathrm{~V}}^{*}, \mathrm{~V}_{\mathrm{S}}=50 \mathrm{~V}$ | 4 | 10 mA Max. |
|  |  | UDS-2982 |  | $\mathrm{V}_{\mathrm{V}}=5.0 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{S}}=50 \mathrm{~V}$ | 4 | 10 mA Max. |
|  |  | UDS-2983H |  | $V_{\text {IV }}=2.4 \mathrm{~V}^{*}, \mathrm{~V}_{\text {S }}=80 \mathrm{~V}$ | 4 | 10 mA Max. |
|  |  | UDS-2984H |  | $\mathrm{V}_{\mathrm{W}}=5.0 \mathrm{~V}^{*}, \mathrm{~V}_{\mathrm{s}}=80 \mathrm{~V}$ | 4 | 10 mA Max. |
| Clamp Diode Leakage Current | $I_{R}$ | UDS-2981/82H |  | $\mathrm{V}_{\text {S }}=50 \mathrm{~V}$ (All Inputs $\mathrm{V}_{\mathrm{W}}=0.25 \mathrm{~V}$ ) | 5 | $50 \mu \mathrm{~A}$ Max. |
|  |  | UDS-2983/84H |  | $\mathrm{V}_{\mathrm{S}}=80 \mathrm{~V}$ (All Inputs $\left.\mathrm{V}_{\mathrm{W}}=0.25 \mathrm{~V}\right)$ | 5 | $50 \mu \mathrm{~A}$ Max. |
| Clamp Diode Forward Voltage | $\mathrm{V}_{\mathrm{F}}$ | ALL |  | $\mathrm{I}_{\mathrm{F}}=200 \mathrm{~mA}$ | 6 | 1.75 V Max. |

*All inputs simultaneously.
**Pulsed test.

## TEST FIGURES



Figure 1


Figure 3


Figure 5


Figure 2


Figure 4


Figure 6

## ALLOWABLE PEAK COLLECTOR CURRENT AS A FUNCTION OF DUTY CYCLE

UDS-2981/82H


DWG. NO. A-11,078

ALL DEVICES


UDS-2983/84H


UDS-2981/82H


DWG. NO. A-11,076

## ALL DEVICES



DWG. NO. A-11,080

UDS-2983/84H


INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE FOR TYPE UDS-2981/83H


INPUT CURRENT AS A FUNCTION OF INPUT VOLTAGE FOR TYPE UDS-2982/84H


ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE


DWG. NO. A-11,082

# SERIES UDS-3600H DUAL 2-INPUT PERIPHERAL AND POWER DRIVERS <br> - Hermetically Sealed 

## FEATURES



OrG. No. A-9792
UDS-3611H

- Four Logic Types
- DTL/TTLPMOS/CMOS Compatible Inputs
- Low Input Current
- Sustaining Voltage of 80 V
- Hermetically Sealed Package
- High-Reliability Screening to MIL-STD-883, Class B


## Description

These 'mini-DIP'" dual 2-input peripheral and power drivers are bi-polar monolithic integrated circuits incorporating AND, NAND, OR, or NOR logic gates, and high-current switching transistors on the same chip. The two output transistors are capable of simultaneously sinking
 250 mA continuously at an ambient temperature of $+75^{\circ} \mathrm{C}$. In the OFF state, these drivers will sustain at least 80 V .

## Applications

The Series UDS 3600 H dual drivers are ideally suited for interface between low-level or high-level logic and high-current/high-voltage loads. Typical applications include driving peripheral loads such as incandescent lamps, light-emitting diodes, memories, and heaters.

With appropriate external diode transient suppression, the Series UDS-3600H drivers can also be used with inductive loads such as relays, solenoids, and stepping motors.


UDS-3613H

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{c c}$ ..... 7.0 V
Input Voltage, $\mathrm{V}_{\text {in }}$ ..... 30 V
Output Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Output On-State Sink Current, Ion ..... 600 mA
Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ (one output) ..... 1.0 W
(total package) ..... See Graph
Ambient Temperature Range (operating), $\mathrm{T}_{\mathrm{A}}$ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$


## PACKAGE POWER DISSIPATION

 AS A FUNCTION OF TEMPERATURE

## RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :--- | :--- | :--- | :---: |
| Supply Voltage $\left(V_{c d}\right.$ | 4.5 | 5.0 | 5.5 | V |
| Operating Temperature Range | -55 | +25 | +125 | ${ }^{\mathrm{C}}$ |
| Current into any output (0N state) | - | - | 300 | mA |

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{c c}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Input Voltage | $V_{\text {in(1) }}$ |  | MIN |  |  |  | 2.0 |  |  | $V$ |  |
| "0" Input Voltage | $V_{\text {inf() }}$ |  | MIN |  |  |  |  |  | 0.7 | V |  |
| "0" Input Current | $\mathrm{I}_{\text {inf(0) }}$ |  | MAX | 0.4 V | 30 V |  |  | 50 | 100 | $\mu \mathrm{A}$ | 2 |
| "1" Input Current | $\mathrm{I}_{\text {in(1) }}$ |  | MAX | 30 V | OV |  |  |  | 10 | $\mu \mathrm{A}$ | 2 |
| Input Clamp Voltage | $V_{1}$ |  | MIN | $-12 \mathrm{~mA}$ |  |  |  |  | -1.5 | V |  |

## SWITCHING CHARACTERISTICS at $\mathrm{V}_{\text {cc }}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time | $\mathrm{t}_{\text {pdo }}$ | $\begin{aligned} & V_{S}=70 \mathrm{~V}, R_{L}=465 \Omega \text { (10 Watts) } \\ & C_{L}=15 \mathrm{pF} \end{aligned}$ | - | 200 | 500 | ns | 3 |
| Turn-off Delay Time | $\mathrm{t}_{\mathrm{pd} 1}$ | $\begin{aligned} & V_{S}=70 V_{,} R_{L}=465 \Omega \text { (10 Watts) } \\ & C_{L}=15 \mathrm{pF} \end{aligned}$ | - | 300 | 750 | ns | 3 |



## Type UDS-3611H Dual AND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $\mathrm{V}_{\mathrm{cc}}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | $\mathrm{I}_{\text {off }}$ |  | MIN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voiltage | $\mathrm{V}_{\text {on }}$ |  | MIN | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 150 mA |  | 0.4 | 0.5 | V |  |
|  |  |  | MIN | 0.8 V | $V_{c c}$ | 300 mA |  | 0.6 | 0.8 | V |  |
| "1" Level Supply Current | $I_{\text {c(1) }}$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 8.0 | 12 | mA | 1,2 |
| "0" Level Supply Current | $\mathrm{I}_{\text {clo }}$ | NOM | MAX | 0 V | OV |  |  | 35 | 49 | mA | 1,2 |



## Type UDS-3612H Dual NAND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 0.8 V | $\mathrm{V}_{\mathrm{cc}}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | $V_{c c}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | $V_{\text {on }}$ |  | MIN | 2.0 V | -2.0V | 150 mA |  | 0.4 | 0.5 | V | $1,2$ |
|  |  |  | MIN | 2.0 V | 2.0 V | 300 mA |  | 0.6 | 0.8 | V |  |
| "1" Level Supply Current | $I_{\text {cc(1) }}$ | NOM | MAX | OV | 0 V |  |  | 12 | 15 | mA |  |
| "0" Level Supply Current | $\mathrm{I}_{\text {cc(0) }}$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 40 | 53 | mA | 1,2 |



OTES
2. Per package.

## Type UDS-3613H Dual OR Driver

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | $\mathrm{I}_{\text {off }}$ |  | MIN | 2.0 V | OV | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 0 " Output Voltage | $\mathrm{V}_{\text {on }}$ |  | MIN | 0.8 V | 0.8 V | 150 mA |  | 0.4 | 0.5 | $V$ |  |
|  |  |  | MIN | 0.8 V | 0.8 V | 300 mA |  | 0.6 | 0.8 | $V$ |  |
| "1" Level Supply Current | $I_{\text {cc(1) }}$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 8.0 | 13 | mA | 1,2 |
| "0" Level Supply Current | $I_{\text {cc(0) }}$ | NOM | MAX | 0 V | OV |  |  | 36 | 50 | mA | 1,2 |



## Type UDS-3614H Dual NOR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)


DWG. No. A-7900A

NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Capacitance values specified include probe and test fixture capacitance.

## UCS-4401H AND UCS-4801H BiMOS LATCHED DRIVERS - Hermetically Sealed

## FEATURES

- High-Voltage, High-Current Outputs
- Output Transient Protection
- CMOS, PMOS, NMOS, TIL Compatible
- Internal Pull-Down Resistors
- Low-Power CMOS Latches

HIGH-VOLTAGE, HIGH-CURRENT interface for military, aerospace and related applications is supplied by these latched drivers. Type UCS4401 H contains four pairs of latches and drivers; Type UCS-4801H has eight pairs of latches and drivers.

The integrated circuits' CMOS inputs work with standard CMOS, PMOS and NMOS logic levels and (with appropriate pull-up resistors) with TTL or DTL circuits. The bipolar open-collector outputs can be used with relays, solenoids, motors, LED or incandescent displays, and other high-power loads.

The output transistors can sink 500 mA and will withstand a $V_{\text {CE }}$ of 50 V in the OFF state. Outputs can be paralleled for higher current capability. Because of limitations on package power dissipation, simultaneous operation of all drivers at maximum rated current can only be accomplished with a reduction of duty cycle.

Type UCS- 4401 H , the four-latch device, is furnished in a standard 14-pin side-brazed hermetic package. Type UCS- 4801 H , the eight-latch device, is furnished in a 22-pin side-brazed hermetic package with row centers 0.400 -inch ( 10.16 mm ) apart.

Both devices meet all processing and environmental requirements of Military Standard MIL-STD883 , Methods 5004 and 5005.


DWG.NO. A-10,499A
UCS-4401H


UCS-4801H

## ABSOLUTE MAXIMUM RATINGS

| Output Voltage, $\mathrm{V}_{\text {EE }}$ | 50 V |
| :---: | :---: |
| Supply Voltage, $\mathrm{V}_{\text {D }}$ | 18 V |
| Input Voltage Range, $\mathrm{V}_{\mathbb{W}}$ | -0.3 V to $\mathrm{V}_{\text {D0 }}+0.3 \mathrm{~V}$ |
| Continuous Collector Current, $I_{c}$ | 500 mA |
| Package Power Dissipation, $\mathrm{P}_{0}$ | See Graph |
| Operating Ambient Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{I}_{\text {S }}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

CAUTION: Sprague CMOS devices have input static protection but are still susceptible to damage when exposed to extremely high static electrical charges.

FUNCTIONAL BLOCK DIAGRAM


## ALLOWABLE AVERAGE <br> PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CESSAT }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}$ | - | 0.9 | 1.1 | V |
|  |  | $\mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}$ | - | 1.1 | 1.3 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=7.0 \mathrm{~V}$ | - | 1.3 | 1.6 | V |
| Input Voltage | $\mathrm{V}_{\mathbf{N}(0)}$ | . | - | - | 1.0 | V |
|  | $V_{\text {W(1) }}$ | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 13.5 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | 8.5 | - | - | V |
|  |  | $\mathrm{V}_{\text {D }}=5.0 \mathrm{~V}$ (See note) | 3.5 | - | - | V |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 50 | 200 | - | k $\Omega$ |
|  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ | 50 | 300 | - | k $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$ | 50 | 600 | - | k $\Omega$ |
| Supply Current | $\mathrm{I}_{\text {Do(on) }}$ (Each Stage) | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$, Outputs open | - | 1.0 | 2.0 | mA |
|  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$, Outputs open | - | 0.9 | 1.7 | mA |
|  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, Outputs open | - | 0.7 | 1.0 | mA |
|  | $\mathrm{I}_{\text {Do(0ff }}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 50 | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$, All drivers 0FF, All inputs $=0 \mathrm{~V}$ | - | - | 200 | $\mu \mathrm{A}$ |
| Clamp Diode Leakage Current | $I_{R}$ | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | 1.7 | 2.0 | V |

Note: Operation of these devices with standard TL or DTL may require the use of appropriate pull-up resistors to ensure the minimum logic "l".

ELECTRICAL CHARACTERISTICS at $T_{A}=-55^{\circ} \mathrm{C}, \mathrm{V}_{D D}=5 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | $\mathrm{V}_{\text {cE }}=50 \mathrm{~V}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $V_{\text {cessat }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}$ | - | - | 1.3 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=200 \mathrm{~mA}$ | - | - | 1.5 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=350 \mathrm{~mA}, \mathrm{~V}_{D D}=7.0 \mathrm{~V}$ | - | - | 1.8 | V |
| Input Voltage | $V_{\text {IN(0) }}$ |  | - | - | 1.0 | V |
|  | $V_{\text {W(1) }}$ | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ | 14 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | 9.0 | - | - | V |
|  |  | $\mathrm{V}_{\text {DO }}=5.0 \mathrm{~V}$ (See note) | 3.6 | - | - | V |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | $V_{\text {DD }}=15 \mathrm{~V}$ | 35 | - | - | k $\Omega$ |
|  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ | 35 | - | - | k $\Omega$ |
|  |  | $V_{D D}=5.0 \mathrm{~V}$ | 35 | - | - | k $\Omega$ |
| Supply Current | $I_{D(O N)}$ (Each Stage) | $\mathrm{V}_{00}=15 \mathrm{~V}$, Ouputs open | - | 1.0 | 2.5 | mA |
|  |  | $V_{D D}=10 \mathrm{~V}$, Outputs open | - | 0.9 | 1.7 | mA |
|  |  | $\mathrm{V}_{\text {DO }}=5.0 \mathrm{~V}$, Outputs open | - | 0.7 | 1.0 | mA |
|  | $I_{\text {Dopoff }}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 50 | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | - | 200 | $\mu \mathrm{A}$ |
| Clamp Diode Leakage Current | $I_{R}$ | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | - | 50 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | $\mathrm{I}_{\mathrm{F}}=350 \mathrm{~mA}$ | - | - | 2.1 | V |

ELECTRICAL CHARACTERISTICS at $T_{A}=+125^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cte }}$ | $\mathrm{V}_{\text {CE }}=50 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CESAA }}$ | $\mathrm{I}_{\mathrm{c}}=100 \mathrm{~mA}^{*}$ | - | - | 1.3 | V |
|  |  | $\mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}^{*}$ | - | - | 1.5 | V |
|  |  | $\mathrm{I}_{\mathrm{c}}=350 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DO}}=7.0 \mathrm{~V}^{*}$ | - | - | 1.8 | V |
| Input Voltage | $V_{\text {m(0) }}$ |  | - | - | 1.0 | V |
|  | $V_{\text {W(I) }}$ | $\mathrm{V}_{\mathrm{DO}}=15 \mathrm{~V}$ | 13.5 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | 8.5 | - | - | V |
|  |  | $\mathrm{V}_{\text {D0 }}=5.0 \mathrm{~V}$ (See note) | 3.5 | - | - | V |
| Input Resistance | $\mathrm{R}_{\text {w }}$ | $V_{\text {DO }}=15 \mathrm{~V}$ | 50 | - | - | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{V}_{\text {D0 }}=10 \mathrm{~V}$ | 50 | - | - | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{V}_{\text {OD }}=5.0 \mathrm{~V}$ | 50 | - | - | $\mathrm{k} \Omega$ |
| Supply Current | $\begin{gathered} I_{\text {Dopon }} \\ \text { (Each Stage) } \end{gathered}$ | $V_{D 0}=15 \mathrm{~V}$, Outputs open | - | 1.0 | 2.2 | mA |
|  |  | $\mathrm{V}_{\text {Do }}=10 \mathrm{~V}$, Outputs open | - | 0.9 | 1.9 | mA |
|  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, Outputs open | - | 0.7 | 1.2 | mA |
|  | $\mathrm{I}_{\text {Oo(f) }}$ | $\mathrm{V}_{\text {DO }}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 50 | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DO}}=15 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | - | 200 | $\mu \mathrm{A}$ |
| Clamp Diode Leakage Current | $I_{\text {R }}$ | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
| Clamp Diode Forward Voltage | $V_{\text {F }}$ | $\mathrm{I}_{\mathrm{f}}=350 \mathrm{~mA}{ }^{*}$ | - | - | 2.0 | V |

Note: Operation of these devices with standard TL or DTL may require the use of appropriate pull-up resistors to ensure the minimum logic "l".
*Pulsed test.

## TIMING CONDITIONS

$T_{A}=+25^{\circ} \mathrm{C}$; Logic Levels are $V_{D D}$ and $V_{S S}$

A. Minimum data active time before strobe enabled (data set-up time) ..... 100 ns
B. Minimum data active time after strobe disabled (data hold time) ..... 100 ns
C. Minimum strobe pulse width ..... 300 ns
D. Typical time between strobe activation and output on to off transition ..... 500 ns
E. Typical time between strobe activation and output off to on transition ..... 500 ns
F. Minimum clear pulse width ..... 300 ns
G. Minimum data pulse width ..... 500 ns

Information present at an input is transferred to its latch when the STROBE is high. A high CLEAR input will set all latches to the output OFF condition regardless of the data or STROBE input levels. A high OUTPUT ENABLE will set all outputs to the OFF condition regardless of any other input conditions. When the OUTPUT ENABLE is low, the outputs depend on the state of their respective latches.

TRUTH TABLE

| $1 \mathrm{~N}_{\mathrm{N}}$ | STROBE | CLEAR | OUTPUT <br> ENABLE | $\mathrm{OUT}_{\mathrm{N}}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | t-1 | t |
| 0 | 1 | 0 | 0 | X | OFF |
| 1 | 1 | 0 | 0 | X | ON |
| X | X | I | X | X | OFF |
| X | X | X | 1 | X | OFF |
| X | 0 | 0 | 0 | ON | ON |
| X | 0 | 0 | 0 | OFF | OFF |

$x=$ irrelevant
$t-1=$ previous output state
$t=$ present output state

# UCS-4810H <br> BiMOS 10-BIT, SERIAL-INPUT, LATCHED DRIVER - Hermetically Sealed 

## FEATURES

- High-Voltage Source Outputs
- CMOS, PMOS, NMOS, TIL Compatible Inputs
- Low-Power CMOS Logic and Latches
- Internal Pull-Down Resistors
- Wide Supply-Voltage Range
- High-Reliability Screening to MIL-STD-883, Class B
- Operating Temperature $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

COMBINING low-power CMOS logic with bipolar source drivers, Type UCS- 4810 H will simplify many display-system designs. Primarily intended for use with vacuum-fluorescent displays, this BiMOS 10-bit serial-input, latched driver can also be used with LED and incandescent displays within its output limitations of 60 V and 40 mA per driver.

The CMOS 10 -bit shift register and associated latches are designed for operation over a 5 V to 15 V supply-voltage range. They cause minimal loading of data lines and are compatible with standard CMOS, PMOS, and NMOS logic. When used with standard TTL or low-speed TTL logic, appropriate pull-up resistors may be required to ensure an inputlogic high. A CMOS serial-data output allows cascading these devices for interface applications requiring many drive lines (dot matrix, alphanumeric, bargraph).

The 10 bipolar outputs are used as segment or digit drivers in vacuum-fluorescent displays. Under normal operating conditions, these devices will sustain


25 mA per output at $50^{\circ} \mathrm{C}$ at a duty cycle of $61 \%$. Other combinations of number of conducting outputs and duty cycle are shown in the specifications in this bulletin.

Type UCS-4810H, when combined with Type UCS- 4815 H , an 8 -bit latched source driver, comprises a minimum component display subsystem requiring few, if any, discrete components.

Type UCS- 4810 H is furnished in an 18-pin hermetic dual-in-line package and is processed to the requirements of MIL-STD-883, Methods 5004 and 5005.

The same circuit is also available, with increased allowable package power dissipation, in plastic or glass/ceramic (cer-DIP) hermetic packages for operation over the extended temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Type UCQ-4810A or UCQ4810 R, respectively). Devices for use over a commercial/industrial temperature range are designated Type UCN-4810A or UCN-4810R, respectively.

## ABSOLUTE MAXIMUM RATINGS <br> at $+25^{\circ} \mathrm{C}$ Free-Air Temperature <br> and $V_{S S}=O V$



| Number of Outputs ON | Maximum Allowable Duty Cycle at $V_{D D}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}$ of: |  |  |
| :---: | :---: | :---: | :---: |
| $\left(\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}\right)$ | $+25^{\circ} \mathrm{C}$ | $+50^{\circ} \mathrm{C}$ | $+85^{\circ} \mathrm{C}$ |
| 10 | 81\% | 61\% | $34 \%$ |
| - 9 | 90\% | 68\% | 38\% |
| 8 | 98\% | 76\% | 43\% |
| 7 | 100\% | 87\% | 49\% |
| 6 |  | 97\% | 57\% |
| 5 |  | 100\% | 69\% |
| 4 |  |  | 86\% |
| 3 |  |  | 100\% |

Caution: Sprague CMOS devices have input-static protection but are susceptible to damage when exposed to extremely high static electrical charges.

FUNCTIONAL BLOCK DIAGRAM


TYPICAL INPUT CIRCUIT


Dwg. No. A-10,980

TYPICAL OUTPUT DRIVER


Dwg. No. A-10,981
allowable average package power dissipation AS A FUNCTION OF TEMPERATURE


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {BB }}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{\text {SS }}=0 \mathrm{~V}$
(unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $V_{\text {out }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 57.5 | - | $V$ |
| Output Pull-Down Current | $\mathrm{I}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BB }}$ | 400 | 850 | $\mu \mathrm{A}$ |
| Output Leakage Current |  |  | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {in(1) }}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$ | 3.5 | - | V |
|  |  | $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | 13.5 | - | V |
|  | $V_{1 \times(0)}$ |  | -0.3 | +0.8 | $V$ |
| Input Current | $l_{\text {IN(I) }}$ | $\mathrm{V}_{\text {DO }}=\mathrm{V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{D D}=V_{1 N}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {IN }}$ | $V_{D D}=5.0 \mathrm{~V}$ | 50 | - | $k \Omega$ |
| Serial Data Output Resistance | $\mathrm{R}_{\text {OUT }}$ | $V_{D D}=5.0 \mathrm{~V}$ | - | 20 | $\mathrm{k} \Omega$ |
|  |  | $V_{\text {DD }}=15 \mathrm{~V}$ | - | 6.0 | $k \Omega$ |
| Supply Current | $I_{B B}$ | All outputs ON, Outputs open | - | 13 | mA |
|  |  | All outputs OFF, Outputs open | - | 100 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\text {D }}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $V_{\text {DO }}=5.0 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 1.0 | mA |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 3.0 | mA |

NOTES: Positive (negative) current is defined as going into (coming out of) the specified device pin.
Operation of this device with standard TTL or DTL may require the use of appropriate pull-up resistors to ensure an input-logic high.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $V_{\text {OUT }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {Out }}=-25 \mathrm{~mA}$ | 57 | - | $V$ |
| Output Pull-Down Current | Iour | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BB }}$ | 300 | 850 | $\mu \mathrm{A}$ |
| Output Leakage Current |  |  | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {W(1) }}$ | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | 3.6 | - | V |
|  |  | $\mathrm{V}_{00}=15 \mathrm{~V}$ | 14 | - | V |
|  | $V_{\text {M(0) }}$ |  | -0.3 | +0.8 | V |
| Input Current | $\mathrm{I}_{\text {(1) }}$ | $\mathrm{V}_{\text {Do }}=\mathrm{V}_{\mathrm{W}}=5.0 \mathrm{~V}$ | - | 145 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {D }}=\mathrm{V}_{\mathrm{W}}=15 \mathrm{~V}$ | - | 430 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {W }}$ | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | 35 | - | $\mathrm{k} \Omega$ |
| Serial Data Output Resistance | $\mathrm{R}_{\text {out }}$ | $\mathrm{V}_{\text {D0 }}=5.0 \mathrm{~V}$ | - | 20 | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{V}_{\text {D0 }}=15 \mathrm{~V}$ | - | 6.0 | $\mathrm{k} \Omega$ |
| Supply Current | $\mathrm{I}_{88}$ | All outputs ON, Outputs open | - | 13 | mA |
|  |  | All outputs OFF, Outputs open | - | 100 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{0}$ | $\mathrm{V}_{\text {D0 }}=5.0 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {Do }}=15 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, One output $0 \mathrm{~N}, \mathrm{All}$ inputs $=0 \mathrm{~V}$ | - | 1.0 | mA |
|  |  | $\mathrm{V}_{\text {D0 }}=15 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 3.0 | mA |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $\mathrm{V}_{\text {OUt }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 57 | - | V |
| Output Pull-Down Current | $\mathrm{I}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BB }}$ | 400 | 1400 | $\mu \mathrm{A}$ |
| Output Leakage Current |  |  | - | -30 | $\mu \mathrm{A}$ |
| Input Voltage | $\mathrm{V}_{1(1)}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ | 3.5 | - | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ | 13.5 | - | V |
|  | $V_{\text {N(0) }}$ |  | -0.3 | +0.8 | V |
| Input Current | $\mathrm{I}_{\text {IN(1) }}$ | $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathbb{N}}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {W }}$ | $V_{D D}=5.0 \mathrm{~V}$ | 50 | - | $k \Omega$ |
| Serial Data Output Resistance | $\mathrm{R}_{\text {out }}$ | $V_{D D}=5.0 \mathrm{~V}$ | - | 27 | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | - | 8.0 | $\mathrm{k} \Omega$ |
| Supply Current | $\mathrm{I}_{\text {BB }}$ | All outputs ON, Outputs open | - | 15 | mA |
|  |  | All outputs OFF, Outputs open | - | 100 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\mathrm{DD}}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{\text {DD }}=15 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, One output 0 N, All inputs $=0 \mathrm{~V}$ | - | 1.5 | mA |
|  |  | $V_{\text {DD }}=15 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 4.5 | mA |

NOTES: Positive (negative) current is defined as going into (coming out of) the specified device pin.
Operation of this device with standard TTL or DTL may require the use of appropriate pull-up resistors to ensure an input-logic high.


$$
\begin{gathered}
\text { TIMING CONDITIONS } \\
\mathrm{T}_{A}=+25^{\circ} \mathrm{C} \text {; Logic Levels are } \mathrm{V}_{D 0} \text { and } \mathrm{V}_{S S}
\end{gathered}
$$

| A. Minimum Data Active Time Before Clock Pulse (Data Set-Up Time) | 250 ns | 150 ns |
| :---: | :---: | :---: |
| B. Minimum Data Pulse Width | 500 ns | 300 ns |
| C. Minimum Clock Pulse Width | $1.0 \mu \mathrm{~s}$ | 250 ns |
| D. Minimum Time Between Clock Activation and Strobe | $1.0 \mu \mathrm{~s}$ | 400 ns |
| E. Minimum Strobe Pulse Width | 500 ns | 300 ns |
| F. Typical Time Between Strobe Activation and Output Transition | $1.0 \mu \mathrm{~s}$ | 1.0 ms |

SERIAL DATA present at the input is transferred to the shift register on the logic " 0 " to logic " 1 ", transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to its respective latch when the STROBE is high (serial-to-parallel conversion). The latches will con-
tinue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the BLANKING input be high during serial data entry.

When the BLANKING input is high, all of the output buffers are disabled (OFF) without affecting the information stored in the latches or shift register. With the BLANKING input low, the outputs are controlled by the state of the latches.

UCS-4810H TRUTH TABLES

| Serial <br> Data <br> Input | Clock Input | Shift Register Contents | Serial <br> Data <br> Output | Strobe Input | Latch Contents | Blanking Input | Output Contents$I_{1} I_{2} I_{3} \ldots \ldots I_{8} I_{9} I_{10}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{I}_{1} \mathrm{I}_{2} \mathrm{I}_{3} \ldots \ldots . \mathrm{I}_{8} \mathrm{I}_{9} \mathrm{I}_{10}$ |  |  | $\mathrm{I}_{1} \mathrm{I}_{2} I_{3} \ldots \ldots . \mathrm{I}_{8} \mathrm{I}_{\mathrm{g}} \mathrm{I}_{10}$ |  |  |
| H | 5 | ${ }^{H} R_{1} R_{2} \ldots R_{7} R_{8} R_{9}$ | $\mathrm{R}_{9}$ |  |  |  |  |
| L | 5 | $L R_{1} R_{2} \ldots R_{7} R_{8} R_{9}$ | $\mathrm{R}_{9}$ |  |  |  |  |
| X | L | $\mathrm{R}_{1} \mathrm{R}_{2} \mathrm{R}_{3} \ldots \mathrm{R}_{8} \mathrm{R}_{9} \mathrm{R}_{10}$ | $\mathrm{R}_{10}$ |  |  |  |  |
|  |  | XXX ..... XXX | X | L | $\mathrm{R}_{1} \mathrm{R}_{2} \mathrm{R}_{3} \ldots \mathrm{R}_{8} \mathrm{R}_{9} \mathrm{R}_{10}$ |  |  |
|  |  | $P_{1} P_{2} P_{3} \ldots P_{8} P_{9} P_{10}$ | $P_{10}$ | H | $\frac{P_{1} P_{2} P_{3} \ldots P_{8} P_{9} P_{10}}{X X X}$ | L | $P_{1} P_{2} P_{3} \ldots P_{8} P_{9} P_{10}$ |
|  |  |  |  |  | XXX $\ldots \ldots .1$ XXX | H | LLL....... LLL |

[^35]
# UCS-4815H BiMOS LATCH/SOURCE DRIVER - Hermetically Sealed 

## FEATURES

- High-Voltage Source Outputs
- CMOS, PMOS, NMOS, TTL Compatible Inputs
- Low-Power CMOS Latches
- Internal Pull-Down Resistors
- Wide Supply-Voltage Range
- High-Reliability Screening to MIL-STD-883, Class B
- Operating Temperature $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

DESIGNED primarily for use with high-voltage vacuum-fluorescent displays, the Type UCS4815 H BiMOS integrated circuit has eight NPN Darlington source drivers with pull-down resistors, a CMOS latch for each driver, and common strobe, blanking, and enable functions.

The CMOS inputs cause minimum loading and are compatible with standard CMOS, PMOS, and NMOS logic commonly found in microprocessor designs. The use of CMOS latches also allows operation over a supply-voltage range of 5 V to 15 V . When employed with either standard TTL or lowspeed TTL, Type UCS- 4815 H may require the use of appropriate pull-up resistors.

The bipolar outputs may be used as segment, dot (matrix), bar, or digit drivers in vacuum-fluorescent displays. Under normal operating conditions, these devices will sustain 25 mA per output at $50^{\circ} \mathrm{C}$ and a duty cycle of $89 \%$. Other combinations of numbers of conducting outputs and duty cycle are shown in the specifications in this bulletin.

A minimum component display subsystem, requiring few or no discrete components, may be as-

sembled by using a Type UCS- 4815 H BiMOS latch/source driver with a Type UCS- 4810 H serial-to-parallel latch/driver.

Type UCS 4815 H is furnished in 22-pin hermetic dual-in-line packages, and is processed to the requirements of MIL-STD-883, Methods 5004 and 5005. To simplify printed wiring board layout, output pins on the package are opposite respective input pins.

The same circuit is also available, with increased allowable package power dissipation, in plastic or glass/ceramic (cer-DIP) hermetic packages for operation over the extended temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Type UCQ-4815A or UCQ4815 R , respectively). Devices for use over a commercial /industrial temperature range are designated Type UCN-4815A or UCN-4815R, respectively.

## ABSOLUTE MAXIMUM RATINGS

## at $+25^{\circ} \mathrm{C}$ Free-Air Temperature and $V_{S S}=\mathbf{O V}$

| Output Voltage, $\mathrm{V}_{\text {out }}$ | 60 V |
| :---: | :---: |
| Logic Supply Voltage Range, $\mathrm{V}_{\text {D }}$ | 4.5 V to 18 V |
| Driver Supply Voltage Range, $\mathrm{V}_{B B}$. | 5.0 V to 60 V |
| Input Voltage Range, $\mathrm{V}_{\text {IN }}$ | -0.3 V to $\mathrm{V}_{\text {D }}+0.3 \mathrm{~V}$ |
| Continuous Output Current, $\mathrm{I}_{\text {our }}$ | $-40 \mathrm{~mA}$ |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | 1.6 W* |
| Operating Temperature Range, $\mathrm{T}_{A}$ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

*Derate at $15.4 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+25^{\circ} \mathrm{C}$.

| Number of Outputs ON | Maximum Allowable Duty Cycle at $V_{D D}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}$ of: |  |  |
| :---: | :---: | :---: | :---: |
| $\left(\mathrm{l}_{\text {out }}=-25 \mathrm{~mA}\right)$ | $+25^{\circ} \mathrm{C}$ | $+50^{\circ} \mathrm{C}$ | $+85^{\circ} \mathrm{C}$ |
| 8 | 100\% | 89\% | 56\% |
| 7 |  | 98\% | 57\% |
| 6 |  | 100\% | 66\% |
| 5 |  |  | 80\% |
| 4 |  |  | 100\% |

Caution: Sprague CMOS devices have input-static protection but are susceptible to damage when exposed to extremely high static electrical charges.

## ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



TYPICAL INPUT CIRCUIT


Dwg. No. A-10,980

TYPICAL OUTPUT DRIVER


Dwg. No. A-10,981

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{B B}=60 \mathrm{~V}, \mathrm{~V}_{D D}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $V_{\text {out }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 57.5 | - | V |
| Output Pull-Down Current | Iour | $V_{\text {OUI }}=V_{\text {BB }}$ | 400 | 850 | $\mu \mathrm{A}$ |
| Output Leakage Current |  |  | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {IN(1) }}$ | $\mathrm{V}_{\text {D }}=5.0 \mathrm{~V}$ | 3.5 | 5.3 | V |
|  |  | $V_{\text {DD }}=15 \mathrm{~V}$ | 13.5 | 15.3 | V |
|  | $\mathrm{V}_{\text {IN(0) }}$ |  | -0.3 | +0.8 | V |
| Input Current | $\mathrm{I}_{\text {W(1) }}$ | $\mathrm{V}_{\text {DO }}=\mathrm{V}_{\text {IV }}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{D D}=V_{1 N}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {W }}$ | $V_{D D}=5.0 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
| Supply Current | $\mathrm{I}_{\text {BB }}$ | All outputs ON, Outputs open | - | 10.5 | mA |
|  |  | All outputs OFF, Outputs open | - | 100 | $\mu \mathrm{A}$ |
|  | $I_{D 0}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$, One output 0N, All inputs $=0 \mathrm{~V}$ | - | 1.0 | mA |
|  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$, One output 0 N, All inputs $=0 \mathrm{~V}$ | - | 3.0 | mA |

NOTES: Positive (negative) current is defined as going into (coming out of) the specified device pin.
Operation of this device with standard TTL or DTL may require the use of appropriate pull-up resistors to ensure an input-logic high.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | $V_{\text {our }}$ |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{l}_{\text {OUT }}=-25 \mathrm{~mA}$ | 57 | - | V |
| Output Pull-Down Current | $\mathrm{I}_{\text {Our }}$ | $\mathrm{V}_{\text {OIT }}=\mathrm{V}_{\text {BB }}$ | 300 | 850 | $\mu \mathrm{A}$ |
| Output Leakage Current |  |  | - | -15 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{\text {(1) }}$ | $\mathrm{V}_{00}=5.0 \mathrm{~V}$ | 3.6 | - | V |
|  |  | $\mathrm{V}_{00}=15 \mathrm{~V}$ | 14 | - | V |
|  | $V_{\text {M(0) }}$ |  | -0.3 | +0.8 | V |
| Input Current | $1{ }_{\text {m(1) }}$ | $\mathrm{V}_{00}=\mathrm{V}_{\text {W }}=5.0 \mathrm{~V}$ | - | 145 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {D0 }}=\mathrm{V}_{\text {W }}=15 \mathrm{~V}$ | - | 430 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {W }}$ | $\mathrm{V}_{\mathrm{DO}}=5.0 \mathrm{~V}$ | 35 | - | $\mathrm{k} \Omega$ |
| Supply Current | $\mathrm{I}_{8 B}$ | All outputs ON, Outputs open | - | 10.5 | mA |
|  |  | All outputs OFF, Outputs open | - | 100 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{00}$ | $\mathrm{V}_{\text {D0 }}=5.0 \mathrm{~V}$, All outputs 0FF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {00 }}=15 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {00 }}=5.0 \mathrm{~V}$, One output 0 $\mathrm{N}, \mathrm{All} \mathrm{inputs}=0 \mathrm{~V}$ | - | 1.0 | mA |
|  |  | $\mathrm{V}_{00}=15 \mathrm{~V}$, One output 0N, All inputs $=0 \mathrm{~V}$ | - | 3.0 | mA |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{BB}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $15.75 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Units |
| Output OFF Voltage | Vout |  | - | 1.0 | V |
| Output ON Voltage |  | $\mathrm{I}_{\text {OUT }}=-25 \mathrm{~mA}$ | 57 | - | V |
| Output Pull-Down Current | $\mathrm{I}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {BB }}$ | 400 | 1400 | $\mu \mathrm{A}$ |
| Output Leakage Current |  |  | - | -30 | $\mu \mathrm{A}$ |
| Input Voltage | $V_{1 N(1)}$ | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ | 3.5 | - | V |
|  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 13.5 | - | V |
|  | $\mathrm{V}_{\text {IN(0) }}$ |  | -0.3 | $+0.8$ | V |
| Input Current | $1_{1 \times(1)}$ | $V_{D D}=V_{\mathbb{N}}=5.0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{D D}=V_{\text {W }}=15 \mathrm{~V}$ | - | 300 | $\mu \mathrm{A}$ |
| Input Impedance | $\mathrm{Z}_{\text {IN }}$ | $V_{D D}=5.0 \mathrm{~V}$ | 50 | - | $k \Omega$ |
| Supply Current | $I_{B B}$ | All outputs ON, Outputs open | - | 12 | mA |
|  |  | All outputs OFF, Outputs open | - | 100 | $\mu \mathrm{A}$ |
|  | $I_{D D}$ | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$, All outputs OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$, All outputs 0FF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, One output ON, All inputs $=0 \mathrm{~V}$ | - | 1.5 | mA |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$, One output 0 N , All inputs $=0 \mathrm{~V}$ | - | 4.5 | mA |

NOTES: Positive (negative) current is defined as going into (coming out of) the specified device pin.
Operation of this device with standard TTL or DTL may require the use of appropriate pull-up resistors to ensure an input-logic high.

## HERMETIC BiMOS LATCH/SOURCE DRIVER



> TIMING CONDITIONS
> $T_{A}=+25^{\circ} \mathrm{C}$; Logic Levels are $V_{D D}$ and $V_{S S}$
A. Minimum Data Active Time Before Strobe Enabled (Data Set-Up Time) ..... 100 ns
B. Minimum Data Active Time After Strobe Disabled (Data Hold Time) ..... 100 ns
C. Typical Strobe Pulse Width For Power-Up Clear Disable ..... 500 ns
Minimum Strobe Pulse Width After Power-Up Clear Disabled ..... 300 ns
D. Typical Time Between Strobe Activation and Output On to Off Transition ..... $1.0 \mu \mathrm{~s}$
E. Typical Time Between Strobe Activation and Output Off to On Transition ..... $1.0 \mu s$
F. Minimum Data Pulse Width ..... 500 ns

Information present at an input is transferred to its latch when the STROBE and ENABLE are high. The latches will continue to accept new data as long as both STROBE and ENABLE are held high. With either STROBE or ENABLE in the low state, no information can be loaded into the latches.

When the BLANKING input is high, all of the output buffers are disabled (OFF) without affecting the information stored in the latches. With the

BLANKING input low, the outputs are controlled by the state of the latches.

On first applying $V_{D D}$ to the device, all latch outputs assume a low state (Power-Up Clear) resulting in all outputs being OFF. The latches will remain in the low condition until the Clear is disabled by a STROBE high input. Data may be entered into the latches during Power-Up Clear disable if the ENABLE input is also high.

UCS-4815H TRUTH TABLE

| Inputs |  |  |  | OUTN |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbb{N}_{N}$ | STROBE | ENABLE | BLANK | T-1 | T |
| 0 | 1 | 1 | 0 | X | 0 |
| 1 | 1 | 1 | 0 | X | 1 |
| X | $x$ | $x$ | 1 | X | 0 |
| X | 0 | X | 0 | 1 | 1 |
| X | 0 | X | - 0 | 0 | 0 |
| X | X | 0 | 0 | 1 | 1 |
| X | X | 0 | 0 | 0 | 0 |
|  | vant |  |  |  |  |
| T-1 | ous output $s$ |  |  |  |  |

# SERIES UCS-4820H <br> BiMOS 8-BIT, SERIAL-INPUT, LATCHED DRIVERS - Hermetically Sealed 

## FEATURES

- High-Voltage Current-Sink Outputs
- CMOS, PMOS, NMOS, TTL Compatible
- Low-Power CMOS Logic and Latches
- Internal Pull-Up/Pull-Down Resistors
- Hermetically Sealed Packages to MIL-M-38510
- High-Reliability Screening to MIL-STD-883, Class B

INTENDED FOR MILITARY, aerospace, and related applications, Series UCS-4820H 8-bit, serial-input, latched drivers combine bipolar Darlington drivers with MOS logic circuitry ( BiMOS ) to provide an interface flexibility beyond the reach of standard logic buffers and power driver arrays. Except for the maximum allowable driver outputvoltage ratings, Types UCS-4821H ( 50 V ), UCS$4822 \mathrm{H}(80 \mathrm{~V})$, and UCS-4823H ( 100 V ) are identical.

Each driver contains a CMOS shift register and associated latches designed for operation over a 5 V to 15 V supply-voltage range. High-impedance inputs cause minimal loading of data lines and are compatible with standard CMOS, PMOS, and NMOS logic. When used with standard TTL or Schottky TTL, appropriate pull-up resistors may be required to ensure an input-logic high. The CMOS serial-data output allows cascading these devices for interface applications requiring additional drive lines.

The eight high-current bipolar outputs can drive multiplexed LED displays, incandescent lamps, thermal print heads, and (with appropriate clamping techniques) relays, solenoids and other high-power inductive loads. Under normal operating conditions,

and without heat sinking, these devices can sustain 200 mA per output at $50^{\circ} \mathrm{C}$ at a $42 \%$ duty cycle. Other combinations of number of conducting outputs, temperature, and duty cycle are shown on the following page.

Series UCS-4820H is furnished in 16-pin sidebrazed dual in-line hermetic packages that meet the processing and environmental requirements of Military Standard MIL-STD-883, Methods 5004 and 5005.

These same circuits are also available, with increased allowable package power dissipation, in glass/ceramic (cer-DIP) hermetic packages or plastic packages for operation over the extended temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Series UCQ-4820R or UCQ-4820A, respectively). Devices for use over a commercial/industrial temperature range are designated Series UCN-4820R or UCN-4820A, respectively.

# ABSOLUTE MAXIMUM RATINGS <br> at $+25^{\circ} \mathrm{C}$ Free-Air Temperature <br> and $V_{s s}=O V$ 

Output Voltage, $\mathrm{V}_{\text {out }}($ UCS-4821H) . .......................................... 50 V
(UCS-4822H) . . . . . . . . . . . . . . . . . . . . ....... . . . . . . . . . . 80 V
(UCS-4823H) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 100 V
Logic Supply Voltage, $\mathrm{V}_{\text {DD }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V

Continuous Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 500 mA
Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . See Graph



| Number of <br> Outputs 0 N | Maximum Allowable Duty Cycle <br> at $\mathrm{V}_{\text {OD }}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}$ of: |  |  |
| :---: | :---: | :---: | :---: |
| $\left(\begin{array}{c}\text { Out }\end{array}=200 \mathrm{~mA}\right)$ | $+25^{\circ} \mathrm{C}$ | $+50^{\circ} \mathrm{C}$ | $+85^{\circ} \mathrm{C}$ |
| 8 | $50 \%$ | $42 \%$ | $18 \%$ |
| 7 | $63 \%$ | $48 \%$ | $21 \%$ |
| 6 | $74 \%$ | $56 \%$ | $25 \%$ |
| 5 | $88 \%$ | $67 \%$ | $30 \%$ |
| 4 | $100 \%$ | $84 \%$ | $37 \%$ |
| 3 | $100 \%$ | $50 \%$ |  |
| 2 |  | $75 \%$ |  |
| 1 |  | $100 \%$ |  |

Caution: Sprague CMOS devices have input-static protection but are susceptible to damage when exposed to extremely high static electrical charges.

FUNCTIONAL BLOCK DIAGRAM


## TYPICAL INPUT CIRCUITS



TYPICAL OUTPUT DRIVER


ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE


5

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{D D}=5 \mathrm{~V}, \mathrm{~V}_{S S}=O \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | UCS-4821H | $\mathrm{V}_{\text {OUT }}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | UCS-4822H | $V_{\text {OUT }}=80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | UCS-4823H | $\mathrm{V}_{\text {OUT }}=100 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CESSAT }}$ | ALL | $\mathrm{l}_{\text {Out }}=100 \mathrm{~mA}$ | - | 1.1 | V |
|  |  |  | $\mathrm{I}_{\text {Out }}=200 \mathrm{~mA}$ | - | 1.3 | V |
|  |  |  | $\mathrm{I}_{\text {OUT }}=350 \mathrm{~mA}, \mathrm{~V}_{\text {DD }}=7.0 \mathrm{~V}$ | - | 1.6 | V |
| Input Voltage | $V_{\text {IN0 }}$ | ALL |  | - | 0.8 | V |
|  | $V_{\text {W(I) }}$ | ALL | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 13.5 | - | V |
|  |  |  | $V_{D D}=10 \mathrm{~V}$ | 8.5 | - | V |
|  |  |  | $V_{\text {Do }}=5.0 \mathrm{~V}$ (See note) | 3.5 | - | V |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | ALL | $V_{D D}=15 \mathrm{~V}$ | 50 | - | $k \Omega$ |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
|  |  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ | 50 | - | $k \Omega$ |
| Supply Current | $\mathrm{I}_{\text {DOON }}$ | ALL | One driver ON, $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | - | 2.0 | mA |
|  |  |  | One driver ON, $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ | - | 1.7 | mA |
|  |  |  | One driver ON, $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ | - | 1.0 | mA |
|  | $\mathrm{l}_{\text {Doforf }}$ | ALL | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |

Note: Operation of these devices with standard TLL or DTL may require the use of appropriate pull-up resistors to ensure an input-logic high.

ELECTRICAL CHARACTERISTICS at $T_{A}=-55^{\circ} \mathrm{C}, \mathrm{V}_{D D}=5 \mathrm{~V}, \mathrm{~V}_{S S}=O \mathrm{~V}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | UCS-4821H | $\mathrm{V}_{\text {OUT }}=50 \mathrm{~V}$ | - | 50 | $\mu \mathrm{A}$ |
|  |  | UCS-4822H | $\mathrm{V}_{\text {OUT }}=80 \mathrm{~V}$ | - | 50 | $\mu \mathrm{V}$ |
|  |  | UCS-4823H | $\mathrm{V}_{\text {out }}=100 \mathrm{~V}$ | - | 50 | $\mu \mathrm{V}$ |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CEISAD }}$ | ALL | $\mathrm{I}_{\text {Out }}=100 \mathrm{~mA}$ | - | 1.3 | V |
|  |  |  | $\mathrm{I}_{\text {OUT }}=200 \mathrm{~mA}$ | - | 1.5 | V |
|  |  |  | $\mathrm{l}_{\text {OUT }}=350 \mathrm{~mA}, \mathrm{~V}_{\text {DD }}=7.0 \mathrm{~V}$ | - | 1.8 | V |
| Input Voltage | $V_{\text {iv(0) }}$ | ALL |  | - | 0.8 | V |
|  | $V_{\text {IN(1) }}$ | ALL | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$ | 14 | - | V |
|  |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ | 9.0 | - | V |
|  |  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ (See note) | 3.6 | - | V |
| Input Resistance | $\mathrm{R}_{\mathrm{N}}$ | ALL | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 35 | - | $k \Omega$ |
|  |  |  | $V_{D D}=10 \mathrm{~V}$ | 35 | - | $\mathrm{k} \Omega$ |
|  |  |  | $\mathrm{V}_{\text {D }}=5.0 \mathrm{~V}$ | 35 | - | $k \Omega$ |
| Supply Current | $\mathrm{I}_{\text {DOON }}$ | ALL | One driver ON, $\mathrm{V}_{\text {D }}=15 \mathrm{~V}$ | - | 2.5 | mA |
|  |  |  | One driver $0 \mathrm{~N}, \mathrm{~V}_{\text {D }}=10 \mathrm{~V}$ | - | 1.9 | mA |
|  |  |  | One driver $0 \mathrm{~N}, \mathrm{~V}_{D D}=5.0 \mathrm{~V}$ | - | 1.2 | mA |
|  | $\mathrm{I}_{\text {Do(0FF }}$ | ALL | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {D }}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+125^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{OV}$ (unless otherwise specified)

| Characteristic | Symbol | Applicable Devices | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. | Units |
| Output Leakage Current | $\mathrm{I}_{\text {cex }}$ | UCS-4821H | $\mathrm{V}_{\text {OUT }}=50 \mathrm{~V}$ | - | 500 | $\mu \mathrm{A}$ |
|  |  | UCS-4822 H | $V_{\text {OUT }}=80 \mathrm{~V}$ | - | 500 | $\mu \mathrm{V}$ |
|  |  | UCS-4823H | $V_{\text {out }}=100 \mathrm{~V}$ | - | 500 | $\mu \mathrm{V}$ |
| Collector-Emitter Saturation Voltage | $V_{\text {celsat }}$ | ALL | $\mathrm{l}_{\text {OUT }}=100 \mathrm{mA*}$ | - | 1.3 | V |
|  |  |  | $\mathrm{I}_{\text {Out }}=200 \mathrm{~mA}$ * | - | 1.5 | V |
|  |  |  | $\mathrm{l}_{\text {OUT }}=350 \mathrm{~mA}^{*}, \mathrm{~V}_{\text {DD }}=7.0 \mathrm{~V}$ | - | 1.8 | V |
| Input Voltage | $V_{\text {INO) }}$ | ALL |  | - | 0.8 | V |
|  | $V_{\text {W(1) }}$ | ALL | $\mathrm{V}_{\text {DO }}=15 \mathrm{~V}$ | 13.5 | - | V |
|  |  |  | $\mathrm{V}_{\text {DO }}=10 \mathrm{~V}$ | 8.5 | - | V |
|  |  |  | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$ (See note) | 3.5 | - | V |
| Input Resistance | $\mathrm{R}_{\mathrm{N}}$ | ALL | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ | 50 | - | $k \Omega$ |
|  |  |  | $\mathrm{V}_{00}=10 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
|  |  |  | $V_{D D}=5.0 \mathrm{~V}$ | 50 | - | $\mathrm{k} \Omega$ |
| Supply Current | $\mathrm{I}_{\mathrm{DD} \text { (ON) }}$ | ALL | One driver $O \mathrm{~N}, \mathrm{~V}_{D D}=15 \mathrm{~V}$ | - | 2.0 | mA |
|  |  |  | One driver ON, $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | - | 1.7 | mA |
|  |  |  | One driver $0 \mathrm{~N}, \mathrm{~V}_{D D}=5.0 \mathrm{~V}$ | - | 1.0 | mA |
|  | $\mathrm{I}_{\text {DOOFF }}$ | ALL | $\mathrm{V}_{\text {DD }}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 100 | $\mu \mathrm{A}$ |
|  |  |  | $V_{D D}=5.0 \mathrm{~V}$, All drivers OFF, All inputs $=0 \mathrm{~V}$ | - | 200 | $\mu \mathrm{A}$ |

Note: Operation of these devices with standard TL or DTL may require the use of appropriate pull-up resistors to ensure an input-logic high.
*Pulsed test.

TIMING CONDITIONS

SERIAL DATA present at the input is transferred to the shift register on the logic " 0 ' to logic " 1 '" transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to its respective latch when the STROBE is high (serial-to-parallel conversion). The latches will con-
tinue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the ENABLE input be high during serial entry.

When the ENABLE input is high, all of the output buffers are disabled (OFF) without affecting the information stored in the latches or shift register. With the ENABLE input low, the outputs are controlled by the state of the latches.

SERIES UCS-4820H TRUTH TABLE


[^36]
# SERIES UDS-5700H QUAD 2-INPUT PERIPHERAL AND POWER DRIVERS Hermetically Sealed 

## FEATURES

- Four Logic Types
- DTL/TTL/PMOS/CMOS Compatible Inputs
- Low Input Current
- Sustaining Voltage of 80 V
- Hermetically Sealed Package to MIL-M-38510
- High-Reliability Screening to MIL-STD-883, Class B


## Description

These 16 -Lead quad 2 -input peripheral and power drivers are bi-polar monolithic integrated circuits incorporating AND, NAND, OR, and NOR logic gates, high-current switching transistors, and transient suppression diodes on the same chip. The four output transistors are capable of simultaneously sinking 150 mA continuously at an ambient temperature of $+70^{\circ} \mathrm{C}$. In the OFF state, these drivers will sustain at least 80 V .

## Applications

The Series UDS-5700H quad drivers are ideally suited for interface between low-level or high-level logic and high-current/high-voltage loads. Typical applications include driving peripheral loads such as incandescent lamps, light-emitting diodes, memories, and heaters.

The integral transient suppression diodes allow their use with inductive loads such as relays, solenoids, or stepping motors without the need for discrete diodes. For non-inductive loads, the diode common bus can be used as a convenient lamp test.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, VCC. ..... 7.0 V
Input Voltage, Vin. ..... 30 V
Output Off-State Voltage, Voff. ..... 80 V
Output On-State Sink Current, Ion. ..... 600 mA
Suppression Diode Off-State Voltage, Voff. ..... 80 V
Suppression Diode On-State Current, Ion ..... 600 mA
Power Dissipation, $\mathrm{P}_{\mathrm{D}}$. ..... 1.0 W
Package Power Dissipation, $P_{D}$. ..... See Graph
Ambient Temperature Range (operating), $T_{A}$. ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, TS. ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



## RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :--- | :--- | :--- | :--- |
| Supply Voltage (VCC) | 4.5 | 5.0 | 5.5 | ${ }^{\circ}$ |
| Operating Temperature Range | -55 | +25 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) | - | - | 300 | mA |

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Input Voltage | $V_{\text {in }}(1)$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {in( }(0)}$ |  | MIN |  |  |  |  |  | 0.7 | V |  |
| "0" Input Current | $\mathrm{I}_{\text {in }(0)}$ |  | MAX | 0.4 V | 30 V |  |  | -50 | -100 | $\mu \mathrm{A}$ | 2 |
| "1" Input Current | $\operatorname{lin}(1)$ |  | MAX | 30 V | 0 V |  |  |  | 10 | $\mu \mathrm{A}$ | 2 |
| Input Clamp Voltage | $V_{1}$ |  | MIN | -12 mA |  |  |  |  | -1.5 | V |  |

SWITCHING CHARACTERISTICS at $V_{c C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time | $\mathrm{t}_{\mathrm{pdO}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 200 | 500 | ns | 3 |
| Turn-off Delay Time | $t_{\text {pd }}$ | $\begin{aligned} & V_{\mathrm{S}}=70 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 300 | 750 | ns | 3 |

NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each input tested separately.
3. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.
4. Capacitance values specified include probe and test fixture capacitance.

## Type UDS-5703H Quad OR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\mathrm{off}}$ (min).
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

## Type UDS-5706H Quad AND Driver

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{C C}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 2.0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 0.8 V | $\mathrm{V}_{\text {cc }}$ | 150 mA |  | 0.4 | 0.5 | $V$ |  |
|  |  |  | MIN | 0.8 V | $\mathrm{V}_{\text {CC }}$ | 300 mA |  | 0.6 | 0.8 | V |  |
| Diode Leakage Current | ILK | NOM | NOM | 0 V | 0 V | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | VD | NOM | NOM | VCC | $\mathrm{V}_{\text {cC }}$ |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | $l_{\text {cc(1) }}$ | NOM | MAX | 5.0 V | 5.0 V |  |  | 16 | 24 | mA | 1,2 |
| "0" Level Supply Current | $\mathrm{ICC}(0)$ | NOM | MAX | 0 V | 0 V |  |  | 70 | 98 | mA | 1,2 |




NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off }}$ min).
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

## Type UDS-5707H Quad NAND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | VCc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 0.8 V | $V_{\text {CC }}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | VCC | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 0 " Output Voltage | Von |  | MIN | 2.0 V | 2.0 V | 150 mA |  | 0.4 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 300 mA |  | 0.6 | 0.8 | V |  |
| Diode Leakage Current | LK | NOM | NOM | Vcc | VCC | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V ${ }_{\text {D }}$ | NOM | NOM | 0 V | OV |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | 0 V | 0 V |  |  | 24 | 30 | mA | 1,2 |
| "0" Level Supply Current | ICC(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 80 | 106 | mA | 1,2 |



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

## Type UDS-5733H Quad NOR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | Vcc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 2.0 V | 0 V | 150 mA |  | 0.4 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | OV | 300 mA |  | 0.6 | 0.8 | $V$ |  |
| Diode Leakage Current | lik | NOM | NOM | $V_{\text {cc }}$ | Vcc | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | OV | 0 V |  |  | 1.5 | 1.75 | $V$ | 4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | 0 V | 0 V |  |  | 24 | 30 | mA | 1,2 |
| "0" Level Supply Current | Icc(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 80 | 100 | mA | 1,2 |




NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

# SERIES UDS-5710H DUAL PERIPHERAL AND POWER DRIVERS - Hermetically Sealed 

## FEATURES

- Four Logic Types
- DTL/TTL/PMOS/CMOS Compatible Inputs
- Low Input Current
- Sustaining Voltage of 80 V
- Transient-Protected Outputs
- High-Reliability Screening to MIL-STD-883, Class B


## Description

These dual peripheral and power drivers are bipolar monolithic integrated circuits incorporating AND, NAND, OR, or NOR logic gates, highcurrent switching transistors, and transient suppression diodes on the same chip. The two output transistors are capable of simultaneously sinking 200 mA continuously at ambient temperatures of up to $+85^{\circ} \mathrm{C}$. In the OFF state, these drivers will sustain at least 80 V . Units are supplied in 8-pin hermetically sealed mini-DIP packages.

## Applications

The Series UDS-5710H dual drivers are ideally suited for interface between low-level or high-level logic and high-current/high-voltage loads. Typical applications include driving peripheral loads such as incandescent lamps, light-emitting diodes, memories, and heaters with a load current of up to a 500 mA peak value.

The integral transient suppression diodes allow the use of these drivers with inductive loads such as relays, solenoids, or stepping motors without the need for discrete diodes. When not required for transient suppression, the diode common bus can be used to perform the "lamp test" function.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{C C}$ ..... 7.0 V
Input Voltage, Vin ..... 30 V
Output Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Output On-State Sink Current, Ion ..... 500 mA
Suppression Diode Off-State Voltage, $\mathrm{V}_{\text {off }}$ ..... 80 V
Suppression Diode On-State Current, Ion ..... 500 mA
Power Dissipation, $P_{D}$ (one output) ..... 1.0 W
(total package) ..... See Graph
Ambient Temperature Range (operating), $\mathrm{T}_{\mathrm{A}}$ ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Storage Temperature Range, IS $_{S}$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$


Type UDS-5713H
Dual OR Driver


Type UDS-5711H Dual AND Driver


Type UDS-5712H Dual NAND Driver


Type UDS-5714H Dual NOR Driver

## POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



RECOMMENDED OPERATING CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :--- | :--- | :--- | :--- | :---: |
| Supply Voltage ( $V_{c c}$ ) | 4.5 | 5.0 | 5.5 | V |
| Operating Temperature Range | -55 | +25 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Current into any output (ON state) | - | - | 300 | mA |

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $V_{\text {cc }}$ | Driven Input | $\begin{aligned} & \text { Other } \\ & \text { Input } \end{aligned}$ | Output | Min. | Typ. | Max. | Units |  |
| "1" Input Voltage | $V_{\text {in(1) }}$ |  | MIN |  |  |  | 2.0 |  |  | V |  |
| "0" Input Voltage | $V_{\text {im( }}$ ( $)$ |  | MIN |  |  |  |  |  | 0.8 | V |  |
| " 0 " Input Current at all Inputs except Strobe | $\mathrm{I}_{\text {in(0) }}$ |  | MAX | 0.4 V | 30 V |  |  | -50 | -100 | $\mu \mathrm{A}$ | 2 |
| "0" Input Current at Strobe | Iin(0) |  | MAX | 0.4 V | 30 V |  |  | $-100$ | $-200$ | $\mu \mathrm{A}$ |  |
| " 1 " Input Current at all Inputs except Strobe | $\mathrm{l}_{\text {in(1) }}$ |  | MAX | 30 V | 0 V |  |  |  | 10 | $\mu \mathrm{A}$ | 2 |
| "1" Input Current at Strobe | In(1) |  | MAX | 30 V | OV |  |  |  | 20 | $\mu \mathrm{A}$ | 2 |
| Input Clamp Voltage | $V_{1}$ |  | MIN | -12 mA |  |  |  |  | -1.5 | V |  |

SWITCHING CHARACTERISTICS at $\mathrm{V}_{\text {CC }}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |  |
| Turn-on Delay Time | $\mathrm{t}_{\mathrm{pdo}}$ | $\begin{aligned} & V_{S}=70 \mathrm{~V}, R_{L}=465 \Omega \text { (10 Watts) } \\ & C_{L}=15 \mathrm{pF} \end{aligned}$ |  | 200 | 500 | ns | 3 |
| Turn-off Delay Time | $\mathrm{T}_{\mathrm{pd} 1}$ | $\begin{aligned} & V_{\mathrm{S}}=70 \mathrm{~V}, R_{\mathrm{L}}=465 \Omega \text { (10 Watts) } \\ & C_{\mathrm{L}}=15 \mathrm{pF} \end{aligned}$ |  | 300 | 750 | ns | 3 |

NOTES:

1. Typical values are at $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Each input tested separately.
3. Voltage values shown in the test circuit waveforms are with respect to network ground terminal.
4. Capacitance values specified include probe and test fixture capacitance.

| INPUT PULSE CHARACTERISTICS |  |  |
| :--- | ---: | ---: |
| $V_{\text {in(0) }}=0 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{f}}=7 \mathrm{~ns}$ | $\mathrm{t}_{\mathrm{p}}=1 \mu \mathrm{~s}$ |
| $V_{\text {in }(1)}=3.5 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{t}}=14 \mathrm{~ns}$ | PRR $=500 \mathrm{kHz}$ |

## UDS-57 11 H Dual AND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)



DWG. No. A-7628C

NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\text {off(min) }}$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

## UDS-57 12H Dual NAND Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | $\mathrm{V}_{\text {CC }}$ | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | Ioff |  | MIN | 0.8 V | Vcc | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | $V_{C C}$ | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 0 ' Output Voltage | Von |  | MIN | 2.0 V | 2.0 V | 150 mA |  | 0.4 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | 2.0 V | 300 mA |  | 0.6 | 0.8 | $V$ |  |
| Diode Leakage Current | ILK | NOM | NOM | VCC | $\mathrm{V}_{\mathrm{cc}}$ | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | 0 V | 0 V |  |  | 1.5 | 1.75 | $V$ | 4 |
| "1" Level Supply Current | Icc(1) | NOM | MAX | 0 V | OV |  |  | 12 | 15 | mA | 1,2 |
| "0" Level Supply Current | Icc(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 40 | 53 | mA | 1.2 |




DWG. No A-7900A

NOTES:

1. Typical values are at $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
2. Per package.
3. Diode leakage current measured at $V_{R}=V_{\text {off(min). }}$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

## UDS-5713H Dual OR Driver

## ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | VCC | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff |  | MIN | 2.0 V | 0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 2.0 V | 0 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| "0" Output Voltage | Von |  | MIN | 0.8 V | 0.8 V | 150 mA |  | 0.4 | 0.5 | V |  |
|  |  |  | MIN | 0.8 V | 0.8 V | 300 mA |  | 0.6 | 0.8 | V |  |
| Diode Leakage Current | luk | NOM | NOM | 0 V | 0 V | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | $V_{\text {cc }}$ | VCC |  |  | 1.5 | 1.75 | V | 4 |
| "1" Level Supply Current | ICC(1) | NOM | MAX | 5.0 V | 5.0 V |  |  | 8.0 | 13 | mA | 1,2 |
| "0" Level Supply Current | $\operatorname{ICC}(0)$ | NOM | MAX | 0 V | 0 V |  |  | 36 | 50 | mA | 1,2 |



NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
2. Per package.
3. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\mathrm{off}}(\mathrm{min})$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$.
5. Capacitance values specified include probe and test fixture capacitance.

## UDS-57 14 H Dual NOR Driver

ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Temp. | VCc | Driven Input | Other Input | Output | Min. | Typ. | Max. | Units |  |
| "1" Output Reverse Current | loff | * | MIN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
|  |  |  | OPEN | 0.8 V | 0.8 V | 80 V |  |  | 100 | $\mu \mathrm{A}$ |  |
| " 0 " Output Voltage | Von |  | MIN | 2.0 V | 0 V | 150 mA |  | 0.4 | 0.5 | V |  |
|  |  |  | MIN | 2.0 V | 0 V | 300 mA |  | 0.6 | 0.8 | V |  |
| Diode Leakage Current | lik | NOM | NOM | VCC | VCC | OPEN |  |  | 200 | $\mu \mathrm{A}$ | 3 |
| Diode Forward Voltage Drop | V | NOM | NOM | 0 V | 0 V |  |  | 1.5 | 1.75 | V | 4 |
| " 1 " Level Supply Current | Icc(1) | NOM | MAX | 0 V | 0 V |  |  | 12 | 15 | mA | 1,2 |
| "0" Level Supply Current | ICC(0) | NOM | MAX | 5.0 V | 5.0 V |  |  | 40 | 50 | mA | 1,2 |




NOTES:

1. Typical values are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
2. Per package.
3. Diode leakage current measured at $\mathrm{V}_{\mathrm{R}}=\mathrm{V}_{\mathrm{off}}(\mathrm{min})$.
4. Diode forward voltage drop measured at $I_{f}=300 \mathrm{~mA}$
5. Capacitance values specified include probe and test fixture capacitance.

## UDS-5791H QUAD PIN DIODE POWER DRIVER

## features

- Low Input Current
- TIL, DTL, MOS Compatible
- Wide Operating Range
- High Output Breakdown Voltage

CONSISTING of four high-voltage NPN output stages and associated logic and level shifting, the Type UDS-5791H monolithic integrated circuit offers an easy solution to many problems associated with driving PIN diodes.

The UDS-5791H quad power driver is designed to replace discrete or hybrid PIN diode drivers. It provides significant reductions in cost and space with improved reliability. The driver uses a commonemitter input stage for inverting operation. It is capable of sustaining off voltages of 120 V and will switch currents to 500 mA .
The input buffer circuitry has been designed to utilize external discrete resistors. The one resistor per driver effectively reduces total package power dissipation and junction temperature while allowing user selection of output base drive current, power supply voltages, and output current.


The device is rated for operation over an extended temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. It is customarily supplied in 16-pin hermetic dual in-line package. The unit is subjected to the $100 \%$ production screen tests specified in MIL-STD-883, Method 5004, Class B paragraphs 3.1.1 through 3.1.6. On special order, 160 hours of burn-in to Method 1015, Condition A, can also be performed.

ABSOLUTE MAXIMUM RATINGS over free-air operating temperature range

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | +6.0V |
| :---: | :---: |
| Supply Voltage, $\mathrm{V}_{\mathrm{EE}}$ | -6.0V |
| Input Voltage, $\mathrm{V}_{\mathbb{W}}$ | $V_{c c}$ |
| Output OFF-State Voltage, $\mathrm{V}_{\text {OFF }}$ (ref. $V_{E E}$ ) | $+120 \mathrm{~V}$ |
| Output ON-State Current, $\mathrm{I}_{\text {on }}$ | 500 mA |
| Package Power Dissipation, $\mathrm{P}_{0}$ | See Graph |
| Operating Ambient Temperature Range, $\mathrm{T}_{\text {}}$ | 0 $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ | $0+150^{\circ} \mathrm{C}$ |

## PARTIAL SCHEMATIC



ONE OF FOUR DRIVERS
UDS-5791H

## RECOMMENDED OPERATION CONDITIONS

|  | Min. | Nom. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: |
| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 4.5 | 5.0 | 5.5 | $V$ |
| Supply Voltage, $\mathrm{V}_{\text {EE }}$ | -1.5 | -3.0 | -5.5 | $V$ |
| Output 0N-State Current, $\mathrm{l}_{\text {on }}$ |  |  | 300 | mA |
| Operating Ambient Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | -55 | +85 | +125 | ${ }^{\circ} \mathrm{C}$ |

## POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



ELECTRICAL CHARACTERISTICS over operating temperature range (unless otherwise noted)

| Characteristic | Symbol | Temp. ( ${ }^{\circ} \mathrm{C}$ ) | $\begin{gathered} V_{c c} \\ (+V) \end{gathered}$ | $\begin{gathered} V_{\mathrm{EE}} \\ (-\mathrm{V}) \end{gathered}$ | $\begin{gathered} V_{\mathbb{W}} \\ (+V) \end{gathered}$ | $\begin{aligned} & V_{\text {off }} \text { or } l_{\text {on }} \\ & (+V) \quad(\mathrm{mA}) \end{aligned}$ | $\begin{gathered} R_{x} \\ (\Omega) \end{gathered}$ | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  | Min. | Max. | Units |
| "1" Input Voltage | $V_{\text {W(1) }}$ |  | 4.5 |  |  |  |  | 2.0 | 4.0 | V |
| "0" Input Voltage | $V_{\text {IV0) }}$ |  | 4.5 |  |  |  |  | - | 0.8 | V |
| "1" Input Current | $\mathrm{I}_{\text {(1) }}$ |  | 5.5 | 3.0 | 5.0 |  |  | - | 50 | $\mu \mathrm{A}$ |
| "0" Input Current | $\mathrm{I}_{\text {m(0) }}$ |  | 5.5 | 3.0 | 0.4 |  |  | - | 1.0 | mA |
| OFF-State Reverse Current | $\mathrm{l}_{\text {OFF }}$ | +25 | 4.5 | 3.0 | 0.4 | 115 |  | - | 50 | $\mu \mathrm{A}$ |
|  |  | +125 | 4.5 | 3.0 | 0.4 | 115 |  | - | 100 | $\mu \mathrm{A}$ |
| ON -State Output Voltage (ref. $V_{E E}$ ) (See Note) | $V_{\text {on }}$ | -55 | 4.5 | 1.5 | 2.4 | 150 | 720 | - | 400 | mV |
|  |  |  |  |  |  | 300 | 360 | - | 600 | mV |
|  |  | +85 | 4.5 | 1.5 | 2.4 | 150 | 720 | - | 400 | mV |
|  |  |  |  |  |  | 300 | 360 | - | 700 | mV |
|  |  | +125 | 4.5 | 1.5 | 2.4 | 150 | 720 | - | 500 | mV |
|  |  |  |  |  |  | 300 | 360 | - | 850 | mV |
| Predriver Collector Voltage (ref. $V_{E E}$ ) (See Note) | $V_{x}$ |  | 4.5 | 1.5 | 2.4 | 150 | 720 | - | 1.3 | V |
|  |  |  |  |  |  | 300 | 360 | - | 1.5 | V |
| Output Short-Circuit Current (See Note) | Ios |  | 4.5 | 3.0 | 0.4 | -2.3 | 510 | 20 | 50 | mA |
| OFF-State Supply Current | $\mathrm{I}_{\mathrm{cc}}$ |  | 5.5 | 5.5 | 0.4 |  |  | - | 4.1 | mA |
| ON-State <br> Supply Current | $\mathrm{l}_{\mathrm{cc}}$ |  | 5.5 | 5.5 | 2.4 |  |  | - | 3.4 | mA |
| Turn-On Delay | $\mathrm{t}_{0}$ | - | 5.0 | 3.0 | - | - - | 510 | - | 500 | ns |
| Storage Delay | $\mathrm{t}_{\text {s }}$ | - | 5.0 | 3.0 | - | - - | 510 | - | 5.0 | $\mu \mathrm{S}$ |
| Fall Time | $t_{f}$ | - | 5.0 | 3.0 | - | - - | 510 | - | 100 | ns |

NOTE: Each output tested separately.

## SWITCHING TEST CIRCUIT AND WAVEFORMS



## GENERAL DESIGN NOTES

$I_{R X}=\frac{I_{O N}}{B}$
$R_{X}=\frac{B\left(V_{C C}-V_{E E}-V_{X}\right)}{I_{O N}}$
where
$B=30$, the minimum output current gain over the operating temperature range
$V_{x}=1.5$, the maximum predriver voltage
It is recommended that a minimum overdrive of $25 \%$ to be used ( $1.25 I_{R X}$ or $0.8_{R X}$ ).

## QUALITY ASSURANCE FLOW CHART




# THE SPRAGUE ELECTRIC 'DOUBLE-DEUCE' BURN-IN PROGRAM FOR INTEGRATED CIRCUITS 

TTHE EXPENSE OF DEVICE FAILURE is more than the time and money spent locating and replacing a defective integrated circuit. The total cost can include the price of assembly rework, system downtime, service calls, warranty claims and lost customer goodwill.

Costs of $\$ 25$ for each in-house failure and $\$ 250$ for each field failure are not uncommon. At a relatively low cost, Sprague

Electric Company's "Double-Deuce" screening program removes marginal devices before shipment. Improved customer satisfaction with performance and reliability is an immeasurable but certain bonus of the program.
"Double-Deuce" screening is done during the last stage of production. Because Sprague does the screening, only qualified devices are received by the user.

## QUALITY AND RELIABILITY

Quality and reliability are terms that are often used interchangeably. Quality implies reliability, but a product's merit should always be defined by both.

Quality is the extent to which a device conforms to specifications when it is shipped to the user. Quality is verified by testing. Inspections at every step of production of Sprague integrated circuits ensure the devices meet demanding standards for workmanship and materials.

Inspections of integrated circuits under the "Double-Deuce" program have been made even more stringent to secure a higher level of quality.

Reliability is the measure of an integrated circuit's ability to meet specifications over time. Reliability is a product of design and process control. Acceleratedlife tests provide the manufacturer and user with an indication of the reliability of a device. Normally, a small number of integrated circuits exhibit signs of early failure or infant mortality. This statistic, taken from the steepest part of the IC
lifetime probability curve, is often used to project time-to-failure for integrated circuits. Because the "Double-Deuce" program eliminates early failures, Sprague integrated circuits delivered after the screening process have a higher degree of reliability.

## PROBABILITY OF FAILURE

 AS A FUNCTION OF TIME

## OUTLINE OF THE 'DOUBLE-DEUCE' PROCESS

The "Double-Deuce" burn-in program uses high stress levels to accelerate the failure mechanisms associated with infant mortality. These normally occur within the first few hours of user application. Although typically less than 1 per cent of a lot will be rejected, user confidence in lot integrity is greatly improved. The screening program is designed to eliminate the following failure modes:

## Stress

High-Temp. Bake
Temp. Cycling
Burn-In
High-Temp. Testing Electrical Degradation
The majority of early integrated circuit failures (infant mortality or ionic contamination) can be attributed to manufacturing defects, package or assembly defects, or final test escapes. The "DoubleDeuce" program is designed to eliminate weaker parts, reduce or eliminate user shipment inspection, assembly rework, system checkout, and warranty returns.

## Failure Mode

Contamination Package-Related Process-Related

## MILITARY AND AEROSPACE DEVICES (Continued)

## TEST PROCEDURES

## 3. Burn-In

The burn-in, or accelerated-life test, is performed to screen out marginal devices, those with inherent defects, or defects resulting from manufacturing deviations that can cause time-dependent or stressdependent failures. Without this conditioning, marginal circuits that initially meet all specifications could exhibit early lifetime failures under normal operating conditions. The test is conducted for 96 hours at a junction temperature of $+150^{\circ} \mathrm{C}$ under electrical stress conditions (similar to MIL-STD-883, Method 1015) such as:

## Type of Device

Bipolar Interface Linear Devices
$I^{2} \mathrm{~L}$ and MOS Logic

## Electrical Stress

Steady-State Reverse Bias Steady-State Forward Bias Clocked

The burn-in conditions ( 96 hours at $\mathrm{T}_{\mathrm{J}}$ $=+150^{\circ} \mathrm{C}$ ) are equivalent to 525 hours at
$\mathrm{T}_{\mathrm{J}}=+125^{\circ} \mathrm{C}$ for ionic contamination ( $\mathrm{E}_{\mathrm{A}}$ $=1.0 \mathrm{eV}$ ) or for 192 hours at $\mathrm{T}_{\mathrm{J}}=+125^{\circ} \mathrm{C}$ for infant mortality defects ( $\mathrm{E}_{\mathrm{A}}=0.4 \mathrm{eV}$ ).

## 4. High-Temperature Test

Every device is subjected to complete electrical tests at $+70^{\circ} \mathrm{C}$ for function and d-c parameters (similar to MIL-STD-883, Methods 3001 through 3014 and 4001 through 4007, as applicable). Relaxed $+25^{\circ} \mathrm{C}$ limits or published hightemperature limits, are used to remove devices with circuit anomalies such as beta mismatch, high leakage current, and intermittent bonds, which may only affect the circuit at higher temperatures.

## 5. Outgoing Quality Control Inspection

All "Double-Deuce" product is inspected to an outgoing sampling plan which guarantees that the product will meet an acceptable quality level of $0.25 \%$.

## HOW TO ORDER

All standard Sprague integrated circuits are branded with the Sprague registered trademark, (2).

Integrated circuits screened to the added requirements of the "Double-Deuce" program are marked:

## (2) (2)

The double "circle-deuce" identifies a
part subjected to the screening program for extra reliability.

Devices processed in the "DoubleDeuce" burn-in program are specified by adding the suffix "BU" to the end of the part number. For example, to order ULN2023A with this processing, specify ULN2023ABU; to order UDN-6116R-2, specify UDN-6116R-2BU.

## INTERFACE DRIVERS WITH MIL-STD-883 HIGH-RELIABILITY SCREENING

Interface drivers with high-reliability screening can be ordered by adding the suffix 'MIL'' to the part number, for example, ULS-2064H-MIL. If marking with the customers part number is necessary in place of the Sprague Electric part number, this must be stated on the purchase order with the marking desired.

Table I - $100 \%$ Production Screen Tests (All Hermetic Parts) MIL-STD-883, Method 5004, Class B, Paragraphs 3.1.1 through 3.1.6

| Screen | MIL-STD-883 Test Method | Conditions |
| :---: | :---: | :---: |
| Internal Visual | 2010, Cond. B | - |
| Stabilization Bake | 1008, Cond. C | $150^{\circ} \mathrm{C}, 24$ Hours |
| Thermal Shock | 1011, Cond. A | 0 to $100^{\circ} \mathrm{C}, 15$ Cycles |
| Constant Acceleration | 2001, Cond. E | 30,000 G's, Y1 Plane |
| Fine Seal | 1014. Cond. A | $5 \times 10^{-7} \mathrm{~atm} \cdot \mathrm{~cm}^{3} / \mathrm{s}$ Maximum |
| Gross Seal | 1014, Cond. C | - |
| Electrical | - | Per Specification |
| Marking | - | Sprague or customer part number, date code, lot identification, index point |



Table III - High-Reliability Qualification and Quality Conformance Inspection MIL-STD-883, Method 5004, Class B, Paragraph 3.1.17

|  | MIL-STD-883 <br> Test | Test Method |
| :--- | :--- | :--- | Description | Group A Subgp. 1-4, $7 \& 9$ | 5005, Table I |
| :--- | :--- |
| Group B | 5005 , Table II |
| Group C | 5005 , Table II |
| Group D | Each production lot |

me of this material has been taken from Military Specification MIL-M-38510E and Military Standard MIL-STD-883B, Methods 1008.2, 1011.4, 1014.5, 1015.4, 01.2, 2009.4, 2010.7, 5004.6, and 5005.8.
e above conditions may not comply with MIL-M-38510F and MIL-STD-883C.

## BiMOS POWER DRIVERS TO MIL-STD-883

CONTINUING in its leadership role in interface integrated circuits, Sprague Electric Company has added hermetic BiMOS power drivers to its long list of innovations.

These high-current and high-voltage drivers with MIL-STD-883 screening provide a new level of interface flexibility and versatility for military, aerospace, avionics, and other applications requiring high reliability. They are supplied in either glass/metal side-brazed hermetic packages (suffix letter ' H ') or ceramic/glass cerDIP hermetic packages (suffix letter ' $R$ ').

BiMOS monolithic devices combine CMOS logic and control functions with four, seven, eight, or ten bipolar output, power-interface buffers. Reliable, single-chip solutions are now available for a wide variety of peripheral power interface problems. No longer are two or three
devices required to link low-level (TTL, CMOS, NMOS, PMOS) LSI or microprocessor functions with power loads such as relays, LEDs, solenoids, lamps, gas-discharge or vacuumfluorescent displays, and motors.

In addition to providing space-saving singlechip solutions to many peripheral power interface problems, Sprague BiMOS devices with an extended temperature range also improve system reliability and lower both component count and system cost.

Detailed engineering bulletins for the hermetic, extended temperature BiMOS integrated circuits described here are available from Sprague district sales offices, or from Technical Literature Service, Sprague Electric Company, Marshall Street, North Adams, Mass. 01247.

## 8-BIT SERIAL-INPUT/PARALLEL-OUTPUT LATCHED DRIVERS

SERIES UCS-4820H BiMOS 8-Bit Serial-In/ Parallel-Out Latched Drivers augment the original Type UCS-4401H and UCS-4801H devices. All of the devices in this series contain an octal shift register, octal latch, and octal high-current, opencollector Darlington outputs. They improve systems designs through a reduced package count and a reduction in I/O line requirements. By using the serial data output, the drivers can be cascaded for interface applications requiring more than eight drive lines.

The three devices in this series are functionally identical, but differ in the maximum allowable output voltage ratings. The bipolar outputs are suitable
for a variety of peripheral loads, including incandescent lamps, LEDs, thermal or electrosensitive printers, and (with appropriate clamping techniques) relays, solenoids, and other high-power inductive loads.

## recommended max. OPERATING CONDITIONS

Output Voltage (UCS-4821H) ..... 45 V
(UCS-4822H) ..... 75 V
(UCS-4823H) ..... 95 V
Logic Supply Voltage ..... 12 V
Continuous Output Current ..... 350 mt

## ELECTROSENSITIVE PRINTER APPLICATION



## 10-BIT SERIAL-INPUT/PARALLEL-OUTPUT LATCHED SOURCE DRIVER

THE TYPE UCS-4810H BiMOS 10-Bit Serial-In/Parallel-Out Latched Source Driver is primarily designed as interface between logic circuitry and vacuum-fluorescent displays but may also be used with LED displays or thermal printers within its output limitations of 60 V and -40 mA per driver. A selected version, Type UCS $-4810 \mathrm{H}-1$, has a maximum operating-yoltage rating of 80 V .

The CMOS shift register and latches will operate over a wide supply-voltage range and are compatible with standard MOS logic families. When used with TTL or low-speed TTL, pull-up resistors may be needed to ensure an input-logic high.

The 10 high-voltage outputs are used to switch the
anodes (segments or dots) and /or grids (character or digit) of typical vacuum-fluorescent panels. The high-voltage version is often used with larger and more complex alphanumeric or graphics panels, or gas-discharge displays. With suitable signal-level shifting, it may also be used as an anode driver for planar gas-discharge applications.

## RECOMMENDED MAX. OPERATING CONDITIONS

Output Voltage (UCS-4810H) ........................ 55 V
(UCS-4810H-1)
75 V
Logic Supply Voltage Range . . . . . . . . . . . . . . . 5.0 V to 12 V
Continuous Output Current . . . . . . . . . . . . . . . . . . . -25 mA


## 8-BIT LATCHED SOURCE DRIVER

THE TYPE UCS-4815H BiMOS 8-Bit Latched Source Driver is designed primarily for use with high-voltage vacuum-fluorescent displays. It contains an 8-bit type D latch and eight source outputs with pull-down resistors, a common strobe, blanking, and enable functions. The standard output voltage rating is 60 V , with a selected version (Type UCS- $4815 \mathrm{H}-1$ ) available for operation to 80 V .

The eight high-voltage outputs are generally used to drive the segments, dots (matrix panel), bars, or
digits of vacuum-fluorescent displays. The highvoltage version is often used with larger and more complex gas-discharge alphanumeric or graphics panels.

RECOMMENDED MAX. OPERATING CONDITIONS
Output Voltage (UCS-4815H) . . . . . . . . . . . . . . . . . . . . 55 V
(UCS-4815H-1) . . . . . . . . . . . . . . . . . . . 75 V
Logic Supply Voltage Range . . . . . . . . . . . . . . . 5.0 V to 12 V
Continuous Output Current . . . . . . . . . ............. -25 mA


## 4- AND 8-BIT LATCHED DRIVERS

TYPES UCS-4401H and UCS-4801H are the original BiMOS integrated circuits. They are used successfully in many applications. These highvoltage, high-current latched drivers have four or eight MOS data latches, a bipolar driver for each latch, and MOS control circuitry for the common CLEAR, STROBE, and OUTPUT ENABLE functions. Type UCS-4401H contains four latched drivers while Type UCS-4801H contains eight latched drivers.

Each of the open-collector Darlington outputs can sink up to 500 mA and will sustain at least 50 V in the OFF state. Internal diodes suppress transients and allow these devices to be used with inductive loads. Package power limitations normally disallow
simultaneous and continuous operation of all outputs at the rated maximum current, and usually dictate either a reduction in output current or a suitable combination of duty cycle and number of active outputs.

Type UCS-4401H is supplied in a standard 14 lead side-brazed hermetic package. Type UCS4801 H is furnished in a 22 -lead side-brazed hermetic package with lead centers on 0.400 -inch spacing.

## RECOMMENDED MAX. OPERATING CONDITIONS

Output Voltage ..... 45 V
Logic Supply Voltage ..... 12 V
Continuous Output Current ..... 350 mA



## 8-BIT ADDRESSABLE LATCHED DRIVERS

TYPE UCS-4807H and UCS-4808H 8-Bit Addressable Latched Drivers are identical except for output current ratings. Type UCS- 4807 H is rated for a maximum of 200 mA per output while Type UCS- 4808 H is capable of sinking up to 600 mA per output. The outputs are NPN saturated switches; the drive currents are optimized for each version.

Both devices are cumprised of a 3 -bit to 8 -line decoder, eight type D latches, eight open-collector NPN output drivers, and MOS control circuitry for CLEAR, input, output, and CHIP SELECT functions.

Both 8-bit addressable latched drivers are useful as demultiplexers. They are capable of driving a wide assortment of peripheral loads including lamps, relays, solenoids, LEDs, stepper motors, or may be
used as DMUX/predrivers for higher power loads requiring discrete power semiconductors.

A typical application for Type UCS- 4808 H , driving a common-cathode LED display, is shown. Many of today's multi-character LED displays can make use of the high-current capability of this device. With the DATA input held high, the proper address code may be furnished by a 3-bit counter.

## RECOMMENDED MAX. OPERATING CONDITIONS

Output Voltage ..... 45 V
Logic Supply Voltage Range ..... 5.0 V to 12 V
Continuous Output Current (UCS-4807H) ..... 150 mA
(UCS-4808H) ..... 350 mA

## MULTIPLEXED COMMON-CATHODE LED DISPLAY DRIVER



MULTIPLEXED POWER DRIVER


## MULTI-CHANNEL INTERFACE TO HIGH-POWER LOADS

SPRAGUE BiMOS power drivers can be employed as multi-channel pre-drivers for discrete ligh-current or high-voltage semiconductors, thus educing the need for many discrete components. For instance, any of the BiMOS sink drivers (Types JCS-4401/4801/4808/4821/4822/4823H) can rovide enough current to the bases of discrete PNP ower transistors to make 5 A load currents possible. figher load currents can be obtained by using power Jarlington devices. BiMOS source drivers (Types JCS-4810/4815H) will require discrete Darlington
power drivers for any significant load currents, but have the added advantage of allowing rather wide load-voltage swings.

For a-c loads, it is possible to use a source driver to provide gate current (with appropriate current limiting) to a power SCR or triac. This scheme can provide an economical solution to many applications such as driving incandescent lamps or a-c motors with current levels of up to 20 A .

DISCRETE POWER DRIVERS FOR HIGH-POWER LOADS


Dwg. No. A-11, 744


Dwg. No. A-11,745

## BiMOS POWER DRIVERS TO MIL-STD-883, METHOD 5004

T'HE QUALITY ASSURANCE and Reliability department of Sprague Electric Company strives to assure that products delivered to customers are of the highest possible quality and reliability level and consistent with customer requirements. During product processing, there are several independent visual and electrical inspections performed by Quality Assurance personnel.

All full-temperature hermetic products are processed to stringent production screen inspec-
tions and tests in accordance with MIL-STD-883, Method 5004, paragraphs 3.1.1 through 3.1.6. BiMOS power drivers subjected to burn-in and additional high-reliability screening (Method 5004, Class B) can be ordered by adding the suffix "-MIL" to the part number, for example UCS- $4815 \mathrm{H}-\mathrm{MIL}$ (side-brazed hermetic) or UCS-4815R-MIL (cer-DIP hermetic). This additional processing incorporates paragraphs 3.1 .9 through 3.1.15, and 3.1 .18 of the military standard.




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# SELECTION GUIDE TO RADIO/COMMUNICATIONS INTEGRATED CIRCUITS 

| Device <br> Type | F-M R-F <br> Mixer | $\begin{aligned} & \mathrm{F}-\mathrm{M} \\ & \mathrm{I}-\mathrm{F} \end{aligned}$ | $\begin{aligned} & \text { F-M } \\ & \text { Det. } \end{aligned}$ | Mute/ <br> Squelch | $\begin{gathered} \Delta f \\ \text { Mute } \end{gathered}$ | Stereo <br> Decoder | A-M <br> Radio | Audio <br> Amp |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ULN-2111A | - | X | X | - | - | - | - | - |
| ULN-2204A | - | $X$ | $X$ | - | - | - | $X$ | X |
| ULN-2240A | - | $X$ | $X$ | $X$ | X | - | $X$ | - |
| ULN-2241A | - | $X$ | $X$ | - | - | - | $X$ | - |
| ULN-2242A | - | $X$ | $X$ | $X$ | - | - | $X$ | - |
| ULN-2243A | X | $X$ | - | - | - | - | - | - |
| ULN-2249A | - | - | - | - | - | - | $X$ | - |
| ULX-3803A* | - | $X$ | $X$ | - | - | - | $X$ | - |
| ULN-3804A | - | X | X | - | - | - | X | - |
| ULN-3809A | - | - | - | - | - | $X$ | - | - |
| ULN-3810A | - | - | - | - | - | $X$ | - | - |
| ULN-3812A | - | - | - | - | - | $X$ | - | - |
| ULN-3838A | - | - | - | - | - | - | $X$ | X |
| ULN-3840A | - | X | $X$ | $X$ | $X$ | - | X | - |
| ULN-3859A | X | $X$ | $X$ | $X$ | - | - | - | - |

NOTE: Additional devices for use as F-M radios can be found in Section 7 ; audio amplifiers appear in Section 8.
*New device. Contact factory for information.

## ULN-2111A F-M I-F AMPLIFIER/LIMITER AND QUADRATURE DETECTOR

## FEATURES

- Good Sensitivity
- Excellent A-M Rejection
- Low Harmonic Distortion
- Single-Adjustment Tuning
- High Gain to 50 MHz
- 500 mV Recovered Audio at 10.7 MHz
- Wide Operating Voltage Range
- Direct Replacement for ULN-2113A, MC1357, SN76643
- 14-Pin Dual In-Line Plastic Package

PROVIDING a multistage wideband amplifier/ limiter, an F-M quadrature detector, and an emitter-follower audio output stage, the Type ULN-2111A is designed for use in F-M receivers or in the sound I-F of TV receivers.

The Type ULN-2111A amplifier/limiter and quadrature detector is a Sprague-originated design. This circuit was the original monolithic integrated circuit F-M detector and was the first integrated circuit to be used in entertainment electronics. Its outstanding feature is that only a single low-cost tuned circuit is required instead of the previous triple-winding transformer.


## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{c c}$
Package Power Dissipation, $P_{0}$. . . . . . . . . . . . . . . . 670 mW*
Operating Temperature Range, $T_{A} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
${ }^{*}$ Derate at the rate of $8.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{A}=+70^{\circ} \mathrm{C}$.


STATIC ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=+12 \mathrm{~V}$

\begin{tabular}{|c|c|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{Characteristic} \& \multirow[b]{2}{*}{Symbol} \& \multirow[t]{2}{*}{$$
\begin{gathered}
\text { Test } \\
\text { Pin }
\end{gathered}
$$} \& \multirow[b]{2}{*}{Test Conditions} \& \multicolumn{4}{|c|}{Limits} <br>
\hline \& \& \& \& Min. \& Typ. \& Max. \& Units <br>
\hline Supply Current \& $\mathrm{l}_{\mathrm{cc}}$ \& 13 \& \& 12 \& 17 \& 27 \& mA <br>
\hline Terminal Voltage \& $$
\begin{aligned}
& V_{1} \\
& V_{2} \\
& V_{6} \\
& V_{9} \\
& V_{10}
\end{aligned}
$$ \& $$
\begin{array}{r}
1 \\
2 \\
6 \\
9 \\
10 \\
\hline
\end{array}
$$ \& \& 4.3 \& $$
\begin{gathered}
\hline 5.7 \\
3.65 \\
1.45 \\
150 \\
1.45 \\
\hline
\end{gathered}
$$ \& 7.2 \& $$
\begin{gathered}
\mathrm{V} \\
\mathrm{~V} \\
\mathrm{~V} \\
\mathrm{mV} \\
\mathrm{~V}
\end{gathered}
$$ <br>
\hline Resistance, Detector Output
1-Clnput
I-F Output

Detector

De-Emphasis \& $$
\begin{aligned}
& \mathbf{R}_{1} \\
& R_{4} \\
& R_{10} \\
& R_{12} \\
& R_{14}
\end{aligned}
$$ \& \[

$$
\begin{array}{r}
1 \\
4 \\
10 \\
12 \\
14 \\
\hline
\end{array}
$$

\] \& \& 6.0 \& \[

$$
\begin{aligned}
& \hline 200 \\
& 5.0 \\
& 60 \\
& 70 \\
& 9.0
\end{aligned}
$$

\] \& 12 \& \[

$$
\begin{aligned}
& \Omega \\
& \mathrm{k} \Omega \\
& \Omega \\
& \mathrm{k} \Omega \\
& \mathrm{k} \Omega
\end{aligned}
$$
\] <br>

\hline Capacitance, 1 I-F Input

Detector Input \& $$
\begin{aligned}
& C_{4} \\
& C_{12}
\end{aligned}
$$ \& \[

$$
\begin{array}{r}
4 \\
12 \\
\hline
\end{array}
$$

\] \& \& 二 \& \[

$$
\begin{array}{r}
11 \\
2.7 \\
\hline
\end{array}
$$

\] \& - \& \[

$$
\begin{aligned}
& \mathrm{pF} \\
& \mathrm{pF}
\end{aligned}
$$
\] <br>

\hline
\end{tabular}

DYNAMIC ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=+12 \mathrm{~V}, \mathrm{f}_{0}=10.7 \mathrm{MHz}$, $f_{m}=400 \mathrm{~Hz}, \Delta f= \pm 75 \mathrm{kHz}$, Peak Separation $=550 \mathrm{kHz}$

| Characteristic | Symbol | Test <br> Pin | Test <br> Figure | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |  |
| Amplifier Voltage Gain | $\mathrm{A}_{\text {e }}$ | 10 | 1 | $\mathrm{V}_{\text {in }} \leq 300 \mu \mathrm{~V}_{\text {rms }}$ | - | 53 | - | dB |  |
| Amplifier Output Voltage | $V_{\text {out }}$ | 10 | 1 | $V_{\text {in }}=10 \mathrm{mV}$ ms | - | 1.45 | - | $V_{\text {p }}$ |  |
| Input Limiting Threshold | $V_{\text {th }}$ | 4 | 2 |  | - | 400 | 800 | $\mu \mathrm{V}_{\text {rms }}$ | 1,3 |
| Recovered Audio Output | $V_{\text {out }}$ | 1 | 2 | $\mathrm{V}_{12}=60 \mathrm{mV}$ ms | - | 500 | - | mV ms | 3 |
| Output Distortion | THD | 1 | 2 | 100\% F-M Modulation | - | 1.0 | - | \% | 3 |
| A-M Rejection | AMR | 1 | 3 | $V_{\text {in }}=10 \mathrm{mV}$ ms | - | 40 | - | dB | 2 |

NOTES:

1. The input limiting threshold is the F-M input voltage for a recovered audio output which is 3 dB less than the recovered audio output for an F-M input voltage of $200 \mathrm{mV}_{\mathrm{mm}}$.
2. The amplitude modulation rejection is determined by: $\mathrm{AMR}_{\text {db }}=20 \log \frac{V_{\text {out }} \text { for } 100 \% \mathrm{~F}-\mathrm{M} V_{\text {in }}}{V_{\text {out }}}$ for $30 \% A-M V_{\text {in }}$
3. See also, General Design Note No. 9 .

COMPONENT CHART

|  | Component Value |  |
| :---: | :---: | :---: |
|  | TV (4.5 MHz) | F-M (10.7 MHz) |
| L-Inductance | $7.0-14 \mu \mathrm{H}$ | $1.5-3.0 \mu \mathrm{H}$ |
| Unloaded Q | 50 | 50 |
| D-C Resistance | $<50 \Omega$ | $<50 \Omega$ |
| Type | Miller \#9052 | Miller \#9050 |
| C $_{1}$ - Capacitance | 120 pF | 120 pF |
| TCC | NPO | NPO |
| C $_{2}$-Capacitance | 3.0 pF | 4.7 pF |
| R-Resistance | $20 \mathrm{k} \Omega$ | $3.9 \mathrm{k} \Omega$ |
| Loaded Network Q | 30 | 20 |



TEST FIGURE 1


## TEST FIGURE 2



TEST FIGURE 3

## TYPICAL APPLICATION



TRANSFER CHARACTERISTICS


LINEAR DETECTION MODE ( $v_{12} \leq 60 \mathrm{mv} \mathrm{v}_{\mathrm{rms}}$ )
SWITCHING DETECTION MODE $\left(V_{12} \approx 600 \mathrm{mV}_{\mathrm{rms}}\right)$ — — - - -

## GENERAL DESIGN NOTES

1. Phase shift network is aligned by applying F-M signal through decoupling network to pin $4\left(\mathrm{~V}_{4}=5 \mathrm{mV}_{\mathrm{rms}}\right)$. Tune for maximum recovered audio at pin 1 or maximum I-F voltage at pin 11.
2. A d-c path of less than $100 \Omega$ must be provided between pins 2 and 12 . No other biasing provisions are required.
3. A d-c path of less than $300 \Omega$ must be provided between pins 4 and 6. No other biasing provisions are required.
4. The maximum a-c load current can be increased by adding an external resistor between pin 1 and ground. The minimum value for this resistor is $800 \Omega$, giving a maximum load current of $4 \mathrm{~mA}_{\mathrm{rms}}$.
5. All decoupling capacitors should be of the ceramic type with minimum inductance at the operating frequency.
6. Decoupling capacitor leads at pins 2,5 , and 6 should be as short as possible.
7. Keep appropriate distance between the input (pin 4 and the input network) and the phase shift network (pins 9,10 , and 12 , and the phase shift inductor).
8. If a high impedance power supply is used (voltage dropping resistor), decouple pin 13 for the lowest audio frequency.
9. The linear detection mode (low signal level at pin 12), as shown, is preferred for communications and other commercial applications, due
to the preservation of the tuned circuit bandwidth and better rejection of Gaussian noise. The combination of coupling capacitor $\left(\mathrm{C}_{2}\right)$ and I-F amplifier output (pin 9) was chosen for optimum quieting. The bandwidth of the phase shift network (peak separation) is primarily defined by the Damping resistor ( R ). A higher value resistor will decrease bandwidth, increase the recovered audio output, reduce the capture ratio, and increase harmonic distortion.
10. The switching detection mode (high signal level at pin 12) features a greater linear range, increased insensitivity to amplitude variations, and is recommended for AFC applications or where side responses must be avoided. Limiting in the quadrature detector will produce slightly more audio output, but will increase the noise bandwidth and degrade quieting.


## ULN-2204A A-M/F-M RADIO SYSTEM

## FEATURES

- Low Harmonic Distortion
- Wide Operating Voltage Range
- Low Power Drain
- D-C A-M/F-M Switching
- $30 \mu \mathrm{~V}$ Limiting Threshold
- Excellent A-M Rejection
- Interchangeable With HA12402, TA7613, TDA1083, U417B


Type ULN-2204A will work with a wide range of supply voltages, and is suitable for use in a-c powered table radios and in battery-powered ( 6 or 9 V ) portable radios.

This system will operate at supply voltages as low as 2 V at reduced volume without significant increase in distortion. Brown-outs or weak batteries need no longer be a major concern.

Type ULN-2204A is housed in a 16-pin dual in-line plastic package with a copper lead frame that eliminates many decoupling problems and allows maximum power dissipation.

## ABSOLUTE MAXIMUM RATINGS

[^38]
## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$,

$V_{C C}=6.0 \mathrm{~V}, \mathbf{R}_{8}=\infty, \mathbf{R}_{16}=1.2 \mathrm{k} \Omega$ (unless otherwise noted)

| Characteristic | Limits |  |  |  |  |
| :--- | :---: | :--- | :--- | :--- | :--- |
|  |  | Test Conditions | Min. | Typ. | Max. |

F.M MODE: $f_{0}=10.7 \mathrm{MHz}, f_{m}=400 \mathrm{~Hz}, f_{d}= \pm 75 \mathrm{kHz}$, Peak Separation $=550 \mathrm{kHz}$

| Input Limiting Threshold | $V_{\text {th }}$ |  | - | 30 | 60 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detector Recovered Audio | $V_{0}$ |  | - | 250 | - | mV |
| Detector Output Distortion | THD ${ }_{\text {d }}$ | $\mathrm{V}_{\text {in }}=10 \mathrm{mV}$ rms | - | 1.0 | - | \% |
| A-M Rejection | AMR | $\begin{aligned} & V_{\text {in }}=10 \mathrm{mV} V_{\text {rms }} \quad 30 \% \mathrm{~A}-\mathrm{M}, \\ & \mathrm{f}_{\mathrm{a}-\mathrm{m}}=400 \mathrm{~Hz} \end{aligned}$ | 35 | 50 | - | dB |
| I-F Input Impedance | $z_{2}$ |  | - | 40 | - | k $\Omega$ |
| I-F Input Capacitance | $\mathrm{C}_{2}$ |  | - | 4.0 | - | pF |
| Quiescent Terminal Voltage | $\mathrm{V}_{1}$ |  | - | 2.1 | - | V |
|  | $\mathrm{V}_{8}$ |  | - | 1.7 | - | V |
| Quiescent Supply Current | ICC | $V_{C C}=6.0 \mathrm{~V}$ | - | 14 | 20 | mA |
|  |  | $V_{C C}=9.0 \mathrm{~V}$ | - | 18 | - | mA |

A-M MODE: $f_{0}=1 \mathrm{MHz}, f_{i f}=455 \mathrm{kHz}, f_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}$

| Sensitivity |  | $\mathrm{V}_{\text {out(8) }}=20 \mathrm{mV}_{\text {rms }}$ | - | 5.0 | 10 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detector Recovered Audio | $\mathrm{V}_{0}$ |  | - | 150 | - | mV |
| Overload Distortion |  | 80\% A-M, also see "ULN-2204A Variations" | - | 10 | - | mV |
| Usable Sensitivity |  | $20 \mathrm{~dB} \mathrm{~S}+\mathrm{N} / \mathrm{N}$ | - | 25 | 35 | $\mu \mathrm{V}$ |
| Mixer Input Impedance | $z_{6}$ | See Note | - | 4.5 | - | $\mathrm{k} \Omega$ |
| Mixer Input Capacitance | $\mathrm{C}_{6}$ |  | - | 5.5 | - | pF |
| Mixer Output Impedance | $2_{4}$ |  | - | 25 | - | $\mathrm{k} \Omega$ |
| Mixer Output Capacitance | $\mathrm{C}_{4}$ |  | - | 3.0 | - | pF |
| I-F Input Impedance | $\mathrm{Z}_{2}$ |  | - | 100 | - | k $\Omega$ |
| 1-F Input Capacitance | $\mathrm{C}_{2}$ |  | - | 3.0 | - | pF |
| Quiescent Terminal Voltage | $V_{1}$ |  | - | 1.3 | - | V |
|  | $V_{8}$ |  | - | 1.7 | - | V |
| Quiescent Supply Current | ${ }^{\text {c }}$ C | $V_{\text {CC }}=6.0 \mathrm{~V}$ | - | 10 | - | mA |
|  |  | $V_{C C}=9.0 \mathrm{~V}$ | - | 13 | - | mA | AUDIO AMPLIFIER: $f_{0}=400 \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=8 \Omega$


| Audio Gain | $\mathrm{A}_{\mathrm{e}}$ |  | 36 | 40 | 44 | dB |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Power | $P_{0}$ | $\mathrm{V}_{\text {CC }}=3.0 \mathrm{~V}, 10 \%$ THD | - | 50 | - | mW |
|  |  | $\mathrm{V}_{\text {CC }}=6.0 \mathrm{~V}, 10 \%$ THD | 250 | 350 | - | mW |
|  |  | $\mathrm{V}_{\text {CC }}=9.0 \mathrm{~V}, 10 \%$ THD | 500 | 650 | - | mW |
| Output Distortion | THD | $\mathrm{P}_{0}=50 \mathrm{~mW}$ | - | 2.0 | - | \% |
| A-F Input Impedance | $z_{9}$ |  | - | 250 | - | k $\Omega$ |
| Quiescent Terminal Voltage | $\mathrm{V}_{10}$ |  | - | 1.1 | - | V |
|  | $\mathrm{V}_{12}$ |  | - | 2.6 | - | V |

NOTE: For optimum noise match, source impedance should be $2.5 \mathrm{k} \Omega$

## TEST CIRCUIT


*See "ULN-2204A Variations"

## COIL WINDING IMFORMATION



| T1 A-M First I-F | $\mathrm{Qu}=120$ | General Instrument | Toko Part No. |
| :---: | :--- | :--- | :--- |
| 455 kHz | $\mathrm{NL}: \mathrm{N} 2: \mathrm{N} 3=15.5: 2.8: 1$ | Part No. EX 27835 | RMC-2A7641A |
|  | $\mathrm{Ct}=180 \mathrm{pF}$ |  |  |
| T2 A-M Second I-F | $\mathrm{Qu}=70$ | General Instrument | Toko Part No. |
| 455 kHz | $\mathrm{Nl}: \mathrm{N} 2=2: 1$ | Part No. EX 27836 | RLE-4A7642GO |
|  | $\mathrm{Ct}=430 \mathrm{pF}$ |  |  |
| T3 F-M Detector | $\mathrm{Qu}=50$ | General Instrument | Toko Part No. |
| 10.7 MHz | $\mathrm{Ct}=100 \mathrm{pF}$ | Part No. EX 27640 | BKAC-K3651HM |
| T4 F-M Detector | $\mathrm{Qu}=50$ | General Instrument | Toko Part No. |
| 10.7 MHz | $\mathrm{Ct}=100 \mathrm{pF}$ | Part No. EX 27640 | BKAC-K3651HM |
| L1 A-M Oscillator | $\mathrm{Qu}=50$ | General Instrument | Toko Part No. |
| 1455 kHz | $\mathrm{Nl}: \mathrm{N} 3=10.7: 1$ | Part No. EX 27641 | RWO-6A7640BM |
|  | $\mathrm{Ct}=39 \mathrm{pF}$ |  |  |

FUNCTIONAL BLOCK DIAGRAM


PIN 16 OUTPUT VOLTAGE, $\mathbf{V}_{16}$

| A-M <br> Operation | Complete Part Number Including Suffix |  |  |
| :---: | :---: | :---: | :---: |
|  | F-M Operation |  |  |
|  | $2.20-2.65 \mathrm{~V}$ | $2.55-3.05 \mathrm{~V}$ | $2.95-3.40 \mathrm{~V}$ |
| $1.40-1.75 \mathrm{~V}$ | ULN-2204A-11 | ULN-2204A-21 | ULN-2204A-31 |
| $1.65-2.00 \mathrm{~V}$ | ULN-2204A-12 | ULN-2204A-22 | ULN-2204A-32 |
| $1.90-2.25 \mathrm{~V}$ | ULN-2204A-13 | ULN-2204A-23 | ULN-2204A-33 |

TYPICAL QUIESCENT SUPPLY CURRENT


OVG. No. A-10.325A

TYPICAL AUDIO POWER OUTPUT

\$w. no. A-10. 327

## ULN-2204A VARIATIONS FOR OPTIMAL SYSTEM PERFORMANCE

The receiver system's performance can be kept within tighter performance limits by matching bias groupings and appropriate external resistors ( $\mathrm{R}_{8}$ and $\mathrm{R}_{16}$ ). With proper matching of parts and lots, consistent device performance can be obtained. Bias groups for Type ULN2204A are shown in the table below. There are three selections for each mode of operation and nine possible combinations.

Sprague Electric Company recommends that customers do not specify particular selections except in unusual circumstances. All parts manufactured with Sprague part numbers are branded with appropriate part-number suffixes. Any shipment to a customer will consist of parts from a single selection (single suffix).

The first digit of the suffix (the " 3 '" in ULN-2204A-31) refers to F-M performance. It indicates F-M gain and pin 16 output voltage as functions of the pin 16 load resistance. (See graph on next page.)

F-M circuit stability is inversely related to gain or sensitivity and is affected by source and load impedances, decoupling, and printed wiring board layout. After an optimal F-M I-F gain is determined for a particular circuit design, that gain can be attained by matching the partnumber suffix and the pin 16 load.

In addition, some system designs derive the F-M tuner supply, tuner bias, or AFC voltage from pin 16 output of Type ULN-2204A. For example, if the tuner design requires 2.4 V at 2.0 mA (an equivalent $\mathrm{R}_{16}$ of 12008), the graph below indicates a Type ULN-2204A-1X is required. A -2 X or -3 X device could also be used by paralleling the equivalent $1200 \Omega$ tuner load with a fixed resistance for an $830 \Omega$ load or a $520 \Omega$ load, respectively. For AFC applications, note that as frequency increases, $\mathrm{V}_{16}$ voltage decreases. The amount of change is a factor of load impedance, detector coil characteristics, and part grouping.

In A-M operation, stability is seldom a problem. However, large-signal overload can be optimized (to typically 30 mV ) by matching the particular part group with an appropriate load resistor at pin 8. The A-M grouping of a device is identified by the second digit of the partnumber suffix (the " 1 "' in ULN-2204A-31).

For - $\mathrm{X1}, \mathrm{R}_{8}$ should be $\infty$.
For - $\mathrm{X} 2, \mathrm{R}_{8}$ should be $47 \mathrm{k} \Omega$.
For - $\mathrm{X} 3, \mathrm{R}_{8}$ should be $33 \mathrm{k} \Omega$.
Additional loading may raise the overload point slightly, but AGC and sensitivity will be compromised. For any fixed value of $\mathrm{R}_{8},-\mathrm{X} 3$ parts will exhibit slightly higher A-M gain, while -X1 parts will have slightly lower A-M gain.

## TYPICAL F-M I-F GAIN CHARACTERISTIC



## TYPICAL APPLICATION

An A-M/F-M radio using the ULN-2204A receiver system, designed for a usable F-M sensitivity of about $4 \mu \mathrm{~V}$ and an A-M sensitivity of $350 \mu \mathrm{~V} / \mathrm{m}$, appears on the next page.

The two-stage F-M tuner is operated at about 4 V . Reducing the pin 16 voltage to 1.8 V (by changing $\mathrm{R}_{16}$ ) reduces interstation noise and the F-M I-F gain. An inductor at pin 12 (L6) prevents the wide-band audio amplifier from
radiating $\mathrm{R}-\mathrm{F}$ noise in the $\mathrm{A}-\mathrm{M}$ spectrum.
The tuning indicator below may be added to the radio circuit to provide an LED indication when the received signal strength exceeds $7 \mu \mathrm{~V}$ in the F-M mode or $700 \mu \mathrm{~V} / \mathrm{m}$ in the A-M mode. The tuning indicator circuit reduces the I-F gain by about 2 dB . The sensitivity may be adjusted by changing the value of C 1 or C 2 .


## COIL AND TRANSFORMER INFORMATION

 FOR TYPICAL APPLICATION| L1 | F-M Antenna Coil | $4^{1 / 2}$ turns, \#20 AWG $(0.8 \mathrm{~mm}), 0.216^{\prime \prime}(5.5 \mathrm{~mm}) 0$ |
| :--- | :--- | :--- |
| L2 | F-M R-F Coil | $3^{1 / 2}$ turns, \#20 AWG $(0.8 \mathrm{~mm}), 0.177^{\prime \prime}(4.5 \mathrm{~mm}) 0$ |
| L3 | F-M I-F Trap | $16^{1 / 2}$ turns, \#24 AWG $(0.5 \mathrm{~mm}), 0.177^{\prime \prime}(4.5 \mathrm{~mm}) 0$ |
| L4 | F-M Oscillator Coil | $2^{1 / 2}$ turns, \#20 AWG $(0.8 \mathrm{~mm}), 0.177^{\prime \prime}(4.5 \mathrm{~mm}) 0$ |
| L5 | F-M Detector Coil | $15 \mu \mathrm{H}, \mathrm{Qu}=120 @ 2.52 \mathrm{MHz}$ |
| L6 | Audio Choke | $10 \mu \mathrm{H}, \mathrm{Qu}=2 @ 2.52 \mathrm{MHz} ;$ |
|  |  | 3 turns through ferrite bead |
| L7 | A-M Antenna Coil | Qu $=250,110: 10$ turns ratio, |
|  |  | Q2B core, $3.5^{\prime \prime}(90 \mathrm{~mm}) \times 0.394^{\prime \prime}(10 \mathrm{~mm}) 0$ |
| T1 | F-M I-F Transformer | $82 \mathrm{pF}, \mathrm{Qu}=90 @ 10.7 \mathrm{MHz}, 11: 3$ turns ratio |
| T2 | F-M I-F Transformer | $390 \mathrm{pF}, \mathrm{Qu}=75 @ 10.7 \mathrm{MHz}, 5: 2$ turns ratio |
| T3 | A-M Detector Coil | $390 \mathrm{pF}, \mathrm{Qu}=130 @ 455 \mathrm{kHz}, 100$ turns center-tapped |
| T4 | F-M Detector Coil | $150 \mathrm{pF}, \mathrm{Qu}=90 @ 10.7 \mathrm{MHz}$ |
| T5 | A-M Oscillator | $460 \mu \mathrm{MH}, \mathrm{Qu}=120 @ 796 \mathrm{kHz}, 110: 11$ turns ratio |
| T6 | A-M I-F Transformer | $180 \mathrm{pF}, \mathrm{Qu}=145 @ 455 \mathrm{kHz}, 155: 10$ turns ratio; |
|  |  | primary tapped at 127 turns |


＊Required only for $V_{c c} \geq 9 \mathrm{~V}$ ．
＊＊I－F gain－dependent：See＂ULN－2204A Variations＂．

## ULN-2240A A-M/F-M SIGNAL PROCESSOR

## FEATURES

- $12 \mu \mathrm{~V}$ Limiting Threshold
- Tuning-Error and Signal-Level Muting
- Zero-Tune Meter Drive
- Balanced A-M Mixer
- $5 \mu \mathrm{~V}$ A-M Sensitivity
- D-C Mode Switching
- Internal Voltage Regulator
- Meets Dolby ${ }^{\circledR}$ Noise Requirements
- 20-Pin Dual In-Line Plastic Package

PREMIUM PERFORMANCE features such as delayed AGC for the R-F stage, an AFC drive circuit, interstation (signal level) muting, and offchannel (tuning error) muting, are offered by Type ULN-2240A.

[^39]

The signal processor combines F-M I-F receiver functions and all $\mathrm{A}-\mathrm{M}$ radio functions in a single monolithic integrated circuit. The system's audio output stage uses low-noise biasing that meets Dolby ${ }^{\circledR}$ receiver noise requirements.


FUNCTIONAL BLOCK DIAGRAM

The A-M mixer is a balanced low-current analog multiplier with very low local oscillator feedthrough, high I-F rejection and freedom from spurious responses. It can be used in the long, medium, and shortwave bands.

A balanced four-stage differential I-F amplifier is used in both A-M and F-M modes. It gives maximum gain without common-mode interference and noise. The delayed AGC output (pin 15) can be used for a discrete R-F stage or for stereo switching logic.

In the F-M mode of operation, the detector is a high-level, four-quadrant analog multiplier. In the A-M mode, the detector is operated as a balanced peak detector.

The low-level audio output is common to both operating modes and can be used to drive an audio
power amplifier (ULN-3701Z) or stereo decoder (ULN-3810A).

A-M gain is controlled with AVC to the I-F and delayed AVC to the mixer. Switching between modes is done with a single-pole d-c switch.

Type ULN-2240A signal processor excels in signal-seeking or scanning applications. False triggers on adjacent channels or strong mistuned signals are eliminated since off-tune mute voltage changes are more pronounced than the usual signal-level voltage changes. In standard F-M radio applications, tuning-error muting eliminates the low-frequency "thump" and noise-tail associated with tuning through a strong signal.
Internal voltage regulators assure consistent performance with wide variations in supply voltage (8.5 to 16 V ) and temperature.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ | 18 V |
| :---: | :---: |
| Mute Input Voltage, $\mathrm{V}_{8}$ | 5.0 V |
| Regulator Current, $\mathrm{I}_{\text {REG }}$ | 5.0 mA |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ (see note) | 750 mW |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\text {S }}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

Note: $P_{D}$ is derated at the rate of $9.4 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.

TYPICAL A-M/F-M STEREO RECEIVER FOR AUTOMOTIVE APPLICATIONS


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {Cc }}=12.8 \mathrm{~V}$

| Characteristic | Symbol | Test Pin | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range | $\mathrm{V}_{\text {cc }}$ | 10 |  | 8.5 | 12.8 | 16 | V |
| Audio Output Voltage | $V_{6}$ | 6 | No Signal | - | 5.8 | - | V |
| Regulator Output Voltage | $V_{\text {REG }}$ | 13 | No Signal | - | 6.4 | - | V |
| Avail. Reg. Output Current | $\mathrm{I}_{\text {ReG }}$ | 13 |  | 2.0 | - | - | mA |

F-M MODE: $\mathrm{f}_{0}=10.7 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 75 \mathrm{kHz}, \mathrm{V}_{\text {in }}=10 \mathrm{mVrms}$, Non-Muted (unless otherwise specified)

| Input Limiting Threshold | $\mathrm{V}_{\text {TH }}$ | 2 |  | - | 12 | 25 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovered Audio | $V_{\text {out }}$ | 6 |  | 350 | 425 | 600 | mV |
| Output Distortion | THD | 6 |  | - | 0.3 | 0.7 | \% |
| Output Noise | $\mathrm{S}+\mathrm{N} / \mathrm{N}$ | 6 |  | 74 | 80 | - | dB |
| A-M Rejection | AMR | 6 | See Note | 40 | > 55 | - | dB |
| Mute | $\Delta \mathrm{V}_{\text {out }}$ | 6 | $\mathrm{V}_{\mathrm{in}}=100 \mu \mathrm{~V}$, max. mute | - | - | -1.0 | dB |
|  |  |  | $V_{\text {in }}=5.0 \mu V$, max. mute | -45 | - | - | dB |
| Mute Bandwidth | $\Delta \mathrm{f}_{\mathrm{w}}$ | 6 | Max. mute | - | 100 | - | kHz |
| I-F Input Voltage | $V_{2}$ | 2 | No Signal | - | 3.5 | - | V |
| Mute Output Voltage | $V_{14}$ | 14 | No Signal | 3.6 | 4.2 | - | V |
| AGC Output Voltage | $\mathrm{V}_{15}$ | 15 | No Signal | 4.2 | 4.8 | 5.5 | V |
|  |  |  | $V_{\text {in }}=10 \mathrm{mVrms}$ | - | - | 0.5 | V |
| Mute Output Current | $\mathrm{I}_{14}$ | 14 | No Signal | 0.5 | - | - | mA |
| Avail. AGC Output Current | $\mathrm{I}_{15}$ | 15 | No Signal | 1.0 | - | - | mA |
| Supply Current | $\mathrm{I}_{C}$ |  | No Signal | - | 26 | 40 | mA |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{if}}=455 \mathrm{kHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}, \mathrm{V}_{\text {in }}=1.0 \mathrm{mVrms}$ (unless otherwise specified)

| Sensitivity | $\mathrm{V}_{\text {in }}$ | 18 | $\mathrm{V}_{\text {out }}=50 \mathrm{mVrms}$ | - | 5.0 | 8.5 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Usable Sensitivity |  | 18 | $20 \mathrm{~dB} \mathrm{~S}+\mathrm{N} / \mathrm{N}$ | - | 6.0 | - | $\mu \mathrm{V}$ |
| Recovered Audio | $V_{\text {ovt }}$ | 6 | 80\% A-M | 250 | 325 | 600 | mV |
| Input Overload | $V_{\text {in }}$ | 18 | $80 \%$ A-M, THD $=10 \%$ | 25 | 50 | - | mV |
| A-M Decoupling Voltage | $V_{1}$ | 1 | No Signal | - | 1.0 | - | V |
| I-F Input Voltage | $V_{2}$ | 2 | No Signal | - | 3.7 | - | V |
| Mute Output Voltage | $V_{14}$ | 14 | No Signal | - | - | 0.5 | V |
| AGC Output Voltage | $V_{15}$ | 15 | No Signal | - | - | 0.5 | V |
| A-M Bias Voltage | $V_{17}$ | 17 | No Signal | 1.6 | 1.8 | 2.1 | V |
| Supply Current | $\mathrm{I}_{\text {cc }}$ |  | No Signal | - | 16 | 30 | mA |

Note:
Amplitude Modulation Rejection is specified as $20 \log \frac{V_{\text {out }}}{V_{\text {out }} \text { for } 100 \% \text { F-M V in }} 30 \% A-M V_{\text {in }} \quad$

## COIL WINDING INFORMATION

| T1 | A-M 1-F 455 kHz | $\begin{aligned} & \mathrm{Qu}=45 \\ & \mathrm{Ct}=1000 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27765 | Toko Part No. RXN-6A6909HM |
| :---: | :---: | :---: | :---: | :---: |
| T2 | F-M Detector 10.7 MHz | $\begin{aligned} & \mathrm{Qu}=60 \\ & \mathrm{Ct}=82 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27975 | Toko Part No. TKAC-17044Z |
| L1 | A-M Oscillator 1455 kHz | $\begin{aligned} & \mathrm{Qu}=50 \\ & \mathrm{~N} 1: \mathrm{N} 2=11: 1 \\ & \mathrm{Ct}=39 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27641 | Toko Part No. RWO-6A7640BM |
| L2 | F-M Detector 10.7 MHz | $\begin{aligned} & \mathrm{L}=18 \mu \mathrm{H} \\ & \mathrm{Qu}=55 \end{aligned}$ | Coilcraft Type V |  |

SMALL-SIGNAL A-C CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Pin | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| 1-F Input Capacitance | $\mathrm{C}_{2}$ | 2 |  | - | 6.0 | - | pF |
| 1-F Output Resistance | $\mathrm{R}_{12}$ | 12 |  | - | 250 | - | $\mathrm{k} \Omega$ |
| I-F Output Capacitance | $\mathrm{C}_{12}$ | 12 |  | - | 2.5 | - | pF |
| Audio Output Impedance | $\mathrm{Z}_{6}$ | 6 |  | - | 6.2 | - | $\mathrm{k} \Omega$ |

F-M MODE: $f_{0}=10.7 \mathrm{MHz}$

| I-F Input Resistance | $\mathrm{R}_{2}$ | 2 |  | - | 10 | - |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $2-12$ |  | 8.0 | - | $\mathrm{kh} \Omega$ |
| Detector Input Resistance | $\mathrm{R}_{11}$ | 11 |  | - | 100 | - |
| Detector Input Capacitance | $\mathrm{C}_{11}$ | 11 |  | -1.5 | - | pF |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{if}}=455 \mathrm{kHz}$

| A-M Input Resistance | $\mathrm{R}_{18}$ | 18 |  | - | 5.0 | - |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A-M Input Capacitance | $\mathrm{C}_{18}$ | 18 |  | $\mathrm{k} \Omega$ |  |  |
| Mixer Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $18-19$ |  | - | 15 | - |
| Mixer Output Resistance | $\mathrm{R}_{19}$ | 19 |  | pF |  |  |
| Mixer Output Capacitance | $\mathrm{C}_{19}$ | 19 |  | - | 500 | - |
| I-F Input Resistance | $\mathrm{R}_{2}$ | 2 |  | $\mathrm{k} \Omega 0^{*}$ |  |  |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $2-12$ |  | - | 15 | - |
| Detector Input Resistance | $\mathrm{R}_{11}$ | 11 |  | - | 160 | - |
| Detector Input Capacitance | $\mathrm{C}_{11}$ | 11 |  | kF |  |  |

*The International Electrotechnical Commission recommends the use of siemens ( $\$$ ) as the standard international unit of conductance, admittance and susceptance.

TEST CIRCUIT


DWG. NO. A-10,796


Filter Assembly:
Toko Part No. CFU455C-82BR


F-M CHARACTERISTICS
AS FUNCTIONS OF INPUT VOLTAGE


A-M CONTROL VOLTAGES AS FUNCTIONS OF INPUT VOLTAGE


F-M CONTROL VOLTAGES
AS FUNCTIONS OF INPUT VOLTAGE


F-M TUNING-ERROR DETECTOR RESPONSE


## ULN-2241A A-M/F-M SIGNAL PROCESSING SYSTEM

## FEATURES

- Low External Parts Count
- D-C A-M/F-M Switching
- $12 \mu \mathrm{~V}$ Limiting Threshold
- $5 \mu \mathrm{~V}$ A-M Sensitivity
- Low Harmonic Distortion
- Balanced A-M Mixer
- Internal Regulator
- 16-Pin Dual In-Line Plastic Package

THIS SIGNAL PROCESSING SYSTEM was designed with careful attention to the total system costs and performance requirements of modern automotive and high-quality home entertainment broadcast receivers. All F-M I-F functions and all A-M functions are provided by Sprague Type ULN-2241A with a minimal external parts count.


The use of an analog multiplier as a balanced low-current mixer results in freedom from spurious responses and gives the system high tweet rejection, low feedthrough (I-F rejection), and low noise, as well as very low local oscillator feedthrough.
(Continued on next page)


Although primarily intended for use in A-M broadcast reception, the A-M mixer is also suitable for use at long-wave or shortwave frequencies. Delayed AGC is available for use with an optional discrete R-F stage.

A fully-balanced, four stage differential I-F amplifier gives maximum gain with freedom from interference and noise. It is used in both the A-M and F-M modes of operation with approximately 82 dB gain in the F-M mode and controlled AGC gain of 26 dB in the A-M mode.

The detector in the F-M mode is a fourquadrant analog multiplier operating in the high-level injection mode. Again, interference and noise are rejected through the use of balanced current-mirror outputs.

The delayed AGC output provides a d-c voltage for control of signal level-related func-
tions. The detector is biased to a no-signal value of 4.7 V , that approaches 0 V with increasing signal input.

In the A-M mode of operation, the detector is configured as a balanced peak detector resulting in low audio distortion. A-M gain control is achieved with AVC applied to the I-F and with delayed AVC applied to the mixer.

Switching between modes can be accomplished with a simple single-pole d-c switch. The common low-level audio output can be used to drive any suitable audio power amplifier or stereo decoder (e.g. Sprague Types ULN-3701Z and ULN-3810A, respectively).

Internal voltage regulators and bias supplies assure premium performance despite variations in external supply voltage ( 8.5 to 16 V ) or temperature $\left(-20^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$. Separate ground leads minimize possible decoupling problems.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, Vcc | 18 V |
| :---: | :---: |
| Regulator Current, $I_{\text {REG }}$ | 5.0 mA |
| Package Power Dissipation, $P_{\text {D }}$ (see note) | 640 mW |
| Operating Temperature Range, $T_{A}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| $\overline{N O T E: ~} P_{0}$ is derated at the rate of $8.0 \mathrm{~mW} /{ }^{\circ} \mathrm{Ca}$ |  |

## TYPICAL APPLICATION

 (High-Performance Table Radio)

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=12.8 \mathrm{~V}$

| Characteristic | Symbol | $\begin{aligned} & \text { Test } \\ & \text { Pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range | $V_{c c}$ | 6 |  | 10 | 12.8 | 16 | V |
| Differential Audio Output | $V_{\text {out }}$ | 5 | See Note 1 | - | - | $\pm 3.0$ | dB |
| Audio Ouput Voltage | $V_{5}$ | 5 | No Signal | - | 5.8 | - | V |
| Avail. Reg. Output Voltage | $\mathrm{V}_{\text {REG }}$ | 9 | No Signal | - | 6.4 | - | V |
| Avail. Reg. Output Current | $\mathrm{I}_{\text {REG }}$ | 9 |  | 2.0 | - | - | mA |

F-M MODE: $f_{0}=10.7 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=\mathbf{4 0 0 ~ H z}, \mathrm{f}_{\mathrm{d}}= \pm \mathbf{7 5} \mathbf{k H z}, \mathrm{V}_{\mathrm{in}}=10 \mathrm{mV} \mathrm{V}_{\mathrm{rms}}$, Non-Muted (unless otherwise specified)

| Input Limiting Threshold | $V_{\text {TH }}$ | 1 |  | - | 12 | 25 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovered Audio | $\mathrm{V}_{\text {out }}$ | 5 |  | 350 | 425 | 600 | mV |
| Output Distortion | THD | 5 |  | - | 0.3 | 0.7 | \% |
| A-M Rejection | AMR | 5 | See Note 2 | 40 | $>55$ | - | dB |
| I-F Input Voltage | $\mathrm{V}_{1}$ | 1 | No Signal | - | 3.5 | - | V |
| AGC Output Voltage | $V_{10}$ | 10 | No Signal | 4.2 | 4.8 | 5.5 | V |
|  |  |  | $\mathrm{V}_{\mathrm{in}}=10 \mathrm{mV}$ rms | - | - | 0.5 | $V$ |
| Avail. AGC Output Current | $\mathrm{I}_{10}$ | 10 | No Signal | 1.0 | - | - | mA |
| Supply Current | $\mathrm{I}_{\text {c }}$ |  | No Signal | - | 23 | 35 | mA |

A-M MODE: $f_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{if}}=455 \mathrm{kHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A} \cdot \mathrm{M}, \mathrm{V}_{\mathrm{in}}=1.0 \mathrm{mV} \mathrm{V}_{\mathrm{ms}}$ (unless otherwise specified)

| Sensitivity | $V_{\text {in }}$ | 13 | $\mathrm{V}_{\text {out }}=50 \mathrm{mV}$ rms | - | 5.0 | 8.5 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Useable Sensitivity |  | 13 | $20 \mathrm{~dB} \mathrm{~S}+\mathrm{N} / \mathrm{N}$ | - | 6.0 | - | $\mu \mathrm{V}$ |
| Recovered Audio | $V_{\text {out }}$ | 5 | 80\% A-M | 250 | 325 | 550 | mV |
| Input Overload | $V_{\text {in }}$ | 13 | 80\% A-M, THD $=10 \%$ | 25 | 50 | - | mV |
| A-M Decoupling Voltage | $V_{16}$ | 16 | No Signal | - | 1.0 | - | V |
| I-F Input Voltage | $V_{1}$ | 1 | No Signal | - | 3.7 | - | V |
| AGC Outpu ${ }^{+}$Voltage | $V_{10}$ | 10 | No Signal | - | - | 0.5 | V |
| A-M Input Voltage | $V_{12}$ | 12 | No Signal | 1.6 | 1.8 | 2.1 | V |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ |  | No Signal | - | 16 | 30 | mA |

Notes: 1. Differential Audio Output is specified as $20 \log \frac{V_{\text {out }} \text { for } 10 \mathrm{mV} \mathrm{F-M} \mathrm{~V}}{\mathrm{~V}_{\text {in }}}$
2. Amplitude Modulation Rejection is specified as $20 \log \frac{V_{\text {out }} \text { for } 100 \% \text { F-M } V_{\text {in }}}{V_{\text {out }} \text { for } 30 \% A-M V_{\text {in }}}$

## COIL WINDING INFORMATION

| $\begin{array}{r} \text { Tl A-M I-F } \\ 455 \mathrm{kHz} \end{array}$ | $\begin{aligned} & \mathrm{Qu}=45 \\ & \mathrm{Ct}=1000 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27765 | Toko Part No. RXN-6A6909HM |
| :---: | :---: | :---: | :---: |
| $\begin{gathered} \text { T2 F-M Detector } \\ 10.7 \mathrm{MHz} \end{gathered}$ | $\begin{aligned} & \mathrm{Qu}=60 \\ & \mathrm{Ct}=82 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27975 | Toko Part No. TKAC-170442 |
| L1 A-M Oscillator 1455 kHz | $\begin{aligned} & \mathrm{Qu}=50 \\ & \mathrm{~N} 1: \mathrm{N} 2=11: 1 \\ & \mathrm{Ct}=39 \mathrm{pF} \\ & \hline \end{aligned}$ | General Instrument Part No. EX 27641 | Toko Part No. RW0-6A7640BM |
| L2 F-M Detector 10.7 MHz | $\begin{aligned} & \mathrm{L}=27 \mu \mathrm{H} \\ & \mathrm{Qu}=55 \text { @ } 2.5 \mathrm{mHz} \end{aligned}$ | General Instrument Part No. EX 27764 | Toko Part No. 154AO-7A6115HM |

SMALL-SIGNAL A.C CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

|  |  | Test | Limits |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristic | Symbol | Pin |  | Min. |  |  |
| I-F Input Capacitance | $\mathrm{C}_{1}$ | 1 |  | - | 6.0 | - |
| I-F Output Resistance | $\mathrm{R}_{8}$ | 8 |  | PF |  |  |
| I-F Output Capacitance | $\mathrm{C}_{8}$ | 8 |  | 250 | - | $\mathrm{k} \Omega$ |
| Audio Output Impedance | $\mathrm{Z}_{5}$ | 5 |  | - | 2.5 | - |

F-M MODE: $\mathrm{f}_{0}=10.7 \mathrm{MHz}$

| I-F Input Resistance | $\mathrm{R}_{1}$ | 1 |  | - | 10 | - |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $1-8$ |  | - | 8.0 | - |
| Detector Input Resistance | $\mathrm{R}_{7}$ | 7 |  | - | 100 | - |
| Detector Input Capacitance | $\mathrm{C}_{7}$ | 7 |  | $\mathrm{k} \Omega$ |  |  |

A-M MODE: $f_{0}=1 \mathrm{MHz}, f_{H}=455 \mathrm{kHz}$

| A-M Input Resistance | $\mathrm{R}_{13}$ | 13 |  | - | 5.0 | - | $\mathrm{k} \Omega$ |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A-M Input Capacitance | $\mathrm{C}_{13}$ | 13 |  | - | 20 | - | pF |
| Mixer Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $13-14$ |  | - | 15 | - | $\mathrm{mmho}^{*}$ |
| Mixer Output Resistance | $\mathrm{R}_{14}$ | 14 |  | - | 500 | - | $\mathrm{k} \Omega$ |
| Mixer Output Capacitance | $\mathrm{C}_{14}$ | 14 |  | - | 5.0 | - | pF |
| I-F Input Resistance | $\mathrm{R}_{1}$ | 1 |  | - | 15 | - | $\mathrm{k} \Omega$ |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $1-8$ |  | - | 160 | - | mmho |
| Detector Input Resistance | $\mathrm{R}_{7}$ | 7 |  | - | 250 | - | $\mathrm{k} \Omega$ |
| Detector Input Capacitance | $\mathrm{C}_{7}$ | 7 |  | - | 1.0 | - | pF |

*The International Electrotechnical Commission recommends the use of siennens ( $S$ ) as the standard international unit of conductance, admittance and susceptance.

TEST CIRCUIT


UNG. No. A-10.718

Filter Assembly:
Toko Part No. CFU455C-82BR


## F-M CHARACTERISTICS

AS FUNCTIONS OF INPUT VOLTAGE


A-M CHARACTERISTICS AS FUNCTIONS OF INPUT VOLTAGE


AGC OUTPUT VOLTAGE
AS A FUNCTION OF INPUT VOLTAGE


AVC VOLTAGE
AS A FUNCTION OF INPUT VOLTAGE


# ULN-2242A/TDA 1090 A-M/F-M SIGNAL PROCESSING SYSTEM 

## FEATURES

- Low External Parts Count
- D-C A-M/F-M Switching
- $12 \mu \mathrm{~V}$ Limiting Threshold
- $5 \mu \mathrm{~V}$ A-M Sensitivity
- Low Harmonic Distortion
- Balanced A-M Mixer
- Meter Drive
- Internal Regulator
- Self-Contained Muting (Squelch)

SUBSTANTIAL SIMPLIFICATION of A-M/F-M receiver design is possible with Type ULN-2242A signal processing system with improved system performance and a minimal external parts count. All F-M I-F functions and all A-M functions are provided by this monolithic integrated circuit.


The use of an analog multiplier as a balanced low-current mixer results in freedom from spurious responses, high tweet rejection, low feedthrough (I-F rejection), and low noise, as well as very low local oscillator radiation.


Although primarily intended for use in A-M broadcast reception, the A-M mixer is also suitable for use at long-wave or short-wave frequencies. Delayed AGC is available for use with an optional, discrete R-F stage.

A fully-balanced, four-stage differential I-F amplifier gives maximum gain with freedom from common-mode signals. It is used in both the A-M and F-M modes of operation with approximately 82 dB gain in the F-M mode and controlled AGC gain of 26 to 82 dB in the $A-M$ mode.

The detector in the F-M mode is a four-quadrant analog multiplier operating in the high-level injection mode. Interference and noise are rejected. AFC and meter-drive signals (pin 7) are generated for use with any reference voltage between $\mathrm{V}_{\mathrm{CC}}$ and ground, with AFC gain determined by the choice of load resistor.

The mute and delayed AGC outputs provide d-c voltages for control of signal-level-related functions. Both detectors are biased to a no-signal value of
4.7 V and approach zero with increasing signal input.

In the A-M mode of operation, the detector is configured as a balanced peak detector for low audio distortion. A-M gain control is achieved with AVC applied to the I-F and delayed AVC applied to the mixer.

Switching between modes can be accomplished with a simple single-pole d-c switch. The common low-level audio output can be used to drive any suitable audio power amplifier or stereo decoder (Sprague Type ULN-3703Z and ULN-3810A, respectively).

Internal voltage regulators and bias supplies assure premium performance despite variations in external supply voltage ( 8.5 to 16 V ) or temperature $\left(-20^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$. Separate ground leads minimize possible decoupling problems.

Type ULN-2242A A-M/F-M signal processing system is housed in a 20 -pin dual in-line plastic package. Parts are marked with the Sprague Electric part number (ULN-2242A) unless the Pro-Electron marking (TDA1090) is requested.

## ABSOLUTE MAXIMUM RATINGS

$$
\begin{aligned}
& \text { Supply Voltage, } V_{\text {cc }} \text {. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 18 \text { V } \\
& \text { Note: } P_{D} \text { is derated at the rate of } 9.4 \mathrm{~mW} /{ }^{\circ} \mathrm{C} \text { above } \mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C} \text {. }
\end{aligned}
$$

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {CC }}=12.8 \mathrm{~V}$

| Characteristic | Symbol | Test <br> Pin | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range | $\mathrm{V}_{\text {cc }}$ | 10 |  | 8.5 | 12.8 | 16 | V |
| Audio Output Voltage | $V_{6}$ | 6 | No Signal | - | 5.8 | - | V |
| Regulator Output Voltage | $V_{\text {REG }}$ | 13 | No Signal | - | 6.4 | - | V |
| Regulator Output Current | $\mathrm{I}_{\text {REG }}$ | 13 |  | 2.0 | - | - | mA |

F-M MODE: $\mathrm{f}_{0}=10.7 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 75 \mathrm{kHz}, \mathrm{V}_{\mathrm{in}}=10 \mathrm{mVrms}$, Non-Muted (unless otherwise specified)

| Input Limiting Threshold | $V_{\text {TH }}$ | 2 |  | - | 12 | 25 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovered Audio | $V_{\text {out }}$ | 6 |  | 350 | 425 | 600 | mV |
| Output Distortion | THD | 6 |  | - | 0.3 | 0.7 | \% |
| A-M Rejection | AMR | 6 | See Note | 40 | $>55$ | - | dB |
| Mute | $\Delta \mathrm{V}_{\text {out }}$ | 6 | $V_{\text {in }}=100 \mu V$, max. mute | - | - | $-1.0$ | dB |
|  |  |  | $V_{\text {in }}=5 \mu \mathrm{~V}$, max. mute | -45 | - | - | dB |
| AFC Output Voltage | $\mathrm{V}_{\text {atc }}$ | 7 |  | 220 | - | 600 | mV |
| I-F Input Voltage | $V_{2}$ | 2 | No Signal | - | 3.5 | - | V |
| Mute Output Voltage | $V_{14}$ | 14 | No Signal | 3.6 | 4.2 | - | V |
| AGC Output Voltage | $V_{15}$ | 15 | No Signal | 4.2 | 4.8 | 5.5 | V |
|  |  |  | $\mathrm{V}_{\text {in }}=10 \mathrm{mVrms}$ | - | - | 0.5 | $V$ |
| Mute Output Current | $\mathrm{I}_{14}$ | 14 | No Signal | 0.5 | - | - | mA |
| AGC Output Current | $\mathrm{I}_{15}$ | 15 | No Signal | 1.0 | - | - | mA |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ |  | No Signal | - | 23 | 35 | mA |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{ff}}=455 \mathrm{kHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}, \mathrm{V}_{\mathrm{in}}=1.0 \mathrm{mVrms}$ (unless otherwise specified)

| Sensitivity | $V_{\text {in }}$ | 18 | $V_{\text {out }}=50 \mathrm{mVrms}$ | - | 5.0 | 8.5 |
| :--- | :--- | ---: | :--- | :---: | :---: | :---: |
| Usable Sensitivity |  | 18 | 20 dB S $+\mathrm{N} / \mathrm{N}$ | $\mu \mathrm{V}$ |  |  |
| Recovered Audio | $\mathrm{V}_{\text {out }}$ | 6 | $80 \% \mathrm{~A}-\mathrm{M}$ | 6.0 | - | $\mu \mathrm{V}$ |
| Input Overload | $\mathrm{V}_{\text {in }}$ | 18 | $80 \%$ A-M, THD $=10 \%$ | 250 | 325 | 600 |
| A-M Decoupling Voltage | $\mathrm{V}_{1}$ | 1 | No Signal | mV |  |  |
| I-F Input Voltage | $\mathrm{V}_{2}$ | 2 | No Signal | 50 | - | mV |
| Mute Output Voltage | $\mathrm{V}_{14}$ | 14 | No Signal | - | 1.0 | - |
| AGC Output Voltage | $\mathrm{V}_{15}$ | 15 | No Signal | V |  |  |
| A-M Input Voltage | $\mathrm{V}_{17}$ | 17 | No Signal | - | - | 0.5 |
| Supply Current | $\mathrm{I}_{\text {cc }}$ |  | No Signal | V |  |  |

Note:
Amplitude Modulation Rejection is specified as $20 \log _{V_{\text {out }}} V_{\text {out }} V_{\text {out }}$ for $100 \%$ F-M V in

SMALL-SIGNAL A-C CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | $\begin{aligned} & \text { Test } \\ & \text { Pe } \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| T-F Input Capacitance | $\mathrm{C}_{2}$ | 2 |  | - | 6.0 | - | pF |
| I-F Output Resistance | $\mathrm{R}_{12}$ | 12 |  | - | 250 | - | k $\Omega$ |
| I-F Output Capacitance | $\mathrm{C}_{12}$ | 12 |  | - | 2.5 | - | pF |
| Audio Output Impedance | $\mathrm{Z}_{6}$ | 6 |  | - | 860 | - | $\Omega$ |

$$
\text { F-M MODE: } \mathrm{f}_{0}=10.7 \mathrm{MHz}
$$

| I-F Input Resistance, | $\mathrm{R}_{2}$ | 2 |  | - | 10 | - |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $2-12$ |  | - | 18 | - |
| Detector Input Resistance | $\mathrm{R}_{11}$ | 11 |  | - | 100 | - |
| Detector Input Capacitance | $\mathrm{C}_{11}$ | 11 |  | - | 1.5 | - |

A-M MODE: $f_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{it}}=455 \mathrm{kHz}$

| A-M Input Resistance | $\mathrm{R}_{18}$ | 18 |  | - | 5.0 | - |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| A-M Input Capacitance | $\mathrm{C}_{18}$ | 18 |  | - | 20 | - |
| Mixer Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $18-19$ |  | pF |  |  |
| Mixer Output Resistance | $\mathrm{R}_{19}$ | 19 |  | - | 500 | - |
| Mixer Output Capacitance | $\mathrm{C}_{19}$ | 19 |  | $\mathrm{mmh} 0^{*}$ |  |  |
| I-F Input Resistance | $\mathrm{R}_{2}$ | 2 |  | - | $\mathrm{k} \Omega$ |  |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $2-12$ |  | - | 15 | - |
| Detector Input Resistance | $\mathrm{R}_{11}$ | 11 |  | $\mathrm{pF} \Omega$ |  |  |
| Detector Input Capacitance | $\mathrm{C}_{11}$ | 11 |  | - | 300 | - |

*The International Electrotechnical Commission recommends the use of siemens $(\mathrm{S})$ as the standard international unit of conductance, admittance and susceptance.

## TEST CIRCUIT



COIL WINDING INFORMATION


| T1 | A-M I-F | Qu $=45$ | General Instrument | Toko Part No. |
| :--- | :--- | :--- | :--- | :--- |
|  | 455 kHz | $\mathrm{Ct}=1000 \mathrm{pF}$ | Part No. EX 27765 | RXN-6A6909HM |
| T2 | F-M Detector | $\mathrm{Qu}=60$ | General Instrument | Toko Part No. |
|  | 10.7 MHz | $\mathrm{Ct}=82 \mathrm{pF}$ | Part No. EX 27975 | TKAC-17044Z |
| L1 | A-M Oscillator | $\mathrm{Qu}=50$ | General Instrument | Toko Part No. |
|  | 1455 kHz | $\mathrm{N1:N2}=11: 1$ | Part No. EX 27641 | RW0-6A7640BM |
|  | $\mathrm{Ct}=39 \mathrm{pF}$ |  |  |  |
| L2 | F-M Detector | $\mathrm{L}=18 \mu \mathrm{H}$ |  | Coilcraft |
|  | 10.7 MHz | $\mathrm{Qu}=55$ |  | Type V |

Filter Assembly:
Toko Part No. CFU455C-82BR


## A-M CHARACTERISTICS <br> AS FUNCTIONS OF INPUT VOLTAGE



F-M CHARACTERISTICS
AS FUNCTIONS OF INPUT VOLTAGE


## A-M CONTROL VOLTAGES AS FUNCTIONS OF INPUT VOLTAGE



F-M CONTROL VOLTAGES
AS FUNCTIONS OF INPUT VOLTAGE


## ULN-2243A <br> MIXER/I-F FOR F-M RADIO APPLICATIONS

## FEATURES

- Doubly-Balanced Linear Mixer
- Very-High I-F Rejection
- 32 mmho (millisiemens) Conversion Gain at 100 MHz
- $330 \Omega$ I-F Input/Output Impedance
- 46 dB I-F Gain at 10.7 MHz
- AGC Detector for MOSFET R-F Stage
- Low External Component Count
- 16-Pin Dual In-Line Plastic Package


PROVIDING AN IMPORTANT basic building block for use in F-M radio applications, the ULN2243A mixer/I-F minimizes spurious responses from strong off-channel signals while providing an excellent noise figure, maximum desired signal gain and very-high I-F rejection.
The linear fully-balanced mixer is an analog multiplier which will outperform discrete mixers. The low local oscillator and received frequency feedthrough greatly reduces the outband rejection requirements.

I-F gain is furnished by a 2-stage amplifier with the
gain set at typically 46 dB . Input and output impedances are $330 \Omega$ to allow the use of inexpensive ceramic filter coupling.

Both bias and AGC voltages, for use with a dualgate MOSFET R-F stage, are provided by the wideband AGC detector. An inhibit connection (pin 14) allows for maximum wide-band R-F gain up to the signal level at which the AGC action of the following narrow-band I-F amplifier/limiter and detector (ULN-3840A or ULN-3889A) starts operating. For strong on-channel signal levels, the wide-band R-F gain is determined by the strongest in-band signal.


FUNCTIONAL BLOCK DIAGRAM

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Fig. | $\begin{aligned} & \text { Test } \\ & \text { Pin } \\ & \hline \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. | Units |
| Quiescent Supply Current | Icc |  | $5+6$ | $\mathrm{V}_{\mathrm{cc}}=+12 \mathrm{~V}$ | 5.0 | - | 11 | mA |
|  |  |  | $12+15$ | $\mathrm{V}_{\text {c }}=+8 \mathrm{~V}$ | 18 | - | 38 | mA |
| MIXER: $\mathrm{f}_{\text {in }}=100 \mathrm{MHz}, \mathrm{V}_{\text {osc }}=200 \mathrm{mV}, \mathrm{f}_{\text {osc }}=110.7 \mathrm{MHz}, \mathrm{f}_{\text {out }}=10.7 \mathrm{MHz}$ |  |  |  |  |  |  |  |  |
| Input Impedance | $Z_{\text {in }}$ | 1 | 9 or 10 | $\mathrm{V}_{\mathrm{in}}=25 \mathrm{mV}$ | - | 525 | - | $\Omega$ |
| Input Capacitance | $\mathrm{C}_{\text {in }}$ | 1 | 9 or 10 | $V_{\text {in }}=25 \mathrm{mV}$ | - | 9.0 | - | pF |
| Osc. Impedance | $Z_{\text {osc }}$ | 1 | 7 or 8 | $\mathrm{V}_{\text {in }}=0$ | - | 170 | - | $\Omega$ |
| Osc. Capacitance | $\mathrm{C}_{\text {osc }}$ | 1 | 7 or 8 | $\mathrm{V}_{\text {in }}=0$ | - | 10 | - | pF |
| Output Impedance | $\mathrm{Z}_{\text {out }}$ | 2 | 5 or 6 | $V_{\text {in }}=0$ | - | 120 | - | $\mathrm{k} \Omega$ |
| Output Capacitance | $\mathrm{C}_{\text {out }}$ | 2 | 5 or 6 | $V_{\text {in }}=0$ | - | 3.2 | - | pF |
| Conversion Gain | $\mathrm{g}_{\mathrm{m}}$ | 3 |  | $V_{\text {in }}=1.0 \mathrm{mV}$ | - | 32 | - | mmho |
| I-F AMPLIFIER: $\mathbf{V}_{\text {in }}=100 \mu \mathrm{~V}, \mathrm{f}_{\text {in }}=10.7 \mathrm{MHz}$ |  |  |  |  |  |  |  |  |
| Input Resistance | $\mathrm{R}_{\text {iN }}$ |  | 1 |  | - | 330 | - | $\Omega$ |
| Output Resistance | $\mathrm{R}_{\text {out }}$ |  | 16 |  | - | 280 | - | $\Omega$ |
| I-F Gain | $\mathrm{A}_{\mathrm{e}}$ |  | 16 |  | - | 46 | - | dB |
| AGC DETECTOR: $\mathrm{f}_{\text {in }}=10.7 \mathrm{MHz}, \mathrm{V}_{\text {in }}=$ Pin $4, \mathrm{~V}_{\text {In }}=$ Pin 14 |  |  |  |  |  |  |  |  |
| Detector Threshold | $V_{\text {in }}$ |  | 4 | $\mathrm{V}_{\mathrm{N}}=3.5 \mathrm{~V}$ | - | 150 | - | mV |
| Inhibit Threshold | $V_{\text {IN }}$ |  | 14 | $\mathrm{V}_{\text {in }}=350 \mathrm{mV}, \mathrm{V}_{\text {OUT }}=2.0 \mathrm{~V}$ | 0.8 | - | 2.0 | V |
| Quiescent Output Voltage | $V_{\text {out }}$ |  | 13 | $V_{\text {in }}=0$ and/or $V_{\text {IV }}=0$ | - | 7.7 | - | V |
| Output Voltage | $V_{\text {out }}$ |  | 13 | $\mathrm{V}_{\text {in }}=350 \mathrm{mV}, \mathrm{V}_{\text {iN }}=3.5 \mathrm{~V}$ | - | 0.7 | - | V |



Figure 1


Figure 2


Figure 3

## APPLICATION INFORMATION

The ULN-2243A mixer/I-F performs a variety of functions especially suitable for automobile radios and other receivers required to handle an extremely wide range of input signal levels. It has been designed to use some of the inherent advantages of an integrated circuit to improve F-M front end designs instead of simply attempting to replace discrete devices with integrated ones. This allows the tuner designer to select an R-F amplifier and oscillator circuit best-suited to the particular application.

The double-balanced mixer is internally biased so that all inputs can be capacitively coupled. This mixer possesses several advantages over discrete devices:

1. High inherent I-F rejection,
2. Good I-F/2 rejection,
3. Less oscillator drive required than with FET mixers,
4. Low oscillator feed through,
5. Less oscillator modulation with large signals, and
6. Balanced inputs eliminate ground loops which can cause stray coupling paths in discrete mixers.
Note that the oscillator input can be to either pin 7 or pin 8 , the R-F input to either pin 9 or pin 10 , to suit the circuit board layout.

The I-F transformer used with the ULN-2243A has been made to utilize both outputs of the mixer and was wound on a bobbin type coil form (Toko Type 10EZ) to maintain close couplings between windings. This eliminates the high cost of a bifilarwound transformer. A conventional tuner with two R-F tuned circuits will typically have an I-F/2 rejection of at least 100 dB and a low noise figure. A sin-gle-ended output from either pin 5 or 6 could have been used (with degradation in rejection and noise figure) with the remaining output connected directly to $\mathrm{V}_{\mathrm{Cc}}$.

The limiting amplifier has about 46 dB of gain at 10.7 MHz. The input and output impedances are $330 \Omega$ for easy ceramic filter connection. The differential input again avoids the low-impedance ground loops associated with discrete common emitter I-F input stages. This makes the construction of a stable amplifier much easier. Since the I-F amplifier is an independent element, various combinations of filters before and after the amplifier are possible.

The relatively high gain of the ULN-2243A I-F amplifier allows the circuit designer to use surface
wave or cascaded ceramic filters between it and the amplifier/detector integrated circuit. The resistive matching pad between ceramic filter elements prevents interactions which can cause undesirable group delay variations.

The AGC detector between pins 4, 13, and 14 has some unique properties which can be used in different ways. If the R-F amplifier is a dual-gate MOSFET (Figure 4), only the minimum in external discrete components is required.

The AGC detector input (pin 4) is connected through a small coupling capacitor to the mixer output. Internally is an R-F peak detector and d-c amplifier. If the AGC inhibit voltage (pin 14) is greater than approximately 1 volt, the AGC output voltage (pin 13) will change from typically 7.7 V with no applied signal to 0.5 V if an R-F signal of more than 150 mV is present at the input. This allows the tuner designer several design possibilities:

1. Connecting the AGC inhibit to the meter drive output of the limiter/detector (pin 15, ULN3840A), the R-F stage will be AGC'd when tuned to a strong signal or when tuned to a weak signal with a strong adjacent channel signal, or
2. Pin 14 can be connected to a fixed bias voltage (typically +5 V ). The R-F stage would then be AGC'd by any signal falling within the mixer coil bandpass, or
3. Combinations of fixed bias and signal-dependent levels (AFC, deviation mute, or delayed AGC) will then allow almost an unlimited number of AGC possibilities.

The AGC characteristics of the ULN-2243A mixer/I-F can be used with many other types of R-F amplifier. By adding a discrete transistor amplifier at pin 13, the AGC signal can be inverted and/or amplified to drive a bipolar R-F stage into forward AGC or to drive a PIN diode attenuator. A simplified graphical illustration of the most common AGC characteristic is shown in Figure 5.

A typical application of the ULN-2243A mixer/ I-F in an F-M tuner was shown in Figure 4. Note that an output from the high-frequency oscillator has been provided with no increase in cost. This is one advantage to having the oscillator external to the integrated circuit. Also, by not including the R-F amplifier within the device, a wide variety of R-F amplifiers can be used depending on the wishes of the designer or the particular constraints of the application.


Figure 4
TYPICAL APPLICATION


Dwg. No. A-11,039

Figure 5
AGC CHARACTERISTICS

# ULN-2249A A-M RADIO SYSTEM FOR AUTOMOTIVE APPLICATIONS 

## FEATURES

- Low External Parts Count
- Internal Bias Regulator
- High AGC Ratio
- Low Distortion
- Good Sensitivity
- Direct Replacement for HA1199

satisfactorily under wide variations in signal level. A typical AGC ratio of 63 dB , a usable sensitivity of
approximately $8 \mu \mathrm{~V}$, and an overload point in extypical AGC ratio of 63 dB , a usable sensitivity of
approximately $8 \mu \mathrm{~V}$, and an overload point in excess of 3 V , all contribute to the excellent performance of these devices under real conditions. Moreover, the ULN-2249A A-M radio system is rated for operation over the broad supply voltage range of 10.8 V to 15.6 V although the selfcontained local oscillator will continue to function at much lower voltages. -

SPECIFICALLY DESIGNED for automotive A-M radio applications, the ULN-2249A A-M radio system consists of an $\mathrm{R}-\mathrm{F}$ amplifier, converter, I-F amplifier, A-M detector, AGC amplifier, and bias voltage regulator. The low-level audio output can be used to drive a standard audio power amplifier, such as the Sprague Type ULN-3701Z.

Of particular significance in automotive applications is the ability of this integrated circuit to perform


## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 670 mW*


*Derate at the rate of $8.3 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=13.5 \mathrm{~V}, \mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{if}}=262.5 \mathrm{kHz}$, $\mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}$, Figure 2 (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Quiescent Supply Current | $\mathrm{I}_{\text {cc }}$ | Figure 1 | - | 15 | - | mA |
| Sensitivity | $V_{\text {in }}$ | $V_{\text {out }}=20 \mathrm{mV}$ | - | 3.0 | 6.0 | $\mu \mathrm{V}$ |
| Detector Output Voltage | $V_{8}$ | $V_{\text {in }}=5.0 \mathrm{mV}$ | 50 | - | - | mV |
| Output Distortion | THD | $V_{\text {in }}=500 \mathrm{mV}$ | - | 0.4 | 5.0 | \% |
| Signal-to-Noise Ratio | $\mathrm{S}+\mathrm{N} / \mathrm{N}$ | $V_{\text {in }}=50 \mu \mathrm{~V}$ | 26 | 30 | - | dB |
| AGC Ratio* |  | $V_{\text {in }}=20 \mathrm{mV}$ | 60 | 63 | - | dB |

*AGC Ratio is defined as the ratio of the input voltages for a reduction in output voltage of 10 dB with the high level input as specified.

SMALL-SIGNAL A-C CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{Cc}}=13.5 \mathrm{~V}, \mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{if}}=262.5 \mathrm{kHz}$, $\mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}, \mathrm{V}_{\text {in }} \leq 27 \mathrm{mVrms}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| R-F Input Impedance | $\mathrm{Z}_{1}$ | Also, see note | - | 6.0 | - | $\mathrm{k} \Omega$ |
| R-F Output Impedance | $\mathrm{Z}_{16}$ |  | - | 100 | - | $\mathrm{k} \Omega$ |
| R-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ |  | - | 16 | - | mmho |
| Conv. Input Impedance | $\mathrm{Z}_{14}$ |  | - | 12 | - | $\mathrm{k} \Omega$ |
| Osc. Input Impedance | $\mathrm{Z}_{13}$ | $\mathrm{f}_{\text {osc }}=1.262 \mathrm{MHz}$ | - | 3.6 | - | k $\Omega$ |
| Conv. Output Impedance | $\mathrm{Z}_{12}$ |  | - | 100 | - | $\mathrm{k} \Omega$ |
| Conv. Transconductance | $\mathrm{g}_{\mathrm{m}}$ | Pin 14-12, $\mathrm{V}_{13}=300 \mathrm{mVrms}$ | - | 0.2 | - | mmho |
|  |  | Pin 13-12, $\mathrm{V}_{13} \leqq 27 \mathrm{mV}$ rms | - | 1.4 | - | mmho |
| Osc. Input Voltage | $V_{13}$ | For optimum conv. performance | 300 | - | - | mVrms |
| I-F Input Impedance | $\mathrm{Z}_{10}$ |  | - | 2.8 | - | k $\Omega$ |
| I-F Output Impedance | $\mathrm{Z}_{5}$ |  | - | 50 | - | $\Omega$ |
| I-F Gain | Ae |  | - | 24 | - | dB |
| Det. Input Impedance | $\mathrm{Z}_{6}$ |  | - | 310 | - | $\Omega$ |
| Det. Output Impedance | $\mathrm{Z}_{8}$ |  | - | 100 | - | $\Omega$ |
| Det. Gain | Ae |  | - | 25 | - | dB |

NOTE: For optimum noise match, source impedance should be $1.2 \mathrm{k} \Omega$.

## TEST CIRCUITS



FIGURE 2

COIL WINDING INFORMATION


| T1 First I-F | $Q_{\mathrm{up}}=80, Q_{\mathrm{us}}=75$ | Toko Part No. |
| :---: | :--- | :--- |
| 262.5 kHz | Nt:No:Ns $=13: 2.2: 1$ | B124FCS-1013PYG/ |
|  | $\mathrm{Ct}=150 \mathrm{pF}$ | B124FCS-1014STB |
| T2 Second I-F | $\mathrm{Q}_{\mathrm{up}}=80, \mathrm{Q}_{\mathrm{us}}=75$ | Toko Part No. |
| 262.5 kHz | Nt:Np:Ns $=13: 5.6: 1$ | B124FCS-60001PYG/ |
|  | $\mathrm{Ct}=150 \mathrm{pF}$ | B124FCS-1014STB |

## RECOVERED AUDIO, NOISE, AND DISTORTION AS FUNCTIONS OF SIGNAL INPUT



OUTPUT VOLTAGE
AS A FUNCTION OF INTERFERENCE FREQUENCY


## ULN-3804A A-M/F-M SIGNAL PROCESSOR

## FEATURES

- Good Sensitivity
- Low Harmonic Distortion
- Wide Operating Voltage Range
- Excellent A-M Rejection
- Low Power Drain
- D-C A-M/F-M Switching
- $30 \mu \mathrm{~V}$ Limiting Threshold
- 16-Pin Dual In-Line Plastic Package

In the A-M mode of operation, Type ULN-3804A provides all high-frequency circuitry, including AGC and envelope peak detection, for a single-conversion superheterodyne broadcast or shortwave receiver. In the F-M mode, the signal processor operates as a high-gain amplifier/limiter and phaseshift detector. A d-c switch is used to change modes.
A single external capacitor at pin 16 provides the A-M AGC time constant, the F-M AFC time constant, and R-F decoupling.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 16 V |
| :---: | :---: |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | 640 mW* |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $T_{\mathrm{S}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

 can be revised for greater power output or for stereo operation (without reworking the printed wiring operation (without reworking the printed wiring
board layout) by replacement of Type ULN-2204A with Type ULN-3804A and addition of appropriate stereo decoders and audio power amplifiers.

DESIGNED for use in battery-powered portable radios or line-driven table radios. Type ULN3804A works well in low-cost applications requiring high performance with few external parts. An entire A-M/F-M stereo receiver can be built with a Type ULN-3804A, a Type ULN-3809A stereo decoder, and two Type ULN-2283B audio amplifiers, for operation over a supply range of 4.5 to 12 V .

The signal processor includes the A-M oscillator and mixer and the A-M/F-M I-F amplifier and detector from the popular radio system, Sprague Type ULN-2204A. Radio designs using Type ULN-2204A

FUNCTIONAL BLOCK DIAGRAM


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$
$V_{c c}=6.0 \mathrm{~V}, \mathrm{R}_{8}=\infty, \mathrm{R}_{16}=1.2 \mathrm{k} \Omega$ (unless otherwise noted)

|  |  | Limits |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Characteristic | Symbol | Test Conditions | Min. $\quad$ Typ. Max. | Units |

F-M MODE: $\mathrm{f}_{0}=10.7 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 75 \mathrm{kHz}$, Peak Separation $=550 \mathrm{kHz}$

| Input Limiting Threshold | $V_{\text {tr }}$ |  | - | 30 | 60 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detector Recovered Audio | $V_{0}$ |  | - | 250 | - | mV |
| Detector Output Distortion | THD | $\mathrm{V}_{\text {in }}=10 \mathrm{mV}$ ms | - | 1.0 | - | \% |
| A-M Rejection | AMR | $\begin{aligned} & \begin{array}{l} V_{\text {in }}=10 \mathrm{mV}_{\text {m }}, 30 \% \mathrm{~A}-\mathrm{M}, \\ \mathrm{f}_{\mathrm{am}}=400 \mathrm{~Hz} \end{array} \\ & \hline \end{aligned}$ | 35 | 50 | - | dB |
| I-F Input Impedance | $\mathrm{Z}_{2}$ |  | - | 40 | - | $\mathrm{k} \Omega$ |
| I-F Input Capacitance | $\mathrm{C}_{2}$ |  | - | 4.0 | - | pF |
| Quiescent Terminal Voltage | $V_{1}$ |  | - | 2.1 | - | V |
|  | $V_{8}$ |  | - | 1.7 | - | V |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{cc}}$ |  | - | 10 | 15 | mA |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{ff}}=455 \mathrm{kHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}$

| Sensitivity |  | Maximum Volume | - | 5.0 | 10 | $\mu \mathrm{~V}$ |
| :--- | :--- | :--- | :--- | :---: | :---: | :---: |
| Detector Recovered Audio | $\mathrm{V}_{0}$ |  | - | 150 | - | mV |
| Overload Distortion |  | $80 \% \mathrm{~A}-\mathrm{M}$ | - | 10 | - | mV |
| Usable Sensitivity |  |  | - | 25 | 35 | $\mathrm{\mu V}$ |
| Mixer Input Impedence | $\mathrm{I}_{6}$ | See Note | 4.5 | - | $\mathrm{k} \Omega$ |  |
| Mixer Input Capacitance | $\mathrm{C}_{6}$ |  | - | 5.5 | - | pF |
| Mixer Output Impedance | $\mathrm{Z}_{4}$ |  | - | 25 | - | $\mathrm{k} \Omega$ |
| Mixer Output Capacitance | $\mathrm{C}_{4}$ |  | - | 3.0 | - | pF |
| I-F Input Impedance | $\mathrm{Z}_{2}$ |  | - | 100 | - | $\mathrm{kJ} \Omega$ |
| I-F Input Capacitance | $\mathrm{C}_{2}$ |  | - | 3.0 | - | pF |
| Quiescent Terminal Voltage | $\mathrm{V}_{1}$ |  | - | 1.3 | - | V |
|  | $\mathrm{V}_{8}$ |  | - | 1.7 | - | V |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{Cc}}$ |  | - | 3.8 | - | mA |

NOTE: For optimum noise match, source impedance should be $2.5 \mathrm{k} \Omega$.

## TEST CIRCUIT



COIL WINDING INFORMATION


| $\begin{gathered} \text { T1 A-M First I-F } \\ 455 \mathrm{kHz} \end{gathered}$ | $\begin{aligned} & \mathrm{Qu}=120 \\ & \mathrm{~N} 1: \mathrm{N} 2: \mathrm{N} 3=15 \cdot 5: 2.8: 1 \\ & \mathrm{Ct}=180 \mathrm{pF} \end{aligned}$ | General Instrument Part №. EX 27835 | Toko Park No. RMC-2A7641A |
| :---: | :---: | :---: | :---: |
| $\begin{gathered} \text { T2 A-M Second I-F } \\ 455 \mathrm{kHz} \end{gathered}$ | $\begin{aligned} & \mathrm{Qu}=70 \\ & \mathrm{~N} 1: \mathrm{N} 2=2: 1 \\ & \mathrm{Ct}=430 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27836 | Toko Part No. RLE-4A7642G0 |
| T3 F-M Detector 10.7 MHz | $\begin{aligned} & \mathrm{Qu}=50 \\ & \mathrm{Ct}=100 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27640 | Toko Part No. BKAC-K3651HM |
| T4 F-M Detector 10.7 MHz | $\begin{aligned} & \mathrm{Qu}=50 \\ & \mathrm{Ct}=100 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27640 | Toko Part N o. BKAC-K3651HM |
| L1 A-M 0scillator 1455 kHz | $\begin{aligned} & \mathrm{Qu}=50 \\ & \mathrm{~N} 1: \mathrm{N} 3=10.7: 1 \\ & \mathrm{Ct}=39 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27641 | Toko Part No. RW0-6A7640BM |

# Device Classification and Design Considerations 

The A-M/F-M receiver system's operation can be kept within tighter performance limits by matching bias groupings and appropriate external resistors (R8 and R16). With proper matching of parts and lots, consistent device performance can be obtained. The groupings, shown in the table below, are based on A-M and F-M operation. There are three selections for each mode and nine possible combinations:

PIN 16 OUTPUT VOLTAGE, $V_{16}$

| A-M <br> Operation | Complete Part Number Including Suffix |  |  |
| :---: | :---: | :---: | :---: |
|  | $2.20-2.65 \mathrm{~V}$ | $2.55-3.05 \mathrm{~V}$ | $2.95-3.40 \mathrm{~V}$ |
|  | ULN-3804A-11 | ULN-3804A-21 | ULN-3804A-31 |
| $1.65-2.00 \mathrm{~V}$ | ULN-3804A-12 | ULN-3804A-22 | ULN-3804A-32 |
| $1.90-2.25 \mathrm{~V}$ | ULN-3804A-13 | ULN-3804A-23 | ULN-3804A-33 |

Sprague recommends that customers not specify particular selections except in unusual circumstances. All parts manufactured with the Sprague part number will be marked with the complete number, including the appropriate suffix. In addition, any one shipment to a customer will consist of a single selection (single suffix).
The first digit of the suffix (such as the " 3 "' in " -31 ") applies to F-M performance. It indicates the F-M gain and pin 16 output voltage as functions of the pin 16 load resistance, as shown in the graph on the next page.

F-M circuit stability is inversely related to gain or sensitivity and is also affected by source and loan impedances, decoupling, and printed wiring board layout. After an optimal F-M I-F gain is determined for a particular circuit design, the gain can be controlled with proper matching of the suffix and the pin 16 load.

## Design Considerations (Continued)

In addition, certain system designs derive the F-M tuner supply, tuner bias, or AFC voltage at pin 16 of Type ULN-3804A. As an example, if the tuner design requires 2.4 V at 2.0 mA (an equivalent R 16 of $1200 \Omega$ ), Type ULN-3804A-1X is required. $\mathrm{A}-2 \mathrm{X}$ or -3 X device can also be used by paralleling the equivalent $1200 \Omega$ tuner load with a fixed resistor to present an $830 \Omega$ load or a $520 \Omega$ load.

For AFC applications, note that as the frequency is increased, the $\mathrm{V}_{16}$ voltage will decrease. The amount of change is a function of load impedance, detector coil characteristics, and part grouping.

## TYPICAL F-M I-F GAIN CHARACTERISTICS



Stability is seldom a problem with A-M operation. However, largesignal overload can be held to typically 30 mV by matching the particular part group with an appropriate load resistor at pin 8. The A-M grouping is identified by the second digit of the part number suffix (such as the " 2 "' in " -32 ").

For $-\mathrm{X} 1, \mathrm{R} 8$ should be an open circuit;
for $-\mathrm{X} 2, \mathrm{R} 8$ should be $47 \mathrm{k} \Omega$;
for -X 3 , R8 should be $33 \mathrm{k} \Omega$.
Additional loading may raise the overload point slightly, but AGC and sensitivity will be compromised. For any fixed value of R8, the - X3 parts will exhibit slightly higher A-M gain, the - X1 parts slightly lower A-M gain.

## ULN-3809A PHASE-LOCKED LOOP STEREO DECODER

## FEATURES

- Unity Voltage Gain
- $I^{2} L$ and Ion Implant Technology
- Wide Dynamic Range
- Low Distortion
- Excellent Channel Separation
- No Tuning Coils
- Automatic Stereo/Mono Switching
- Stereo Indicator Lamp Driver
- Direct Replacement for MC1309
- 14-Pin Dual In-Line Plastic Package

SPRAGUE Type ULN-3809A phase-locked loop decoder demodulates standard composite F-M stereo input signals within the range of 0.25 to 1.7 Vpp without the use of tuning coils.

Integrated circuit design allows tuning with a single resistive adjustment. The decoder automatically switches between stereo and monaural operation by detection and evaluation of the $19-\mathrm{kHz}$ pilot carrier signal.


Type ULN-3809A exhibits 35 dB suppression of the $19-\mathrm{kHz}$ pilot and 45 dB rejection of the regenerated $38-\mathrm{kHz}$ subcarrier at demodulator output terminals. Stereo channel separation is typically 47 dB . With a composite input signal of 850 mV , total harmonic distortion for the unit is typically $0.06 \%$.

Type ULN-3809A is designed to work within a range of supply voltages from 4.5 to 16 V .


## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 16 V |
| :---: | :---: |
| Nominal Lamp Current, I Lanp | 50 mA |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | 670 mW* |
| Operating Temperature Range, $T_{A}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage, Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

*Derate at the rate of $8.3 \mathrm{~mW} / \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.

ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=9.0 \mathrm{~V}$,
$V_{\text {in }}=1.7 \mathrm{Vpp}, \mathrm{f}_{\mathrm{m}}=1.0 \mathrm{kHz}$ (L or R only), Pilot Level $=10 \%$ unless otherwise specified

| Characteristic | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Units |
| Max. Standard Composite Input Signal | $V_{c c}=6.0 \mathrm{~V}, 0.5 \%$ THD | 0.85 | 1.7 | - | Vpp |
|  | $\mathrm{V}_{\text {cc }}=9.0 \mathrm{~V}, 0.5 \%$ THD | 1.7 | 2.1 | - | Vpp |
| Max. Monaural Input Signal | $\mathrm{V}_{\text {cc }}=6.0 \mathrm{~V}, 1.0 \%$ THD | 0.85 | 1.7 | - | Vpp |
|  | $\mathrm{V}_{\text {cc }}=9.0 \mathrm{~V}, 1.0 \%$ THD | 1.7 | 2.2 | - | Vpp |
| Input Impedance |  | 15 | 30 | - | $\mathrm{k} \Omega$ |
| Stereo Channel Separation | $\mathrm{f}=100 \mathrm{~Hz}$ | - | 45 | - | dB |
|  | $\mathrm{f}=1.0 \mathrm{kHz}$ | 30 | 47 | - | dB |
|  | $\mathrm{f}=10 \mathrm{kHz}$ | - | 40 | - | dB |
| Monaural Gain |  | 0.6 | 0.9 | - | V/V |
| Channel Balance |  | - | 0 | 1.0 | dB |
| Total Harmonic Distortion | Stereo, $\mathrm{V}_{\text {in }}=850 \mathrm{mVpp}$ | - | 0.06 | - | \% |
|  | Mono, $\mathrm{V}_{\text {in }}=850 \mathrm{mVpp}$ | - | 0.08 | - | \% |
| Ultrasonic Frequency Rejection | 19 kHz | - | 35 | - | dB |
|  | 38 kHz | - | 45 | - | dB |
| SCA Rejection |  | - | 75 | - | dB |
| Stereo Switch Level | Lamp ON | - | 9.0 | 12 | mV |
|  | Lamp OFF | 2.0 | 4.5 | - | mV |
| Mono/Stereo Switch Transient | No Lamp | - | 0 | - | mV |
| Capture Range | Pilot $=60 \mathrm{mVrms}$ | - | 7.0 | - | \% |
| Supply Current |  | - | 11 | - | mA |

NOTE: THD and channel separation are measured after a bandpass filter ( 200 Hz to 10 kHz ).

## APPLICATIONS INFORMATION



TEST CIRCUIT AND TYPICAL APPLICATION

1. If relaxed performance is acceptable, the external circuit can be simplified by decreasing the value of $C_{1}$ (reduces separation at low frequencies), decreasing the values of $C_{4}$ and $R_{3}$ while eliminat-
ing $\mathrm{C}_{5}$, and decreasing the value of $\mathrm{C}_{6}$ while increasing the values of $R_{4}$ and $R_{5}$ (increases capture-range and beat-note distortion).
2. Typical I-F amplifier frequency response restricts channel separation to about 32 dB . This restriction can be counteracted by the network shown below. Exact circuit values will be determined by the I-F amplifier design.


DWG. No. A- 10.656
3. To manually disable the stereo decoder, ground pin 8 and connect pin 14 to ground through a resistance of $3.3 \mathrm{k} \Omega$.
4. Capacitor $\mathrm{C}_{6}$ should be temperature-stable (NPO).

MINIMUM-COST APPLICATION IN A-MF-M STEREO RADIO


## ULN-3810A

## PHASE-LOCKED LOOP STEREO DECODER

## FEATURES

- No Tuning Coils Required
- $I^{2} L$ and Ion Implant Technology
- Single-Adjustment Tuning
- Automatic Stereo/Mono Switching
- Stereo Indicator Lamp Driver
- Excellent SCA Rejection
- Direct Replacement for TA7157, KB4409, CA1310, XR1310, LM1310, SN76115, MC1310 \& ULN-2110A
- 14-Pin Dual In-Line Plastic Package



## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$.................................... 16 V
Nominal Lamp Current, $\mathrm{I}_{\text {Lamp }}$. . . . . . . . . . . . . . . . . . . 75 mA
Package Power Dissipation, $P_{D} \ldots . . . . . . . . . . . . . . . .670$ mW*
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage, Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . . .65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $8.3 \mathrm{~mW} / \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.


## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathbf{V}_{\mathrm{CC}}=+\mathbf{1 2 V}$, <br> $\mathrm{V}_{\text {in }}=\mathbf{5 6 0 m V r m s}\left(\mathbf{2 . 8} \mathrm{V}_{\text {pp }}\right), \mathrm{f}_{\mathrm{m}}=1.0 \mathrm{kHz}$ (L or R only), <br> Pilot Level $=\mathbf{1 0 0} \mathbf{m V r m s}(\mathbf{1 0 \%})$ unless otherwise specified

| Characteristic | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Units |
| Max. Standard Composite Input Signal | THD $=0.5 \%$ | 2.8 | - | - | $V_{p p}$ |
| Max. Monaural Input Signal | THD $=1.0 \%$ | 2.8 | - | - | $V_{\text {pp }}$ |
| Input Impedance | Pin 2 | 20 | 25 | - | k $\Omega$ |
| Stereo Channel Separation |  | 30 | 40 | - | dB |
| Audio Output Voltage | Desired Channel | - | 485 | - | mVrms |
| Monaural Channel Balance | Pilot Level $=0 \mathrm{~V}$ | - | - | 1.5 | dB |
| Total Harmonic Distortion |  | - | $<0.3$ | - | \% |
| Ultrasonic Freqency | 19 kHz | - | 34.4 | - | dB |
| Rejection | 38 kHz | - | 45 | - | dB |
| SCA Rejection | 67 kHz , No Modulation, Measure 9 kHz Beat | - | 75 | - | dB |
| Stereo Switch Level | Pilot Only, Lamp ON | - | 18 | 25 | mVrms |
|  | Pilot Only, Lamp OFF | 5.0 | 9.0 | - | mVrms |
| Capture Range | Permissible Tuning Error | - | 3.5 | - | \% |
| Supply Current | Lamp OFF | - | 12 | 22 | mA |

## APPLICATION INFORMATION



TEST CIRCUIT AND TYPICAL APPLICATION

1. If relaxed performance is acceptable, the external circuit can be simplified by decreasing the value of $\mathrm{C}_{1}$ (reduces separation at low frequencies), decreasing the values of $C_{4}$ and $R_{3}$ while eliminating $C_{5}$,
and decreasing the value of $\mathrm{C}_{6}$ while increasing the values of $R_{4}$ and $R_{5}$ (increases capture-range and beat-note distortion).
2. Typical I-F amplifier frequency response restricts channel separation to about 32 dB . This restriction can be counteracted by the network shown below. Exact circuit values will be determined by the I-F amplifier design.

3. To manually disable the stereo decoder, ground pin 8 and connect pin 14 to ground through a resistance of $3.3 \mathrm{k} \Omega$.
4. Capacitor $\mathrm{C}_{6}$ should be temperature stable (NPO).

## ULN-3812A PHASE-LOCKED LOOP STEREO DECODER

## FEATURES

- Internal Temperature Compensation
- Single-Adjustment Tuning
- Automatic Stereo/Mono Switching
- Stereo Indicator Lamp Driver
- 70 dB SCA Rejection
- Operating Voltage - 9 to 16 V
- Low Harmonic Distortion
- Replaces ULN-2245A, CA3145, ULN-2244A, $\mu$ A758, LM1800, and MC1311
- 16-Pin Dual In-Line Plastic Package

REQUIRING only a single, non-critical resistive tuning adjustment, the Type ULN-3812A integrated circuit derives left and right audio channels from the standard composite stereo signal. This phase-locked loop stereo decoder can also be used in a number of subscription TV decoder schemes or in various proposed TV stereo systems.

Using phase-lock techniques, the subcarrier (38 kHz for $\mathrm{F}-\mathrm{M}$ stereo) is regenerated in phase with and at exactly twice the frequency of the transmitted pilot signal. Switching between monaural and stereo op-

eration is accomplished automatically by the presence of the pilot signal.

Low-impedance emitter-follower outputs and an internal voltage regulator for increased stability make Type ULN-3812A suitable for both lineoperated and automotive applications. It is designed to operate over a wide supply-voltage range and will function with supplies as low as 9 V .

Type ULN-3812A is functionally and pin compatible with the Type ULN-2245A decoder and, except for a reduced audio-output impedance, is also interchangeable with Type ULN-2244A.


## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ (Continuous) $(<15 s) .$ | $\begin{aligned} & +16 \mathrm{~V} \\ & +22 \mathrm{~V} \end{aligned}$ |
| :---: | :---: |
| Lamp Supply Voltage, $\mathrm{V}_{\text {LAMP }}$ | +22 V |
| Lamp Current, $\mathrm{I}_{\text {Lamp }}$ | 150 mA |
| Output Current, $\mathrm{I}_{4}$ or $\mathrm{I}_{5}$ | 10 mA |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | 670 mW* |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\text {s }}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V}$, Composite Input $=300 \mathrm{mV} \mathrm{V}_{\mathrm{ms}}(\mathrm{L}=\mathrm{R}$, Pilot OFF), Pilot Level $=30 \mathrm{mV} \mathrm{r}_{\mathrm{ms}}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}$ or 1 kHz , unless otherwise specified.

| Characteristic | Test Conditions | Limits |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Units |  |
| Input Impedance | Pin 2 | 20 | 35 | - | k $\Omega$ |  |
| Output Impedance | Pin 4 or 5 | - | 50 | - | $\Omega$ |  |
| Audio Voltage Gain | Desired Channel | 0.7 | 1.0 | 1.4 | V/V |  |
| Stereo Channel Separation | $\mathrm{f}_{\mathrm{m}}=100 \mathrm{~Hz}$ | - | 30 | - | dB |  |
|  | $\mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}$ | 30 | 40 | - | dB | 3 |
|  | $\mathrm{f}_{\mathrm{m}}=10 \mathrm{kHz}$ | - | 30 | - | dB |  |
| Monaural Channel Balance | Pilot Level $=0 \mathrm{~V}$ | - | 0.1 | 1.5 | dB |  |
| Total Harmonic Distortion | Multiplex Level $=600 \mathrm{mV}$ | - | 0.4 | 1.5 | \% | 3 |
| Ultrasonic Frequency Rejection | 19 kHz | 25 | 35 | - | dB |  |
|  | 38 kHz | 25 | 40 | - | dB |  |
| SCA Rejection | 67 kHz | - | 70 | - | dB | 1 |
| Stereo Switch Level | Pilot Only, Lamp ON | - | 14 | 25 | mVrms |  |
|  | Pilot Only, Lamp OFF | 2.0 | 7.0 | - | mVrms |  |
| VCO Tuning Resistance | Pin 15 | 20 | 23 | 26 | $\mathrm{k} \Omega$ | 2 |
| VCO Frequency Drift | $-20^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+25^{\circ} \mathrm{C}$ | - | $\pm 0.5$ | $\pm 2.0$ | \% |  |
|  | $+25^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+70^{\circ} \mathrm{C}$ | - | $\pm 0.5$ | $\pm 2.0$ | \% |  |
| Stereo Lamp Hysteresis | Lamp OFF to Lamp ON | 3.0 | 6.0 | - | dB |  |
| Capture Range | Permissable Tuning Error | - | 4.0 | - | \% |  |
| Output Voltage Shift | Stereo to Mono Operation | - | $\pm 30$ | - | mV |  |
| Lamp Output Current | Short Circuit, Lamp ON | 50 | 100 | - | mA |  |
|  | Lamp OFF | - | 1.0 | 100 | $\mu \mathrm{A}$ |  |
| Lamp Driver Terminal Voltage | $1_{\text {LMMP }}=50 \mathrm{~mA}$ | - | 1.3 | 2.0 | V |  |
| Supply Current | Lamp OFF | - | 20 | 40 | mA |  |
| Power Supply Rejection | $200 \mathrm{~Hz}, 200 \mathrm{mVrms}$ | - | 40 | - | dB |  |

NOTES: 1. Measured with a stereo composite signal of $80 \%$ stereo, $10 \%$ pilot, and $10 \%$ SCA.
2. Total resistance from pin 15 to ground, to set reference frequency at pin 11 to $19 \mathrm{kHz} \pm 10 \mathrm{~Hz}$.
3. Measured with Toko 208BLR-3152N filter, or equivalent.

## APPLICATION INFORMATION



TEST CIRCUIT AND TYPICAL APPLICATION

1. If relaxed performance is acceptable, the external circuit can be simplified by decreasing the value of $\mathrm{C}_{1}$ (reduces separation at low frequencies), decreasing the values of $\mathrm{C}_{4}$ and $\mathrm{R}_{3}$ while eliminating $\mathrm{C}_{5}$, and decreasing the value of $\mathrm{C}_{6}$ while increasing the values of $\mathrm{R}_{4}$ and $\mathrm{R}_{5}$ (increases capture-range and beat-note distortion).
2. Typical I-F amplifier frequency response restricts channel separation to about 32 dB . This restric-
tion can be countered by the network shown below. Exact circuit values will be determined by the I-F amplifier design.
3. The network at pin 15 should be temperature stable (NP0).
4. To manually disable the stereo decoder, ground pin 9 and connect pin 15 to ground through a resistance of $3.3 \mathrm{k} \Omega$.


## ULN-3838A A-M RADIO SYSTEM

## FEATURES

-3, 6, or 9 V Operation

- Low Power Drain
- Low Harmonic Distortion
- 16-Pin Dual In-Line Plastic Package

OUTSTANDING for use in low-cost applications that require a minimum parts count and high performance, the Type ULN-3838A integrated circuit provides all standard A-M radio functions. It is a complete single-conversion superheterodyne broadcast or shortwave receiver with AGC and peak envelope detection.

Its ability to operate with a wide range of supply voltages makes the Type ULN-3838A receiver system suitable for use in battery-powered portable radios and in a-c table radios. This system will operate at supply voltages as low as 2 V at reduced volume without significant increase in distortion. Weak batteries need no longer be a major design concern.

A single external capacitor at pin 16 provides the AGC time constant and R-F decoupling. A single resistor at the same pin will adjust the A-M gain for optimum performance.

Class B operation of the audio power amplifier yields high efficiency at rated output power with very

low quiescent current drain. The amplifier exhibits little crossover distortion. Its output impedance is significantly less than one ohm, allowing it to be used with a wide variety of speaker and headphone impedances.

Type ULN-3838A A-M radio system is supplied in a 16 -pin dual in-line plastic package with a copper lead frame that eliminates many decoupling problems and gives the package an enhanced power dissipation rating.

## ABSOLUTE MAXIMUM RATINGS


Package Power Dissipation, $P_{D}$ (Note) . . . . . . . . . . . . . . . 1.0 W
Operating Temperature Range, $T_{A} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
NOTE: Derate at the rate of $15 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.


ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} \mathrm{C}$,
$V_{\text {cC }}=6.0 \mathrm{~V}, R_{8}=\infty$ (unless otherwise noted)

|  |  | Limits |  |  |
| :--- | :--- | :--- | :--- | :--- |
| Characteristic | Symbol | Test Conditions | Min. | Typ. Max. |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{it}}=455 \mathrm{kHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}$

| Sensitivity |  | $\mathrm{V}_{\text {OUI(8) }}=20 \mathrm{mV} \mathrm{V}_{\text {ms }}$ | - | 5.0 | 10 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detector Recovered Audio | $\mathrm{V}_{0}$ |  | - | 150 | - | mV |
| Overioad Distortion |  | 80\% A-M, also see "Optimizing System Performance" | - | 10 | - | mV |
| Usable Sensitivity |  | $20 \mathrm{dBS}+\mathrm{N} / \mathrm{N}$ | - | 18 | 30 | $\mu \mathrm{V}$ |
| Mixer Input Impedance | $z_{6}$ | See Note | - | 4.5 | - | $\mathrm{k} \Omega$ |
| Mixer Input Capacitance | $\mathrm{C}_{6}$ |  | - | 5.5 | - | pF |
| Mixer Output Impedance | $\mathrm{Z}_{4}$ |  | - | 25 | - | $\mathrm{k} \Omega$ |
| Mixer Output Capacitance | $\mathrm{C}_{4}$ |  | - | 3.0 | - | pF |
| I-F Input Impedance | $\mathrm{Z}_{2}$ |  | - | 100 | - | $\mathrm{k} \Omega$ |
| --F Input Capacitancs | $\mathrm{C}_{2}$ |  | - | 3.0 | - | pF |
| Quiescent Terminal Voltage | $\mathrm{V}_{1}$ |  | - | 1.3 | - | V |
|  | $\mathrm{V}_{8}$ |  | - | 1.7 | - | $V$ |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | $\mathrm{V}_{\text {cc }}=3.0 \mathrm{~V}$ | - | 8.0 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}$ | - | 10 | 17 | mA |
|  |  | $\mathrm{V}_{\mathrm{cc}}=9.0 \mathrm{~V}$ | - | 13 | - | mA |

AUDIO AMPLIFIER: $f_{0}=400 \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=8 \Omega$

| Audio Gain | $\mathrm{A}_{6}$ |  | 36 | 40 | 44 | dB |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Power | $\mathrm{P}_{0}$ | $\mathrm{V}_{\text {cc }}=3.0 \mathrm{~V}, 10 \%$ THD | - | 50 | - | mW |
|  |  | $\mathrm{V}_{\text {cc }}=6.0 \mathrm{~V}, 10 \%$ THD | 250 | 350 | - | mW |
|  |  | $\mathrm{V}_{\mathrm{cc}}=9.0 \mathrm{~V}, 10 \%$ THD | 500 | 650 | - | mW |
| Output Distortion | THD | $\mathrm{P}_{\mathrm{o}}=50 \mathrm{~mW}$ | - | 2.0 | - | \% |
| A-F Input Impedance | $Z_{9}$ |  | - | 250 | - | $\mathrm{k} \Omega$ |
| Quiescent Terminal Voltage | $\mathrm{V}_{10}$ |  | - | 1.1 | - | V |
|  | $\mathrm{V}_{12}$ |  | - | 2.6 | - | V |

NOTE: For optimum noise match, source impedance should be $2.5 \mathrm{k} \Omega$.

## Device Classification and Design Considerations

Type ULN-3838A integrated circuits are sorted into three groups defined by the pin 16 voltage in the following test circuit. Applications information for this grouping is given in the text entitled "Optimizing System Performance.,

| $\mathrm{V}_{16}$ | Complete Part Number |
| :---: | :---: |
| $1.40-1.75 \mathrm{~V}$ | ULN-3838A-1 |
| $1.65-2.00 \mathrm{~V}$ | ULN-3838A-2 |
| $1.90-2.25 \mathrm{~V}$ | ULN-3838A-3 |

## TEST CIRCUIT


*See "Optimizing System Performance."

## COIL WINDING INFORMATION



| T1 A-M First I-F | Qu $=120$ | General Instrument | Toko Part No. |
| :---: | :--- | :--- | :--- |
| 455 kHz | $\mathrm{N1:N2:N3=15.5:2.8:1}$ | Part No. EX 27835 | RMC-2A7641A |
|  | $\mathrm{Ct}=180 \mathrm{pF}$ |  |  |
| T2 A-M Second I-F | $\mathrm{Qu}=70$ | General Instrument | Toko Part No. |
| 455 kHz | $\mathrm{N}: \mathrm{N} 2=2: 1$ | Part No. EX 27836 | RLE-4A7642GO |
|  | $\mathrm{Ct}=430 \mathrm{pF}$ |  |  |
| L1 A-M Oscillator | $\mathrm{Qu}=50$ |  |  |
| 1455 kHz | $\mathrm{Nl}: \mathrm{N} 3=10.7: 1$ | Ceneral Instrument | Toko Part No. |
|  | $\mathrm{Ct}=39 \mathrm{pF}$ |  |  |
|  |  |  |  |

## OPTIMIZING SYSTEM PERFORMANCE

Type ULN-3838A receiver system's performance can be kept within tighter limits by matching the bias group with an appropriate external resistor (R8). With proper matching, consistent device performance between parts and lots can be obtained. The bias groups, shown in the table are based on A-M operation; three selections are possible.

| $\mathrm{V}_{16}$ | Complete Part Number |
| :---: | :---: |
| $1.40-1.75 \mathrm{~V}$ | ULN-3838A-1 |
| $1.65-2.00 \mathrm{~V}$ | ULN-3838A-2 |
| $1.90-2.25 \mathrm{~V}$ | ULN-3838A-3 |

Sprague recommends that customers not specify particular selections except in unusual circumstances. All parts manufactured with Sprague part number marking will be branded with the appro-

TYPICAL QUIESCENT SUPPLY CURRENT AS A FUNCTION OF SUPPLY VOLTAGE

priate suffix. Any one customer shipment will consist of a single selection (single suffix).

In A-M operation, large-signal overload can be optimized (to typically 30 mV ) by matching the particular part group with an appropriate load resistor at pin 8. The group is identified by the part number suffix (ULN-3838A-1).

For -1, R8 should be $\infty$;
for -2 , R8 should be $47 \mathrm{k} \Omega$;
for $-3, \mathrm{R} 8$ should be $33 \mathrm{k} \Omega$.
Additional loading may raise the overload point slightly, but AGC and sensitivity will be compromised. For any fixed value of R8, the - 3 parts will exhibit slightly higher A-M gain, while the -1 parts will have slightly lower A-M gain.

## TYPICAL AUDIO POWER OUTPUT AS A FUNCTION OF SUPPLY VOLTAGE



Dwg. No. A-11,518

## AUDIO AMPLIFIER

TOTAL HARMONIC DISTORTION AS A FUNCTION OF OUTPUT POWER

AUDIO AMPLIFIER
WITH $8 \Omega$ LOAD


Dwg. No. A-11,519

AUDIO AMPLIFIER
WITH $16 \Omega$ LOAD


## TYPICAL APPLICATION



NOTE: Dress speaker wires as far as possible from antenna. Ll and $0.04 \mu \mathrm{~F}$ speaker bypass capacitor may be deleted, depending on speaker location.

COIL AND TRANSFORMER INFORMATION

| L1 | Audio Choke | $10 \mu \mathrm{H}, \mathrm{Qu}=2 @ 2.52 \mathrm{MHz}$, <br> 3 turns through ferrite bead |
| :--- | :--- | :--- |
| L2 | A-M Antenna Coil | Qu $=250,110: 10$ turns ratio, <br> Q2B core, $3.5^{\prime \prime}(90 \mathrm{~mm}) \times 0.394^{\prime \prime}(10 \mathrm{~mm}) \phi$ |
| T1 | A-M Detector Coil | $390 \mathrm{pF}, \mathrm{Qu}=130 @ 45 \mathrm{kHz}, 100$ turns, center-tapped |
| T2 | A-M Oscillator | $460 \mu \mathrm{HH}, \mathrm{Qu}=120 @ 796 \mathrm{kHz}, 110: 11$ turns ratio |
| T3 | A-M I-F Transformer | $180 \mathrm{pF}, \mathrm{Qu}=145 @ 45 \mathrm{kHz}, 155: 10$ turns ratio, <br> primary tapped at 127 turns |

# ULN-3840A HIGH-PERFORMANCE A-M/F-M SIGNAL PROCESSING SYSTEM 

## FEATURES

- $12 \mu \mathrm{~V}$ Limiting Threshold
- Tuning-Error/Level Muting
- Meter Drive
- Balanced A-M Mixer
- $5 \mu \mathrm{~V}$ A-M Sensitivity
- D-C Mode Switching
- Internal Voltage Regulator
- Meets Dolby ${ }^{8}$ Noise Requirements
- 20-Pin Dual In-Line Plastic Package


硅DEALLY SUITED FOR TOP-NOTCH A-M/F-M radios, Type ULN-3840A provides sophisticated operating features highly desired by the modern consumer at a price that allows it to be used in budget receivers.

A combination of inter-station (signal-level) muting and off-channel (tuning-error) muting is useful in signal-seeking or scanning applications. The circuit design eliminates annoying low-frequency thump and noise tail when the system is manually tuned through a strong signal.

Outputs are available for directly driving a peak reading meter and a zero-tune meter. The peak meter output also is useful in controlling external system functions, such as blending multiplexers, stereo decoders, noise blankers, or in providing pos-itive-going AGC for the tuner.

All standard F-M I-F functions and all A-M functions are provided by this single monolithic integrated circuit. The low-level audio output stages have been designed to meet stringent Dolby ${ }^{\circledR}$ noise requirements.

The A-M mixer is a balanced low-current analog multiplier with very low local oscillator feedthrough, high I-F rejection, and freedom from spurious responses. This mixer can be used in the long-wave, medium-wave, and shortwave bands.

A fully-balanced, four-stage differential I-F amplifier gives maximum gain with freedom from com-mon-mode signals. It is used in both the A-M and F$M$ modes of operation with approximately 82 dB of gain in the F-M mode and controlled AGC gain of 26 dB in the $\mathrm{A}-\mathrm{M}$ mode.

The detector in the F-M mode is a four-quadrant analog multiplier operating in the high-level injection mode. Common-mode signals are rejected through the use of balanced current-mirror outputs.

In the A-M mode of operation, the detector is configured as a balanced peak detector for low audio distortion. A-M gain control is achieved with AVC applied to the I-F and delayed AVC applied to the mixer.

[^40]Switching between modes can be accomplished with a simple single-pole d-c switch. The common low-level audio output can be used to drive an audio power amplifier (Type ULN-3703Z) or stereo decoder (Type ULN-3810A).

Internal voltage regulators and bias supplies assure premium performance despite variations in external supply voltage $(8.5$ to 16 V$)$ or temperature $\left(-20^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$. Separate ground leads minimize decoupling problems.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ ..... 18 V
Mute Input Voltage, $V_{8}$ ..... 5.0 V
Regulator Current, $\mathrm{I}_{\text {REG }}$ ..... 5 .0 mA
Package Power Dissipation, $P_{D}$ ..... 750 mW *
Operating Temperature Range, $T_{A}$ ..... $20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ ..... $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
*Derated at $9.4 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.

FUNCTIONAL BLOCK DIAGRAM


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=12.8 \mathrm{~V}$

| Characteristic | Symbol | $\begin{aligned} & \text { Test } \\ & \text { Pin } \\ & \hline \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range | $\mathrm{V}_{\mathrm{cc}}$ | 10 |  | 8.5 | 12.8 | 16 | V |
| Audio Output Voltage | $V_{6}$ | 6 | No Signal | - | 5.8 | - | V |
| Regulator Output Voltage | $\mathrm{V}_{\text {REG }}$ | 13 | No Signal | - | 6.4 | - | V |
| Avail. Reg. Output Current | $\mathrm{I}_{\text {Reg }}$ | 13 |  | 2.0 | - | - | mA |

F-M MODE: $\mathrm{f}_{0}=10.7 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 75 \mathrm{kHz}, \mathrm{V}_{\mathrm{in}}=10 \mathrm{mVrms}$, Non-Muted (unless otherwise specified)

| Input Limiting Threshold | $V_{\text {TH }}$ | 2 |  | - | 12 | 25 | $\mu \mathrm{V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovered Audio | $V_{\text {our }}$ | 6 |  | 350 | 425 | 600 | mV |
| Output Distortion | THD | 6 |  | - | 0.3 | 0.7 | \% |
| Output Noise | S + N/N | 6 |  | 74 | 80 | - | dB |
| A-M Rejection | AMR | 12 | See Note | 40 | $>55$ | - | dB |
| Mute | $\Delta \mathrm{V}_{\text {out }}$ | 6 | $V_{\text {in }}=100 \mu \mathrm{~V}$, Max. Mute | - | - | -1.0 | dB |
|  |  |  | $V_{\text {in }}=5.0 \mu \mathrm{~V}$, Max. Mute | -45 | - | - | dB |
| AFC Output Voltage | $\mathrm{V}_{\text {atc }}$ | 7 |  | 220 | - | 600 | mV |
| I-F Input Voltage | $\mathrm{V}_{2}$ | 2 | No Signal | - | 3.5 | - | V |
| Mute Output Voltage | $V_{14}$ | 14 | No Signal | 3.6 | 4.2 | - | V |
| Mute Output Current | $\mathrm{I}_{14}$ | 14 | No Signal | 0.5 | - | - | mA |
| Supply Current | $\mathrm{l}_{\mathrm{cc}}$ |  | No Signal | - | 23 | 35 | mA |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{it}}=455 \mathrm{kHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, 30 \% \mathrm{~A}-\mathrm{M}, \mathrm{V}_{\mathrm{in}}=1.0 \mathrm{mVrms}$ (unless otherwise specified)

| Sensitivity | $\mathrm{V}_{\text {in }}$ | 18 | $\mathrm{~V}_{\text {out }}=50 \mathrm{mVrms}$ | - | 5.0 | 8.5 | $\mu \mathrm{~V}$ |
| :--- | :---: | :---: | :--- | :--- | :---: | :---: | :---: |
| Usable Sensitivity |  | 18 | $20 \mathrm{dBS}+\mathrm{N} / \mathrm{N}$ | - | 6.0 | - | $\mu \mathrm{V}$ |
| Recovered Audio | $\mathrm{V}_{\text {out }}$ | 6 | $80 \% \mathrm{~A}-\mathrm{M}$ | 250 | 325 | 600 | mV |
| Input Overload | $\mathrm{V}_{\text {in }}$ | 18 | $80 \% \mathrm{~A}-\mathrm{M}, \mathrm{THD}=10 \%$ | 25 | 50 | - | mV |
| A-M Decoupling Voltage | $\mathrm{V}_{1}$ | 1 | No Signal | - | 1.0 | - | V |
| I-F Input Voltage | $\mathrm{V}_{2}$ | 2 | No Signal | - | 3.7 | - | V |
| Mute Output Voltage | $\mathrm{V}_{14}$ | 14 | No Signal | - | - | 0.5 | V |
| Peak Meter | $\mathrm{V}_{15}$ | 15 |  | No Signal | - | $<0.5$ | - |
|  |  |  | $\mathrm{V}_{\text {in }}=10 \mathrm{mV}$ | V |  |  |  |
| A-M Input Voltage | $\mathrm{V}_{17}$ | 17 | No Signal | - | 3.0 | - | V |
| Supply Current | $\mathrm{I}_{\mathrm{cc}}$ |  | No Signal | 1.6 | 1.8 | 2.1 | V |

Note: Amplitude Modulation Rejection is specified as $20 \log \frac{V_{\text {out }} \text { for } 100 \% \mathrm{~F}-\mathrm{M} \mathrm{V}_{\text {in }}}{\mathrm{V}_{\text {out }}}$ for $30 \% \mathrm{~A}-\mathrm{M} \mathrm{V}_{\text {in }}$

SMALL-SIGNAL A-C CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

|  |  |  | Limits |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristic | Test |  |  | Min. | Typ. | Max. | Units |
| I-FInput Capacitance | $\mathrm{C}_{2}$ |  |  | - | 6.0 | - | pF |
| I-F Output Resistance | $\mathrm{R}_{12}$ | 12 |  | - | 250 | - | $\mathrm{k} \Omega$ |
| I-F Output Capacitance | $\mathrm{C}_{12}$ | 12 |  | - | 2.5 | - | pF |
| Audio Output Impedance | $\mathrm{Z}_{6}$ | 6 |  | - | 350 | - | $\mathrm{k} \Omega$ |

## F-M MODE: $\mathrm{f}_{0}=10.7 \mathrm{MHz}$

| I-F Input Resistance | $\mathrm{R}_{2}$ | 2 |  | - | 10 | - | $\mathrm{k} \Omega$ |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| I-F Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $2-12$ |  | - | 8.0 | - | mho |
| Detector Input Resistance | $\mathrm{R}_{11}$ | 11 |  | - | 100 | - | $\mathrm{k} \Omega$ |
| Detector Input Capacitance | $\mathrm{C}_{11}$ | 11 |  | - | 1.5 | - | pF |

A-M MODE: $\mathrm{f}_{0}=1 \mathrm{MHz}, \mathrm{f}_{\mathrm{if}}=455 \mathrm{kHz}$

| A-M Input Resistance | $\mathrm{R}_{18}$ | 18 |  | - | 5.0 | - | $\mathrm{k} \Omega$ |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A-M Input Capacitance | $\mathrm{C}_{18}$ | 18 |  | - | 20 | - | pF |
| Mixer Transconductance | $\mathrm{g}_{\mathrm{m}}$ | $18-19$ |  | - | 15 | - | $\mathrm{mmho}{ }^{*}$ |
| Mixer Output Resistance | $\mathrm{R}_{19}$ | 19 |  | - | 500 | - | $\mathrm{k} \Omega$ |
| Mixer Output Capacitance | $\mathrm{C}_{19}$ | 19 |  | - | 5.0 | - | pF |
| I-FInput Resistance | $\mathrm{R}_{2}$ | 2 |  | - | 15 | - | $\mathrm{k} \Omega$ |
| I-FTransconductance | $\mathrm{g}_{\mathrm{m}}$ | $2-12$ |  | - | 160 | - | $\mathrm{mmho}{ }^{*}$ |
| Detector Input Resistance | $\mathrm{R}_{11}$ | 11 |  | - | 250 | - | $\mathrm{k} \Omega$ |
| Detector Input Capacitance | $\mathrm{C}_{11}$ | 11 |  | - | 1.0 | - | pF |

*The International Electrotechnical Commission recommends the use of siemens ( $S$ ) as the standard international unit of conductance, admittance and susceptance.

F-M TUNING-ERROR DETECTOR RESPONSE


## TEST CIRCUIT


*In application, $R=0 \Omega, C=0.008 \mu \mathrm{~F}$ for $50 \mu \mathrm{~S}$ de-emphasis (Europe) or $0.012 \mu \mathrm{~F}$ for $75 \mu \mathrm{~S}$ de-emphasis (U.S.A.)

Filter Assembly:
Toko Part No. CFU455C-82BR


COIL WINDING INFORMATION


| T1 A-M I-F | Qu $=45$ | General Instrument | Toko Part No. |
| :---: | :--- | :--- | :--- |
| 455 kHz | $\mathrm{Ct}=1000 \mathrm{pF}$ | Part No. EX 27765 | RXN-6A6909HM |
| T2 F-M Detector | $\mathrm{Qu}=60$ | General Instrument | Toko Part No. |
| 10.7 MHz | $\mathrm{Ct}=82 \mathrm{pF}$ | Part No. EX 27975 | TKAC-17044Z |
| L1 A-M Oscillator | $\mathrm{Qu}=50$ | General Instrument | Toko Part No. |
| 1455 kHz | $\mathrm{N1:N2=11:1}$ | Part No. EX 27641 | RWO-6A7640BM |
|  | $\mathrm{Ct}=39 \mathrm{pF}$ |  |  |
| L2 F-M Detector | $\mathrm{L}=18 \mu \mathrm{H}$ | Coilcraft |  |
| 10.7 MHz | $\mathrm{Qu}=55 @ 2.5 \mathrm{MHz}$ | Type V |  |

## A-M CONTROL VOLTAGES AS FUNCTIONS OF INPUT SIGNAL



F-M CONTROL VOLTAGES AS FUNCTIONS OF INPUT SIGNAL


## A-M CHARACTERISTICS AS FUNCTIONS OF INPUT SIGNAL



F-M CHARACTERISTICS AS FUNCTIONS OF INPUT SIGNAL


# ULN-3859A <br> F-M COMMUNICATIONS I-F SYSTEM 

## FEATURES

- Dual Conversion
- Low Current Drain
- Wide Operating Voltage Range
- High Sensitivity
- Replaces MC3359P
- 18-Pin Dual In-Line Plastic Package

THIS low-power, narrow-band F-M I-F system provides the second converter, second I-F, demodulator and squelch circuitry for communications and scanning receivers.

Type ULN-3859A's double-balanced mixer permits low-noise operation while eliminating spurious responses, effectively rejecting tweet and I-F feedthrough, and reducing local oscillator radiation. The mixer's high input impedance matches popular 10.7 MHz crystal filters while its output impedance matches most 455 kHz ceramic filters. Although designed for use with a 10.7 MHz first I-F and a 455 kHz second I-F, the mixer operates at other R-F or I-F input frequencies through 30 MHz .

A multi-stage 1 MHz differential amplifier/ limiter following the second I-F filter operates as

a high gain stage with excellent common-mode rejection.

Audio is recovered by a quadrature F-M detector that requires only a single low-cost tuned circuit.

Type ULN-3859A has both a low-impedance emitter-follower audio output and an AFC output. Few external components are needed for operation with noise-activated or tone squelch.

This communications I-F system meets the stability requirements of many automotive applications, and also meets the low-power demands of portable radio design. Internal voltage regulators and bias supplies ensure stable performance despite variations in external supply voltage ( 4 to 9 V ) or temperature $\left(-20^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ ).

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{c c}$ ..... 12 V
Mixer Terminal Voltage, $V_{\text {in }}$ ..... 1.0 Vrms
Mute Terminal Voltage Range, $\mathrm{V}_{16}$ ..... -0.5 V to +12 V
Operating Temperature Range, $T_{A}$

$$
-20^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
$$Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=8.0 \mathrm{~V}$, $f_{0}=10.7 \mathrm{MHz}, f_{m}=1.0 \mathrm{kHz}, \mathrm{f}_{\mathrm{d}}= \pm 3.0 \mathrm{kHz}$ (unless otherwise noted)

| Characteristic | $\begin{aligned} & \text { Test } \\ & \text { Pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range | 4 |  | 4.0 | 8.0 | 9.0 | V |
| Quiescent Supply Current | 4 | $\mathrm{V}_{14}=0$, Mute OFF | - | 3.0 | 6.0 | mA |
|  |  | $V_{14} \geq 0.7 \mathrm{~V}$, Mute ON | - | 4.0 | 7.0 | mA |
| Tnput Limiting Threshold | 18 | -3 dB Limiting | - | 2.0 | 6.0 | $\mu \mathrm{V}$ |
| Mixer Conversion Gain | 3 | See Note 1, Next Page | - | 24 | - | dB |
| Mixer Input Resistance | 18 |  | - | 3.6 | - | k 8 |
| Mixer Input Capacitance | 18 | See Note 2, Next Page | - | 2.2 | - | pF |
| Mixer Output Impedance | 3 |  | - | 1.8 | - | k 8 |
| Limiter Input Impedance | 5 |  | - | 1.8 | - | k 8 |
| Quiescent D-C Output Voltage | 10 | $\mathrm{V}_{\text {in }}=0$ | 2.4 | 3.6 | 4.4 | $V$ |
| Audio Output Impedance | 10 |  | - | 500 | - | $\Omega$ |
| Recovered Audio Output | 10 | $V_{\text {in }}=3.0 \mathrm{mV}$ | 450 | 700 | - | $\mathrm{mV}_{\mathrm{rms}}$ |
| Amplifier Gain | 13 | $f=4.0 \mathrm{kHz}, \mathrm{V}_{\text {in }}=5.0 \mathrm{mV}$ | 40 | 53 | - | dB |
| Quiescent D-C Output Voltage | 13 | $\mathrm{V}_{\text {in }}=0$ | - | 1.7 | - | V |
| Mute Switch Resistance | 16 | $\mathrm{I}_{16}=2.5 \mathrm{~mA}, \mathrm{~V}_{14} \geq 0.7 \mathrm{~V}$ | - | 4.0 | 10 | $\Omega$ |
| Scan Source Current | 15 | $\mathrm{V}_{14}=\mathrm{V}_{15}=0$, Mute OFF | 2.0 | 4.0 | - | mA |

## TEST CIRCUIT



## APPLICATION INFORMATION

1. In a typical application, with a $3.6 \mathrm{k} \Omega$ crystal filter source, Type ULN-3859A will give 23 dB conversion gain.
2. Because crystal filters are extremely sensitive to reactive loading, radio designers frequently have added a coil and/or capacitor at pin 18 to cancel the input reactance component. This practice is not required with Type ULN-3859A, since its input is designed to match typical 10.7 MHz crystal filters. However, if an external reactive component is used, it is important to adjust it for optimal passband shape and not simply to peak it for maximum sensitivity.
3. Pin 11 provides AFC . If AFC is not required, pin 11 should be grounded, or tied to pin 9 to double the available recovered audio.
4. Pin 10 may require an external resistor ( $2 \mathrm{k} \Omega$ minimum) to ground to prevent audio rectification with some capacitive loads.

## ULN-2204A A-M/F-M RECEIVER SYSTEM -TYPICAL APPLICATIONS AND OPERATION

## Introduction

Through the relatively short history of bipolar monolithic circuits, several revolutionary new circuits have been developed for $a-m / f-m$ receiver design. A. Bilotti pioneered the original monolithic f-m quadrature detector/I-F gainblock in the form of the Sprague ULN-2111A.

Subsequent devices have included gain-control stages, output drivers, and voltage regulators. During this same period a-m integrated circuitry showed far less inspiration. Numerous a-m circuits were developed which in essence attempted to combine the active elements of a discrete bipolar a-m receiver in a monolithic circuit. To no surprise, the resulting chips were at best capable of performance no better than the parent discrete design, and with the uneconomical displacement of three discrete transistors with one integrated circuit. In addition to the a-monly circuits and $\mathrm{f}-\mathrm{m}$-only circuits, $\mathrm{a}-\mathrm{m} / \mathrm{f}-\mathrm{m}$ circuits were also attempted using the same design approaches used for the a-m only circuit, that of combining an existing discrete receiver circuitry in a monolithic device. The results were much like the a-m only efforts, a bewildering collection of economically unattractive circuits of modest performance.

To achieve useful cost and performance objectives, the ULN-2204A was designed with careful attention to the cost and performance objectives of the modern portable and table model broadcast receiver. Concern for low external component count, low power consumption, wide supply voltage range, and versatility remained foremost as design objectives.

## Power Amplifier

To achieve the desired performance objectives of high power output and efficiency from a 2 to 12 V supply requires that the power amplifier be capable
of peak-to-peak voltage swings approaching the available supply. To meet these performance objectives a new power amplifier design was required having no more than one $V_{B E}$ of swing restriction.

As shown in Figure 1, the output stage is comprised of 2 NPN transistors (Q42 and Q49) plus a phase inverter (Q54). Quiescent operating current is set up by the current source (I).


Figure 1

Assuming $\mathrm{V}_{\mathrm{oq}}=\mathrm{V}_{\mathrm{CC} / 2}$ then the collector current of Q54 $=\mathrm{I}$, ignoring base currents, and if Q54 is matched to Q49 as is possible in a monolithic circuit, then the collector current of Q49 equals the collector current of Q54. The circuit in Figure 1 achieves an excellent voltage swing capability of $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{Be}}-$ $2 \mathrm{~V}_{\text {CE(SAT) }}$. This totally NPN configuration also has good freedom from the high-frequency problems that often occur with quasi-complementary composite NPN-PNP configurations.

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS (Continued)

Although the circuit in Figure 1 has been incorporated in production monolithic circuits in essentially the form shown, in practice it has unacceptable design restrictions. Since I is also the base drive current for Q42, the ratio of available base drive current I to idling current is proportional to the ratio of the emitter areas of Q49 to Q54. For practical values of IQ54/IQ49, i.e. one, the circuit has a serious implementation problem; it requires three output transistors (Q42, Q49, and Q54).

To reduce the size of Q54, an additional transistor (Q48) is added to the circuit as shown in Figure 2. Transistor Q48 divides I by its beta +1 allowing Q54 to be reduced in area by a similar value. In the practical realization of the ULN-2204A, Q54 is chosen as $1 / 5$ the emitter area of Q49 with a typical beta for Q48 of 6 .


Figure 2

Figure 3 illustrates other refinements in the practical realization of the output circuit. The drive and idling current I is derived from a $\mathrm{V}_{\mathrm{CC}}$ dependent source allowing maximum drive under maximum supply conditions while affording reduced drive and associated current conservation under minimum supply conditions. In addition, the Q48 divider circuit is refined to reduce PNP beta dependence. Finally with the addition of an input emitter follower (Q53) and a local negative feedback loop (R36), the output is completed as it appears in the ULN-2204A.

The input stage of the power amplifier (Figure 4) is comprised of a PNP differential pair (Q44 and Q45) preceded by a $\mathrm{PN}^{\mathbf{N}}$ emitter follower (Q43) which allows d-c referencin ${ }_{5}$ - .he source signal to ground. This eliminates the need for an input coupling


Figure 3
capacitor. Overall negative feedback, set by the ratio of R33 to R32, is applied to the inverting input Q45 through an NPN emitter follower (Q46) which also provides d-c level shifting.


Figure 4
The $\mathrm{V}_{\mathrm{CC} / 2}$ output tracking is achieved by summing the current flow through R33 and R32, with the current through R41 "reflected off of ground". Thus $\mathrm{V}_{\mathrm{CC} / 2}$ tracking is maintained by the voltage drop across 2 resistors. This allows the current from R41 to be bypassed at Pin 10, thereby combining the ripple bypass capacitor with the audio feedback capacitor.

Figure 5 illustrates the complete power amplifier as realized in the ULN-2204A, including the external components. The remarkably-low external component count, (only two capacitors including the output coupling) reflects concern for simplicity in implementation, yet the device achieves excellent performance. Typical output power can be as high as 850 mW from a 9 volt supply and useful output power at supply voltages of as low as 2 volts, with minimum of distortion as the curves in Figure 6 illustrate.


DWA. NO. A-10.634

Figure 6


Figure 5

## Receiver

The a-m signal is processed from the antenna to the detector output via the traditional blocks of mixer, I-F, and detector enclosed in a reverse A-G-C loop. However, closer examination reveals certain very important advantages that can be afforded only by the monolithic design.

The a-m mixer is a fully-balanced mixer based on a four-quadrant multiplier as shown in Figure 7. This affords rejection of both the oscillator and input signal as observed at the output. In addition, an analog multiplier is (as the name implies) a true linear device. Balanced operation of the mixer provides typically 25 dB of I-F rejection at the input, with a similar rejection of the associated noise passband. Also, the linear operation of the circuit affords good freedom from intermodulation product responses.

I-F gain is provided for both $\mathrm{a}-\mathrm{m}$ and $\mathrm{f}-\mathrm{m}$ by a common I-F amplifier (Figure 8) using "stacked" selectivity. In $\mathrm{f}-\mathrm{m}$ operation the gain of stages 1,2 , 3, and $4(\mathrm{Q} 1$ thru Q 8$)$ is set at typically 76 dB providing a typical limiting threshold of $40 \mu \mathrm{~V}$.

For a-m the gain is lowered by reducing stage current. This is accomplished by reducing the current applied to the I-F amplifier by the current source Q17. The fifth I-F stage (Q9 and Q10) is operated at maximum gain and current to provide full signal to the a-m and f-m detector.

## A-M/F-M Detector

The detector is also a combination circuit. It recovers a-m audio by peak detection and $\mathrm{f}-\mathrm{m}$ audio by phase discrimination.

The a-m signal from the I-F output appears at Pin 15 across $\mathrm{T}_{2}$ as shown in Figure 9. The signal is applied to the base of Q18 and after phase inversion by $T_{2}$ is applied also to the base of Q19. Full wave detection occurs at the emitter of Q18 and Q19, utilizing the on-chip junction capacity for integration. This requires only that the stage current be chosen at a low value (typically $1 \mu \mathrm{~A}$ ) to produce the desired integration.

The $\mathrm{f}-\mathrm{m}$ detection process relies on the phase/frequency relationship of a tuned external circuit for demodulation. The device converts phase


Figure 7
variation, as observed across the tuned network, to a proportional voltage. The basic phase detection process combines the positive-going portions of the quadrature and reference signals (Pin 14 and 15 , respectively), and evaluating the duty cycle of the resulting waveform as shown in Figure 10. The combining action occurs at the emitters of Q18 and Q19 resulting in the waveform shown. Subsequent processing involves squaring up the signal in a limiter, comprised of Q24 and Q27, resulting in the constant-amplitude plus train which is also shown. This pulse train is then applied to a PNP gain stage which, owing to the PNP's low $\mathrm{f}_{\mathrm{T}}$ of typically 1 MHz , integrates the pulse train into an average d-c
voltage which appears at Pin 8 , the detector audio output. Figure 11 illustrates the complete $a-m / f-m$ detector of the ULN-2204A, including the external components.

To complete the circuit, the a-m stages also require A-G-C. This is implemented in the ULN2204A by internally setting the I-F supply voltage (Pin 16) equal to the voltage at the detector audio output. As carrier appears, a corresponding reduction in the d-c voltage occurs at the audio output terminal and at Pin 16, where an external bypass capacitor removes audio from the A-G-C line and sets the time constant.


Figure 8


Figure 9


Figure 10

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS (Continued)



Figure 11

## Application

The primary application, but certainly not the only application, for the ULN-2204A is the broadcast band a-m/f-m table or portable radio as illustrated in Figure 12.

## Power Amplifier

Selection of power supply voltage and speaker impedance allow the designer to choose audio power levels up to almost 1 watt as the curves in Figure 6 illustrated. No unique precautions are necessary when designing with the ULN-2204A power amplifier. The device is stable and short-circuit immune.

External component choice for the power amplifier involves only two capacitors; one for the speaker coupling and one for the feedback and ripple by-passing. The coupling capacitor value should be
selected to provide the desired low-frequency cutoff with the chosen speaker impedance. The feedback and ripple bypass capacitor at Pin 10 should be chosen for both low-frequency audio rolloff and supply ripple rejection.

Ripple rejection is not practical to calculate due to the large number of mechanisms involved. The 220 $\mu \mathrm{F}$ capacitor indicated in Figure 12 achieves typically 35 dB rejection.

The high gain of typically 43 dB and the high input impedance ( $200 \mathrm{k} \Omega$ ) of the power amplifier allow utilization of this stage for other applications such as ceramic cartridge phono amplifiers.

Typical ceramic phono cartridges develop approximately 400 mV . However, the recommended
load impedance for the most economical cartridges is usually $1 \mathrm{M} \Omega$. This poses no problem with the $200 \mathrm{k} \Omega$ input impedance of the ULN-2204A since the cartridge manufacturer specifies the load impedance for full low-frequency response to less than 40 Hz . Decreasing the load impedance produces an increased low end cutoff frequency.

In a ULN-2204A based application employing a cost and space conscious loudspeaker, 40 Hz program material capability is not only unnecessary but undesirable, and therefore a mismatch of the cartridge to increase the lower cutoff frequency to a value more in keeping with the other components of the system is recommended.

The ULN-2204A audio amplifier stage has other input considerations to be taken into account for best results. The input is referenced to ground for internal biasing and must be provided with a d-c path to ground. A current of typically $0.1 \mu \mathrm{~A}$ flows from Pin 9 through the volume control producing an IR drop which is multiplied by the closed loop d-c gain of the amplifier (1), and appears as an error in output centering at Pin 12. This recommends a value of $200 \mathrm{k} \Omega$ or less for the volume control, with values of less than $100 \mathrm{k} \Omega$ preferred.
The selection of power amplifier load impedance involves more consideration than just the desired power output. Ideally an $8 \Omega$ speaker impedance would produce the highest power outputs for any one supply voltage as the curves in Figure 6 illustrated. However, operation with a $16 \Omega$ load can produce as much power as with an $8 \Omega$ load as is also shown in Figure 6. The higher impedance load will also furnish a significant reduction in harmonic distortion and improvement in overall repeatability in power output capacity. In applications which allow the selection of the power supply voltage it is therefore recommended that a 168 load impedance be utilized in applications up to 0.75 watt. For applications having fixed power supply values, i.e. batteries, device selections can be had that produce the maximum power level into $8 \Omega$.

## Receiver Section - F-M

The f-m intermediate frequency input transformer, comprised of $\mathrm{T}_{5}$ and $\mathrm{T}_{6}$, provides both selectivity and coupling. $\mathrm{T}_{5}$ should present a source impedance to the device of approximately $500 \Omega$ for optimal stability. $\mathrm{T}_{6}$, the primary, is governed primarily by the characteristics of the tuner head feeding it, and should be selected for those considerations. $\mathrm{T}_{5}$ and $\mathrm{T}_{6}$ comprise a double tuned section which for monaural f-m should have a bandwidth of 150 kHz .

The ULN-2204A also provides a regulated and decoupled d-c bias voltage to be used as the $\mathrm{V}_{\mathrm{CC}}$ supply for the tuner head. This bias voltage is obtained at Pin 16 and provides typically 2.5 mA . The current drain loads Pin 16 significantly and must appear for Pin 16 to operate at the correct voltage of 2.2 V . The voltage at Pin 16 determines the gain of the f-m intermediate frequency with higher values producing increased gain. The voltage at Pin 16 also varies with the voltage at Pin 8 (the detector output voltage), and therefore applies some A-F-C to the tuner head through the oscillators' $\mathrm{V}_{\mathrm{CC}}$ supply.

As described earlier, the f -m detector is a phase detector which detects the phase shift of an external network appearing between Pin 14 and Pin 15. The preferred network is a double-tuned transformer as shown in Figure 10. This network is selected to provide the correct recovered audio and minimum distortion by choosing the loaded and coupled "Q's. In Figure 12, $T_{3}$ (the primary) and $T_{4}$ (the secondary) are loaded by resistors of $2.2 \mathrm{k} \Omega$ and $4.7 \mathrm{k} \Omega$, respectively, and top coupled by a 4.7 pF capacitor giving an $S$ curve peak to peak separation of 400 kHz . Coupling factor ( Qk ) is slightly greater than 1 to improve harmonic distortion. The bandwidth has been selected to place the carrier of an adjacent channel interfering station (standard f-m broadcasting) on the peaks of the $S$ curve, thereby improving selectivity. Using the circuitry shown, a typical recovered audio value of 250 millivolts at Pin 8 and total harmonic distortion value of 0.7 percent are achieved with 75 kHz deviation. It should be noted that the network, particularly the coupling capacitor value, is affected by layout and may require optimization for a particular application. Extremely high values of coupling factor should be avoided as this produces an undesirable voltage gain from Pin 15 to Pin 14 which manifests itself as S curve inbalance at low signal levels.

The f-m de-emphasis is formed by the $0.01 \mu \mathrm{~F}$ capacitor connected at Pin 8 with an internal $7.5 \mathrm{k} \Omega$ resistor.

## Receiver Section - A-M

The a-m section requires two external coils for I-F matching and selectivity, plus the local oscillator coil. The a-m detector transformer ( $\mathrm{T}_{2}$ ) and mixer load coil ( $\mathrm{T}_{1}$ ) are stacked with the corresponding f-m components to form the composite. The selection of bandwidth for the two-coil system shown in Figure 12 is restricted primarily by the practical coil Qs available. The unloaded Q of the first transformer ( $\mathrm{T}_{1}$ ) being selected as 120 and loaded to ap-


COIL WINDING INFORMATION

| 11 | A-M First I-F 455 kHz | $\begin{aligned} & \mathrm{Qu}=120 \\ & \mathrm{N1}: \mathrm{N} 2 \mathrm{N3}=15.5: 2.8: 1 \\ & \mathrm{Ct}=180 \mathrm{pF} \end{aligned}$ | General Instrument Part No. 27835 | Toko <br> 7MC-A4018A or RMC2A7641A |
| :---: | :---: | :---: | :---: | :---: |
| T2 | A-M Second I-F 455 kHz | $\begin{aligned} & \mathrm{Qu}=70 \\ & \mathrm{~N} 1: \mathrm{N} 2=2: 1 \\ & \mathrm{Ct}=430 \mathrm{pF} \end{aligned}$ | General Instrument Part No. 27836 | Toko <br> 7B0-A4017BM or RLE4A7642G0 |
| T3 | F-M Detector 10.7 MHz | $\begin{aligned} & Q u=50 \\ & C t=100 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27639 | Toko <br> BKAC-K3651HM |
| T4 | F-M Detector 10.7 MHz | $\begin{aligned} & \mathrm{Qu}=50 \\ & \mathrm{Ct}=100 \mathrm{pF} \end{aligned}$ | General Instrument Part No. EX 27640 | Toko <br> BKAC-K3651HM |
| L1 | A-M Oscillator 1455 kHz | $\begin{aligned} & \text { Qu }=50 \\ & \text { N1:N3 }=10.7: 1 \\ & \mathrm{Ct}=39 \mathrm{pf} \end{aligned}$ | General Instrument Part No. EX 27641 | Toko 7B0-A4017BM or RW0-6A7640BM |




150 mW OUTPUT

$8 \Omega$ SPEAKER - 1.0 W OUTPUT
$16 \Omega$ SPEAKER - 0.7 W OUTPUT


6 V BATTERY (4'AA' CELLS) - 250 mW OUTPUT
9V BATTERY (NEDA 1604) - 750 mW OUTPUT

Figure 12
proximately 90 in the circuit, and the second transformer $\mathrm{T}_{2}$ as 70 with virtually no load presented by the circuit. Impedances are selected based on two constraints: a-m gain and overload. One additional point to consider is the behavior of the a-m component when the receiver is in the f - m mode.

The available I-F current at Pin 15 is $200 \mu \mathrm{~A}$ peak, $100 \mu \mathrm{~A}$ at its quiescent point. (See Figure 9). Maximum permissable swing at Pins 14 and 15 is limited to 0.5 volt positive with respect to Pin 13. This restricts peak voltage swing at Pin 15 to $1 \mathrm{~V}_{\mathrm{pp}}$, considering the inverting action of $\mathrm{T}_{2}$. This restricts the impedance of $\mathrm{T}_{2}$, as seen by the I-F output, to values greater than $15 \mathrm{k} \Omega$ to permit maximum dynamic range. Including all worst case conditions, a value of $18 \mathrm{k} \Omega$ is chosen for $\mathrm{T}_{2}$ in the example. Considered were temperature variations and internal device tolerances. In addition, a 470 pF capacitor has been added to assure an adequate a-c return for the $\mathrm{f}-\mathrm{m}$ coil.

Transformer $\mathrm{T}_{1}$ (Figure 7) is chosen for the correct overload characteristics of the mixer. It also features a $100 \mu \mathrm{~A}$ quiescent state and a 0.5 volt peak swing restriction for primary impedance considerations, and the secondary winding chosen as the lowest practical impedance for desired system gain. Unlike $\mathrm{T}_{2}$ which is not loaded to any degree by the circuit, $\mathrm{T}_{1}$ is loaded by both the mixer output impedance of approximately $50 \mathrm{k} \Omega$ and the I-F input impedance of approximately $30 \mathrm{k} \Omega$. Both must be taken into consideration in calculating the loaded Q of the transformer. In addition, the effect of the a-m components on the f-m I-F stability must be considered - the device must be stable at both the intermediate frequencies in both modes of operation. Although no practical method exists for evaluating stability criteria for an integrated circuit as is commonly done for discrete circuits, the practical ground rules are much the same - mismatching of the input at the first transformer to achieve stability.

The oscillator coil $\left(\mathrm{L}_{1}\right)$ has a secondary impedance selected to be approximately $800 \Omega$ at resonance. This provides typically 150 millivolts of injection voltage to the mixer driving the upper differential pairs of the four-quadrant multiplier into hard limiting. The oscillator is also restricted to a $1 \mathrm{~V}_{\mathrm{pp}}$ swing and operates with a quiescent current of 0.5 mA .

## Printed Wiring Board Layout and Special Considerations

Special on-chip considerations for minimizing tendencies towards instabilities of all types were taken in the design of the ULN-2204A. However, like all
complex high-gain circuits, considerable care and forethought should still be given to a printed wiring board layout to avoid undesirable effects. Inputs and outputs should be well separated and should avoid common mode impedances wherever possible. Much of the signal-processing circuitry is referenced off of the supply line, and this should avoid being in a common mode loop caused by current drain of the power amplifier through Pin 13. Reference points for the local oscillator, a-m mixer, and the detector coils should be connected to Pin 13 very close to the device and away from the $\mathrm{V}_{\mathrm{CC}}$ connection to the power supply bypass capacitor.
The Pin 13 common mode resistance will also interfere with device operation in a socket. In the f-m mode of operation, current drawn by the power amplifier will cause the Pin 13 voltage to drop slightly with respect to the reference for Pin 14 and 15. This will cause a variation in gain of the $\mathrm{f}-\mathrm{m}$ detector. The effect also causes an apparent increase in distortion when the power amplifier is loaded, with distortion figures approaching several percent under worst case conditions. The effect is negligible, however, when the device is soldered into a printed wiring board.

Connections between Pins 14, 15, and transformers $T_{2}, T_{3}$, and $T_{4}$ should be kept as short as possible as should connections for Pins 1 and 2, those associated with the transformers. The ground return for the audio bypass at Pin 10 should be kept reasonably close to the volume control ground as Pin 9 and 10 represent the inverting and non-inverting inputs to the amplifier and enjoy about 40 dB of common mode rejection.

## Other Applications - TV Sound Channel

Beyond the obvious applications of the ULN2204A as an a-m/f-m receiver it has much to offer as a sound system for television. The device offers ex-ceptionally-low current consumption and a wide operating supply voltage range. Its high a-m rejection and low external component count will make it practical for use in many power conscious applications. Most of the comments which apply to the $\mathrm{f}-\mathrm{m}$ application of the ULN-2204A also apply to its application at 4.5 MHz or 5.5 MHz with suitable adaptations of the external selectivity components. (See Figure 13)

## Multiband Receiver

The ULN-2204A A-Mcircuitry is not restricted to conventional broadcast band applications. The

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS (Continued)



Figure 13

ULN-2204A mixer and oscillator are both capable of operation from the very-long wave band to well above the medium wave bands. Only the antenna and oscillator coils need to be switched or adapted
for use at other frequencies. The useful limits of the mixer-oscillator combination extend to approximately 50 MHz with excellent performance up through and including the citizens' band at 28 MHz .


## A-M/F-M RECEIVER DESIGNS USING ULN-2240A, ULN-2241A, and ULN-2242A INTEGRATED CIRCUITS

## THREE MONOLITHIC INTEGRATED

 circuits, Types ULN-2240A, ULN-2241A and ULN-2242A, each contain all the active circuit elements required for the A-M tuner, F-M I-F amplifier and detector functions. Only an F-M tuner, filter elements, and a minimum of additional external components are necessary for a complete A-M/F-M receiver.This Application Note discusses several circuits and options for a number of A-M/F-M receiver applications. Each of the three Sprague integrated circuits used provides performance characteristics equivalent to or better than systems using discrete components for A-M and $\mathrm{F}-\mathrm{M}$ functions.

The circuits are ideal for special receivers such as scanners which must be able to detect A-M and F-M signals at one I-F frequency. Also, the three devices lend themselves to shortwave receiver designs because of the simplicity of their A-M oscillator systems.

The various receiver designs covered here include an A-M tuner using a ferrite antenna, and a permeability-tuned automobile radio. Enhanced sensitivity and overload performance is obtained with the addition of an R-F amplifier, easily accomplished using the AGC voltage for the A-M mixer to control an R-F amplifier stage. The discussion covers a table model receiver with a ferrite antenna and R-F stage, and an R-F stage for an automobile receiver. The concept is extended to varactor-tuned automobile radios with the addition of an FET-bipolar cascode R-F stage and an AGC driver.


DWG. NO. A-10,426
ULN-2240A ULN-2242A


ULN-2241A

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS (Continued)

## General Performance Considerations

Internal voltage regulators and bias supplies assure consistent performance despite variations in external supply voltage ( 8.5 to 16 V ) or operating temperature $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$. Separate ground leads minimize decoupling problems.

The A-M sections of all three devices are the same. Use of an analog multiplier as a balanced low-current mixer results in freedom from spurious responses, high tweet rejection, low feedthrough, and low noise and very low local oscillator feedthrough. A fully-balanced fourstage differential amplifier gives maximum gain with freedom from common-mode interference
and noise. A-M gain control is achieved with AVC applied to the I-F and delayed AVC applied to the mixer.

The differences in these three circuits are found in the F-M sections, with packaging variations to accomodate the different features. Type ULN-2241A is supplied in a 16 -pin plastic dual in-line package. This circuit has no mute, and no AFC/tuning meter output (the audio output can be used for AFC). Type ULN-2242A, in a 20 -pin package, incorporates the F-M mute and AFC/tuning meter output. Type ULN-2240A, also in a 20 -pin package, adds tuning-error mute, and higher F-M S/N.

## Input-Filter Coupling

The common A-M and F-M I-F inputs for all three devices are basically the same. Note that terminals 1, 2 and 3 for Type ULN-2241A correspond to terminals 2,3 and 4 respectively for Types ULN-2240A and ULN-2242A.

The method of arranging the I-F filters


Figure 1
depends entirely on the type of filters used. For example, coils placed in series may be used for A-M and F-M connected as shown in Figure 1.

A ceramic filter may be used for F-M with an A-M filter incorporating a tuned coil in its output. This arrangement is illustrated in Figure 2.


Figure 2

The I-F input impedance is very high ( $10 \mathrm{k} \Omega$ @ $10.7 \mathrm{MHz} ; 15 \mathrm{k} \Omega$ at 455 kHz ) and can be ignored when selecting loading resistors for different types of I-F filters. Additionally, the input stage bias currents are very low, therefore a relatively high-value resistor can be connected between pins 1 and 3 of Type ULN-2241A, or pins 2 and 4 of Type ULN-2240A or ULN2242A, without significantly affecting the limiter balance.
These characteristics simplify the input filter coupling to accomodate ceramic filters used for both A-M and F-M I-Fs as shown in Figure 3.

Most 455 kHz filters are terminated by a 1 to 3 $\mathrm{k} \Omega$ resistor in parallel with a capacitor of less
than 50 pF . The 10.7 MHz filter requires a $330 \Omega$ termination. If the capacitance of the 455 kHz filter is high at 10.7 MHz , the circuit will work properly as shown. However, if the capacitance of the 455 kHz filter is low, it would be advantageous to add an inductance in series with the $330 \Omega$ resistor to form a series resonant circuit with the output capacitance of the 455 kHz filter. Such a modification is shown in Figure 4.

If the inductance required is very small, it might be possible to incorporate it as an integral part of the printed wiring board.


## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS (Continued)

## F-M Detector Options

The F-M detector functions in these three integrated circuits are very similar to those of Type ULN-3889A and the same type of circuit arrangements may be used. For low-cost receivers where distortion up to $0.4 \%$ at $100 \%$ modulation can be tolerated, the single-tuned coil detector illustrated in Figure 5 is most appropriate.


Figure 5

Note that terminals 7, 8 and 9 of Type ULN2241A correspond respectively to terminals 11 , 12 and 13 for both Type ULN-2240A and Type ULN-2242A.

Types ULN-2240A and ULN-2242A require 165 mV injection level at pin 11 to insure proper mute detector operation.

Lower interstation noise levels can be obtained in applications using Type ULN-2241A by using a lower value resistor than the $220 \Omega$ I-F load resistor shown (typically $82 \Omega$ ) and thus reducing the injection level.

The double-tuned detector shown in Figure 6 provides signal distortion levels as low as $0.1 \%$. In addition, the double-tuned detector minimizes distortion as a function of tuning, when the receiver is tuned away from a strong signal.



Figure 6

Usually the primary coil is adjusted for the maximum audio output while the secondary coil is adjusted for minimum distortion. Perfect detector balance at minimum distortion is desirable; however, a signal lag caused by excess parasitic capacitance from the I-F output to ground could prevent this.

The parasitic capacitance of the A-M detector coil may effectively compensate for this signal lag or it can be eliminated by placing a small inductance ( 0.1 to $1.0 \mu \mathrm{H}$ ) in series with the $220 \Omega$ load resistor.

Any of the three signal processing systems can be used as phase-locked F-M detectors. An external, voltage-controlled oscillator signal must be applied to the F-M detector. If the audio output is used, the phase detector constant $K_{D}=$ 4.8 volts/radian. If the AFC output is used, then:

$$
K_{D}=785 \times 10^{-6} \times R_{L}
$$

$\mathrm{R}_{\mathrm{L}}$ is the value of the resistor connected to $\mathrm{V}_{\text {REG }}$.

The AFC output is preferred because the audio can then still be muted without affecting the loop operation. More detailed information can be found in a paper published by Jon P. GrosJean. See Reference 2.

## High-Performance A-M/F-M Tuner

A high-performance A-M/F-M tuner illustrated in Figure 7 uses an R-F stage controlled by the mixer bias on pin 17 . This is 1.7 V with no
input signal and 0.6 V with large input signals. The circuit also includes mute, a tuning meter, and an AFC output to the F-M tuner.


Figure 7

## PARTS LIST FOR FIGURE 7

| F1 | SFE10.7MA, F-M I-F Filter |
| :--- | :--- |
| F2 | CFZ455C, A-M I-F Filter |
| Q1 | MPS3563, F-M Converter |
| Q2 | MPSH-04, A-M R-F Amplifier |
| T1 | Ferrite Loop, $571 \mu \mathrm{H}, \mathrm{Qu}=150,17: 1$ turns ratio |
| T2 | RWO-6A7640BM, A-M Osc., $\mathrm{Qu}=50,11: 1$ turns ratio |
| T3 | RLCS-4A7893GO, A-M Det., $256 \mu \mathrm{H}, \mathrm{Qu}=75,5.4: 1$ turns ratio |
| T4 | BKAC-K3651HM, F-M Det., $\mathrm{Qu}=65$ |
| T5 | BKACS-K4551AO, F-M Input, $\mathrm{Qu}=90,7: 1$ turns ratio |

## Low-Cost Receiver Design

A simplified receiver design illustrated in Figure 8 can produce excellent performance at very low cost using Type ULN-2241A. This simple A-M/F-M system uses a Type ULN-2283B audio amplifier and a Toko CY2-22124 PT Polyvaricon type of tuning capacitor.

The A-M section tunes from 540 to 1610 kHz . The ferrite antenna T1 has an inductance of 571 $\mu \mathrm{H}$, and 6 turns on the secondary. Twenty dB quieting sensitivity is $180 \mu \mathrm{~V} / \mathrm{m}$ and the maximum signal is about $1.0 \mathrm{~V} / \mathrm{m}$. The A-M oscillator is a negative resistance type needing only an impedance greater than $1.5 \mathrm{k} \Omega$ across pins 9 and 15 to oscillate. The oscillator coil T2 has been designed for a secondary impedance of about 5 k .

In order to obtain good A-M selectivity, a low-cost ceramic I-F filter F2 and a relatively high-Q detector coil T3 are used. The tap impedance T3 is $4.7 \mathrm{k} \Omega$.

The CFZ455C filter F2 contains a tuned circuit and ceramic resonator and has sufficient input impedance for a good mixer gain. It must be loaded with $2 \mathrm{k} \Omega$. The output capacitance of 250 pF at 10.7 MHz is large enough to terminate the F-M I-F filter F1 through $330 \Omega$. A slightly better termination for $F 1$ can be produced using a small inductance $(0.88 \mu \mathrm{H})$ placed in series
with the output of $\mathbf{F}$, the 455 kHz filter. At 10.7 MHz , this inductance will form a series resonant circuit with the F2 output capacitance.

The single-tuned detector coil T4 is easily aligned by simply tuning for maximum audio output. Note that AFC has been included even though Type ULN-2241A has no AFC output pin. It is only necessary to filter the audio output at pin 5 with a $1 \mathrm{M} \Omega$ resistor and a $0.05 \mu \mathrm{~F}$ capacitor for AFC.

The F-M tuner design is relatively straightforward, except: the autodyne converter is designed so that the F-M oscillator signal does not appear across the primary of the mixer coil T5, and the oscillator coil is grounded. This circuit configuration prevents the F-M oscillator signal from coupling across T5 through F1 into the ULN-2241A (pin 1). Excessive oscillator input would cause the limiters to be driven by the oscillator producing undesirable offsets with weak signals.

Note the AGC output of Type ULN-2241A is used to drive the R-F amplifier Q1. This eliminates any problems with large signals overdriving the converter Q2. Consequently, the oscillator frequency in this tuner will not change even when the input voltage rises as high as $300,000 \mu \mathrm{~V}$.
$\left.\begin{array}{|c|l|}\hline \text { LOW-COST TUNER PERFORMANCE CHARACTERISTICS } \\ \text { (Figure 8) }\end{array}\right\}$


Figure 8

## PARTS LIST FOR FIGURE 8

D1 Siemens TA314, F-M Varactor Diode
F1 SFE10.7MA, F-M I-F Filter
CFZ455C, A-M I-F Filter
MPS3563, F-M R-F Amplifier
MPS3563, F-M Converter
T1
T2
T3
T4
T5
Ferrite Loop, $571 \mu \mathrm{H}, \mathrm{Qu}=150,17: 1$ turns ratio
RWO-6A7640BM, A-M Osc., $\mathrm{Qu}=50,11: 1$ turns ratio
RLCS-4A7893GO, A-M Det., $256 \mu \mathrm{H}, \mathrm{Qu}=75$, 5.4:1 turns ratio
BKAC-K3651HM, F-M Det., $\mathrm{Qu}=65$
BKACS-K4551AO, F-M Input, $\mathrm{Qu}=\mathbf{9 0}, 7: 1$ turns ratio

Low-Cost Automobile Radio

Automobile radios usually have two tuned R-F circuits in addition to the local oscillator. In this case Type ULN-2242A can be used in an A-M/F-M automobile radio without an A-M R-F amplifier. The R-F circuit can be doubletuned with minimal loss in sensitivity. The inductive tuning circuit is easily connected to the mixer of Type ULN-2242A as shown in Figure 9.

Note that L51 and L53 are not tapped and only the oscillator coil L55 needs a secondary winding. The $150 \mu \mathrm{H}$ coil L54 forms an inductive tap with L53 to provide a desired sensitivity and
overload level. The A-M sensitivity of the tuner with the $30 \mathrm{pF} / 30 \mathrm{pF}$ dummy antenna shown is $10 \mu \mathrm{~V}$ for $10 \mathrm{~dB}(\mathrm{~S}+\mathrm{N}) / \mathrm{N}$, and the maximum input at $80 \%$ modulation is 300 mV .

The I-F uses a ceramic filter and a singletuned high-Q detector coil. The I-F collector load resistor of $150 \Omega$ on pin 13 has been reduced from the usual $220 \Omega$ (pin 9, Figure 8) to reduce the interstation noise and to increase the limiting level for better tuning feel. An F-M tuner of the designer's choice can be added to this circuit to form a complete A-M/F-M tuner.


Figure 9

## PARTS LIST FOR FIGURE 9

F1 SFE10.7MA, F-M I-F Filter
F2 CFZ455C, A-M I-F Filter
T1 RWO-6A7640BM, A-M Osc., $\mathrm{Qu}=50,11: 1$ turns ratio
T2
RLCS-4A7893GO, A-M Det., $256 \mu \mathrm{H}, \mathrm{Qu}=75,5.4: 1$ turns ratio BKAC-K3651HM, F-M Det., $\mathrm{Qu}=65$

## LOW-COST AUTO RADIO PERFORMANCE CHARACTERISTICS <br> (Figure 9)

## A-M $\quad 10 \mathrm{~dB}(\mathrm{~S}+\mathrm{N}) / \mathrm{N}=10 \mu \mathrm{~V}$ with $30 \%$ modulation Maximum Signal $=300 \mathrm{mV}$ with $80 \%$ modulation

## Automobile Tuner With A-M R-F Stage

Improved sensitivity and excellent overload performance with the radio tuner illustrated in Figure 9 may be obtained by adding the R-F stage of Figure 10. A secondary winding has been added to L53 to couple it to the mixer of Type ULN-2241A. The emitter of the R-F stage is biased up to 0.5 V when it is turned OFF to im-
prove the overload. This condition causes the R-F stage to be turned OFF at a lower R-F level. Large signals are not rectified in the R-F stage.

This circuit will handle input signals to 1 volt into the $30 \mathrm{pF} / 30 \mathrm{pF}$ dummy antenna.


Dwg. No, A-11,325
Figure 10

## Varactor-Tuned Automobile Radio

The tuner in Figure 11 was specifically designed for a digital synthesized A-M/F-M automobile radio. A large area, low-noise JFET, Q1, provides a reasonable broad-band match to the antenna. Tuning the antenna with a varactor diode would require a capacitance change of 9 times the total of antenna, input cable, minimum diode and stray capacitance. Because Q1 has about 5 pF feedback capacitance, Q3 is added to form a cascode input.

Q2 provides the interface between the AGC of Type ULN-2242A and Q1, reducing the $\mathrm{g}_{\mathrm{m}}$ of Q1 by dropping the drain current as the signal level increases. This arrangement produces excellent large-signal and cross-modulation characteristics. L1 and R1 provide a static current discharge path for the antenna while L2 reduces interference from VHF signals.

T1, T2 and L4 form a double-tuned R-F circuit, an arrangement with several advantages over single-tuned circuits. The bandwidth is greater, especially at the low end of the band, so that receiver bandwidth is not determined by the R-F stages and image rejection is maintained. Mistracking caused by the matched tuning diodes is much less of a problem with the wider R-F bandwidth. The primary voltage of T1 increases as the receiver is tuned off a station, producing better local AGC action.

As the receiver is tuned off a strong station, the AGC supplied by Q2 is normally removed from the R-F stage Q1. Large signals applied to the diodes will cause oscillations heard as whistles when the receiver is tuned in and out of a strong station. Local AGC is therefore required, and is provided by Q4 and associated components.

Q4 is coupled to T 1 by C 2 and C3 so minimum additional capacitance is added to T 1 . The output of Q 4 is rectified by a voltage doubler and filtered to remove audio frequencies produced by the voltage doubler. This arrangement coupled with the very good AGC characteristics of Type ULN-2242A, results in a receiver with large-signal capabilities better than most conventional automobile radios.

An A-M oscillator signal of about 200 mV at pin 20 can be used to drive a synthesizer if desired. Most synthesized radios mute the audio when changing stations. Since A-M and F-M are common in Type ULN-2242A, the mute works for both. A 3 to 4 -volt signal applied to pin 8 will mute either A-M or F-M.

The A-M AGC and F-M mute signals applied to Q5 provide a stop signal for use with signalseeking receivers. The collector of Q5 goes high when a signal is reached and is limited to 6.5 V to interface with 5 V digital logic circuits.

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4. Richards, Oliver. "A Complete A-M/F-M Signal Processing System," Sprague Technical Paper TP77-6.
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Figure 11

## PARTS LIST FOR FIGURE 11

| D1-3 | Toko KV1215 or Sanyo SVC311 A-M Varactor Diode (3) |
| :--- | :--- |
| D4-7 | 1N914 or 1N4148 General Purpose Diode (4) |
| F1 | SFJ10.7MA, F-M I-F Filter |
| F2 | CFU455C, A-M I-F Filter |
| T1 | RWOS-6A7894AO, A-M R-F, $178 \mu \mathrm{H}, \mathrm{Qu}=120,10: 1$ turns ratio |
| T2 | RWOS-6A7894AO, A-M R-F, $178 \mu \mathrm{H}, \mathrm{Qu}=120,10: 1$ turns ratio |
| T3 | RWOS-6A7892AO, A-M Osc., $\mathrm{Qu}=120, \mathrm{Q1}=80,5: 1$ turns ratio |
| T4 | RLCS-4A7893GO, A-M Det., $256 \mu \mathrm{H}, \mathrm{Qu}=75,5.4: 1$ turns ratio |
| T5 | BKAC-K3651HM, F-M Det., $\mathrm{Qu}=65$ |
| Q1 | MPF820 A-M R-F Amplifier |
| Q2-5 | 2N4124 General Purpose Amplifier |

# THE ULN-2242A, <br> A COMPLETE AM/FM SIGNAL PROCESSING SYSTEM 

## Introduction

This paper describes a monolithic integrated circuit which makes possible substantial simplification of AM/FM receiver design, while at the same time improving system performance.
Prior attempts at monolithic implementation started with the quadrature detector/IF gain block which was first described by A. Bilotti in 1967.1 Other devices were developed for AM circuits which in essence attempted to combine the active elements of a descrete bipolar AM receiver. The resulting monolithic devices were capable of performance no better than the original discrete design, and with the very uneconomical displacement of three discrete transistors with one integrated circuit.
To achieve useful cost and performance objectives, a new monolithic AM/FM signal processing system ${ }^{2}$ was designed with careful attention to the total system costs and performance objectives of modern
automotive and high quality home entertainment broadcast receivers. In addition to providing state-of-the-art receiver performance, this "one-chip" receiver also provides for meter drive, interstation muting, delayed AGC (for control of external AM and FM RF stages), and simple AM/FM switching.

## Circuit Description-AM Mixer

An analog multiplier is used for the AM mixer. It substantially outperforms discrete mixers in the areas of noise and spurious response rejection. As an AM mixer this circuit provides both local oscillator and received frequency rejection. The local oscillator is suppressed by approximately 40 dB and the intermediate frequency feedthrough is down by 26 dB . Spurious response suppression is important as a receiver performance objective, and also the receiver's ability to reject undesired noise passbands. The mixer's freedom from oscillator signal in


Figure 1
the IF also reduces the outband rejection requirement for the IF selectivity elements, simplifying the use of low-cost ceramic filters. The mixer current is chosen to provide 20 mmho of gain with an acceptable output overload capability.

## The AM Detector

The AM signal is peak detected, recovering audio and a d-c voltage to control AGC. Low audio distortion of $1 \%$ is achieved by maintaining a relatively constant current and resistance load, presented by the emitter-base junction of Q82 as shown in Figure 2. The recovered audio is taken off in a balanced configuration and summed at a node to cancel stage current.

## AM AGC

AM gain control is achieved by reverse AGC of the first IF by cutting off stage current to the first IF stage. AGC to the mixer is by the same method, but with a 14 dB delay to optimize gain distribution for noise considerations, and allow a better match to the input to the mixer. Gain reduction as a function of signal level is shown in the graph of Figure 3.

## Combined AM/FM IF

Stacking of the AM and FM selectivity components allows the use of a common IF amplifier.

The IF (Figure 5) is a fully-balanced amplifier having each stage differentially coupled to the succeeding stage. In addition to providing a 6 dB per stage increase in gain over single-ended coupling, this maintains constant stage and emitter follower currents to prevent signal current from appearing in on-chip grounds or supplies. Attendant signals or noise appearing on ground or supplies will be rejected as common mode by the balanced stages.

The differential coupling approach also balances capacitive effects to minimize phase delay modulation with various signal levels. To further control AC effects and reduce device input capacitance, the first IF stage is a cascode configuration to reduce Miller effect.

In the FM configuration, the IF stages are operated as limiters and provide 76 dB of gain with a corner frequency of 36 MHz . Coupled with the detector section, the combination achieves a 3 dB limiting threshold of $15 \mu \mathrm{~V}$.


Figure 2


OWG. NO. A-10637
Figure 3


Figure 4


Figure 5

AM operation utilizes the same IF section as used for FM with a gain reduction and redistribution. To accomplish this, stage current is reduced in the second, third, and fourth IF stages. This puts 20 dB of gain in the first, and only 6 dB total in the remaining three stages, and also maintains a reasonably low input impedance to the IF.

## The FM Detector

The FM detector (Figure 6) is an analog multiplier operating in the high-level injection mode. In this mode, a multiplier provides high recovered audio with low audio distortion. Like the IF, the detector is also driven differentially. In addition, the inphase and quadrature signals are passed through the same number of stages. This assures good freedom from a-c offset, i.e. detector d-c offset caused by unequal phase delay in the two applied signals.

Recovered audio is processed through the same current mirrors, summing resistor, and output pin as was used for AM. AFC and meter information is provided open collector for use with an external load. This allows the AFC to be used with any reference voltage between $\mathrm{V}+$ and ground, and also permits adjustment of AFC gain by the choice of load resistor value.

## FM Mute and AGC Detectors

The mute and AGC provide d-c voltages for control of signal level related functions. The basic detector (Figure 7) is biased as a triple Darlington current source, with a quiescent state value of $10 \mu \mathrm{~A}$. Detector operation is accomplished by applying an a-c signal to C3 which forms a voltage doubler with the emitter-base junctions of Q61 and Q62 plus the smoothing Miller capacitors of convenient size for integration.


Figure 6


Figure 7

Signal for the mute detector is taken out of the quadrature coil to limit bandwidth and allow mute detector operation at the approximate limiting threshold of the device. The mute attenuation is obtained by cutting off the current mirrors to the audio. This achieves greater than 60 dB of attenuation with a minimum disturbance in d-c levels.

The AGC detector is basically the same as the mute detector, with the exception of the source of the a-c signal. This detector responds with a 2 mV signal input. Both detectors are biased to a no-signal value of 4.7 volts, and approach zero with increasing signal input as shown in Figure 8.

## Typical Application

Figure 9 illustrates a typical home entertainment receiver application for this new AM/FM signal processing system.

Sufficient FM IF gain is provided by the device to eliminate the need for any additional external gain besides that of the tuner. A 3 dB limiting sensitivity of about $2 \mu \mathrm{~V}$ is easily achieved.

All AM signal processing is performed within the device. The gain AGC and noise performance of the device in the AM mode is sufficient to achieve a useable sensitivity of $150 \mu \mathrm{~V} / \mathrm{m}$ while featuring an overload capability of $2 \mathrm{~V} / \mathrm{m}$ with a 15 cm ferrite antenna.

## Conclusion

Much of the original design for this new device was to define its operation as a system rather than as a simple component. To achieve the same revolutionary impact in AM/FM radio receivers as the design by A. Bilotti did for FM only, the new device required more than simple assembly of discrete components into an integrated circuit. Despite the integrated circuit's limitations on pin count and component values, the monolithic process with ion implantation is capable of fabricating superior circuit implementations such as fully-balanced mixers, multi-rate AGC systems, linear AM detectors, etc. at costs comparable to inferior circuits constructed with discrete components.


Figure 8

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS (Continued)



Figure 9

The device is most often specified in a standardized test fixture, eliminating as many variables as possible including AM antenna and FM tuner characteristics. Typical overall performance in such a fixture is illustrated in the following curves.

This new monolithic AM/FM signal processing system which has been described, provides the radio designer with a modern cost-effective approach to
the "one-chip" radio receiver without the performance tradeoffs so common with previous AM/FM integrated circuits.
(1) A. Bilotti and R. S. Pepper, A Monolithic Limiter and Balanced Discriminator for FM AND TV Receivers, National Electronics Conference, October (1967).
(2) Sprague Electric part number ULN-2242A.


Figure 10


Figure 11

# DEVELOPMENT OF HIGH-QUALITY RECEIVERS FOR A-M STEREO 

## Introduction

Almost all current designs for A-M receivers or tuners use a ferrite antenna and /or a tuned R-F stage with one or two separate tuned R-F circuits. These are basically just slight modifications of the old fivetube radio. Because of this, almost all literature written on the subject of A-M receiver design was written when large tube-type receivers were popular.

When a receiver must have an audio-frequency response greater than about 4 kHz , this arrangement is not satisfactory and a new approach is required. This does not, however, necessitate the design of new integrated circuits for the R-F and I-F portions of high-quality A-M stereo tuners. Presently available integrated circuits can be used (with minor circuit variations) to produce A-M tuners with performance that compete with that of the receiver's F-M section.

## Design Parameters

A-M stereo testing of many different types of A-M receivers indicates that receivers performing well with monophonic signals also perform well with stereophonic signals. A good criterion appears to be total harmonic distortion and audio frequency response. In addition to the usual requirements of good sensitivity, selectivity, image rejection, and the ability to handle large signals, distortion, signal-to-noise ratio, and audio fidelity are important parameters when designing A-M receivers for stereo or mono. Fortunately, if the I-F filter response can be kept symmetrical, current A-M integrated circuits will give very low distortion for a large range of signal levels. In addition, most of them have also had their gains apportioned properly so that under AGC conditions, signal-to-noise ratios are not degraded and high ultimate $S+N / N$ ratios can be reached. This eliminates some problems for the designer, but does not solve all of the possible problems.

As a guide, the following receiver parameters have been chosen: (The modulation is $30 \%$ at 1 kHz unless otherwise noted.)

1. $20 \mathrm{~dB} \mathrm{~S}+\mathrm{N} / \mathrm{N} \leq 200 \mu \mathrm{~V} / \mathrm{M}$
2. Adjacent Channel Attenuation $\geq 35 \mathrm{~dB}$
3. Image Rejection $\geq 50 \mathrm{~dB}$
4. Maximum Input Signal $1 \mathrm{~V} / \mathrm{M}$
5. THD $<0.5 \%$ and $1 \%$ at $80 \%$ Modulation
6. Maximum $\mathrm{S} / \mathrm{N} \geq 50 \mathrm{~dB}$
7. Audio Response: $20 \mathrm{~Hz}-15 \mathrm{kHz}$

Unfortunately, items 2 and 7 are incompatible with channel spacings of 10 kHz , so either a dualbandwidth I-F or poorer frequency response must be accepted.

## I-F Filters

The audio distortion and receiver selectivity are essentially determined by the I-F filter of a receiver. (Some other factors degrading the audio frequency response will be discussed under R-F circuits.) The traditional approach of using LC networks in a good quality receiver becomes very difficult because of $Q$ limitations.

As an example, consider a transitional filter with a 40 dB bandwidth of 20 kHz and center frequency of 455 kHz .

| Number of | Max. | Min. |
| :---: | :---: | :---: |
| Sections | 3 dB BW | Coil Q |
| 3 | 3.2 kHz | 211 |
| 4 | 5.0 kHz | 180 |
| 5 | 6.7 kHz | 238 |
| 6 | 8.0 kHz | 322 |
| 7 | 9.1 kHz | 411 |
| 8 | 10.5 kHz | 483 |

[^41]The maximum available coil Q is only about 140 , so it is almost imperative that the I-F filter be a ceramic filter designed specifically for that purpose. Suitable communications ceramic filters are available, but at a cost 3 to 10 times greater than that of standard I-F transformers. There is, however, a good compromise available. Reasonably priced ceramic ladder filters with zeros in their transfer function are available with the following response (Figure 1):


DWG.NO. A-11,510
Figure 1
The zeros can be selected to fall at $\pm 10 \mathrm{kHz}$ for narrow-band I-Fs, and at $\pm 20 \mathrm{kHz}$ for wide-band I-Fs. The minimum attenuation beyond the zeros of only 27 dB is too small, but this falls within a range where supplemental inductive filters can be used. This requires buffers between the coil and ceramic filters, but, as we shall see later, some integrated circuit designs easily accommodate this arrangement.

It has been found by experiment that a full 20 kHz or even 15 kHz audio response is not necessarily desirable in a high quality A-M tuner, and might even be undesirable. So much background noise and interference from other stations is present even during local daytime listening that a narrower bandwidth is more acceptable. A good compromise appears to be about 20 kHz for 3 dB bandwidth. This is degraded by other filtering in the set plus the necessary 10 kHz notch filter in the audio output to give an overall audio frequency response of about 7 to 8 kHz . In the narrow bandwidth mode for nighttime listening, the $\pm 10 \mathrm{kHz}$ attenuation must be greater than 40 dB , restricting the audio response to about 4 kHz . It should be noted that this is considerably better than the 1.6 kHz to 3 kHz audio response of current receivers.

## R-F Circuits

The R-F circuits of a high-quality A-M tuner present difficult challenges. The first occurs because the R-F stage bandwidth should not degrade the audio
frequency response. A few calculations will demonstrate the problem:

If the $\mathrm{R}-\mathrm{F}$ circuit loaded Q is 60 :

$$
\begin{aligned}
& 1400 \mathrm{kHz}-3 \mathrm{~dB} \mathrm{BW}=23 \mathrm{kHz} \text {, Audio }= \\
& 12 \mathrm{kHz} \\
& \text { At } 600 \mathrm{kHz}-3 \mathrm{~dB} \mathrm{BW}=10 \mathrm{kHz} \text {, Audio }=5 \mathrm{kHz} \\
& 600 \mathrm{kHz} \text { Image rejection }=48 \mathrm{~dB}
\end{aligned}
$$

If the Q of the ferrite antenna or $\mathrm{R}-\mathrm{F}$ tuned circuit is reduced to improve the audio response, the image rejection suffers. In the case of the ferrite antenna, the sensitivity also suffers:

$$
\begin{aligned}
& \mathrm{E}_{\mathrm{g}}=\frac{\mathrm{n} \mu \mathrm{Af}}{60} \mathrm{E} \quad \mathrm{~V}=\mathrm{QE}_{\mathrm{g}} \\
& \mathrm{~V}=\text { Voltage Across Antenna Circuit } \\
& \mathrm{n}=\text { Number of Turns } \\
& \mu=\text { Antenna Permeability } \\
& \mathrm{A}=\text { Antenna Cross Sectional Area } \\
& \mathrm{f}=\text { Received Frequency } \\
& \mathrm{Q}=\text { Antenna } \mathrm{Q} \\
& \mathrm{E}=\text { Electric Field Strength } \\
& \mathrm{E}_{\mathrm{g}}=\text { Induced Voltage }
\end{aligned}
$$

This situation can be improved by using a large loop of a few turns of wire. In this case, the formula is the same with $\mu$ being replaced with $\mu_{o}$. This antenna must, however, be very large in crosssectional area (typically $1 \mathrm{~m}^{2}$ ) before it is effective. It is also directional.

The only other alternative is the old-fashioned wire antenna which turns out to be much better in terms of signal reception. For this type:

$$
\mathrm{E}_{\mathrm{g}}=\frac{\ell}{2} \mathrm{E} \quad \mathrm{~V}=\mathrm{QE}_{\mathrm{g}}
$$

$$
\ell=\text { Antenna Length }
$$

Now, the received signal can be increased to offset reduced Q simply by making the wire longer.

This still leaves the problem of how to deal with the loss in image rejection when the $R$ - $F$ circuit $Q$ is reduced. The most obvious solution is to use a double-tuned R-F circuit. This can be manipulated to have constant bandwidth with different center frequencies so almost any desired result (without severe loss in image rejection) can be obtained. Additionally, the wider R-F bandwidth reduces tracking problems which are not usually serious for A-M mono signals, but which will cause problems with A-M stereo signals because of the group delay variations they produce.

This leaves two possibilities for antenna input circuits:

1. Couple the antenna directly to the double-tuned circuit and suffer a 6 dB insertion loss.
2. Use an untuned FET input and put the doubletuned circuit between the FET and the mixer.
Option 2 also eliminates the need for an antenna trimming capacitor. This can be a significant cost savings in automobile receivers. In both cases, however, the $Q$ of the antenna circuit will be quite low at the low end of the A-M band, and the receiver will have somewhat poor I-F rejection. This can easily be solved by using an integrated circuit with a doublebalanced mixer.

## Receiver Designs

Illustrations of two high quality A-M tuned designs which use currently available parts are shown in Figures 2 and 3.

Both achieve the following performance levels.

$$
20 \mathrm{~dB} \frac{\mathrm{~S}+\mathrm{N}}{\mathrm{~N}} 100 \mu \mathrm{~V} / \mathrm{m}
$$

(depends on antenna length)
Image Rejection $=55 \mathrm{~dB}$
-3 dB audio frequency response from 550 to 1600 kHz :
wide -7.5 kHz
narrow -4 kHz
THD $<0.5 \%$ at $30 \%$ modulation
Maximum signal level $>1 \mathrm{~V} / \mathrm{m}$
Max signal-to-noise at $30 \%$ modulation $=47$ to 50 dB
The first design shown in Figure 2 uses a combination A-M/F-M integrated circuit (1) with a balanced mixer for A-M. A junction FET must be used for the R-F stage to obtain a reasonable sensitivity (MOSFETs are very noisy at these low frequencies), but since it has a high feedback capacitance, a transistor is also used to form a cascode stage. AGC is derived from the IC and is used to reduce the current of the R-F stage. Since the IC has enough gain, the R-F stage gain can be kept low to reduce overloading. The ceramic filters in the IF stage are separated by low-cost buffer transistor stages which also perform the bandwidth switching. Added to the ceramic filters are double-tuned input (pin 14) and output coils (pin 1) to suppress the spurious responses of the filters.

The audio output terminal (pin 4) includes a 10 kHz notch filter and a 15 kHz low-pass filter to reduce unwanted noise in wideband operation. Note the simplicity of the double-tuned R-F filter. The two coils are identical and a mutual coupling capacitor is used to give greater coupling at low frequencies.

The second tuner shown in Figure 3 uses a very popular A-M-only integrated circuit (2). This IC, while not having a balanced mixer, has a separate I-F stage perfectly suited to driving the ceramic I-F filter. The R-F stage is slightly different here but retains the double-tuned interstage filter. The required R-F gain is higher because of the lower overall gain of the IC.

Instead of two double-tuned I-F filters, a 3-section filter is used and transistors are again used for bandwidth switching. The lowpass and notch filters are also retained in the audio output.

## Conclusion

It has been shown that high-quality A-M tuners using existing monolithic integrated circuits can be designed and their cost is reasonable. They are suitable for driving A-M stereo decoders and should produce very good A-M mono or stereo results. In the case of the first tuner, the 455 kHz signal to the decoder can be taken from the last I-F collector, or from a secondary winding on the detector coil. A 455 kHz signal of high-enough level is somewhat harder to obtain from the second tuner. The easiest approach appears to be to amplify the approximately 5 mV detector input signal. The internal detector then serves to generate AGC signals.

The advent of A-M stereo may hopefully serve as a catalyst for the re-development of good A-M tuners which died out when the 'all-American'' five-tube table radio was first introduced.

## References

(1) Sprague Type ULN2240, $41,42 \mathrm{~A}$, or TDA1090.
(2) Sprague Type ULN2249A or HA1 199


Figure 2


Figure 3


> GENERAL INFORMATION

HIGH-VOLTAGE INTERFACE DRIVERS

HIGH-CURRENT INTERFACE DRIVERS

BIMOS AND COMPLEX ARRAY INTERFACE DRIVERS

MILITARY AND AEROSPACE DEVICES

RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

VIDEO AND TELEVISION INTEGRATED CIRCUITS

> AUDIO POWER AMPLIFIERS

## HALL EFFECT DEVICES

TRANSISTOR ARRAYS AND MISCELLANEOUS DEVICES

## CUSTOM DEVICES




## SECTION 7-VIDEO AND TELEVISION INTEGRATED CIRCUITS

Selection Guide ..... $7-2$
ULN-2260A AGC Control, Sync Separator, and Scan Processor ..... 7-3
ULN-2270B and 2270Q (TDA1170) Vertical Deflection System ..... 7-6
ULN-2290B (TDA3190) and 2290Q (TDA1190Z) 4-Watt TV Sound Channel ..... 7-12
See Also:
ULN-3702Z as Vertical Output Driver ..... 8-22
Application Note:
ULN-2260A Signal, Sync, and Scan Processor ..... $7-19$

## SELECTION GUIDE TO VIDEO AND TELEVISION INTEGRATED CIRCUITS

| Device Type | Chroma | Luma | Sound | Sync | Defl. |
| :--- | :---: | :---: | :---: | :---: | :---: |
| ULN-2260A | - | - | - | $X$ | - |
| ULN-2270B/Q | - | - | - | - | $X$ |
| ULN-2290B/Q | - | - | $X$ | - | - |
| ULN-3702Z* | - | - | $X$ | - | $X$ |

NOTE: Additional devices for use as sound channels may be found in Section 6. Audio amplifiers are described in Section 8.
*See page 8-22.

## ULN-2260A AGC CONTROL, SYNC SEPARATOR, AND SCAN PROCESSOR

## FEATURES

- Excellent AGC Noise Immunity
- High Output Sync Level
- Balanced Phase Detector
- Stable Master Oscillator
- 16-Pin Dual-In-Line Plastic Package

T[ELEVISION-CIRCUIT SIMPLIFICATION and high performance are primary advantages of designs using Type ULN-2260A. NTSC or PAL television receivers, color or monochrome, with countdown or conventional synchronization, can be flexibly and efficiently partitioned through use of this device.

The AGC detector of Type ULN-2260A employs a coincidence gate approach that minimizes noise effects. The circuit maintains constant AGC levels despite temporary losses of synchronization and temporary horizontal timing disturbances. The AGC-synchronization loop has both the high gain and high slew rate needed for fast channel-to-channel gain equalization and reduction of airplane flutter. Both forward and reverse delayed AGC currents are developed.


The sync separator uses an external passive network. The designer chooses the sampling level and time constants. The 10 Vpp output is short-circuit limited at approximately 25 mA .

The phase detector of Type ULN-2260A compares the sync separator's output to the integrated horizontal flyback pulse. Its output is a voltage proportional to the phasing error. Static phase error attributable to detector imbalance is minimized.

The designer is able to define the free-running frequency, control sensitivity and temperature compensation of the integrated circuit's oscillator. A wide range of frequencies can be generated, accomodating any of several TV or video display terminal deflection systems.

## TYPICAL APPLICATION




DWG. NO. A-11,221



SCHEMATIC
ULN-2260A AGC CONTROL,
SYNC SEPARATOR, AND SCAN PROCESSOR

## ULN-2270B AND ULN-2270Q/TDA 1170 VERTICAL DEFLECTION SYSTEMS

## FEATURES

- Internal Reference
- Positive or Negative Sync Input
- Vertical Ramp Generator
- Vertical Driver
- Flyback Generator
- Single-Supply Operation


AS A SINGLE DEVICE containing a vertical oscillator, a flyback generator and a power amplifier, this vertical deflection system can greatly simplify design of black-and-white and small-screen color television receivers.

The oscillator of Types ULN-2270B and ULN2270Q is directly synchronized by positive or negative sync pulses. A current feedback loop makes yoke current independent of yoke resistance changes caused by operating temperature variations. The flyback generator develops the high voltage required by the yoke for short flyback time and high efficiency.
Type ULN-2270B is supplied in a 16 -pin dual in-line plastic package with heat sink contact tabs. Its copper alloy lead frame gives enhanced power dissipation ratings with standard cooling methods. Greater package power dissipation is available with attachment of an external heat sink to the webbed center leads of the device. The lead configuration makes possible easy attachment of a heat sink and
use of a standard integrated circuit socket or printed wiring board layout.
Type ULN-2270Q/TDA1170 is supplied in a 16 -pin quad in-line plastic package. It uses the printed wiring board on which it is mounted as a heat sink. Small heat sinks can also be attached to the center tabs of the device. The device carries the Sprague Electric Company part number (ULN2270Q) unless the Pro-Electron marking (TDA1170) is requested.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 27 V |
| :---: | :---: |
| Peak Flyback Voltage, $V_{6}-V_{7}$ | 58 V |
| Sync Input Voltage, $V_{10}$ | $\pm 12 \mathrm{~V}$ |
| Amp. Input Voltage Range, $V_{14}$ | -0.5 V to +10 V |
| Peak Output Current, $\mathrm{I}_{6}(50 \mathrm{~Hz}, \leq 10 \mathrm{\mu s})$ | 2.5 A |
| ( $50 \mathrm{~Hz},>10 \mu \mathrm{~S}$ ) | 1.5 A |
| (non-repetitive, 2 ms ) | 2.0 A |
| Package Power Dissipation, $\mathrm{P}_{0}$ | Graph |
| Junction Temperature Range, T , | C to $+150^{\circ} \mathrm{C}$ |

Peak Flyback Voltage, $V_{6}-V_{7} \ldots \ldots . . . . . . . . . . . . . . . . . . . . .58 \mathrm{~V}$
Sync Input Voltage, $\mathrm{V}_{10} \ldots \ldots . . . . . . . . . . . . . . . . . .$.
Amp. Input Voltage Range, $\mathrm{V}_{14} \ldots \ldots \ldots .-0.5 \mathrm{~V}$ to +10 V
Peak Output Current, $\mathrm{I}_{6}(50 \mathrm{~Hz}, \leq 10 \mu \mathrm{~s}) \ldots . . . . . . .2 .2 .5 \mathrm{~A}$
$(50 \mathrm{~Hz},>10 \mu \mathrm{~s}) \ldots \ldots . \ldots . .1 .5 \mathrm{~A}$
(non-repetitive, 2 ms ) $\ldots \ldots . .2 .2 .0 \mathrm{~A}$
Junction Temperature Range, $\mathrm{T}_{\mathrm{J}} \ldots \ldots . . .-40^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

For increased power-handling capability, these devices can be ordered in a 12-lead single in-line power-tab package by changing the part-number suffix from ' B ' or ' Q ' to ' W '.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=25 \mathrm{~V}, \mathbf{f}=50 \mathrm{~Hz}$ (unless otherwise specified)

| Characteristic | Test <br> Pin | Test <br> Fig. | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| Operating Supply Voltage Range | 2 |  |  | 10 | - | 27 | V |
| Sync Input Voltage | 10 | 3 | Positive or. negative | 1.0 | - | - | $V_{p}$ |
| Sync Input Resistance | 10 | 3 | $\mathrm{V}_{10}=1.0 \mathrm{~V}$ | - | 3.5 | - | $k \Omega$ |
| Oscillator Bias Current | 11 | 1 |  | - | 0.2 | 1.0 | $\mu \mathrm{A}$ |
| Oscillator Voltage | 11 | 3 |  | - | 2.4 | - | $V_{p p}$ |
| Oscillator Pull-In Range | 10-11 | 3 | Below 50 Hz | - | 7.0 | - | Hz |
| Oscillator Frequency Drift | 11 | 3 | $\mathrm{V}_{\text {cc }}=10 \mathrm{~V}$ to 27 V | - | 0.01 | - | $\mathrm{Hz} / \mathrm{V}$ |
|  |  |  | $\mathrm{T}_{\text {TAB }}=40^{\circ} \mathrm{C}$ to $120^{\circ} \mathrm{C}$ | - | 0.015 | - | $\mathrm{Hz} /{ }^{\circ} \mathrm{C}$ |
| Ramp Generator Bias Current | 16 | 1 |  | - | 50 | 500 | nA |
| Amplifier Input Current | 14 | 2 |  | - | 0.15 | 1.0 | $\mu \mathrm{A}$ |
| Quiescent Output Voltage | 6 | 1 | $\mathrm{V}_{\text {cc }}=10 \mathrm{~V}, \mathrm{R}_{2}=10 \mathrm{k} \Omega$ | 4.0 | 4.4 | 4.8 | V |
|  |  |  | $\mathrm{V}_{\text {cc }}=25 \mathrm{~V}, \mathrm{R}_{2}=30 \mathrm{k} \Omega$ | 8.0 | 8.8 | 9.6 | V |
| Flyback Voltage |  | 3 | $\mathrm{I}_{\text {YOKE }}=1.0 \mathrm{~A}$ | - | 51 | - | V |
| Flyback Time |  | 3 | $\mathrm{I}_{\text {YOKE }}=1.0 \mathrm{~A}$ | - | 0.6 | 0.8 | ms |
| Yoke Current |  | 3 |  | - | - | 1.6 | $\mathrm{A}_{\mathrm{pp}}$ |
| Regulator Voltage | 8 or 9 | 2 |  | 6.0 | 6.5 | 7.0 | V |
| Line Regulation | 8 or 9 | 2 | $\mathrm{V}_{\mathrm{cc}}=10 \mathrm{~V}$ to 27 V | - | 1.5 | - | $\mathrm{mV} / \mathrm{V}$ |
| Supply Current |  |  | $\mathrm{I}_{\text {YOKE }}=1.0 \mathrm{~A}$ | - | 140 | - | mA |

NOTE: Pin numbering shown is in accordance with U.S. (JEDEC) practice where all positions are numbered (1 thru 16). European (Pro-Electron) practice is to skip the tab positions.

```
5
Pro-Electron 1 1 2 3 TAB TAB 4 5 5 6 7 7 8 9
```

ALLOWABLE POWER DISSIPATION
AS A FUNCTION OF AMBIENT TEMPERATURE


## TEST FIGURES



Figure 1


Figure 2


Figure 3

## TYPICAL APPLICATION IN LARGE-SCREEN BLACK-AND-WHITE TV

| Supply Current, $\mathrm{I}_{\text {cc }}$ | 140 mA |
| :---: | :---: |
| Flyback Time | 0.75 ms |
| Yoke Current, $I_{\text {Yoke }}$ | $1.2 \mathrm{~A}_{\mathrm{pp}}$ |
| Operating Supply Voltage Range, $\mathrm{V}_{\mathrm{cc}}$ | 20 V to 24 V |
| Package Power Dissipation, $\mathrm{P}_{0}$ | 2.2 W |



Flyback Time $\approx \frac{2 \mathrm{~L}_{\mathrm{YOKE}} I_{\mathrm{YOKE}}}{3 \mathrm{~V}_{\mathrm{CC}}}$
$\mathrm{I}_{\mathrm{CC}} \approx \frac{\mathrm{I}_{\mathrm{YOKE}}}{8}+0.02$
$V_{6} \approx V_{14} \frac{R_{1}+R_{2}}{R_{1}}$

Where:
Flyback Time is in seconds;
$\mathrm{L}_{\text {YOKE }}$ is in henries;
$\mathrm{I}_{\text {Yoke }}$ is the peak-to-peak current in amperes;
$\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{6}$ are in volts;
$I_{C C}$ is in amperes;
$\mathrm{V}_{14}$ is approximately 2.0 V .

## TYPICAL APPLICATION IN SMALL-SCREEN BLACK-AND-WHITE TV

Supply Current, Icc ..... 150 mA
Flyback Time ..... 0.7 ms
Yoke Current, I Iooke ..... $1.15 \mathrm{~A}_{\mathrm{po}}$
Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ ..... 1.3 W


$$
\text { Flyback Time } \approx \frac{2 \mathrm{~L}_{\mathrm{YOKE}} \mathrm{I}_{\mathrm{YOKE}}}{3 \mathrm{~V}_{\mathrm{CC}}}
$$

$$
\mathrm{I}_{\mathrm{CC}} \approx \frac{\mathrm{I}_{\mathrm{YOKE}}}{8}+0.02
$$

$$
V_{6} \approx V_{14} \frac{R_{1}+R_{2}}{R_{1}}
$$

Where:
Flyback Time is in seconds;
$\mathrm{L}_{\text {YOKE }}$ is in henries;
$\mathrm{I}_{\text {YOKE }}$ is the peak-to-peak current in amperes;
$\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{6}$ are in volts;
$\mathrm{I}_{\mathrm{CC}}$ is in amperes;
$\mathrm{V}_{14}$ is approximately 2.0 V .

## CIRCUIT SCHEMATIC



FUNCTIONAL BLOCK DIAGRAM


# ULN-2290B AND ULN-2290Q <br> (TDA3190 AND TDA1 190Z) 4-WATT TV SOUND CHANNELS 

## FEATURES

- High Sensitivity
- High A-M Rejection
- D-C Volume Control
- High Power Output
- Low Distortion
- Wide Operating Voltage Range ( 9 to 28 V )
- Low Quiescent Current Drain

CAPABLE OF CARRYING OUT all of the functions of a TV sound channel, the ULN-2290 silicon monolithic integrated circuit consists of a six-stage I-F amplifier/limiter, low-pass filter, differential peak detector, d-c volume control, regulated power supply, audio preamplifier and output stage.

The audio power amplifier will deliver 4 W of low-distortion audio to a $16 \Omega$ load with a supply of 24 V . When used with a 12 V supply, such as is found in many portable TV sets, these ICs will furnish 1.5 W to an $8 \Omega$ loud speaker.

This TV sound channel is available in either of two package configurations. Type ULN-2290Q is supplied in a quad in-line plastic package with a copper lead frame. This device is designed to use the printed wiring board on which it is mounted for heat dissipation and is identical to European Type TDA1190Z. It is marked with its Pro-Electron registration unless otherwise specified on production orders.


Type ULN-2290B is furnished in an improved 16-lead plastic dual in-line package with heat-sink contact tabs. The webbed lead configuration, originated by Sprague Electric, allows an inexpensive heat sink to be easily attached for increased power dissipation capability and yet permits the use of a standard IC socket or printed wiring board hole layout. This device is identical to European Type TDA3190.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\text {cc }} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots .+28 \mathrm{~F}$
Repetitive Peak Output Current, Iout $\ldots \ldots . . . . . . . . . . .1 .5 \mathrm{~A}$
Package Power Dissipation, $P_{D} \ldots \ldots \ldots \ldots$.............. See Graph
Junction Temperature Range, $\mathrm{T}_{\mathrm{J}} \ldots \ldots . . .-40^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{0}=4.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 7.5 \mathrm{kHz}$,
$V_{\text {cc }}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {in }}=1 \mathrm{mV}$ (unless otherwise specified)

| Characteristic | Symbol | Test Pin | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Quiescent Output Voltage | $V_{\text {our }}$ | 11 | $V_{\text {in }}=0$ | 5.1 | 6.0 | 6.9 | V |
| Quiescent Supply Current | $\mathrm{T}_{\text {co }}$ | 14 | $\mathrm{R}_{\mathrm{x}}=22 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{in}}=0$ | - | 19 | 33 | mA |
| Input Limiting Threshold | $V_{\text {TH }}$ | 1 | $\mathrm{R}_{\mathrm{x}}=0$ | - | 40 | 100 | $\mu \mathrm{V}$ |
| A-M Rejection | AMR |  | $\mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}, \mathrm{m}=0.3$ | 40 | 55 | - | dB |
| Signal-to-Noise Ratio | $\mathrm{S}+\mathrm{N} / \mathrm{N}$ |  | $\mathrm{P}_{\text {out }}=0.5 \mathrm{~W}, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}$ | 50 | 65 | - | dB |
| Recovered Audio | $V_{\text {out }}$ | 16 | $\mathrm{R}_{\mathrm{x}}=0$ | - | 120 | - | mV |
| Output Distortion | THD | 11 | $\mathrm{P}_{\text {out }}=50 \mathrm{~mW}$ | - | 1.0 | - | \% |
| Output Power | $\mathrm{P}_{\text {out }}$ | 11 | THD $=2 \%, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}$ | - | 1.4 | - | W |
|  |  |  | THD $=10 \%, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}$ | - | 1.5 | - | W |
| Power Supply Rejection | PSR |  | $f=120 \mathrm{~Hz}, \mathrm{R}_{\mathrm{x}}=22 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 46 | - | dB |
| Input Resistance | $\mathrm{R}_{\text {in }}$ | 1 |  | - | 30 | - | $\mathrm{k} \Omega$ |
| Input Capacitance | $\mathrm{C}_{\text {in }}$ | 1 |  | - | 5.0 | - | pF |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{o}}=4.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 7.5 \mathrm{kHz}, \mathrm{V}_{\mathrm{CC}}=24 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=16 \Omega$, $V_{\text {in }}=1 \mathrm{mV}$ (unless otherwise specified). Heat Sinking is Required

| Characteristic | Symbol | $\begin{aligned} & \text { Test } \\ & \text { Pin } \\ & \hline \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Quiescent Output Voltage | $V_{\text {our }}$ | 11 | $V_{\text {in }}=0$ | 11 | 12 | 13 | V |
| Quiescent Supply Current | lca | 14 | $\mathrm{R}_{\mathrm{x}}=22 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{in}}=0$ | 11 | 22 | 35 | mA |
| Input Limiting Threshold | $V_{\text {IH }}$ | 1 | $\mathrm{R}_{\mathrm{x}}=0$ | - | 40 | 100 | $\mu \mathrm{V}$ |
| A-M Rejection | AMR |  | $\mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}, \mathrm{m}=0.3$ | 40 | 55 | - | dB |
| Signal-to-Noise Ratio | S $+\mathrm{N} / \mathrm{N}$ |  | $\mathrm{P}_{\text {our }}=1.0 \mathrm{~W}, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}$ | 50 | 65 | - | dB |
| Recovered Audio | $V_{\text {out }}$ | 16 | $\mathrm{R}_{\mathrm{x}}=0$ | - | 120 | - | mV |
| Output Distortion | THD | 11 | $\mathrm{P}_{\text {our }}=50 \mathrm{~mW}$ | - | 0.75 | - | \% |
| Output Power | $\mathrm{P}_{\text {our }}$ | 11 | THD $=2 \%, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}$ | - | 3.5 | - | W |
|  |  |  | THD $=10 \%, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}$ | - | 4.2 | - | W |
| Power Supply Rejection | PSR |  | $\mathrm{f}=120 \mathrm{~Hz}, \mathrm{R}_{\mathrm{x}}=22 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 46 | - | dB |
| Input Resistance | $\mathrm{R}_{\text {in }}$ | 1 |  | - | 30 | - | k $\Omega$ |
| Input Capacitance | $\mathrm{C}_{\text {in }}$ | 1 |  | - | 5.0 | - | pF |

## TEST CIRCUIT



## TYPICAL APPLICATION <br> (Heat Sink Required)



NOTE: Pin numbering shown is in accordance with U.S. (JEDEC) practice where all positions are numbered ( 1 thru 16). European (Pro-Electron) practice is to skip the tab positions.

| JEDEC | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 |
| :--- | :--- | :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Pro-Electron | 1 | 2 | 3 | TAB TAB | 4 | 5 | 6 | 7 | 8 | 9 | TAB | TAB | 10 | 11 | 12 |  |

## ALLOWABLE POWER DISSIPATION AS A FUNCTION OF AMBIENT TEMPERATURE



## TYPICAL CHARACTERISTICS

at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{0}=4.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{m}}=400 \mathrm{~Hz}, \mathrm{f}_{\mathrm{d}}= \pm 25 \mathrm{kHz}, \mathrm{V}_{\text {in }}=1 \mathrm{mV}$ (unless otherwise shown)

## AUDIO OUTPUT and NOISE

 AS A FUNCTION OF INPUT VOLTAGE

SOUND CHANNEL OUTPUT AS A FUNCTION OF MODULATING FREQUENCY


A-M REJECTION
AS A FUNCTION OF INPUT VOLTAGE


A-M REJECTION AS A FUNCTION OF TUNING ERROR


## TYPICAL CHARACTERISTICS (Continued)

AUDIO AMPLIFIER OUTPUT AS A FUNCTION OF FREQUENCY


DISTORTION
AS A FUNCTION OF TUNING ERROR


ATTENUATION
AS FUNCTION OF RESISTANCE


DISTORTION AS A FUNCTION OF FREQUENCY DEVIATION


## TYPICAL CHARACTERISTICS (Continued)

DISTORTION
AS A FUNCTION OF OUTPUT POWER


OUTPUT POWER
AS A FUNCTION OF SUPPLY VOLTAGE


DISSIPATION and EFFICIENCY AS FUNCTIONS OF OUTPUT POWER


DISSIPATION AS A FUNCTION OF SUPPLY VOLTAGE



SCHEMATIC

# THE ULN-2260A SIGNAL, SYNC, AND SCAN PROCESSOR 

## Introduction

The monolithic integrated circuit provides high performance by careful selection of circuit techniques, and efficient partitioning of the AGC, sync separator, and master-scan phase-locked loop.

This grouping of circuit functions is particularly efficient. Since the video input is common to both AGC and sync separator, the separated sync can be internally coupled to the phase detector of the scan phase-locked loop; the flyback waveform is required for AGC gating and the phase detector.


DWG.NO. A-11, 484
Figure 1
RECEIVER PARTITIONING


DWG.NO. A-11,485
Figure 2

AGC
When the scan is synchronized, current is supplied to the AGC detector (comparator) during the separated sync. The negative-going sync video waveform at pin 1 is compared with a 4.0 V level during this time. As a result of the AGC loop, the tip of the sync is clamped to 4.0 V .


Figure 3 AGC DETECTOR

The AGC detector is a high gain comparator with an asymetrical active load (Figures 3 and 4). The active load provides approximately 3.2 mA of primary filter capacitor charge current and 1.0 mA of discharge current.


Figure 4
AGC DETECTOR CHARACTERISTICS

## VIDEO AND TELEVISION INTEGRATED CIRCUITS (Continued)

The high AGC-loop gain provides the high slew rate necessary for fast channel-to-channel gain equalization and response to airplane flutter variations.

The AGC detector is gated ON by a pulse defined by coincidence of horizontal flyback and sync. Coincidence-gating provides improved AGC noise immunity over systems only are flyback-gated. Coincidence-gating maintains AGC levels in the event of temporary loss of horizontal sync or disturbance of horizontal timing.

Coincidence-gating demands the use of two additional internal circuits to compensate for two extremes of video input level at pin 1. The first is a sync recovery system (Figure 5).


Figure 5
SYNC RECOVERY SYSTEM
Extremes occur in the transition from a strong to a weak signal. The AGC loop requires time to respond to new signal level. In the meantime, system gain is too low, and the video amplitude at pin 1 is too low for the sync separator to provide sync pulses for coincidence-gating. The resulting condition would be lockout of the signal. However, a threshold detector composed of $Q_{35}$ and $Q_{36}$ senses sync-separator (pin 2) voltages less than 3.8 V . When this occurs, the AGC detector is gated by flyback only, allowing the AGC system to respond to the new signal level. As the video amplitude at pin 1 increases to its nominal value, the AGC detector returns to the coincidence-gating mode.

The second extreme of video input level occurs in the transition from a weak to a strong signal. In the transition, the I-F amplifier overloads, resulting in a low d-c level at pin 1, Figure 6. The sync separator at pin 2 charges to a higher d-c level, and no sync pulses are generated for coincidence-gating. Lockout of the signal is again possible, being dependent on both AGC-loop response and sync-separator time constants.


The threshold detector, $\mathrm{Q}_{6}$ and $\mathrm{Q}_{4}$, senses when the d-c level at pin 1 is below 3.4 V . When this occurs, the AGC detector is gated by flyback only, allowing the AGC system to respond to the new signal level. As the video level at pin 1 decreases to its nominal value, the AGC detector returns to the coincidence-gating mode.

The AGC primary filter at pin 15 integrates the AGC-detector output into a d-c voltage, which drives the AGC control circuit. A low d-c level at pin 15 corresponds to a low received-signal level. Conversely, a high d-c level at pin 15 corresponds to a high received-signal level.

Figure 7 is a simplification of the I-F portion of the AGC control circuit. As is common practice, the I-F amplifier is gain-reduced prior to the tuner under increasing signal levels.


Figure 7
I-F AGC CONTROL CIRCUIT

The maximum-gain voltage of the AGC primary filter is defined by the circuit designer as

$$
\mathrm{V}_{14}-0.7 \mathrm{~V}
$$

since this level is internally clamped by $\mathrm{Q}_{18}$. Under gain reduction, $\mathrm{Q}_{16}$ and $\mathrm{Q}_{17}$ force the voltage at pin 14 to follow 1.4 V below the primary filter voltage.

Produced by a series of emitter-followers, the I-F AGC output has a gain of 1 , referenced to the AGC primary filter.

Choice of the external voltage-divider level, $\mathrm{V}_{\mathrm{x}}$, at pin 13 (I-F AGC output) defines the maximum I-F gain-reduction level, or AGC delay point, at which the tuner is called upon for further gain reduction. As there is a finite dead zone in the cross-over between I-F AGC and tuner AGC, a capacitor between pin 14 (a buffered primary AGC filter a-c voltage source) and pin 13 will decrease AGC recovery time in the transition between I-F and tuner AGC.

At the maximum I-F AGC level, $\mathrm{V}_{\mathrm{x}}$, the values of resistors $\mathrm{R}_{27}$ and $\mathrm{R}_{30}$ are such that the voltage at the base of $\mathrm{Q}_{27}$ is 1.4 V (Figure 8). This defines the point at which tuner AGC action is initiated. The collector current of $\mathrm{Q}_{27}$ is mirrored to provide forward-tuner AGC with a trans-conductance gain of $2.1 \mathrm{~mA} / \mathrm{V}$, referenced to the AGC primary filter. The emitter current of $\mathrm{Q}_{27}$ is mirrored to provide reverse-tuner AGC with a gain of $3.1 \mathrm{~mA} / \mathrm{V}$.


Figure 8 TUNER CONTROL CIRCUIT

Sync Separator
Since $Q_{4}$, (Figure 6), clamps the video waveform to 0.5 V below the level of the sync tip, noise accompanying the incoming video, is prevented from severely altering the sampling level of the sync separator.

The negative-going sync video waveform at pin 1 is inverted and amplified by 6 dB . This waveform is
buffered and applied to the base of $\mathrm{Q}_{33}$, which has as its emitter load a dual time-constant sync-separator network (Figure 9). Since this network is external to the device, the circuit designer has freedom to choose the sampling level and sync-separator time constants.


Figure 9

## SINGLE PIN SYNC SEPARATOR

The separated sync-voltage waveform at the collector of $Q_{33}$ is clamped to 7.3 V by $Q_{38}$, and is amplified by approximately 20 dB (Figure 10). Complementary emitter-followers buffering the sync waveform have an amplitude of $10 \mathrm{~V}_{\mathrm{PP}}$. The sync output is provided at pin 3 , protected by shortcircuit current-limiting of approximately 25 mA . It is internally coupled to the scan-phase detector. In addition to protecting the device against accidental shorts, grounding pin 3 also provides a convenient method of adjusting the oscillator's free-run frequency.


Figure 10
SYNC OUTPUT CIRCUIT

## Scan Processing

The scan-phase detector consists of a differential amplifier that is gated ON by separated sync. An integrated flyback waveform is applied to the input of the differential amplifier (Figure 11). The differential amplifier has an active load, providing singleended output of the phase-detector currents.


Figure 11
PHASE DETECTOR CIRCUIT
The positive and negative-output currents $(500 \mu \mathrm{~A})$ of the phase detector are internally balanced to within approximately $5 \%$ of the absolute value of these currents. This limits the static phaseerror attributable to phase-detector imbalance. Since the phase-detector output filter is external to the device, pull-in characteristics can be defined by the choice of external filter components at pin 10.

A simplification of the master-scan VCO of Type ULN-2260A is shown in Figure 12. The VCO is designed to minimize the effects of device parameter variations on free-run frequency and VCO characteristics. Components defining phase-shift and filter


Figure 12
MASTER SCAN VCO
functions are external to the device. This provides the circuit designer with freedom to define the characteristics of the oscillator: Free-run frequency, control sensitivity and temperature compensation. Control of free-run frequency allows operation of the circuit in both countdown-synchronized and conventionally synchronized receivers.

The oscillator is controlled by weighted summing of quadrature components of feedback-signal current. The quadrature is inherently defined by the external resistor and capacitor of the tank circuit at the input of each of the two differential amplifiers. These external components are series connected. Therefore, the capacitor voltage waveform lags that of the resistor by $90^{\circ}$. VCO characteristics for a $503.5-\mathrm{KHz} \mathrm{L-C}$ oscillator, vertical countdown receiver, are shown in Figure 13.


Figure 13
VCO CHARACTERISTICS

Because it is a low-impedance source-point, pin 8 is internally short-circuit current-limited to approximately 70 mA .

## Conclusions

The device presented above was designed to provide, with as much flexibility as possible, efficient partitioning of AGC, sync, and scan-control functions. Coincidence AGC-gating was utilized to improve AGC noise immunity. The circuit provides a high-level separated-sync output for sync integrators. The scan-phase detector is accurately balanced internally. The scan VCO was chosen to minimize the effects of device-parameter variations on oscillator characteristics, and is adaptable to both countdown-synchronized and conventionally synchronized receivers.

## GENERAL INFORMATION

## HIGH-VOLTAGE INTERFACE DRIVERS

HIGH-CURRENT INTERFACE DRIVERS

BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS

## MILITARY AND AEROSPACE DEVICES

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

## VIDEO AND TELEVISION INTEGRATED CIRCUITS

## AUDIO POWER AMPLIFIERS

| HALL EFFECT DEVICES |  |
| :--- | :--- |
| TRANSISTOR ARRAYS AND MISCELLANEOUS DEVICES | 0 |

CUSTOM DEVICES



## SECTION 8-AUDIO POWER AMPLIFIERS

Selection Guide ..... 8-2
ULN-2280B 2.5-Watt Audio Power Amplifier ..... 8-3
ULN-2283B Low-Power Audio Amplifier ..... 8-9
ULN-37012 (TDA2002) 5 to 10-Watt Audio Power Amplifier ..... 8-17
ULN-3702Z (TDA2008) 12-Watt Audio Power Amplifier ..... 8-22
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ULN-3705M Low-Voltage Audio Power Amplifier ..... 8-28
ULN-3783M Dual Low-Voltage Audio Power Amplifier .....
ULN-3784B 4-Watt Audio Power Amplifier ..... 8-35
ULN-3793W 20-Watt Audio Power Amplifier ..... *
*New product. Contact factory for detailed information.

SELECTION GUIDE TO AUDIO POWER AMPLIFIERS

| Device Type | Monophonic | Stereo | $P_{\text {out }}$ | $\mathrm{V}_{\text {cc }}$ |
| :--- | :---: | :---: | :---: | :---: |
| ULN-2280B | X | - | 2.5 W | $8.0-26 \mathrm{~V}$ |
| ULN-2283B | X | - | 1.2 W | $3.0-18 \mathrm{~V}$ |
| ULN-3701Z | X | - | 10 W | $8.0-18 \mathrm{~V}$ |
| ULN-3702Z | X | - | 12 W | $8.0-26 \mathrm{~V}$ |
| ULN-3703Z | X | - | 10 W | $8.0-18 \mathrm{~V}$ |
| ULN-3705M | X | - | 600 mW | $1.8-9.0 \mathrm{~V}$ |
| ULN-3783M* | - | X | 520 mW | $2.4-9.0 \mathrm{~V}$ |
| ULN-3784B | X | - | 4.0 W | $9.0-28 \mathrm{~V}$ |
| ULN-3793W* | X | - | 20 W | $8.0-18 \mathrm{~V}$ |

*New product. Consult factory for information.

## ULN-2280B AUDIO POWER AMPLIFIER

## FEATURES

- Low Distortion
- Low Quiescent Current
- A-C Short-Circuit Protection
- 34 dB Internally Fixed Gain
- High Input Impedance
- Thermal Overload Protection
- Replaces LM380N

FIEW SUPPLEMENTAL discrete components are needed to use Sprague Type ULN-2280B audio power amplifier in automotive, communication and consumer designs.

With an 18 V supply, the amplifier delivers 2.5 W of low-distortion audio into an $8 \Omega$ load. Output power with a 24 V supply is 2.5 W into a $16 \Omega$ load.


The audio amplifier is supplied in an improved 14-pin dual in-line plastic package with heat sink contact tabs. The webbed lead configuration, originated by Sprague Electric, permits attachment of an inexpensive heat sink for increased power dissipation capability and use of a standard integrated circuit socket or printed wiring board layout.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 26 V |
| :---: | :---: |
| Peak Output Current, $\mathrm{I}_{\text {our }}$ | 1.2 A |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | See Graph |
| Operating Temperature Range, $T_{A}$ | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |



ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} \mathrm{C}$,
$V_{\text {CC }}=18 \mathrm{~V}, R_{\mathrm{L}}=8 \Omega, \mathrm{f}_{\text {in }}=1 \mathrm{kHz}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $\mathrm{V}_{\mathrm{cc}}$ |  | 8.0 | 18 | 26 | V |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}$ | - | 15 | - | mA |
| Quiescent Output Voltage | $V_{00}$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}$, See Note 1 | - | 9.0 | - | V |
| Output Voltage Swing | $V_{\text {out }}$ | $\mathrm{P}_{\text {out }}=2 \mathrm{~W}$ | - | 12 | - | Vpp |
| Voltage Gain | $\mathrm{A}_{\mathrm{v}}$ | $\mathrm{P}_{\text {out }}=0 \mathrm{~W}$ | 31 | 34 | 37 | dB |
| Total Harmonic Distortion | THD | $\mathrm{P}_{\text {out }}=50 \mathrm{~mW}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {cc }}=18 \mathrm{~V}$ | - | <0.2 | 1.0 | \% |
|  |  | $P_{\text {out }}=50 \mathrm{~mW}, \mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{\text {cc }}=24 \mathrm{~V}$ | - | - | 0.5 | \% |
|  |  | $\mathrm{P}_{\text {out }}=2 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {cc }}=18 \mathrm{~V}$ | - | $<1.0$ | 2.0 | \% |
| Audio Power Output | Pout | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {c }}=18 \mathrm{~V}$, THD $=2 \%$ | 2.0 | 2.5 | - | W |
|  |  | $\mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{\text {cc }}=24 \mathrm{~V}, \mathrm{THD}=2 \%$ | 2.0 | 2.5 | - | W |
| Input Impedance | $Z_{\text {in }}$ | Each Input | 140 | 170 | - | k $\Omega$ |
| Power Supply Rejection | PSRR | $\mathrm{P}_{\text {out }}=0 . \mathrm{W}, \mathrm{f}=120 \mathrm{~Hz}$ | - | 35 | - | dB |
| Equiv. Input Noise |  | $f=20 \mathrm{~Hz}$ to 20 kHz | - | 60 | - | $\mu V_{\text {ms }}$ |
| Bandwidth ( -3 dB ) | BW | $\mathrm{P}_{\text {out }}=1 \mathrm{~W}$, See Note 2 | - | 100 | - | kHz |

NOTES: 1 . The quiescent output voltage typically equals $1 / 2$ the supply voltage.
2. Unity gain typically occurs between 10 MHz and 100 MHz .

## TEST CIRCUIT



## TYPICAL CHARACTERISTICS

DISTORTION AS A FUNCTION OF OUTPUT POWER


PSRR AS A FUNCTION OF FREQUENCY


DISTORTION AS A FUNCTION
OF FREQUENCY


VOLTAGE GAIN AS A FUNCTION OF FREQUENCY


## THERMAL FACTORS AND ULN-2280B OPERATION

Thermal factors must be considered in achieving reliable operation of Type ULN-2280B. Guidelines given here provide the circuit design engineer with information on maintaining IC junction temperature below safe limits when the audio power amplifier is operated at maximum ambient temperature and power dissipation.

The graphs below show package power dissipation as a function of output power over a wide range of supply voltage with a load resistance of $8 \Omega$ or $16 \Omega$. Lines indicating $3 \%$ distortion and $10 \%$ distortion are shown as guides to trade-offs between supply voltages, package power dissipation and upper-limit distortion.

As the power supply voltage increases for any output power requirement, distortion decreases and package power dissipation increases. Package power dissipation figures must be taken from the highest point on the supply voltage curve.

## DISSIPATION AS A FUNCTION OF OUTPUT POWER ( $8 \Omega$ LOAD)



## DISSIPATION AS A FUNCTION OF OUTPUT POWER ( $16 \Omega$ LOAD)



## CIRCUIT DESIGN

If design values of audio output power, distortion and maximum ambient temperature have been selected, optimal speaker impedance and supply voltage, as well as heat-sink requirements, can be determined from curves below and on page 4.

For an output of 2.5 W with $3 \%$ distortion and a maximum ambient temperature of $+50^{\circ} \mathrm{C}$ :

| $R_{1}$ | $8 \Omega$ | $16 \Omega$ |
| :--- | :--- | :--- |
| THD | $3 \%$ | $3 \%$ |
| $P_{\text {our }}$ | 2.5 W | 2.5 W |
| $V_{\text {cc }}$ | 16.7 V | 22 V |
| $P_{D}($ max $)$ | 1.9 W | 1.75 W |
| $P_{D}+P_{\text {ouI }}$ | 4.4 W | 4.25 W |
| $\mathrm{I}_{\text {cc }}$ | 263 mA | 193 mA |

The preceding appears to indicate the best choice is an output impedance of $16 \Omega$ with a 22 V supply. However, if an unregulated supply is used, the designer may prefer an $8 \Omega$ load with a 16 V supply, since the absolute maximum $\mathrm{V}_{\mathrm{Cc}}$ rating of Type ULN-2280B is 26 V and since maximum package dissipation must be calculated using the no-load voltage level.

The graph below (left) shows that the Staver V-8 heat sink would be just adequate for design conditions outlined above at an ambient temperature of $50^{\circ} \mathrm{C}$. The Staver V-7 heat sink would provide a wider margin of safety.

## ALLOWABLE POWER DISSIPATION

 AS A FUNCTION OF AMBIENT TEMPERATURE

SUPPLY CURRENT AS A FUNCTION OF SUPPLY VOLTAGE


TYPICAL APPLICATIONS


Dwg. No. A-11,403B

LOW-COST PHONOGRAPH


Dwg. No. A-11,404B


## ULN-2283B LOW POWER AUDIO AMPLIFIER

## FEATURES

-Wide Operating Voltage Range (3 to 18 V )

- Low Quiescent Current Drain
- A-C Short Circuit Protected
-Low External Parts Count
-Low Distortion
-42 dB Voltage Gain

DESIGNED primarily for use in low-cost phonographs and radio receivers, the ULN2283B audio power amplifier is well-suited for use in battery-operated portable equipment. It will function with supply voltages as low as 2 volts (at reduced volume) without any significant increase in distortion. Weak batteries need no longer be a major concern for users in sets with this device. The class AB audio amplifier also features low quiescent current drain for maximum battery life.

The ULN-2283B is rated for operation over the supply voltage range of 3.0 to 15 volts. Selected devices, for operation with supply voltages of up to 18 volts, are available as ULN-2283B-1. Except for the maximum allowable supply voltage specification, the ULN-2283B and the ULN-2283B-1 are identical.

The ULN-2283B audio power amplifier is supplied in an improved 8 -lead dual in-line plasticpackage with two webbed tabs. A copper alloy lead frame results in maximum power dissipation without need for an external heat sink. Lead configuration is compatible with standard IC sockets or printed wiring board hole layouts.


## abSolute maximum ratings

Supply Voltage, $V_{\text {CC }}$ (ULN-2283B) . . . . . . . . . . . . . . . . . 15 V
(ULN-2283B-1) . . . . . . . . . . . . . . . . 18 V
Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . See Graph
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}_{\text {in }}=400 \mathrm{~Hz}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $V_{c c}$ | ULN-2283B | 3.0 | - | 15 | V |
|  |  | ULN-2283B-1 | 3.0 | - | 18 | V |
| Quiescent Supply Current | $\mathrm{l}_{\mathrm{cc}}$ | $\mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}$ | - | 12 | 16 | mA |
|  |  | $V_{c c}=12 \mathrm{~V}$ | - | 24 | 28 | mA |
| Voltage Gain | $\mathrm{A}_{\mathrm{e}}$ | $\mathrm{P}_{\text {OUI }}=0 \mathrm{~W}$ | 39 | 42 | 46 | dB |
| Audio Power Output | Pout | $V_{c c}=6.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{THD}=10 \%$ | 0.25 | 0.35 | - | W |
|  |  | $\mathrm{V}_{\mathrm{cc}}=9.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{THD}=10 \%$ | 0.80 | 1.1 | - | W |
|  |  | $\mathrm{V}_{\text {cc }}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{THD}=10 \%$ | 0.80 | 1.2 | - | W |
| Input Resistance | $\mathrm{R}_{1 \times}$ | Pin 8. | - | 250 | - | $\mathrm{k} \Omega$ |
| Power Supply Rejection | PSRR | $\mathrm{C}_{0}=500 \mu \mathrm{~F}, \mathrm{f}_{\text {riple }}=120 \mathrm{~Hz}$ | 28 | 34 | - | dB |

TEST CIRCUIT


TYPICAL FREQUENCY RESPONSE


## ALLOWABLE PACKAGE POWER DISSIPATION

## Printed Wiring Board Copper

 is $2 \mathrm{oz} . / \mathrm{ft}^{2}, 2.5 \mathrm{sq}$. in.( $610 \mathrm{~g} / \mathrm{m}^{2}, 16.1 \mathrm{~cm}^{2}$ )


AMBIENT TEMPERATURE, $\mathrm{T}_{\mathrm{A}}, \mathbb{N N}^{\circ} \mathrm{C}$

## TYPICAL CHARACTERISTICS

QUIESCENT SUPPLY CURRENT AS A FUNCTION OF SUPPLY VOLTAGE

OUTPUT POWER
AS A FUNCTION OF SUPPLY VOLTAGE

POWER SUPPLY REJECTION IS A FUNCTION OF FREQUENCY


DWG.NO. A-11,238


8


## PACKAGE POWER DISSIPATION AS A FUNCTION OF OUTPUT POWER




AT $8 \Omega$ LOAD


AT $16 \Omega$ LOAD

TOTAL HARMONIC DISTORTION AS A FUNCTION OF OUTPUT POWER


AT $8 \Omega$ LOAD


## CIRCUIT DESCRIPTION

To achieve the desired performance objectives of high power output and efficiency from a 2 to 18 V supply requires that the amplifier be capable of peak-to-peak voltage swings approaching the available supply. To meet these performance objectives, a power amplifier design is required having no more than one $V_{\mathrm{BE}}$ of swing restriction.

As shown in Figure 1, the output stage is comprised of 2 NPN transistors (Q17 and Q18) plus a phase inverter (Q15). Quiescent operating current is set up by the current source (I).
Assuming $\mathrm{V}_{\mathrm{oq}}=\mathrm{V}_{\mathrm{cd}} / 2$ then the collector current of Q15 = I, ignoring base currents, and if Q15 is matched to Q 18 as is possible in a monolithic circuit, then the collector current of Q18 equals the collector current of Q15.

The circuit in Figure 1 achieves an excellent voltage swing capability of $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{BE}}-2 \mathrm{~V}_{\mathrm{CE}(S A T)}$. This totally NPN configuration also has good freedom from the high-frequency problems that often occur with quasi-complementary composite NPN-PNP configurations.


Figure 1

Although the circuit in Figure 1 has been incorporated in production monolithic circuits in essentially the form shown, in practice it has unacceptable design restrictions. Since I is also the base drive current for Q17, the ratio of available base drive current I to idling current is proportional to the ratio of the emitter areas of Q18 to Q15. For practical values of $\mathrm{I}_{\mathrm{Q} 15} / \mathrm{I}_{\mathrm{Q} 18}$, i.e. one, the circuit has a serious implementation problem; it requires three output transistors (Q15, Q17, and Q18).


Figure 2
To reduce the size of Q15, an additional transistor (Q16) is added to the circuit as shown in Figure 2. Transistor Q16 divides I by its beta +1 allowing Q15 to be reduced in area by a similar value. In the practical realization of the ULN-2283B, Q15 is chosen as $1 / 5$ the emitter area of Q18 with a typical beta for Q16 of 6 .


Figure 3
Figure 3 illustrates other refinements in the practical realization of the output circuit. The drive and idling current I is derived from a $\mathrm{V}_{\mathrm{cc}}$ dependent source allowing maximum drive under maximum supply conditions while affording reduced drive and associated current conservation under minimum supply conditions. In addition, the Q16 divider circuit is refined to reduce PNP beta dependence. Finally with the addition of an input emitter follower (Q11) and a local negative feedback loop (R8), the output is completed as it appears in the ULN-2283B.


Figure 4
The input stage of the power amplifier (Figure 4) is comprised of a PNP differential pair (Q2 and Q3) preceded by a PNP emitter follower (Q1) which allows d-c referencing of the source signal to ground. This eliminates the need for an input coupling capacitor. Overall negative feedback, set by the ratio of R4 to R5, is applied to the inverting input Q3 through an NPN emitter follower (Q7) which also provides d-c level shifting.

The $\mathrm{V}_{\mathrm{cc}} / 2$ output tracking is achieved by summing the current flow through R4 and R5, with the current through R13 'reflected off of ground." Thus $\mathrm{V}_{\mathrm{cc}} / 2$ tracking is maintained by the voltage drop across 2 resistors. This allows the current from R13 to be bypassed at Pin 1, thereby combining the ripple bypass capacitor with the audio feedback capacitor.

Figure 5 illustrates the complete power amplifier as realized in the ULN-2283B, including the external components. The remarkably-low external component count, (only two capacitors including the output coupling) reflects concern for simplicity in implementation, yet the device achieves excellent performance. Typical output power can be as high as 2.1 W from a 12 volt supply and useful output power at supply voltages of as low as 2 volts.

## APPLICATIONS

Selection of power supply voltage and speaker impedance allow the designer to choose audio power levels. No unique precautions are necessary when designing with the ULN-2283B power amplifier. The device is stable and a-c short-circuit immune.


Figure 5

External component choice for the power amplifier involves only two capacitors; one for the speaker coupling and one for the feedback and ripple by-passing. The coupling capacitor value should be selected to provide the desired low-frequency cutoff with the chosen speaker impedance. The feedback and ripple bypass capacitor at Pin 1 should be chosen for both low-frequency audio rolloff and supply ripple rejection.

Ripple rejection is not practical to calculate due to the large number of mechanisms involved. A $500 \mu \mathrm{~F}$ capacitor at Pin 1 achieves typically 34 dB rejection.
The high gain of typically 42 dB and the high input impedance ( $250 \mathrm{k} \Omega$ ) of the power amplifier allow utilization of this device for applications such as ceramic cartridge phono amplifiers.
Typical ceramic phono cartridges develop approximately 400 mV . However, the recommended load impedance for the most economical cartridges is usually $1 \mathrm{M} \Omega$. This poses no problem with the $250 \mathrm{k} \Omega$ input impedance of the ULN-2283B since the cartridge manufacturer specifies the load impedance for full low-frequency response to less than 40 Hz . Decreasing the load impedance produces an increased low end cutoff frequency.
In a ULN-2283B based application employing a cost and space conscious loudspeaker, 40 Hz program material capability is not only unnecessary but undesirable, and therefore a mismatch of the cartridge to increase the lower cutoff frequency to a value more in keeping with the other components of the system is recommended.
The ULN-2283B audio amplifier stage has other input considerations to be taken into account for best results. The input is referenced to ground for internal biasing and must be provided with a d-c path to ground. A current of typically $0.1 \mu \mathrm{~A}$ flows from Pin 8 through the volume control producing an IR drop which is multiplied by the closed loop d-c gain of the amplifier (1), and appears as an error in output centering at Pin 4. This recommends a value of $200 \mathrm{k} \Omega$ or less for the volume control, with values of less than $100 \mathrm{k} \Omega$ preferred.

The selection of amplifier load impedance involves more consideration than just the desired power output. Ideally a low speaker impedance would produce the highest power outputs for any one supply voltage as the curves illustrated. However, operation with a $16 \Omega$ load can produce as much power as with an $8 \Omega$ load. The higher impedance löad will also furnish a significant reduction in harmonic distortion and improvement in overall repeatability in power output capacity. In applications which allow the selection of the power supply voltage it is therefore recommended that a $16 \Omega$ load impedance be utilized in applications up to 1.2 watt.

## PRINTED WIRING BOARD LAYOUT \& SPECIAL CONSIDERATIONS

Special on-chip considerations for minimizing tendencies towards instabilities of all types were taken in the design of the ULN-2283B. However, like all high-gain circuits, care and forethought should still be given to a printed wiring board layout to avoid undesirable effects. Input and output should be well separated and should avoid common mode impedances wherever possible. The ground return for the audio bypass at Pin 1 should be kept reasonably close to the volume control ground as Pins 1 and 8 represent the inverting and non-inverting inputs to the amplifier and enjoy about 40 dB of common mode rejection.

Device dissipation vs. output power and supply voltage for 4,8 , and 16 ohm loads is shown in the curves on page 4 . With no heat sinking (free air), the ULN-2283B audio power amplifier will withstand the worst case conditions ( $4 \Omega$ at 9 V ) for ambient temperatures to $+42.5^{\circ} \mathrm{C}$. For conditions not shown, for higher ambient temperatures, or for improved device reliability, a minimum heat sink is recommended. As illustrated in the allowable package power dissipation curves, with the heat sink tabs (Pins 2, 3, 6, and 7) soldered into a 2.5 square inch ( $16.13 \mathrm{~cm}^{2}$ ) copper area of a printed circuit board, adequate heat sinking is easily obtained.

## ULN-3701Z / TDA2002 <br> 5 TO 10-WATT AUDIO POWER AMPLIFIER

## FEATURES

- Low External Parts Count
- Low Distortion
- Class B Operation
- Short-Circuit Protected
- Thermal Overload Protected
- Low Noise
- High Output-Voltage Swing
- T0-220 Style Package
- Direct Replacement for LM383 and CA2002

DESIGNED specifically to drive low-impedance loads down to $1.6 \Omega$, the Type ULN-3701Z / TDA2002 audio power amplifier is ideal for automotive radio, tape player, and CB applications.

It can deliver 5 W to 10 W of audio in the singleended mode. Operating in the extremely harsh au-


tomotive environment, this device is capable of withstanding high ambient temperatures, output overloads, and repeated power supply transient voltages without damage.

The Type ULN-3701Z/TDA2002 amplifier is rated for continuous operation with supply voltages of up to 18 V . With the application of increased voltages (to 28 V , maximum), a high-voltage protective circuit becomes operative, disabling the device. Devices without this internal high-voltage shutdown are available as Type ULN-3702Z/TDA2008 and are recommended for use where more than 10 W of audio power is required with higher impedance loads and supply voltages to 28 V . In all other respects, Types ULN-3701Z and ULN-3702Z are identical.

Type ULN-3701Z/TDA2002 is supplied in a modified 5-lead JEDEC Style TO-220 plastic package. The heat-sink tab is at ground potential; no insulation is required.

Lead configurations for vertical mounting (ULN3701 V ) and for horizontal mounting (ULN-3701H) are available. Parts are branded with a partial Sprague Electric part number (ULN3701) and the basic Pro-Electron marking (TDA2002)

## ABSOLUTE MAXIMUM RATINGS


Peak Supply Voltage ( 50 ms ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 40 V*
Peak Output Current, Ior . .................................................... 3.5 A
Non-Repetitive Peak Output Current . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 4.5 A
Package Power Dissipation, $P_{0}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . See Graph
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . .20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

*Internal high-voltage shutdown above 18 V .

ALLOWABLE POWER DISSIPATION
AS A FUNCTION OF AMBIENT TEMPERATURE


DWG. NO. A-12,000A

ELECTRICAL CHARACTERISTICS af $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=14.4 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=4 \Omega, \mathrm{f}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{fb}}=\infty$
(unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $\mathrm{V}_{\mathrm{cc}}$ |  | 8.0 | 14.4 | 18 | V |
| Quiescent Supply Current | $\mathrm{l}_{\text {cc }}$ | No signal applied | - | 45 | 80 | mA |
| Quiescent Output Voltage | $V_{4}$ | No signal applied | 6.4 | 7.2 | 8.0 | V |
| Open Loop Gain | A | T | - | 80 | - | dB |
| Closed Loop Gain | A |  | 39.5 | 40 | 40.5 | dB |
| Total Harmonic Distortion | THD | $\mathrm{P}_{\text {our }}=0.05$ to 3.5 W | - | 0.2 | - | \% |
|  |  | $\mathrm{P}_{\text {our }}=0.05$ to $5.0 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 0.2 | - | \% |
| Audio Power Output | Pour | THD $=10 \%$ | 4.8 | 5.2 | - | W |
|  |  | THD $=10 \%, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | 7.0 | 8.0 | - | W |
|  |  | THD $=10 \%, V_{\text {cc }}=16 \mathrm{~V}$ | - | 6.5 | - | W |
|  |  | THD $=10 \%, \mathrm{R}_{\mathrm{L}}=2 \Omega, \mathrm{~V}_{\text {cc }}=16 \mathrm{~V}$ | - | 10 | - | W |
| Efficiency | $\eta$ | $\mathrm{P}_{\text {our }}=5.2 \mathrm{~W}$ | - | 68 | - | \% |
|  |  | $\mathrm{P}_{\text {out }}=8.0 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 58 | - | \% |
| Input Impedance | $\mathrm{Z}_{1}$ |  | 70 | 150 | - | k $\Omega$ |
| Power Supply Rejection | PSR | $\mathrm{f}_{\text {ippole }}=120 \mathrm{~Hz}, \mathrm{~V}_{\text {riple }}=0.5 \mathrm{~V}$ | 30 | 35 | - | dB |
| Equiv. Input Noise Voltage | $\mathrm{V}_{N}$ | $\mathrm{f}=40 \mathrm{~Hz}$ to 15 kHz | - | 4.0 | - | $\mu \mathrm{V}$ |
| Equiv. Input Noise Current | $\mathrm{i}_{\text {N }}$ | $\mathrm{f}=40 \mathrm{~Hz}$ to 15 kHz | - | 60 | - | pA |
| Input Sensitivity | $v_{\text {in }}$ | $\mathrm{P}_{\text {our }}=0.5 \mathrm{~W}$ | - | 15 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=0.5 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 11 | - | mV |
|  |  | $\mathrm{P}_{\text {our }}=5.2 \mathrm{~W}$ | - | 55 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=8.0 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 50 | - | mV |
| Input Saturation Voltage | $\mathrm{v}_{\text {in }}$ |  | - | 600 | - | mV |
| Frequency Response ( -3 dB ) |  | $\mathrm{C}_{\text {to }}=0.039 \mu \mathrm{~F}, \mathrm{R}_{\text {to }}=39 \Omega$ | 40 | - | 15k | Hz |
| Thermal Resistance | $\mathrm{R}_{\text {er }}$ |  | - | - | 4.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |



## APPLICATIONS INFORMATION



FIGURE 1
A typical application using Type ULN-3701Z/ TDA2002 is shown in Figure 1. Component values other than those shown will affect circuit performance as follows:
$C_{1}$-The value of the input capacitor may be reduced with the lower limit determined by the device's input impedance and the required low-frequency performance. For a 20 Hz low-frequency cutoff, and a minimum input impedance of $70 \mathrm{k} \Omega$, the minimum recommended value is $0.1 \mu \mathrm{~F}$. This capacitor's value is normally very large so that transients (turnon, turn-off) are inaudible. Common $1 \mu \mathrm{~F}$ to $2 \mu \mathrm{~F}$ electrolytic capacitors will work quite well.
$C_{2}$-The negative feedback capacitor affects the power supply rejection ratio; the capacitive value is therefore usually very large. If the power supply has low ripple, the feedback capacitor value can be reduced. Increasing the value of this capacitor above the recommended $470 \mu \mathrm{~F}$ will not have a large effect on PSRR, due to the terminating impedance of the output resistive divider.
$C_{4}$-The output capacitor is chosen to provide the desired low-frequency cutoff with the lower limit determined by the load impedance. The values shown provide for a 20 Hz cutoff.
$C_{5}$-The large electrolytic can be considered to be part of the power supply and may be reduced in capacitive value or eliminated, depending on the particular supply. The low-value capacitor is usually a monolithic ceramic capacitor. It provides for highfrequency bypass and should have a low series resistance and a high self-resonant frequency.
$R_{2}, R_{4}$-The output resistive divider sets the closedloop gain of the amplifier according to $A_{v}=\left(R_{2}+\right.$ $\left.\mathbf{R}_{4}\right) / \mathbf{R}_{2}$. The values shown provide for a gain of 100 and a typical PSRR of 35 dB . Connecting this divider to the d-c side of the output capacitor increases the supply current drain (by 32 mA for a supply of 14.4 V and $\mathrm{R}_{2}+\mathrm{R}_{4}=222 \Omega$ ) but will reduce any tendency toward crossover distortion.
$R_{\mathrm{fb}}, C_{\mathrm{fb}}$-High-frequency roll-off can be controlled with the addition of this series $R C$ combination. Values are approximately $\mathrm{R}_{\mathrm{fb}}=20 \times \mathrm{R}_{2}$ and $\mathrm{C}_{\mathrm{fb}}=1 /$ $\left(2 \pi R_{4} f_{H}\right)$.
$R_{11}, C_{11}$-This network is chosen to suppress spurious oscillation. The values shown should work for loads between $2 \Omega$ and $16 \Omega$. Some changes may be required depending on factors such as circuit layout, load reactances, and lead length. A factor of $2 \times$ should be worst-case variation.

## CIRCUIT MUTING

A simple muting circuit is shown in Figure 2. In this circuit, the a-c input signal is attenuated without affecting any d-c levels. The $47 \mu \mathrm{~F}$ capacitor and the $18 \mathrm{k} \Omega$ resistor can be eliminated if signal-level ramping is not desired.


FIGURE 2

TYPICAL OUTPUT POWER AS A FUNCTION OF SUPPLY VOLTAGE


TYPICAL OUTPUT DISTORTION AS A FUNCTION OF OUTPUT POWER


## ULN-3702Z/TDA2008 12-WATT AUDIO POWER AMPLIFIER

## FEATURES

- Low External Parts Count
- Low Distortion
- Class B Operation
- Short-Circuit Protected
- Thermal Overload Protected
- Low Noise
- T0-220 Style Package

T'HE ABILITY TO DRIVE high-power loads in consumer and industrial electronics expands the field of application for Type ULN-3702Z/ TDA2008.

The high-gain power amplifier can be used as a vertical output driver in television receivers and video terminals or as a linear d-c motor driver. Its operational-amplifier configuration, with high input impedance and low output impedance, makes it adaptable to many input, output and feedback arrangements.

One modification sets this audio power amplifier apart from Sprague Type ULN-3701Z/TDA2002: The integrated circuit's internal high-voltage shutdown has been disabled. The change allows continuous operation with supply voltages of up to 26 V . With a d-c load current rating of 2.5 A, Type ULN3702Z/TDA2008 can handle up to 60 watts of power with an appropriate heat sink. It is able to withstand high ambient temperatures, output overloads, and repeated power supply transients without damage.

The amplifier is supplied in a modified five-lead JEDEC Style TO-220 plastic package. The heat sink tab is at ground potential; no insulation is required.

Lead configurations for vertical mounting (ULN3702 V ) and for horizontal mounting (ULN-3702ZH) are available. Parts are branded with a partial Sprague Electric part number (ULN3702) and the basic Pro-Electron marking (TDA2008).


## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 28 V |
| :---: | :---: |
| Peak Supply Voltage ( 50 ms ) | 40 V |
| Peak Output Current, $\mathrm{I}_{\text {out }}$ | 3.5 A |
| Non-Repetitive Peak Output Current | 4.5 A |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | 15 W* |
| Storage Temperature Range, $\mathrm{T}_{S}$ | $+150^{\circ} \mathrm{C}$ |
| ${ }^{*}$ Derate at the rate of $0.25 \mathrm{~W} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\text {TAB }}$ |  |

Peak Supply Voltage ( 50 ms ) . . . . . . . . . . . . . . . . . . . . . . 40 V
Peak Output Current, I Iout . . . . . . . . . . . . . . . . . . . . . . . 3.5 A
Non-Repetitive Peak Output Current . . . . . . . . . . . . . . . 4.5 A

Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-40^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $0.25 \mathrm{~W} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{TAB}}=90^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$,
$V_{C C}=+24 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{f}=1 \mathrm{kHz}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $V_{c c}$ |  | 8.0 | 24 | 26 | V |
| Quiescent Supply Current | $l_{\text {cc }}$ | No signal applied | - | 80 | 120 | mA |
| Quiescent Output Voltage | $V_{4}$ | No signal applied | - | 12 | - | V |
| Open Loop Gain | $\mathrm{A}_{\mathrm{e}}$ |  | - | 80 | - | dB |
| Closed Loop Gain | $\mathrm{A}_{\mathrm{e}}$ |  | 39.5 | 40 | 40.5 | dB |
| Total Harmonic Distortion | THD | $\mathrm{P}_{\text {OUI }}=0.05$ to $3.5 \mathrm{~W}, \mathrm{R}_{\mathrm{\perp}}=8 \Omega$ | - | 0.2 | - | \% |
|  |  | $\mathrm{P}_{\text {out }}=0.05$ to $5.0 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 0.2 | $-$ | \% |
| Audio Power Output | $\mathrm{P}_{\text {out }}$ | THD $=10 \%, \mathrm{R}_{\perp}=8 \Omega$ | - | 8.0 | - | W |
|  |  | THD $=10 \%, \mathrm{R}_{\perp}=4 \Omega$ | 10 | 12 | - | W |
| Input Impedance | $\mathrm{Z}_{1}$ |  | 70 | 150 | - | k $\Omega$ |
| Power Supply Rejection | PSRR | $\mathrm{f}_{\text {fiople }}=120 \mathrm{~Hz}, \mathrm{~V}_{\text {niple }}=0.5 \mathrm{~V}$ | 30 | 35 | - | dB. |
| Equiv. Input Noise Voltage | $\mathrm{e}_{\mathrm{N}}$ | $\mathrm{f}=40 \mathrm{~Hz}$ to 15 kHz | - | 4.0 | - | $\mu \mathrm{V}$ |
| Equiv. Input Noise Current | $\mathrm{i}_{1}$ | $\mathrm{f}=40 \mathrm{~Hz}$ to 15 kHz | - | 60 | - | pA |
| Input Sensitivity | $\mathrm{e}_{\text {in }}$ | $P_{\text {out }}=0.5 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 15 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=0.5 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=8 \Omega$ | - | 21 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=8.0 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 71 | - | mV |
| Tnput Saturation Voltage | $\mathrm{e}_{\text {in }}$ |  | 400 | 600 | - | $\mathrm{mV}_{\text {cms }}$ |
| Frequency Response ( -3 dB ) |  | $\mathrm{C}_{\text {fb }}=0.039 \mu \mathrm{~F}, \mathrm{R}_{\text {fb }}=39 \Omega$ | 40 | - | 15 k | Hz |
| Thermal Resistance | $\mathrm{R}_{\text {өл }}$ |  | - | - | 4.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

TEST CIRCUIT AND TYPICAL APPLICATION

TYPICAL LOW-COST APPLICATION


Dwg. No. A-10,466A

## OUTPUT POWER

AS A FUNCTION OF SUPPLY VOLTAGE


Dwg. No. A-11,409

## POWER DISSIPATION

AS A FUNCTION OF OUTPUT POWER


## TYPICAL D-C MOTOR DRIVE APPLICATIONS



Dwg. No. A $11,334 \mathrm{~A}$

## TYPICAL MOTOR CONTROL CURVE



## ULN-3703Z / TDA2003 10-WATT AUDIO POWER AMPLIFIER

## FEATURES

- Low External Parts Count
- Low Distortion
- Class B Operation
- Short-Circuit Protected
- Thermal Overload Protected
- Low Noise
- High Output-Voltage Swing
- T0-220 Style Package

DESIGNED to drive low-impedance loads down to $1.6 \Omega$, Type ULN-3703Z/TDA2003 audio power amplifier is ideal for automotive radio, tape player, and CB applications and can deliver 15 W of audio in the bridge configuration or 5 W to 10 W
 single-ended.

Operating in the harsh automotive environment, this device is capable of withstanding high ambient temperatures, output overloads, and repeated power supply transient voltages without damage. It is protected against a-c/d-c short-circuits, polarity inversions, or open grounds.

Type ULN-3703Z/TDA2003 is supplied in a modified five-lead JEDEC Style TO-220 plastic package. The heat sink tab is at ground potential; no insulation is required. Lead forming for either vertical or horizontal mounting (suffix letter " $V$ "' or " H ," respectively) is standard.

Parts are branded with both a partial Sprague Electric part number (ULN3703) and the basic ProElectron marking (TDA2003).

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\text {cc }}$ ..... 28 V
Peak Supply Voltage ( 50 ms ) ..... 40 V
Peak Output Current, I Iout ..... 3.5 A
Non-Repetitive Peak Output Current ..... 4.5 A
Package Power Dissipation, $P_{D}$ ..... 20 W*
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$

$\qquad$
$-40^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$


[^42]ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+14.4 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=4 \Omega, \mathrm{f}=1 \mathrm{kHz}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $\mathrm{V}_{\text {c }}$ |  | 8.0 | - | 18 | V |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | No signal applied | - | 44 | - | mA |
| Quiescent Output Voltage | $V_{4}$ | No signal applied | 6.1 | 6.9 | 7.7 | V |
| Open Loop Gain | $\mathrm{A}_{\mathrm{e}}$ |  | - | 80 | - | dB |
| Closed Loop Gain | $\mathrm{A}_{\mathrm{e}}$ |  | 39.5 | 40 | 40.5 | dB |
| Total Harmonic Distortion | THD | $\mathrm{P}_{\text {Out }}=0.05$ to 4.5 W | - | 0.15 | - | \% |
|  |  | $\mathrm{P}_{\text {out }}=0.05$ to $7.0 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 0.15 | - | \% |
| Audio Power Output | Pout | THD $=10 \%$ | 5.5 | 6.0 | - | W |
|  |  | THD $=10 \%, \mathrm{R}_{\mathrm{L}}=3.2 \Omega$ | - | 7.5 | - | W |
|  |  | THD $=10 \%, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | 8.0 | 10 | - | W |
|  |  | THD $=10 \%, \mathrm{R}_{\mathrm{L}}=1.6 \Omega$ | - | 12 | - | W |
| Efficiency | $\eta$ | $\mathrm{P}_{\text {out }}=6.0 \mathrm{~W}$ | - | 69 | - | \% |
|  |  | $\mathrm{P}_{\text {out }}=10 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 65 | - | \% |
| Input Impedance | $\mathrm{Z}_{1}$ |  | 70 | 150 | - | $\mathrm{k} \Omega$ |
| Power Supply Rejection | PSR | $\mathrm{f}_{\text {ripple }}=120 \mathrm{~Hz}, \mathrm{~V}_{\text {ripple }}=0.5 \mathrm{~V}$ | 30 | 36 | - | dB |
| Equiv. Input Noise Voltage | $\mathrm{e}_{\mathrm{N}}$ | $\mathrm{f}=22 \mathrm{~Hz}$ to 22 kHz | - | 1.0 | 5.0 | $\mu \mathrm{V}$ |
| Equiv. Input Noise Current | $\mathrm{i}_{\mathrm{N}}$ | $f=22 \mathrm{~Hz}$ to 22 kHz | - | 60 | 200 | pA |
| Input Sensitivity | $\mathrm{e}_{\text {in }}$ | $\mathrm{P}_{\text {OUI }}=0.5 \mathrm{~W}$ | - | 14 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=0.5 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 10 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=6.0 \mathrm{~W}$ | - | 55 | - | mV |
|  |  | $\mathrm{P}_{\text {out }}=10 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=2 \Omega$ | - | 50 | - | mV |
| Input Saturation Voltage | $\mathrm{e}_{\text {in }}$ |  | 300 | - | - | mV |
| Frequency Response ( -3 dB ) |  | $\begin{aligned} & \mathrm{C}_{\mathrm{tb}}=0.039 \mu \mathrm{~F}, \mathrm{R}_{\mathrm{fb}}=39 \Omega, \\ & \mathrm{P}_{\text {out }}=1.0 \mathrm{~W} \end{aligned}$ | 40 | - | 15 k | Hz |
| Thermal Resistance | $\mathrm{R}_{\text {өf }}$ |  | - | - | 3.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |



## ULN-3705M

## LOW-VOLTAGE AUDIO POWER AMPLIFIER

## FEATURES

- Wide Operating Voltage Range
- Low Quiescent Current
- A-C Short-Circuit Protection
- Low External Parts Count
- Low Distortion
- 42 dB Voltage Gain
- Low Noise

PROVIDING a low-cost, compact alternative to discrete transistor amplifiers, the Type ULN3705 M integrated circuit is ideal for application as a headphone driver in portable radios, tape players, and other battery-operated equipment. The lowpower audio amplifier's wide frequency response and low noise ensure premium performance.

The amplifier will operate (at reduced volume) with supply voltages as low as 1.8 V without a significant increase in distortion. This feature allows operation with a 3 V battery supply and minimizes concern about weak batteries. The class AB audio amplifier has low quiescent current drain for maximum battery life.

This device is rated for operation with supply voltages up to 12 V . Similar devices for operation up to 18 V (ULN-2283B) are described in Sprague Engineering Bulletin 27117.21.

The Type ULN-3705M audio amplifier is supplied in an 8-pin mini-DIP plastic package. A copper alloy lead frame gives the amplifier enhanced power dissipation ratings.


## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\text {cc }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . 12 V
Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . See Graph
Operating Temperature Range, $T_{A} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} \mathrm{C}$,
$V_{c c}=6 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=32 \Omega, \mathrm{f}_{\mathrm{in}}=400 \mathrm{~Hz}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $\mathrm{V}_{\text {cc }}$ |  | 1.8 | 6.0 | 9.0 | V |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}$ | - | 6.0 | - | mA |
|  |  | $V_{c c}=6.0 \mathrm{~V}$ | - | 7.0 | 15 | mA |
|  |  | $V_{c C}=9.0 \mathrm{~V}$ | - | 10 | 20 | mA |
| Voltage Gain | $\mathrm{A}_{\mathrm{V}}$ |  | - | 42 | - | dB |
| Audio Power Output | $P_{\text {out }}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {cc }}=4.5 \mathrm{~V}, \mathrm{THD}=10 \%$ | - | 220 | - | mW |
|  |  | $\mathrm{R}_{\perp}=8 \Omega, \mathrm{~V}_{c c}=6.0 \mathrm{~V}, \mathrm{THD}=10 \%$ | 250 | 430 | - | mW |
|  |  | $\mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{C C}=4.5 \mathrm{~V}, \mathrm{THD}=10 \%$ | - | 125 | - | mW |
|  |  | $\mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{c c}=6.0 \mathrm{~V}, \mathrm{THD}=10 \%$ | 150 | 240 | - | mW |
|  |  | $\mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{\text {cc }}=9.0 \mathrm{~V}, \mathrm{THD}=10 \%$ | - | 600 | - | mW |
|  |  | $\mathrm{R}_{\mathrm{L}}=32 \Omega, \mathrm{~V}_{\text {cc }}=4.5 \mathrm{~V}, \mathrm{THD}=10 \%$ | - | 60 | - | mW |
|  |  | $\mathrm{R}_{\mathrm{L}}=32 \Omega, \mathrm{~V}_{c c}=6.0 \mathrm{~V}, \mathrm{THD}=10 \%$ | 85 | 110 | - | mW |
|  |  | $\mathrm{R}_{\mathrm{L}}=32 \Omega, \mathrm{~V}_{\text {cc }}=9.0 \mathrm{~V}, \mathrm{THD}=10 \%$ | - | 310 | - | mW |
| Distortion | THD | $\mathrm{P}_{\text {OUI }}=50 \mathrm{~mW}, \mathrm{R}_{\mathrm{L}}=32 \Omega$ | - | 0.4 | 1.0 | \% |
|  |  | $P_{\text {out }}=50 \mathrm{~mW}, \mathrm{R}_{\perp}=16 \Omega$ | - | 0.5 | - | \% |
| Output Noise | $V_{\text {out }}$ | Input Shorted, BW $=80 \mathrm{kHz}$ | - | 225 | - | $\mu \mathrm{V}$ |
| Input Resistance | $\mathrm{R}_{\text {IN }}$ | Pin 8 | - | 250 | - | $k \Omega$ |
| Power Supply Rejection | PSRR | $\mathrm{C}_{0}($ Pin 1$)=500 \mu \mathrm{~F}, \mathrm{f}=120 \mathrm{~Hz}$ | - | 34 | - | dB |

[^43]ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE

TYPICAL OUTPUT POWER AS A FUNCTION OF SUPPLY VOLTAGE


Owg. No. A-11,727


Dwg. No. A-11,720A


Dwg. No. A-11, 717

## TYPICAL CHARACTERISTICS

TOTAL HARMONIC DISTORTION AT $8 \Omega$ LOAD



Dwg. No. A-11,719
8


## TYPICAL CHARACTERISTICS (Continued)

PACKAGE POWER DISSIPATION AT $8 \Omega$ LOAD


Dwg. No. A-11,721


Dwg. No. A-11,722A


## TYPICAL CHARACTERISTICS (Continued)

QUIESCENT SUPPLY CURRENT AS A FUNCTION OF SUPPLY VOLTAGE


POWER SUPPLY REJECTION RATIO AS A FUNCTION OF FREQUENCY


## APPLICATIONS INFORMATION

Selection of power-supply voltage and speaker impedance allows a designer to choose audio power levels within the allowable package power dissipation rating for any maximum operating temperature. No unique precautions are necessary when designing with this device. It is stable and a-c short-circuit immune.

External component selection for this low-power amplifier involves only two capacitors - one for output coupling and one for feedback and ripple decoupling. The coupling capacitor value should be selected to provide the desired low-frequency cutoff with the chosen load impedance. The decoupling capacitor should be chosen for both low-frequency audio rolloff and supply-ripple rejection.

Ripple rejection is not practical to calculate due to the large number of mechanisms involved. A $500 \mu \mathrm{~F}$ capacitor achieves typically 34 dB rejection at 120 Hz .

The high gain and the high input impedance of the power amplifier recommend use of this device in many diverse applications. However, the input stage does have other characteristics that should be taken into account for best results. The input is referenced to ground for internal biasing and must be provided with a d-c path to ground. A current of typically $1 \mu \mathrm{~A}$ flows from the input through the volume con-
trol. This produces an IR drop that is multiplied by the closed loop d-c gain of the amplifier and appears as an error in output centering. This recommends a value of $200 \mathrm{k} \Omega$ or less for the volume control; values of less than $100 \mathrm{k} \Omega$ are preferred.

The selection of amplifier load impedance involves more than just consideration of the desired power output. A low load impedance will produce the highest power output for any given supply voltage. Higher impedances will furnish significant reduction in harmonic distortion and improvement in overall repeatability in power output capacity.

Special steps toward minimizing tendencies towards instabilities of all types were taken in the design of this device. However, as with all high-gain circuits, care should be given to printed wiring board layout to avoid undesirable effects. Inputs and outputs should be well separated and should avoid common-mode impedances wherever possible. For best performance, connect low-level input-signal ground terminals and the decoupling capacitor ground terminal together at pin 3 (signal ground); connect the high-level speaker ground terminal and the power supply ground terminal together at pin 2 (power ground). The signal ground and the power ground should be interconnected at only one point.

## ULN-3784B 4-WATT AUDIO POWER AMPLIFIER

## FEATURES

- Low External Parts Count
- Wide Supply-Voltage Range (To 32 V )
- Single Power Supply
- 34 dB Internally Fixed Gain
- High Input Impedance
- Bandwidth Limited
- A-C Short-Circuit Protection
- Thermal Overload Protection
- Directly Replaces LM384N

AMINIMUM of external components is needed to obtain high-quality audio from the Type ULN-3784B integrated circuit in communications, automotive, and consumer applications.
The audio power amplifier is supplied in a 14 -pin dual in-line plastic package with heat-sink contact tabs. The lead configuration enables attachment of an inexpensive heat sink for increased power dissipation capability, and use of a standard integrated circuit socket or printed wiring board layout.

With a 24 V supply, Type ULN-3784B delivers a minimum of 4 W of audio into an $8 \Omega$ load. Output power with a 28 V supply is typically 4.8 W of lowdistortion audio into a $16 \Omega$ load.

Type ULN-3784B is pin-compatible with, and significantly improves upon, several older designs. Its higher supply-voltage rating allows it to replace

the LM380N, LM384N, and Sprague Types ULN2280B and ULN-2281B with a wider margin of protection against supply transients. Internal bandwidth limiting provides a significant immunity to r-f not found in many other integrated amplifiers.


Dwg.No. A-11,681A

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{c c}$. . . . . . . . ................................................. 32 V
Peak Output Current, I $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1.2 A
Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . See Graph



ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=24 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{f}_{\mathrm{in}}=1 \mathrm{kHz}$
(unless otherwise noted)

| Characteristic | Symbol | Test Conditions. | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $V_{c c}$. |  | 9.0 | 24 | 28 | V |
| Quiescent Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}$ | - | 20 | - | mA |
| Quiescent Output Voltage | $V_{00}$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}$, See Note 1 | - | 12 | - | V |
| Voltage Gain | $\mathrm{A}_{\mathrm{v}}$ | $\mathrm{P}_{\text {out }}=0 \mathrm{~W}$ | 31 | 34 | 37 | dB |
| Total Harmonic Distortion | THD | $\mathrm{P}_{\text {out }}=50 \mathrm{~mW}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {cc }}=24 \mathrm{~V}$ | - | 0.2 | - | \% |
|  |  | $\mathrm{P}_{\text {out }}=50 \mathrm{~mW}, \mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{\text {cC }}=28 \mathrm{~V}$ | - | $<0.2$ | - | \% |
|  |  | $P_{\text {out }}=4 \mathrm{~W}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {cc }}=24 \mathrm{~V}$ | - | $<0.3$ | 5.0 | \% |
| Audio Output Power | $\mathrm{P}_{\text {out }}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {CC }}=24 \mathrm{~V}, \mathrm{THD}=5 \%$ | 4.0 | 5.0 | - | W |
|  |  | $\mathrm{R}_{\mathrm{L}}=16 \Omega, \mathrm{~V}_{\text {cC }}=28 \mathrm{~V}, \mathrm{THD}=5 \%$ | 4.0 | 4.8 | - | W |
| Input Impedance | $Z_{\text {in }}$ | Each Input | 140 | 170 | - | $\mathrm{k} \Omega$ |
| Power Supply Rejection | PSRR | $\mathrm{P}_{\text {out }}=0 \mathrm{~W}, \mathrm{f}=120 \mathrm{~Hz}$ | - | 30 | - | dB |
| Equiv. Input Noise Voltage | \% | $f=20 \mathrm{~Hz}$ to 20 kHz | - | 60 | - | $\mu V_{\text {ms }}$ |
| Bandwidth ( -3 dB ) | BW | $\mathrm{P}_{\text {out }}=1 \mathrm{~W}$, See Note 2 | - | 100 | - | kHz |

NOTES: 1. The quiescent output voltage typically equals $1 / 2$ the supply voltage.
2. Unity gain typically occurs between 10 MHz and 100 MHz .

TEST CIRCUIT


ALLOWABLE POWER DISSIPATION AS A FUNCTION OF AMBIENT TEMPERATURE

## TYPICAL CHARACTERISTICS



PSRR AS A FUNCTION OF FREQUENCY


DISTORTION AS A FUNCTION OF FREQUENCY


Dwg.No. A-12,354

VOLTAGE GAIN AS A FUNCTION OF FREQUENCY


## THERMAL FACTORS AND ULN-3784B OPERATION

Thermal factors must be considered in achieving reliable operation of Type ULN-3784B. Guidelines given here provide the circuit-design engineer with information on maintaining IC junction temperature below safe limits.
The graphs below show package power dissipation as a function of output power over a wide range of supply voltage with a load resistance of $8 \Omega$ or $16 \Omega$. Lines indicating $3 \%$ distortion and $5 \%$ distortion are shown as guides to trade-offs between supply voltages, package power dissipation, and upper-limit distortion. As the power supply voltage increases for any output power requirement, distortion decreases and package power dissipation increases.
Package power dissipation figures must be taken from the highest point on the supply voltage curve. Note that although supply voltage is normally specified at the rated audio-output power, it will usually increase for reduced audio-output levels.


POWER DISSIPATION AS A FUNCTION OF OUTPUT POWEK ( $8 \Omega$ LOAD)


## CIRCUIT DESIGN

If design values of audio output power, distortion, and maximum ambient temperature have been selected, optimal speaker impedance, supply voltage, as well as heat-sink requirements can be determined from the curves below and on the previous page.

For an output of 4.5 W at $5 \%$ distortion and a maximum ambient temperature of $+50^{\circ} \mathrm{C}$ :

| $R_{L}$ | $8 \Omega$ | $16 \Omega$ | Specified |
| :--- | :--- | :--- | :--- |
| $V_{C c}$ | 22.5 V | 26.5 V | From Graph |
| $P_{\text {o(max) }}$ | 3.2 W | 2.6 W | From Graph (determines heat sink) |
| $P_{D}$ | 3.1 W | 2.2 W | From Graph at $\mathrm{V}_{\text {cc }}$ and $\mathrm{P}_{\text {our }}$ |
| $\mathrm{P}_{\mathrm{D}}+\mathrm{P}_{\text {out }}$ | 7.6 W | 6.7 W | Calculated |
| $\mathrm{I}_{\mathrm{Cc}}$ | 338 mA | 253 mA | Calculated (determines supply current) |

The Allowable Package Power Dissipation graph shows that the Staver V-7 heat sink is required for the $8 \Omega, 22.5 \mathrm{~V}$ design, while the smaller Staver $\mathrm{V}-8$ heat sink is just adequate for the $16 \Omega, 26.5 \mathrm{~V}$ design.

The preceding appears to indicate that the best choice is an output impedance of $16 \Omega$ with its higher efficiency and smaller heat sink requirements. If lower distortion is required, the higher impedence load with the higher supply voltage becomes even better. However, if an unregulated supply is used, the designer may prefer the $8 \Omega$ load, since the absolute maximum supply voltage rating is 32 V .

## QUIESCENT SUPPLY CURRENT

 AS A FUNCTION OF SUPPLY VOLTAGE

## TYPICAL APPLICATIONS

## AMPLIFIER WITH COMPLETE TONE CONTROLS



AMPLIFIER WITH BASS-BOOST NETWORK


GENERAL INFORMATION

HIGH-VOLTAGE INTERFACE DRIVERS
high-Current interface drivers

## BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS

MILITARY AND AEROSPACE DEVICES

| RADIO/COMMUNICATIONS INTEGRATED CIRCUITS |  |
| :--- | :--- |
| VIDEO AND TELEVISION INTEGRATED CIRCUITS |  |

## AUDIO POWER AMPLIFIERS

HALL EFFECT DEVICES

TRANSISTOR ARRAYS AND MISCELLANEOUS DEVICES 10

## CUSTOM DEVICES

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4,
N+5
<<a
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A
%
```




```
5%
ANCNOLCN
```


## SECTION 9—HALL EFFECT DEVICES

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UGN-3013T/U Low-Cost Digital Switch ..... 9-3
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Application Notes:
Hall Effect Integrated Circuit Application Guide ..... 9-33*New Product. Contact factory in Concord, N.H., for information.

## SELECTION GUIDE TO HALL EFFECT DEVICES

| Device Type | Switch Points (Gauss) |  | Outputs |
| :--- | ---: | :---: | :---: |
| UGN-3013T/U | 225 | 300 | 1 |
| UGN/UGS-3019T/U | 300 | 420 | 1 |
| UGN/UGS-3020T/U | 165 | 220 | 1 |
| UGN/UGS-3030T/U | 110 | 160 | 1 |
| UGN-3035U | 25 | +25 | 1 |
| UGN-3040T/U | 100 | 150 | 1 |
| UGN/UGS-3075T/U | -100 | +100 | 1 |
| UGN/UGS-3076T/U | -100 | +100 | 1 |
| UGN-3201M | 300 | 450 | 2 |
| UGN-3203M | 100 | 235 | 2 |
| UGN-3220S | 160 | 220 | 2 |
| UGN-3501M | Linear |  | Push-Pull |
| UGN-3501T/U | Linear |  | 1 |
| UGN-3503U | Linear | 1 |  |
| UGN-3604M | Linear | Push-Pull |  |
| UGN-3605M | Linear | Push-Pull |  |

Additional information on all Hall Effect devices is available from:

Sprague Electric Company
Hall Effect IC Marketing
70 Pembroke Road
Concord, New Hampshire 03301
(603) 224-1961

## UGN-3013T SOLID-STATE LOW-COST HALL EFFECT DIGITAL SWITCH

## FEATURES

- Operate from 4.5 V to 16 V D-C Power Source
- Activates With Small, Commercially Available Permanent Magnets
- Solid-State Reliability - No Moving Parts
- Small Size
- Constant Amplitude Output
- Output Compatible With All Digital Logic Families

THE SPRAGUE TYPE UGN-3013T is a low-cost magnetically-activated electronic switch. Each device consists of a voltage regulator, a Hall voltage generator, amplifier, Schmitt trigger, and an open collector output stage integrated in a single monolithic silicon chip.

The on-board regulator permits operation over a wide variation of supply voltages. The circuit output can be interfaced directly with bipolar or MOS logic circuits.

UGN-3013T integrated circuits are packaged in the miniature 3-pin single output plastic ' T '' pack.


ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to $16 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point | $\mathrm{B}_{0}$ |  | - | 300 | 450 | Gauss |
| Release Point | $\mathrm{B}_{\mathrm{RP}}$ |  | 25 | 225 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ |  | 30 | 75 | - | Gauss |
| Output Saturation Voltage | $V_{\text {SAI }}$ | $B \geq 450$ Gauss, $\mathrm{I}_{\text {SIMK }}=15 \mathrm{~mA}$ | - | 120 | 400 | mV |
| Output Leakage Current | $\mathrm{I}_{\text {OFF }}$ | $\mathrm{B} \leq 25$ Gauss, $\mathrm{V}_{\text {out }}=16 \mathrm{~V}$ | - | 0.1 | 20 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{l}_{\mathrm{cc}}$ | $\mathrm{V}_{\text {CC }}=5 \mathrm{~V}$, Output open | - | 7.0 | 9.0 | mA |
|  |  | $\mathrm{V}_{\text {cc }}=12 \mathrm{~V}$, Output open | - | 12 | 16 | mA |
| Output Rise Time | $\mathrm{t}_{\mathrm{r}}$ | $\begin{aligned} & V_{c \mathrm{cc}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 15 | - | ns |
| Output Fall Time | $\mathrm{t}_{4}$ | $\begin{aligned} & V_{C C}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 100 | - | ns |

## OPERATION

The output transistor is normally 'off"' when the magnetic field perpendicular to the surface of the chip is below the threshold or "operate point." When the field exceeds the "operate point," the output transistor switches 'on'" and is capable of sinking 25 mA of current.

The output transistor switches "off"' when the magnetic field is reduced below the "release point", which is less than the "operate point." This is illustrated graphically in the transfer characteristics curve. The hysteresis characteristic provides for unambiguous or non-oscillatory switching.

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.032^{\prime \prime} \pm 0.002^{\prime \prime}(0.81 \pm 0.05 \mathrm{~mm})$ below the branded surface of the T package and $0.012^{\prime \prime} \pm 0.002^{\prime \prime}(0.30 \pm 0.05 \mathrm{~mm})$ below the branded surface of the $U$ package.

For reference purposes, both an Alnico VIII magnet, $0.212^{\prime \prime}$ ( 5.38 mm ) in diameter and $0.187^{\prime \prime}$ $(4.75 \mathrm{~mm})$ long and a samarium cobalt magnet, $0.100^{\prime \prime}(2.54 \mathrm{~mm})$ square and $0.040^{\prime \prime}(1.02 \mathrm{~mm})$ thick, are approximately 1200 gauss at its surface.

The flux density decays at a high rate as the distance from a pole increases.

As an example, using the Alnico VIII magnet referenced above in good alignment and the pole surface in contact with the branded surface of the package, the flux density at the active Hall sensing area of the device would be approximately 850 gauss.

The flux density would drop to approximately 600 gauss with an air-gap between the package and the magnet of $0.031^{\prime \prime}(0.79 \mathrm{~mm})$.

TRANSFER CHARACTERISTICS SHOWING HYSTERESIS


Dwg. No. A-11,003

These Hall effect devices are also available in a miniature 3-pin plastic " $U$ '" package. The ' $T$ "' package is 0.080 ' ( 2.03 mm ) thick; the " $U$ "' package is $0.061^{\prime \prime}$ (1.54 mm) thick. All other dimensions are identical.

## UGN-3019T/U AND UGS-3019T/U LOW-COST HALL EFFECT DIGITAL SWITCHES

## FEATURES

- D-C Operation from 4.5 V to 24 V
- Operable with a Small Permanent Magnet
- High Reliability - No Moving Parts
- Small Size
- Constant Amplitude Output
- Output Compatible with All Digital Logic Families

THESE low-cost, magnetically-activated electronic switches use the Hall Effect to sense a magnetic field. Each circuit consists of a voltage regulator, Hall cell, signal amplifier, Schmitt trigger, and current-sinking output stage on a monolithic silicon chip.

The switches' outputs can be used directly with bipolar or MOS logic circuits. The on-board regulator ensures stable operation over a wide range of supply voltages. Operation over an extended temperature range is made possible by carefully matching integrated circuit components.


Type UGN-3019T/U and UGS-3019T/U digital switches are available in two three-pin single-output plastic packages: The ' $T$ '" package is 80 mils ( 2.03 mm ) thick; the ' $U$ '' package is 60.5 mils ( 1.54 mm ) thick.

## ABSOLUTE MAXIMUM RATINGS

| Power Supply, $\mathrm{V}_{\text {cc }}$ | 25 V |
| :---: | :---: |
| Magnetic Flux Density, B | Unlimited |
| Output OFF Voltage, $\mathrm{V}_{\text {our }}$ | 25 V |
| Output ON Current, $\mathrm{I}_{\text {SmK }}$ | 25 mA |
| Storage Temperature Range, $\mathrm{T}_{\text {s }}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range, $\mathrm{T}_{A}$ |  |
| UGS-3019T/U | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| UGN-3019T/U | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $V_{C C}=4.5 \mathrm{~V}$ to $24 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point* | $\mathrm{B}_{0}$ |  | - | 420 | 500 | Gauss |
| Release Point* | $\mathrm{B}_{\text {RP }}$ |  | 125 | 300 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ |  | 50 | 120 | - | Gauss |
| Output Saturation Voltage | $V_{\text {Sat }}$ | $B \geq 500$ Gauss, $I_{\text {SINK }}=20 \mathrm{~mA}$ | - | 100 | 400 | mV |
| Output Leakage Current | $\mathrm{I}_{\text {OFF }}$ | $B \leq 125$ Gauss, $\mathrm{V}_{\text {out }}=24 \mathrm{~V}$ | - | 0.1 | 1.0 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | $\mathrm{V}_{\text {cC }}=4.5 \mathrm{~V}$, Output Open | - | 2.5 | 5.0 | mA |
|  |  | $V_{\text {cc }}=24 \mathrm{~V}$, Output Open | - | 3.5 | 7.0 | mA |
| Output Rise Time | $\mathrm{t}_{\text {, }}$ | $\begin{aligned} & V_{C C}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & C_{L}=20 \mathrm{pF} \end{aligned}$ | - | 100 | - | ns |
| Output Fall Time | $t_{\text {f }}$ | $\begin{aligned} & V_{c C}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 500 | - | ns |

[^44]
## OPERATION

The output transistor is normally OFF when the magnetic field perpendicular to the surface of the chip is below the threshold or Operate Point. When the field exceeds the Operate Point, the output transistor switches ON and is capable of sinking 25 mA of current. Selections to 30 mA are available.

The output transistor switches OFF when the magnetic field is reduced below the Release Point (which is less than the Operate Point). This is illustrated in the transfer characteristics graph. The hysteresis characteristic provides for unambiguous or non-oscillatory switching.

The simplest form of magnet that will operate the Hall Effect digital switch is a bar magnet as shown. Other methods are possible.

In the illustration, the magnet's axis is on the centerline of the packaged device and the magnet is moved toward and away from the device. Also, note the orientation of the magnet's south pole in relation to the branded surface of the package.

The magnetic flux density is indicated for the most sensitive area of the device. This area is $0.032^{\prime \prime}$ $\pm 0.002^{\prime \prime}(0.81 \pm 0.05 \mathrm{~mm})$ below the branded surface of the " T '' package, 0.012 " $\pm 0.002^{\prime \prime}$ ' $(0.305$ $\pm 0.05 \mathrm{~mm}$ ) below the branded surface of the " U " package.

For reference purposes, both an Alnico VIII magnet, $0.212^{\prime \prime}(5.38 \mathrm{~mm})$ in diameter and $0.187^{\prime \prime}$ $(4.75 \mathrm{~mm})$ long and a samarium cobalt magnet, $0.100^{\prime \prime}(2.54 \mathrm{~mm})$ square and $0.040^{\prime \prime}(1.02 \mathrm{~mm})$ thick, are approximately 1200 gauss at their surfaces.

The flux density decays at a high rate as the distance from a pole increases. As an example, using the Alnico VIII magnet referenced above in good alignment and with the pole surface in contact with the branded surface of the package, the flux density

DV'G. No. A-9762

transfer characteristics showing hysteresis

at the active Hall-sensing area of the device would be approximately 850 gauss ( $0.032^{\prime \prime}(0.81 \mathrm{~mm}$ ) below the package surface).

The flux density would drop to approximately 600 gauss with an air gap between the package and the magnet of $0.031^{\prime \prime}(0.79 \mathrm{~mm})$.

Switching-point variations with temperature should be considered in applications covering a wide temperature range.

## SWITCHING POINT VARIATION WITH TEMPERATURE



1. All Hall Effect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}(3.18 \mathrm{~mm})$ to the epoxy package.

## UGN-3020T AND UGS-3020T LOW-COST HALL EFFECT DIGITAL SWITCHES

## features

- Operate from 4.5 V to 24 V D-C Power Source
- Operable With a Small Permanent Magnet
- High Reliability — Eliminates Contact Wear, Contact Bounce
- No Moving Parts
- Small Size
- Constant Amplitude Output
- Output Compatible With All Logic Families

THE TYPE UGN-3020T and UGS-3020T are lowcost magnetically-activated electronic switches utilizing the Hall effect for sensing a magnetic field. Each circuit consists of a voltage regulator, Hall cell, signal amplifier, Schmitt trigger, and current sinking output stage integrated in a single monolithic silicon chip.

The on-board regulator permits stable operation over a wide variation of supply voltages. Operation over an extended temperature range is made possible by the careful matching of components which can be done economically only on a monolithic circuit.

Both devices will typically operate up to a 100 kHz repetition rate.

The circuit output can be interfaced directly with bipolar or MOS logic circuits.


These devices are packaged in the 3-pin single output plastic "T" pack.

These devices were originally introduced with ULN and ULS prefixes.

## ABSOLUTE MAXIMUM RATINGS

| Power Supply, | 25 V |
| :---: | :---: |
| Magnetic Flux Density, B | Unlimited |
| Output OFF Voltage, $\mathrm{V}_{\text {ourioff }}$ | 25. |
| Output ON. Current, $\mathrm{I}_{\text {SINK }}$ | 25 mA |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ |  |
| UGS-3020T | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| UGN-3020T | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Storage Temperature, Range, | $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=4.5 \mathrm{~V}$ to $24 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point | $\mathrm{B}_{0}$ |  | - | 220 | 350 | Gauss |
| Release Point | $\mathrm{B}_{\mathrm{RP}}$ |  | 50 | 165 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ |  | 20 | 55 | - | Gauss |
| Output Saturation Voltage | $V_{\text {SAT }}$ | $B \geq 350$ Gauss, $\mathrm{I}_{\text {SINK }}=15 \mathrm{~mA}$ | - | 85 | 400 | mV |
| Output Leakage Current | $\mathrm{l}_{\text {Off }}$ | $\mathrm{B} \leq 50$ Gauss, $\mathrm{V}_{\text {out }}=24 \mathrm{~V}$ | - | 0.1 | 20 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{I}_{\text {cc }}$ | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}$, Output open | - | 5.0 | 9.0 | mA |
|  |  | $V_{\text {cc }}=24 \mathrm{~V}$, Output open | - | 6.0 | 14 | mA |
| Output Rise Time | $\mathrm{t}_{\mathrm{r}}$ | $\begin{aligned} & V_{c c}=12 \mathrm{~V}, R_{L}=820 \Omega, \\ & C_{L}=20 \mathrm{pF} \end{aligned}$ | - | 15 | - | ns |
| Output Fall Time | $t_{f}$ | $\begin{aligned} & V_{c c}=12 \mathrm{~V}, R_{L}=820 \Omega, \\ & C_{L}=20 \mathrm{pF} \end{aligned}$ | - | 100 | - | ns |

## OPERATION

The output transistor is normally "off'" when the magnetic field perpendicular to the surface of the chip is below the threshold or "operate point." When the field exceeds the "operate point," the output transistor switches "on" and is capable of sinking 25 mA of current. Selections to 50 mA are available.

The output transistor switches "off"' when the magnetic field is reduced below the "release point" which is less than the "operate point." This is illustrated graphically in the transfer characteristics curve. The hysteresis characteristic provides for unambiguous or non-oscillatory switching.

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.032^{\prime \prime} \pm 0.002^{\prime \prime}(0.81 \pm 0.05 \mathrm{~mm})$ below the branded surface of the T package and $0.012^{\prime \prime} \pm 0.002^{\prime \prime}(0.30 \pm 0.05 \mathrm{~mm})$ below the branded surface of the $U$ package.

For reference purposes, both an Alnico VIII magnet, $0.212^{\prime \prime}(5.38 \mathrm{~mm})$ in diameter and $0.187^{\prime \prime}$

## SWITCHIMG POINT VarIation with temperature


$(4.75 \mathrm{~mm})$ long and a samarium cobalt magnet, $0.100^{\prime \prime}$ ( 2.54 mm ) square and $0.040^{\prime \prime}(1.02 \mathrm{~mm})$ thick, are approximately 1200 gauss at the pole surfaces.

The flux density decays at a high rate as the distance from a pole increases.

As an example, using the Alnico VIII magnet referenced above in good alignment and the pole surface in contact with the branded surface of the package, the flux density at the active Hall sensing area of the device would be approximately 850 gauss.

The flux density would drop to approximately 600 gauss with an air-gap between the package and the magnet of $0.031^{\prime \prime}(0.79 \mathrm{~mm})$.

Note: Switching point variations with temperature should be considered in applications covering a wide temperature range.

TRANSFER CHARACTERISTICS SHOWING HYSTERESIS


Dwg. No. A-11,010

These Hall effect devices are also available in a miniature 3-pin plastic ' $U$ '" package. The ' $T$ "' package is 0.080 " ( 2.03 mm ) thick; the ' $U$ "' package is $0.061^{\prime \prime}(1.54 \mathrm{~mm})$ thick. All other dimensions are identical.

# UGN-3030T/U AND UGS-3030T/U BIPOLAR HALL EFFECT DIGITAL SWITCHES 

## FEATURES

$\bullet$ Operable with Inexpensive Multipole Ring Magnets

- High Reliability - No Moving Parts
- Small Size
- Compatible with All Digital Logic Families

THESE LOW-COST HALL EFFECT switches are designed for use with inexpensive multipole ring magnets. Both devices operate with supply voltages of 4.5 V to 24 V .

Type UGN-3030T/U operates over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. Type UGS-3030T/ U , intended for use in more severe automotive environments, operates over the temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

Circuit output of both Hall Effect ICs can be directly linked to bipolar or MOS logic circuitry. The switches provide a constant amplitude output at switching frequencies of up to 100 kHz .


Types UGN-3030T and UGS-3030T are supplied in a three-pin plastic package 80 mils ( 2.03 mm ) thick. Types UGN-3030U and UGS-3030U are furnished in a magnetically optimized $60.5-\mathrm{mil}$ ( 1.54 mm ) plastic 3-pin package.

## ABSOLUTE MAXIMUM RATINGS

| Power Supply, $\mathrm{V}_{\text {cc }}$ | 25 V |
| :---: | :---: |
| Magnetic Flux Density, B | Unlimited |
| Output OFF Voltage, V ${ }_{\text {out }}$ | 25 V |
| Output ON Current, $\mathrm{I}_{\text {sINK }}$ | 25 mA |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{s}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range, $T_{A}$ |  |
| UGS-3030T/U | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| UGN-3030T/U | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $V_{C C}=4.5 \mathrm{~V}$ to $24 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point* | $\mathrm{B}_{0}$ |  | - | 160 | 250 | Gauss |
| Release Point* | $\mathrm{B}_{\text {RP }}$ |  | $-250$ | 110 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ |  | 20 | 50 | - | Gauss |
| Output Saturation Voltage | $V_{\text {SAT }}$ | $\mathrm{B} \geq 250$ Gauss, $I_{\text {SIINK }}=20 \mathrm{~mA}$ | - | 100 | 400 | mV |
| Output Leakage Current | $\mathrm{I}_{\text {off }}$ | $B \leq-250$ Gauss, $\mathrm{V}_{\text {out }}=24 \mathrm{~V}$ | - | 0.1 | 1.0 | $\mu \mathrm{A}$ |
| Supply Current | $I_{c c}$ | $V_{C C}=4.5 \mathrm{~V}$, Output Open | - | 2.5 | 5.0 | mA |
|  |  | $V_{\text {cc }}=24 \mathrm{~V}$, Output Open | - | 3.5 | 7.0 | mA |
| Output Rise Time | $\mathrm{t}_{\mathrm{t}}$ | $\begin{aligned} & V_{c C}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 100 | - | ns |
| Output Fall Time | $t_{\text {f }}$ | $\begin{aligned} & V_{c C}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & C_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 500 | - | ns |

[^45]
## OPERATION

The output transistor is normally OFF when the magnetic field perpendicular to the surface of the chip is below the threshold or Operate Point. When the field exceeds the Operate Point, the output transistor switches ON and is capable of current-sinking 25 mA .

The output transistor switches OFF when the magnetic field is reduced below the "release point'" which is less than the "operate point." This is illustrated graphically in the transfer characteristics curve. The hysteresis characteristic provides for unambiguous or non-oscillatory switching.

## SENSOR-CENTER LOCATION



Dwg.No. A-11,912 A

TRANSFER CHARACTERISTICS SHOWING HYSTERESIS


MAGNETIC FLUX DENSITY
Dwg. No. A-11,040

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.032^{\prime \prime} \pm 0.002^{\prime \prime}(0.81 \pm 0.05 \mathrm{~mm})$ below the branded surface of the " T '" package, $0.012^{\prime \prime} \pm 0.002^{\prime \prime}(0.305 \pm 0.05 \mathrm{~mm})$ below the branded surface of the " $U$ "' package.
The magnetic circuit must provide a +250 gauss to - 250 gauss magnetic flux density range at this point for all conditions to ensure reliable operation; + gauss indicates a South pole is toward the branded face of the package; - gauss indicates a North pole is toward the branded package face.

The simplest form of magnet that will operate the Hall Effect bipolar digital switch is a multipole ring magnet as shown. Such magnets are commercially available and inexpensive.

SWITCH ACTIVATION WITH MULTIPOLE RING MAGNET


## GUIDE TO INSTALLATION

1. All Hall Effect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}(3.18 \mathrm{~mm})$ to the epoxy package.

# UGN-3040T ULTRA-SENSITIVE HALL EFFECT DIGITAL SWITCH 

## FEATURES

- Operate from 4.5 V to 24 V D-C Power Source
- Operable With Small Permanent Magnets
- Solid-State Reliability - No Moving Parts
- Small Size
- Constant Amplitude Output
- Output Compatible With All Digital Logic Families

THE SPRAGUE TYPE UGN-3040T is a magnetically-activated electronic switch with extreme sensitivity for use with small, inexpensive magnets, or with relatively large magnet-toswitch distances.

Each circuit consists of a voltage regulator, Hall voltage generator, signal amplifier, Schmitt trigger circuit, and an open collector output driver integrated in a single silicon chip.

The on-board regulator permits operation over a wide range of supply voltages. Circuit output can be interfaced directly with bipolar or MOS logic circuits, and will typically operate up to a 100 kHz repetition rate.

The UGN-3040T is packaged in a miniature 3-pin single-output plastic " $T$ " pack.


## ABSOLUTE MAXIMUM RATINGS

| Power Supply, VCC | 25 V |
| :---: | :---: |
| Magnetic Flux Density, B | Unlimited |
| Output "OFF" Voltage, V Out(OFF $^{\text {a }}$ | 25 V |
| Output "ON" Current, İINK | 25 mA |
| Storage Temperature Range, Is . | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=4.5 \mathrm{~V}$ to $24 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point | $\mathrm{B}_{0}$ |  | - | 150 | 200 | Gauss |
| Release Point | $\mathrm{B}_{\text {RP }}$ |  | 50 | 100 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ |  | 20 | 50 | - | Gauss |
| Output Saturation Voltage | $V_{\text {SAI }}$ | $\mathrm{B} \geq 200$ Gauss, $\mathrm{I}_{\text {smk }}=20 \mathrm{~mA}$ | - | 85 | 400 | mV |
| Output Leakage Current | $\mathrm{l}_{\text {Off }}$ | $B \leq 50$ Gauss, $\mathrm{V}_{\text {out }}=24 \mathrm{~V}$ | - | 0.1 | 20 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{I}_{\text {cc }}$ | $\mathrm{V}_{\text {cc }}=4.5 \mathrm{~V}$, Output open | - | 5.0 | 9.0 | mA |
|  |  | $\mathrm{V}_{\mathrm{cc}}=24 \mathrm{~V}$, Output open | - | 6.0 | 14 | mA |
| Output Rise Time | $\mathrm{t}_{5}$ | $\begin{aligned} & V_{\mathrm{cc}}=12 \mathrm{~V}, R_{\mathrm{L}}=820 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 15 | - | ns |
| Output Fall Time | $\mathrm{t}_{\mathrm{t}}$ | $\begin{aligned} & V_{\mathrm{cc}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF} \end{aligned}$ | - | 100 | - | ns |

## Guide to Installation

1. All HallEffect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}(3.18 \mathrm{~mm})$ to the epoxy package.

## SWITCHING POINT AS A FUNCTION OF TEMPERATURE



> These Hall effect devices are also available in a miniature 3-pin plastic ' $U$ "' package. The " $T$ "' package is 0.080 ' ( 2.03 mm ) thick; the " $U$ "' package is $0.061^{\prime \prime}$ ( 1.54 mm ) thick. All other dimensions are identical.

## OPERATION

The simplest form of magnet which will operate the Hall Effect digital sensor is a bar magnet as shown. Other methods are possible.

In the illustration, the magnet's axis is on the center line of the packaged device and the magnet is moved toward and away from the device. Also, note the orientation of the magnet's south pole in relation to the branded face of the package.


BASIC 'HEAD.ON' MODE OF OPERATION

SENSOR CENTER LOCATION


TRANSFER CHARACTERISTICS SHOWING HYSTERESIS


## OPERATION (Continued)

The output transistor is normally "off"' when the magnetic field perpendicular to the surface of the chip is below the threshold or "operate point." When the field exceeds the "operate point," the output transistor switches "on" and is capable of sinking 25 mA of current. A 50 mA unit is available upon special order.

The output transistor switches "off" when the magnetic field is reduced below the 'release point" which is less than the "operate point." This is illustrated graphically in the transfer characteristics curve. The hysteresis characteristic provides for unambiguous or nonoscillatory switching.

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located $0.032^{\prime \prime} \pm 0.005^{\prime \prime} \quad$ ( 0.81 $\pm 0.127 \mathrm{~mm}$ ) below the branded surface of the T package and $0.012 \pm 0.005^{\prime \prime}(0.30 \pm 0.127 \mathrm{~mm})$ below the branded surface of the $U$ package.
A variety of magnets are commercially available, each exhibiting unique field characteristics. The curves presented below are flux density values for the magnets measured for switch activation in a head-on mode (along the magnet axis). The curves are also pertinent for peak flux density for a given clearance in the slide-by mode of actuation.

## FLUX DENSITY AS A FUNCTION OF AIR GAP



## UGN-3075T/U AND UGS-3075T/U BIPOLAR HALL EFFECT DIGITAL LATCHES

## FEATURES

- Operable with Inexpensive Multipole Ring Magnets
- High Reliability - No Moving Parts
- Small Size
- Output Compatible with All Digital Logic Families
- Symmetrical Output
- High Hysteresis Level Minimizes Stray-Field Problems

THESE MAGNETICALLY-ACTIVATED, solid-state latches are designed for use with inexpensive multipole ring magnets and brushless d-c motors. They provide effective, reliable interface between electromechanical equipment and bipolar or MOS logic circuits at switching frequencies of up to 100 kHz .

The bipolar output of these devices saturates when the Hall cell is exposed to a magnetic flux density greater than the ON threshold ( 100 G typical, 250 G maximum). The output transistor remains in the ON state until magnetic field reversal exposes the Hall cell to a magnetic flux density below the OFF threshold ( -100 G typical, -250 G minimum). Because the operating state switches only with magnetic field reversal, and not merely with a change in its strength, these integrated circuits qualify as true Hall Effect latches.


Type UGN-3075T/U is rated for operation over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. For applications in more severe environments, Type UGS-3075T/U has an operating temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Both types work with supply voltages of 4.5 to 24 V .

Both Hall Effect latches are supplied in either the $80-\mathrm{mil}(2.03 \mathrm{~mm})$ three-pin plastic " $T$ "' package or the magnetically optimized $60.5-\mathrm{mil}(1.54 \mathrm{~mm})$ three-pin plastic "U' package.

## ABSOLUTE MAXIMUM RATINGS

Power Supply, Vcc ..... 25 V
Magnetic Flux Density, B ..... Unlimited
Output OFF Voltage ..... 25 V
Output ON Current, $I_{\text {SNK }}$ ..... 50 mA
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$
UGS-3075T/U*

$$
-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
$$

$$
\text { UGN-3075T/U . . . . ..................................... }-20^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
$$

[^46]
## Catalog Numbering System



ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 24 V (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operate Point* | $\mathrm{B}_{0 \mathrm{P}}$ |  | 50 | 100 | 250 | Gauss |
| Release Point* | $\mathrm{B}_{\text {RP }}$ |  | -250 | -100 | -50 | Gauss |
| Hysteresis* | $\mathrm{B}_{\mathrm{H}}$ |  | 100 | 200 | - | Gauss |
| Output Saturation Voltage | $V_{\text {SAI }}$ | $B \geq 250$ Gauss, $\mathrm{I}_{\text {SINK }}=20 \mathrm{~mA}$ | - | 85 | 400 | mV |
| Output Leakage Current | $\mathrm{I}_{\text {Off }}$ | $\mathrm{B} \leq-250$ Gauss, $\mathrm{V}_{\text {out }}=24 \mathrm{~V}$ | - | 0.2 | 1.0 | $\mu \mathrm{A}$ |
| Supply Current | $I_{\text {cc }}$ | $\mathrm{B} \leq-250$ Gauss, $\mathrm{V}_{\text {cc }}=24 \mathrm{~V}$, Output Open | - | 3.0 | 7.0 | mA |
| Output Rise Time | t, | $\mathrm{V}_{\text {cC }}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ | - | 100 | - | ns |
| Output Fall Time | $\mathrm{t}_{\mathrm{f}}$ | $\mathrm{V}_{\text {cc }}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ | - | 200 | - | ns |

*Magnetic flux density is measured at most sensitive area of device located $0.032^{\prime \prime} \pm 0.002^{\prime \prime}(0.81 \mathrm{~mm} \pm 0.05 \mathrm{~mm})$ below the branded face of the ' T ' package and $0.012^{\prime \prime} \pm 0.002^{\prime \prime}(0.31 \mathrm{~mm} \pm 0.05 \mathrm{~mm}$ ) below the branded face of the ' $U$ ' package.

## SENSOR-CENTER LOCATION



DWG. NO. A-11,896

## GUIDE TO INSTALLATION

1. All Hall Effect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell, heat sink the leads during hand soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}$ $(3.18 \mathrm{~mm})$ to the epoxy package.

## OPERATION

The output transistor is normally OFF when the strength of the magnetic field perpendicular to the surface of the chip is below threshold or the Operate Point. When the field strength exceeds the Operate Point, the output transistor switches ON and is capable of current sinking 50 mA of current.

The output transistor switches OFF when magnetic field reversal results in a magnetic flux density below the OFF threshold. This is illustrated in the transfer characteristics graph.

The simplest form of magnet that will operate Types UGN-3075T/U and UGS-3075T/U is a ring magnet, as shown in Figure 1. Other methods of operation are possible.


Figure 1

Note that the device latches; that is, a south pole of sufficient strength will turn the device ON. Removal of the south pole will leave the device ON. The presence of a north pole of sufficient strength is required to turn the device OFF.

## ACTIVE AREA DEPTH (AAD)

The magnetic flux density is indicated in the operating-points graph for the active area of the device, which is located $0.032^{\prime \prime}$ ( 0.81 mm ) below the branded surface of the " T "' package and 0.012 ", ( 0.31 mm ) below the branded surface of the " $U$ "' package. Note that, as shown in the plot of magnetic flux density as a function of total effective air gap, the ' $U$ '' package offers a significant advantage in marginal flux density conditions for certain magnetic configurations.

TYPICAL TRANSFER CHARACTERISTICS


Dwg. No. A-11,739

PEAK FLUX DENSITY AS A FUNCTION OF TOTAL EFFECTIVE AIR GAP
Plastic 20-Pole Pair Ring (Radial Poles) $1^{\prime \prime}(25.4 \mathrm{~mm})$ in diameter and $0.2^{\prime \prime}(5.1 \mathrm{~mm})$ long with $0.01^{\prime \prime}(0.25 \mathrm{~mm})$ clearance


## UGN-3076T/U AND UGS-3076T/U BIPOLAR HALL EFFECT DIGITAL LATCHES

## FEATURES

- Operable with Inexpensive Multipole Ring Magnets
- High Reliability - No Moving Parts
- Small Size
- Output Compatible with All Digital Logic Families
- Symmetrical Output
- High Hysteresis Level Minimizes Stray-Field Problems

THESE SOLID-STATE, magnetically-activated latches, designed for use with brushless d-c motors and inexpensive multipole ring magnets, operate as effective, reliable interface between electromechanical equipment and bipolar or MOS logic circuits at switching frequencies of up to 100 kHz .

The bipolar output of these devices saturates when the Hall cell is exposed to a magnetic flux density greater than the ON threshold ( 100 G typical, 350 G maximum). The output transistor remains in the ON state until magnetic field reversal exposes the Hall cell to a magnetic flux density below the OFF threshold ( -100 G typical, -350 G minimum). Because the operating state switches only with magnetic field reversal, and not merely with a change in its strength, these integrated circuits qualify as true Hall Effect latches.


Type UGN-3076T/U is rated for operation over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. For applications in more severe environments, Type UGS-3076T/U has an operating temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Both types work with supply voltages of 4.5 to 24 V .

Both Hall Effect latches are supplied in either the $80-\mathrm{mil}(2.03 \mathrm{~mm})$ three-pin plastic " $T$ '" package or the magnetically optimized $60.5-\mathrm{mil}(1.54 \mathrm{~mm})$ three-pin plastic " $U$ '' package.

## abSOLUTE MAXIMUM RATINGS

| Power Supply, V ${ }_{\text {cc }}$ | ..... . 25 V |
| :---: | :---: |
| Magnetic Flux Density, B | Unlimited |
| Output OFF Voltage | 25 V |
| Output ON Current, $I_{\text {SWK }}$ | 50 mA |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ |  |
| UGS-3076T/U* | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| UGN-3076T/U | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{S}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

*Selected devices are available with a maximum $\mathrm{T}_{\mathrm{A}}$ rating of $+150^{\circ} \mathrm{C}$.

> Additional information on all Hall Effect devices is available from:
> Sprague Electric Company Hall Effect IC Marketing 70 Pembroke Road
> Concord, New Hampshire 03301
> (603) 224-1961

# Catalog Numbering System 



ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 24 V (unless otherwise noted)

| Characteristic | Symbol | Test Conditions |  |  |  |  |  |  | Min. | Typ. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operate Point* | $\mathrm{B}_{\text {OP }}$ |  | 50 | 100 | 350 | Gauss |  |  |  |  |  |  |
| Release Point* | $\mathrm{B}_{\mathrm{RP}}$ |  | -350 | -100 | -50 | Gauss |  |  |  |  |  |  |
| Hysteresis* | $\mathrm{B}_{\mathrm{H}}$ |  | 100 | 200 | - | Gauss |  |  |  |  |  |  |
| Output Saturation Voltage | $\mathrm{V}_{\text {SAT }}$ | $\mathrm{B} \geq 350$ Gauss, $\mathrm{I}_{\text {SIMK }}=20 \mathrm{~mA}$ | - | 85 | 400 | mV |  |  |  |  |  |  |
| Output Leakage Current | $\mathrm{I}_{\text {OFF }}$ | $\mathrm{B} \leq-350$ Gauss, $\mathrm{V}_{\text {OUT }}=24 \mathrm{~V}$ | - | 0.2 | 1.0 | $\mu \mathrm{~A}$ |  |  |  |  |  |  |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}=24 \mathrm{~V}$, Output Open, $\mathrm{B} \leq-350 \mathrm{Gauss}$ | - | 3.0 | 7.0 | mA |  |  |  |  |  |  |
| Output Rise Time | $\mathrm{t}_{\mathrm{r}}$ | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ | - | 100 | - | ns |  |  |  |  |  |  |
| Output Fall Time | $\mathrm{t}_{\mathrm{f}}$ | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ | - | 200 | - | ns |  |  |  |  |  |  |

*Magnetic flux density is measured at most sensitive area of device located $0.032^{\prime \prime} \pm 0.002^{\prime \prime}(0.81 \mathrm{~mm} \pm 0.05 \mathrm{~mm})$ below the branded face of the ' $T$ ' package and $0.012^{\prime \prime} \pm 0.002^{\prime \prime}(0.31 \mathrm{~mm} \pm 0.05 \mathrm{~mm})$ below the branded face of the ' U ' package.

## SENSOR-CENTER LOCATION



## GUIDE TO INSTALLATION

1. All Hall Effect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell, heat sink the leads during hand soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}$ $(3.18 \mathrm{~mm})$ to the epoxy package.

## OPERATION

The output transistor is normally OFF when the strength of the magnetic field perpendicular to the surface of the chip is below threshold or the Operate Point. When the field strength exceeds the Operate Point, the output transistor switches ON and is capable of sinking 50 mA of current.
The output transistor switches OFF when magnetic field reversal results in a magnetic flux density below the OFF Threshold. This is illustrated in the transfer characteristics graph.

The simplest form of magnet that will operate Types UGN-3076T/U and UGS-3076T/U is a ring magnet, as shown in Figure 1. Other methods of operation are possible.


Figure 1

Note that the device latches; that is, a south pole of sufficient strength will turn the device ON. Removal of the south pole will leave the device ON. The presence of a north pole of sufficient strength is required to turn the device OFF.

## ACTIVE AREA DEPTH (AAD)

The magnetic flux density is indicated in the operating-points graph for the active area of the device, which is located $0.032^{\prime \prime}(0.81 \mathrm{~mm})$ below the branded surface of the " T "' package and 0.012 " $(0.31 \mathrm{~mm})$ below the branded surface of the " U " package. Note that, as shown in the plot of magnetic flux density as a function of total effective air gap, the "U" package offers a significant advantage in marginal flux density conditions for certain magnetic configurations.

TYPICAL TRANSFER CHARACTERISTICS


Dwg. No. A-11, 739

PEAK FLUX DENSITY AS A FUNCTION OF TOTAL EFFECTIVE AIR GAP
Plastic 20-Pole Pair Ring (Radial Poles)
$1^{\prime \prime}(25.4 \mathrm{~mm})$ in diameter
and $0.2^{\prime \prime}(5.1 \mathrm{~mm})$ long with $0.01^{\prime \prime}(0.25 \mathrm{~mm})$ clearance


TOTAL EFFECTIVE AIR GAP IN INCHES (ACTIVE AREA DEPTH PLUS CLEARANCE)

Dwg. No. A-11, 741

## UGN-3201M AND UGN-3203M DUAL OUTPUT HALL EFFECT DIGITAL SWITCHES

## FEATURES

- Operate from 5 V to 16 V D-C Power Supply
- Operate With a Small Permanent Magnet
- High Reliability — No Contact Wear or Bounce
- Small Size - 8-Pin DIP
- Constant Amplitude Output
- Dual Open-Collector Outputs

INTENDED for use in position sensing and contactless switching applications, the Types UGN3201M and UGN-3203M switches utilize the Hall Effect for detecting a magnetic field.

Both devices feature identical electrical and environmental characteristics. However, the UGN3201 M has a typical Operate Point of 450 gauss and Release Point of 300 gauss; the UGN-3203M is more sensitive, with a typical Operate Point of 235 gauss and Release Point of 100 gauss. The UGN3203 M may be activated by smaller magnets, or at a greater magnet-device spacing.

The UGN-3201M and UGN-3203M Hall Effect digital switches are supplied in 8-pin dual in-line plastic packages. These switches were originally introduced as device numbers ULN-3006M and ULN-3007M, respectively.


## ABSOLUTE MAXIMUM RATINGS



ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=12 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point | $\mathrm{B}_{0}$ | UGN-3201M | - | 450 | 750 | Gauss |
|  |  | UGN-3203M | - | 235 | 350 | Gauss |
| Release Point | $\mathrm{B}_{\text {RP }}$ | UGN-3201M | 100 | 300 | - | Gauss |
|  |  | UGN-3203M | 25 | 100 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ | UGN-3201M | - | 150 | - | Gauss |
|  |  | UGN-3203M | - | 135 | - | Gauss |
| Output Saturation Voltage | $V_{\text {SAT }}$ | $B \geq 350$ Gauss, $I_{\text {SINK }}=20 \mathrm{~mA}$ | - | - | 400 | mV |
| Output Leakage Current | $\mathrm{I}_{\text {OfF }}$ | $\mathrm{B} \leq 25$ Gauss, $\mathrm{V}_{\text {out }}=12 \mathrm{~V}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{l}_{\mathrm{cc}(1)}$ | $\mathrm{B} \leq 25$ Gauss, Outputs open | - | 20 | 25 | mA |
|  | $\mathrm{I}_{\mathrm{cc}(0)}$ | $B \geq 350$ Gauss, Outputs open | - | 20 | 25 | mA |

## Guide to Installation

1. All HallEffect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}(3.18 \mathrm{~mm})$ to the epoxy package.

## ‘M' PACKAGE

## DIMENSIONS IN INCHES



Additional information on all Hall Effect devices is available from:

Sprague Electric Company
Hall Effect IC Marketing
70 Pembroke Road
Concord, New Hampshire 03301
(603) 224-1961

## OPERATION

The output transistors are normally "off"' when the magnetic field perpendicular to the surface of the chip is below the threshold or "operate point." When the field exceeds the 'operate point,' the output transistors switch 'on'" and will each typically sink 20 mA .

The output transistors switch 'off'" when the magnetic field is reduced below the "release point" which is less than the "operate point." This is illustrated graphically in the transfer characteristic curves. The hysteresis characteristic provides for unambiguous or non-oscillatory switching regardless of the rate of change of the magnetic field.

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.037^{\prime \prime} \pm 0.001^{\prime \prime}$ ( $0.94 \pm 0.05$ mm ) below the top surface of the package.

For reference purposes, both an Alnico VIII magnet, $0.212^{\prime \prime}(5.38 \mathrm{~mm})$ in diameter and $0.187^{\prime \prime}$ $(4.75 \mathrm{~mm})$ long and a samarium cobalt magnet, $0.100^{\prime \prime}$ ( 2.54 mm ) square and $0.040^{\prime \prime}$ ( 1.02 mm ) thick, are approximately 1200 gauss at its surface.

The flux density decays at a high rate as the distance from a pole increases.

As an example, using the Alnico VIII magnet referenced above in good alignment and the pole surface in contact with the branded surface of the package, the flux density at the active Hall sensing area of the device would be approximately 850 gauss ( $0.032^{\prime \prime}$ below the package surface).

The flux density would drop to approximately 600 gauss with an air-gap between the package and the magnet of $0.031^{\prime \prime}$ ( 0.79 mm ).

TYPICAL TRANSFER CHARACTERISTICS SHOWING HYSTERESIS


DWG. NO. A-10. 307
basic 'head-on' mode of operation


## UGN-3220S <br> LOW-COST DUAL OUTPUT HALL EFFECT DIGITAL SWITCH

## features

- Operate from 4.5 V to 16 V D-C Power Source
- Operable With a Small Permanent Magnet
- High Reliability - Eliminates Contact Wear, Contact Bounce
- No Moving Parts
- Small Size
- Outputs Compatible With All Logic Families
- Operation to 100 kHz
- Dual Output Transistors Can Drive Independent Loads

T
YPE UGN-3220S INTEGRATED CIRCUITS are low-cost magnetically-activated electronic switches which utilize the Hall Effect for sensing a magnetic field.

Each circuit consists of a voltage regulator, Hall sensor, signal amplifier, Schmitt trigger, and current sinking output stage, integrated onto a single monolithic silicon chip.

The on-board regulator permits operation over a wide variation of supply voltages. Operation over an extended temperature range is made possible by the careful matching of circuit components - something which can be done economically only on a monolithic circuit.

The circuit output can be interfaced directly with bipolar or MOS logic circuits.


These devices are supplied in a 4-pin single inline molded package.

## ABSOLUTE MAXIMUM RATINGS

Power Supply, $V_{c c}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 17 V
Magnetic Flux Density, B . . . . . . . . . . . . . . . . . . . . . Unlimited
Output OFF Voltage, $V_{\text {outroff }}$. . . . . . . . . . . . . . . . . . . . . . . 17 V
Output ON Current, $I_{\text {sINk }}$. . . . . . . . . . . . . . . . . . . . . . . 25 mA
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots \ldots . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . . .-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=4.5 \mathrm{~V}$ to $16 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point | $\mathrm{B}_{0}$ |  | - | 220 | 350 | Gauss |
| Release Point | $\mathrm{B}_{\mathrm{RP}}$ |  | 50 | 160 | - | Gauss |
| Hysteresis | $\mathrm{B}_{\mathrm{H}}$ |  | 20 | 60 | - | Gauss |
| Output Saturation Voltage | $\mathrm{V}_{\text {SAI }}$ | $\mathrm{B} \geq 350$ Gauss, $\mathrm{I}_{\text {smk }}=15 \mathrm{~mA}$ | - | 110 | 400 | mV |
| Output Leakage Current | $\mathrm{l}_{\text {off }}$ | $\mathrm{B} \leq 50$ Gauss, $\mathrm{V}_{\text {out }}=16 \mathrm{~V}$ | - | 0.1 | 20 | $\mu \mathrm{A}$ |
| Supply Current | $\mathrm{l}_{\mathrm{cc}}$ | $\mathrm{V}_{\text {cc }}=5 \mathrm{~V}, \mathrm{~B} \leq 50$ Gauss | - | 3.5 | 9.0 | mA |

## OPERATION

The output transistors are normally "off" when the magnetic field perpendicular to the surface of the chip is below the threshold or "operate point." When the field exceeds the "operate point," each output transistor switches "on" and is capable of sinking 25 mA of current. Selections to 30 mA are available.

The output transistors switch "off" when the magnetic field is reduced below the "release point" (which is less than the "operate point"). This is illustrated graphically in the transfer characteristics curve. The hysteresis characteristic provides for unambiguous or non-oscillatory switching.

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.032^{\prime \prime} \pm 0.002^{\prime \prime}$ ( $0.81 \pm 0.05$ mm ) below the branded surface of the package.

For reference purposes, both an Alnico VIII magnet, $0.212^{\prime \prime}$ ( 5.38 mm ) in diameter and $0.187^{\prime \prime}$ $(4.75 \mathrm{~mm})$ long and a samarium cobalt magnet, $0.100^{\prime \prime}$ ( 2.54 mm ) square and $0.040^{\prime \prime}(1.02 \mathrm{~mm}$ ) thick, are approximately 1200 gauss at its surface.

The flux density decays at a high rate as the distance from a pole increases.

As an example, using the Alnico VIII magnet referenced above in good alignment and the pole surface in contact with the branded surface of the package, the flux density at the active Hall sensing area of the device would be approximately 850 gauss ( $0.032^{\prime \prime}$ below the package surface).

The flux density would drop to approximately 600 gauss with an air-gap between the package and the magnet of $0.031^{\prime \prime}(0.79 \mathrm{~mm})$.

BASIC 'HEAD-ON' MODE OF OPERATION
transfer characteristics showimg hysteresis



Additional information on all Hall Effect devices is available from:

Sprague Electric Company Hall Effect IC Marketing 70 Pembroke Road Concord, New Hampshire 03301 (603) 224-1961

## UGN-3501M SOLID-STATE LINEAR OUTPUT HALL EFFECT SENSOR

## FEATURES

- Excellent Sensitivity
- Flat Response to 25 kHz (typ.)
- Internal Voltage Regulation
- Excellent Temperature Stability

UTILIZING THE HALL EFFECT for sensing a magnetic field, Type UGN-3501M ICs provide a linear differential output which is a function of magnetic field intensity.

These devices are intended for applications requiring accurate measurement and/or control of position, weight, thickness, velocity, etc.

The Type UGN-3501M Hall Effect IC includes a monolithic Hall cell, linear differential amplifier, differential emitter follower output, and a voltage regulator. Integrating the Hall cell and the amplifier into one monolithic device minimizes problems related to the handling of millivolt analog signals.

Provisions are included for output offset null. This sensor is supplied as a 8 -pin dual in-line plastic package and is rated for continuous operation over the temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and a voltage range of 8 to 16 volts $d-c$.


## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . +16 V
Output Current, I Iout . . . . . . . . . . . . . . . . . . . . . . . . . . 2 mA Magnetic Flux Density, B . . . . . . . . . . . . . . . . . . . . . . Unlimited Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . . . . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ Storage Temperature Range, $T_{S} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=12 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage | $\mathrm{V}_{\text {cc }}$ |  | 8.0 | - | 16 | $V$ |
| Supply Current | $\mathrm{I}_{\text {c }}$ | $\mathrm{V}_{\text {cc }}=16 \mathrm{~V}$ | - | 10 | 18 | mA |
| Output Offset Voltage | $V_{\text {Off }}$ | $B=0$ Gauss, R-5-6-7 $=0 \Omega$, Note 1 | - | 100 | 400 | mV |
| Output Common Mode Voltage | $V_{\text {cm }}$ | $B=0$ Gauss, Note 1 | - | 3.6 | - | V |
| Sensitivity | $\Delta \mathrm{V}_{\text {our }}$ | $B=1000 \text { Gauss, R5-6-7 }=0 \Omega \text {, }$ Notes 1,2 | 700 | 1400 | - | mV |
| Sensitivity | $\Delta \mathrm{V}_{\text {out }}$ | $\begin{aligned} & B=1000 \text { Gauss, } \mathrm{R} 5-6=15 \Omega \text {, } \\ & \text { Notes } 1,2 \end{aligned}$ | 650 | 1300 | - | mV |
| Frequency Response | BW | R5-6-7 $=0 \Omega, \mathrm{f}_{H}-\mathrm{f}_{L}$ at -3 dB | - | 25 | - | kHz |
| Broadband Output Noise | $\mathrm{e}_{\mathrm{n}}$ | $\begin{aligned} & f=10 \mathrm{~Hz} \text { to } 10 \mathrm{kHz}, \\ & \mathrm{R} 5-6-7=0 \Omega \end{aligned}$ | - | 0.15 | - | mV |
| Output Offset Voltage vs. Temperature | $\Delta \mathrm{V}_{\text {off }} / \Delta \mathrm{T}$ | R5-6-7 $=0 \Omega$ | - | 0.20 | - | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |

NOTE 1. All output voltage measurements are made with a voltmeter having an input impedance of $10 \mathrm{k} \Omega$ or greater and a common-mode rejection ratio greater than 60 dB .
2. Magnetic flux density is measured at the most sensitive area of the device, which is on the top center, $0.037 \pm 0.001^{\prime \prime}(0.94 \pm 0.03 \mathrm{~mm})$ below the surface.

## NORMALIZED SENSITIVITY

 AS A FUNCTION OF VCC

RELATIVE OUTPUT VOLTAGE
AS A FUNCTION OF LOAD RESISTANCE


NORMALIZED SENSITIVITY
AS A FUNCTION OF TEMPERATURE


OUTPUT VOLTAGE AS A FUNCTION OF MAGNETIC FLUX DENSITY


Additional information on all
Hall Effect devices is available from:
Sprague Electric Company
Hall Effect IC Marketing
70 Pembroke Road
Concord, New Hampshire 03301
(603) 224-1961

## OUTPUT VOLTAGE

## NOISE SPECTRAL DENSITY

## AS A FUNCTION OF AIR GAP



## Guide to Installation

1. All HallEffect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}(3.18 \mathrm{~mm})$ to the epoxy package.
3. If a zeroing potentiometer is used, minimize lead lengths from it and isolate these leads from output leads if possible. In some cases, it may be more practical to limit the frequency response with an output RC network to prevent oscillation.

## DIMENSIONS IN INCHES



DIMENSIONS IN MILLIMETRES
Based on $1 \mathrm{in} .=25.4 \mathrm{~mm}$


## UGN-3501T SOLID-STATE LINEAR OUTPUT HALL EFFECT SENSOR

## FEATURES

- Excellent Sensitivity
- Flat Response to 25 kHz (typ.)
- Internal Voltage Regulation
- Excellent Temperature Stability

UJTILIZING THE HALL EFFECT for sensing a magnetic field, Type UGN-3501T integrated circuits provide a linear single-ended output which is a function of magnetic field intensity.

These devices are used principally to sense relatively small changes in a magnetic field changes which are too small to operate a Hall effect switching device. They are customarily capacitively coupled to an amplifier, which boosts the output to a higher level.

The Type UGN-3501T Hall Effect IC includes a monolithic Hall cell, linear amplifier, emitter follower output, and a voltage regulator. Integrating the Hall cell and the amplifier into one monolithic device minimizes problems related to the handling of millivolt analog signals.

This sensor is supplied a a 3-pin plastic package and is rated for continuous operation over the temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and a voltage range of 8 to 12 volts d-c.


## absolute maximum ratings

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . +16 V
Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . 4 mA
Magnetic Flux Density, B . . . . . . . . . . . . . . . . . . . . . Unlimited
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{s} \ldots . . . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

These Hall effect devices are also available in a miniature 3-pin plastic ' $U$ '' package. The " $T$ " package is 0.080 " ( 2.03 mm ) thick; the " $U$ ' package is $0.061^{\prime \prime}(1.54 \mathrm{~mm})$ thick. All other dimensions are identical.

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{cc}}=12 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage | $\mathrm{V}_{\mathrm{cc}}$ |  | 8.0 | - | 12 | V |
| Supply Current | Icc | $\mathrm{V}_{\mathrm{cc}}=12 \mathrm{~V}$ | - | 10 | 20 | mA |
| Quiescent Output Voltage | $V_{\text {our }}$ | $\mathrm{B}=0$ Gauss, Note 1 | 2.5 | 3.6 | 5.0 | V |
| Sensitivity | $\Delta \mathrm{V}_{\text {our }}$ | B $=1000$ Gauss, Notes 1, 2 | 350 | 700 | - | mV |
| Frequency Response | BW | $\mathrm{f}_{\mathrm{H}}-\mathrm{f}_{\mathrm{L}}$ at -3 dB | - | 25 | - | kHz |
| Broadband Output Noise | $\mathrm{e}_{\mathrm{n}}$ | $\mathrm{f}=10 \mathrm{~Hz}$ to 10 kHz | - | 0.1 | - | mV |
| Output Resistance | $\mathrm{R}_{0}$ |  | - | 100 | - | $\Omega$ |

[^47]NORMALIZED SENSITIVITY AS A FUNCTION OF VCC


OUTPUT VOLTAGE AS A FUNCTION OF MAGNETIC FLUX DENSITY


NORMALIZED SENSITIVITY AS A FUNCTION OF TEMPERATURE


OUTPUT VOLTAGE AS A FUNCTION OF AIR GAP


NOISE SPECTRAL DENSITY


# Typical Applications of Hall Effect Linear Sensors 



LOBE OR COG SENSOR

## NOTCH OR HOLE SENSOR



For reference only - an Alnico VIII permanent magnet, $0.212^{\prime \prime}$ ( 5.38 mm ) in diameter and $0.187^{\prime \prime}(4.75 \mathrm{~mm}$ ) long is approximately 800 gauss at the surface. A samarium cobalt perma-
nent magnet, $0.100^{\prime \prime}(2.54 \mathrm{~mm})$ square and $0.040^{\prime \prime}(1.02 \mathrm{~mm})$ thick is approximately 1200 gauss at its surface.

## Guide to Installation

1. All Hall Effect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}$ ( 3.18 mm ) to the epoxy package.

## UGN-3604M AND UGN-3605M HALL EFFECT SENSORS

THE MOST BASIC Hall Effect magnetic field sensors are the Type UGN- 3604 M and UGN3605 M . The differential output of the devices is a function of the magnetic flux density present at the sensor. Sensitivity is a function of the control current: sensitivity increases as the control current increases.

The UGN-3604M and UGN-3605M are most often used for magnetic circuit design, analysis, testing and alignment, and for calibrating magnetic sensing devices.

The UGN-3604M is supplied in an 8-pin DIP package, with a calibration chart. The UGN-3605M is the same device without the calibration chart.

Each Type UGN-3604M Hall Effect sensor is individually calibrated at a temperature of $+25^{\circ} \mathrm{C}$ using a supply voltage of 5 -volts. The calibration chart supplied indicates differential output values for a magnetic flux density range from 0 gauss to 1000 gauss. Sensitivity at this supply voltage level is typically 40 mV per 1000 gauss.

Since the differential output voltage is a linear function of the magnetic flux density, other readings are easily interpolated.


The UGN-3605M is intended to be used primarily as a sensing device. When operated from a constant current source of 3 mA the device provides a typical sensitivity of 60 mV per 1000 gauss. This is the preferred biasing method, to achieve the most stable output voltage vs. temperature.

## ABSOLUTE MAXIMUM RATING

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ ..... 7 V
Supply Current, $\mathrm{I}_{\mathrm{cc}}$ ..... 10 mA
Magnetic Flux Density, B ..... Unlimited
Operating Temperature Range, $T_{A}$. ..... $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S}$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Control Current | $\mathrm{I}_{\mathrm{cc}}$ | Notes 1, 2 | - | 3.0 | 7.0 | mA |
| Control Resistance | $\mathrm{R}_{1-3}$ | - | 1.0 | 2.2 | 4.5 | k $\Omega$ |
| Control Resistance vs. Temperature | $\Delta R_{1-3} / \Delta T$ | - | - | +0.8 | - | $\% /{ }^{\circ} \mathrm{C}$ |
| Differential Output Resistance | $\mathrm{R}_{2-4}$ | - | 2.0 | 4.4 | 9.0 | $\mathrm{k} \Omega$ |
| Output Offset Voltage | $V_{\text {OfF }}$ | $B=0$ Gauss | - | 5.0 | - | mV |
| Output Offset Voltage vs. Temperature | $\Delta \mathrm{V}_{\text {off }} / \Delta \mathrm{T}$ | $B=0$ Gauss | - | 30 | - | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Sensitivity | $\Delta V_{\text {our }} / \Delta \mathrm{B}$ | Note 1 | - | 0.06 | - | $\mathrm{mV} / \mathrm{G}$ |
| Sensitivity vs. Temperature | $\Delta V_{\text {our }} / \Delta \mathrm{B}$ | $\mathrm{I}_{\mathrm{cc}}=1.5 \mathrm{~mA}$ | - | +0.1 | - | \%/ ${ }^{\circ} \mathrm{C}$ |
|  | $\Delta \mathrm{T}$ |  |  |  |  |  |
| Product Sensitivity | V/A $\times \mathrm{kG}$ | Note 1 | - | 20 | - | - |

[^48]
## Guide to Installation

1. All HallEffect integrated circuits are susceptible to mechanical stress effects. Caution should be exercised to minimize the application of stress to the leads or the epoxy package.
2. To prevent permanent damage to the Hall cell integrated circuit, heat-sink the leads during hand-soldering. For wave soldering, the part should not experience more than $260^{\circ} \mathrm{C}$ for more than five seconds. Solder flow should be no closer than $0.125^{\prime \prime}(3.18 \mathrm{~mm})$ to the epoxy package.
3. The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.037^{\prime \prime} \pm 0.001^{\prime \prime}(0.94 \pm 0.03 \mathrm{~mm})$ below the top surface of the package.
4. For reference purposes, an Alnico VIII magnet, $0.212^{\prime \prime}(5.38 \mathrm{~mm})$ in diameter and $0.187^{\prime \prime}$

## DIMENSIONS IN INCHES


( 4.75 mm ) long or a samarium cobalt magnet, $0.100^{\prime \prime}$ ( 2.54 mm ) square and $0.040^{\prime \prime}(1.02 \mathrm{~mm}$ ) thick, is approximately 1200 gauss at its surface.
Note that the flux density decays at a high rate as the distance from a pole increases. In most cases, this is a relatively linear decrease in the region of interest, and it may range from 5 to 20 gauss $/$ mil.

DIMENSIONS IN MILLIMETRES
Based on $1 \mathrm{in} .=25.4 \mathrm{~mm}$


## Additional information on all Hall Effect devices is available from:

## Sprague Electric Company

Hall Effect IC Marketing
70 Pembroke Road
Concord, New Hampshire 03301
(603) 224-1961

## Hall Effect IC Application Guide

SPRAGUE ELECTRIC uses the latest linear integrated circuit technology in combination with the $100^{+}$year old Hall Effect to produce Hall Effect ICs. These are magnetically activated switches and sensors with the potential to simplify and improve systems designed for switch and sensor applications.

## Simplified Switching At Low Cost

Simplified switching is a Hall switch feature. Sprague Hall Effect ICs combine Hall voltage generators, signal amplifiers, Schmitt trigger circuits and transistor output circuits on an IC chip. Output is clean, fast, and switched with no bounce, an inherent problem in mechanical contact switches. A Sprague Hall Effect IC switch costs less than many common electromechanical switches.

## Efficient, Effective Low-Cost Sensors

A Hall Effect sensor detects the motion, position, or change in field strength of an electromagnet, a permanent magnet, or a ferromagnetic material with an applied magnetic bias. Output is linear and temperature stable. Energy consumption is significantly low. Response is independent of the velocity of the field being sensed.

A Sprague Hall Effect IC sensor can be more efficient and effective than inductive or optoelectronic sensors and at lower cost.

## Sensitive Circuits For Rugged Service

The Hall Effect IC is virtually immune to environmental contaminants, is particularly rugged, and is suitable for use under severe service conditions. These circuits are very sensitive, providing reliable, repetitive operations in close tolerance applications. The Hall Effect IC can 'see'' precisely through dirt and darkness.

Sprague Hall Effect IC switches and sensing systems cost less than most optoelectronic switch and sensor circuits.

HALL EFFECT SWITCH OUTPUT WAVEFORM


REED RELAY OUTPUT WAVEFORM


HALL EFFECT SENSOR LINEAR OUTPUT


## HISTORY AND THE HALL EFFECT

E. H. Hall, at Johns Hopkins University in 1879, first noted the effect that bears his name. A magnetic field applied to a conductor carrying current produces a voltage across the conductor as shown in Figure 6.

The effect is caused by electron deflection within the solid, concentrating the negative charges to one side or the other depending on the influence of the magnetic lines of force. The difference in potential is called the Hall voltage.

The ratio $V t / I H$ is the Hall Coefficient. ( $V$ is the Hall voltage, $t$ the material thickness, $I$ the primary current flow, and $H$ the magnetic field.) This ratio is a constant for a given material.
H. A. Lorentz and Paul Drude developed theories of conduction which apparently accounted for the Hall Effect early in this century. Subsequently the Hall Effect was widely used to study conductivity of materials, with a Hall Coefficient assigned as a means of classification.

Attempts to classify some specific materials such as lead sulphide and silicon produced baffling, contradictory data. The introduction of quantum mechanics in 1926 provided a means for clarification of these problems and other difficulties associated with semiconductor materials.

A proper understanding of semiconductor theory, impurity conduction, junction theory and the fundamental approaches to semiconductor device design did evolve out of studies using the Hall Effect.

The Hall voltage is proportional to the crossproduct Ix $H$ (Current x Field). A device that exhibits the Hall Effect is a multiplier: if current flow is constant, the Hall voltage will be proportional to the magnetic field applied; if the magnetic field is constant, the Hall voltage will be proportional to the current flow.

Early Hall Effect devices found limited application as wattmeters or gaussmeters. Such devices were complex, expensive, and susceptible to noise and temperature variations. It was difficult to achieve useful Hall voltage levels.

Production of Hall Effect integrated circuits have eliminated the problems associated with discrete component circuit designs. The Hall Effect ICs are simple, inexpensive, virtually immune to noise, and are temperature stable. Amplifier circuits integral to the devices produce useful electrical output levels.


## SOME CURRENT HALL EFFECT IC APPLICATIONS -

Ignition Systems
Speed Controls
Speedometer Pickups
Security Systems
Alignment Controls
Mechanical Limit Switches
(computers)
(printers)
(floppy discs)
(sewing machines)
(record players)
(machine tools)
Current Sensors
Current Limit Switches
Linear Potentiometers
Position Detectors
Keyboard/Keyswitch
Selector Switches Pushbutton Switches Micrometers

## HALL EFFECT SWITCH and SENSOR APPLICATIONS AREAS -

## Appliances

Automotive OEM
Automotive Aftermarket
Business Machines
Communications
Computers/Peripherals
Controls
Entertainment Products
Industrial and Commercial Switches
Instrumentation
Keyboard/Keyswitch
Machinery
Machine Tools
Military Systems and Equipment
Power Supplies
Test Equipment

## TYPICAL APPLICATIONS



## What Does A Hall Effect Switch Do?

Switch designers have obtained high performance switching characteristics with the use of photoelectric switching, capacitive circuits, mercury wetting switches, proximity devices and magnetic pickup techniques. Such designs have unique characteristics suitable for one or more specific applications. In general these designs are usually more complex and more expensive than Hall Effect IC switches performing similar functions.

Snap-action or reed switches have been used wherever the switch life, speed and reliability per-
mitted, primarily because of their low cost. Some applications require performance standards not available in electro-mechanical switches.

Sprague Electric Hall Effect IC switches provide high-performance switching characteristics at costs comparable with snap-action or reed switches.

The devices are very small. The 3-lead ' $T$ ', pack units are $0.18^{\prime \prime} \times 0.18^{\prime \prime} \times 0.08^{\prime \prime}$. The cost is as low as the devices are small.

## Whatever Turns Them On...

The application of Hall Effect switches is not very different from other switching methods. A means for mounting and making electrical connections must be provided. Supply voltage, load, environment and ambient temperature range must fall within limits specified in the applicable engineering bulletin.

Hall Effect switches incorporate a voltage regulator, a Hall voltage generator, a signal amplifier, trigger circuits and output drivers on a single silicon chip.


Switching is dependent on the proximity of an external magnet whose field passes perpendicularly through the Hall voltage generator on the chip face. The Hall generator produces an analog voltage amplified and converted by the trigger circuit to a digital output.

Hall Effect IC switches feature such characteristics as high-speed response and very high cycle rates. Typical rise time (turn-on) is 15 nanoseconds, fall time (turn-off) 100 nanoseconds. These units have the capability for cycling at $100,000 \mathrm{~Hz}$ (cycles-per-second).

Hall Effect IC switches feature constant amplitude output without the bounce characteristics of electromechanical switches. Hall Effect ICs also feature low power consumption: 7 mA is typical.

The magnetic characteristics of the Hall Effect switch are specified in terms of magnetic flux density (in gauss). Typical, maximum, and minimum operate and release points and hysteresis factors are specified.

A built-in hysteresis feature insures that stray magnetic fields from transformers, solenoids, or other associated circuitry will not cause unwanted switch operation. The graph below shows typical hysteresis characteristics for the UGN-3019T switch.

TRANSFER CHARACTERISTICS SHOWING HYSTERESIS


The maximum operate point for the UGN-3019T switch is specified at 500 gauss and the minimum release point at 100 gauss. The maximum hysteresis factor for this switch, however, is 275 gauss. Should the operate point fall near the maximum, the release point will move up as well. Similarly, if the release point falls near the minimum, the operate point will have a correspondingly lower value. The hysteresis factor will remain close to a typical value.

Basic fixed element switch designs will take the maximum and minimum operate and release points into account. However, a configuration which permits adjustment of switch and magnet elements in assembly or operation can take advantage of the closer tolerance hysteresis limits to achieve even more precise switching characteristics.

## Head-On Mode of Operation

The simplest form of magnet which will operate the Hall Effect switch is a rod or bar. The curves below illustrate typical flux density (in gauss) as a function of air gap distance for two rod magnets.
In each case, the magnet is oriented with its axis perpendicular to, and on the center line of, a Hall Effect IC switch. Flux density and air gap distance are measured along the magnet axis and switch centerline.


The magnet is moved toward the switch to activate it and away to release it. This method of operation is commonly referred to as the head-on mode.

The switch used is the Sprague UGN-3019T. The typical operate and typical release points are 420 and 300 gauss, respectively.
An ALNICO V rod magnet $0.25^{\prime \prime}$ in diameter by $1.25^{\prime \prime}$ in length must be $0.18^{\prime \prime}$ or less from the switch to insure operation at the 420 gauss typical operate point. The magnet must be moved to a distance $0.25^{\prime \prime}$ from the switch to insure release, an "operate-release" distance of $1 / 16^{\prime \prime}$ ".
The UGN-3019T can be switched with a larger or stronger magnet over greater distances. Or, the device can be switched with a smaller or weaker magnet provided the air gap between the magnet and the switch is properly decreased.

An ALNICO VIII rod magnet $0.212^{\prime \prime}$ in diameter by $0.187^{\prime \prime}$ in length must be $0.05^{\prime \prime}$ or less from the switch to insure operation at the 420 gauss typical operate point. The magnet must be moved to a distance $0.085^{\prime \prime}$ from the switch to insure release at the 300 gauss typical release point.
Use of the smaller ALNICO VIII rod magnet reduced the on-to-off motion from approx. $1 / 16^{\prime \prime}$ to $1 / 32^{\prime \prime}$.

## MAGNETIC FLUX DENSITY AS A FUNCTION OF AIR GAP

Head-On Mode of Operation



## Slide-By Mode of Operation

Hall Effect switches are often activated by means of a slide-by movement of the magnet past the switch as illustrated below.

The axis of the magnet remains perpendicular to the face of the switch, the air gap remains constant, and the magnet passes close enough to the switch to activate it. The maximum flux density is obtained when the magnet axis is on the switch centerline.

The graph at bottom left shows slide-by characteristics for the same magnet used in the previous head-on mode example. The air gap is $0.01^{\prime \prime}$. Flux density at the switch is a function of the distance between the magnet axis and the switch centerline.

Movement from the operate point to the release point covers only $0.018^{\prime \prime}$. Movement continuing past the switch covers an 'operate-release'' distance of $0.24^{\prime \prime}$, but no change in direction is required.


## Slide-By With Actuator

Magnetic fields may be distorted, interrupted, squeezed, squashed, or focused by various ferromagnetic concentrators, shunts, vanes, flux returns, and actuators. The magnetic circuit improves the efficiency of the magnet by concentrating the magnetic field.

The extent of field distortion can be seen in a comparison of flux density at the switch for a magnet with and without the actuator. Flux density is plotted in a slide-by mode, with a $0.05^{\prime \prime}$ air gap for an ALNICO VIII rod magnet $0.188^{\prime \prime}$ in diameter by $0.938^{\prime \prime}$ in length.

Without the actuator, the flux density across the $0.05^{\prime \prime}$ air gap is not sufficient to activate a UGN3019 T , as illustrated in the graph at bottom right. With the actuator, the 420 gauss operate point is obtained with the magnet axis $0.15^{\prime \prime}$ from the switch centerline.



DWG. NO. 11,117-A

MAGNETIC FLUX DENSITY AS A FUNCTION OF MAGNET AXIS-TO-CENTERLINE DISTANCE Slide-By Mode of Operation


DISTANCE (D) OF MAGNET FROM CENTERLINE (£) INCHES
Dwg. No. A-10,956


DISTANCE (D) OF MAGNET FROM CENTERLINE (Q) INCHES
Dwg. No. A-9011C

## Vane Activation

A ferromagnetic plate or vane moved between the magnet and switch will shunt the field, shielding the switch from the magnet. A movable vane, as shown below, is a most practical device for switching a Hall Effect IC.

Vane activation is often accomplished in a fixed assembly incorporating a magnetic conductor to concentrate and focus the magnetic field through the switch. A ferrous vane is used to shunt the flux, turning the switch off. The magnet, switch and magnetic conductor may be molded in place, eliminating alignment problems, and often producing an extremely rugged completed switch.

A fixed assembly designed for vane activation lends itself to a wide variety of possible switch configurations.

Note the curve at bottom left is an approximation. Several factors influence the switching characteristics of a vane activated Hall Effect switch. The relative position of the vane leading and trailing edges and the strength of the magnet used are of primary importance.

The flux density, vane dimensions, and material

all affect the slope of the flux density curve. $A$ steeper curve will minimize the effect of switching point tolerance and temperature and voltage variation. A stronger magnet reduces the vane travel required to switch the Hall Effect switch.

Switch designers have utilized strong magnets with efficient magnetic circuit design in a fixed element molded assembly to provide a very high flux density and a steep curve. This approach minimizes operate-release point variations with changes in temperature.

A different design approach has used an adjustable air gap, permitting use of a smaller magnet in the magnetic circuit design. This design approach produces a shallow flux density curve, and places severe operate-release point restrictions on the Hall switch required. Vane material is typically greater than $1 / 32^{\prime \prime}$ thick to result in a minimum flux density. This leaves little clearance.

Generally, the physical position of the vane leading and trailing edges, (which determine switch points), the switch characteristics, and the magnet specifications should all be considered as part of an overall switch design. Independent selection of any element can severely restrict the possibilities for designing an effective switch.

The graph at bottom right is a generalization of the principle involved in reducing switching distances and tolerances for vane activated switches. A stronger magnet produces a higher initial flux density and a steeper curve. Note that a steep slope minimizes the effect of temperature changes on the operate point.

FLUX DENSITY AS A FUNCTION OF VANE POSITION
 U:G. Ho. A-10. 354


## Ring Magnets and Bipolar Switches

Multiple-pole ring magnets and Hall Effect bipolar switches are used to monitor or measure rotary motion and are especially useful in high-speed applications: speedometer pickups, rpm indicators, angle indicators, etc.

Rugged inexpensive ceramic or plastic ring magnets incorporate up to 20 magnetic pole pairs per inch of ring diameter. The useful field strength available in this type of magnet construction is approximately 250 gauss to 1000 gauss.

Sprague UGN-3030T and UGS-3030T bipolar digital switches operate in the magnetic field range of 250 gauss (South) to -250 gauss (North) and are intended specifically for operation with multiplepole ring magnets.

Note below that exposure to a single pair of opposite magnetic poles accomplishes a single switching cycle.

## A SINGLE SWITCHING CYCLE FOR A MULTIPLE POLE RING MAGNET USING A UGN-3030T SWITCH



The curves shown are approximations. Actual magnetic field exposure at the switch depends on the field strength available and the magnet-to-switch spacing.

Ring magnets are available with radially-oriented poles or with axially-oriented poles.

The output voltage wave form will be determined by the specific distribution of the operate and release points within the switching range. As with other Hall Effect switches, both points move together within the switching range so that the hysteresis factor remains close to the typical value in all cases, as illustrated in the graph at bottom.

> RADIAL OR AXIAL ORIENTED POLES FOR SWITCH ACTUATION WITH A RING MAGNET


## TRANSFER CHARACTERISTICS SHOWING HYSTERESIS



## MODEL OF A MAGNET

An inexpensive commercially available standard ALNICO VIII magnet* is shown in the scale drawing. The solid lines are maximum operate and minimum release points for a Sprague UGN-3019T switch. The field strength levels indicated by dotted lines are maximum operate and minimum release points for other Sprague Hall Effect IC switches.

The field is unique to this magnet, and is a function of the material used and the geometry and dimensions of the magnet. Increasing the diameter would tend to spread the field. Extending the length of the magnet would strengthen the field.
A variety of magnet materials are commercially available, each exhibiting unique field characteristics. A samarium-cobalt magnet only $0.085^{\prime \prime}$ square by $0.04^{\prime \prime}$ long will produce up to 1200 gauss at its pole surface, more than adequate field strength to operate all Sprague Hall Effect IC switches. The strongest known field available in a permanent magnet is that generated by an ALNICO V magnet capped with a samarium-cobalt rare earth magnet.

The curves below left are flux density values for the magnet measured for switch activation in a head-on mode (along the magnet axis), and for slide-by modes with air gaps of $0.01^{\prime \prime}$ and $0.025^{\prime \prime}$.
fLUX DENSITY CURVES


Dwg. No. A-11,065

## MAGNETIC FIELD MODEL OF AN ALNICO VIII SINTERED ROD MAGNET



The slide-by curves cross each other, reflecting the fact that the field strength contours are not concentric circles.

The magnetic flux density is indicated for the most sensitive area of the device. This area is centrally located and $0.032^{\prime \prime} \pm 0.002^{\prime \prime}$ below the branded surface of the T package and $0.012^{\prime \prime} \pm 0.002^{\prime \prime}$ below the branded face of the $U$ package.

Note that Sprague Hall Effect ICs are designed to be activated by the field generated by a magnetic South pole, applied to the face or branded side of the switch package. The Hall Effect switches will operate with a magnetic North pole of sufficient strength applied to the back of the switch.

A magnetic South pole at the face, and a magnetic North pole at the back of the switch at the same time produce a concentrated field through the switch. A magnetic South pole applied to the reverse side of the switch will offset the effects of a South pole applied to the switch face. Conversely, a North pole may be applied to the back side of the switch so the device is normally on, and a North pole approaching the switch face will turn it off.

[^49]
## LOW-COST HALL EFFECT DIGITAL SWITCHES

Sprague offers 10 different Hall Effect switches from its automated high-volume production, packaging and test facilities in Concord, N.H. These rugged solid-state switches operate with small lowcost commercially available permanent magnets.

The devices feature "no-bounce" contactless switching to $100,000 \mathrm{~Hz}$, circuit operation over a wide range of specified supply voltages ( 4.5 to 25 V ), and constant amplitude output. Output stages are easily interfaced with a variety of output loads.

Each Hall Effect switch is a plastic-packaged monolithic integrated circuit: a voltage regulator,

Hall voltage generator, signal amplifier, trigger circuit and output transistors on a single silicon chip.

Output transistors are normally off until a magnetic activating field exceeds a specified operate point. Switched on the transistors will sink up to 25 mA . See Electrical Characteristics below.

The output transistors switch off when the activating field drops below a specified release point that is a lower value than the operate point. This switching hysteresis characteristic insures unambiguous, non-oscillatory switching.

## FUNCTIONAL BLOCK DIAGRAM TYPE UGN-3201 and UGN-3203 8-Pin DIP and UGN-3220 "S" Pack



OwG. NO. A-10.898

ELECTRICAL CHARACTERISTICS

| Characteristics |  | UGN-3013T/U | $\begin{aligned} & \text { UGN-3019T/U } \\ & \text { UGS-3019T/U } \end{aligned}$ | UGN-3201M | UGN-3203M | $\begin{array}{\|l} \text { UGN-3020T/U } \\ \text { UGS-3020T/U } \end{array}$ | $\begin{array}{\|l\|} \hline \text { UGN-3030T/U } \\ \text { UGS-3030T/U } \end{array}$ | UGN-3040T/U | UGN-3220S |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {cc }}$ Max. <br> $V_{\text {out }}$ Max. <br> (Logical 1) |  | 17 V | 25V |  | $\cdots$ |  | 25 V |  | 17V |
| $\begin{aligned} & I_{\text {IINK Max. }} \\ & (\text { LLogical } 0) \end{aligned}$ |  |  | 5 mA |  |  |  | 25 mA |  | 2(25) mA* |
| Operate Point in Gauss | Max. | 450 | 500 | 750 | 350 | 350 | 250 | 200 | 350 |
|  | Typ. | 300 | 420 | 450 | 235 | 220 | 160 | 150 | 220 |
| Release Point in Gauss | Typ. | 225 | 300 | 300 | 100 | 165 | 110 | 100 | 160 |
|  | Min. | 25 | 100 | 100 | 25 | 50 | -250 | 50 | 50 |
| Package |  | 3-Pin "T" or | or "U' Pack |  | DIP |  | in "T" or "U" P | Pack | 4-Pin "S" Pack |

[^50]
## SUGGESTED OUTPUT LOADS FOR HALL EFFECT SWITCHES

The output of each Sprague Hall Effect switch is a grounded-emitter, open-collector structure. In the absence of a magnetic field the output transistor is OFF and switches ON when the proper field is applied to the associated Hall voltage generator.


With a simple external resistor network the output can be interfaced with transistors, triacs, SCRs or common DTL, TTL, RTL and MOS logic circuits. Any type of load within specified current and voltage limitations is possible. Transient suppression may be required on all inductive loads.

Output is specified in the engineering bulletins in terms of positive logic: low or on voltage level $=0$; high or OFF voltage level $=1$. In the logic ' ' 1 '" state, the output is guaranteed to sustain a specified voltage level. The UGN-3019T is capable of sinking up to 15 mA with a voltage drop of less than 400 mV .


The graph at bottom left illustrates the typical output ON voltage level as a function of temperature for the UGN-3019T.

Below are some suggested interfacing approaches. Many techniques can be used and are discussed in the following pages.


Specific device type numbers are referenced in this section in discussion of applications, loads and interfacing techniques. However, all Sprague Hall Effect switches may be used in the same way provided the total sink current and maximum OFF voltage levels do not exceed values specified for each device.

## HALL EFFECT DEVICES (Continued)

## Switching Common Loads With The UGN-3020T

The UGN-3020T is supplied in a 3-pin plastic " T "' Pack. The branded side of the package is the face. Terminals are, from left-to-right facing the package, the input ( $\mathrm{V}_{\mathrm{CC}}$ ) terminal, common ground and output terminals.

Supply voltage is any value between +4.5 and +24 volts applied between the $\mathrm{V}_{\mathrm{cc}}$ terminal and common ground. The absolute maximum output terminal sink current is 25 mA . Voltage drop at 25 mA is typically 0.2 volts.

Note that the voltage on the output terminal must always be positive ( + ).

The South pole of the magnet shown below will activate the UGN-3020T in a head-on mode, at a typical distance of $0.12^{\prime \prime}$ from the switch face (typical operate point is 220 gauss). The switch is turned OFF by removing the magnet to a distance of $0.16^{\prime \prime}$ from the switch (typical release point is 165 gauss).

## Light-Emitting-Diode

Let's connect a load, a light-emitting-diode. We have a +12 volt supply. We must connect a currentlimiting resistor in series with the diode to keep the ON current under 50 mA maximum, as illustrated below.

If the LED drops 1.4 volt, we need a resistor of $\frac{12 \mathrm{v}-1.4 \mathrm{v}}{.05 \mathrm{~A}}=212 \mathrm{ohms}$. The closest standard value is 220 ohms.


## 40669 Triac

The RCA 40669 triac is often used to control a-c loads up to 8 amperes rms maximum. We must add a current gain stage between the UGN-3020T and the 40669 triac.

When the Hall switch is turned on, it supplies 9 mA of base current to the 2 N 5811 which turns on and supplies 80 mA of drive to the triac. Note that
the +12 volt supply common ground is connected to the low side of the a-c line. Be careful. If the high and low are mixed up the Hall switch could be hot!


## D-C Load 4 Amperes

When the UGN-3030T is activated, base drive is pulled away from the 2N5812. Collector current then flows to the base of the 2 N 3055 . A 4 ampere load can be activated.


TTL/DTL
The popular TTL 7400 series is quite simple to drive. The UGN-3020T, switched ON, will sink the 1.6 mA maximum to operate the 7400 .


## Isolating The Switch From The A-C Line

It is desirable to isolate the Hall Effect switch from the a-c line for many control applications driving line-operated loads. A Fairchild MC-232 photoisolator may be used to accomplish this design.

The activated UGN-3020T will draw current through the LED. The current must be limited to 50 mA . A 5 -volt supply is used. The calculation is

$$
R=\frac{V_{C C}-V_{F}(L E D)}{I}=\frac{5 V-1.4 \mathrm{~V}}{.05 \mathrm{~A}}=72 \mathrm{ohms}
$$

The resistor selected is the closest standard value 68 ohms. The LED drives the detector which supplies 70 mA to drive the triac. Note that the 10 volt power supply, consisting of the 6.3 -volt transformer, diode and capacitor, can supply detector bias for several of these control circuits.


Types UGN-3013T, UGN-3019T, UGS-3019T, UGN-3020T, UGS3020T, UGN-3030T, UGS-3030T, UGN-3040T, and UGN-3501T are supplied in 3-pin plastic " $T$ "' packages 0.080 " ( 2.03 mm ) thick. These Hall effect devices are also available in 3-pin plastic " $U$ '" packages 0.061 ' ( 1.54 mm ) thick. The ' $U$ '' package is specified by replacing the ' $T$ '' suffix to the part number with a ' $U$ '" (UGN-3013U).

## LINEAR OUTPUT HALL EFFECT SENSORS

## TYPE UGN-3501T

Utilizing the Hall Effect for sensing a magnetic field, Type UGN-3501T integrated circuits provide a linear single-ended output which is a function of magnetic field intensity. Integrating the Hall cell and the amplifier into one monolithic device minimizes problems related to the handling of millivolt analog signals.

This sensor, supplied in a 3-pin plastic package, is rated for continuous operation over the temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and a voltage range of 8 to 12 volts d-c.

The functional block diagram for the UGN-3501T is shown below.

FUNCTIONAL BLOCK DIAGRAM


TYPE UGN-3501M
The Type UGN-3501M Hall Effect IC includes a monolithic Hall cell, linear differential amplifier, differential emitter follower output, and a voltage regulator.

Provisions are included for output offset null. This sensor is supplied in an 8-pin dual in-line plastic package and is rated for continuous operation over the temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ and a voltage range of 8 to 16 volts d-c.

The figure below shows the functional block diagram for the UGN-3501M Hall Effect Sensor.

FUNCTIONAL BLOCK DIAGRAM


OUTPUT VOLTAGE AS A FUNCTION OF AIR GAP FOR HEAD-ON MODE OF OPERAT:ON



## APPLICATIONS FOR TYPE UGN-3501T SENSORS

These devices are used principally to sense relatively small changes in a magnetic field - changes which are too small to operate a 'Hall Effect' switching device. They are customarily capacitively coupled to an amplifier, which boosts the output to a higher level.

The UGN-3501T is a single output linear device having a sensitivity of $700 \mathrm{mV} / 1000$ gauss, and output offset which is typically +3.6 volts, at a $\mathrm{V}_{\mathrm{cc}}$ of +12 volts.

The device will respond to magnetic North and South poles directed to the face or reverse side of the 3-pin " $T$ "' package, as illustrated below.


On'G. No. A- 10.971

## OUTPUT VOLTAGE AS A FUNCTION OF MAGNETIC FLUX DENSITY



## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, VCC | 16 V |
| :---: | :---: |
| Output Current, IOUT | 4 mA |
| Magnetic Flux Density, B | No Limit |
| Operating Temperature Range, $T_{A}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Storage Temperature Range, IS. | $6^{6}{ }^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Min. | Typ. | Max. | Units | Notes |
| :--- | :--- | :--- | ---: | :--- | :--- | :--- | :--- |
| Operating Voltage | $\mathrm{V}_{\mathrm{CC}}$ |  | 8.0 | - | 12 | V | - |
| Supply Current | ICC | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | - | 10 | 20 | mA | - |
| Quiescent Output Voltage | $\mathrm{V}_{0 \mathrm{OT}}$ | $\mathrm{B}=0$ Gauss | 2.5 | 3.6 | 5.0 | V | 1 |
| Sensitivity | $\triangle \mathrm{V}_{0}$ OUT | $\mathrm{B}=1000$ Gauss | 350 | 700 | - | mV | 1,2 |
| Frequency Response | $\mathrm{F}(-3 \mathrm{~dB})$ |  | - | 25 | - | kHz | - |
| Broadband Output Noise | $\mathrm{e}_{\mathrm{n}}$ | 3 dB B.W. 10 Hz to 10 kHz | - | 0.10 | - | mV | - |
| Output Resistance | $\mathrm{R}_{0}$ |  | - | 100 | - | $\Omega$ | - |

[^51]
## Ferrous Metal Detector

Two similar detector designs are illustrated below. One senses the presence of a ferrous metal, the other senses an absence of the metal. The two sensing modes are accomplished simply by reversing the magnet poles relative to the UGN-3501T. The pole of the magnet is fixed in contact with the reverse side of the UGN-3501T in both cases.

Frequency response characteristics of this circuit are easily controlled by changing the input decoupling capacitor value for the low-frequency breakpoint. If high-frequency attenuation is desired a capacitor may be used to shunt the feedback resistor.


## Metal Sensor

The North pole of the magnet is fixed to the reverse side of the UGN-3501T. The sensor is in contact with the bottom of a ${ }^{3 / 32^{\prime \prime}}$ epoxy board. A 20 mV peak output change (decrease) is produced as
the $1^{\prime \prime}$ steel ball rolls over the sensor. This signal is amplified by the $\mu \mathrm{A} 741 \mathrm{C}$ to drive the 2 N 8512 ON to carry a 0.5 A collector current.


## Notch Sensor

The South pole of the magnet is fixed to the reverse side of the UGN-3501T. The sensor is $1 / 32^{\prime \prime}$ from the edge of the steel rotor. $\mathrm{A}^{1} / 16^{\prime \prime}$ wide by $1 / 8^{\prime \prime}$ deep slot in the rotor edge passing the sensor causes a 10 mV peak output change (decrease). This signal is amplified by the $\mu \mathrm{A} 741 \mathrm{C}$ to drive the 2N5812 on, carrying a 0.5 A collector current.

Note that in both examples the branded side of the UGN-3501T faces the material (or lack of material) to be sensed. In both cases the presence (or absence) of the ferrous metal changes the flux density at the Hall Effect sensor so as to produce a negative going output pulse. This pulse is inverted by the amplifier to drive the transistor ON.

## Printer Application For The UGN-3501T

The application below is for a sensor that will sense lobes on the character drum. Lobes are spaced
$\approx 3 / 16^{\prime \prime}$ apart around the circumference, are $\approx 1 / 4^{\prime \prime}$ long and rise 10 to 15 mils from the surface of the drum.
 SR8522 magnet. The North pole is fixed to the fixed to the branded face of the "T" pack. Though it does not provide a flux return path, a concentrator will 'focus'' the magnetic field through the switch.

The concentrator "blade" at right is aligned with the drum lobe at an air gap distance of $0.01^{\prime \prime}$. The output change is 10 mV peak, amplified as shown to develop a +3 volt output from the operational amplifier, driving the transistor ON.

Sensitivity is so great in this configuration the UGN-3501T output signal base line tracked the eccentricities in the drum quite closely. This affected the lobe resolution, but the lobe position may still be measured.


DWG. NO. A- 11073

## APPLICATIONS FOR TYPE UGN-3501M SENSORS

Type UGN-3501M sensors are well-suited for accurate measurement and/or control of position, weight, thickness, velocity, current, etc. The device provides a linear differential output which is a function of magnetic field intensity, with a typical sensitivity of 1.4 volts/ 1000 gauss.

Either magnetic pole can be used. Pins 1 and 8 are sinking and sourcing terminals for the differential output. Changing poles inverts the output. Connections may be reversed to account for this change.

The figure below shows a $20 \Omega$ trimmer potentiometer being used for output offset nulling. Pins 5, 6 , and 7 may be shorted if an output offset voltage of up to $\pm 400 \mathrm{mV}$ can be tolerated.


## OUTPUT VOLTAGE

 AS A FUNCTION OF MAGNETIC FLUX DENSITY

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, VCC | +16V |
| :---: | :---: |
| Output Current, IOUT | 2 mA |
| Magnetic Flux Density, B | No Limit |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
|  | $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise specified)

| Characteristic | Symbol | Test Conditions | Min. | Typ. | Max. | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Voltage | $V_{\text {cc }}$ |  | 8.0 | - | 16 | V | - |
| Supply Current | ICC | $\mathrm{V}_{\mathrm{CC}}=16 \mathrm{~V}$ | - | 10 | 18 | mA | - |
| Output Offset Voltage | VOFF | $B=0$ Gauss, R-5-6-7 $=0 \Omega$ | - | 100 | 400 | mV | 1 |
| Output Common Mode Voltage | $V_{C M}$ | $B=0$ Gauss | - | 3.6 | - | $\checkmark$ | 1 |
| Sensitivity | $\triangle V_{\text {OUT }}$ | $\mathrm{B}=1000$ Gauss, R5-6.7 $=0 \Omega$ | 700 | 1400 | - | mV | 1,2 |
| Sensitivity | $\Delta V_{\text {OUT }}$ | $B=1000$ Gauss, R5-6 $=15 \Omega$ | 650 | 1300 | - | mV | 1,2 |
| Frequency Response | $\mathrm{f}(-3 \mathrm{~dB})$ | R5-6-7 $=0$ ¢ | - | 25 | - | kHz | - |
| Broadband Output Noise | $\mathrm{e}_{\mathrm{n}}$ | 3dB B.W. 10 Hz to 10 kHz R5-6-7 $=0 \Omega$ | - | 0.15 | - | mV | - |
| Output Offset Voltage vs $\mathrm{T}\left({ }^{\circ} \mathrm{C}\right)$ | $\Delta \mathrm{V}_{0 \mathrm{FF} / \mathrm{LT}}$ | $\mathrm{R} 5-6-7=0 \Omega$ | - | 0.2 | - | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | - |

[^52]2. Magnetic flux density is measured at the most sensitive area of the device, which is on the top center, $0.037 \pm 0.001^{\prime \prime}(0.94 \pm 0.03 \mathrm{~mm})$ below the surface.

## Motion Measurement With Permanent Magnets

The UGN-3501M, properly biased, will produce the output voltage values shown below when activated in a head-on mode of operation.

Note the output voltage curve is almost linear over the first $0.04^{\prime \prime}$ of travel. The change rate here is 10 $\mathrm{mV} / 0.001^{\prime \prime}$ air gap change.


The same magnet used in a "slide-by" mode of operation will produce the three curves presented at bottom.

Movement measurements would generate the largest outputs and most accurate readings where they are centered on the steepest portion of each curve, and are confined to the linear segment of that curve. This is the case for the head-on and the slideby curves.

For example, in a slide-by mode of operation with an $0.03^{\prime \prime}$ air gap, movement to be measured could be centered at a "zero" of 0.1 " from the centerline. The voltage rate of change would be linear at 5 $\mathrm{mV} / 0.001^{\prime \prime}$ movement, for a movement distance of $\pm 0.02^{\prime \prime}$.

The rate of change is, of course, a function of the flux density gradient across the magnetic field for the particular magnet used. A samarium-cobalt magnet, with its relatively compact field, can produce voltage change rates to $30 \mathrm{mV} / 0.001^{\prime \prime}$ movement.


## UGN-3501M Output Circuit Design

The output current handling capability of the UGN-3501M is 0.5 mA . In the differential connection one output pin sources load current, the other must sink it. A simple method for increasing drive capability is illustrated below.


A $4.3 \mathrm{k} \Omega$ resistor is connected from each output pin to ground. The quiescent bias current of the output stage is increased, and the sinking capability is increased to 1 mA .

If even higher current drive capability is required, the simplest solution is the addition of a pair of emitter-followers:


Up to 30 mA of load current can be sourced by the circuit as shown, and this can be increased considerably by using Darlington power transistors and lower resistance in the emitter circuits.

Note that the emitter-followers have no voltage gain. The output voltage differential is essentially the same as that of the UGN-3501M.

An operational amplifier will supply a voltage gain and a current gain, and transform the differential output of the UGN-3501M to a single-ended output. (The circuit will drive a load which has one side grounded.)


DWi. NO. - 10.950

The LM-324 quad operational amplifier will operate from a single power supply if the output does not swing in the negative direction. Pin 1 of the UGN3501M does swing negative when a magnetic South pole approaches the device surface. Pin 1, therefore, is connected to the negative or inverting input of the LM-324, and its output swings in the positive direction. Reversing connections to pins 1 and 8 allows the output to respond to a magnetic North pole. If the application requires the output be capable of swing both negative and positive, then a dual $\pm$ power supply would have to be used.

$$
\begin{aligned}
& \text { Voltage amplification } \approx \frac{R_{2}}{R_{1}} \\
& \text { with } \\
& R_{1}=R_{3} \\
& R_{2}=R_{4}
\end{aligned}
$$

The LM-324 can source 40 mA . Other operational amplifiers suitable for single supply operation are MC-3403P, MC-3458P1, CA-3160E.

## Current Sensing Applications

The UGN-3501M is ideally suited for current measurement applications. Typical applications are overload detectors for electric motors, current limiters for high-current power supplies, clamp-on current probes for high-current d-c loads, etc.

The standard toroid is typical of small commercially-available electromagnetic devices which can be used with the UGN-3501M:


UGN3501M

With this toroid, the UGN-3501M, fixed in the gap, would "see" 5.6 gauss per ampere-turn. To "read" from zero to 20 amperes, 9 turns would develop $9 \times 20 \times 5.6=1008$ gauss. The UGN3501 M would have a 1.4 volt output with a 20 ampere activating current.

## Eaussmeter Applications

A typical UGN-3501M has a differential output of 1400 mV in a 1000 gauss field. Using a $100 \mu \mathrm{~A}$ movement, with a series calibrating trimmer potentiometer, a simple gaussmeter suitable for many applications can be easily produced:


The UGN-3501M is quite linear to $\approx 1000$ gauss. The input differential stage gain must be reduced to naintain linearity beyond this range.

A $47 \Omega \pm 5 \%$ resistor in series with pins 5 and 6 extends the useful linear range to 3000 gauss:


## Calibrating The UGN-3501M Gaussmeter

Where applications require the differential output voltage at pins 1 and 8 be calibrated, dual precision 100 ohm variable resistors may be used:


A calibration field can be constructed using standard Stancor C-2709 filter chokes, with the pole pieces removed and the center magnetic path completed with a section of the pole piece removed. Brass stock ${ }^{1 / 16^{\prime \prime}} \times 1 / 2^{\prime \prime} \times 43 / 8^{\prime \prime}$ was used for mechanical support, 2 pieces in the front and 2 pieces in the rear, plus $41^{1 / 4^{\prime \prime}} \times 1^{\prime \prime}$ No. 6-32 threaded standoffs. The air gap was set at $3 / /^{\prime \prime}$ as depicted below.


## HALL EFFECT DEVICES (Continued)

The chokes are wired in series opposing, and are driven from a constant current source. Initial calibration may be accomplished with a UGN- 3600 Hall generator supplied with a calibration curve. The current is fixed at the value which produces 1000 gauss.

The UGN-3501M to be calibrated is "zeroed" and placed in the 1000 gauss field. The dual precision variable resistor is adjusted until the output is 1 volt. The UGN-3501M circuit is re-zeroed out of the field and the calibration rechecked.

The value of the precision variable resistor is then measured. Two $1 \%$ resistors of the closest standard value replace these in the final circuit configuration.

## Check Oscillation Problems

The UGN-3501M has a relatively wide band width. Oscillation is the most common problem encountered in applications for the device, caused by excessive lead lengths ( $2^{\prime \prime}$ ) on the zero control, and coupling between the zero control leads and the output leads from pins 1 and 8 . (If moving your hand near the zero control changes the output voltage there are oscillation problems.)

Solutions to oscillation problems are: 1) cut the zero control lead lengths; 2 ) separate the zero control and output leads; and 3) (in extreme cases) use a low-pass filter on the output:


## Sensitivity Variations

Note that the UGN-3501M is specified with a typical sensitivity of $1.4 \mathrm{mV} /$ gauss and a minimum sensitivity of $.7 \mathrm{mV} /$ gauss. Unless a special "sort"" is ordered, plan on this variation.

Note also that the " 0 ", output varies typically $1 \mathrm{mV} /{ }^{\circ} \mathrm{C}$, a major factor in determining a minimum detectable long term signal.

The sensitivity varies with temperature and $\mathrm{V}_{\mathrm{CE}}$. The output voltage is a function of the load resistance. These factors are illustrated in the graphs at right.

NORMALIZED SENSITIVITT AS A FUNCTION OF TEMPERATURE


NORMALIZED SENSITIVITY AS A FUNCTION OF V $\mathbf{c c}$

relative output voltage as a function OF LOAD RESISTANCE


## Type UGN-3604M/UGN-3605M Hall Cells

The UGN-3604M is a basic Hall voltage generator in an 8-pin DIP package, supplied with a calibration chart. Intended for use as a design or production test aid, the UGN-3604M permits accurate measurement of magnetic field inlensity as a means of aligning magnet/Hall switch positions, and for calibrating Hall Effect sensor circuits.
A UGN-3605M is the same Hall voltage generator without a calibration chart. Supply voltage for these units is 5 volts. Below is the terminal pinning diagram for UGN-3605M.


## Applications at Sprague Electric Co. <br> (We use them . . . and love them)

Hall Effect ICs are designed into Sprague's own production and test equipment. Position-sensing digital switches control and monitor high-speed automatic machine operations. Hall Effect switch output provides direct input to a microprocessor-based control unit.

Data is compiled continuously from critical points in the production process. The control informs the machine operator, makes automatic adjustments, indicates manual adjustments which may be necessary, and reports on production.

Hall Effect ICs perform simultaneous control and reporting functions. Extremely reliable precise repetitive operation of these switches helps to achieve and maintain very high levels of process control and roduct quality.

## PACKAGE INFORMATION

Sprague's Hall Effect IC's are packaged in a special epoxy material formulated to handle severe service environments. It is impervious to all commercially available consumer and industrial solvents and degreasing compounds, oils and alkaline chemicals. It is susceptible only to hot $\left(+150^{\circ} \mathrm{C}\right)$ concentrated fuming red nitric acid applied under pressure.

The material has a continuous thermal rating of $+150^{\circ} \mathrm{C}$, and a hot-spot rating ( 100 hours) of $+170^{\circ} \mathrm{C}$. It is classed by Underwriters' Laboratories, Inc. as a self-extinguishing material. Its resistivity is $10^{15}$ ohms. Thermal coefficient of expansion $\left(\mathrm{T}_{\mathrm{G}}\right)$ is $30 \times 10^{-6} \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.

Device leads will meet solderability requirements of Military Standard MIL-STD-202 (95\% or better solder-wetting without special preparation).

## Catalog Numbering System



## 3-Pin "T" Pack or "U" Pack*

LOCATION OF SENSOR CIRCUIT

"The "T" package is 0.080 " ( 2.03 mm ) thick; the " V " package is 0.061 " ( 1.54 mm ) thick; All other dimensions are identical.

## 4-Pin "S" Pack

TERMINAL LEAD DESIGNATION
LOCATION OF SENSOR CIRCUIT


UGN-3220S


## 8-Pin "M" Package

TERMINAL LEAD DESIGNATION

## Magnet Marketplace

A strong field of magnetic components manufacturers can supply parts suitable for use in virtually any conceivable Hall Effect IC application. Comprehensive listings of these suppliers are presented in reference documents such as the Thomas Register.
Many of these firms are familiar with Hall Effect ICs application.

Magnetic components available from these manufacturers include ALNICO, rare-earth, ceramic, and plastic permanent magnets in a variety of form factors such as rods, bars, rings, sheets, etc. Ferromagnetic components for use as electro-magnets, concentrators, actuators, etc. are also available.

Additional information on all Hall Effect devices is available from:

## Sprague Electric Company Hall Effect IC Marketing

 70 Pembroke RoadConcord, New Hampshire 03301
(603) 224-1961


## SENSOR CIRCUIT LOCATION

```
40.8 4 = 0 0. 
```




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# ULN-2031A, ULN-2032A, AND ULN-2033A HIGH-CURRENT DARLINGTON TRANSISTORS ARRAYS 

## S

 PRAGUE TYPE ULN-2031A, ULN-2032A, and ULN-2033A High-Current Darlington Transistor Arrays are comprised of seven silicon Darlington pairs on a common monolithic substrate. The Type ULN-2031A consists of 14 NPN transistors connected to form seven Darlington pairs with NPN action. The Type ULN-2032A ( $\mathrm{h}_{\mathrm{FE}}=500 \mathrm{~min}$.) and the Type ULN-2033A ( $\mathrm{h}_{\mathrm{FE}}=50 \mathrm{~min}$.) consist of seven NPN and seven PNP transistors connected to form seven Darlington pairs with PNP action. All devices feature a common emitter configuration.These devices are especially suited for interfacing between MOS, TTL, or DTL outputs and 7-segment LED or tungsten filament indicators. Peak inrush currents to 100 mA are allowable. They are also ideal for a variety of other driver applications such as relay control and thyristor firing.

Type ULN-2031A, ULN-2032A, and ULN-2033A transistor arrays are housed in 16-lead DIP plastic packages which include a separate substrate connection for maximum circuit design flexibility.


ULN-2031A


ULN-2032A
ULN-2033A

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature (unless otherwise noted)

Power Dissipation (any one Darlington pair) ..... 500 mW
(total package) ..... 750 mW
Derating Factor Above $+25^{\circ} \mathrm{C}$ ..... $6.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
Ambient Temperature Range (operating), $\mathrm{T}_{\mathrm{A}}$. ..... $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, Ts. $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$Individual Darlington Pair Ratings:
Collector-to-Emitter Voltage, $\mathrm{V}_{\text {ceo }}$ ..... 16V
Collector-to-Base Voltage, $V_{\text {сво }}$ ..... 40V
Collector-to-Substrate Voltage, $\mathrm{V}_{\mathrm{cl}}$ ..... 40 VEmitter-to-Base Voltage, $V_{\text {EBO }}$Type ULN-2031A.5 V
Type ULN-2032A and ULN-2033A ..... 40V
Continuous Collector Current, I IC ..... 80 mA
Continuous Base Current, $I_{B}$ ..... 5 mA

## NOTE:

The substrate must be connected to a voltage which is more negative than any collector or base voltage so as to maintain isolation between transistors, and to provide normal transistor action.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Collector-Base Breakdown Voltage | $\mathrm{BV}_{\text {CBO }}$ | $\mathrm{IC}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 40 | - | - | V |
| Collector-Substrate Breakdown Voltage | $\mathrm{BV}_{\mathrm{ClO}}$ | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 40 | - | - | V |
| Collector-Emitter Breakdown Voltage | $B V_{C E O}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ | 16 | - | - | V |
| Emitter-Base Breakdown Voltage <br> Type ULN-2031A <br> Type ULN-2032A and ULN-2033A | $\mathrm{BV}_{\text {EBO }}$ | $\mathrm{I}_{\mathrm{E}}=500 \mu \mathrm{~A}$ | $\begin{array}{r}5 \\ 40 \\ \hline\end{array}$ | - | - | $\begin{aligned} & V \\ & V \end{aligned}$ |
| D-C Forward Current Transfer Ratio Type ULN-2031A and ULN-2032A Type ULN-2033A | $\mathrm{h}_{\mathrm{FE}}$ | $\mathrm{V}_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=20 \mathrm{~mA}$ | $\begin{array}{r} 500 \\ 50 \end{array}$ | - | 500 | - |
| Base-Emitter Saturation Voltage Type ULN-2031A <br> Type ULN-2032A and ULN-2033A | $\mathrm{V}_{\text {be(SAT) }}$ | $\mathrm{I}_{\mathrm{C}}=20 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=500 \mu \mathrm{~A}$ | - | - | $\begin{aligned} & 2 \\ & 1 \\ & \hline \end{aligned}$ | $\begin{aligned} & V \\ & V \end{aligned}$ |
| Collector-Emitter Saturation Voltage <br> Type ULN-2031A and ULN-2032A <br> Type ULN-2033A | $\mathrm{V}_{\text {CE(SAT) }}$ | $\begin{aligned} & I_{\mathrm{C}}=20 \mathrm{~mA}, I_{\mathrm{B}}=40 \mu \mathrm{~A} \\ & I_{\mathrm{C}}=80 \mathrm{~mA}, I_{\mathrm{B}}=1 \mathrm{~mA} \\ & I_{\mathrm{C}}=20 \mathrm{~mA}, I_{\mathrm{B}}=400 \mu \mathrm{~A} \\ & I_{\mathrm{C}}=80 \mathrm{~mA}, I_{\mathrm{B}}=2 \mathrm{~mA} \end{aligned}$ | - | - | 1.2 1.5 1.2 1.5 | $\begin{aligned} & V \\ & V \\ & V \\ & V \end{aligned}$ |
| Collector Cutoff Current | $\begin{aligned} & I_{\mathrm{CEO}} \\ & I_{\mathrm{CBO}} \end{aligned}$ | $\begin{aligned} & V_{C E}=8 \mathrm{~V} \\ & V_{C B}=10 \mathrm{~V} \end{aligned}$ | - | - | $\begin{array}{r} 100 \\ 10 \\ \hline \end{array}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |

# ULS-2045H AND ULN-2046A TRANSISTOR ARRAYS (Three Isolated Transistors and One Differential Amplifier) 

THE ULS-2045H and ULN-2046A are general-purpose transistor arrays each consisting of five silicon N -P-N transistors on a single monolithic chip. Two transistors are internally connected to form a differential pair. Integrated circuit construction provides close electrical and thermal matching between each transistor.

These arrays are well-suited for a wide range of applications such as: DC to VHF signal processing systems; temperature-compensated amplifiers; custom designed differential amplifiers and discrete transistors in conventional circuits.

Two package configurations are available. Type ULS-2045H is supplied in a hermetic 14-lead dual inline ceramic package and is rated for operation over the military temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.


Type ULN-2046A is electrically identical to the ULS2045 H but is supplied in a dual in-line plastic package rated for $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ambients.

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ}$ C Free-Air Temperature (unless otherwise noted)

| Power Dissipation: | ULS-2045H |  | ULN-2046A |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | EACH | TOTAL | EACH | TOTAL |  |
|  | TRANSISTOR | PACKAGE | TRANSISTOR | PACKAGE |  |
| $\mathrm{T}_{\mathrm{A}}$ to $+55^{\circ} \mathrm{C}$ |  |  | 300 | 750 | mW |
| $\mathrm{T}_{\mathrm{A}}$ to $+75^{\circ} \mathrm{C}$ | 300 | 750 | - | - | mW |
| Derating Factor: |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{A}}>+55^{\circ} \mathrm{C}$. | - | - | - | 6.67 | $\mathrm{mW} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{A}}>+75^{\circ} \mathrm{C}$. | - | 8 | - | - | $\mathrm{mW} /{ }^{\circ} \mathrm{C}$ |

Collector-Base Voltage, $\mathrm{V}_{\text {(BR)CBO }}$ ..... 30V
Collector-Emitter Voltage, $\mathrm{V}_{\text {(BR)CEO }}$ ..... 20V
Collector-Substrate Voltage, $\mathrm{V}_{\text {(BR)CIO }}$ (See note 2) ..... 20V
Emitter-Base Voltage, $\mathrm{V}_{(\mathrm{BR}) \in \mathrm{BO}}$ .....  6 V
Collector Current, Ic ..... 50 mA
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ :
Type ULS-2045H ..... $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Type ULN-2046A.$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ :

## Notes:

1. The maximum ratings are limiting absolute values above which the serviceability may be impaired from the viewpoint of life or satisfactory performance. The breakdown voltages may be far above the maximum voltage ratings. To avoid permanent damage to the transistor, do not attempt to measure these characteristics above the maximum ratings.
2. Pin 13 is connected to the substrate. This terminal must be tied to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.

STATIC ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Collector-Base Breakdown Voltage | $V_{\text {(B) }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{E}}=0$ | 20 | 60 |  | V |
| Collector-Emitter Breakdown Voltage | $V_{\text {(BRICEO }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=0$ | 15 | 24 |  | V |
| Collector-Substrate Breakdown Voltage | $V_{\text {(B) }} \mathrm{V}_{\text {cio }}$ | $I_{C}=10 \mu A, I_{C l}=0$ | 20 | 60 |  | V |
| Emitter-Base Breakdown Voltage | $V_{\text {(BR) }{ }^{\text {ebo }}}$ | $\mathrm{I}_{\mathrm{E}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{C}}=0$ | 5 | 7 |  | V |
| Collector Cutoff Current | CBBO | $V_{C B}=10 \mathrm{~V}, \mathrm{~L}_{\mathrm{E}}=0$ |  |  | 40 | nA |
|  | $\mathrm{I}_{\text {ceo }}$ | $V_{C E}=10 \mathrm{~V}, \mathrm{I}_{8}=0$ |  |  | 0.5 | $\mu \mathrm{A}$ |
| Static Forward Current Transfer Ratio | $\mathrm{h}_{\mathrm{FE}}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ |  | 54 |  | - |
|  |  | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}$ | 40 | 100 |  | - |
|  |  | $\mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ |  | 100 |  | - |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {celsat) }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=1 \mathrm{~mA}$ |  | 0.23 |  | V |
| Base-Emitter Voltage | $V_{B E}$ | $\mathrm{T}_{\mathrm{E}}=1 \mathrm{~mA}, \mathrm{~V}_{C E}=3 \mathrm{~V}$ |  | 0.715 |  | V |
|  |  | $\mathrm{I}_{\mathrm{E}}=10 \mathrm{~mA}, \mathrm{~V}_{C E}=3 \mathrm{~V}$ |  | 0.800 |  | V |
| Input Offset Current for Matched Pair $Q_{1}$ and $Q_{2}$ | $\mathrm{I}_{101} \mathrm{I}_{102}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}$ |  | 0.3 | 2 | $\mu \mathrm{A}$ |
| Magnitude of Input Offset Voltage for Differential Pair | $V_{\text {BE1 }}-V_{\text {BE2 }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ |  | 0.45 | 5 | mV |
| Magnitude of Input Offset Voltage for Isolated Transistors | $V_{\text {BE3 }}-V_{\text {BE }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}$ |  | 0.45 | 5 | mV |
|  | $V_{\text {BE4 }}-V_{\text {BE5 }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ |  | 0.45 | 5 | mV |
|  | $V_{\text {BE5 }}-V_{\text {BE3 }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ |  | 0.45 | 5 | mV |
| Temperature Coefficient of Base-Emitter Voltage | $\frac{\Delta V_{B E}}{\Delta T}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}$ |  | -1.9 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| Temperature Coefficient Magnitude of Input-Offset Voltage | $\frac{\Delta V_{10}}{\Delta T}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}$ |  | 1.1 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Small-Signal Common-Emitter Forward Current Transfer Ratio | $\mathrm{hf}_{\text {fe }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | 110 |  | - |
| Small-Signal Common-Emitter Short-Circuit Input Impedance | $\mathrm{h}_{\text {ib }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | 3.5 |  | k $\Omega$ |
| Small-Signal Common-Emitter Open-Circuit Output Impedance | $\mathrm{h}_{\mathrm{oe}}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | 15.6 |  | $\mu \mathrm{mho}$ |
| Small-Signal Common-Emitter Open-Circuit Reverse Voltage-Transfer Ratio | $\mathrm{hre}_{\text {re }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | $8 \times 10^{-4}$ |  | - |
| Gain-Bandwidth Product | $\mathrm{f}_{T}$ | $\mathrm{I}_{\mathrm{C}}=3 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ | 300 | 550 |  | MHz |
| Emitter-to-Base Capacitance | $\mathrm{C}_{\text {E8 }}$ | $\mathrm{V}_{\mathrm{EB}}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0, \mathrm{f}=1 \mathrm{MHz}$ |  | 0.6 |  | pF |
| Collector-to-Base Capacitance | $\mathrm{C}_{\text {CB }}$ | $V_{C B}=3 V_{,} I_{C}=0, \mathrm{f}=1 \mathrm{MHz}$ |  | 0.6 |  | pF |
| Collector-to-Substrate Capacitance | $\mathrm{C}_{\mathrm{c}}$ | $\mathrm{V}_{\text {cs }}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=0, \mathrm{f}=1 \mathrm{MHz}$ |  | 2.8 |  | pF |
| Noise Figure | N.F. | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=1 \mathrm{k} \Omega \\ & \mathrm{f}=1 \mathrm{kHz}, \mathrm{BW}=15.7 \mathrm{kHz} \end{aligned}$ |  | 3.25 |  | dB |

## NOTE:

Characteristics apply for each transistor unless otherwise specified.

## ULN-2046A-1 <br> TRANSISTOR ARRAY

TYPE ULN-2046A-1 general-purpose transistor array consists of five silicon NPN transistors, two of which are connected as a differential amplifier. The monolithic construction provides close electrical and thermal matching between all transistors.

Except as shown in the following electrical characteristics, Type ULN-2046A-1 transistor array is identical to Type ULN-2046A.


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Collector-Base Breakdown Voltage | $\mathrm{BV}_{\text {CB0 }}$ | $\mathrm{T}_{\mathrm{c}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{E}}=0$ | 40 | 60 | - | V |
| Collector-Emitter Breakdown Voltage | $\mathrm{BV}_{\text {ceo }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=0$ | 30 | - | - | V |
| Collector-Substrate Breakdown Voltage | $\mathrm{BV}_{\text {c10 }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{Cl}}=0$ | 40 | 60 | - | V |
| Collector Cutoff Current | $\mathrm{I}_{\text {cbo }}$ | $\mathrm{V}_{\mathrm{CB}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0$ | - | - | 100 | nA |
|  | $\mathrm{c}_{\text {ceo }}$ | $\mathrm{V}_{\mathrm{CE}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{B}}=0$ | - | - | 5.0 | $\mu \mathrm{A}$ |
| Static Forward Current Transfer Ratio | $\mathrm{h}_{\mathrm{FE}}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}$ | 30 | 100 | - |  |

NOTE:
Pin 13 is connected to the substrate. This terminal must be tied to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.

## ULN-2047A TRANSISTOR ARRAY (Three Differential Amplifiers)

TYPE ULN-2047A is a silicon NPN multiple transistor array comprising three independent differential amplifiers. It is specifically intended for use in switching applications such as electronic organ keyboards. All base leads are brought out on one side of the 16-lead plastic dual in-line package to simplify printed wiring board layout. A separate substrate connection permits maximum circuit design flexibility.

Type ULN-2047A is supplied in a 16-pin dual in-line plastic package.


## ABSOLUTE MAXIMUM RATINGS at $25^{\circ} \mathrm{C}$ Free-Air Temperature



## ELECTRICAL CHARACTERISTICS at $25^{\circ} \mathrm{C}$ Free-Air Temperature

```
Collector-Emitter Breakdown Voltage, BV ceo (note 1)
    at I}\mp@subsup{I}{C}{}=5\textrm{mA}\ldots................................................. . . . . V Min
Emitter Cutoff Current, IEBO (note 2)
    at \mp@subsup{V}{EB}{}=5}\mp@subsup{5}{}{\prime
Collector Cutoff Current, I IES (note 1)
    at }\mp@subsup{V}{CE}{}=25V\mathrm{ V................................................. . . }100\mathrm{ nA Max.
D-C Forward Current Transfer Ratio, haE (note 1)
    at }\mp@subsup{V}{CE}{}=2V,\mp@subsup{I}{C}{}=0.1 mA.\ldots........................................ . 30 Min.
    at }\mp@subsup{V}{CE}{}=2V,\mp@subsup{I}{C}{}=10\textrm{mA}\ldots....................................... . . M Min.
Differential Input Offset Voltage, V }\mp@subsup{V}{10}{}\mathrm{ (note 1)
```



## NOTES:

1. All other pins common to emitter of transistor under test.
2. Base and collector of associated transistor connected to emitter, all other pins common to base of transistor under test.

## ULN-2054A TRANSISTOR ARRAY (Dual Independent Differential Amplifiers)

T$\checkmark$ HE ULN-2054A is a transistor array consisting of six silicon NPN transistors on a single monolithic chip. The transistors are internally interconnected to form two independent differential amplifiers.

The ULN-2054A is intended for a wide range of applications requiring extremely close electrical and thermal matching characteristics. Some applications are: cascade limiter circuits; balanced mixer circuits; balanced quadrature/synchronous detector circuits; balanced (push-pull) cascade/sense/IF amplifier circuits; or in almost any multifunction system requiring $\mathrm{RF} /$ Mixer/Oscillator, converter/IF functions.

Available in a 14 -lead dual in-line plastic package the ULN-2054A is rated for operation over a $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ambient temperature range.


Other features are:

- Input Offset Voltage -5 mV max.
- Input Offset Current - $2 \mu \mathrm{~A}$ max.
- Voltage gain (single-stage double ended output) - 32 dB typ.
- Common-Mode Rejection Ratio (each amplifier) - 100 dB typ.


## ABSOLUTE MAXIMUM RATINGS <br> at $+25^{\circ} \mathrm{C}$ Free-Air Temperature (unless otherwise noted)

[^53]
## STATIC ELECTRICAL CHARACTERISTICS at $T_{A}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Collector-Base Breakdown Voltage | $V_{\text {(BR)CB0 }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{E}}=0$ | 20 | 60 |  | V |
| Collector-Substrate Breakdown Voltage | $V_{\text {(BRCIIO }}$ | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{Cl}}=0$ | 20 | 60 |  | V |
| Collector-Emitter Breakdown Voltage | $V_{\text {BRICEO }}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=0$ | 15 | 24 |  | V |
| Emitter-Base Breakdown Voltage | $V_{\text {(BR)EBO }}$ | $\mathrm{I}_{\mathrm{E}}=10 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{C}}=0$ | 5 | 7 |  | V |
| Collector Cutoff Current | $\mathrm{I}_{\text {cB0 }}$ | $\mathrm{V}_{C B}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0$ |  |  | 100 | nA |
| Base-Emitter Voltage | $V_{\text {BE }}$ | $\mathrm{I}_{\mathrm{C}}=50 \mu \mathrm{~A}, \mathrm{~V}_{C B}=3 \mathrm{~V}$ |  | 0.630 | 0.700 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {CB }}=3 \mathrm{~V}$ |  | 0.715 | 0.800 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=3 \mathrm{~mA}, \mathrm{~V}_{C B}=3 \mathrm{~V}$ |  | 0.750 | 0.850 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}, \mathrm{~V}_{\text {CB }}=3 \mathrm{~V}$ |  | 0.800 | 0.900 | V |
| Temperature Coefficient of Base-Emitter Voltage | $\frac{\Delta V_{B E}}{\Delta T}$ | $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}, \mathrm{~V}_{C B}=3 \mathrm{~V}$ |  | -1.9 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| Input Offset Voltage | $V_{10}$ | $\mathrm{I}_{\mathrm{E}(03)}=\mathrm{I}_{\mathrm{E}(04)}=2 \mathrm{~mA}, \mathrm{~V}_{C B}=3 \mathrm{~V}$ |  | 0.45 | 5 | mV |
| Input Offset Current | $0_{10}$ | $\mathrm{I}_{\mathrm{E}(03)}=\mathrm{I}_{\mathrm{E}(04)}=2 \mathrm{~mA}, \mathrm{~V}_{\text {CB }}=3 \mathrm{~V}$ |  | 0.3 | 2 | $\mu \mathrm{A}$ |
| Input Bias Current | 1 | $\mathrm{I}_{E(03)}=\mathrm{I}_{E(04)}=2 \mathrm{~mA}, \mathrm{~V}_{C B}=3 \mathrm{~V}$ |  | 10 | 24 | $\mu \mathrm{A}$ |
| Quiescent Operating Current Ratio | $\frac{I_{\text {(001) }}}{T_{\text {(012) }}}$ | $\mathrm{I}_{\text {(03) }}=2 \mathrm{~mA}, \mathrm{~V}_{\text {CB }}=3 \mathrm{~V}$ |  | 0.98-1.02 |  | - |
|  | $\frac{T_{(105)}}{T_{c(106)}}$ | $\mathrm{I}_{\mathrm{E}(04)}=2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CB}}=3 \mathrm{~V}$ |  | 0.98-1.02 |  | - |
| Temperature Coefficient Magnitude of Input-Offset Voltage | $\frac{\Delta V_{10}}{\Delta T}$ | $I_{E(03)}=I_{E(04)}=2 \mathrm{~mA}, \mathrm{~V}_{C B}=3 \mathrm{~V}$ |  | 1.1 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |

DYNAMIC ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Common-Mode Rejection Ratio For Each Amplifier | CMR | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{x}}=3.3 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{kHz}(\text { See figure } 1) \end{aligned}$ |  | 100 |  | dB |
| AGC Range, One Stage | AGC | $\begin{aligned} & \mathrm{V}_{\mathrm{Cc}}=12 \mathrm{~V}, \mathrm{~V}_{\text {EE }}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{x}}=3.3 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{kHz} \text { (See figure 2) } \end{aligned}$ |  | 75 |  | dB |
| Voltage Gain, Single Stage Double-Ended Output | $\mathrm{A}_{v}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{Cc}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{x}}=3.3 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{kHz} \text { (See figure 2) } \end{aligned}$ |  | 32 |  | dB |
| AGC Range, Two Stage | AGC | $\begin{aligned} & \mathrm{V}_{\mathrm{Cc}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{x}}=3.3 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{kHz} \text { (See figure 3) } \end{aligned}$ |  | 105 |  | dB |
| Voltage Gain, Two Stage Double-Ended Output | A | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{x}}=3.3 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{kHz}(\text { See figure } 3) \end{aligned}$ |  | 60 |  | dB |
| Small-Signal Common-Emitter Forward Current Transfer Ratio | $\mathrm{h}_{\text {fe }}$ | $\mathrm{I}_{\mathrm{c}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | 110 |  | - |
| Small-Signal Common-Emitter Short-Circuit Input Impedance | $\mathrm{h}_{\mathrm{ie}}$ | $\mathrm{I}_{\mathrm{c}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | 3.5 |  | k $\Omega$ |
| Small-Signal Common-Emitter Open-Circuit Output Impedance | $\mathrm{h}_{\text {ee }}$ | $\mathrm{I}_{\mathrm{c}}=1 \mathrm{~mA}, \mathrm{~V}_{\text {cF }}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | 15.6 |  | $\mu \mathrm{mho}$ |
| Small-Signal Common-Emitter Open-Circuit Reverse Voltage-Transfer Ratio | $\mathrm{hre}_{\text {fe }}$ | $\mathrm{I}_{\mathrm{c}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}$ |  | $1.8 \times 10^{-4}$ |  | - |
| Gain-Bandwidth Product (for Single Transistor) | $\mathrm{f}_{\mathrm{T}}$ | $\mathrm{I}_{\mathrm{c}}=3 \mathrm{~mA}, \mathrm{~V}_{\text {CE }}=3 \mathrm{~V}$ |  | 550 |  | MHz |
| Noise Figure (for Single Transistor) | N.F. | $\begin{aligned} & \mathrm{V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{g}}=1 \mathrm{k} \Omega, \mathrm{BW}=15.7 \mathrm{kHz} \end{aligned}$ |  | 3.25 |  | dB |
| Noise Figure (for each Amplifier) | N.F. | $\mathrm{f}=100 \mathrm{MHz}$ |  | 8 |  | dB |

## NOTE:

Characteristics apply for each transistor unless otherwise specified.

## AMPLIFIER TEST CIRCUITS



COMMON MODE REJECTION RATIO
Figure 1


SINGLE-STAGE VOLTAGE GAIN
Figure 2


TWO-STAGE VOLTAGE GAIN
Figure 3

## ULN-2081A AND ULN-2082A GENERAL-PURPOSE HIGH-CURRENT TRANSISTOR ARRAYS

SPRAGUE TYPE ULN-2081A and ULN-2082A Transistor Arrays are comprised of seven highcurrent silicon NPN transistors on a common monolithic substrate. The Type ULN-2081A is connected in a common-emitter configuration and the Type ULN-2082A is connected in a common-collector configuration.

Both arrays are capable of directly driving seven segment displays and LED displays. They are ideal for a variety of other driver applications such as relay control and thyristor firing.

Type ULN-2081A and ULN-2082A are housed in 16-lead DIP plastic packages which include a separate substrate connection for maximum circuit design flexibility.


ULN-2081A


ULN-2082A

## ABSOLUTE MAXIMUM RATINGS

| Power Dissipation (any one transistor) (total package) | 500 mW 750 mW |
| :---: | :---: |
| Ambient Temperature Range (operating) | $+85^{\circ} \mathrm{C}$ |
| Individual Transistor Ratings: |  |
| Collector-to-Emitter Voltage, $\mathrm{V}_{\text {CEO }}$ | 16 V |
| Collector-to-Base Voltage, $\mathrm{V}_{\text {CBO }}$ | 20 V |
| Collector-to-Substrate Voltage, $\mathrm{V}_{\text {cıo }}$ | 20 V |
| Emitter-to-Base Voltage, $\mathrm{V}_{\text {EBO }}$ | 5 V |
| Collector Current, $I_{c}$ | . 200 mA |
| Base Current, IB | 20 mA |

## NOTE:

The collector of each transistor in the Type ULN-2081A and ULN-2082A is isolated from the substrate by an integral diode. The substrate must be connected to a voltage which is more negative than any collector voltage so as to maintain isolation between transistors, and to provide normal transistor action. Undesired coupling between transistors is avoided by maintaining the substrate terminal (5) at either d-c or signal (a-c) ground. An appropriate bypass capacitor can be used to establish a signal ground.

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. Max. | Units |
| Collector-Emitter Breakdown Voltage | $\mathrm{BV}_{\text {ces }}$ | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 20 | 80 | V |
| Collector-Substrate Breakdown Voltage | $\mathrm{BV}_{\text {Cli }}$ | $\mathrm{ICl}_{\text {c }}=500 \mu \mathrm{~A}$ | 20 | 80 | V |
| Collector-Emitter Breakdown Voltage | $\mathrm{BV}_{\text {ceo }}$ | $\mathrm{I}_{\mathrm{c}}=1 \mathrm{~mA}$ | 16 | 40 | V |
| Emitter-Base Breakdown Voltage | $\mathrm{BV}_{\text {EBO }}$ | $\mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 5 | 7 | V |
| Forward Current Transfer Ratio | $\mathrm{h}_{\mathrm{FE}}$ | $\mathrm{V}_{\mathrm{CE}}=0.5 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=30 \mathrm{~mA}$ | 30 | 80 |  |
|  |  | $\mathrm{V}_{\mathrm{CE}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=50 \mathrm{~mA}$ | 40 | 85 |  |
| Base-Emitter Saturation Voltage | $V_{\text {belSAT }}$ | $\mathrm{I}_{\mathrm{c}}=30 \mathrm{~mA}$ |  | $0.75 \quad 1$ | V |
| Collector-Emitter Saturation Voltage | $V_{\text {cel(Sat }}$ | $\mathrm{I}_{\mathrm{c}}=30 \mathrm{~mA}$ |  | 0.130 .5 | V |
|  |  | $\mathrm{I}_{\mathrm{C}}=50 \mathrm{~mA}$ |  | $0.2 \quad 0.7$ | V |
| Collector Cutoff Current | Iceo | $\mathrm{V}_{\text {cE }}=10 \mathrm{~V}$ |  | 10 | $\mu \mathrm{A}$ |
|  | Iсво | $\mathrm{V}_{\mathrm{CB}}=10 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |

# ULN-2083A AND ULS-2083H TRANSISTOR ARRAYS (Five Independent NPN Transistors) 

DESIGNED for use in general purpose, medium current (to 100 mA ) switching and differential amplifier applications, the ULN-2083A and ULS2083 H transistor arrays each consist of five NPN transistors on a single monolithic chip. Two transistors are matched at low currents ( 1 mA ) making them ideal for use in balanced mixer circuits, push-pull amplifiers, and other circuit functions requiring close thermal and offset matching.

A separate substrate connection permits maximum circuit design flexibility. In order to maintain isolation between transistors and provide normal transistor action, the substrate must be connected to a voltage which is more negative than any collector voltage. The substrate terminal (pin 5) should therefore be maintained at either d-c ground or suitably bypassed to a-c ground to avoid undesired coupling between transistors.

Two package configurations are available. The Type ULN-2083A is supplied in a 16 -lead dual in-line plastic package for operation over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. This package is similar to


JEDEC style MO-001AC. The Type ULS-2083H is electrically identical to the ULN-2083A but is supplied in a hermetic dual in-line package for operation over the temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. This package conforms to the dimensional requirements of Military Specification MIL-M-38510 and can meet all of the applicable environmental requirements of Military Standard MIL-STD-883.

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature

| Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ (any one transistor) .(total package) | $\begin{aligned} & .500 \mathrm{~mW} \\ & 750 \mathrm{~mW} \end{aligned}$ |
| :---: | :---: |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ (ULN-2083A) | $20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| (ULS-2083H). | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathbf{s}}$ | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| the rate of $6.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$. |  |

ELECTRICAL CHARACTERISTICS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Collector-Base Breakdown Voltage | $\mathrm{BV}_{\text {CBO }}$ | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 20 | 60 | - | V |
| Collector-Emitter Breakdown Voltage | $\mathrm{BV}_{\text {ceo }}$ | $\mathrm{T}_{\mathrm{C}}=1 \mathrm{~mA}$ | 15 | 24 | - | $V$ |
| Collector-Substrate Breakdown Voltage | $\mathrm{BV}_{\mathrm{cl}}$ | $\mathrm{ICI}=100 \mu \mathrm{~A}$ | 20 | 60 | - | V |
| Emitter-Base Breakdown Voltage | $\mathrm{BV}_{\text {EBO }}$ | $\mathrm{T}_{\mathrm{E}}=500 \mu \mathrm{~A}$ | 5.0 | 6.9 | - | V |
| Collector Cutoff Current | İEO | $\mathrm{V}_{\mathrm{CE}}=10 \mathrm{~V}$ | - | - | 10 | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\text {CBO }}$ | $\mathrm{V}_{\text {CB }}=10 \mathrm{~V}$ | - | - | 1.0 | $\mu \mathrm{A}$ |
| Base-Emitter Voltage | $V_{\text {BE }}$ | $\mathrm{V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}$ | 650 | 740 | 850 | mV |
| Collector-Emitter Saturation Voltage | $V_{\text {cel(SAT }}$ | $T_{C}=50 \mathrm{~mA} \mathrm{I}_{\mathrm{B}}=5 \mathrm{~mA}$ | - | 400 | 700 | mV |
| D-C Forward Current Transfer Ratio | $h_{\text {FE }}$ | $\mathrm{V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=10 \mathrm{~mA}$ | 40 | 76 | - |  |
|  |  | $\mathrm{V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=50 \mathrm{~mA}$ | 40 | 75 | - |  |
| Differential Input Offset Voltage* | $V_{10}$ | $\mathrm{V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ | - | 1.2 | 5.0 | mV |
| Differential Input Offset Current* | 10 | $\mathrm{V}_{\mathrm{CE}}=3 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$ | - | 0.7 | 2.5 | $\mu \mathrm{A}$ |

[^54]D-C FORWARD CURRENT TRANSFER RATIO AS A FUNCTION OF COLLECTOR CURRENT


BASE-EMITTER SATURATION VOLTAGE AS A FUNCTION OF COLLECTOR CURRENT


DIFFERENTIAL INPUT OFFSET VOLTAGE AS A FUNCTION OF COLLECTOR CURRENT


COLLECTOR-EMITTER SATURATION VOLTAGE AS A FUNCTION OF COLLECTOR CURRENT



BASE-EMITTER VOLTAGE AS A FUNCTION OF COLLECTOR CURRENT


DIFFERENTIAL INPUT OFFSET CURRENT AS A FUNCTION OF COLLECTOR CURRENT


## ULN-2083A-1 TRANSISTOR ARRAY

This device is a general-purpose transistor array for use in medium-current switching and differential amplifier applications. With the exception of the increased breakdown voltages shown below, Type ULN-2083A-1 is identical to Type ULN-2083A transistor array.


ELECTRICAL CHARACTERISTICS at $+25^{\circ}$ C Free-Air Temperature

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Collector-Base Breakdown Voltage | $\mathrm{BV}_{\text {cBo }}$ | $\mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 40 | 60 | - | V |
| Collector-Emitter Breakdown Voltage | $\mathrm{BV}_{\text {ceo }}$ | $\mathrm{l}_{\mathrm{c}}=1 \mathrm{~mA}$ | 30 | - | - | V |

## ULN-2086A TRANSISTOR ARRAY

Type ULN-2086A general-purpose transistor array consists of five silicon NPN transistors, two of which are connected as a differential amplifier. The monolithic construction provides close electrical and thermal matching between all transistors.

With the exception of the collector cutoff current specifications listed below and the omission of guaranteed limits on input offset voltage and input offset current, Type ULN-2086A is identical to Type ULN-2046A transistor array.


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $I_{C B O}$ | $\mathrm{~V}_{\mathrm{CB}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{E}}=0$ | - | - | 100 | nA |
|  | $\mathrm{I}_{\mathrm{CEO}}$ | $\mathrm{V}_{\mathrm{CE}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{B}}=0$ | - | - | 5.0 | $\mu \mathrm{~A}$ |

NOTE: The substrate terminal must be tied to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.

# SERIES 2140 <br> HIGH-PERFORMANCE QUAD CURRENT SWITCHES 

## FEATURES

- Variable Reference: -3 to -10 Volts
- Low Temperature Coefficient: $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$
- Fast Settling: 300 ns to $0.01 \%$
- TTLCMOS Compatible Inputs

SERIES 2140 quad current switches are high precision monolithic integrated circuits for use in digital-to-analog converters. Each device contains four logic-controlled current switches and a reference transistor. Continuously running current sources and superior thermal layout, maximize speed and accuracy by reducing transitional anomalies. Series 2140 switches accept a wide range of d-c references or an a-c reference for two-quadrant mutiplying D/A applications. Inputs may be driven from TTL, or similar sources and are independent of reference voltage level.
Type ULN-2140A switches are rated for operation over the temperature range of $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; the ' A ' suffix indicates a 14 -pin dual in-line plastic package. Type ULS-2140H switches are rated for operation over the extended temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$; the ' H ' suffix indicates a dual in-line hermetic package to Military Specification MIL-M-38510. Devices in unpackaged, chip form, for use in hybrid circuit applications, are designated by changing the suffix letter from A or H to C .

On special order, hermetically sealed quad current switches with highreliability screening to MIL-STD-883 are available by adding the suffix 'MIL' to the part number, for example, ULS-2140H-MIL. Also, on special order, devices with improved linearity and drift can be supplied.

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {CC }}$ | +18V |
| :---: | :---: |
|  | -18V |
|  |  |
|  |  |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ (ULN-2140A) | $-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| (ULS-2140H) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\text {S }}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=+5 \mathrm{to}+15 \mathrm{~V}, \mathbf{V}_{\mathrm{EE}}=-15 \mathrm{~V}, \mathrm{I}_{\mathrm{MSB}}=1 \mathrm{~mA}$, Operational Amplifier Summing Junction Load (unless otherwise noted)

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| "0" Input Voltage | $V_{\text {(10) }}$ |  | - | - | 0.8 | V |
| "1" Input Voltage | $V_{\text {INow }}$ |  | 2.0 | - | - | $V$ |
| "0" Input Current | Invo) | $V_{\mathbb{W}}=0.8 \mathrm{~V}$ | - | - | -1.0 | $\mu \mathrm{A}$ |
| "1" Input Current | 1 IN(i) | $V_{\mathbb{N}}=2.4 \mathrm{~V}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Output Voltage | $V_{\text {OUI }}$ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ | See Note |  |  |  |
| Output Voltage Swing | $\Delta V_{\text {OUI }}$ | $R_{1}=1 \mathrm{k} \Omega_{\text {, Logic }}=0000$ to 1111 | -2.0 | - | - | V |
| Output Current | $I_{\text {mse }}$ | Logic $=0111$ | 2.0 | 1.0 | - | mA |
|  | $\mathrm{I}_{\mathrm{BII} 2}$ | Logic $=1011$ | 1.0 | 0.5 | - | mA |
|  | $\mathrm{I}_{\mathrm{BI} 3}$ | Logic $=1101$ | 0.5 | 0.25 | - | mA |
|  | $\mathrm{I}_{\text {LSB }}$ | Logic $=1110$ | 0.25 | 0.125 | - | mA |
| Settling Time |  | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$, To $0.01 \%$, Logic $=1000$ to 0111 | - | 300 | - | ns |
| Output Leakage Current | Tout | Logic $=1111$ | - | - | 10 | $\mu \mathrm{A}$ |
| Ref. Transistor Static Forward Current Gain | $\mathrm{h}_{\mathrm{FE}}$ | $\mathrm{I}_{\mathrm{C}}=125 \mu \mathrm{~A}$ | 100 | - | - | - |
| Non-Linearity |  | Over Operating Temperature Range | - | - | 0.5 | \% |
| TC of Non-Linearity |  | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (ULN-2140 Devices) | - | - | 20 | ppm/ ${ }^{\circ} \mathrm{C}$ |
|  |  | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (ULS-2140 Devices) | - | - | 10 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Scale Factor Drift |  | Over Operating Temperature Range | - | 5.0 | - | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Supply Current | $\mathrm{I}_{\mathrm{cc}}$ | $V_{\text {cc }}=+15 \mathrm{~V}$ | - | 8.0 | - | mA |
|  | $\mathrm{I}_{\text {EE }}$ |  | - | -8.0 | - | mA |

Note: Output voltage with a resistive load will be a negative voltage.

## TYPICAL APPLICATION



## ULN-2401A AUTOMOTIVE LAMP MONITOR

## FEATURES

- № Standby Power
- Completely Integral to Wiring Assembly
- Monitor 1 to 8 Lamps per Channel
- Fail-Safe
- Reverse Voltage Protected
- 14-Pin Dual In-Line Plastic Package

OFFERING SEVERAL ADVANTAGES for a lamp monitoring system, the ULN-2401A monolithic integrated circuit is versatile, easily connected, and does not affect normal lamp operation. Little additional wiring is required for installation since the system is completely integral to the wiring assembly.

The ULN-2401A electronic lamp monitor was specifically designed for application in the severe automotive environment. Lateral PNP transistors provide high-frequency noise immunity and differential transient voltage protection. Reverse voltage protection, internal voltage regulators, and temperature compensation are all incorporated in the design. A failure within the device will not affect lamp operation. As a quad comparator, the ULN-2401A can also be used to monitor multiple low-voltage power supplies or, with appropriate sensors, industrial processes.

This lamp monitor operates by sensing the voltage drop in the wiring ( 50 to 100 mV ) for each lamp circuit. If any of the four comparators sees a differential input voltage of greater than 26 mV , a failure lamp is turned on. Lamp and wiring tolerances causing differential input voltages of up to 7 mV are permitted. Each comparator is capable of monitoring a mixture of one to eight similar lamps. No standby power is required because the operating voltage is obtained from the sense leads and is energized only when the lamps are turned on.


ABSOLUTE MAXIMUM RATINGS

Peak Reverse Voltage ( 30 s ) ...................... 6.0 V
( 0.1 s ) ....................... 30 V

Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-35^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots \ldots-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
EQUIVALENT LOGIC CIRCUITRY


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range | $\mathrm{V}_{\text {cc }}$ |  | 10 | 13 | 16 | V |
| Output Saturation Voltage | $V_{\text {Oution }}$ | $V_{\text {cc }}=10 \mathrm{~V}, \Delta V_{\text {IN }}=26 \mathrm{mV}$ | - | - | 2.2 | V |
|  |  | $V_{\text {cc }}=13 \mathrm{~V}, \Delta V_{\text {iN }}=26 \mathrm{mV}$ | - | - | 2.4 | V |
|  |  | $\mathrm{V}_{\mathrm{cC}}=16 \mathrm{~V}, \Delta \mathrm{~V}_{\text {IN }}=26 \mathrm{mV}$ | - | - | 2.6 | V |
| Output Leakage Current | $I_{\text {Outioff }}$ | $\mathrm{V}_{\mathrm{cc}}=16 \mathrm{~V}, \Delta \mathrm{~V}_{\mathrm{iN}}=0 \mathrm{mV}$ | - | - | 6.0 | mA |
|  |  | $\mathrm{V}_{\text {cC }}=16 \mathrm{~V}, \Delta \mathrm{~V}_{\mathrm{IN}}=7 \mathrm{mV}$ | - | - | 10 | mA |
|  |  | $\mathrm{V}_{\mathrm{cc}}=16 \mathrm{~V}, \Delta \mathrm{~V}_{\text {IN }}=0 \mathrm{mV}$ (all inputs) | - | - | 15 | mA |

NOTE: Electrical characteristics (unless otherwise specified) apply to any one pair of comparator inputs (pins $1 \& 2$, or $9 \& 10$, or $11 \& 12$ ) with all remaining comparator inputs (including pins $3 \& 4$ ) open-circuited. To test the comparator at pins $3 \& 4$, pins $9,10,11 \& 12$ must be connected to $V_{c c}$. In application, pins 10 and 11 must both be at or near $V_{c c}$ for the comparator at pins $3 \& 4$ to be operative.


## SCHEMATIC



# ULN-2429A FLUID DETECTOR 

## FEATURES

- High Output Current
- A-C or D-C Output
- Single-Wire Probe
- Low External Parts Count
- Internal Voltage Regulator
- Reverse Voltage Protection
- 14-Pin Dual In-Line Plastic Package

P PRIMARILY DESIGNED for use as an automotive low coolant detector, the ULN-2429A monolithic bipolar integrated circuit is ideal for detecting the presence or absence of many different types of liquids in automotive, home, or industrial applictions. Especially useful in harsh environments, reverse voltage protection, internal voltage regulation, temperature compensation, and high-frequency noise immunity are all incorporated in the design.

A simple probe, immersed in the fluid being monitored, is driven with an a-c signal to prevent plating problems. The presence, ab sence, or condition of the fluid is determined by comparing the loaded probe resistance with an internal (pin 8) or external (pin 6) resistance. Typical conductive fluids which can be sensed are tap water, sea water, weak acids and bases, wet soil, wine, beer, and coffee. Non-conductive fluids include most petroleum products, distilled water, dry soil, and vodka. The probe can be replaced with any variable-resistance element such as a photodiode or photoconductive cell, rotary or linear position sensor, or thermistor for detecting solids, non-conducting liquids, gases, etc.
The high-current output is typically a square wave signal for use with an LED, incandescent lamp, or loudspeaker. A capacitor can be connected (pin 12) to provide a d-c output for use with inductive loads such as relays and solenoids.


The ULN-2429A is rated for operation with a load voltage of úp to 30 volts. Selected devices, for operation up to 50 V are available as the ULN-2429A-1. In all other respects, the ULN-2429A and the ULN-2429A-1 fluid detectors are identical.
These devices are furnished in an improved 14-lead dual in-line plastic package with a copper alloy lead frame for superior thermal characteristics. However, in order to realize the maximum current-handling capability of these devices, both of the output pins ( 1 and 14) and both ground pins ( 3 and 4 ) should be used.


FUNCTIONAL BLOCK DIAGRAM

## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ (continuous) ( 1 hr . at $+25^{\circ} \mathrm{C}$ ) ( $10 \mu \mathrm{~s}$ ) | $\begin{aligned} & +16 \mathrm{~V},-50 \mathrm{~V} \\ & \ldots \ldots+24 \mathrm{~V} \\ & \ldots \ldots+50 \mathrm{~V} \end{aligned}$ |
| :---: | :---: |
| Output Voltage, $\mathrm{V}_{\text {OUT }}$ (ULN-2429A). . <br> (ULN-2429A-1) | $\begin{aligned} & +30 \mathrm{~V} \\ & +50 \mathrm{~V} \end{aligned}$ |
| Output Current, I IOTT (continuous) ... $\text { ( } 1 \mathrm{hr} . \mathrm{at}+25^{\circ} \mathrm{C} \text { ) }$ | $\begin{aligned} & .700 \mathrm{~mA} \\ & \ldots \\ & \hline \end{aligned}$ |
| Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$ | 1.33 |
| Operating Temperature Range, $\mathrm{T}_{A}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| *Derate at the rate of $16.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | $=+70^{\circ} \mathrm{C}$. |

ELECTRICAL CHARACTERISTICS at $T_{\boldsymbol{A}}=-25^{\circ} \mathrm{C}, \mathbf{V}_{\mathbf{C C}}=\mathbf{V}_{\text {OUT }}=+12 \mathrm{~V}$
(unless otherwise specified)

| Characteristic | Symbol | $\begin{aligned} & \text { Test } \\ & \text { Pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $V_{c c}$ | 13 | - | 10 | - | 16 | $\checkmark$ |
| Supply Current | $\mathrm{ICC}_{\text {c }}$ | 13 | $\mathrm{V}_{\mathrm{CC}}=+16 \mathrm{~V}$ | - | - | 10 | mA |
| Oscillator Output Voltage | $V_{\text {osc }}$ | 6 | $R_{L}=18 \mathrm{kS}$ | - | 3.0 | - | $V_{p p}$ |
| Output ON Voltage | $V_{\text {OUT }}$ | 1,14 | $R_{L} \geq 30 \mathrm{kQ}, \mathrm{I}_{\text {OUT }}=500 \mathrm{~mA}$ | - | 0.9 | 1.5 | V |
| Output OFF Current | Iout | 1,14 | $R_{L} \leq 10 \mathrm{kQ}, \mathrm{V}_{\text {OUT }}=V_{\text {OUT }}($ max $)$ | - | - | 100 | $\mu \mathrm{A}$ |
| Oscillator Frequency | $\mathrm{f}_{\text {osc }}$ | 6 | $R_{L}=18 \mathrm{kQ}$ | - | 2.4 | - | kHz |

## TEST CIRCUIT



## CIRCUIT SCHEMATIC



TYPICAL APPLICATIONS


## ULN-2430M TIMER

## FEATURES

- Microseconds to Minutes
- Temperature Compensated
- 400 mA Output
- 8-Pin Dual In-Line Plastic Package


PROVIDING time delays from several microseconds to approximately 10 minutes, the ULN-2430M timer was originally designed for use as a rear window heater timer in automotive applications. In typical system designs, this device will meet all of the stringent automotive environmental and transient requirements, including "load dump". The rugged design, the high output current rating, and an internal voltage regulator and reference allow the ULN-2430M timer to be used in many industrial applications.

## ABSOLUTE MAXIMUM RATINGS

Regulator Current, $\mathrm{I}_{\text {ReG }} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . .15 \mathrm{~mA}$
Latch Current, $I_{4} \ldots \ldots . . . . . . . . . . . . . . . . . . . . . .3$ mA
Output Current, I Iorr $\ldots \ldots \ldots \ldots \ldots \ldots \ldots . . .400 \mathrm{~mA}$
Package Power Dissipation, $P_{0} \ldots \ldots . \ldots . . . .330 \mathrm{mW*}$
Operating Temperature Range, $T_{A} \ldots \ldots . .-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $4.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.


ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (unless otherwise noted), Fig. 1

| Characteristic | $\begin{aligned} & \text { Test } \\ & \text { pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operating Voltage Range |  |  | 10 | - | 16 | V |
| Regulator Voltage | 5 |  | 8.4 | 9.0 | 10.1 | V |
| Output Breakdown Voltage | 2 | $\mathrm{I}_{\text {LEAK }}=100 \mu \mathrm{~A}$ | 30 | - | - | V |
| Output Saturation Voltage | 2 | $T_{\text {Out }}=400 \mathrm{~mA}$ | - | - | 2.5 | $V$ |
|  |  | $\mathrm{l}_{\text {our }}=250 \mathrm{~mA}$ | - | - | 1.3 | V |
| Latch Voltage | 4 | Over Op. Temp. Range | 5.5 | 7.0 | 8.0 | V |
| Trigger Threshold | 7 | $\mathrm{V}_{7} / \mathrm{N}_{5}$ | 0.60 | 0.63 | 0.67 |  |
| Reference | 8 | $\mathrm{V}_{8} / V_{5}$ | 0.58 | 0.63 | 0.68 |  |
| Temp. Coeff. of Trigger Threshold | 7 |  | -2.0 | - | -4.0 | $\mathrm{mV}^{\circ} \mathrm{C}$ |
| Trigger Input Current | 7 |  | - | 20 | 200 | nA |
| Capacitor Discharge Time | 7 | $\mathrm{C}_{1}=220 \mu \mathrm{~F}, \pm 10 \%$ | - | - | 2.0 | $s$ |
| Supply Current | 5 | $\mathrm{V}_{\mathrm{cc}}=16 \mathrm{~V}$ | - | - | 10 | mA |

## CIRCUIT OPERATION

The basic system shown in Figure 1 provides power for the timer after the momentary closure of the "rear window heater switch"' $S_{1}$. Momentary closure provides an input to pin 4 which turns ON the output driver, energizes the relay, and (through the relay contacts) provides power to the timer and the heater element. Waveforms are shown in Figure 2.
The output remains ON, supplying power to the heater until $V_{7}=62 \% V_{5}$, which occurs at time $t=$ $\mathrm{R}_{1} \times \mathrm{C}_{1}$. The time delay can be adjusted from several microseconds to approximately 10 minutes by the choice of $R_{1}$ and $C_{1}$. When $t=R_{1} \times C_{1}$, the comparator changes state and the relay de-energizes, returning the circuit to the quiescent condition.
Timing accuracy is primarily a function of capacitor leakage for long time delays. Hard switching of
the comparator necessitates low input bias currents on the comparator and low capacitor leakage current. The worst case comparator input is 200 nA and the charge current at $\mathrm{V}_{7}=62 \% \mathrm{~V}_{5}$ is approximately $1.7 \mu \mathrm{~A}$ for $\mathrm{R}_{1}=2 \mathrm{M} \Omega$. For these reasons, it is recommended that $R_{1}$ not exceed $2 \mathrm{M} \Omega$ and $\mathrm{C}_{1}$ leakage be less than 500 nA .

Diode $D_{1}$ and the circuitry associated with pin 4 provide start-stop capability for the timer. When the voltage at pin 4 is larger than 8 V timing is initiated. When less than 5.5 V , timing is stopped. Transient protection against load dump and other automotive environmental hazards is provided by the integrated circuit design and discrete components $\mathrm{Z}_{1}, \mathrm{C}_{2}, \mathrm{R}_{3}$, $\mathrm{R}_{4}$, and $\mathrm{D}_{1}$.

## TYPICAL APPLICATION

(Figure 1)


TIMER WAVEFORMS


## ULN-2435A, ULN-2445A, AND ULN-2455A AUTOMOTIVE LAMP MONITORS

## FEATURES

- No Standby Power
- Integral to Wiring Assembly
- Fail-Safe
- Reverse Voltage Protected
- Internal Transient Protection
- Dual In-Line Plastic Packages

CAPABLE of monitoring all types of automotive lamps, Type ULN-2435A, ULN-2445A, and ULN-2455A lamp monitors provide multiple LED outputs to pinpoint the area in which a lamp has failed. Types ULN-2435A and ULN-2445A feature an additional output that triggers an alarm if any of the comparators detects a lamp failure. This output can be used to drive an audible signaling device or centrally located warning indicator.

The Type ULN-2435A lamp monitor has interconnected comparator ouputs and logic to monitor the ignition circuit and fuses, making it uniquely applicable to automotive applications. Type ULN-2445A is similar, but has no interconnected comparators. Type ULN-2455A is a general-purpose quad comparator that can be used to monitor automotive lamps, multiple low-voltage power supplies, or, with appropriate sensors, industrial processes.

Installation and operation of these quad lamp monitors has no effect on normal lamp operation. Comparators sense the normal voltage drop in the lamp wiring (approximately 20 mV ) for each of the monitored lamp circuits. Little additional wiring is necessary for installation because the system can be completely integral to the wiring assembly. No standby power is required: The operating voltage is obtained from the sense leads; the system is energized only when the lamps are turned ON.


All three integrated circuits are designed for use in the severe automotive environment. Lateral PNP transistors provide high-frequency noise immunity and differential transient-voltage protection. Reverse voltage protection, internal regulators, and temperature compensation are all embodied in the circuit design. A failure within the device will not affect lamp operation.

Types ULN-2435A and ULN-2445A are supplied in 18-pin dual in-line plastic packages. The Type ULN-2455A lamp monitor is supplied in a 14-pin dual in-line plastic package.

## ABSOLUTE MAXIMUM RATINGS at $+25^{\circ} \mathrm{C}$ Free-Air Temperature

Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$. ..... 30 V
Peak Supply Voltage, $\mathrm{V}_{\mathrm{cc}}$ (0.1s) ..... 80 V
Peak Reverse Voltage, $V_{R}$ ..... 30 V
Output Current, $\mathrm{I}_{\text {out }}$ ..... 35 mA
Package Power Dissipation, $P_{D}$ (ULN-2435/45A) ..... 2.3 W*Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$
$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

[^55]
## PRINCIPLE OF OPERATION

Operation of these lamp monitors is similar to that of a simple bridge circuit in which the top two legs of the bridge are formed by the wiring assembly resistance or discrete low-value resistors. The bottom legs of the bridge are the monitored lamps. Four differential amplifier circuits sense the voltage drops in the wiring assemblies (approximately 20 mV ) for each of the lamp circuits. When the system detects a difference in voltage due to an open filament, the appropriate output driver is turned ON.

Sprague Electric Technical Paper TP 81-7 discusses the requirements of automotive lamp monitoring systems and presents a more detailed description of the operation of these differential sense amplifiers (page 10-56).

## BASIC BRIDGE MONITORING SYSTEM



Dwg. No. A-11,473A

## TYPICAL SWITCH CHARACTERISTICS



DIFFERENTIAL SWITCH VOLTAGE, $\Delta V_{I N}$
Dwg. No. A-12,187

ELECTRICAL CHARACTERISTICS of $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{IN}}=10$ to 16 V (unless otherwise shown)

| Characteristic | Test Pins |  | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | ULN-2435/45A | ULN-2455A |  | Min. | Typ. | Max. | Units |
| Output Leakage Current | $\begin{aligned} & 1,7,10 \\ & 13,15,16 \end{aligned}$ | 1,4, 8, 11 | $\mathrm{V}_{\text {OUT }}=80 \mathrm{~V}, \Delta \mathrm{~V}_{\text {W }}<7 \mathrm{mV}$ | - | - | 100 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $\begin{aligned} & 1,7,10 \\ & 13,15,16 \end{aligned}$ | 1, 4, 8, 11 | $\mathrm{I}_{\text {OUT }}=5 \mathrm{~mA}, \Delta \mathrm{~V}_{\text {IN }}>20 \mathrm{mV}$ | - | 0.8 | 1.0 | V |
|  |  |  | $\mathrm{l}_{\text {out }}=30 \mathrm{~mA}, \Delta \mathrm{~V}_{\mathbb{N}}>20 \mathrm{mV}$ | - | 1.4 | 2.0 | V |
| Differential Switch Voltage | $\begin{aligned} & 2-3,8-9 \\ & 11-12,17-18 \end{aligned}$ | $\begin{aligned} & 2-3,5-6, \\ & 9-10,12-13 \end{aligned}$ | Absolute Value $V_{(2)}-V_{(3)}$ | 7.0 | 13 | 20 | mV |
| Input Current | 4 | NA | $\mathrm{V}_{\mathrm{W}}=\mathrm{V}_{\mathrm{cc}}=16 \mathrm{~V}$ | - | - | 500 | $\mu \mathrm{A}$ |
|  | 5 | NA | $V_{\text {W }}=V_{\text {cC }}=16 \mathrm{~V}$ | - | - | 15 | mA |
|  | 6 | NA | $V_{1 N}=0 \mathrm{~V}, \mathrm{~V}_{\text {CC }}=16 \mathrm{~V}$ | - | - | -1.0 | mA |
|  | 2, 8, 11, 17 | 2, 5, 9, 12 | $\Delta V_{\text {W }}=V_{(2)}-V_{(3)}=+30 \mathrm{mV}$ | 150 | 300 | 800 | $\mu \mathrm{A}$ |
|  | 3, 9, 12, 18 | 3,6,10,1 3 | $\Delta V_{\text {(1 }}=V_{(2)}-V_{(3)}=-30 \mathrm{mV}$ | 1.0 | 2.5 | 4.0 | mA |

ULN-2435A
FUNCTIONAL BLOCK DIAGRAM


ULN-2435A and ULN-2445A TRUTH TABLES

| CONDITIONS | INPUT PINS |  |  |  |  |  |  | OUTPUT PINS |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  | ULN-2435A |  |  |  |  |  | ULN-2445A |  |  |  |  |  |
|  | 2/3 | $8 / 9$ | 11/12 | 17/18 | 6 | 4 | 5 | 1 | 7 | 10 | 13 | 15 | 16 | 1 | 7 | 10 | 13 | 15 | 16 |
| Normal | $=$ | = |  | = | 0 | H | X | H | H | H | H | H | H | H | H | H | H | H | H |
| L. Park Lamp Failure | $>$ | = | = | = | 0 | H | X | L | H | H | H | L | H | L | H | H | H | L | H |
| L. Tail Lamp Failure | $<$ | $=$ | $=$ | $=$ | 0 | H | X | H | H | H | L | 1 | H | H | H | H | H | L | H |
| Marker Lamp Failure | $=$ | > | = | = | 0 | H | X | H | L | H | H | L | H | H | L | H | H | L | H |
| Marker Lamp Failure | = | $<$ | = | = | 0 | H | X | H | L | H | H | 1 | H | H | L | H | H | L | H |
| R. Stop Lamp Failure | = | = | $>$ | $=$ | 0 | H | $x$ | H | H | L | H | L | H | H | H | L | H | L | H |
| L. Stop Lamp Failure | = | = | $<$ | $=$ | 0 | H | X | H | H | H | L | L | H | H | H | H | L | L | H |
| R. Park Lamp Failure | $=$ | = | $=$ | > | 0 | H | X | H | H | H | H | L | 1 | H | H |  | H | L | L |
| R. Tail Lamp Failure | $=$ | = | $=$ | $<$ | 0 | H | X | H | H | L | H | L | H | H | H | H | H | L | H |
| Stop Lamp Fuse Failure | $=$ | $=$ |  | - | 0 | L | H | H | H | L | , | L | H | H | H | L | L | L | H |
| Indicator Lamp Test | $x$ | $\chi$ | $\chi$ | X | L | X | H | L |  | L | L | L | L | L | L | L | L | L | L |

$=-$ Less than 7 mV offset between a pair of input pins
$>-$ Greater than +20 mV differential between a pair of input pins $\left[V_{(2)}-V_{(33}\right]$
$<-$ Greater than -20 mV differential between a pair of input pins $\left[V_{(2)}-V_{(3)}\right]$
$\mathrm{H}-\mathrm{V}_{\mathrm{cc}}$
$L$ - $V_{\text {SaT }}$ (outputs) or GROUND (inputs)
0 - Open or $V_{\text {cc }}$
$X$ - Irrelevant

## ULN-2445A FUNCTIONAL BLOCK DIAGRAM



## TYPICAL APPLICATIONS

AUTOMOTIVE LAMP MONITOR


QUAD LAMP MONITOR


Dug. Mo. A-12,035A

## TYPICAL APPLICATIONS (Continued)

## POWER SUPPLY SUPERVISORY CIRCUIT



SIMPLIFIED SCHEMATIC
(One of 4 differential
sense amplifiers)


## ULN-3310D AND ULN-3310T PRECISION LIGHT SENSORS

## FEATURES

- Two-Terminal Operation
- Linear Over a Wide Range
- Precalibrated
- Wide Operating-Voltage Range
- High Output

DIRECT REPLACEMENTS for photocells and phototransistors, Type ULN-3310D and ULN3310T Precision Light Sensors are two-terminal monolithic integrated circuits that linearly convert light level into electrical current. The light-controlled current sources are linear over a wide range of supply voltages and light levels and require no external calibration.

Each Precision Light Sensor (PLS) consists of a photodiode and a calibrated current amplifier. The design of the amplifier allows derivation of its supply current from the same terminal as the photodiode cathode and the amplifier output. Since this supply current is a linear function of the photodiode current, it acts as part of the signal current. Each PLS is calibrated during manufacture for an output current of $40 \mu \mathrm{~A}$ at $100 \mu \mathrm{~W} / \mathrm{cm}^{2}$ at 880 nm .


Type ULN-3310D is furnished in a hermetically sealed metal package with glass end cap conforming to JEDEC outline TO-52 (TO-206AC). Type ULN3310T is supplied in an inexpensive clear plastic package. Both devices are rated for operation over the temperature range of $-40^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.

## abSOLUTE MAXIMUM RATINGS

Supply Voltage ................................... 24 V
Operating Temperature Range $\ldots \ldots \ldots . \quad-40^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range
(ULN-3310D) $\ldots . . . . . . . . . . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
(ULN-3310T) $\ldots \ldots . . . . . . .-55^{\circ} \mathrm{C}$ to $+110^{\circ} \mathrm{C}$

FUNCTIONAL BLOCK DIAGRAM


## APPLICATIONS INFORMATION

Type ULN-3310D and ULN-3310T precision light sensors can be used to replace several types of light sensors:
Photocells exhibit a change in resistance proportional to light intensity. However, they are highly inaccurate. They exhibit light memory, which makes their response dependent on the previous light level.
Phototransistors exhibit no light memory, but show as much as $50 \%$ variation in sensitivity among parts of the same type due to process and beta variations. Output current as a function of light level is linear only over a very small range.

Photodiodes have an output current that is a linear function of illumination, but the output is very small. The output current is typically in the range of tens of nanoamperes. These devices also show wide unit-to-unit sensitivity variations.
Sprague Electric precision light sensors are two-terminal replacements for photocells, phototransistors, and photodiodes. They are internally calibrated, have relatively high output currents, and are linear over a very wide range of light levels. Low-level amplifiers and adjustable controls can be eliminated. The ULN-3310D/T Precision Light Sensors are also ideal for use in arrays where matched characteristics are often required. Unpackaged chips are available on special order.

Both the hermetically sealed Type ULN-3310D sensor, and the low-cost Type ULN-3310T plastic-encapsulated sensor, are cost-effective solutions to precise light-sensing or light-measurement applications.

ELECTRICAL CHARACTERISTICS af $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=12 \mathrm{~V}$

| Characteristic | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. | Units |
| Initial Accuracy at $100 \mu \mathrm{~W} / \mathrm{cm}^{2}$ | - | - | $\pm 5.0$ | \% |
| Sensitivity | 380 | 400 | 420 | $\mathrm{nA} / \mu \mathrm{W} / \mathrm{cm}^{2}$ |
| Operating Voltage Range | 2.7 | 12 | 24 | V |
| Output Linearity, 10 to $10 \mathrm{k} \mu \mathrm{W} / \mathrm{cm}^{2}$ | - | - | $\pm 5.0$ | \% |
| Dark Current | - | - | 100 | nA |
| Power Supply Rejection, $\left(\Delta \\|_{0} / l_{0}\right) / \Delta V$ | 40 | 50 | - | dB |
| Temperature Coefficient of Sensitivity | - | 3500 | - | $\mathrm{ppM} /{ }^{\circ} \mathrm{C}$ |

[^56]
## TYPICAL CHARACTERISTICS

RELATIVE SPECTRAL RESPONSE AS A FUNCTION OF WAVELENGTH OF LIGHT


PROPAGATION DELAY
AS A FUNCTION OF ILLUMINANCE


OUTPUT CURRENT
AS A FUNCTION OF ILLUMINANCE


OUTPUT CURRENT AS A FUNCTION OF SUPPLY VOLTAGE


## TYPICAL APPLICATIONS

Figure 1 shows a Type ULN-3310D or ULN-3310T integrated circuit replacing a photocell or phototransistor for the precise detection of a light level. Use of the precision light sensor eliminates the need for external calibration because it is calibrated to an initial accuracy of better than $5 \%$ during manufacture.


DWG. N0. A-11,808

Figure 1A LIGHT-LEVEL DETECTOR REQUIRING EXTERNAL CALIBRATION


DWG. NO. A-11,809

Figure 1B LIGHT-LEVEL DETECTOR USING PLS

In Figure 2, two precision light sensors are used in a differential configuration to detect the edge of an object. When the light level on the first sensor is half of that on the second, the circuit switches. This circuit operates over a wide range of ambient light levels. No external calibration is required.


Dwg. No. A-11,995
Figure 2
DIFFERENTIAL EDGE DETECTOR

SCHEMATIC


Dwg. No. A-11,996

## ULN-3310D

SENSOR-CENTER LOCATION


Dwg. No. A-11,993A

## ULN-3310T




10

## ULN-3330D, ULN-3330T, AND ULN-3330Y OPTOELECTRONIC SWITCHES

## FEATURES

- Photodiode with: On-Chip Amplifier On-Chip Level Detector On-Chip Power Driver On-Chip Regulator
- Operation to 30 kHz
- Plastic or Hermetic Package


PROVIDING complete light detection and lowlevel signal-processing circuitry in a single 3lead package, Type ULN-3330D, ULN-3330T, and ULN-3330Y optoelectronic switches are monolithic integrated circuits containing a photodiode, lowlevel amplifier, level detector, output power driver, and voltage regulator. The three devices are costeffective solutions to light-sensing consumer or industrial applications. They require no external components for operation.

The optoelectronic switches typically turn on as illumination of the photodiode falls below $55 \mu \mathrm{~W} /$ $\mathrm{cm}^{2}$ at 880 nm . An internal latch provides hysteresis: The output will not turn off until the illumina-
tion increases by approximately $12 \%$. Typical loads include an incandescent lamp, LED, sensitive relay, or d-c motor. For applications requiring interface to TTL or CMOS, Series ULN-3360 integrated circuits are similar devices that include an internal pull-up resistor.

Type ULN-3330D is furnished in a hermetically sealed metal package with a glass end cap. The ' $D$ ' package conforms to JEDEC outline TO-52 (TO206AC). The miniature Type ULN-3330T is supplied in a clear plastic package only $0.080^{\prime \prime}$ ( 2.0 mm ) thick. Type ULN-3330Y is furnished in an inexpensive clear plastic package meeting the JEDEC TO-92 (TO-226AA) outline.


## ABSOLUTE MAXIMUM RATINGS

| Supply Voltage, $\mathrm{V}_{\text {cc }}$ | 15 V |
| :---: | :---: |
| Output Voltage, $V_{\text {our }}$ | 15 V |
| Output Current, Iour | 50 mA |
| Package Power Dissipation, $P_{0}$ | See Graph |
| Operating Temperature Range, $T_{A}$ | $-40^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\text {S }}$ |  |
| ULN-3330D | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| ULN-3330T | $-55^{\circ} \mathrm{C}$ to $+110^{\circ} \mathrm{C}$ |
| ULN-3330Y | $-55^{\circ} \mathrm{C}$ to $+110^{\circ} \mathrm{C}$ |

TYPICAL TRANSFER CHARACTERISTICS


Dwg. No. A-11, 128

ELECTRICAL CHARACTERISTICS af $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}, \lambda=880 \mathrm{~nm}$

| Characteristic | Symbol | Test Conditions | Limits |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Supply Voltage Range | $V_{c c}$ |  | 4.0 | 6.0 | 15 | V |
| Supply Current | $\mathrm{lcc}^{\text {c }}$ |  | - | 4.0 | 8.0 | mA |
| Light Threshold Level | $\mathrm{E}_{\text {on }}$ | Output ON | 45 | 55 | 65 | $\mu \mathrm{W} / \mathrm{cm}^{2}$ |
|  | $E_{\text {Off }}$ | Output 0FF | - | 62 | - | $\mu \mathrm{W} / \mathrm{cm}^{2}$ |
| Hysteresis | $\Delta \mathrm{E}$ | $\left(E_{\text {off }}-E_{\text {ow }}\right) / E_{\text {off }}$ | 10 | 12 | 14 | \% |
| Output ON Voltage | $V_{\text {our }}$ | $\mathrm{l}_{\text {out }}=15 \mathrm{~mA}$ | - | 300 | 500 | mV |
|  |  | $\mathrm{I}_{\text {oir }}=25 \mathrm{~mA}$ | - | 500 | 800 | mV |
| Output OFF Current | $\mathrm{I}_{\text {our }}$ | $V_{\text {OUI }}=15 \mathrm{~V}$ | - | - | 1.0 | $\mu \mathrm{A}$ |
| Output Fall Time | $t_{1}$ | 90\% to 10\% | - | 200 | 500 | ns |
| Output Rise Time | , | 10\% to 90\% | - | 200 | 500 | ns |

RELATIVE SPECTRAL RESPONSE
AS A FUNCTION OF WAVELENGTH OF LIGHT


Dwg. No. A-12,135A

RELATIVE SWITCH RESPONSE
as a function of the angle of incidence


Dwg. No. A-10,853A

## SERIES 8126 <br> (SG3526J, SG2526J AND SG1526J) SWITCHED-MODE POWER SUPPLY CONTROL CIRCUITS

## FEATURES

- 8 V to 35 V Operation
- Dual 100 mA Source/Sink Outputs
- Internal Regulator
- Current Limiting
- Temperature-Compensated

Reference Source

- Sawtooth Generator
- Low Supply-Voltage Protection
- External Synchronization
- Double-Pulse Suppression
- Programmable Dead-Time
- Programmable Soft-Start


ULN-8126A
ULQ-8126A


ULN-8126R/SG3526J
ULQ-8126R/SG2526J
ULS-8126R/SG1526J

## ABSOLUTE MAXIMUM RATINGS of $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

Supply Voltage, V ..... 40 V
Collector Supply Voltage, $V_{c}$ ..... 40 V
Logic Input Voltage Range, $\mathrm{V}_{\text {IN }}$ ..... -0.3 V to +5.5 V
Analog Input Voltage Range, $\mathrm{V}_{\text {IN }}$ ..... -0.3 V to $\mathrm{V}_{\mathrm{s}}$
Output Current, I ..... $\pm 200 \mathrm{~mA}$
Reference Load Current, $\mathrm{I}_{\text {ReF }}$ ..... 50 mA
Logic Sink Current, I $I_{\text {IN }}$ ..... 15 mA
Package Power Dissipation, $P_{0}$ (Plastic DIP) ..... 2.3 W* $^{*}$
(Cer-DIP) ..... 1.9 W* $^{*}$
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$
See Ordering Data

[^57]All digital inputs are TTL and CMOS compatible. Active-low logic allows use of wired-OR connections.

Type ULS-8126R is supplied in an 18-pin glass/ceramic hermetically sealed (cer-DIP) package. It is rated for operation over a temperature range that recommends its use in military and aerospace applications $\left(-55^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$ ).

Types ULQ-8126A and ULQ-8126R operate over an extended temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ that meets the demands of many industrial applications.

Low-cost Types ULN-8126A and ULN-8126R are rated for continuous operation over a temperature range that recommends them for commercial use $\left(0^{\circ} \mathrm{C}\right.$ to $\left.+70^{\circ} \mathrm{C}\right)$.

Control circuits with commercial and extended temperature ranges are available in both the hermetically sealed cer-DIP package (suffix ' $R$ '") and a dual in-line plastic package (suffix " $A$ ") with a copper alloy lead frame that gives them enhanced power dissipation ratings.

Cer-DIP packaged parts normally are marked with original source part numbers shown below. Sprague part numbers appear on plastic packages. Sprague part numbers should be used on orders and correspondence concerning all Series 8126 devices.

ORDERING INFORMATION

| Operating Temperature Range | Package | Original Source Part Number | Sprague Part Number |
| :---: | :---: | :---: | :---: |
| Commercial | Cer-DIP | SG3526J | ULN-8126R |
| $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic | - | ULN-8126A |
| $\begin{gathered} \text { Extended } \\ -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{gathered}$ | Cer-DIP | SG2526J | ULQ-8126R |
|  | Plastic | - | ULQ-8126A |
| $\begin{gathered} \text { Full } \\ -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{gathered}$ | Cer-DIP | SG1526J | ULS-8126R |

## RECOMMENDED OPERATING CONDITIONS

| Logic Supply Voltage, $\mathrm{V}_{S}$ | 8 V to 35 V |
| :---: | :---: |
| Collector Voltage, $\mathrm{V}_{\mathrm{c}}$ | 4.5 V to 35 V |
| Output Load Current, Io | 0 to $\pm 100 \mathrm{~mA}$ |
| Reference Load Current, IL | 0 to 20 mA |
| Oscillator Frequency, f. | 1 Hz to 400 kHz |
| Oscillator Timing Resistance, $\mathrm{R}_{\mathrm{T}}$ | $2 \mathrm{k} \Omega$ to $150 \mathrm{k} \Omega$ |
| Oscillator Timing Capacitance, $C_{T}$ | . $0.001 \mu \mathrm{~F}$ to $20 \mu \mathrm{~F}$ |
| Programmed Deadtime | 3\% to 50\% |
| Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ | See Ordering Data |

FUNCTIONAL BLOCK DIAGRAM


Dwg. No. A-11,427

## ELECTRICAL CHARACTERISTICS over operating temperature range, $\mathbf{V}_{\mathrm{s}}=15 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | Test Pins | Test Conditions | Limits |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Extended \& FullTemperature Devices* |  |  | Commercial Temperature Devices* |  |  | Units |
|  |  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |

REFERENCE SECTION ( $I_{L}=0 \mathrm{~mA}$ )

| Reference Voltage | 18 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 4.95 | 5.00 | 5.05 | 4.90 | 5.00 | 5.10 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Over recommended conditions | 4.90 | 5.00 | 5.10 | 4.85 | 5.00 | 5.15 | V |
| Reference Voltage Regulation | 18 | $\mathrm{V}_{\mathrm{S}}=8$ to 35 V | - | 10 | 20 | - | 10 | 30 | mV |
|  |  | $\mathrm{I}_{\mathrm{L}}=0$ to 20 mA | - | 10 | 30 | - | 10 | 50 | mV |
|  |  | Over operating temperature range | - | 15 | 50 | - | 15 | 50 | mV |
| Short Circuit Current | 18 | $\mathrm{V}_{\text {REF }}=0 \mathrm{~V}$ | 25 | 50 | 100 | 25 | 50 | 100 | mA |
| Stand by Current | 17 | $\mathrm{V}_{\mathrm{S}}=35 \mathrm{~V}, \mathrm{R}_{\mathrm{T}}=4.22 \mathrm{kS}, \mathrm{V}_{8}=0.4 \mathrm{~V}$ | - | 18 | - | - | 18 | - | mA |

OSCILLATOR SECTION ( $f=40 \mathrm{kHz}, R_{T}=4.22 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{T}}=0.01 \mu \mathrm{~F}, \mathrm{R}_{\mathrm{D}}=0 \Omega$ )

| Oscillator Frequency | 9,10 | $\mathrm{R}_{\mathrm{T}}=150 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{T}}=20 \mu \mathrm{~F}$ | - | - | 1.0 | - | - | 1.0 | Hz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{R}_{\mathrm{T}}=2 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{T}}=0.001 \mu \mathrm{~F}$ | 400 | - | - | 400 | - | - | kHz |
| Initial Oscillator Accuracy | 9,10 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 3.0 | - | - | 3.0 | - | \% |
| Oscillator Stability | 9,10 | $V_{S}=8$ to 35 V | - | 0.5 | - | - | 0.5 | - | \% |
|  |  | Over operating temperature range | - | 1.0 | - | - | 1.0 | - | \% |
|  |  | Over recommended conditions | - | 2.0 | - | - | 2.0 | - | \% |
| Sawtooth Peak Voltage | 10 | $\mathrm{V}_{\mathrm{S}}=35 \mathrm{~V}$ | - | 3.0 | 3.5 | - | 3.0 | 3.5 | V |
| Sawtooth Valley Voltage | 10 | $\mathrm{V}_{\mathrm{S}}=8.0 \mathrm{~V}$ | 0.5 | 1.0 | - | 0.5 | 1.0 | - | V |
| Sync Pulse Width | 12 | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | - | 500 | - | - | 500 | - | ns |

## HOUSEKEEPING FUNCTIONS

| Logic Voltage Levels | 5,8,12 | Logic HIGH, $\mathrm{I}_{\text {SOURCE }}=-40 \mu \mathrm{~A}$ | 2.4 | 4.0 | - | 2.4 | 4.0 | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Logic LOW, SiNk $=3.6 \mathrm{~mA}$ | - | 0.2 | 0.4 | - | 0.2 | 0.4 | V |
| Input Current | 5,8,12 | $\mathrm{V}_{\text {IN }}=2.4 \mathrm{~V}$ | - | -125 | -200 | - | -125 | -200 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ | - | -225 | -360 | - | -225 | -360 | $\mu \mathrm{A}$ |
| Shutdown Delay | $\begin{gathered} 8-13 \\ 16 \end{gathered}$ | 100 mV step, 5 mv overdrive, $\mathrm{R}_{S}=50 \Omega$ | - | 300 | - | - | 300 | - | ns |

NOTES: Negative current is defined as coming out of (sourcing) the specified device pin.
"Commercial, extended, and full temperature-range devices are defined in preceding text and "Ordering Information" table.

## ELECTRICAL CHARACTERISTICS (Continued)

| Characteristic | Test Pins | Test Conditions | Limits |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Extended \& Full Temperature Devices* |  |  | Commercial Temperature Devices* |  |  | Units |
|  |  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |

## ERROR AMPLIFIER ( $\mathbf{V}_{\mathbf{c M}}=\mathbf{0}$ to 5.2 V)

| Input Offset Voltage | 1,2 | $\mathrm{R}_{\mathrm{S}}=2 \mathrm{k} \Omega$ | - | 2.0 | 5.0 | - | 2.0 | 5.0 | mV |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Bias Current | 1,2 |  | - | -350 | -1000 | - | -350 | -2000 | nA |
| Input Offset Current | 1,2 |  | - | 35 | 100 | - | 35 | 200 | nA |
| Error Amplifier Gain | 1-3 | Open loop, $\mathrm{R}_{\mathrm{L}}=10 \mathrm{M} \Omega$ | 64 | 72 | - | 60 | 72 | - | dB |
| Small Signal Bandwidth | 1-3 | $\mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}$ | 0.7 | 1.0 | - | 0.7 | 1.0 | - | MHz |
| Output Voltage Swing | 3 | Positive limit, $\mathrm{R}_{\mathrm{L}}=50 \mathrm{k} \Omega$ | 3.6 | 4.2 | - | 3.6 | 4.2 | - | V |
|  |  | Negative limit, $R_{L}=50 \mathrm{k} \Omega$ | - | 0.2 | 0.4 | - | 0.2 | 0.4 | V |
| Common Mode Range | 1,2 | $\mathrm{V}_{\mathrm{S}}=8.0 \mathrm{~V}$ | 0 | - | 5.2 | 0 | - | 5.2 | V |
| Common Mode Rejection | 1,2 | $\mathrm{R}_{\mathrm{S}}=10 \mathrm{k} \Omega$ | 70 | 94 | - | 70 | 94 | - | dB |
| Error Amplifier $V_{S}$ Rejection | 3 | $\mathrm{f}=120 \mathrm{~Hz}, \Delta \mathrm{~V}_{\mathrm{S}}=1.0 \mathrm{~V}_{\mathrm{rms}}$ | 66 | 80 | - | 66 | 80 | - | dB |

## CURRENT LIMITING

| Common Mode Range | 6,7 | $\mathrm{~V}_{\mathrm{S}}=18 \mathrm{~V}$ | 0 | - | 15 | 0 | - | 15 |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Sense Voltage | 6,7 | $\mathrm{~V}_{C M}=0$ to 15 V | - | 100 | - | - | 100 | - |
| Input Current | 6,7 | $\mathrm{~V}_{\mathrm{CM}}=0$ to 15 V | mV |  |  |  |  |  |
| Voltage Gain | $7-8$ | $\mathrm{I}_{8}=360 \mu \mathrm{~A}$ | - | -3.0 | - | - | -3.0 | - |

## SOFT-START SECTION

| Error Clamp Voltage | - | $V_{5}=0.4 \mathrm{~V}$ | - | 100 | 400 | - | 100 |
| :--- | :---: | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{C}_{S}$ Charging Current | 4 | $V_{5}=2.4 \mathrm{~V}$ | - | 100 | - | - | 100 |

## OUTPUT DRIVERS $\left(V_{c}=15 \mathrm{~V}\right)$

| Output Voltage | 13,16 | $\mathrm{I}_{\text {OUT }}=-20 \mathrm{~mA}$ | 12.5 | 13.5 | - | 12.5 | 13.5 | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{I}_{\text {OUI }}=-100 \mathrm{~mA}$ | - | 13 | - | - | 13 | - | V |
|  |  | $\mathrm{I}_{\text {OUT }}=20 \mathrm{~mA}$ | - | 0.2 | 0.3 | - | 0.2 | 0.3 | V |
|  |  | $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ | - | 1.2 | - | - | 1.2 | - | V |
| Leakage Current | 13,16 | $\mathrm{V}_{\mathrm{c}}=40 \mathrm{~V}$ | - | 0.1 | 100 | - | 0.1 | 100 | $\mu \mathrm{A}$ |
| Rise Time | 13,16 | $C_{L}=1000 \mathrm{pF}$ | - | 300 | - | - | 300 | - | ns |
| Fall Time | 13,16 | $\mathrm{C}_{L}=1000 \mathrm{pF}$ | - | 200 | - | - | 200 | - | ns |

OTES: Negative current is defined as coming out of (sourcing) the specified device pin.
*Commercial, extended, and full temperature-range devices are defined in preceding text and "Ordering Information" table.

SERIES 8160
(NE5560N, NE5560F AND SE5560F) SWITCHED-MODE POWER SUPPLY CONTROL CIRCUITS

## FEATURES

- Internal Voltage Regulator
- Current Limiting
- Temperature-Compensated Reference Source
- Sawtooth Generator
- Pulse-Width Modulator
- Remote ON/OFF Switching
- Low Supply-Voltage Protection
- Loop-Fault Protection
- Demagnetization/High-Voltage Protection
- Maximum Duty-Cycle Adjustment
- Feed-Forward Control
- External Synchronization


COMPREHENSIVE CONTROL of state-of-theart power supplies is offered by Sprague Type ULN-8160A, ULN-8160R, and ULS-8160R integrated circuits. Each control circuit has its own tem-perature-compensated reference source, an internal error amplifier, a sawtooth waveform generator, a pulse-width modulator, an output driver, and a variety of protection circuitry.

Type ULN-8160A is supplied in a 16-pin dual inline plastic package with a copper lead frame that gives the device enhanced power dissipation ratings. It is rated for operation over a temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.

Types ULN-8160R and ULS-8160R are furnished in 16-pin hermetically sealed glass/ceramic packages. These devices will withstand severe environmental contamination.

In addition, the extended temperature range of Type ULS-8160R $\left(-55^{\circ} \mathrm{C}\right.$ to $\left.+125^{\circ} \mathrm{C}\right)$ recommends it for use in military and aerospace applications.

These devices are normally branded with both the original source part number and the Sprague part numbers; however, the Sprague part number should be used on orders and in correspondence.

## ABSOLUTE MAXIMUM RATINGS

$$
\text { AT } \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}
$$

| Supply Voltage, V ${ }_{\text {S }}$ | (See Note) |
| :---: | :---: |
| Supply Current, $\mathrm{I}_{\text {ReG }}$ | 30 mA |
| Output Current, Io | 40 mA |
| Package Power Dissipation, $P_{D}$ (ULN-8160A) | $2.1 W^{*}$ |
| (ULN-8160R/ULS-8160R) | $1.7 \mathrm{~W}^{*}$ |
| Operating Temperature Range, $T_{A}$ (ULN-8160A/R) | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| (ULS-8160R) | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| *Derate linearly to OW at $\mathrm{T}_{A}=+150^{\circ} \mathrm{C}$. |  |
| Note: Maximum allowable supply voltage is dependent on value 18V@0』. | rent limiting resistor; |

ORDERING INFORMATION

| Original Source <br> Part Number | Sprague <br> Part Number | Operating <br> Temperature Range | Package |
| :---: | :---: | :---: | :---: |
| NE5560N | ULN-8160A | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic |
| NE5560F | ULN-8160R | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Cer-DIP |
| SE5560F | ULS-8160R | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Cer-DIP |

*These devices are manufactured under a cross-license with Signetics Corp. (a subsidiary of U.S. Philips Corp.)

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}$ (unless otherwise noted)

| Characteristic | $\begin{aligned} & \text { Test } \\ & \text { Pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | ULS-8160R |  |  | ULN-8160A/R |  |  | Units |
|  |  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Supply Clamp Voltage | 1 | $\mathrm{I}_{\mathrm{s}}=10 \mathrm{~mA}$ | 20 | - | 23 | 19 | - | 24 | $V$ |
|  |  | $\mathrm{I}_{\mathrm{s}}=30 \mathrm{~mA}$ | 20 | - | 30 | 20 | - | 30 | V |
| Supply Current | 1 | $\mathrm{V}_{\mathrm{S}}=12 \mathrm{~V}, \mathrm{I}_{2}=0$ | - | - | 10 | - | - | 10 | mA |

REFERENCE SECTIONS

| Internal Reference, $\mathrm{V}_{\text {REF }}$ | - | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 3.69 | 3.72 | 3.81 | 3.57 | 3.72 | 3.95 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Over operating temperature range | 3.65 | - | 3.85 | 3.53 | - | 4.00 | $V$ |
| Temperature Coefficient of $V_{\text {REF }}$ | - |  | - | $\pm 100$ | - | - | $\pm 100$ | - | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Zener Reference, $\mathrm{V}_{2}$ | 2 | $\mathrm{I}_{2}=-7.0 \mathrm{~mA}$ | 7.8 | 8.4 | 9.0 | 7.8 | 8.4 | 9.0 | V |
| Temperature Coefficient ff $V_{Z}$ | 2 |  | - | -200 | - | - | -200 | - | ppm $/{ }^{\circ} \mathrm{C}$ |

JSCILLATOR SECTION

| Jscillator Frequency Range | 7,8 |  | 50 | - | 100 k | 50 | - | 100 k | Hz |
| :--- | :--- | :--- | ---: | ---: | ---: | ---: | ---: | :---: | :---: |
| nitial Oscillator Accuracy | 7,8 | $\mathrm{R}_{7}=5 \mathrm{k} \Omega$ | - | 5.0 | - | - | 5.0 | - | $\%$ |
| Juty-Cycle Range | 7,8 | $\mathrm{f}_{0}=20 \mathrm{kHz}$ | 0 | - | 98 | 0 | - | 98 | $\%$ |

AODULATOR

| Nodulator Input Current | 5 | $\mathrm{~V}_{5}=1.0 \mathrm{~V}$ | -0.2 | 20 | - | 0.2 | 20 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

SERIES 8160
SWITCHED-MODE POWER SUPPLY CONTROL CIRCUITS

## ELECTRICAL CHARACTERISTICS (Continued)

| Characteristic | $\begin{aligned} & \text { Test } \\ & \text { Pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | ULS-8160R |  |  | ULN-8160A/R |  |  | Units |
|  |  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |

## HOUSEKEEPING FUNCTIONS

| Duty-Cycle Control | 6 | $V_{6}=0.41 \mathrm{~V}_{z}$ | 40 | 50 | 60 | 40 | 50 | 60 | $\%$ |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Duty-Cycle Control Current | 6 | Over operating temperature range | - | 0.2 | 20 | - | 0.2 | 20 | $\mu \mathrm{~A}$ |
| Protection Thresholds | 1 | Low supply-voltage protection | 8.0 | 9.0 | 10.5 | 8.0 | 9.0 | 10.5 | V |
|  | 3 | Feedback-loop protection 0 N | 400 | 600 | 720 | 400 | 600 | 720 | mV |
|  | 13 | Demagnetization/high-voltage protection | 470 | 600 | 720 | 470 | 600 | 720 | mV |
| Sense-Input Current | 3 | Over operating temperature range | -7.0 | -15 | -35 | -7.0 | -15 | -35 | $\mu \mathrm{~A}$ |
| Input Current |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | -3.0 | -20 | - | -3.0 | -20 | $\mu \mathrm{~A}$ |
|  |  | Over operating temperature range | - | - | -40 | - | - | -40 | $\mu \mathrm{~A}$ |
| Duty-Cycle Control | 16 | $\mathrm{~V}_{16}=2 \mathrm{~V}_{\mathrm{Z}}$, Percent of original duty cycle | 30 | 40 | 50 | 30 | 40 | 50 | $\%$ |
| Input Current | 16 | $\mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 0.2 | 5.0 | - | 0.2 | 5.0 | $\mu \mathrm{~A}$ |
|  |  | Over operating temperature range | - | - | 10 | - | - | 10 | $\mu \mathrm{~A}$ |

EXTERNAL SYNCHRONIZATION

| Sync Input OFF Voltage | 9 |  | 0 | - | 0.8 | 0 | - |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: | :---: |

REMOTE

| Remote OFF Voltage | 10 |  | 0 | - | 0.8 | 0 | - | 0.8 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Remote ON Voltage | 10 |  | 2.0 | - | $\mathrm{V}_{2}$ | 2.0 | - | $\mathrm{V}_{2}$ | V |
| Remote Input Current | 10 | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | -85 | -100 | - | -85 | -125 | $\mu \mathrm{A}$ |
|  |  | Over operating temperature range | - | - | -125 | - | - | -125 | $\mu \mathrm{A}$ |

CURRENT LIMITING

| Input Current | 11 | $\mathrm{V}_{11}=250 \mathrm{mV}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | -6.0 | -40 | - | -6.0 | -40 | $\mu \mathrm{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{11}=250 \mathrm{mV}$, Over operating temp. range | - | - | -80 | - | - | -80 | $\mu \mathrm{A}$ |
| Inhibit Delay | 11 | One pulse, $20 \%$ overdrive @ $\mathrm{I}_{0}=40 \mathrm{~mA}$ | - | 700 | 800 | - | 700 | 800 | ns |
| Trip Levels | 11 | Shutdown/slow start | 560 | 600 | 700 | 560 | 600 | 700 | mV |
|  |  | Current limit | 400 | 480 | 560 | 400 | 480 | 560 | mV |

## ERROR AMPLIFIER

| Error-Amplifier Gain | $3-4$ | Open loop | 54 | 60 | - | 54 | 60 | - | dB |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Error-Amplifier Feedback <br> Resistance | 4 |  | 10 | - | - | 10 | - | - | $\mathrm{k} \Omega$ |
| Small-Signal Bandwidth | $3-4$ |  | - | 3.0 | - | - | 3.0 | - | MHz |
| Output-Voltage Swing | 4 | Positive limits | 6.2 | - | 9.5 | 6.2 | - | 9.5 | V |

## OUTPUT STAGE

| Output Current | 15 |  | 40 | - | - | 40 | - | - |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| mA |  |  |  |  |  |  |  |  |
| Output-Saturation Voltage | 15 | $\mathrm{~V}_{\text {CESA } 7} @ \mathrm{I}_{\mathrm{c}}=40 \mathrm{~mA}$ | - | - | 500 | - | - | 500 |
| Output Voltage | 14 |  | 5.0 | 6.0 | - | 5.0 | 6.0 | - |

NOTE: Negative current is defined as coming out of (sourcing) the specified device pin.

## ULN-8161M (NE5561N) SWITCHED-MODE POWER SUPPLY CONTROL CIRCUIT

## FEATURES

- Stabilized Power Supply
- Current Limiting
- Temperature-Compensated

Reference Source

- Sawtooth Generator
- Pulse-Width Modulator
- Double-Pulse Protection
- Applications in
- Switched-Mode Power Supplies
- Motor Controller-Inverters
-D-C/D-C Converters


ULN-8161M/NE5561N

DESIGNED AS A CONTROLLER for low-cost switched-mode power supplies, Sprague Type ULN-8161M excels in applications requiring only limited housekeeping functions.

The integrated circuit has its own temperaturecompensated reference source, an internal Zener reference, a sawtooth waveform generator, an error amplifier, pulse-width modulator, output driver, current-sensing and low-voltage protection.

Type ULN-8161M is supplied in an 8-pin dual inline plastic package with a copper lead frame that gives it enhanced power dissipation ratings. It is rated for continuous operation over the temperature range of $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$. Similar devices are available for operation over extended temperature ranges.

This device is normally branded with both the original source part number and the Sprague part number; however, the Sprague part number should be used on orders and in correspondence.

## ABSOLUTE MAXIMUM RATINGS $\mathrm{otr}_{4}=+25^{\circ} \mathrm{C}$

Supply Voltage, $\mathrm{V}_{\mathrm{s}}$ (Voltage Sourced) . . . . . . . . . . . . . . . 18 V
Output Current, $I_{0}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . 40 mA
Output Duty Cycle . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 98\%

Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots \ldots .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{s}} \ldots \ldots \ldots-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $12.5 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

ORDERING INFORMATION

| Original Source* <br> Part Number | Sprague <br> Part Number | Operating <br> Temperature Range | Package |
| :---: | :---: | :---: | :---: |
| NE5561N | ULN-8161M | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Plastic |

*This device is manufactured in accordance with a cross-license with Signetics Corp. (a subsidary of U.S. Philips Corp.)

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+\mathbf{2 5}^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=\mathbf{1 2 \mathrm { V }}$ (unless otherwise noted)

| Characteristic | $\begin{aligned} & \hline \text { Test } \\ & \text { Pin } \end{aligned}$ | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | 1 | $\mathrm{I}_{\mathrm{S}}=10 \mathrm{~mA}$, current-fed | 19 | - | 24 | V |
| Internal Reference, $\mathrm{V}_{\text {ReF }}$ | - | Over operating temperature range | 3.55 | - | 3.98 | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 3.57 | 3.76 | 3.96 | V |
| Temperature Coefficient of $\mathrm{V}_{\text {REF }}$ | - |  | - | $\pm 100$ | - | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Zener Reference, $\mathrm{V}_{2}$ | 2 | $\mathrm{I}_{2}=-7.0 \mathrm{~mA}$ | 7.8 | 8.4 | 9.0 | V |
| Temperature Coefficient of $\mathrm{V}_{2}$ | 2 |  | - | $\pm 150$ | - | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Oscillator Frequency Range | 5 | Over operating temperature range | 50 | - | 100k | Hz |
| Initial Oscillator Accuracy | 5 |  | - | 5.0 | - | \% |
| Duty-Cycle Range | 5. | $\mathrm{f}_{0}=20 \mathrm{kHz}$ | 0 | - | 98 | \% |
| Protection Threshold | 1 | Low supply-voltage protection | 8.5 | 9.1 | 10.5 | V |
| Input Current | 6 | $\mathrm{V}_{6}=250 \mathrm{mV}$, over operating temperature range | - | - | -20 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{6}=250 \mathrm{mV}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | -2.0 | -10 | $\mu \mathrm{A}$ |
| Inhibit Delay | 6 | Single pulse, $20 \%$ overdrive at $\mathrm{I}_{0}=20 \mathrm{~mA}$ | - | 700 | 800 | ns |
| Trip Level | 6 | Current limit | 400 | 520 | 600 | mV |
| Error Amplifier Gain | 3.4 | Open loop | - | 60 | - | dB |
| Error Amplifier Feedback Resistance | 4 |  | 10 | - | - | k 2 |
| Small-Signal Bandwidth | 3.4 |  | - | 3.0 | - | MHz |
| Output-Voltage Swing | 4 | Positive limit | 6.2 | - | - | V |
|  |  | Negative limit | - | - | 0.6 | V |
| Output Current | 7 | Over operating temperature range | 20 | - | - | mA |
| Output Saturation Voltage | 7 | $V_{\text {CEISAI }}$ @ $\mathrm{I}_{\mathrm{C}}=20 \mathrm{~mA}$ | - | - | 0.5 | V |
| Supply Current | 1 | $\mathrm{I}_{2}=0$, over operating temp. range, voltage-fed | - | - | 15 | mA |
|  |  | $\mathrm{T}_{2}=0, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, voltage-fed | - | - | 9.0 | mA |

FUNCTIONAL BLOCK DIAGRAM


Dwg. No. A-11, 424

## SERIES TPP <br> MEDIUM-POWER DARLINGTON ARRAYS



TPP-1000


TPP-2000


TPP-3000


TPP-4000

THESE SPRAGUE MEDIUM-POWER arrays consist of one, two, three, or four Darlingtonpairs in a single 14-pin dual in-line plastic package.

Features of Series TPP, which complements the Sprague TPQ Series of quad transistor arrays, includes a collector-current rating of 4 A , a minimum $\mathrm{h}_{\mathrm{FE}}$ of 2,000 , and a 2 W package power dissipation rating.

The standard molded dual in-line package for Se ries TPP is identical to the type used for many inte-
grated circuits. It offers superior mechanical protection for circuit elements during automatic insertion into printed wiring boards.

## ABSOLUTE MAXIMUM RATINGS

Collector Current, $I_{\mathrm{c}}$. . . . . . . . . . . . . . . . . . . . . . . . . 4.0 A
Power Dissipation, $P_{D}$ (total package) . . . . . . . . . . . . . 2 W* $^{*}$
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature Range, $T_{S} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $16 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Collector-Emitter Breakdown Voltage | $\mathrm{BV}_{\text {ces }}$ | $\mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 40 | 50 | - | V |
| Collector-Base Breakdown Voltage | $\mathrm{BV}_{\text {c80 }}$ | $\mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 50 | 60 | - | V |
| Emitter-Base Breakdown Voltage | $\mathrm{BV}_{\text {E80 }}$ | $\mathrm{I}_{\mathrm{E}}=100 \mu \mathrm{~A}$ | 12 | 14 | - | V |
| CollectorCutoff Current | $\mathrm{I}_{680}$ | $V_{C B}=30 \mathrm{~V}$ | - | 10 | 100 | nA |
| Emitter-Cutoff Current | $1_{\text {E8O}}$ | $\mathrm{V}_{\mathrm{EB}}=10 \mathrm{~V}$ | - | 10 | 100 | nA |
| Collector-Emitter Saturation Voltage | $\mathrm{V}_{\text {CE }}$ (ata) | $\mathrm{I}_{\mathrm{B}}=1.0 \mathrm{~mA}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 1.0 | 1:5 | V |
| Base-Emitter Saturation Voltage | $V_{\text {BE }}$ (sat) | $\mathrm{I}_{\mathrm{B}}=1.0 \mathrm{~mA}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | - | 1.6 | 2.0 | V |
| Static Forward <br> Current-Transfer <br> Ratio | $\mathrm{h}_{\mathrm{FE}}$ | $\mathrm{V}_{\text {GE }}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA}$ | 2000 | - | - | - |
|  |  | $\mathrm{V}_{\mathrm{CE}}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~A}$ | 2000 | - | - | - |
|  |  | $\mathrm{V}_{\mathrm{CE}}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{c}}=2.0 \mathrm{~A}$ | 2000 | - | - | - |

## SERIES TPQ

## QUAD TRANSISTOR ARRAYS

SPRAGUE SERIES TPQ quad transistor arrays are general-purpose silicon transistor arrays consisting of four independent devices. Shown are 12 NPN types, 12 PNP types, and nine NPN/PNP complementary pairs.

All of these devices are furnished in a 14-pin dual in-line plastic package. The molded package is identical to that used in most consumer integrated circuits and offers superior mechanical protection during insertion into printed wiring boards.

## ABSOLUTE MAXIUMUM RATINGS

Power Dissipation, $P_{D}$ (Each Transistor) . . . . . . . . . . . . 500 mW
(Total Package) . . . . . . . . . . . . . . 2.0 W*
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . . .-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
*Derate at the rate of $16 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$


DWG. NO. A-10,052A
TPQ6001
TPQ6002
TPQ6100
TPQ6100A


DWG. NO. A-10.053A
TPQ6501
TPQ6502
TPQ6600 TPQ6600A TPQ6700

## Additional information on

 TPP and TPQ Transistor arrays is available from:Sprague Electric Company
Discrete Semiconductor Operation
70 Pembroke Road
Concord, New Hampshire 03301
(603) 224-1961

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Part Number | $\begin{gathered} \mathrm{Min}_{1} \\ \mathrm{BV}_{\mathrm{CBO}} \\ (V)^{2} \\ \hline \end{gathered}$ | $\begin{array}{\|c} \operatorname{Min}_{1} \\ \mathrm{BV}_{\mathrm{cE0}} \\ (V) \\ \hline \end{array}$ | $\begin{array}{\|l} \begin{array}{c} \text { Min. }^{2} \\ \mathrm{BV}_{\text {EBO }} \\ (V) \\ \hline \end{array} \\ \hline \end{array}$ | $\mathrm{I}_{880}$ |  | D-C Current Gain |  |  | Saturation Voltage, |  |  | $\mathrm{f}_{\mathrm{T}}$ |  | $\begin{aligned} & \text { Max. } \\ & C_{0} \\ & \text { (pFF) } \end{aligned}$ | Similar Discrete Devices |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  | Conditions |  | $\begin{aligned} & \text { Max. } \\ & V_{\text {CE }} \\ & (V) \\ & \hline \end{aligned}$ | $\begin{gathered} \text { Max. } \\ V_{B E} \\ \text { (V) } \\ \hline \end{gathered}$ | $\begin{array}{\|l} @ l_{c} \\ (\mathrm{~mA}) \\ \hline \end{array}$ |  |  |  |  |
|  |  |  |  | $\operatorname{Max}$ | $\begin{gathered} @ V_{\text {CB }} \\ (V) \end{gathered}$ |  | $\begin{gathered} I_{c} \\ (\mathrm{~mA}) \end{gathered}$ | $\begin{aligned} & V_{C E} \\ & \text { (V) } \end{aligned}$ |  |  |  | Min. (MHz) | $\begin{aligned} & \left.@ I_{c}\right) \\ & (\mathrm{mA}) \end{aligned}$ |  |  |
| Four NPN Devices |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| TPQ2221 | 60 | 40 | 5.0 | 50 | 50 | $\begin{aligned} & 35 \\ & 40 \\ & 20 \end{aligned}$ | $\begin{aligned} & 10 \\ & 150 \\ & 300 \end{aligned}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.40 \\ & 1.60 \end{aligned}$ | $\begin{aligned} & 1.30 \\ & 2.60 \end{aligned}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 20 | 8.0 | 2N2221 |
| TPQ2222 | 60 | 50 | 5.0 | 50 | 50 | $\begin{array}{r} 75 \\ 100 \\ 30 \\ \hline \end{array}$ | $\begin{aligned} & 10 \\ & 150 \\ & 300 \end{aligned}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.40 \\ & 1.60 \end{aligned}$ | $\begin{aligned} & 1.30 \\ & 2.60 \end{aligned}$ | $\begin{array}{\|l\|} \hline 150 \\ 300 \end{array}$ | 200 | 20 | 8.0 | 2N2222 |
| TPQ2483 | 60 | 40 | 6.0 | 20 | 45 | $\begin{array}{\|l} \hline 100 \\ 150 \\ 150 \\ \hline \end{array}$ | $\begin{aligned} & 0.1 \\ & 1.0 \\ & 10 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & \hline 0.35 \\ & 0.50 \\ & \text { (See No } \end{aligned}$ | $\begin{aligned} & 0.70 \\ & 0.80 \\ & \text { ote 1) } \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 10 \end{aligned}$ | 50 | 0.5 | 6.0 | 2N2483 |
| TPQ2484 | 60 | 40 | 6.0 | 20 | 45 | $\begin{array}{\|l\|} \hline 200 \\ 300 \\ 300 \\ \hline \end{array}$ | $\begin{gathered} 0.1 \\ 1.0 \\ 10 \end{gathered}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 0.35 \\ & 0.50 \\ & \text { See N } \end{aligned}$ | $\begin{gathered} 0.70 \\ 0.80 \\ \text { ote 1) } \end{gathered}$ | $\begin{aligned} & 1.0 \\ & 10 \end{aligned}$ | 50 | 0.5 | 6.0 | 2N2484 |
| TPQ3724 | $\begin{array}{\|c\|} \hline 60 \\ \text { (Note } \\ \text { 2) } \\ \hline \end{array}$ | 30 | 5.0 | 500 | 40 | $\begin{aligned} & 35 \\ & 25 \end{aligned}$ | $\begin{aligned} & \hline 100 \\ & 500 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 2.0 \end{aligned}$ | 0.45 | 1.00 | 500 | 250 | 50 | 10 | 2N3724 |
| TPQ3725 | 60 | 40 | 5.0 | 500 | 40 | $\begin{aligned} & 35 \\ & 25 \end{aligned}$ | $\begin{aligned} & 100 \\ & 500 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 2.0 \\ & \hline \end{aligned}$ | 0.45 | 1.00 | 500 | 250 | 50 | 10 | 2N3725 |
| TPQ3725A | $\begin{array}{\|c\|} \hline 70 \\ \text { (Note } \\ \hline \text { 2) } \\ \hline \end{array}$ | 50 | 5.0 | 500 | 40 | $\begin{aligned} & 40 \\ & 30 \end{aligned}$ | $\begin{aligned} & 100 \\ & 500 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 2.0 \end{aligned}$ | 0.45 | 1.00 | 500 | 200 | 50 | 10 | 2N3725A |
| TPQ3904 | 60 | 40 | 6.0 | 50 | 40 | $\begin{aligned} & 30 \\ & 50 \\ & 75 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 1.0 \\ & 10 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ | 0.20 | 0.85 | 10 | 250 | 10 | 4.0 | 2N3904 |
| TPQ5550 | 160 | 140 | 6.0 | 100 | 100 | $\begin{aligned} & 60 \\ & 60 \\ & 20 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 10 \\ & 50 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.15 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 1.00 \\ & 1.20 \end{aligned}$ | $\begin{aligned} & 10 \\ & 50 \end{aligned}$ | 100 | 10 | 6.0 | 2N5550 |
| TP05551 | 180 | 160 | 6.0 | 50 | 120 | $\begin{aligned} & \hline 80 \\ & 80 \\ & 30 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 10 \\ & 50 \\ & \hline \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.15 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 1.00 \\ & 1.20 \end{aligned}$ | $\begin{aligned} & 10 \\ & 50 \end{aligned}$ | 100 | 10 | 6.0 | 2N5551 |
| TPQA05 | 60 | 60 | 4.0 | 100 | (Note 3) | $\begin{aligned} & 50 \\ & 50 \end{aligned}$ | $\begin{array}{r} 10 \\ 100 \\ \hline \end{array}$ | $\begin{array}{r} 1.0 \\ 2.0 \\ \hline \end{array}$ | 0.25 | - | 100 | - | - | 10 | MPSA05 |
| TPQA06 | 80 | 80 | 4.0 | 100 | (Note 4) | $\begin{aligned} & \hline 50 \\ & 50 \end{aligned}$ | $\begin{array}{r} 10 \\ 100 \\ \hline \end{array}$ | $\begin{aligned} & 1.0 \\ & 2.0 \\ & \hline \end{aligned}$ | 0.25 | - | 100 | - | - | 10 | MPSA06 |

## NOTES:

1. Base-emitter voltage shown is $\mathrm{V}_{\text {Beom }}$ at indicated $\mathrm{I}_{\mathrm{c}}, \mathrm{V}_{\mathrm{CE}}=5.0 \mathrm{~V}$.
2. $\mathrm{BV}_{\text {ces }}$
3. $1_{\mathrm{CSS}} \mathrm{at} \mathrm{V}_{\mathrm{OE}}=50 \mathrm{~V}, V_{\mathrm{BE}}=0$.
4. $\mathrm{l}_{\mathrm{Cs}} \mathrm{at} \mathrm{V}_{\mathrm{CE}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

| Part Number | $\begin{array}{\|c} \begin{array}{c} \text { Min. }_{1} \\ \mathrm{BV}_{\text {c80 }} \\ (V) \end{array} \\ \hline \end{array}$ | $\begin{array}{\|c} \begin{array}{c} \text { Min. } \\ \text { BV }{ }_{\text {ceo }} \\ (V) \end{array} \\ \hline \end{array}$ | $\begin{array}{\|c} \begin{array}{c} \text { Min. } \\ \mathrm{BV}_{\mathrm{EBO}} \\ (\mathrm{~V}) \end{array} \\ \hline \end{array}$ | $\mathrm{I}_{680}$ |  | D-C Current Gain |  |  | Saturation Voltage |  |  |  |  | $\begin{gathered} \text { Max. } \\ C_{00} \\ (\mathrm{pF}) \end{gathered}$ | Similar Discrete Devices |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | $\begin{gathered} \text { Min. } \\ \mathrm{h}_{\mathrm{fE}} \end{gathered}$ | Conditions |  | $\begin{array}{\|cc} \hline \text { Max. } & \text { Max. } \\ V_{\mathrm{CE}} & \mathrm{~V}_{\mathrm{BE}} \\ \text { (V) } & (\mathrm{V}) \\ \hline \end{array}$ |  | $\begin{aligned} & @ \cdot I_{c} \\ & (\mathrm{~mA}) \end{aligned}$ |  |  |  |  |
|  |  |  |  | Max. <br> (nA) | $\begin{gathered} @ V_{\text {CB }} \\ \text { (V) } \end{gathered}$ |  | $\begin{gathered} \mathrm{I}_{\mathrm{c}} \\ (\mathrm{~mA}) \end{gathered}$ | $\begin{aligned} & V_{\mathrm{VE}} \\ & \text { (V) } \end{aligned}$ |  |  |  |  |  |  |  |
| Four PNP Devices |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| TPQ2906 | -60 | -40 | -5.0 | 50 | -30 | $\begin{aligned} & 35 \\ & 40 \\ & 30 \end{aligned}$ | $\begin{array}{r} 10 \\ 150 \\ 300 \\ \hline \end{array}$ | $\begin{array}{r} \hline-10 \\ -10 \\ -10 \\ \hline \end{array}$ | $\begin{aligned} & -0.40- \\ & -1.60 \end{aligned}$ | $\begin{array}{l\|} \hline-1.30 \\ -2.60 \end{array}$ |  | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 50 | 8.0 | 2N2906 |
| TPQ2907 | -60 | -40 | -5.0 | 50 | -30 | $\begin{array}{\|r\|} \hline 75 \\ 100 \\ 50 \\ \hline \end{array}$ | $\begin{array}{r} 10 \\ 150 \\ 300 \end{array}$ | $\begin{aligned} & \hline-10 \\ & -10 \\ & -10 \\ & \hline \end{aligned}$ | $\begin{array}{\|l\|} \hline-0.40- \\ -1.60- \end{array}$ | $\begin{aligned} & \hline-1.30 \\ & -2.60 \end{aligned}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 50 | 8.0 | 2N2907 |
| TPQ2907A | -60 | -60 | -5.0 | 50 | -30 | $\begin{array}{\|r\|} \hline 75 \\ 100 \\ 50 \\ \hline \end{array}$ | $\begin{array}{r} 10 \\ 150 \\ 300 \\ \hline \end{array}$ | $\begin{array}{r} \hline-10 \\ -10 \\ -10 \\ \hline \end{array}$ | $\begin{aligned} & -0.40- \\ & -1.60 \end{aligned}$ | $\begin{aligned} & -1.30 \\ & -2.60 \end{aligned}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 50 | 8.0 | 2N2907A |
| TPQ3798 | -60 | -40 | -5.0 | 10 | -50 | $\begin{array}{\|l\|} \hline 100 \\ 150 \\ 150 \\ 125 \\ \hline \end{array}$ | $\begin{gathered} 0.01 \\ 0.1 \\ 0.5 \\ 10 \end{gathered}$ | $\begin{aligned} & -5.0 \\ & -5.0 \\ & -5.0 \\ & -5.0 \\ & \hline \end{aligned}$ | $\begin{array}{\|l\|} \hline-0.20- \\ -0.25- \end{array}$ | $\begin{aligned} & -0.70 \\ & -0.80 \end{aligned}$ | $\begin{aligned} & \hline 0.1 \\ & 1.0 \end{aligned}$ | 60 | 1.0 | 4.0 | 2N3798 |
| TPQ3799 | -60 | -60 | -5.0 | 10 | -50 | $\begin{array}{\|l\|} \hline 225 \\ 300 \\ 300 \\ 250 \\ \hline \end{array}$ | $\begin{array}{\|c\|} \hline 0.01 \\ 0.1 \\ 0.5 \\ 10 \\ \hline \end{array}$ | $\begin{array}{r} -5.0 \\ -5.0 \\ -5.0 \\ -5.0 \\ \hline \end{array}$ | $\begin{aligned} & -0.20- \\ & -0.25- \end{aligned}$ | $\begin{aligned} & \hline-0.70 \\ & -0.80 \end{aligned}$ | $\begin{aligned} & \hline 0.1 \\ & 1.0 \end{aligned}$ | 60 | 1.0 | 4.0 | 2N3799 |
| TPQ3906 | -40 | -40 | $-5.0$ | 50 | -30 | $\begin{aligned} & 40 \\ & 60 \\ & 75 \end{aligned}$ | $\begin{gathered} \hline 0.1 \\ 1.0 \\ 10 \\ \hline \end{gathered}$ | $\begin{array}{r} -1.0 \\ -1.0 \\ -1.0 \\ \hline \end{array}$ | -0.25- | -0.85 | 10 | 200 | 10 | 4.5 | 2N3906 |
| TPQ4258 | -12 | -12 | -4.5 | 10 | -6.0 | 30 | 10 | -3.0 | -0.15 - | -0.95 | 10 | 700 | 10 | 3.0 | 2N4258 |
| TPQ4354 | -60 | -60 | -5.0 | 50 | -50 | $\begin{aligned} & 25 \\ & 40 \\ & 50 \\ & 40 \\ & \hline \end{aligned}$ | $\begin{array}{r} 0.1 \\ 1.0 \\ 10 \\ 100 \\ \hline \end{array}$ | $\begin{array}{r} -10 \\ -10 \\ -10 \\ -10 \\ \hline \end{array}$ | -0.15- | -0.90 | 150 | 100 | 50 | $\begin{array}{\|c\|} \hline 30 \\ \text { Note } \\ 1) \end{array}$ | 2N4354 |
| TPQ5400 | -130 | -120 | -5.0 | 100 | (Note 2) | $\begin{aligned} & 30 \\ & 40 \\ & 40 \\ & \hline \end{aligned}$ | $\begin{gathered} 1.0 \\ 10 \\ 50 \\ \hline \end{gathered}$ | $\begin{array}{r} -5.0 \\ -5.0 \\ -5.0 \\ \hline \end{array}$ | $\begin{aligned} & -0.20 \\ & -0.50 \\ & \hline \end{aligned}$ | $\begin{aligned} & -1.00 \\ & -1.00 \end{aligned}$ | $\begin{aligned} & 10 \\ & 50 \end{aligned}$ | 100 | 10 | 6.0 | 2N5400 |
| TPQ5401 | -160 | -150 | -5.0 | 100 | (Note 3) | $\begin{aligned} & 50 \\ & 60 \\ & 50 \\ & \hline \end{aligned}$ | $\begin{gathered} \hline 1.0 \\ 10 \\ 50 \\ \hline \end{gathered}$ | $\begin{array}{r} -5.0 \\ -5.0 \\ -5.0 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline-0.20 \\ -0.50 \end{array}$ | $\begin{aligned} & 1.00 \\ & 1.00 \end{aligned}$ | $\begin{aligned} & 10 \\ & 50 \end{aligned}$ | 100 | 10 | 6.0 | 2N5401 |
| TPQA55 | -60 | -60 | -4.0 | 100 | (Note 4) | $\begin{aligned} & 50 \\ & 50 \end{aligned}$ | $\begin{array}{r} 10 \\ 100 \end{array}$ | $\begin{array}{r} -1.0 \\ -2.0 \end{array}$ | $-0.25$ | - | 100 | - | - | 15 | MPSA55 |
| TPQA56 | -80 | -80 | -4.0 | 100 | (Note 5) | $\begin{aligned} & 50 \\ & 50 \end{aligned}$ | 10 100 | -1.0 -2.0 | $-0.25$ | - | 100 | - | - | 15 | MPSA56 |

## NOTES:

1. $\mathrm{C}_{\mathrm{c}}$
2. $\mathrm{I}_{\mathrm{CsS}}$ at $\mathrm{V}_{\mathrm{CE}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$.
3. $\mathrm{C}_{\mathrm{CE}} \mathrm{at} \mathrm{V}_{\mathrm{CE}}=120 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$.
4. $\mathrm{I}_{\mathrm{Css}}$ at $\mathrm{V}_{\mathrm{VE}}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$.
5. $l_{\text {Ces }} a t V_{\mathrm{cE}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$.

## ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{A}=+25^{\circ} \mathrm{C}$

| Part <br> Number <br> (See Note) | $\begin{array}{\|c} \begin{array}{c} \text { Min. } \\ \mathrm{BV}_{\text {c8o }} \\ \text { (V) } \end{array} \\ \hline \end{array}$ | $\begin{array}{\|c\|} \hline \text { Min. } \\ \text { BV }{ }_{\text {ceo }} \\ (V) \\ \hline \end{array}$ | $\begin{gathered} \mathrm{Min}_{1} \\ \mathrm{BV}_{\text {EBO }} \\ (\mathrm{V}) \\ \hline \end{gathered}$ | $\mathrm{I}_{\text {c80 }}$ |  | D-C Current Gain |  |  | Saturation Voltage |  |  | $\mathrm{f}_{\mathrm{T}}$ |  | $\begin{aligned} & \text { Max. } \\ & \mathrm{C}_{\mathrm{ob}} \\ & \text { (pF) } \end{aligned}$ | Similar <br> Discrete Devices |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | $\begin{aligned} & \text { Min. } \\ & h_{\mathrm{ff}} \\ & \hline \end{aligned}$ | Conditions |  | Max. <br> $V_{\text {cE }}$ <br> (V) <br> evices | $\begin{aligned} & \text { Max. } \\ & V_{\text {BE }} \\ & \text { (V) } \\ & \hline \end{aligned}$ | $\begin{gathered} @ l_{c} \\ (\mathrm{~mA}) \end{gathered}$ |  |  |  |  |
|  |  |  |  | Max. <br> (nA) | $\begin{gathered} @ V_{\text {CB }} \\ (V) \\ \hline \end{gathered}$ |  | $\begin{gathered} I_{c} \\ (\mathrm{~mA}) \end{gathered}$ | $\begin{aligned} & V_{\mathrm{VE}} \\ & \text { (V) } \end{aligned}$ |  |  |  | Min. (MHz) | $\begin{aligned} & @ I_{c} \\ & (\mathrm{~mA}) \end{aligned}$ |  |  |
| Two NPN/Two PNP Devices |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| TPQ6001 | 60 | 30 | 5.0 | 30 | 50 | $\begin{aligned} & 25 \\ & 35 \\ & 40 \\ & 20 \\ & \hline \end{aligned}$ | $\begin{array}{r}1.0 \\ 10 \\ 150 \\ 300 \\ \hline\end{array}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & 10 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 0.40 \\ & 1.40 \end{aligned}$ | $\begin{aligned} & 1.30 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 50 | 8.0 | $\begin{aligned} & \text { 2N2221 } \\ & \text { and } \\ & \text { 2N2906 } \end{aligned}$ |
| TPQ6002 (Note 1) | 60 | 30 | 5.0 | 30 | 50 | $\begin{array}{\|r\|} \hline 50 \\ 75 \\ 100 \\ 30 \\ \hline \end{array}$ | $\begin{array}{r} 1.0 \\ 10 \\ 150 \\ 300 \\ \hline \end{array}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & 10 \\ & \hline \end{aligned}$ | $\begin{aligned} & 0.40 \\ & 1.40 \end{aligned}$ | $\begin{aligned} & 1.30 \\ & 2.00 \end{aligned}$ | $\begin{array}{\|l\|} \hline 150 \\ 300 \end{array}$ | 200 | 50 | 8.0 | $\begin{gathered} \text { 2N2222 } \\ \text { and } \\ \text { 2N2907 } \end{gathered}$ |
| TPQ6100 | 60 | 40 | 5.0 |  | 50 | $\begin{aligned} & 50 \\ & 75 \\ & 75 \\ & 60 \end{aligned}$ | 0.1 0.5 1.0 10 | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | 0.25 | 0.80 | 1.0 | 100 | 0.5 | 4.0 | $\begin{aligned} & \text { 2N2483 } \\ & \text { and } \\ & \text { 2N3798 } \end{aligned}$ |
| TPQ6100A | 60 | 45 | 5.0 | 10 | 50 | $\begin{array}{\|c\|} \hline 100 \\ 150 \\ 150 \\ 60 \\ \hline \end{array}$ | 10 <br> 0.1 <br> 0.5 <br> 1.0 <br> 10 | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | 0.25 | 0.80 | 1.0 | 100 | 0.5 | 4.0 | $\begin{gathered} \text { 2N2484 } \\ \text { and } \\ \text { 2N3799 } \end{gathered}$ |
| TPQ6501 | 60 | 30 | 5.0 |  | 50 | $\begin{aligned} & 25 \\ & 35 \\ & 40 \\ & 20 \\ & \hline \end{aligned}$ | $\begin{array}{r} 1.0 \\ 10 \\ 150 \\ 300 \\ \hline \end{array}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.40 \\ & 1.40 \end{aligned}$ | $\begin{aligned} & 1.30 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 50 | 8.0 | $\begin{gathered} \text { 2N2221 } \\ \text { and } \\ \text { 2N2906 } \end{gathered}$ |
| TPQ6502 | 60 | 30 | 5.0 | 30 | 50 | $\begin{array}{r} 50 \\ 75 \\ 100 \\ 30 \end{array}$ | $\begin{array}{r} 1.0 \\ 10 \\ 150 \\ 300 \\ \hline \end{array}$ | $\begin{aligned} & 10 \\ & 10 \\ & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 0.40 \\ & 1.40 \end{aligned}$ | $\begin{aligned} & 1.30 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 150 \\ & 300 \end{aligned}$ | 200 | 50 | 8.0 | $\begin{gathered} \text { 2N2222 } \\ \text { and } \\ \text { 2N2907 } \end{gathered}$ |
| TPQ6600 | 60 | 40 | 5.0 | 10 | 50 | $\begin{aligned} & 50 \\ & 75 \\ & 75 \\ & 60 \end{aligned}$ | 0.1 0.5 1.0 10 | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | 0.25 | 0.80 | 1.0 | 100 | 0.5 | 4.0 | $\begin{gathered} \text { 2N2483 } \\ \text { and } \\ \text { 2N3798 } \end{gathered}$ |
| TPQ6600A | 60 | 45 | 5.0 | 10 |  | $\begin{array}{\|r\|} \hline 100 \\ 150 \\ 150 \\ 60 \\ \hline \end{array}$ | 10 <br> 0.1 <br> 0.5 <br> 1.0 <br> 10 | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | 0.25 | 0.80 | 1.0 | 100 | 0.5 | 4.0 | $\begin{gathered} \text { 2N2484 } \\ \text { and } \\ \text { 2N3799 } \end{gathered}$ |
| TPQ6700 | 40 | 40 | 5.0 | 50 | 30 | 30 50 70 | 0.1 1.0 10 | 1.0 1.0 1.0 | 0.25 | 0.90 | 10 | 200 | 10 | 4.5 | $\begin{gathered} \hline \text { 2N3904 } \\ \text { and } \\ \text { 2N3906 } \end{gathered}$ |

## NOTE:

NPN/PNP complementary pairs. Polarity shown is for NPN devices.

## AN ELECTRONIC LAMP MONITOR

## REQUIREMENTS

There are several requirements for a lamp monitoring system. The system should be able to monitor all types of exterior lamps on the automobile; the number of lamps must not be critical to the design. The system must be easy to assemble; it should be simple in design so that it can be repaired in the field with minimal training of personnel; it must be reliable and must be able to withstand the electrical and environmental conditions to which the vehicle is subjected. There should be minimal change from one car line to another, and from one model year to another. Most importantly, the unit cost should be reasonable.

## LAMP MONITORING METHODS

Several methods of detecting lamp failure have been examined by the automotive industry. In one, reed relays mounted close to the wiring harness are closed by the electromagnetic force produced by the lamp current. If a lamp fails, the relay opens, resulting in an indication on the dashboard. The system has inherent problems, including a lack of uniformity of the relays, tight tolerances on the proximity of the relays to the wiring assemblies, and the effects of vibration in the automobile.

Another method of monitoring lamps involves the use of phototransistors (Figure 1). These lightsensitive solid-state devices detect the presence of light at each monitored lamp. The signals from each


Figure 1
PHOTOTRANSISTOR SYSTEM
lamp are brought to a common switch, which controls the operation of an indicator on the dash. This monitoring system is unattractive to the user because of cost, difficulty in placement of the sensing devices, inability to detect a single failure in a dual filament lamp, and the need for calibration of devices for various types of lamps.
One of the more frequently used systems employs fiber optics (Figure 2). The fiber-optic system uses a plastic or glass fiber that transmits light and gives a positive-function indication for each of the lamps monitored. However, this system is used only in applications requiring the monitoring of a small number of lamps, since the cost of materials and of routing fiber optics is prohibitively expensive.


Dwg. No. $A-11,472$

Figure 2
FIBER-OPTIC SYSTEM

## SOLUTION

The Sprague Type ULN-2435A electronic lamp monitor overcomes technical problems discussed above while taking advantage of the low cost of integrated circuits. This integrated circuit monitors all types of exterior lamps and provides five outputs capable of driving light-emitting diodes that indicate the location of automotive lamp failure.


Figure 3
BRIDGE MONITORING SYSTEM
The principle of operation is that of a simple bridge circuit (Figure 3) in which the top two legs of the bridge are the wiring-assembly resistance or discrete resistors. The bottom legs of the bridge circuit are the monitored lamps. Four differential amplifiers sense the voltage drops in the wiring assemblies (approximately 20 mV ) for each of the various lamp circuits. When the system detects a difference in voltage due to an open filament, the appropriate output driver is turned ON.

A sixth output driver gives an indication if any of the monitored lamps fail. This output can be used to drive an audible signaling device or a centrallylocated warning lamp.

## CIRCUIT DESCRIPTION

A simplified detector is shown in Figure 4. Q1 and Q2 form a differential amplifier. The amplified differential signal is applied at Point A-B to threshold


Figure 4 SIMPLIFIED DETECTOR
detectors Q3 and Q4, which drive the LED driver transistors. D1 and D2 perform the dual function of level-shifting the input signal and establishing required bias currents for Q1 and Q2. Since the supply current is derived from the lamp lines, standby current is reduced to zero when the lamps are turned off.

The use of PNPs in the detectors reduces the system's susceptibility to high-frequency noise. Figure 5 shows a comparison of frequency response for a monolithic NPN transistor and a monolithic PNP transistor.


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Figure 5 FREQUENCY RESPONSE

A block diagram of a typical application of Type ULN-2435A is depicted in Figure 6. In this application, eight lamps and three fuses are monitored. The stop-lamp fuse (A) is monitored by the circuitry at Pin 4. If the fuse blows, the LEDs connected to pins 10 and 13 turn ON. By using separate fuses for the park lamps and tail/marker-lamp circuits, detectors 1 and 2 can double as fuse monitors. If, for example, fuse B blows, detectors 1 and 2 turn on the LEDs connected to pins 1 and 16. An additional input, pin 6 , is used to test the LEDs and the master indicator during cranking.

The simplistic design of this system enables easy installation in an automobile. No external components are required, other than the LED indicators and the voltage-dropping resistors, to complete the system. The integrated circuit may be mounted on a printed wiring board. Depending on lamp current, the copper runs of a printed wiring board might be
used as the top legs of the bridge circuit. A failure within the integrated circuit will not affect lamp operation or other automotive functions.

## TRANSIENT PROTECTION

In laying out the integrated circuit, careful consideration was given to providing on-chip voltagetransient protection. The LED driver transistors, for example, were designed to withstand an 80 -volt load-dump transient. The detector inputs are also designed to withstand 80 volts. In addition, the inputs to the detectors are essentially grounded through the low-resistance lamps being monitored, which further protects the integrated circuit from transients. Reverse-battery protection is included on the chip. In the event of a battery reversal, the PNPs provide inherent protection, while the dielectrically-isolated resistors provide additional safeguards.


Figure 6
TYPICAL APPLICATION
high-Current interface drivers

## BIMOS AND COMPLEX ARRAY INTERFACE DRIVERS

## MIITARY AND AEROSPACE DEVICES

RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

## AUDIO POWER AMPLIFIERS

HALL EFFECT DEVICES

TRANSISTOR ARRAYS AND MISCELLANEOUS DEVICES

| CUSTOM DEVICES |  |
| :--- | :--- |
| PACKAGE INFORMATION | $\square$ |




$x^{2}+x+\frac{1}{2}$
$3+4$
$3 \times 2+3 \times$



## SECTION 11 - CUSTOM DEVICES

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## ULN-2350C AND ULN-2351C TUFF CHIP ${ }^{\circledR}$ SEMI-CUSTOM INTEGRATED CIRCUITS

## FEATURES

- $\mathrm{BV}_{\text {ces }}=80 \mathrm{~V}$ Min.
- 250 mA Outputs
- 500 Volt Resistors
- High-Gain PNP Transistors
- 80 pF Capacitors
- Time and Cost Savings

TUFF CHIP SEMI-CUSTOM integrated circuits offer substantial time and cost savings for custom circuit applications requiring from 2,000 to 100,000 pieces. This is an area that previously was met by hybrid circuits and, in some cases, by printed wiring boards.
The TUFF CHIP semi-custom approach utilizes a standard array of components fabricated on a single silicon chip: the ULN-2350C contains 460 separate elements; the ULN-2351C provides 261. Besides the traditional complement of NPN and lateral PNP transistors, high-gain vertical PNP transistors are included.
The user lays out the interconnecting circuit, similar to a printed wiring board layout, on sheets provided by Sprague Electric. The artwork is checked by Sprague engineers, and used to generate the customer's proprietary metal mask. Finished circuits are electrically probed and visually inspected. Chips are tray-packed for hybrid circuit manufacturers or are mounted in plastic, ceramic, or hermetic dual inline packages with from eight to 28 pins.
TUFF CHIP components are optimized for a minimum $\mathrm{BV}_{\text {CES }}$ of 80 volts. Two or four 250 mA power transistors are provided, and these may be paralleled for high current requirements. On-chip transient protection of sensitive circuit components utilizes deposited film resistors with breakdown voltages higher than 500 volts. On-chip

$89 \times 104$ mils
$2.26 \times 2.64 \mathrm{~mm}$
ULN-2351C

capacitors may be used for noise suppression or filtering.
Circuit users can expect prototypes six to 10 weeks after submitting initial artwork; production quantities can be shipped eight to 10 weeks after prototype approval.

ELECTRICAL CHARACTERISTICS at $\mathrm{T}_{\mathbf{j}}=+25^{\circ} \mathrm{C}$

| Characteristic |  | Limits |  | Units |
| :---: | :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |  |
| Small-Signal NPN Transistors |  |  |  |  |
| $\mathrm{h}_{\mathrm{Ft}}$ at $\mathrm{l}_{\mathrm{c}}=1.0 \mathrm{~mA}$ | 50 | 150 | 200 | - |
| Matching of $\mathrm{h}_{\text {fe }}$ | - | 10 | 20 | $\pm \%$ |
| $\mathrm{BV}_{\text {CEO }}$ at $\mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 30 | 40 | - | V |
| $\mathrm{BV}_{\text {ces }}$ at $\mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 80 | 100 | - | V |
| $\mathrm{BV}_{\text {E80 }}$ at $\mathrm{I}_{\mathrm{E}}=100 \mu \mathrm{~A}$ | 6.9 | - | 7.7 | V |
| $\begin{aligned} & \mathrm{R}_{\text {sar }} \text { at } \mathrm{I}_{\mathrm{B}}=100 \mu \mathrm{~A} \\ & \text { (with plug) } \end{aligned}$ | - | 300 | - | $\Omega$ |
| Cutoff Frequency | - | 500 | - | MHz |
| Useful Current Range | 0.1 | - | 10k | $\mu \mathrm{A}$ |
| NPN Power Transistors |  |  |  |  |
| $\mathrm{h}_{\mathrm{FE}}$ at $\mathrm{I}_{\mathrm{c}}=200 \mathrm{~mA}$ | 50 | 150 | 200 | - |
| $\mathrm{BV}_{\text {ce }}$ at $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 30 | 40 | - | $V$ |
| $\mathrm{BV}_{\text {ces }}$ at $\mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 80 | 100 | - | V |
| $\mathrm{V}_{\text {CESAI }}$ at $\mathrm{I}_{\mathrm{c}}=250 \mathrm{~mA}$ | - | - | 1.4 | V |
| Useful Current Range | 2.0 | - | 250 | mA |
| Lateral PNP Transistors |  |  |  |  |
| $\mathrm{hfita}_{\text {at }} \mathrm{I}_{\mathrm{c}}=100 \mu \mathrm{~A}$ | 15 | 30 | - | - |
| $\mathrm{BV}_{\text {cto }}$ at $\mathrm{I}_{\mathrm{c}}=10 \mu \mathrm{~A}$ | 60 | 80 | - | V |
| Cutoff Frequency | - | 3.0 | - | MHz |
| Vertical PNP Transistors |  |  |  |  |
| $\mathrm{hrE}_{\text {Ft }}$ at $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 30 | 60 | - | - |
| $\mathrm{BV}_{\text {ceo }}$ at $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | 50 | - | - | V |
| Passive Components |  |  |  |  |
| Resistor Tolerance | - | - | 30 | $\pm \%$ |
| Resistor Matching (1:1) Tol. | - | 1.0 | 3.0 | $\pm \%$ |
| BV-Base Resistor to Substrate | - | 80 | - | V |
| BV-Deposited Film Resistor to Substrate | 500 | - | - | V |
| Capacitance Tolerance | - | 40 | - | $\pm \%$ |
| BV-Capacitors | 12 | - | - | V |

## COMPONENT LIST

| Component | Number of Devices |  |
| :---: | :---: | :---: |
|  | ULN-2350C | ULN-2351C |
| Small-Signal NPN Transistors | 70 | 38 |
| NPN Power Transistors | 4 | 2 |
| Lateral PNP Transistors | 27 | 14 |
| Vertical PNP Transistors | 10 | 17 |
| $5.8 \mathrm{~V}$ <br> Zener Diodes | 5 | 2 |
| Base Resistors: $200 \Omega$ | 10 | 5 |
| $450 \Omega$ | 20 | 12 |
| $900 \Omega$ | 20 | 12 |
| $1.8 \mathrm{k} \Omega$ | 20 | 12 |
| $3.6 \mathrm{k} \Omega$ | 20 | 12 |
| Deposited Film Resistors: $2.0 \mathrm{k} \Omega$ | 16 | 8 |
| $4.5 \mathrm{k} \Omega$ | 58 | 33 |
| $9.0 \mathrm{k} \Omega$ | 48 | 28 |
| $18 \mathrm{k} \Omega$ | 50 | 29 |
| $36 \mathrm{k} \Omega$ | 72 | 42 |
| 80 pF Capacitors | 10 | 5 |
| Bonding Pads | 28 | 19 |

## HIGH-VOLTAGE, SEMI-CUSTOM COMPONENT ARRAYS

## INTRODUC'TION

Semi-custom integrated circuits have been produced for several years for the low-volume integrated circuit market.

The semi-custom approach uses wafers that are completely fabricated except for the interconnecting metal. The user designs the interconnecting metal mask to convert the uncommitted circuit components into a unique integrated circuit based on his original pattern.

Traditionally, component arrays have been limited in voltage-handing capability to less than 30 volts. The ULN-2350C and ULN-2351C component arrays overcome this limitation, and provide features not found in other arrays.

## CHIP FEATURES

One of the goals of laying out the arrays was to enable the user to design a semi-custom integrated circuit without concern over how to protect the circuit from destructive transient voltages. For example, the arrays' power transistors were designed to meet present automotive "load dump" requirements without the usual zener clamp diode. Design rules for layout and the manufacturing process were developed for a BVCES of greater than 80 volts.


#### Abstract

Dielectrically isolated chin-film polysilicon resistors were chosen for the major portion of the resistive element, along with a complement of diffused resistors. Among advantages of thin-film resistors are an inherent ability to withstand voltage transients of up to 500 volts, and high resistance per unit area. These two properties can be utilized to protect sensitive circuit elements from damage by limiting the peak transient current.


Since thin-film resistors do not form a PN junction during their manufacture and are not polarity-sensitive, protection from inadvertant power supply reversal is achieved without external components.

The total available resistance for the ULN-2350C is $4 \mathrm{M} \Omega$. Previous component arrays of similar chip size, using only diffused resistors, offered a total resistance of approximately $400 \mathrm{k} \Omega$.

The availability of highvalue resistors is important in applications requiring low standby current and/or low power dissipation.

Capacitors formed by buriedlayer and isolation diffusions, with typical values of 80 pF , were included in the arrays for applications requiring noise suppression and stabilization. The capacitors in the ULN-2350C and ULN-2351C may be paralleled for totals of up to 800 pF and 400 pF , respectively.

In addition to the standard complement of NPN and lateral PNP transistors, vertical PNP transistors were built into the arrays to take advantage of their characteristically high current gain, which can be two to three times greater than that of standard lateral PNP transistors.

Figure 1 shows an example of the utilization of a vertical PNP in a current mirror to decrease the error introduced by base current from $20 \%$ to less than $1 \%$.


Figure 1

Figure 2 shows application of vertical PNP in a differential amplifier to decrease base drive current requirements.

$I_{B}=\frac{I_{C 2}}{B_{1} \beta_{2}}$
Figure 2

As an aid in designing voltage regulators, emitterisolation Zener diodes with a nominal breakdown voltage
of 5.8 V are incorporated in the arrays. They are particularly useful with low supply voltage circuits.

## APPLICATION

Figure 3 depicts a hypothetical automotive application of a low-voltage integrated circuit that turns on an indicator if the ignition is turned on and the alternator voltage is below some predetermined value.


Figure 3

External components protect this circuit from damage by transient voltages encountered in the automotive environment.

AUTOMOTIVE TRANSIENTS

| SOURCE | SOURCE IMPEDANCE | AMPLITUDE | DURATION |
| :---: | :---: | :---: | :---: |
| Air- |  |  |  |
| Conditionina |  |  |  |
| Compressor/ |  |  |  |
| Clutch |  |  |  |
| Coil | $250 \Omega$ | $\pm 250 \mathrm{~V}$ | $1.0 \mu \mathrm{~s}$ |
| Service |  |  |  |
| Motors | $60 \Omega$ | $\pm 32 \mathrm{~V}$ | $40 \mu \mathrm{~s}$ |
| Anti- |  |  |  |
| Dieseling |  |  |  |
| Solenoid | $200 \Omega$ | $\pm 450 \mathrm{~V}$ | $22 \mu \mathrm{~s}$ |
| Alternator |  |  |  |
| Load |  |  |  |
| Disconnect |  |  |  |
| "Load Dump" | $0.1 \Omega$ | 80 V | 200 ms |

To protect the supply pin, a low-value resistor $\left(R_{1}=500 \Omega\right.$ to $1 \mathrm{k} \Omega$ ), and a large value capacitor $\left(C_{1}=1 \mu F\right.$ to 500 $\mu F)$ are used to supress the
transients. The power tran sistor driving $R_{L}$ is normally protected with a Zener diode. Pins 4 and 5 are protected from transients by current-limiting resistors $\mathrm{R}_{4}$ and $\mathrm{R}_{5}$. In addition, the sense input, pin 4, requires a capacitor, $\mathrm{C}_{4}$, to form a low-pass filter to ensure rejection of noise pulses.


Figure 4

Figure 4 shows the highvoltage array performing the same function; all external protection components have been eliminated.

The actual circuit, shown in Figure 5 , demonstrates the design's self-protective properties.

Resistors $\mathrm{R}_{1}-\mathrm{R}_{6}$ limit the current through transistors $Q_{1}-Q_{5}$ during a transient. This protection cannot be achieved with diffused resistors because of their low breakdown voltage ratings.

The output driver Q7, Q8, with a $\mathrm{BV}_{\text {CES }}$ of greater than 80 volts, is capable of withstanding the load dump transient. Voltage transients of greater magnitude are usually accompanied by high source impedance that limits the current.

The load connected to pin 2 limits the current in the event of battery reversal.

Capacitor C1 supresses noise at pin 4 that could cause the lamp, such as $R_{L}$ of Figure 4, to turn on erroneously.

## CONCLUSION

Although an automotive application is presented above, the arrays' high-voltage capabilities can be used in other noisy environments and in interface circuits such as motor drivers and display drivers.


Figure 5

# CUSTOM BIPOLAR INTEGRATED CIRCUITS FOR AUTOMOTIVE APPLICATION 


#### Abstract

Here is a manager's overview of how to use bipolar integrated circuits (ICs) for a custom approach to an automotive system application. After selecting the IC technology and establishing the application specifications, the project will follow a basic development cycle. The schedule of events that take place is basic to all custom bipolar ICs for automotive applications. The cycle starts with selection of semiconductor supplier and ends with a reliable cost effective, custom bipolar IC in production several months later. Reaching a successful conclusion requires considerable positive interaction between systems manager and semiconductor supplier.


The first step is to determine that customizing a system is cost effective versus using standard "off-theshelf" components. In conjunction with this, the manager will determine the extent of system integration desired, the type of interconnect needed and, to a broad extent, the semiconductor packaging.

The reliability level that must be met should be established at the beginning of the program. The reliability specifications have a direct effect on the cost of a device. This must be taken into consideration at the very beginning of the design. The phrase "reliability is designed in -- not tested in" is as true in the semiconductor as the vehicle brake system.

From a system point of view, is there any advantage to having one "large" custom device, versus having two or more "building block" devices which could be used in other or future systems? The "building block" approach will usually cost more (on stand alone
basis) at the system level. Application in other systems has the added advantage of lower overall tooling costs, development times, and economics of higher run rates.

The manager needs to determine the amount of lead time his project has available. The development of a custom IC takes 7 to 9 months, and another 3 months to achieve production buildup. This lead time alone may force the project to use available standard circuits.

Other questions which must be addressed are how many sources will be required and, with this, what is the risk of the parts not being interchangeable? Interchangeability can be a problem, especially with custom circuits where differing semiconductor technologies provide substantially different performance characteristics. Linear circuits, even when the technologies are "identical", can behave entirely different in an application. It is highly desirable to stay with "identical" technologies for all

[^58]|  | CMOS | PMOS | BIMOS | BIPOLAR | BIPOLAR $1^{2}$ L |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power per Gate | $1 \mathrm{uW}-10 \mathrm{~mW}$ | $200 \mathrm{uW}-10 \mathrm{~mW}$ | $1 u W-10 \mathrm{~mW}$ | $2.5 \mathrm{uW}-10 \mathrm{~mW}$ | $0.5 \mathrm{uW}-2.5 \mathrm{~mW}$ |
| Output Drive | 5 mA | 10 mA | 1 A | $1 A-4 A$ | $1 \mathrm{~A}-4 \mathrm{~A}$ |
| Timing Accuracy | Fair | Poor | Fair | Excellent | Excellent |
| DC Noise Immunity | Excellent | Fair-Good | Excellent | * | * |
| Device Diversity | Fair | Poor | Excellent | Excellent | Excellent |
| Supply (Max. Typ) | 20V | 30 V | Logic 15 V Output 85 V | $35 \mathrm{~V}-100 \mathrm{~V}$ | Logic 10 V Output 85 V |
| Logic Density | Med-High | High | Medium | Medium | High |
| Process Complexity | 6 Masks | 4 Masks | 11-12 Masks | 6-8 Masks | 6-7 Masks |

Figure 1
TECHNOLOGY COMPARISONS FOR AUTOMOTIVE ELECTRONIC SYSTEMS
suppliers of a given circuit. Almost all suppliers have their own process variation within a given technology so the term "identical" must be used with caution. Concentrate on defining the system's elec trical, environmental, and mechanical Iimits, and establish a broad specification to achieve this end.

Once the decision has been made to customize, the next problem is getting the desired function within an acceptable schedule. At this stage the systems manager loses some control over the program's success, since there is a "new member" in the design and development team - the semiconductor supplier. The supplier can be another department or division within a vertically integrated company, however, most of the time this will be an "outside" supplier.

The larger or older semiconductor companies doing custom work will have several semiconductor technologies in production; the medium sized companies,
two or more; and the smaller suppliers generally concentrate on one technology. Today there are two popular technologies available (each having wide variations) - MOS and bipolar. MOS is suited for digital only applications (see Fig. 1), and bipolar for digital or analog (linear) amplification, $I^{2}$ L (analog/ digital) and power handifing capability. MOS usually requires external (to the package) buffers and drivers. Bipolar devices normally interface directly with lamps, solenoids, motors, relays etc., and will have the drivers "on chip" requiring fewer external components. An alternate choice for certain applications is BiMOS which is the combination of MOS and bipolar on the same chip.

The biggest feature of MOS is its ability to perform many functions using a very small device. One of the main advantages to using a bipolar technology (without sacrificing performance) is its power
handling capability and high voltage tolerance. In reality, future vehicles will probably have both technologies on board since most microprocessors under consideration use a MOS technology with the interfaces to the microprocessor being bipolar.

Circuits can be designed to handle all present transient conditions, load dump, reverse battery, etc. However, most "off-the-shelf" standard ICs were not designed to handle these conditions, and require added discrete (diode and resistor) protection. Fortunately there are bipolar circuits, designed specifically for automotive use, that have the required "bullet proof process". These devices have established a bench mark from which future design and reliability levels can be accurately predicted.

Ideally a new project will be one of a series of previous custom circuits with the selected supplier(s). If the custom project is the first, then it will be necessary to seek out and establish a positive working relationship with a supplier(s) having the required expertise. The emphasis is on a positive relationship - for the semiconductor supplier is, as mentioned previously, a member of the design team.The success of the project is directly related to the relationship of the two organizations. Each team member knows their own disciplines best, and when brought together always require tradeoffs and compromise in order to get the best possible circuit design at the lowest possible cost. System cost effectiveness will be determined by the producibility of the IC, long term reliability, and system design. The unit cost for any custom IC
can, at best, only be estimated at the beginning of a project. This cost is based on the system requirements specified at the start of the project. Tightening of limits, addition (or deletion) of functions, and changes in electrical or mechanical specifications will have a very direct bearing on unit cost. The entire design team (systems manager and semiconductor supplier) must try to make all system trade-offs during the system design phase, and minimize any changes to the IC once started. If changes must be made, they should be during the IC design phase, for once beyond this there is a heavy penalty to schedule (and cost). This will be discussed to a greater extent later.

If the systems manager has selected an IC supplier from previous projects, then some of the unknowns will be eliminated. Also, previous program successes will give a guide as to how long the project realistically will take. In any event, several key steps will take place in the


Figure 2
TYPICAL BIPOLAR IC DEVELOPMENT CYCLE
development of the custom bipolar IC, each with its own cycle and problems.

CUSTOM BIPOLAR IC DEVELOPMENT (See Fig. 2)

All of the following development steps would apply to MOS technology with variations only in device characteristics.

1. Selection of Semiconductor Supplier
will be performed on many variables, and is beyond the scope of this paper. However, previous comments on working relationship and supplier expertise in automotive circuits should be key elements in the selection process. Some other points that need to be determined of any potential supplier:

## a. Stability - Financial and Workforce

b. Volume Capability - for Present and Anticipated Quantities
c. Basic Packaging Capability IC, Module, etc.
d. Test Capability - IC Module, etc.
A full and complete review of system, electrical and mechanical specifications along with quality requirements should be performed by both parties before contract finalization.

An IC supplier unfamiliar with automotive requirements may unknowingly accept a contract that has "hidden" costs which could result in the development of an unprofitable part. The prudent systems manager will make certain the IC supplier fully understands the system and contract requirements.
3. Circuit Design will ultimately determine the performance of the IC, the cost and long-term reliability. It is during this phase of the development that the greatest interaction should take place. When this stage is reached, the system (custom IC) specification should be "frozen". Once the IC design is finalized and committed to "lay-out" (step 6) only minor changes can be made without impacting the entire schedule and cost.

Trade-offs may be required in the system due to findings during the IC design. They will be verified during the simulation or breadboard phase. Most automotive electronic systems can be "breadboarded" (step 4) with discrete semiconductors ("kit parts" from the bipolar process to be used on final circuits). If major trade-offs are required they must be made here.

The systems manager could breadboard his own IC with the same discretes (supplied by supplier to do final design analysis - do not use another supplier's breadboard components as the process can be different). This breadboarding can be very useful during system definition and development. The systems manager can optimize the system prior to committing the project. Here again is an example of having a positive working relationship with the selected supplier(s), as these components are not commercially available. A review of the IC design should be made at this point, and any system of IC modification implemented.
4. Breadboard layout is actually performed during, and in conjunction with the IC design (step 3). Some suppliers may use computer simulation from component models in conjunction with CAD (Computer Aided Design). If the CAD method is used, it is more difficult for the systems manager to review the customized design. The cell (component models) library is useful only when using the same CAD. In addition, (unlike some MOS technologies) the cells will be designed for the supplier's bipolar process, and therefore possibly proprietary to the semiconductor supplier.

A good breadboard is a very powerful tool and has often brought out unknown system problems during circuit design evaluation.
5. Design Review is the last convenient point in the design process to make modifications. At this step the design is reviewed in detail. The performance of the circuit is compared, via the breadboard, to the design objectives. The systems manager should make it a point to attend this session.

The circuit designer will have selected a particular bipolar process to best meet the system requirement. The interface (input or output) component from transients, accidental grounding, load dump, etc. Because of these requirements the designer will configure the component layout to handle these conditions. Few standard bipolar parts can meet all of these conditions, and will require external discrete protective circuitry.

Therefore, the systems manager, should determine the semiconductor suppliers' capabilities in this area during supplier selection. The inherent reliability of the system is improved with the fewest possible discrete components per system.

Most standard "off-theshelf" ICs have breakdown voltages in the 20V DC range, while a bullet-proof automotive IC should be at least 50 V DC. Note that this applies to the interface components within the IC. The signal processing section of the IC need not have high breakdown capability. This allows the most efficient use of area on the layout as highvoltage breakdown components and output drivers tend to be very large in comparison.

Design reviews are normally attended by engineers from all key facets of the semiconductor operation; production, mask making, wafer processing, packaging, test, reliability, etc. The design engineer(s) responsible for the custom IC(s) present the design to a critical review by all of these departments. Each of these departments must agree that the design is sound, does not violate any rules, and is manufacturable. At this point the designer will commit the custom design to layout.
6. Circuit Layout can be performed by either hand drafting or through the use of computer aided design. The use of either method generates "artwork" (every designer considers his work a masterpiece), which is a composite drawing of each "mask level". The layout artwork will be drawn
at several hundred times (typically 254 x or 508x) the final IC's size. The actual magnification is dependent on the "die" size (once produced, the unpackaged individual circuit is referred to as a die or chip) or capability of photo reduction equipment. The CAD circuit layout method closely parallels the manual method but is usually completed faster.

In order to efficiently use CAD there first must be a library of devices (transistors, diodes, etc.) compatible with the bullet-proof process. This library can have standard "cells" of differing functions such as; drivers, gates, flip flops, etc. These will be used, as needed, by the CAD operator to integrate the required function. A CAD circuit design is better suited for digital than linear, especially where both are part of the circuit.

Caution: If a cell library is not already established, it must be created and this is very time consuming. If done properly, the cells will have been life tested (usually in IC form), and will have been interconnected previously to make certain that they are compatible. If the cells do not already exist, use the more familiar hand layout method. If used properly, CAD can be a very powerful tool, or a very expensive draftsperson.
7. Layout Review is attended by basically the same group as Design Review. At this juncture the layout is subjected to a careful examination of layout rules, component placement, test points (for wafer probe and evaluation prior to packaging) and conformity to the circuit design.

The application of ICs to the automotive electrical system dictates special test requirements. Therefore, special wafer and package test requirements will be "finalized" at this point. This will mean building and fixturing the specialized interface hardware for the automatic testers. Since most of the general IC testers do not have high-voltage capability, special interface boxes must be created to do the required tests. This can cause incoming inspection problems for systems managers, as it is highly unlikely that the test systems will be exactly the same. For this reason the special interface boxes created by the IC supplier will not be usable by the systems manager. Therefore, it is vital that there be a "good" specification established so that differing test equipments will be able to do the same tests and obtain correlatable results.
8. Mask Making is performed next through one of several methods. If a CAD system was used, then the mask levels will be generated directly or by cutting Rubylith. (Bame as doing a printed circuit board), which will be peeled by hand. These systems are fast, compared to hand cutting, but are not always available to the designer (especially. if the CAD was not used). A common approach is to use a digitizer, with hand-drawn artwork, which normally feeds an $X-Y$ plotter that cuts the Rubylith. The Rubylith is then peeled by hand. In addition, the digitized artwork can be fed to a "reticle" generator which eliminates the Rubylith and required photo-reduction steps. A reticle is the mask (one level master
and is $10 x$ the finished die size). The reticle will be "step-and-repeated" on the final working "plates" for the individual wafer masking steps.
9. Pilot Wafer Run will be made following the mask-making operation. The systems manager should follow this run with tempered enthusiasm.

The first run is actually a circuit "debug" step. For when it is checked out there are usually changes or error corrections to be made in the circuit, masks, and/or process. Therefore a second wafer run will be made following any changes. This second run is very important, since it will provide working parts for both the systems manager and semiconductor partner. The supplier will get the first "hard" yield information against the target specification. Up to this point the supplier has used experience to project yields which determine cost (this will be covered in later sections).

The final pilot run will be packaged, usually on an engineering assembly line, and submitted to initial electrical evaluation. Depending on the relationship between the partners, advance parts may be obtained by the systems manager. The semiconductor supplier will want to perform a complete device (IC) evaluation, and will be reluctant to provide parts until the evaluation and characterization is complete.
10. Device Characterization will be performed to ensure the custom bipolar IC meets the initial target specification. Depending on the circuit complexity, the characterization
can be very time consuming. However, it is essential to both the systems manager and semiconductor partner for slightly different reasons.

The semiconductor manufacturer is looking to make certain the custom IC meets the target specification, or to what extent it does not meet the specification. In the first case, the overall yeild can be projected with a much higher degree of accuracy. In the second case (some parameter is out of specification) corrective action is required. This may entail a simple mask or process change, or a major redesign. However, before this is initiated the partners should get together to determine if the part will work satisfactorily within the system. If it will meet system objectives, the specifications may be relaxed (step 11), then it's possible to derive the needed yield information.

The systems manager is concerned with the custom IC's performance within the system. Therefore it is essential that the custom IC be evaluated within the system during the system characterization. Differences may appear between the breadboard's operation and the "equivalent" IC due to capacitance, layout, and discrete versus integrated components (parasitics). If a careful system evaluation and design was performed at the start of the program, few surprises will develop.

Following system and IC charactertization it is essential to review and finalize any differences in specifications and parametrics. Remember that this is a partnership with a
common objective of selling systems, so approach the next phase with compromise in mind.
11. Specification Review takes place following successful pilot run(s) and product characterization. It is very important that the systems manager approach this as an opportunity to improve performance, manufacturability, reliability, and yield. As with any system the ultimate in performance and cost is a result of a series of tradeoffs. This stage in the system's development is no different.

The IC characterization provided a baseline with respect to the parametric distribution. Hopefully the IC comes into the center of the specification limits so that $100 \%$ of the product will be usable. In reality this seldom happens. There are so many variables in process that any given lot of parts will have a slightly different distribution. This results in throwing away product that does not meet the desired specification (yield loss), and shipping that which meets the limits (shippable yield).

At the beginning of the program the systems manager selected a partner who projected a satisfactory unit based on a specification and anticipated shippable yields. A product was developed and resulted in an IC that has a certain character. The semiconductor manufacturer will be able to make recommendations, based on the characterization data, for ways to improve performance and yield. Every percentage point of yield loss affects shipments and cost. Therefore, it is definitely to the systems manager's benefit to work towards the highest practical shippable yield.

Every engineer uses guard bands. Realistic guard bands are prudent and necessary to take care of a product's manufacturing variation. However, every guard band affects yield and is reelected in unit and system cost.

It is not possible to give exact comparisons of the interrelationship of parameters to yield. However, it is to the systems manager's benefit to be flexible on "non-critical" parameters as the final IC will likely differ from the target specification following characterization. This happens because of the layout and interaction of active and passive components on the custom IC. It is not possible to predict with 100\% confidence the behavior of an integrated system versus the discrete version. This is where the systems manager must rely on the semiconductor partner's experience and recommendations.
12. Life Test is essential for any new IC to determine circuit integrity and establish failure rates, etc. Normal accelerated life test procedures are adequate for bipolar ICs. The testing should be run only on parts produced with production tooling and assembly lines. Test samples should come from the same assembly line as will be used for the volume production, and the parts should be as representative of future production as is possible. If a common failure analysis should be performed to determine cause. Corrective action will be determined following the analysis.

If a major change is made (as a result of the life test) to the mask set, the part should be put through a new operating life test. Changes in test
procedures or limits will not normally require a new life test. The systems manager must keep in mind that a normal life test is 1000 hours, and takes six weeks of oven time with two weeks on each end to take data. This time should be factored into the development schedule as a normal part of any custom program.

Historical data on the bipolar process used for the custom IC is very useful in predicting long-term failure rates. This also will provide guidance in supplier selection. An established supplier of automotive ICs will have a
history on similar devices which can be used to predict system life.
13. Release to Production of the custom IC can be achieved following, or even prior to completion (dotted area Fig. 2) of successful life testing. However, release prior to completion of life testing is very risky before 500 hours. once released, it will take about sixteen weeks to achieve full production. Since the production cycle is so long, the system manager should consider that any change to the IC may affect a considerable quantity of product. Therefore, such changes can be very costly.

1. Selection of Semiconductor Supplier
2. Contract Definition and Negotiation
3. Circuit Design
4. Breadboard
5. Design Review
6. Circuit Layout
7. Layout Review
8. Mask Making
9. Pilot Wafer Run
10. Device Characterization
11. Specification Review
12. Life Test
13. Release to Production

## SUMMARY

An overview of how to use a custom bipolar approach to a system requirement. The systems manager needs to determine when it is cost effective to either customize or use standard "off-the shelf" components. The manager needs to decide how much of the system to integrate.

Should it be in one package, or broken up into several packages? What lead time is available and when will the electrical, environmental, and mechanical specification limits have to be frozen? How many sources will be required, and what is
the risk that parts will not be interchangeable? The preceding is a partial list of questions that have to be answered for any tentative "custom" project. The answers will affect the choice of technology, device development time, system development time, etc., all of which affect cost and have a direct bearing on reliability and program success.

Once the decision has been made to go "custom" the next problem is getting the desired function, within an acceptable schedule. At this stage the systems manager loses some control over his program's success, because at this point of the program there is a "new" member in his design team - the semiconductor supplier.

Ideally the program will be one of a series of customizations, and will have had a positive relationship with one or more of the suppliers that have the required expertise. Previous program successes will give a guide as to how long the project will take. In any event, the following major steps will take place, each with its own cycle and problems:

## CONCLUSION

As previously indicated, the semiconductor supplier should be considered as a member of the project team. As such it is highly desirable to work closely with him on an open and frank basis. Remember, the circuit is a result of the designer's interpretation of the specification's basic system needs.

Assuming the systems manager has chosen the correct supplier; defined and brought to production a system that the final customer will buy; overcome all the major and minor problems during the development period; the systems manager may find it cannot be made for the desired price (because of low yield) and in the required quantities. Therefore, temper enthusiasm for all the latest technologies. Determine at the outset which approach is the best - a custom IC or "discrete" off-the-shelf design, and be flexible on specifications that affect yields. The advertising department will be able to live with either, because after all; it is SOLID STATE ELECTRONICS!!

## CUSTOM CIRCUIT DESIGNS

Sprague is active in the design of standard and custom high-volume integrated circuits and subassemblies for both linear and digital applications. A wide range of semiconductor technologies is available to optimize cost and performance. Often, new processes or innovative circuit designs are involved.

Generally, the first concern of a designer of a custom device is one of cost, though performance, reliability, size, and process are also important considerations. Cost is determined by the following factors:

Production Volume: Unit cost is dependent on quantity. A minimum volume of $\$ 250,000$ per year is required after the initial design and development.

Chip Size: Unit cost is directly affected by chip size, which is related to circuit complexity, outputcurrent and output-voltage ratings.

Test Requirements: Logic, d-c, and static measurements are simple, fast, and inexpensive to perform, while linear measurements such as those for distortion, phase, and noise, may affect production rates and increase cost.

| Typical Custom Design Schedule |  |
| :--- | ---: |
|  | Time in Weeks |
| Task | - |
| Define Specifications | 2 to 20 |
| Circuit Design | 4 to 12 |
| Breadboard Construction and Analysis | 4 to 12 |
| Circuit Layout and Maskmaking | 3 to 10 |
| Prototype Processing | 4 to 8 |
| Prototype Evaluation | 8 to 16 |
| Production Pilot Run | 12 to 20 |
| Production Volume |  |

Total 37 to 98 weeks at an engineering cost of between $\$ 20,000$ and $\$ 100,000$, not including special test hardware or assembly tooling.

## Application Areas of Sprague Expertise

Interface-Display drivers, motor/relay/solenoid drivers, Hall cells, opto-sensors
Computer-Peripheral power interface to 200 V or 5 A , video display drivers, SMPS
Radio-A-M, F-M, F-M stereo, communications, A-M stereo
Audio- 250 mW to 20 W , mono and stereo
Control-Timers, Hall cells, opto-sensors, switching regulators, motor drivers, PWM

Package: Plastic packages are the least expensive. Cer-DIP packages are less expensive than sidebrazed hermetic packages, which are the most costly. Cost also increases with pin count.

Specifications: Well-defined specifications can expedite circuit design. Excessive or arbitrarily tight specifications will reduce yields and increase cost.

Integrated Component Capability
fransistors: NPN - Beta to $300, \mathrm{BV}_{\text {ces }}$ to $200 \mathrm{~V}, \mathrm{f}_{\mathrm{T}}$ to 500 MHz
PNP-Beta to $60, \mathrm{BV}_{\text {CES }}$ to $150 \mathrm{~V}, \mathrm{f}_{\mathrm{T}}$ to 5 MHz
CMOS - $V_{T H} 0.8$ to $2.5 \mathrm{~V}, \mathrm{BV}_{D S}$ to 18 V
Resistors: Diffused $-5 \Omega / \square$, to $100 \Omega$, to 100 V
$175 \Omega / \square$, to $100 \mathrm{k} \Omega$, to 100 V
Ion Implant- $1 \mathrm{k} \Omega / \square$ to $4 \mathrm{k} \Omega / \square$, to $1 \mathrm{M} \Omega, 20 \mathrm{~V}$
Thin Film $-2 \mathrm{k} \Omega / \square$, to $2 \mathrm{M} \Omega, 250 \mathrm{~V}$
Aluminum- $0.025 \Omega / \square$, to $1.0 \Omega, 150 \mathrm{~V}$
Capacitors: Junction- $0.1 \mathrm{pF} / \mathrm{mil}^{2}$, to $30 \mathrm{pF}, 100 \mathrm{~V}$
$0.3 \mathrm{pF} / \mathrm{mil}^{2}$, to $100 \mathrm{pF}, 12 \mathrm{~V}$
$0.9 \mathrm{pF} / \mathrm{mil}^{2}$, to $300 \mathrm{pF}, 6 \mathrm{~V}$
MOS- $0.1 \mathrm{pF} / \mathrm{mil}^{2}$, to $30 \mathrm{pF}, 50 \mathrm{~V}$
$0.2 \mathrm{pF} / \mathrm{mil}^{2}$, to $50 \mathrm{pF}, 20 \mathrm{~V}$
Diodes: $\quad$ Zener- 5.7 or $7.0 \mathrm{~V}, \pm 0.3 \mathrm{~V}$
Photo- 0.5 AW or $>300 \mathrm{nA} / \mathrm{fc}$ at 800 nm
Schottky- 0.1 to 0.4 V at $1 \mu \mathrm{~A}, 0.3$ to 0.6 V at 1 mA
Small Signal—BV $=7.0 \mathrm{~V}$
Other: $\quad$ SCRs-to 1 A , to 60 V
PUTs - to 1 A , to 60 V
12 _-Propogation delay typically 100 ns
BiMOS-High-power bipolar plus low-power MOS
Hall Ceills- $35 \mathrm{mV} / \mathrm{kG}$

Military-Communications, fuze, interface
Camera-Light integrators, timers, controls
Telecommunications-SLIC, electronic telephones, wireless telephones
Automotive-Controls, monitoring, safety, radio
Transistor Arrays-Small-signal, high-current, SCR, control
General-Sound generators and amplifiers, timers, controls

## OPTIONAL PACKAGE CAPABILITIES



Standard integrated circuits from Sprague Electric Company are most often furnished in packages meeting industry or military standards (JEDEC TO-87, TO-91, TO-99, TO-100, or TO-116, or MIL-M-38510). However, on special order, other packages or assemblies of packaged devices can also be supplied. A few special order devices are illustrated above, including special heat sink tabs, subminiature plastic packages, printed wiring boards, flexible circuits, and complex assemblies. Devices with photodiodes are furnished in clear plastic cases.

## GENERAL INFORMATION

## HIGH-CURRENT INTERFACE DRIVERS

## BiMOS AND COMPLEX ARRAY INTERFACE DRIVERS

## MILITARY AND AEROSPACE DEVICES

## RADIO/COMMUNICATIONS INTEGRATED CIRCUITS

## VIDEO AND TELEVISION INTEGRATED CIRCUITS

## AUDIO POWER AMPLIFIERS

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## PACKAGE INFORMATION

## Package Thermal Characteristics

| Package Designator | Package Type | Frame <br> Material | $\begin{aligned} & R \Theta_{11} \dagger \\ & \left({ }^{\circ} \mathrm{C} /{ }^{2}\right) \end{aligned}$ | $\begin{aligned} & R \Theta_{\mathrm{c}} \dagger \\ & \left({ }^{\circ} \mathrm{C} / \mathrm{N}^{2}\right) \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: |
| A | 14-Lead Plastic DIP | Copper | 60 | 38 |
| A | 16-Lead Plastic DIP | Copper | 60 | 38 |
| A | 18-Lead Plastic DIP | Copper | 55 | 25 |
| A | 20-Lead Plastic DIP | Copper | 55 | 25 |
| A | 22-Lead Plastic DIP | Copper | 50 | 21 |
| A | 28-Lead Plastic DIP | Copper | 40 | 16 |
| B | 8 -Lead Semi-Tab Plastic DIP | Copper | 75 | 13* |
| B | 14-Lead Semi-Tab Plastic DIP | Copper | 45 | 13* |
| B | 16-Lead Semi-Tab Plastic DIP | Copper | 45 | 13* |
| D | 3-Lead Transistor | Kovar | 300 | 150 |
| H | 8 -Lead Hermetic DIP | Kovar | 120 | 40 |
| , | 14-Lead Hermetic DIP | Kovar | 90 | 20 |
| H | 16-Lead Hermetic DIP | Kovar | 90 | 20 |
| H | 18-Lead Hermetic DIP | Kovar | 75 | 20 |
| J | 14-Lead Flat Pack | Kovar | 140 | 80 |
| M | 8-Lead Mini DIP | Copper | 80 | 55 |
| Q | 16-Lead Quad In-Line | Copper | 45 | 13* |
| R | 14-Lead CerDIP | Kovar | 75 | - |
| R | 16-Lead CerDIP | Kovar | 75 | - |
| R | 18-Lead CerDIP | Kovar | 65 | - |
| W | 12-Lead Power Tab SIP | Copper | 24 | 3.0* |
| Y | 3-Lead Transistor | Copper | 310 | 170 |
| Z | 5-Lead Power Tab SIP | Copper | 40 | 4.5* |

The data given is intended as a general reference only and is based on certain simplifications such as constant chip size, standard bonding methods, and an allowable $+150^{\circ} \mathrm{C}$ junction temperature. Where differences exist, the detail specification takes precedence.
$\dagger G \Theta_{\mathrm{A}}=1 / R \Theta_{\mathrm{JA}}$ and $\mathrm{G} \Theta_{\mathrm{IC}}=1 / R \Theta_{\mathrm{Jc}}$
${ }^{*} R \Theta_{\pi}$

## THERMAL DESIGN FOR PLASTIC INTEGRATED CIRCUITS

PROPER THERMAL DESIGN is essential for reliable operation of many electronic circuits. Under severe thermal stress, leakage currents increase, materials decompose, and components drift in value or fail. Present-day linear integrated circuits are capable of delivering 5 to 10 watts of continuous power. Previously, such power levels came only with discrete metal can power transistors. It was relatively easy to determine the thermal resistance of these devices and attach a massive heat sink. However, in many markets, economic factors now dictate the use of molded dual in-line plastic packaged monolithic circuits. The guidelines to be discussed will provide the circuit design engineer with information on maintaining junction temperature below a safe limit under worst case conditions.

## Design Considerations

Four factors must be considered before the required heat-sinking can be determined. These are:

1. Maximum ambient temperature
2. Maximum allowable chip temperature
3. Junction-to-ambient thermal resistance
4. Continuous chip power dissipation

Maximum ambient temperature for the integrated circuit is normally between $+70^{\circ} \mathrm{C}$ and $+85^{\circ} \mathrm{C}$ and is usually dependent on the case material. In most applications, however, the limiting factor is the associated discrete components and a limit of about
$+50^{\circ} \mathrm{C}$ is specified. The maximum allowable chip temperature is usually $+150^{\circ} \mathrm{C}$ for silicon.

Thermal resistance is the all-important design factor. It is composed of several individual elements, some of which are determined by the integrated circuits manufacturer, and some by the user.

## Chip Power Dissipation

The chip power dissipation should be obtainable from the manufacturer's specifications. In most applications it is a variable and determined by the user when he specifies the circuit variables.

A typical example is a dual 2-watt audio power amplifier. Power dissipation is determined by the load impedance, the required peak output power, the acceptable amount of total harmonic distortion (THD), and the supply voltage ( $\mathrm{V}_{\mathrm{CC}}$ ). This is illustrated in Figures 1-3. Note that for a given supply voltage, the chip dissipation may be greatest at some point below the peak output power rating and must be considered.

As shown in the figures, a peak output power of 2 watts per channel with $3 \%$ maximum THD would mean a chip power dissipation of about 2.7 W and a $\mathrm{V}_{\mathrm{CC}}$ of 15 V with a load impedance of $4 \Omega$, or 1.8 W and 15 V at $8 \Omega$, or 1.4 W and 19 V at $16 \Omega$. In general, the highest load impedance for a given output power is the most desirable (within the output voltage capability of the device).

## PACKAGE INFORMATION (Continued)



Figure 1


Figure 2


Figure 3

## Heat Dissipation

In any circuit involving power, a major design objective is to reduce the temperature of the components in order to improve reliability, reduce cost, or improve operation. The logical place to start is with the heat-producing component itself. First, keep the amount of heat generated to a minimum. Second, get rid of the heat that must be generated.

Heat generation can be minimized through proper circuit design. Heat dissipation is a function of thermal resistance.
With the typical discrete component, heat dissipation can be accomplished by fastening it directly to the chassis. Dual in-line plastic packaged integrated circuits, however, are quite a bit different. Their shape is not conducive to fastening directly to the chassis, they are normally installed in a plastic socket or on a printed wiring board, and the heat producing chip is not readily accessible.

Some users specify unusual packages so as to get the heat sink as close as possible to the chip and /or provide an attachment point for an external heat sink. A common factor in many of these special designs is that the lead frame is an integral part of the heat sink.
Since the plastic package may have a thermal resistance of between 50 and $100^{\circ} \mathrm{C} / \mathrm{W}$ and the lead frame a thermal resistance of only 10 to $20^{\circ} \mathrm{C} / \mathrm{W}$, this would seem like the best route to go.

## Standard Packages

The most common lead frame material has been Kovar (an iron-nickel-cobalt alloy). Its coefficient of expansion is close to that of silicon thereby minimizing mechanical stresses. However, Kovar has a relatively high thermal resistance and consequently is not suitable for standard lead frames in high power dissipation circuits. For these applications, copper or copper-alloy lead frames should be used. Additionally, some type of added heat sinking may be necessary. Thus lead frame configurations are
being altered from the standard 14 -pin or 16 -pin designs.
Rapidly becoming an industry standard is the "bat-wing" package. This package is the same size as a 14 -pin dual in-line package, but the center portion of the frame is left as tabs, measuring about $11^{\prime \prime}$ square. These tabs can be soldered, welded, or bolted to a heat sink, or inserted directly into some sockets. The worst case thermal resistance of various lead frames $\left(\Theta_{\mathrm{Jc}}\right)$ is given below.

| Lead Frame | Thermal Resistance |
| :---: | :---: |
| 14 -pin Kovar | $47^{\circ} \mathrm{C} / \mathrm{W}$ |
| 14 -pin copper | $19^{\circ} / \mathrm{W}$ |
| "Bat-wing" | $11^{\circ} \mathrm{C} / \mathrm{W}$ |

## Which Heat Sink?

If the integrated circuit manufacturer has done his job well, the chip-to-ambient thermal resistance will be minimized for maximum chip power dissipation. It would appear that even the Kovar lead frame would be adequate for most applications. However, the total thermal resistance ( $\Theta_{\mathrm{IA}}$ ) is also dependent on a stagnant layer of air at the lead frame-ambient interface which will support a temperature gradient. The total thermal resistance of a non-heat sinked dual in-line plastic package is therefore much higher. Since air is a natural thermal insulator, maximum heat transfer is through convection and the total thermal resistance will decrease some at high power levels.
$\left.\begin{array}{lcc}\hline & \begin{array}{c}\text { Total } \\ \text { Thermal } \\ \text { Resistance }\end{array} & \text { Max. Power Diss. (W) } \\ \text { Le } 50^{\circ} \mathrm{C} \mathrm{T} \mathrm{T}_{\mathrm{A}}, 150^{\circ} \mathrm{C} \mathrm{T}\end{array}\right]$

Ignoring any safety margin and device performance, even the "bat-wing" is now only barely adequate for most applications. The obvious solution is the use of an external heat sink.

Referring to Figures 4 and 5, the thermal resistance requirement of the heat sink is found at the junction of the specified chip power dissipation and maximum ambient temperature. These curves are typical of those furnished in many monolithic integrated circuit data sheets. Actual performance in a specific situation depends on factors such as the proximity of objects interfering with air flow, heat radiated or convected from other components, atmospheric pressure, and humidity. A good safety factor is therefore in order.


Figure 4


Figure 5

Heat sinks for plastic dual in-line packages can be of almost unlimited variety in design, material, and finish. Economics will normally play a very important role in the selection of any heat sink.

The least expensive and easiest to fabricate heat sink is the plain copper sheet. It is also very effective in reducing the total thermal resistance. The necessary dimensions can be obtained from Figure 6. These heat sinks are square in geometry, 0.015 inches thick, mounted vertically on each side of the lead frame, and with a dull or painted surface (Figure 7). The heat sinks should be soldered directly to the lead frame (approximately $0.3^{\circ} \mathrm{C} / \mathrm{W}$ interface thermal resistance).

The plain copper sheet heat sink is also available commercially and may be less expensive than inhouse manufacture. Two standard types are the Staver V7 and V8.


Figure 6


Figure 7

## Heat Sink Finishes

Although plain copper is an effective heat sink, it is sometimes desirable to have something that is more appealing to the eye. For this reason, and others, many heat sinks are either painted or anodized.

The most common finish is probably black anodizing. It is economical and offers a good appearance. The black finish will also increase the performance of the heat sink, due to radiation, by as much as $25 \%$. However, since anodizing is an electrical and thermal insulator, the heat sink should have an area free of anodize where the heat-generating device is attached.

Other popular finishes for heat sinks are irridite and chromic acid dips. They are economical and have negligible thermal and electrical resistances. These finishes, however, do not enjoy the $25 \%$ increase in performance that a dull black finish has.

## Forced Air Cooling

The performance of many heat sinks can be increased by as much as $100 \%$ by forcing air over the fins. Where space is a problem, the cost of a small fan can often be justified. If a fan is required for other purposes, it is advantageous to place the semiconductor heat source in the air flow. A rule-of-thumb is that semiconductor failure rate is halved for each $10^{\circ} \mathrm{C}$ reduction in junction operating temperature.

## Chip Design

Proper thermal design by the integrated circuit user can reduce the operating temperature of the semiconductor junction. However, the minimum chip temperature at any power level is determined solely by the device manufacturer. For this reason, care must be taken in choosing the manufacturer. 'Exact equivalent'" integrated circuits are not necessarily identical. Electrically and mechanically they may be the same, but thermal differences can mean that "identical", audio power amplifiers will not put out the same power without exceeding the rated junction temperature.

The circuit manufacturer must optimize his chip design so that component drift is minimized and /or equalized so that rated performance can actually be obtained under maximum thermal stress.

Note in Figures 8 and 9 that the Darlington input differential pairs are cross-connected so as to minimize differences in gain as a function of output transistor power dissipation. Transistor $Q_{4}$, being closest to the output power transistors, is naturally the hottest; $\mathrm{Q}_{3}$ is a degree or two cooler; $\mathrm{Q}_{1}$ and $\mathrm{Q}_{2}$ are about equal and midway between $Q_{3}$ and $Q_{4}$. The gain of the $Q_{1}-Q_{2}$ Darlington pair is about equal to the gain of $\mathrm{Q}_{3}-\mathrm{Q}_{4}$ at all output power levels because of careful thermal design.


Figure 8


Figure 9

In certain specialized applications, thermal coupling can be used to a distinct advantage. Experimentally, thermal coupling has been used to provide a low-pass feedback network which otherwise could be obtained only with very large values of capacitance.

The foregoing discussion has covered the average thermal characteristics of today's dual in-line plastic integrated circuits. The specific devices will vary with the different packages and bonding techniques employed, but the concepts will remain the same.

## APPENDIX

The following is intended to review terminology and compare thermal circuits with the more familiar electrical quantities.

The first law of thermodynamics states that energy cannot be created or destroyed but can be converted from one form to another. The second law of thermodynamics states that energy transfer will occur only in the direction of lower energy. In the semiconductor junction, the electrical energy is converted to thermal energy. Since no heat will be stored at the junction, the heat will flow to a lower temperature medium, air. The rate of heat flow is dependent on the resistance to that flow and the temperature difference between the source and the sink.


Figure 10

This thermal electrical analogy is convenient only for conduction problems where heat flow and temperature obey linear equations. The analogy becomes much more complex for situations involving heat flow by convection and radiation. Where these two modes are not negligible, they can be approximated by an equivalent thermal resistance. If ignored, the error introduced will only improve the device reliability.

A simplified thermal flow diagram of a molded dual in-line package and heat sink is shown. The
thermal resistance of the lead frame-heat sinkambient is shown as a variable resistor, because this is under the control of the user and may be varied over a considerable range.


Figure 11

| Material | Thermal Resistance in ${ }^{\circ} \mathrm{C} / \mathrm{W}$ <br> for Unit Area/Unit Length |
| :--- | :---: |
| Silver | 0.09 |
| Copper, Annealed | 0.10 |
| Gold | 0.12 |
| Beryllia Ceramic | 0.20 |
| Aluminum | 0.20 |
| Brass (66 Cu, 34 Zn) | 0.40 |
| Silicon | 0.50 |
| Germanium | 0.70 |
| Steel, SAE 1045 | 0.80 |
| Solder (60 Sn, 40 Pb) | 1.5 |
| Alumina Ceramic | 2.0 |
| Kovar (54 Fe, $29 \mathrm{Ni}, 17 \mathrm{Co}$ ) | 3.0 |
| Glass | 40 |
| Epoxy | 40 |
| Mica | 50 |
| Teflon PTFE | 200 |
| Air | 2000 |

## Computing IC Temperature Rise

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EXCESSIVE heat shortens the life of an IC and reduces its operating capability. Until recently, ICs were capable of operating only in low-power applications requiring perhaps a few milliwatts of power. But now, new ICs handle several hundred milliamperes and drive devices such as relays, solenoids, stepping motors, and incandescent lamps. These high power levels may increase IC temperatures substantially and are capable of destroying devices unless appropriate precautions are taken.

## Thermal Characteristics

The thermal characteristics of any IC are determined by four parameters. Maximum allowable IC chip junction temperature $T_{J}$ and thermal resistance $R_{\theta}$ are specified by the IC manufacturer. Ambient temperature $T_{A}$ and the power dissipation $P_{D}$ are determined by the user. Equation 1 expresses the rela-

Heat is the enemy of integrated circuits-particularly power devices. Here's how to use thermal ratings to determine safe IC operation.

## Why IC Temperatures Rise

IC temperature $T_{J}$ is determined by ambient temperature $T_{A}$, heat dissipated $P_{D}$, and total thermal resistance $R_{\theta}$. This total thermal resistance is comprised of three individual component resistances: chip $R_{C}$, lead frame $R_{L}$, and heat sink $R_{s}$.

tion of these parameters.

$$
\begin{equation*}
T_{J}=T_{A}+P_{D} R_{\theta} \tag{1}
\end{equation*}
$$

Junction temperature $T_{J}$ usually is limited to $150^{\circ} \mathrm{C}$ for silicon ICs. Devices may operate momentarily at slightly higher temperatures, but device life expectancy decreases exponentially for extended hightemperature operation. Usually, the lower the junction operating temperature, the greater the anticipated life of the IC.

Ambient temperature $T_{A}$ is
traditionally limited either to $70^{\circ} \mathrm{C}$ or $85^{\circ} \mathrm{C}$ for plastic dual inline packages (DIPs) or $125^{\circ} \mathrm{C}$ for hermetic devices. Again, the objective is to operate at as low a junction temperature as practical.

Thermal resistance $R_{\theta}$ is the basic thermal characteristic for ICs. It is usually expressed in terms of ${ }^{\circ} \mathrm{C} / \mathrm{W}$ and represents the rise in junction temperature with a unit of power applied in still air. (The reciprocal of thermal resistance is thermal conductance, or derating factor,

## PACKAGE INFORMATION (Continued)

$G_{\theta}$ expressed as $\mathrm{W} /{ }^{\circ} \mathrm{C}$.) Thermal resistance of an IC consists of several distinct components, the sum of which is the specified thermal resistance. For a typical IC, these components of thermal resistance are $0.5^{\circ} \mathrm{C} / \mathrm{W}$ per unit thickness of the silicon chip, 0.1 to $3^{\circ} \mathrm{C} / \mathrm{W}$ per unit length of the lead frame, and up to $2,000^{\circ} \mathrm{C} / \mathrm{W}$ per unit thickness of still air surrounding the IC. DIPs are used more than any other type of packaging for ICs and newer copper-alloy lead frames provide a superior thermal rating over the standard iron-nickel-cobalt alloy (Kovar) lead frames. However, power ICs are also available in other packages such as flatpacks and TO-type cans.

The power $P_{D}$ that an IC can safely dissipate usually depends on the size of the IC chip and the type of packaging. Most common copper-frame DIPs can dissipate about 1.5 W , although some special-purpose types have ratings as high as 5 W .

Total IC power to be dissipated depends on input current, output current, voltage drop,

## Finding Safe Operating Limits

Here's how to calculate the safe operating limits for an IC, The first two examples are simple calculations involving maximum allowable power and are straightforward. The third and tourth examples are more complex and involve logic power, output power, and duty cycle.
Problem: Deternine the maximum allowable power dissipation that can be handled safely by a 16-1ead Kovar DIP with an R© of $125^{\circ} \mathrm{C}$ W in an ambient temperature of $70^{\circ} \mathrm{C}$.
Solution: From Equation 1, the maximum allowable power dissipation $P_{p}$ for thisic is

$$
\begin{aligned}
P_{D} & =\frac{150^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}}{125^{\circ} \mathrm{C} / \mathrm{W}} \\
& =0.64 \mathrm{~W}
\end{aligned}
$$

Problem: Determine the maximum allowable power dissipation that can be handed by a $14-10 a d$ copper DIP
with a derating factor $G 0$ of 16.67 $m W 0^{\circ} \mathrm{C}$ in an ambient of $70^{\circ} \mathrm{C}$. Solution: Since the derating factor $G_{0}$ is the reciprocal. of thermal resistance $R$ e, the maximum allowable power dissipation $P_{D}$ from Equation 11 is

$$
\begin{aligned}
\mathrm{B}_{D} & =\left(150^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}\right) \\
& \left.=1.33 \mathrm{~B} .67 \mathrm{~mW} l^{\circ} \mathrm{C}\right)
\end{aligned}
$$

Problom: Calculate the maximum junction temperature for a quad power driver with a thermal resistance of $60^{\circ} \mathrm{CN}$ in an ambiont of $70^{\circ} \mathrm{C}$ and which is controlling a 250 mA load on each of the four outputs.

Solution To detormine the
maximum (worat casol junction temperature for this IC; the maximum total power dissfipation must be determined from the datallsted on the 1C data sheot. The specifications are: usually isted as typical and minimum or maximum values. It is important to use maxinum voltage and current limits to insure an adequate design. Common maximum values for an
and duty cycle. Thus, for many industrial digital-control ICs, logic-gate power $P_{l}$ (typically less than 0.1 W ) and output power $P_{o}$ must be determined to find the total power to be dissipated. Total power dissipation for these logic devices is the sum
of $P_{l}$ and $P_{o}$.
$\mathbf{P}_{l}=\boldsymbol{n}\left(V_{C C} I_{C C}\right)$
$P_{o}=n\left(V_{C E(S A T)} I_{C}\right)$
where $V_{C C}=$ logic-gate supply voltage, $I_{C C}=$ logic-gate ON current, $V_{\text {CE(SAT) }}=$ output saturation voltage, $I_{C}=$ output

## Measuring IC Temperature

Sometimes IC junction temperature cannot be calculated readily and instead must be measured. Measurement should be made when there is insufficient data with which to calculate, when the effects of external variables such as forced-air cooling or enclosure size must be determined, or as a check on the manufacturer's specifications regarding package thermal resistance.

The most popular technique for measuring IC temperature uses the characteristic of a diode to reduce its forward voltage with temperature. Many IC chips have some sort of accessible diode-parasitic, input protection, base-emitter junction, or output clamp. With this technique, a "sense" diode is calibrated so that forward voltage is a direct indicator of diode junction temperature. Then, current is applied to some other component on the chip to simulate operating conditions and to produce a temperature rise. Since the thermal resistance of the silicon chip is low, the temperature of the sense diode is assumed to be the same as the rest of the monolithic chip.

The sense diode should be calibrated over at least the expected junction operating temperature chamber. Apply an accurately measured, low current of about 1 mA through the
sense diode and measure the forward voltage in $25^{\circ} \mathrm{C}$ increments after stabilization at each temperature. This calibration provides enough data for at least six points to construct a diode-forward-voltage versus junction-temperature graph at the specified forward current. A typical $25^{\circ} \mathrm{C}$ forward voltage is between 600 and 750 mV and decreases 1.6 to $2.0 \mathrm{mV} /{ }^{\circ} \mathrm{C}$.

For power levels above 2 W , it may be necessary to use more than a single transistor if only the device saturation voltage and sink current are used. When higher power is desired, keep the output out of saturation.

Measuring the sense-diode forward voltage may require a considerable waiting period ( 10 to 15 minutes) for thermal equilibrium. In any event, at the instant of measurement, the heating power may have to be disconnected since erroneous readings may result from IR drop in circuit common leads. Various circuit connections (such as four-point Kelvin) may be arranged to reduce or eliminate this source of error.

The IC junction temperature can be determined by comparing the voltage measurement with the internal power source against the voltage measurement with the temperature chamber.
industrial power driver are $V_{c c}=5.25 \mathrm{~V}$, $I_{C c}=25 \mathrm{~mA}$, and $V_{C E(S A T)}=0.7 \mathrm{~V}$, and $I_{c}=$ 250 mA . From Equations 2 and 3 , worst case logic and output power dissipation are

$$
\begin{aligned}
P_{l} & =4(5.25 \mathrm{~V} \times 25 \mathrm{~mA}) \\
& =525 \mathrm{~mW} \\
P_{o} & =4(0.7 \mathrm{~V} \times 250 \mathrm{~mA}) \\
& =700 \mathrm{~mW}
\end{aligned}
$$

Thus, the total worst case power dissipation $P_{D}$ is 525 mW plus 700 mW . or 1.225 W. From Equation 1, maximum junction temperature $T_{\text {, }}$ is

$$
\begin{aligned}
\boldsymbol{T}_{\boldsymbol{j}} & =70^{\circ} \mathrm{C}+(1.225 \mathrm{~W}) \\
& x\left(16.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}\right) \\
= & 143.5^{\circ} \mathrm{C}
\end{aligned}
$$

Problem: Determine the acceptable duty cycle for a hermetic power driver with a thermal resistance of $100^{\circ} \mathrm{C} / \mathrm{W}$ in an ambient of $85^{\circ} \mathrm{C}$ and which is controlling load currénts of 250 mA on each of four outputs.
Solution: From Equation 1, the allowable average power dissipation
$P_{D}$ for this IC is

$$
\begin{aligned}
P_{D} & =\frac{150^{\circ} \mathrm{C}-85^{\circ} \mathrm{C}}{100^{\circ} \mathrm{C} / \mathrm{W}} \\
& =0.65 \mathrm{~W}
\end{aligned}
$$

This means that there is 0.65 W limit on average power, but, not instantaneous power. If the duty cycle is law enough. and the ON time is not more than about 0.5 sec, the average power dissipation can be considerably lower than the peak power. The ON, or peak power, is determined from the data sheet maximum values of $V_{c c}, I_{c c}$, and $V_{c a r s a t}$ at the specified load current of 250 mA . From Equations 2 and 3, logic-gate power $P_{1}$, and output power $P_{0}$ for the ON state are

$$
\begin{aligned}
P_{1} & =4(5.5 \mathrm{~V} \times 26.5 \mathrm{~mA}) \\
& =583 \mathrm{~mW} \\
P_{0} & =4(0.7 \mathrm{~V} \times 250 \mathrm{~mA}) \\
& =700 \mathrm{~mW}
\end{aligned}
$$

Instantaneous ON power $P_{\text {ON }}$ is the sum of $P_{i}$ and $P_{f}$ for the ON state, or 1.283 W. The OFF power is primarily the
power dissipated by the logic in the OFF state, and is found by using the $I_{c c}$ maximum rated current listed on the specification sheet. The power
dissipated in the output stage can be calculated from the leakage current $I_{c}$ and supply voltage $V_{C E}$. From
Equations 2 and 3 , logic-gate power $P$, and output power $P_{0}$ for the OFF state are

$$
\begin{aligned}
P_{1} & =4(5.5 \mathrm{~V} \times 7.5 \mathrm{~mA}) \\
& =165 \mathrm{~mW} \\
\mathrm{P}_{0} & =4(100 \mathrm{~V} \times 0.1 \mathrm{~mA}) \\
& =40 \mathrm{~mW}
\end{aligned}
$$

Instantaneous OFF power Porf is the sum of $P_{1}$ and $P_{0}$, for the OFF state, or 205 mW . From Equation 4, acceptable duty cycle $D$ is

$$
\begin{aligned}
D & =\frac{P_{D}-P_{\text {OFF }}}{P_{\text {OY }}-P_{\text {orF }}} \\
& =\frac{0.65 W-0.205 \mathrm{~W}}{1.283 \mathrm{~W}-0.205 \mathrm{~W}}
\end{aligned}
$$

load current, and $n=$ number of logic gates. Manufacturers usually list typical and maximum values for these voltages and currents. For thermal considerations it is best to use the
maximum values so that worst-case power dissipation is determined.

If the duty cycle of the device is longer than 0.5 sec , the peak power dissipation is the sum of
the logic-gate power $P_{l}$ and output power $P_{o}$ for the logic ON state alone. If the ON time is less than 0.5 sec , however, average power dissipation must be calculated from instantaneous


## PACKAGE INFORMATION (Continued)

## What the Curves Show

The junction temperature of an IC depends on several factors, including the thermal resistance of the IC and the operating duty cycle. Graphs showing the relationship of these factors are often useful in specifying an IC.


Typical thermal-resistance ratings for ICs in still air range from $60^{\circ} \mathrm{C} / \mathrm{W}$ to $140^{\circ} \mathrm{C} / \mathrm{W}$. The slope of each curve on this graph is equal to the derating factor $\mathrm{G} \theta$, which is the reciprocal of thermal resistance $R \theta$. For an ambient temperature of $50^{\circ} \mathrm{C}$, a typical 14-lead flatpack with an $\mathrm{R} \theta$ of $140^{\circ} \mathrm{C} / \mathrm{W}$ can dissipate about 0.7 W . A typical DIP, however, with 14 copper-alloy leads can dissipate almost 1.7 W at $50^{\circ} \mathrm{C}$.

The highest allowable package power dissipation shown here is 2.5 W . Other special-purpose DIP packages are available with power dissipation ratings as high as 3.3 W at $0^{\circ} \mathrm{C}\left(R \theta=45^{\circ} \mathrm{C} / \mathrm{W}\right)$. If not for package limitations, IC chip dissipation might be greater than 9 W at an ambient temperature of up to $70^{\circ} \mathrm{C}$.

Although the curve for plastic DIPs goes all the way to $150^{\circ} \mathrm{C}$, they ordinarily are not used in ambients above $85^{\circ} \mathrm{C}$ because of traditional package limitations. Hermetic DIPs are specified to temperatures of $125^{\circ} \mathrm{C}$, and at $150^{\circ} \mathrm{C}$ the device should be derated to 0 W . The higher specification limits for hermetic devices is the result of their design for use in rigorous, high-reliability military applications.


Duty cycle is important in calculating IC junction temperature because average power-not instantaneous power-is responsible for heating the IC. To convert from peak power to average power, multiply the peak power dissipation by the duty cycle. The average-power rating is then used with the thermal-resistance rating to calculate the IC junction temperature. Thus, short duty cycles allow peak power to be high without exceeding the $150^{\circ} \mathrm{C}$ junction-temperature limit. However, this consideration applies only to ON times of less than 0.5 sec .
$\bigcirc \mathrm{ON}$ and OFF power $P_{O N}$ and
$P_{\text {OFF }}$ from
$P_{D}=D P_{O N}+(1-D) P_{O F F}$

## Corrective Actions

If the junction temperature or the required power dissipation
of the IC is calculated to be greater than the maximum values specified by the manufacturer, device reliability and operating characteristics possibly will be reduced. Possible solutions are: 1 . Modify or partition the circuit design so the IC is not required to dissipate as much power. 2. Reduce the
thermal resistance of the IC by using a heat sink or forced-air cooling. 3 . Reduce the ambient temperature by moving heatproducing components such as transformers and resistors away from the IC. 4. Specify a different IC with improved thermal or electrical characteristics (if available).

## THERMAL RESISTANCEA RELIABILITY CONSIDERATION

More and more the semiconductor component supplier and the ultimate system user are becoming aware of the need for reliable components. Most failure mechanisms responsible for reliability failures are temperature dependent and the kinetics of the failure reaction are normally described by an Arrhenius function. This dependence, therefore, demands the capability of measuring the mean temperature which an integrated circuit die will attain during operation to realistically assess the reliability of the part.

The problem addressed by this paper is the inconsistency of the measurement techniques and the results used by manufacturers and users to determine the thermal characteristics of packaged semiconductor components. Our objective is to provide insight into the considerations which must be applied when evaluating these thermal properties of the packaged component. These considerations are materials, geometry and environment.

Furthermore, we wish to instill uniformity in the method of determining thermal properties of packaged semiconductors through understanding of the variables involved which can lead to a useable industry standard.

## Reliability-The Temperature Function

The recognition of the problems one encounters in measuring the mean temperature of a die has been directly related to our experiences at the Sprague Electric Co. in our Reliability Assurance Programs. The large number of device types manufactured require an equally large number of burn-in boards having different functions and geometry for the individual reliability studies. The variations in board density and thermal environment for a device under test have provided considerable junction temperature data from which we conclude that a "thermal resistance" measured in one oven with its set of conditions is not transferable to another oven with different boards, loading, etc. when the reference temperature for the measurement is the oven control temperature. Furthermore, it has become obvious that these same problems in measuring a mean die temperature exist in a system environment.

Most reactions which can cause a failure in an electrical parameter of an integrated circuit are chemical in nature and are influenced by temperature. The temperature dependence of these reactions has been described very well by S. Arrhenius in his treatment of reaction kinetics. ${ }^{1}$ In his treatment, the reaction velocity or rate is given by the equation.

$$
\mathrm{d} \ln \mathrm{~V}_{\mathrm{r}} / \mathrm{dT}=\mathrm{E} / \mathrm{RT}^{2}
$$

here $\mathrm{V}_{\mathrm{r}}$ is the specific reaction rate, T is the absolute temperature, R is the Molar Gas Constant, and E is the energy difference between a mole of active molecules and a mole of normal molecules.

This equation integrates to

$$
\ln V_{r}=E / R T+A
$$

where $A$ is a constant which is the value of $\ln V_{r}$ at $1 / \mathrm{T}=0,\left(\ln V_{r}\right)$. A more familiar expression is

$$
\ln V_{r}=\ln V_{r}^{0}-\epsilon / k T
$$

or

$$
V_{r}=V_{r}^{0} e-\epsilon / k T
$$

where $\epsilon$ is the activation energy per molecule ( $=\mathrm{E} / \mathrm{N}$ ), $\mathrm{N}=$ Avagado's number and k is the gas constant per molecule ( $=\mathrm{R} / \mathrm{N}$ ), which is generally known as the Boltzmann constant. It has the value $8.6 \times 10^{-5} \mathrm{eV} /{ }^{\circ} \mathrm{K}$.
$\mathrm{V}_{\mathrm{E}}$, the time rate of change of the electrical parameter is proportional to $V_{r}$, i.e., $V_{E}=B V_{r}$. The amount of change in the electrical parameter necessary to cause a normal device to fail, $\Delta \mathrm{P}_{\mathrm{f}}$, is $\mathrm{V}_{\mathrm{E}} \mathrm{t}_{\mathrm{f}}$ where $t_{f}$ is the time of failure.
Recalling that $\mathrm{V}_{\mathrm{E}}=\mathrm{BV} V_{\mathrm{r}}$, then

$$
\Delta \mathrm{P}_{\mathrm{f}}=\mathrm{BV} V_{\mathrm{r}} \mathrm{t}_{\mathrm{f}}
$$

For a given device $\Delta \mathrm{P}_{\mathrm{F}}$ is a constant, therefore,

$$
\mathrm{t}_{\mathrm{f}}=\Delta \mathrm{P}_{\mathrm{f}} \mathrm{~B}^{-1 /} \mathrm{V}_{\mathrm{r}}
$$

but

$$
\mathrm{V}_{\mathrm{r}}=\mathrm{V}_{\mathrm{r}}^{0} e \in / \mathrm{kT}
$$

therefore

$$
\mathrm{t}_{\mathrm{f}}=\left(\mathrm{B}^{-1} \Delta \mathrm{P}_{\mathrm{f}} / \mathrm{V}_{\mathrm{f}}^{0} \mathrm{e}^{e k T}=\delta \mathrm{e}^{e k T}\right.
$$

where

$$
\delta=B^{-1} \Delta P_{f} / V_{r}^{0}
$$

## PACKAGE INFORMATION (Continued)

The acceleration factor ( $\overline{\mathrm{AF}}$ ) between any two temperatures is derived from this equation, when the activation energy for the failure reaction is known:

$$
\overline{\mathrm{AF}}=\mathrm{t}_{\mathrm{f}_{1}} / \mathrm{t}_{\mathrm{f}_{2}}=\mathrm{e}^{\epsilon \mathrm{k}\left(1 / \mathrm{T}_{1}-1 / \mathrm{T}_{2}\right)}
$$

Activation energies of most reactions responsible for random failures in a normal operating period (beyond infant mortality) are nominally

$$
(0.4-1.0) \mathrm{eV}
$$

The importance of accurately determining the die temperature is now clear if one considers a not unrealistic situation where a device is thought to be operating with a die temperature of $120^{\circ}$ and the actual temperature is $150^{\circ} \mathrm{C}$. If the failure reaction has an activation energy of 0.7 eV , then the acceleration factor is 4.3 which means the device would fail in less than one quarter of the time it would have taken if the device actually operated at $120^{\circ} \mathrm{C}$.

## Thermal Resistance - $\boldsymbol{\theta}_{\mathrm{JA}}$

Quite frequently applications engineers have made attempts to identify the temperature attained by a die when a steady state rate of heat is being generated by the die by applying the term called "Thermal Resistance." This "constant," designated $R \theta_{\mathrm{JA}}$ or simply $\theta_{\mathrm{JA}}$, relates the temperature rise of a packaged integrated circuit die above an ambient temperature when a known constant power is generated in the die. This term is normally defined as

$$
\theta_{\mathrm{JA}}=\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{A}}\right) / \mathrm{P}_{\mathrm{D}}
$$

where $T_{J}$ is the mean junction or die temperature, $T_{A}$ is an ambient temperature, and $\mathrm{P}_{\mathrm{D}}$ is the power generated within the die which must be conducted from the die to the ambient. This is occasionally designated $Q_{T}$, the time rate of heat generation in the die. Thermal resistance data supplied by manufacturers may be referenced to a cubic foot of free or still air, flowing air at some velocity, or simply no reference. These are some of the definitions of 'ambient'" from which one must determine where to measure $T_{A}$.

Thermal resistance as defined by $\theta_{\mathrm{JA}}$ is not constant. It is made up of a constant term (or terms) in series with a number of variable terms. The constant terms relate to the package materials and geometry, which we will designate $\theta_{\mathrm{JC}_{\mathrm{i}}}$ and the variable terms relate to the heat paths from the package boundary to some isothermal envelope in the system which has the temperature $T_{A}$. Even if the system for measuring $\theta_{\mathrm{JA}}$ is defined, it is virtually impossible to re-
produce that system in an application since the external thermal paths are determined by the method of mounting, the printed wiring board if used, other heat generating components on the board or in the vicinity, air flow patterns, etc. These are all variable for each application. We have measured values of $\theta_{J A}$ for the same device which vary by a factor of two when the mounting and environmental conditions are changed. The values in the $\theta_{\mathrm{JA}}$ column in Tables 2 and 3 are indicative of the variation.

One is tempted to partition $\theta_{\mathrm{JA}}$ into two thermal terms,

$$
\theta_{\mathrm{JA}}=\theta_{\mathrm{JC}}+\theta_{\mathrm{CA}}
$$

where $\theta_{\mathrm{JC}}$ is defined as the thermal resistance from the source of power at $T_{J}$ to the boundary of the package not including the external legs, and $\theta_{C A}$ is the thermal resistance from the package boundary to that isothermal envelope at $\mathrm{T}_{\mathrm{A}}$. However, when one examines the thermal profile along the surface of a plastic dual-in-line package such as shown in Figure 1, it is immediately obvious that a definition of $\theta_{\mathrm{JC}}$

$$
\theta_{\mathrm{JC}}=\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}}\right) / \mathrm{P}_{\mathrm{D}}
$$

cannot be applied because $T_{C}$ varies with position. Similarly, the term $\theta_{\mathrm{CA}}$ defined by

$$
\theta_{\mathrm{CA}}=\left(\mathrm{T}_{\mathrm{C}}-\mathrm{T}_{\mathrm{A}}\right) / \mathrm{P}_{\mathrm{D}}
$$

suffers from the same variability in $\mathrm{T}_{\mathrm{C}}$. This being the case it is invalid to partition $\theta_{\mathrm{JA}}$ when operating on the total power to be dissipated, $\mathrm{P}_{\mathrm{D}}$.


Figure 1

## The Thermal Model

When one examines a plastic package supplied by an individual manufacturer it is found that the geometry of the lead frame, its position within the package boundary, its composition, the composition of the plastic and its filler, the internal wire bonding are very carefully controlled and constant in time. This being the case one can readily build a model of the package which can be as invariant as the package material properties. If one considers all possible heat flows, a very complex model emerges. However, if the thermal conductivities of the package materials and the orders of magnitude difference in the values of these conductivities are considered, a simplified workable model can be generated by neglecting heat paths where heat flows are minimal. The simplified model shown in Figure 2 has ignored the heat flow between leads and assumes that the large difference between the thermal conductivity of the loaded plastic and the metals in the package define the specified heat paths. For example, the heat flow between leads would be a shunting resistor between heat paths in the model. The thermal conductivity of most plastics range between 1.5 and $3 \times$ $10^{-3}$ calories $/ \mathrm{cm}-{ }^{\circ} \mathrm{C}$ while copper based materials range between 0.5 and 0.82 calories $/ \mathrm{cm}-{ }^{\circ} \mathrm{C}$ and nickel based alloys are about 0.03 calories $/ \mathrm{cm}-{ }^{\circ} \mathrm{C}$.


Figure 2
The heat paths defined by $\theta_{\mathrm{sc}_{\mathrm{i}}}$, where i refers to a particular path, radiate from the chip to an area on the package periphery defined by the projected chip or pad area as well as the mean cross-sectional area of each of the leads within the plastic package boundary (see Figure 1). Because of package symmetry, a 16 lead isolated pad package may have seven different heat paths which can be characterized. The thermal resistance, $\theta_{\mathrm{JC}_{\mathrm{i}}}$, can be calculated
for each path from the geometry and material properties. For example $\theta_{\mathrm{JC}}^{1}$ is the resistance from the top of the chip to the projected area on the package surface. The value of $\theta_{\mathrm{JC}_{1}}$ is given by

$$
\theta_{\mathrm{JC}_{1}}=\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}\right) / \mathrm{q}_{1}=\mathrm{L} / \mathrm{K}_{\mathrm{p}} \mathrm{~A}
$$

where $L$ is the length of the heat path (thickness of the plastic above the die), A is the cross-sectional area of the heat path (are of the die or the pad), $\mathrm{K}_{\mathrm{p}}$ is the thermal conductivity of the loaded plastic and $q_{1}$ is the heat/second flowing in the path defined by A and $L$.
$\theta_{\mathrm{JC}_{2}}$ is the thermal resistance from the top of the die through the silicon, through the pad and through the plastic to the bottom surface. The value of $\theta_{\mathrm{JC}_{2}}$ is given by

$$
\begin{aligned}
& \theta_{\mathrm{IC}_{2}}=\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}_{2}}\right) / \mathrm{q}_{2}= \\
& \quad[1 / \mathrm{A}] \sum \mathrm{L}_{\mathrm{n}} / \mathrm{K}_{\mathrm{n}} \\
& \mathrm{n}=\mathrm{Si}, \text { Metal, Plastic }
\end{aligned}
$$

Similar expressions can be derived for each of the leads and they have the form

$$
\begin{gathered}
\theta_{\mathrm{IC}_{\mathrm{i}}}=\left(\mathrm{T}_{J}-\mathrm{T}_{\mathrm{C}_{\mathrm{i}}} / \mathrm{q}_{\mathrm{i}}=\right. \\
{[1 / \mathrm{t}]\left[\left(\mathrm{L} / \mathrm{K}_{\mathrm{P}} \mathrm{~W}_{\mathrm{P}}\right)+\left(1 / \mathrm{K}_{\mathrm{M}}\right) \sum_{\mathrm{n}} \mathrm{~L}_{\mathrm{n}} / \mathrm{W}_{\mathrm{n}}\right]} \\
\quad 1,2 \ldots . \ldots
\end{gathered}
$$

where $t$ is the thickness of the lead frame, $\mathrm{K}_{\mathrm{p}}$ is the thermal conductivity of the loaded plastic, $\mathrm{K}_{\mathrm{M}}$ is the thermal conductivity of the frame metal, $\mathrm{L}_{\mathrm{n}}$ is the mean length of each connected portion of a leg segment having a mean width, $\mathrm{W}_{\mathrm{n}}$. In accord with the model, each internal path characterized by a thermal resistance, $\theta_{\mathrm{JC}_{\mathrm{C}}}$, is in series with an external thermal resistance, $\theta_{\mathrm{CiA}}$, which completes the path to $\mathrm{T}_{\mathrm{A}}$. The value of $\theta_{\mathrm{C}_{\mathrm{A}}}$ can be calculated from the amount of heat, $\mathrm{q}_{\mathrm{i}}$, flowing through the internal package path and the temperature difference, $\left(\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}-\mathrm{T}_{\mathrm{A}}\right)$, with the equation

$$
\theta_{\mathrm{C}_{\mathrm{i}} \mathrm{~A}}=\left(\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}-\mathrm{T}_{\mathrm{A}}\right) / \mathrm{q}_{\mathrm{i}} .
$$

Values of $\theta_{\text {CiA }}$ are variable and depend upon the specific environment.

We at Sprague Electric Company identify the heat paths in our calculations and data as follows: a) when $i=1$ the path is from die to case surface directly above, b ) when $\mathrm{i}=2$ the path is from die to the case surface directly below and $c$ ) when $i=3,4$, $5 \ldots$. . the path is from die through an identified metal lead to the intersection with the plastic surface.

## PACKAGE INFORMATION (Continued)

## Verification of Model

From the model one can derive the minimum thermal resistance which is characteristic of the package. This can be calculated for the condition when all case temperatures are equal and at $\mathrm{T}_{\mathrm{A}}$. This is equivalent to shorting all external thermal resistances so that $\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}=\mathrm{T}_{\mathrm{A}}$. When all $\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}$ are equal, the reciprocal of the sum of the reciprocals of all $\theta_{\mathrm{JC}_{\mathrm{i}}}$ is the minimum thermal resistance for the package. This is realized experimentally by placing the unit in an infinite heat sink such as a rapidly stirred, lowviscosity controlled temperature bath. The case temperature is now forced to be the same over all surfaces and by definition it is $\mathrm{T}_{\mathrm{A}} \cdot \theta_{\mathrm{JC}}$ is the minimum limit of $\theta_{\mathrm{JA}}$. Table 1 shows the agreement between the values of $\theta_{\mathrm{JC}}$ calculated from the model when the case temperatures are shorted together and the values experimentally measured in a controlled temperature liquid bath. The agreement between calculated and experimental values for packages constructed from different materials enhance the validity of the model.

## Applying The Model To Measure $\mathrm{T}_{\mathrm{J}}$

Having verified the model, any one of the identified heat paths, which has a constant thermal resistance, $\mathrm{o}_{\mathrm{JC}_{\mathrm{i}}}$, can now be used to determine quite accurately the die temperature, $\mathrm{T}_{\mathrm{J}}$. If one chooses to measure the case temperature directly above the die, the difference between die temperature and case temperature is related to the heat flow, $q_{i}$, through that path by the thermal conductivity equation:

$$
\mathrm{q}_{\mathrm{i}}=\mathrm{K}_{\mathrm{p}} \mathrm{~A}\left(\mathrm{~T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}_{1}}\right) / \mathrm{L}_{\mathrm{i}} .
$$

Rearranging this equation to

$$
\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}_{1}}\right) / \mathrm{q}_{1}=\mathrm{L}_{1} / \mathrm{k}_{\mathrm{p}} \mathrm{~A}_{1}=\theta_{\mathrm{JC}_{1}}
$$

Then

$$
\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{C}_{1}}+\mathrm{q}_{1} \theta_{\mathrm{JC}_{1}}
$$

If the fraction of total heat, $P_{D}$ generated by the die which passes through path 1 is defined as $k$, then

$$
\mathrm{q}_{1}=\mathrm{k}_{1} \mathrm{P}_{\mathrm{D}}
$$

Substituting into the previous equation, $\mathrm{T}_{\mathrm{J}}$ is now referenced to $\mathrm{T}_{\mathrm{C}_{1}}$ by

$$
\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{C}_{1}}+\mathrm{k}_{1} \theta_{\mathrm{JC}_{1}} \mathrm{P}_{\mathrm{D}}
$$

where $T_{s}, T_{C_{1}}$, and $P_{D}$ are experimentally measureable quantities. Values of $k_{1} \theta_{\mathrm{JC}_{1}}$ can be determined. This term can be used to determine $T_{5}$ in any environment by measuring $\mathrm{T}_{\mathrm{C} 1}$ and the total heat generated by the die. This equation applies for any path, i., i, e.

$$
\mathrm{T}_{\mathrm{J}}=\mathrm{T}_{\mathrm{C}_{1}}+\mathrm{k}_{\mathrm{i}} \theta_{\mathrm{J}} \mathrm{P}_{\mathrm{D}}
$$

Experimental results are presented in Table 2 which establish that $k_{i} \theta_{\mathrm{JC}_{\mathrm{i}}}$ is a constant, the magnitude of which is determined by the heat path chosen.

In our notation, $\mathrm{k}_{4} \theta_{\mathrm{JC}_{4}}$ is the thermal resistance of the path determined by measuring the temperature of pin 4 at the point of intersection with the case body. Further data are presented in Table 3 for a copper tab package where the pad on which the die is mounted extends to the outside of the package. The values of $\mathrm{k}_{5} \theta_{\mathrm{JC}_{5}}$ remain constant over a large change in environment. When $i=5$, the heat path is from the die through the heat tab to the intersection with the case surface.

Figure 3 shows the outline of the frame in the 16 pin isolated pad package which is designated the "A" package. The "B" package or tab package frame outline is also shown.

## Measurement of $\mathbf{k}_{\mathbf{i}} \boldsymbol{\theta}_{\mathbf{j} \mathrm{c}_{\mathbf{i}}}$

Although the derived equations indicate that $k_{i} \theta_{J C_{i}}$ are determined by two temperature measurements at one power level, the values are more accurately determined from temperature versus power plots.

## TABLE 1

 COMPARISON OF CALCULATED AND EXPERIMENTAL VALUES $O F\left[\theta_{\mathrm{J}}\right] \mathbf{T}_{\mathbf{c}_{\mathbf{i}}}=\mathbf{T}_{\mathbf{A}}$(All measurements in ${ }^{\circ} \mathrm{C} / \mathrm{W}$ )

| Package | Frame |  | $\left[\theta_{j c}\right] T_{c_{i}}=T_{A}$ |
| :--- | :---: | :---: | :---: |
| $\quad$ Type | Material | Experimental | Calculated |
| 16 pin, isolated | copper | $41 \pm 3$ | 43 |
| pad, Epoxy I | Kovar | $100 \pm 4$ | 93 |
| 16 pin, isolated |  | $8.6 \pm .7$ | 8.5 |
| pad, Epoxy I | copper |  |  |

## TABLE 2 <br> THERMAL RESISTANCE VALUES—ISOLATED PAD-EPOXY PACKAGE

(All measurements in ${ }^{\circ} \mathrm{C} / \mathrm{W}$ )

| Device | Condition of Measurement | $\theta_{\text {IA }}$ | $k_{4} \theta_{c_{4} A}$ | $k_{1} \theta_{\text {cla }}$ | ${ }^{1} \theta_{1} \theta_{c_{1}}$ | $\mathrm{k}_{4} \theta_{\mathrm{c}_{4}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ULN-2003A <br> 16-Pin Copper <br> Frame. "A" <br> Package | $1 \mathrm{ft}^{3}{ }^{3}$ still air, socket mount | 84.7 | 39.1 | 48.1 | 36.6 | 45.6 |
| ULN-2003A 16-Pin Copper Frame. "A" Package | Oven \#1 60 CFM, pin connectors | 60.0 | 17.0 | 25.2 | 34.8 | 42.3 |
| ULN-2003A 16-Pin Copper Frame. "A" Package | AAVID E type 5010 heat sink Oven \#1 60 CFM | 50.4 | 11.4 | 15.2 | 35.2 | 39 |
| UIN-2003A 16-Pin Copper Frame. "A" Package | Fluorocarbon Bath, pin connectors | 41.3 | 3.3 | 2.9 | 38.4 | 38 |


"A" PACKAGE

"B" PACKAGE

Figure 3
Plastic Package Frame Geometry
If one considers any one path, $i$, in the model, that path is described by:

$$
\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{A}}=\mathrm{q}_{\mathrm{i}}\left(\theta_{\mathrm{JC}_{\mathrm{i}}}+\theta_{\mathrm{C}_{\mathrm{i}} \mathrm{~A}}\right)
$$

Here again if $k_{i}$ is the fraction of the total heat $\left(P_{D}\right)$ which traverses path i then the previous equation can be written

$$
\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{A}}=\mathrm{k}_{\mathrm{i}} \mathrm{P}_{\mathrm{D}}\left(\theta_{\mathrm{J} \mathrm{C}_{\mathrm{i}}}+\theta_{\mathrm{C}_{\mathrm{i}} \mathrm{~A}}\right)
$$

or rearranging terms

$$
\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{A}}\right) / \mathrm{P}_{\mathrm{D}}=\mathrm{k}_{\mathrm{i}} \theta_{\mathrm{J} \mathrm{C}_{\mathrm{i}}}+\mathrm{k}_{\mathrm{i}} \theta_{\mathrm{C}_{\mathrm{i}} \mathrm{~A}}
$$

## TABLE 3

## THERMAL RESISTANCE VALUES-TAB PAD-EPOXY PACKAGE

(All measurements in ${ }^{\circ} \mathrm{C} / \mathrm{W}$ )

| Device | Condition of Measurement | $\theta_{\text {JA }}$ | $K_{5} \theta_{C 5} A$ | $\mathrm{K}_{5} \mathrm{~J}_{5}$ |
| :---: | :---: | :---: | :---: | :---: |
| Test Chip "B" Package | $\begin{aligned} & \text { oven \#1, } \mathrm{T}_{\mathrm{A}}=50^{\circ} \text {, } \\ & 60 \mathrm{CFM} \end{aligned}$ | 32.8 | 25.0 | 7.8 |
| ULN-2068 "B" Package | $\text { oven \#1, } \mathrm{T}_{\mathrm{A}}=50^{\circ}$ $60 \text { CFM }$ | 34.9 | 26.4 | 8.5 |
| ULN-2068 "B" Package | Socket mount, FC-40 Bath | 23.2 | 13.5 | 9.7 |
| ULN-2068 "B" Package | Socket mounted on board, FC-40 Bath | 26.8 | 17.4 | 9.4 |
| Test Die "B" Package | oven \#1, soldered on test board, 60 CFM | 31.2 | 22.8 | 8.4 |
| Test Die "B" Package | oven \#1, soldered in test board w/Staver heat sink | 22.3 | 14.2 | 8.1 |

By definition $\left(T_{J}-T_{A}\right) / P_{D}=\theta_{J A}$, therefore by substitution and rearrangement

$$
\mathrm{k}_{\mathrm{i}} \theta_{\mathrm{JC}}^{\mathrm{i}}, ~=\theta_{\mathrm{JA}}-\mathrm{k}_{\mathrm{i}} \theta_{\mathrm{C}_{\mathrm{i}} \mathrm{~A}}
$$

where experimentally $\theta_{J A}$ is the slope of a plot of $T_{J}$ versus $P_{D}$ and $K_{i} \theta_{C_{i} A}$ is the slope of the plot of $T_{C_{i}}$, versus $P_{D}$. Figures 4, 5, and 6 are representative of the experimental plots for evaluation of $k_{i} \theta_{\mathrm{JC}_{i}}$.


Figure 4


Figure 5


Figure 6

## $T_{c_{i}}$ Measurement

The numerical values of $k_{i} \theta_{\mathrm{JC}_{i}}$ which we have shown experimentally to be constant over a large variation in environmental conditions are functions of the measuring system for determining the case or leg temperature, $\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}$. This can be shown by considering heat path 1 in the Model shown in Figure 2. In this case $\mathrm{q}_{1}=\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{A}}\right) /\left(\theta_{\mathrm{JC}_{1}}+\theta_{\mathrm{C}_{1} \mathrm{~A}}\right) \cdot \theta_{\mathrm{JC}_{1}}$ is defined as $L_{1} / k_{p} A_{1}$ where $A_{1}$ is determined by the die area. When a thermocouple is attached to the surface directly over the die it also functions as a heat sink. This changes the effective area $A$ of the internal heat path and also changes the external thermal resistance, $\theta_{\mathrm{C}_{1} \mathrm{~A}}$. The changes are functions of the thermocouple composition and size. The value of $\theta_{\mathrm{JC}_{1}}$ is now determined by the effective area of contact of the thermocouple and its value remains constant when the attached thermocouple's size is held constant. $\mathrm{k}_{1},\left(=\mathrm{q}_{1} / \mathrm{Q}_{\mathrm{t}}\right)$, also changes because $\mathrm{q}_{1}$ is determined by the sum of $\theta_{\mathrm{JC}_{1}}$ and $\theta_{\mathrm{C}_{1} \mathrm{~A}}$. The term ( $\mathrm{T}_{\mathrm{J}}-$ $T_{A}$ ) is essentially constant within experimental error because $q_{1}$ is small compared to $Q_{t}$ and the variations in $\mathrm{q}_{1}$ do not measureably change the die temperature.
$\theta_{\mathrm{C}_{1} \mathrm{~A}^{\mathrm{A}}}$ decreases as the wire size of a copper-constantan thermocouple increases and it increases as the composition is changed from copper-constantan to iron constantan. The thermal conductivities of copper, iron, and constantan are respectively 0.9 , 0.16 , and $0.054 \mathrm{cal} /{ }^{\circ} \mathrm{C}-\mathrm{cm}$.

Data in Table 4 confirm the direction and change in $\mathrm{k}_{1} \theta_{\mathrm{JC}_{1}}$ with change in measuring system. Data were taken in the same oven ambient.
When the physical system for $\mathrm{T}_{\mathrm{C}}$ measurement and the conditions for measurement are specified and held constant, values for $\mathrm{k}_{1} \theta_{\mathrm{JC}_{1}}$ are constants.

## $T_{j}$ Measurement For $k_{i} \boldsymbol{\theta}_{j} c_{i}$ Determination

An accurate measurement of the value of $k_{i} \theta_{\mathrm{JC}_{i}}$ requires a method of measuring the mean temperature of the die, $\mathrm{T}_{\mathrm{J}}$. Techniques to make this measurement have been discussed elsewhere. (See Ref. 2, 3, 4) They involve measurement of a temperature sensitive parameter of an element on the die. The forward voltage drop across a diode measured at constant current is a commonly used parameter. One must observe caution when applying the cali-

# TABLE 4 <br> VARIATIONS IN $\mathbf{k}_{\mathbf{i}} \boldsymbol{\theta}_{\mathbf{j} \mathbf{c}_{\mathbf{1}}}$ WITH MEASUREMENT SYSTEM (All measurements in ${ }^{\circ} \mathrm{C} / \mathrm{W}$ ) 

Condition of

| Device | Measurement |
| :--- | :--- |
| Test device | .005" Type "J" <br> thermocouple |
| Test device | .012" Type "j" <br> thermocouple |
| 2125 Linear | .005 " Type "T" <br> TV Circuit |
| thermocouple |  |

bration data for an element in an unpowered die to the measured values of that element when the die is powered. It is rather unique if a parasitic voltage or current from the powered portion of the die does not interact with the temperature measuring element. This interaction leads to an inaccurate indication of the true temperature.
A test chip with a number of temperature sensitive elements is valuable. Figure 7 is a photo micrograph of a test chip designed by personnel at the Sprague Electric Company to evaluate thermal resistance values for various packages as well as packagesurface interactions. The die contains 3 heat generators, and 6 primary temperature sensors, which are either diodes or special resistors. Parasitics normally interact differently with different elements because of location or structure variations. Agreement in the value of temperatures measured simultaneously for different elements on the chip normally indicates a correct measurement.


Figure 7

Figure 8 illustrates errors which can be introduced when making static steady state measurements of temperature during power application. Observe the plots of $T_{j}$ (from $V_{e b}$ calibration) versus $P_{D}$ for three different diodes on the chip. Although the slopes of the plots after initial power agree within $10 \%$, the initial portion of the curve indicates a negative ther-

| $\theta_{\mathrm{JA}}$ | $\mathrm{k}_{1} \theta_{\mathrm{C}_{1 \mathrm{~A}}}$ | $\mathrm{k}_{1} \theta_{\mathrm{c}_{1}}$ |
| :---: | :---: | :---: |
| 127.6 | 52.2 | 75.4 |
| 123.5 | 31.5 | 92.0 |
| 123.3 | 75.0 | 48.3 |

mal resistance and the offsets of the curves indicate a varying interaction at different power levels. Although calculation of thermal resistance by the slope method would introduce a similar error for all three diodes, the single power point method for calculating $k_{i} \theta_{\mathrm{J}_{\mathrm{i}}}$, where $\mathrm{k}_{\mathrm{i}} \theta_{\mathrm{JC}_{\mathrm{i}}}=\left(\mathrm{T}_{\mathrm{J}}-\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}\right) / P_{\mathrm{D}}$, would introduce considerable and different levels of error in the calculated values for each diode measurement.


Figure 8

For example, if temperature measurements were made at a power level of 0.22 Watts, one would calculate a value of $44.6^{\circ} \mathrm{C} / \mathrm{W}$ for $\mathrm{k}_{1} \theta_{\mathrm{JC}_{1}}$ using $\mathrm{T}_{5}$ from diode $7-15.57 .1^{\circ} \mathrm{C} / \mathrm{W}$ using $\mathrm{T}_{\mathrm{J}}$ from diode $7-5$, and $63.8^{\circ} \mathrm{C} / \mathrm{W}$ using $\mathrm{T}_{\mathrm{J}}$ from diode 7-6. The true value which was verified by pulsed measurements was $97^{\circ} \mathrm{C} / \mathrm{W}$.
To eliminate interactions between the powered portion of a circuit and the temperature sensing element during measurement, the circuit shown in Figure 9 was developed. This circuit was designed for thermal evaluation of packages in which the function could be a linear circuit, a digital circuit, or the standard test chip which has a number of different power sources and temperature sensing elements.


Figure 9

In operation, the circuit applies power at a measured level to the device under test for approximately one second, interrupts power for 40 microseconds, and continues this cycle throughout the test period. At the beginning of the 40 -microsecond power off interval, a $10-\mathrm{mic}$ cosecond delay allows circuit transients to decay before the diode current is activated. A 6-microsecond delay allows the current to settle before a sample and hold circuit
samples the diode voltage to determine the chip temperature. This sequence allows the package under test to come to thermal equilibrium with the environment which approaches that for continuous power input. The power down sequence and temperature measurement interval are short enough to insure that the actual temperature drop when power is removed is less than the sensitivity of the temperature sensitive element.

The case temperature measurements, $\mathrm{T}_{\mathrm{C}_{\mathrm{i}}}$, can be made by thermocouple or by infra-red measurements. ${ }^{4}$ In theory the infra-red measurements would be preferred since a conductive contact is not made to the surface which is to be measured. In practice a number of difficulties with I.R. measurements are encountered. The emissivity of the surface to be measured must be controlled to give accurate measurements. This normally requires painting the surface with a "proprietary" film. When the emissivity is mastered, twa larger difficulties must be overcome; a) physically placing the infra-red measuring instrument into the system to view a package surface when the unit may be buried in a maze of printed wiring boards and circuitry and $b$ ) the cost of available instrumentation.

The thermocouple technique to measure case temperature is a practical and reliable method when the composition of the thermocouples, its physical size, its location on the package, and the method of its attachment are defined. The method of measure-
ment can be standardized and provides an accurate, inexpensive method for the applications engineer or the reliability engineer to determine a reference temperature to which the temperature rise across the package path, $\left(k_{i} \theta_{\mathrm{JC}_{\mathrm{C}}}\right) \mathrm{P}_{\mathrm{D}}$, can be applied in order to determine a true $\mathrm{T}_{\mathrm{J}}$.

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# Operating and Handling Practices for MOS Integrated Circuits 

## Handling Practices - Packaged Devices

Sprague Electric incorporates input protection diodes in all of its MOS/CMOS devices. Because of the very high input resistance in MOS devices, the following practices should be observed for protection against high static electrical charges:

1. Device leads should be in contact with a conductive material except when being tested or in actual operation.
2. Conductive parts of tools, fixtures, soldering irons and handling equipment should be grounded.
3. Devices should not be inserted into or removed from test stations unless the power is off.
4. Neither should signals be applied to the inputs while the device power supply is in an off condition.
5. Unused input leads should be committed to either VSS or VDD.

## Handling Practices - Die

A conductive carrier should be used in order to avoid differences in voltage potential.

## Automatic Handling Equipment

Grounding alone may not be sufficient and feed mechanisms should be insulated from the devices under test at the point where the devices are connected to the test equipment. Ionized air blowers can be of aide here and are available commercially. This method is very effective in eliminating static electricity problems.

## Ambient Conditions

Dry weather with accompanying low humidity tends to intensify the accumulation of static charges on any surface. In this atmosphere, proper handling procedures take on added importance. If necessary, steam injectors can be procured commercially.

## Alert Failure Modes

The common failure modes that appear when static energy exists and when proper handling practices are not used are:

1. Shorted input protection diodes.
2. Shorted or 'blown' open gates.
3. Open metal runs.

Simple diagnostic checks with curve tracers or similar equipment readily identifies the above failure modes.

## 'A' PACKAGE: 14-Pin Plastic Dual In-Line

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$

## DIMENSIONS IN INCHES




Dwg. No. A-5496G in


Dwg. No. A-5496G mm

## 'A' PACKAGE: 16-Pin Plastic Dual In-Line

## DIMENSIONS IN INCHES



## DIMENSIONS IN MILLIMETRES

Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## PACKAGE INFORMATION (Continued)

## 'A' PACKAGE: 18-Pin Plastic Dual In-Line

## DIMENSIONS IN INCHES

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-9649 mm

## 'A' PACKAGE: 20-Pin Plastic Dual In-Line

DIMENSIONS IN INCHES


Dwg. No. A-10,430 in

NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'A' PACKAGE: 22-Pin Plastic Dual In-Line

DIMENSIONS IN INCHES

(200 MAX.
Dwg. No. A-10,536B IN

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$
5.08 MAX.


## 'A' PACKAGE: 28-Pin Plastic Dual In-Line

## DIMENSIONS IN INCHES



NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


## 'B' PACKAGE: 8-Pin Plastic Dual In-Line

## DIMENSIONS IN INCHES



DWG.NO. A-10,474A IN


DIMENSIONS IN MILLIMETRES
(Based on $1 \mathrm{in} .=25.4 \mathrm{~mm}$ )


DWG.NO. A-10,474A MM

## 'B' PACKAGE: 14-Pin Plastic Dual In-Line

## DIMENSIONS IN INCHES



DWG.NO. A-9843C IN


DIMENSIONS IN MILLIMETRES
(Based on $1 \mathrm{in} .=25.4 \mathrm{~mm}$ )

SEATING PLANE
DWG.NO. A-9843C MM

NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'B' PACKAGE: 16-Pin Plastic Dual In-Line



NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.
'D' PACKAGE: 3-Pin Metal TO-52/TO-206AC

DIMENSIONS IN INCHES


DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-3893B MM

NOTE: Lead diameter is controlled in the zone between $0.050^{\prime \prime}(0.13 \mathrm{~mm})$ and $0.250^{\prime \prime}(6.35 \mathrm{~mm})$ from the seating plane. Between $0.250^{\prime \prime}$ $(6.35 \mathrm{~mm})$ and $0.500^{\prime \prime}(12.7 \mathrm{~mm})$ from the seating plane, a maximum lead diameter of $0.021^{\prime \prime}(0.53 \mathrm{~mm})$ is specified. Outside of these zones the lead diameter is not controlled.

## 'H' PACKAGE: 8-Pin Hermetic Dual In-Line



NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'H' PACKAGE: 16-Pin Hermetic Dual In-Line

## DIMENSIONS IN INCHES



## DIMENSIONS IN MILLIMETRES

Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. $A-10,211 \mathrm{Bmm}$

## 'H' PACKAGE: 18-Pin Hermetic Dual In-Line

## DIMENSIONS IN INCHES



DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-10,312A mm

## NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'J' PACKAGE: 14-Pin Hermetic Flat-Pack



DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-10,252B MM

NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Includes off-center lid, meniscus, and glass overrun.
5. All leads weldable and solderable.
' $\mathbf{M}^{\prime}$ PACKAGE: 8-Pin Plastic Dual In-Line

## DIMENSIONS IN INCHES

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


LEADS 1, 4, 5, VENDOR'S OPTION

Dwg. No. A-5842D IN


LEADS 1, 4, 5,
AND 8 AT
VENDOR'S OPTION

Dwg.No. A-5842D MM

NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## ‘Q' PACKAGE: 16-Pin Plastic Quad In-Line

## DIMENSIONS IN INCHES



## 'R' PACKAGE: 14-Pin Ceramic Dual In-Line

## DIMENSIONS IN INCHES



DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'R' PACKAGE: 16-Pin Ceramic Dual In-Line

## DIMENSIONS IN INCHES



Dwg. No. A-10,549 in

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


## 'R' PACKAGE: 18-Pin Ceramic Dual In-Line

## DIMENSIONS IN INCHES

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-10,548 in

D.08 MAX.
DWg. No. A- $10,548 \mathrm{~mm}$

NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'S' PACKAGE: 4-Pin Molded Single In-Line

## DIMENSIONS IN INCHES

Dwg. No. A-9002C in


DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-9002C mm

NOTES:

1. Lead spacing tolerance is non-cumulative
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'T' PACKAGE: 3-Pin Plastic Single In-Line

## DIMENSIONS IN INCHES



DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg.No. A-12,139 MM

NOTE: Lead diameter is controlled in the zone between $0.050^{\prime \prime}(0.13 \mathrm{~mm})$ and $0.250^{\prime \prime}(6.35 \mathrm{~mm})$ from the seating plane. Between $0.250^{\prime \prime}$ $(6.35 \mathrm{~mm})$ and $0.500^{\prime \prime}(12.7 \mathrm{~mm})$ from the seating plane, a maximum lead diameter of $0.021^{\prime \prime}(0.53 \mathrm{~mm})$ is specified. Outside of these zones the lead diameter is not controlled.

## 'U' PACKAGE: 3-Pin Plastic Single In-Line



NOTE: Lead diameter is controlled in the zone between $0.050^{\prime \prime}(0.13 \mathrm{~mm})$ and $0.250^{\prime \prime}(6.35 \mathrm{~mm})$ from the seating plane. Between $0.250^{\prime \prime}$ $(6.35 \mathrm{~mm})$ and $0.500^{\prime \prime}(12.7 \mathrm{~mm})$ from the seating plane, a maximum lead diameter of $0.021^{\prime \prime}(0.53 \mathrm{~mm})$ is specified. Outside of these zones the lead diameter is not controlled.

## 'W' PACKAGE: 12-Pin Plastic Single In-Line

## DIMENSIONS IN INCHES

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'Y' PACKAGE: 3-Pin TO-92/TO-226AA

DIMENSIONS IN INCHES


Dwg. No. A-10,852A in

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


NOTE: Lead diameter is controlled in the zone between $0.050^{\prime \prime}(0.13 \mathrm{~mm})$ and $0.250^{\prime \prime}(6.35 \mathrm{~mm})$ from the seating plane. Between $0.250^{\prime \prime}$ $(6.35 \mathrm{~mm})$ and $0.500^{\prime \prime}(12.7 \mathrm{~mm})$ from the seating plane, a maximum lead diameter of $0.021^{\prime \prime}(0.53 \mathrm{~mm})$ is specified. Outside of these zones the lead diameter is not controlled.

## 'Z' PACKAGE: 5-Lead TO-220

DIMENSIONS IN INCHES


DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-10,460 mm
NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

## 'ZH' PACKAGE: 5-Lead TO-220 (Horizontal Mount)

DIMENSIONS IN INCHES


Dwg. No. A-10,462B IN

DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-10,462B MM
'ZV' PACKAGE: 5-Lead TO-220 (Vertical Mount)

DIMENSIONS IN INCHES

Dwg. No. $A-10,461 B$ IN


DIMENSIONS IN MILLIMETRES
Based on $1^{\prime \prime}=25.4 \mathrm{~mm}$


Dwg. No. A-10,461B MM

NOTES:

1. Lead spacing tolerance is non-cumulative.
2. Exact body and lead configuration at vendor's option within limits shown.
3. Leads missing from their designated positions shall also be counted when numbering leads.
4. Terminal lead standoffs may be omitted and replaced by body standoffs.
5. Lead gauge plane is $0.030^{\prime \prime}(0.76 \mathrm{~mm})$ max. below seating plane.

In the construction of the components described, the full intent of the specification will be met. The Sprague Electric Company, however, reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the design of its products. Components made under military approvals will be in accordance with the approval requirements.

The information included herein is believed to be accurate and reliable. However, the Sprague Electric Company assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties which may result from its use.


# Sprague Electric Company <br> A unit of the Penn Central Corporation 

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115 NORTHEAST CUTOFF, WORCESTER, MA 01606 TEL.: (617) 853-5000


[^0]:    *New product. Contact factory for detailed information.

[^1]:    *New product. Contact factory for detailed information.

[^2]:    *New product. Contact factory for detailed information.

[^3]:    $\ddagger$ European registration; manufactured by various companies including ITT, Philips, SGS/ATES, Siemens, Thomson-CSF, AEG-Telefunken, and Valvo.
    *No longer manufactured. Listed for reference only

[^4]:    TSprague device includes internal pull-down resistors.
    *No longer manufactured. Listed for reference only.
    $\dagger$ Some differences in specified switching speed with the Sprague device being superior for use with inductive loads.

[^5]:    *№ longer manufactured. Listed for reference only.

[^6]:    *No longer manufactured. Listed for reference only.
    §Sprague engineering bulletin in preparation.

[^7]:    ${ }^{*}$ No longer manufactured. Listed for reference only.
    §Sprague engineering bulletin in preparation.

[^8]:    *№ longer manufactured. Listed for reference only.
    $\dagger$ Some differences in specified switching speed with the Sprague device being superior for use with inductive loads.
    §Sprague engineering bulletin in preparation.

[^9]:    $\ddagger$ European registration; manufactured by various companies including ITT, Philips, SGS/ATES, Siemens,
    Thomson-CSF, AEG-Telefunken, and Valvo.
    *No longer manufactured. Listed for reference only.
    §Sprague engineering bulletin in preparation.

[^10]:    *№ longer manufactured. Listed for reference only.
    §Sprague engineering bulletin in preparation.

[^11]:    *№ longer manufactured. Listed for reference only.
    §Sprague engineering bulletin in preparation.

[^12]:    *No longer manufactured. Listed for reference only.

[^13]:    *No longer manufactured. Listed for reference only.

[^14]:    *Derate at the rate of $9.1 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$

[^15]:    Code: GD $=$ D-C Gas-Discharge \& Glow Transfer
    $A C P=A-C$ Plasma
    DCEL = D-C Electroluminescent EM = Electromagnetic
    VF = Vacuum Fluorescent

[^16]:    *New product. Contact factory for detailed information.

[^17]:    Series ULN-2800A and ULN-2810A devices are also available (with reduced package power capability) in industrial-grade hermetic packages. To order, change the last letter of the part number from ' $A$ ' to ' $R$ '. Note that the high-voltage devices ( $B V_{C E} \geq 95 \mathrm{~V}$ ) are not presently available with this packaging option.

[^18]:    Note: Positive (negative) current is defined as going into (coming out of) the specified device pin.

[^19]:    Output Voltage Range, $\mathrm{V}_{\text {CE }}$ (UDN-2981A \& UDN-2982A) +5 V to +50 V
    (UDN-2983A \& UDN-2984A) $+35 V$ to $+80 V$
    Input Voltage, $\mathrm{V}_{\mathbb{N}}(\mathrm{UDN}-2981 \mathrm{~A}$ \& UDN-2983A) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+15 \mathrm{~V}$
    (UDN-2982A \& UDN-2984A) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +30 V
    Output Current, $\mathrm{I}_{\text {out }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 500 mA
    Power Dissipation, $P_{D}$ (any one driver) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1 W
    (total package) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 2.2 W*
    
    
    *Derate at the rate of $18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+25^{\circ} \mathrm{C}$.

[^20]:    *All Inputs Simultaneously

[^21]:    *Examples and data in this application note applies equally to Series ULN-2800A Darlington arrays.

[^22]:    Simultaneous operation at these voltage and current limits is not ivailable with a single device.

[^23]:    *Note: Operation of these devices with standard TLL or DTL may require the use of appropriate pull-up resistors to insure the minimum logic "I".

[^24]:    $X=$ irrelevant
    $\mathrm{t}-1=$ previous output state
    $\mathrm{t}=$ present output state

[^25]:    Output Voltage, $V_{\text {out }}$. 50 V
    Logic Supply Voltage Range, $V_{D D} \ldots . . . . . . . . .$. . . . 4.5 V to 18 V
    
    Input Voltage Range, $\mathrm{V}_{\mathbb{N}} \ldots \ldots \ldots . .-0.3 \mathrm{~V}$ to $\mathrm{V}_{D D}+0.3 \mathrm{~V}$
    Continuous Output Current, $\mathrm{I}_{\text {out }}$ (UCN-4807A) $\ldots . .200 \mathrm{~mA}$
    (UCN-4808A) . ..... 600 mA
    Package Power Dissipation, $P_{D}$. . . . . . . . . . . . . . . . . 1.82 W* $^{*}$
    Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots . .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
    Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
    *Derate at the rate of $18.18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

[^26]:    L = Low Logic Level
    $H=$ High Logic Level
    D = Data (High or Low)
    $X=$ Irrelevant
    $R=$ Previous State

[^27]:    Caution: Sprague Electric CMOS devices have input static protection but are

[^28]:    L = Low Logic Level
    $H=$ High Logic Level
    $X=$ Irrelevant
    $\mathrm{P}=$ Present State
    $R=$ Previous State

[^29]:    *Derate at the rate of $16.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

[^30]:    L = Low Logic Level
    $H=$ High Logic Level
    $X=$ Irrelevant
    $\mathrm{P}=$ Present State
    $R=$ Previous State

[^31]:    *Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See following part number description.

[^32]:    *Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See previous part number description.

[^33]:    *Complete part number includes a prefix to indicate temperature range and a suffix to indicate package style. See following part number description.

[^34]:    Note 1: All limits stated apply to the complete Darlington series except as specified for a single device type.
    Note 2: The $I_{\text {IN(OFF) }}$ current limit guarantees against partial turn-on of the output.
    Note 3: The $V_{\mathbb{N}(\mathbb{N})}$ voltage limit guarantees a minimum output sink current per the specified test conditions.

[^35]:    L = Low Logic Level
    $H$ = High Logic Level
    $X=$ Irrelevant
    $P=$ Present State
    $R=$ Previous State

[^36]:    $L=$ Low Logic Level
    H = High Logic Level
    $X=$ Irrelevant
    $P=$ Present State
    $R=$ Previous State

[^37]:    *New Product . . Contact factory for detailed information.

[^38]:    Supply Voltage, $\mathrm{V}_{\mathrm{Cc}}$
    (Note 1)
    Zener Current, $I_{\text {REG }}$. . . . . . . . . . . . . . . . . . . . . . . . . 60 mA
    Package Power Dissipation, $P_{D}$ (Note 2) . . . . . . . . . . . 1.0 W
    Operating Temperature Range, $\mathrm{T}_{\mathrm{A}} \ldots \ldots .-20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
    Storage Temperature Range, $\mathrm{T}_{\mathrm{S}} \ldots \ldots . .-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
    NOTES:

    1. Dependent on value of external current limiting resistor, 13 V at $0 \Omega$.
    2. Derate at the rate of $15 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$.
[^39]:    ${ }^{(3}$ Registered Trademark, Dolby Laboratories, Inc.

[^40]:    ${ }^{\text {® }}$ Registered Trademark, Dolby Laboratories, Inc.

[^41]:    Copyright © 1980 IEEE. Reprinted by permission. This paper was originally presented at the IEEE Fall Conference on Consumer Electronics, Chicago, III., November 1980.

[^42]:    ${ }^{*}$ Derate at the rate of $0.33 \mathrm{~W} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{TAB}}=+90^{\circ} \mathrm{C}$

[^43]:    TEST CIRCUIT
    AND TYPICAL APPLICATION
    

    Dwg. No. A-11,716A

[^44]:    "Magnetic flux density is measured at most sensitive area of device, located $0.032^{\prime \prime} \pm 0.002(0.81 \pm 0.05 \mathrm{~mm})$ below the branded face of the " $T$ " package and $0.012^{\prime \prime} \pm 0.002$ " $(0.305 \pm 0.05 \mathrm{~mm})$ below the branded face of the " U " package.

[^45]:    *Magnetic flux density is measured at most sensitive area of device, located 0.032 " $\pm 0.002(0.81 \pm 0.05 \mathrm{~mm})$ below the branded face of the " T " package and $0.012^{\prime \prime} \pm 0.002$ ' $(0.305 \pm 0.05 \mathrm{~mm})$ below the branded face of the " $U$ " package.

[^46]:    *Selected devices are available with a maximum $\mathrm{T}_{\mathrm{A}}$ rating of $+150^{\circ} \mathrm{C}$.

[^47]:    NOTE 1. All output voltage measurements are made with a voltmeter having an input impedance of $10 \mathrm{k} \Omega$ or greater.
    NOTE 2. Magnetic flux density is measured at the most sensitive area of the device, which is centered on the branded side of the T package, $0.042 \pm 0.001^{\prime \prime}$ ( $1.07 \pm 0.03 \mathrm{~mm}$ ) below the surface and $0.022^{\prime \prime} \pm 0.001^{\prime \prime}(0.56 \pm 0.03 \mathrm{~mm})$ below the branded side of the $U$ package.

[^48]:    1. $I_{c c}$ is limited to a maximum value which produces a 7 V drop across the control resistance, $\mathrm{R}_{1-3}$.
    2. Terminal 1 must always be positive in relation to terminal 3 .
[^49]:    *Indiana General Magnet Products Co. SR8522.

[^50]:    $T_{A}$ Max. Operating Temperature for $U G N$ prefix devices is $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$.
    $\mathrm{T}_{\mathrm{A}}$ Max. Operating Temperature for UGS prefix devices is $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
    *Dual Outputs

[^51]:    NOTE 1. All output voltage measurements are made with a voltmeter having an input impedance of $10 \mathrm{k} \Omega$ or greater.
    NOTE 2. Magnetic flux density is measured at the most sensitive area of the device, which is centered on the branded side of the package: $0.042 \pm 0.001^{\prime \prime}(1.07 \pm 0.03 \mathrm{~mm})$ below the surface of the $T$ package or $0.022^{\prime \prime} \pm 0.001^{\prime \prime}(0.56 \pm 0.03 \mathrm{~mm})$ below the surface of the $U$ package.

[^52]:    NOTE 1. All output voltage measurements are made with a voltmeter having an input impedance of $10 \mathrm{k} \Omega$ or greater and a common mode rejection ratio greater than 60 dB .

[^53]:    Power Dissipation $\mathrm{T}_{\mathrm{A}}$ to $+55^{\circ} \mathrm{C}$ :
    Each Transistor. ..... 300 mW
    Total Package ..... 750 mW
    Derating Factor, Total Package, $\mathrm{T}_{\mathrm{A}} \geq 55^{\circ} \mathrm{C}$ ..... $6.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
    Collector-Base Voltage, $\mathrm{V}_{\text {(BR)свO }}$ ..... 20V
    Collector-Substrate Voltage, $\mathrm{V}_{(\mathrm{BR}) \mathrm{C} 10}$ (See note 2) ..... 20V
    Collector-Emitter Voltage, $\mathrm{V}_{\text {(BR)CEO }}$ ..... 15 V
    Emitter-Base Voltage, $\mathrm{V}_{\text {(BR) } \mathrm{EBO}}$ ..... 5V
    Collector Current, Ic ..... 50 mA
    Base Current IB ..... 5 mA
    Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$ ..... $20^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
    Storage Temperature Range, $\mathrm{T}_{\mathrm{S}}$ ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
    Notes:

    1. The maximum ratings are limiting absolute values above which the serviceability may be impaired from the viewpoint of life or satisfactory performance. The breakdown voltages may be far above the maximum voltage ratings. To avoid permanent damage to the transistor, do not attempt to measure these characteristics above the maximum ratings.
    2. Pin 5 is connected to the substrate. This terminal must be tied to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.
[^54]:    *Applies only to transistors $\mathrm{Q}_{1}$ and $\mathrm{Q}_{2}$ when connected as a differential pair.

[^55]:    *Derate at the rate of $18.18 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
    ${ }^{* *}$ Derate at the rate of $16.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

[^56]:    NOTE: Light source is an infrared LED with a peak output wavelength of 880 nm .

[^57]:    *Derate linearly to 0 watts at $T_{A}=+150^{\circ} \mathrm{C}$

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